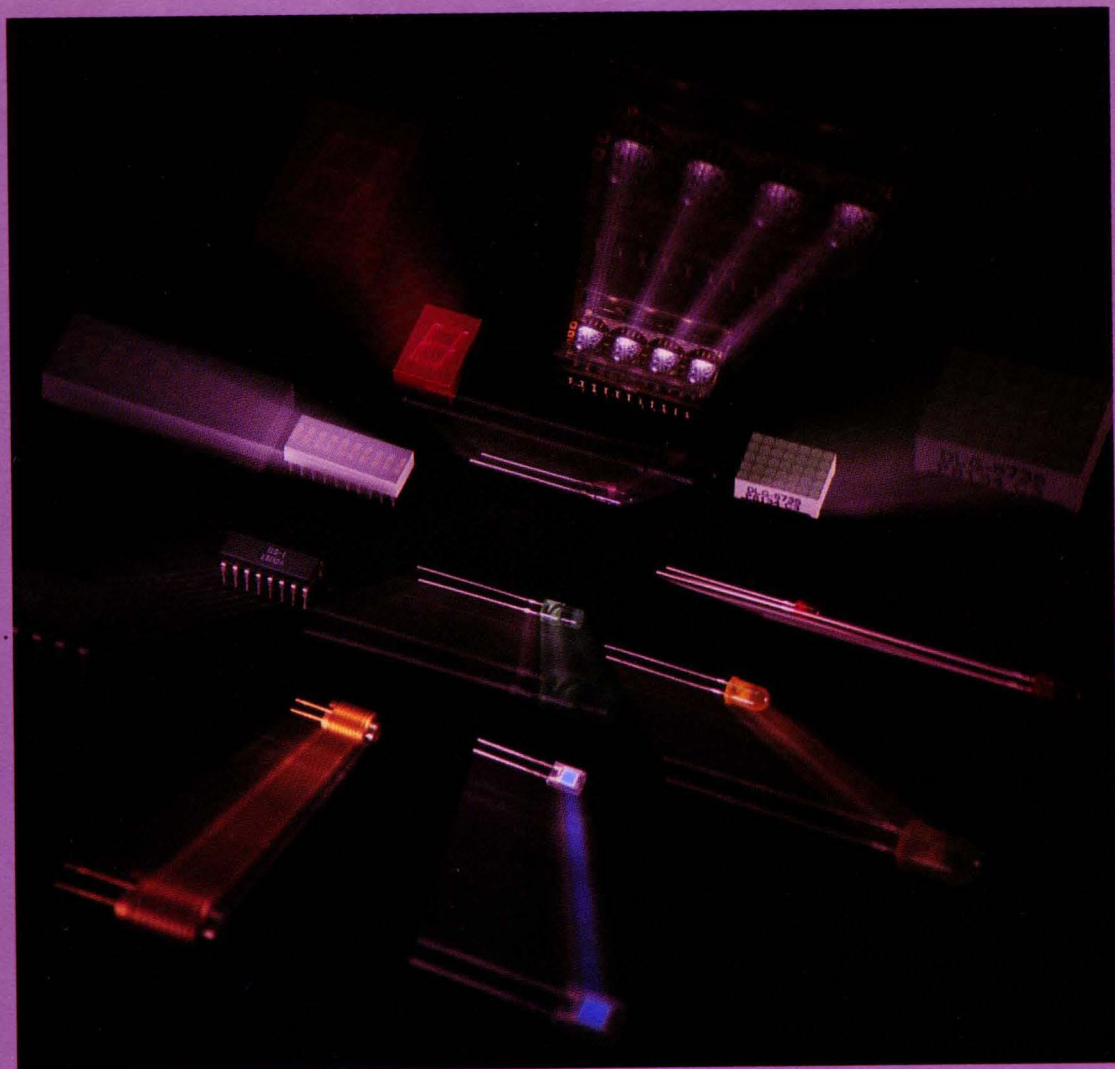
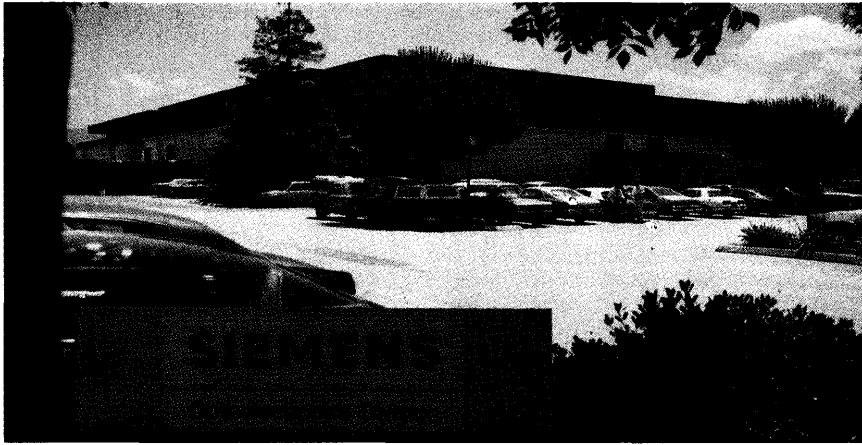


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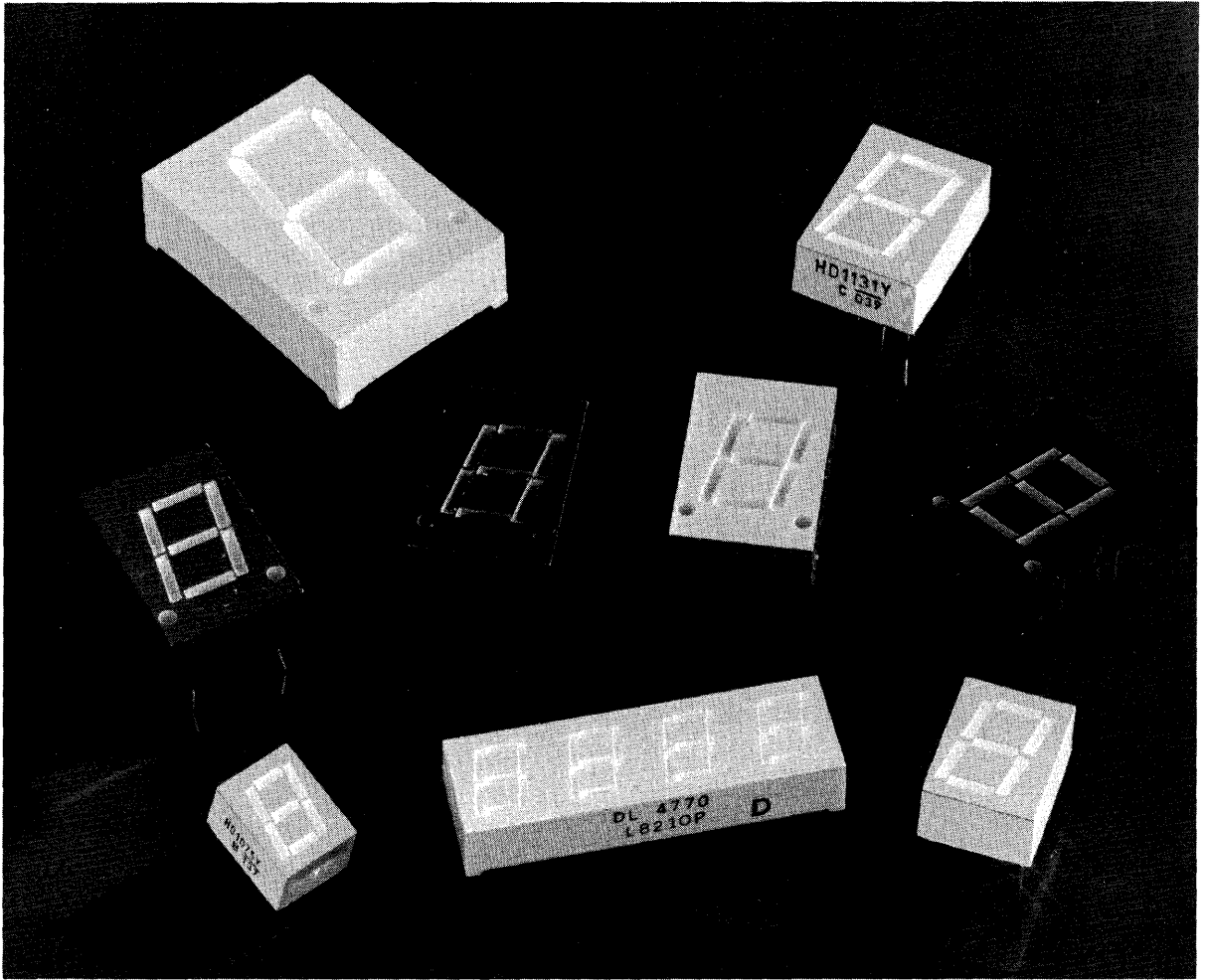
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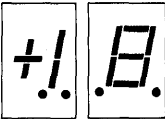
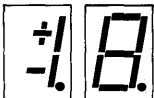
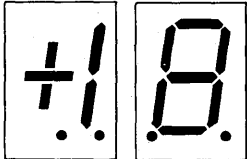
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| LDH-5121 | Lamp, HER, T1¼, 2.0 mcd @ 10 mA | 173 | LPT80 | Photoxtr, Plastic, Side Facing 40 Deg | 397 |
| LDH-5122 | Lamp, HER, T1¼, 4.0 mcd @ 10 mA | 173 | LPT100 | Phototransistor, Ceramic, 30 Deg, .2 mA | 399 |
| LDH-5123 | Lamp, HER, T1¼, 6.0 mcd @ 10 mA | 173 | LPT100A | Photoxtr, Ceramic TO-18, 30 Deg, 1.0 mA | 399 |
| LDH-5191 | Replaces CQV51FG,H T1¼ HER Lamp | 169 | LPT100B | Photoxtr, Ceramic TO-18, 30 Deg, 1.3 mA | 399 |
| LDH-5192 | Replaces CQV51J T1¼ HER Lamp | 169 | LPT110 | Photoxtr, Ceramic TO-18, 50 Deg, .2 mA | 399 |
| LDH-5193 | Replaces CQV51K T1¼ HER Lamp | 169 | LPT110A | Photoxtr, Ceramic TO-18, 50 Deg, .6 mA | 399 |
| LDH-5601 | Replaces CQV56-4 T1¼ HER Lamp | 177 | LPT110B | Photoxtr, Ceramic TO-18, 50 Deg, .8 mA | 399 |
| LDH-5602 | Replaces CQV56-5 T1¼ HER Lamp | 177 | LPT500 | Photoxtr, Wide Gap | 402 |
| LDR-460 | Replaces LD460 10 Element Red Array | 141 | MDL2416 | Int. Display, 4 Char, 15", Red Hi-Rel | 92 |
| LDR-461 | Replaces LD461 1 Element Red Lamp | 141 | MDL2416B | Int. Display, 4 Char, 15", Hi-Rel Lev. B | 92 |
| LDR-462 | Replaces LD462 2 Element Red Array | 141 | OBG1000 | Display, HER Red, 10 Element Bargraph | 42 |
| LDR-463 | Replaces LD463 3 Element Red Array | 141 | OBG-4830 | Display, HER, 10 Element Bargraph | 44 |
| LDR-464 | Replaces LD464 4 Element Red Array | 141 | OLB-2300 | Light Bar, HER, .15"x.35" Emitting Area | 39 |
| LDR-465 | Replaces LD465 5 Element Red Array | 141 | OLB-2655 | Light Bar, HER, .35"x.35" Emitting Area | 40 |
| LDR-466 | Replaces LD466 6 Element Red Array | 141 | OLB-2685 | Light Bar, HER, .35"x.75" Emitting Area | 41 |
| LDR-467 | Replaces LD467 7 Element Red Array | 141 | PD2816 | Int. Display, 8 Char, 160" Red | 96 |
| LDR-468 | Replaces LD468 8 Element Red Array | 141 | RBG-112 | Linear Array, 112 Element | 46 |
| LDR-469 | Replaces LD469 9 Element Red Array | 141 | RBG-1000 | Display, HER Green, 10 Element Bargraph | 42 |
| LDR-1101 | Replaces CQV10-3 T1 Red Lamp | 149 | RBG-4820 | Display, Red, 10 Element Bargraph | 44 |
| LDR-1102 | Replaces CQV10-4,4 T1 Red Lamp | 149 | RBG-8820 | Linear Array, 101 Element | 48 |
| LDR-1103 | Lamp, Red, T1, 4.0 mcd @ 20 mA | 149 | RGL5621 | Lamp, Resistor, Axial, Green, 2 mcd @ 5V | 195 |
| LDR-1201 | Lamp, Red, T1¼, 1.0 mcd @ 20 mA | 153 | RL50 | Lamp, Axial, Red, 5 mcd @ 10 mA Water Cir | 181 |
| LDR-3501 | Replaces RL209A & RL4484, 1, T1 Red Lamp | 157 | RL50-01 | Replaced by RL54 Red Lamp | 183 |
| LDR-3502 | Replaces RL209-2, LD350-4 T1 Red Lamp | 157 | RL54 | Lamp, Axial, Red, 0.5 mcd Typ. @ 10 mA | 183 |
| LDR-3503 | Lamp, Red, T1, 4.0 mcd @ 20 mA | 157 | RL55 | Lamp, Axial, Red, 2.0 mcd @ 10 mA | 185 |
| LDR-3701 | Replaces CQV37-1 Rect Red Lamp | 161 | RL209-1 | Replaced by LDR3501 T1 Red Lamp | 157 |
| LDR-3702 | Replaces CQV37-2 Rect Red Lamp | 161 | RL209-2 | Replaced by LDR3502 T1 Red Lamp | 157 |
| LDR-5001 | Replaces RL4403 & RL4850, T1¼ Red Lamp | 165 | RL209A | Replaced by LDR3501 T1 Red Lamp | 157 |
| LDR-5002 | Replaces RL2000, CQV20-4 & -5 T1¼ Red Lamp | 165 | RL2000 | Replaced by LDR5001 T1¼ Red Lamp | 165 |
| LDR-5003 | Lamp, T1¼, Red, 4.0 mcd @ 20 mA | 165 | RL4403 | Replaced by LDR5001 T1¼ Red Lamp | 165 |
| LDR-5091 | Replaces LD50-1, 2, T1¼ Red Lamp | 169 | RL4484 | Replaced by LDR3501 T1 Red Lamp | 157 |
| LDR-5092 | Replaces CQV50-6,7 T1¼ Red Lamp | 169 | RL4850 | Replaced by LDR5001 T1¼ Red Lamp | 165 |
| LDR-5093 | Replaces CQV50-8 T1¼ Red Lamp | 169 | RL5053-1 | Replaced by LDR5101 T1¼ Red Lamp | 173 |
| LDR-5101 | Replaces RL5053A & -1 T1¼ Red Lamp | 173 | RL5053-2 | Replaced by LDR5102 T1¼ Red Lamp | 173 |
| LDR-5102 | Replaces RL5053-2, T1¼ Red Lamp | 173 | RL5053-3 | Replaced by LDR5102 T1¼ Red Lamp | 173 |
| LDR-5103 | Replaces RL5053-3, T1¼ Red Lamp | 173 | RL5053-A | Replaced by LDR5101 T1¼ Red Lamp | 173 |
| LDR-5701 | Replaces CQV57-1 Cylin Red Lamp | 177 | RRL-1100 | Lamp, Resistor, T1, Red 5V | 189 |
| LDR-5702 | Replaces CQV57-2 Cylin Red Lamp | 177 | RRL-3105 | Lamp, Resistor, T1¼, Red 5V | 191 |
| LDRG-2340 | SOT 23 Surface Mountable Lamp | 145 | RRL-3112 | Lamp, Resistor, T1¼, Red 12V | 191 |
| LDY-481 | Replaces LD481 1 Element Yellow Lamp | 143 | RRL5601 | Lamp, Resistor Axial, Red, 3 mcd @ 5V | 193 |
| LDY-1131 | Replaces CQV13-4,5 T1 Yellow Lamp | 149 | RRL5621 | Lamp, Resistor Axial, Red, .6 mcd @ 5V | 193 |
| LDY-1132 | Replaces CQV13-6 T1 Yellow Lamp | 149 | RRL5641 | Lamp, Resistor Axial, Red, 1.0 mcd @ 5V | 193 |
| LDY-1133 | Replaces CQV13-7 T1 Yellow Lamp | 149 | RYL5621 | Lamp, Resistor Axial, Yellow, .2 mcd @ 5V | 195 |
| LDY-1231 | Lamp, Yellow, T1¼, 1.0 mcd @ 10 mA | 153 | SFH100 | Photodiode, Plastic, 1.2µS, 10nA | 362 |
| LDY-2320 | SOT 23 Surface Mountable Lamp | 145 | SFH200 | Photodiode, SFH200, 1µS, 20pA | 364 |
| LDY-3561 | Replaces YL212, YL4484 T1 Yellow Lamp | 157 | SFH202 | Photodiode, Pin, TO-18, 0.5nS, 5nA | 366 |
| LDY-3562 | Lamp, Yellow, T1, 2.5 mcd @ 10 mA | 157 | SFH203 | Replaced by BPW21 | 368 |
| LDY-3801 | Replaces CQV38-3 Rect Yellow Lamp | 161 | SFH204 | Photodiode, Plastic, 4 Quadrant, 2nA | 370 |
| LDY-3802 | Replaces CQV38-4 Rect Yellow Lamp | 161 | SFH205 | Photodiode, Black TO-92, Pin, 50nS, 30nA | 372 |
| LDY-3803 | Replaces CQV38-5 Rect Yellow Lamp | 161 | SFH205-Q2 | Photodiode, Pin, Black TO-92, 50nS, 30nA | 374 |
| LDY-5061 | Replaces CQV23-4, 5, LD506-5 T1¼ Yellow Lamp | 165 | SFH206 | Photodiode, Black TO92, Pin, 50nS, 30nA | 376 |
| LDY-5062 | Replaces CQV23-6,7, LD506-6,7 T1¼ Yellow Lamp | 165 | SFH206K | Photodiode, Pin, 50nS, 30nA | 378 |
| LDY-5161 | Replaces LD516-5,6 YL4550/4850 T1¼ Yellow Lamp | 173 | SFH305-2 | Photoxtr, Mini, 16 Deg, 1.0 mA | 404 |
| LDY-5162 | Replaces LD516-7, T1¼ Yellow Lamp | 173 | SFH305-3 | Photoxtr, Mini, 16 Deg, 1.6 mA | 404 |
| LDY-5163 | Replaces LD516-8, T1¼ Yellow Lamp | 173 | SFH309 | Photoxtr, T1, 1mA, 30 Deg | 406 |
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| LDY-5802 | Replaces CQV58-4 Cylin Yellow Lamp | 177 | SFH402-2 | Emitter, IR, TO-18, 40 Deg, 2.5mW/SR | 302 |
| LDY-5803 | Replaces CQV58-5 Cylin Yellow Lamp | 177 | SFH402-3 | Emitter, IR, TO-18, 40 Deg, 4.0mW/SR | 302 |

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| SFH600-3 | Isolator, 6 Pin Sngl, 160% CTR, 2800V | 255 |
| SFH601-1 | Isolator, 6 Pin Sngl, 40% CTR, 5300V | 259 |
| SFH601-2 | Isolator, 6 Pin Sngl, 63% CTR, 5300V | 259 |
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| SFH601-4 | Isolator, 6 Pin Sngl, 160% CTR, 5300V | 259 |
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| SFH610-2 | Isolator, 4 Pin Sngl, 63% CTR, 2600V | 267 |
| SFH610-3 | Isolator, 4 Pin Sngl, 100% CTR, 2600V | 267 |
| SFH610-4 | Isolator, 4 Pin Sngl, 160% CTR, 2600V | 267 |
| SFH611-1 | Isolator, 4 Pin Sngl, 40% CTR, 2600V | 267 |
| SFH611-2 | Isolator, 4 Pin Sngl, 63% CTR, 2600V | 267 |
| SFH611-3 | Isolator, 4 Pin Sngl, 100% CTR, 2600V | 267 |
| SFH611-4 | Isolator, 4 Pin Sngl, 160% CTR, 2600V | 267 |
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| YL4550 | Replaced by LDY5161 T1¾ Yellow Lamp | 173 |
| YL4850 | Replaced by LDY5161 T1¾ Yellow Lamp | 173 |
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| YLB-2755 | Light Bar, Yellow, .35"x.35" Emitting Area | 40 |
| YLB-2785 | Light Bar, Yellow, .35"x.75" Emitting Area | 41 |



Led Numeric Displays

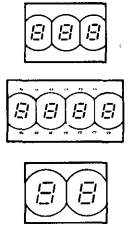
| Package Type | Package Dimensions (Shown Actual Size) | Part Number | Character Height | Description | Polarity | Color | Luminous Intensity Per Segment | | Page |
|--|--|-------------|------------------|-------------------|-----------------|-----------------|--------------------------------|-------|--------|
| | | | | | | | Type | @ mA | |
| Single Digit Encapsulated (Filled Reflector) |  H W D .750" .500" .246" | DL-7750R | 11mm .43" | 7 seg. D.P. left | C.A. | Red | 400 μ cd | 20 | 21 |
| | | DL-7751R | | 7 seg. D.P. right | UNIV. | | | | |
| | | DL-7756R | | ± 1 overflow | | | | | |
| | | DL-7760R | | 7 seg. D.P. right | C.C. | Hi. Eff. Red | 1720 μ cd | 20 | |
| | | DL-7650O | | 7 seg. D.P. left | C.A. | | | | |
| | | DL-7651O | | 7 seg. D.P. right | UNIV. | | | | |
| | | DL-7653O | | 7 seg. D.P. right | | | | | |
| | | DL-7656O | | ± 1 overflow | C.A. | | | | |
| | | DL-7660Y | | 7 seg. D.P. left | C.A. | | | | |
| | | DL-7661Y | | 7 seg. D.P. right | C.C. | | | | |
| | | DL-7663Y | | 7 seg. D.P. right | | | | | |
| | | DL-7666Y | | ± 1 overflow | UNIV. | Green | 640 μ cd | 20 | |
| | | DL-7670G | | 7 seg. D.P. left | C.A. | | | | |
| | | DL-7671G | | 7 seg. D.P. right | UNIV. | | | | |
| | | DL-7673G | | 7 seg. D.P. right | | | | | |
| DL-7676G | ± 1 overflow | C.C. | | | | | | | |
| Single Digit Encapsulated (Filled Reflector) |  H W D .691" .488" .238" | HD1131R | 13.5mm .53" | 7 seg. D.P. right | C.A. | | | | Red |
| | | HD1132R | | ± 1 overflow | C.C. | | | | |
| | | HD1133R | | 7 seg. D.P. right | | | | | |
| | | HD1134R | | ± 1 overflow | Hi. Eff. Red | 1400 μ cd | 20 | | |
| | | HD1131O | | 7 seg. D.P. right | | | | C.A. | |
| | | HD1132O | | ± 1 overflow | | | | UNIV. | |
| | | HD1133O | | 7 seg. D.P. right | | | | | |
| | | HD1134O | | ± 1 overflow | | | | C.A. | |
| | | HD1131Y | | 7 seg. D.P. right | | | | C.A. | Yellow |
| | | HD1132Y | | ± 1 overflow | C.C. | | | | |
| | | HD1133Y | | 7 seg. D.P. right | | | | | |
| | | HD1134Y | | ± 1 overflow | C.A. | Green | 1400 μ cd | 20 | |
| | | HG1131G | | 7 seg. D.P. right | C.A. | | | | |
| | | HG1132G | | ± 1 overflow | UNIV. | | | | |
| | | HG1133G | | 7 seg. D.P. right | | | | | |
| HG1134G | ± 1 overflow | C.C. | | | | | | | |
| Single Digit Encapsulated (Filled Reflector) |  H W D 1.09" .780" .330" | DL-3400 | 20mm .8" | 7 seg. D.P. left | C.A. | | | | Red |
| | | DL-3401 | | 7 seg. D.P. right | UNIV. | | | | |
| | | DL-3403 | | 7 seg. D.P. right | | | | | |
| | | DL-3405 | | 7 seg. D.P. left | Hi. Eff. Red | 2000 μ cd | 20 | | |
| | | DL-3406 | | ± 1 overflow | | | | C.A. | |
| | | DLO-3900 | | 7 seg. D.P. left | | | | C.C. | |
| | | DLO-3901 | | 7 seg. D.P. right | | | | | |
| | | DLO-3903 | | 7 seg. D.P. right | | | | UNIV. | |
| | | DLO-3905 | | 7 seg. D.P. left | | | | | |
| | | DLO-3906 | | ± 1 overflow | | | | | |

PACKAGE DIMENSIONS: H (HEIGHT), W (WIDTH), D (DEPTH - WITHOUT LEADS OR STANDOFFS)

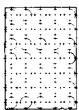
| Package Type | Package Dimensions (Shown Actual Size) | | | Part Number | Character Height | Description | Polarity | Color | Luminous Intensity Per Segment | | Page |
|--|---|-------------|--|-----------------------------------|------------------|-----------------|-------------------|-------|--------------------------------|---------|------|
| | | | | | | | | | Typ | @ mA | |
| Compact Single Digit Encapsulated (Filled Reflector) | H .390" W .295" D .236" | 7mm .28" | HD1075R | 7 seg. D.P. right | C.A. | Red | 800μcd | 20 | | | |
| | | | HD1077R | 7 seg. D.P. right | C.C. | | | | | | |
| | | | HD1075O | 7 seg. D.P. right | C.A. | Hi. Eff. Red | 1000μcd | 15 | | | |
| | | | HD1077O | 7 seg. D.P. right | C.C. | | | | | | |
| | | | HD1075Y | 7 seg. D.P. right | C.A. | Yellow | 900μcd | 15 | | | |
| | | | HD1077Y | 7 seg. D.P. right | C.C. | | | | | | |
| | | | HG1075G | 7 seg. D.P. right | C.A. | Green | 1000μcd | 15 | | | |
| | | | HG1077G | 7 seg. D.P. right | C.C. | | | | | | |
| Compact Four Digit Encapsulated (Filled Reflector) | H .390" W 1.26" D .220" | 7mm .28" | DL-4770 | 7 seg. D.P. right | C.C. | Red | 180μcd | 10 | | | |
| | | | DL-4775 | | C.A. | | | | | | |
| | | | DLO-4770 | 7 seg. D.P. right | C.C. | Hi. Eff. Red | 400μcd | 10 | | | |
| | | | DLO-4775 | | C.A. | | | | | | |
| | | | Compact Single Digit Encapsulated (Filled Reflector) | H .508" W .386" D .236" | 10mm .39" | HD1105R | 7 seg. D.P. right | C.A. | Red | 1000μcd | 25 |
| | | | | | | HD1107R | 7 seg. D.P. right | C.C. | | | |
| HD1105O | 7 seg. D.P. right | C.A. | | | | Hi. Eff. Red | 1000μcd | 15 | | | |
| HD1107O | 7 seg. D.P. right | C.C. | | | | | | | | | |
| HD1105Y | 7 seg. D.P. right | C.A. | | | | Yellow | 900μcd | 15 | | | |
| HD1107Y | 7 seg. D.P. right | C.C. | | | | | | | | | |
| HG1105G | 7 seg. D.P. right | C.A. | | | | Green | 1000μcd | 15 | | | |
| HG1107G | 7 seg. D.P. right | C.C. | | | | | | | | | |

PACKAGE DIMENSIONS: H (HEIGHT), W (WIDTH), D (DEPTH – WITHOUT LEADS OR STANDOFFS)

Magnified Monolithic Numeric Displays

| Package Type | Package Dimensions (Shown Actual Size) | Part Number | Character Height | Description | Polarity | Color | Luminous Intensity Per Segment Typ @ (mA) | | Page | | | | | | | | | | | | | | | | | | |
|---|---|-------------|------------------|----------------|------------------------|---------|---|-------|-------|---------|-------|-------|-------|---------|-------|-------|-------|---------|-------|-------|-------|--|--|--|--|--|--|
| Multi Digit Magnified Monolithic |  | DL-330M | 2.8mm | 7 seg. 3 Digit | C.C. MULTI- PLEX | Red | 1500 μ cd | 5 | 13 | | | | | | | | | | | | | | | | | | |
| | | DL-340M | .11" | 7 seg. 4 Digit | | | | | | | | | | | | | | | | | | | | | | | |
| | | DL-430M | 3.8mm | 7 seg. 3 Digit | | | | | | | | | | | | | | | | | | | | | | | |
| | | DL-440M | .15" | 7 seg. 2 Digit | | | | | | | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | <table border="0"> <tr> <td></td> <td>H</td> <td>W</td> <td>D</td> </tr> <tr> <td>DL-330M</td> <td>.435"</td> <td>.595"</td> <td>.230"</td> </tr> <tr> <td>DL-340M</td> <td>.435"</td> <td>.795"</td> <td>.230"</td> </tr> <tr> <td>DL-430M</td> <td>.435"</td> <td>.895"</td> <td>.300"</td> </tr> <tr> <td>DL-440M</td> <td>.435"</td> <td>.595"</td> <td>.300"</td> </tr> </table> | | H | W | D | DL-330M | .435" | .595" | .230" | DL-340M | .435" | .795" | .230" | DL-430M | .435" | .895" | .300" | DL-440M | .435" | .595" | .300" | | | | | | |
| | H | W | D | | | | | | | | | | | | | | | | | | | | | | | | |
| DL-330M | .435" | .595" | .230" | | | | | | | | | | | | | | | | | | | | | | | | |
| DL-340M | .435" | .795" | .230" | | | | | | | | | | | | | | | | | | | | | | | | |
| DL-430M | .435" | .895" | .300" | | | | | | | | | | | | | | | | | | | | | | | | |
| DL-440M | .435" | .595" | .300" | | | | | | | | | | | | | | | | | | | | | | | | |

Alpha Numeric Display

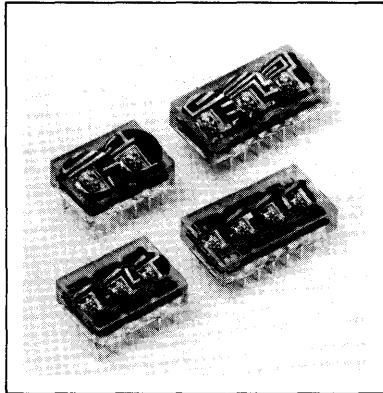
| Package Type | Package Dimensions (Shown Actual Size) | Part Number | Light Emitting Area | Description | Polarity | Color | Luminous Intensity Per Segment Typ @ (mA) | | Page | | | | | |
|---|---|-------------|---------------------|------------------|--------------------|-------|---|----|------|--|--|--|--|--|
| Single Char. Encap- sulated (Filled Reflector) |  | DLR-5735 | 17.5mm .69" | 5 x 7 dot matrix | Common cathode row | Red | 200 μ cd | 20 | 19 | | | | | |
| | | DLR-5736 | | | Common anode row | | | | | | | | | |
| | | DLG-5735 | | | MULTI- PLEX | | | | | | | | | |
| | | DLG-5736 | | | Common cathode row | | | | | | | | | |
| | | | | | Common anode row | | | | | | | | | |
| | <table border="0"> <tr> <td>H</td> <td>W</td> <td>D</td> </tr> <tr> <td>.705"</td> <td>.505"</td> <td>.250"</td> </tr> </table> | H | W | D | .705" | .505" | .250" | | | | | | | |
| H | W | D | | | | | | | | | | | | |
| .705" | .505" | .250" | | | | | | | | | | | | |

SIEMENS

DL-330M .11 INCH 3 DIGIT DL-430M .15 INCH 3 DIGIT

DL-340M .11 INCH 4 DIGIT DL-440M .15 INCH 2 DIGIT

RED 7 SEGMENT MAGNIFIED MONOLITHIC NUMERIC DISPLAY



FEATURES

- Rugged Encapsulated Package
- Integrated Magnifier Lens
- Monolithic Construction for Maximum Brightness at Minimum Power
- Common Cathode for Simplicity of Multiplexing
- Standard Dual-In-Line Package
- Categorized for Brightness Uniformity

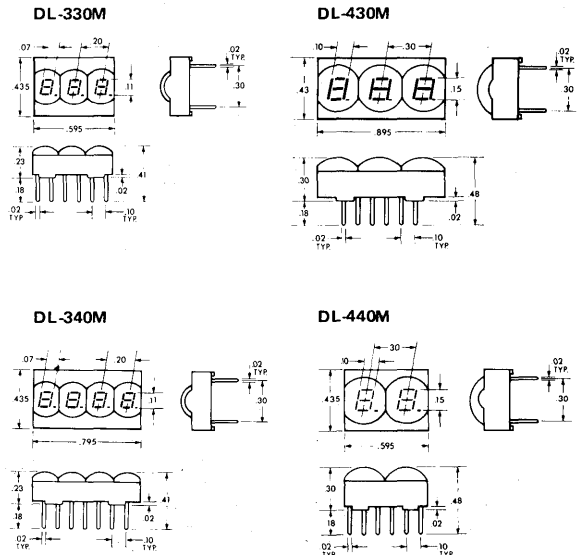
DESCRIPTION

The DL-330M/340M and DL-430M/440M are red numeric LED displays. Low cost is achieved through minimum use of monolithic GaAsP material and magnification to full height using a simple integrated lens construction. A red plexiglass or circularly polarized filter is recommended to enhance visibility and to eliminate glare from the surface of the package.

These displays are designed for multiplex operation, the desired digit being displayed by selecting the appropriate cathode. A right hand decimal point is provided.

All devices are optimized for low power portable battery operated equipment using MOS and CMOS integrated logic circuits such as DMM's and digital thermometers.

Package Dimensions in Inches (mm)



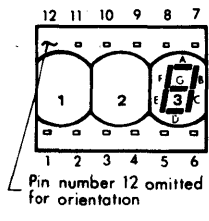
Maximum Ratings (at 25 °C)

| | |
|-----------------------------------|------------------|
| Power Dissipation/Digit | 80 mW |
| Derating Factor from 25 °C/Digit | 1.8 mW/°C |
| Storage and Operating Temperature | -20 °C to +70 °C |
| Continuous Forward Current | |
| Per Segment and Decimal | 20 mA |
| Per Digit Total | 40 mA |
| Peak Inverse Voltage | |
| Per Segment and Decimal | 3 V |

Opto-Electronic Characteristics (at 25 °C)

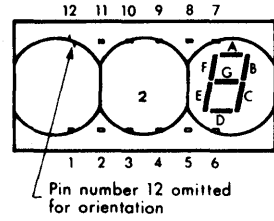
| Parameter | Min | Typ | Max | Unit | Test Condition |
|--------------------------|-----|-----|-----|------|------------------------|
| Luminance | 1.5 | | | mcd | I _F = 5 mA |
| Emission Peak Wavelength | 650 | | | nm | |
| Line Half-Width | 40 | | | nm | |
| Forward Voltage | | 1.7 | 2.0 | | I _F = 20 mA |
| Dynamic Resistance | 7 | | | Ω | I _F = 10 mA |
| Capacitance | 50 | | | pF | V = 0, f = 1 MHz |
| Reverse Leakage | | | 100 | μA | V _R = 3.0 V |

Specifications subject to change without notice.



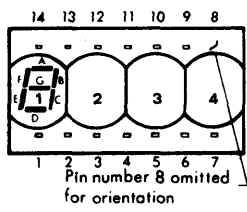
DL-330M

| Pin | Function |
|-----|------------|
| 1 | Cathode D1 |
| 2 | Anode E |
| 3 | Anode D |
| 4 | Cathode D2 |
| 5 | Anode C |
| 6 | Anode DP |
| 7 | Cathode D3 |
| 8 | Anode B |
| 9 | Anode G |
| 10 | Anode A |
| 11 | Anode F |
| 12 | No Pin |



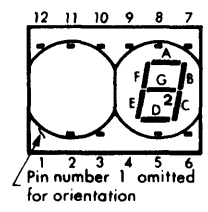
DL-430M

| Pin | Function |
|-----|------------|
| 1 | Cathode D1 |
| 2 | Anode E |
| 3 | Anode D |
| 4 | Cathode D2 |
| 5 | Anode C |
| 6 | Anode DP |
| 7 | Cathode D3 |
| 8 | Anode B |
| 9 | Anode G |
| 10 | Anode A |
| 11 | Anode F |
| 12 | No Pin |



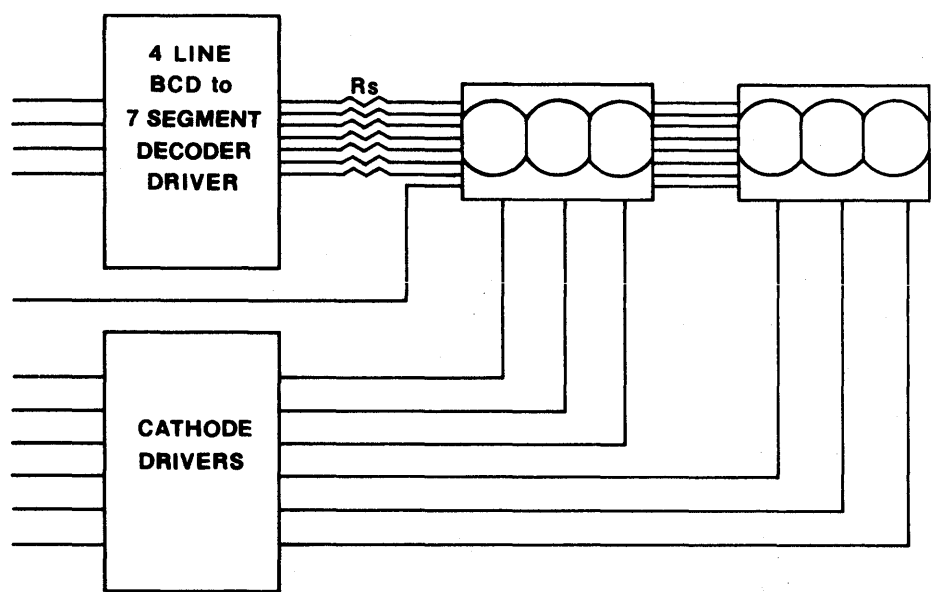
DL-340M

| Pin | Function |
|-----|---------------|
| 1 | No Connection |
| 2 | Anode E |
| 3 | Anode D |
| 4 | Anode C |
| 5 | Anode DP |
| 6 | Anode G |
| 7 | Cathode 4 |
| 8 | No Pin |
| 9 | Anode B |
| 10 | Cathode 3 |
| 11 | Anode F |
| 12 | Cathode 2 |
| 13 | Anode A |
| 14 | Cathode 1 |



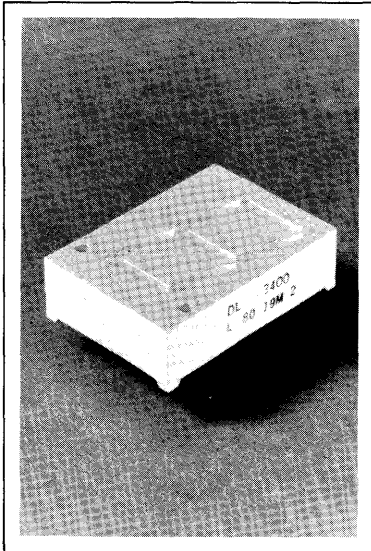
DL-440M

| Pin | Function |
|-----|------------|
| 1 | No Pin |
| 2 | Anode E |
| 3 | Anode D |
| 4 | No Pin |
| 5 | Anode C |
| 6 | Anode DP |
| 7 | Cathode D2 |
| 8 | Anode B |
| 9 | Anode G |
| 10 | Anode A |
| 11 | Anode F |
| 12 | Cathode D1 |

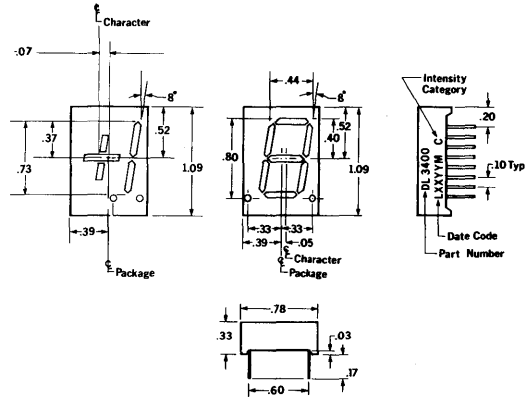


BLOCK DIAGRAM FOR TYPICAL DISPLAY DRIVE CIRCUITRY

DLO-3900 SERIES HIGH EFFICIENCY RED 0.8 INCH SEVEN SEGMENT NUMERIC DISPLAY



Package Dimensions in Inches



Specifications subject to change without notice.

FEATURES

- Rugged Encapsulated Package
- Filled Reflector Construction
- Very Large 0.8 inch (20 mm) Digit Height
- Choice of: Common Anode or Common Cathode
Left or Right Decimal Point
Universal Polarity Overflow
- Wide Viewing Angle
- Good "Off" Segment Contrast
- Intensity Coded for Display Uniformity
- Standard 0.6 inch Dual-In-Line Package
with Leads on 0.1 inch Centers

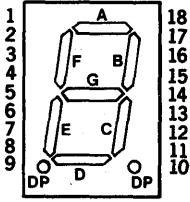
DESCRIPTION

The DL-3400 Series, Red, and DLO-3900 Series, High Efficiency Red, are very large 0.8 inch (20 mm) LED seven segment displays. The series offers the choice of either common anode or common cathode versions, left or right decimal point, as well as a polarity and overflow indicator.

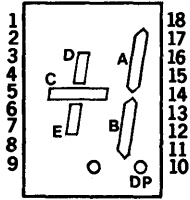
These displays were designed for viewing distances of up to 30 feet and can be used in electronic instruments, point-of-sale systems, clocks, and other general industrial and consumer applications.

These displays are painted to match the appearance of an unlit segment in order to maximize contrast enhancement. Contrast enhancement filters are recommended for use with all displays.

| Part Number | Description | |
|-------------|------------------------|--------------------|
| DL-3400 | Common Anode | Left Hand Decimal |
| DL-3401 | Common Anode | Right Hand Decimal |
| DL-3403 | Common Cathode | Right Hand Decimal |
| DL-3405 | Common Cathode | Left Hand Decimal |
| DL-3406 | Universal Overflow ± 1 | Right Hand Decimal |
| DLO-3900 | Common Anode | Left Hand Decimal |
| DLO-3901 | Common Anode | Right Hand Decimal |
| DLO-3903 | Common Cathode | Right Hand Decimal |
| DLO-3905 | Common Cathode | Left Hand Decimal |
| DLO-3906 | Universal Overflow ± 1 | Right Hand Decimal |



TOP VIEW



TOP VIEW

| PIN | FUNCTION | | | | | PIN |
|-----|----------------|----------------|----------------|----------------|----------------|-----|
| | -3900 -3400 | -3901 -3401 | -3903 -3403 | -3905 -3405 | -3908 -3408 | |
| 1 | NO PIN | NO PIN | NO PIN | NO PIN | NO PIN | 1 |
| 2 | CATHODE A | CATHODE A | ANODE A | ANODE A | CATHODE A | 2 |
| 3 | CATHODE F | CATHODE F | ANODE F | ANODE F | ANODE D | 3 |
| 4 | ANODE | ANODE | CATHODE | CATHODE | CATHODE D | 4 |
| 5 | CATHODE E | CATHODE E | ANODE E | ANODE E | CATHODE C | 5 |
| 6 | ANODE | ANODE | CATHODE | CATHODE | CATHODE E | 6 |
| 7 | CATHODE DP | NO CONN. | NO CONN. | ANODE DP | ANODE E | 7 |
| 8 | NO PIN | NO PIN | NO PIN | NO PIN | CATHODE DP | 8 |
| 9 | NO PIN | NO PIN | NO PIN | NO PIN | NO PIN | 9 |
| 10 | NO PIN | CATHODE DP | ANODE DP | NO PIN | ANODE DP | 10 |
| 11 | CATHODE D | CATHODE D | ANODE D | ANODE D | CATHODE DP | 11 |
| 12 | ANODE | ANODE | CATHODE | CATHODE | CATHODE B | 12 |
| 13 | CATHODE C | CATHODE C | ANODE C | ANODE C | ANODE B | 13 |
| 14 | CATHODE G | CATHODE G | ANODE G | ANODE G | ANODE C | 14 |
| 15 | CATHODE B | CATHODE B | ANODE B | ANODE B | ANODE A | 15 |
| 16 | NO PIN | NO PIN | NO PIN | NO PIN | NO PIN | 16 |
| 17 | ANODE | ANODE | CATHODE | CATHODE | CATHODE A | 17 |
| 18 | NO PIN | NO PIN | NO PIN | NO PIN | NO PIN | 18 |

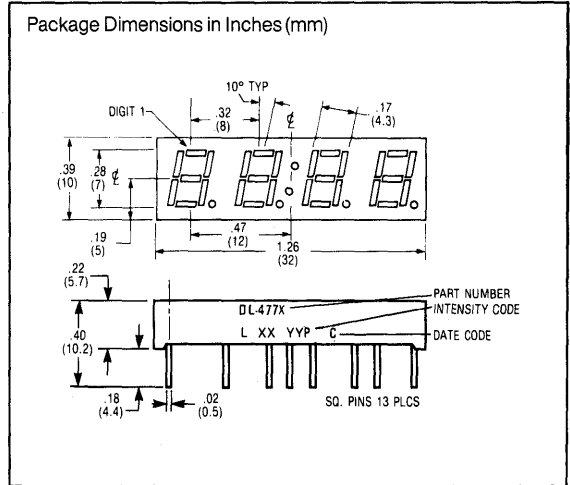
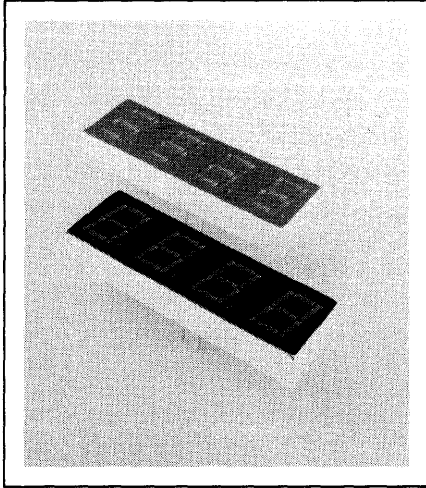
MAXIMUM RATINGS

| | DL-3400 Series | DLO-3900 Series |
|---|-------------------|-------------------|
| Power Dissipation per Segment on D _p (T _A = 50 °C) | 100mW | 85mW |
| Operating Temperature | -20 °C to +85 °C | -20 °C to +85 °C |
| Storage Temperature | -20 °C to +85 °C | -20 °C to +85 °C |
| Peak Forward Current per Segment or D _p (T _A = 50 °C, Pulse Width < 1.2ms) | 200mA | 120mA |
| DC Forward Current per Segment or D _p | 50mA | 30mA |
| Derating Factor from 50 °C | 1mA/°C | .6mA/°C |
| Reverse Voltage per Segment or D _p | 6.0V | 6.0V |
| Lead Soldering Temperature (1/16 inch Below Seating Place) | 260 °C for 3 sec. | 260 °C for 3 sec. |

OPTO-ELECTRICAL CHARACTERISTICS @ T_A = 25 °C

| Parameter | Test Condition | Min. | Typ. | Max. | Units |
|--|-----------------------|------|------|------|-------|
| Luminous Intensity/Segment (Digit Average) | | | | | |
| DL-3400 Series | I _F = 20mA | 500 | 900 | | μcd |
| DLO-3900 Series | I _F = 20mA | 650 | 2000 | | μcd |
| Forward Voltage | | | | | |
| DL-3400 Series | I _F = 20mA | | 1.6 | 2.0 | V |
| DLO-3900 Series | I _F = 20mA | | 2.2 | 2.8 | V |
| Reverse Current | | | | | |
| DL-3400 Series | V _R = 5V | | 10 | 100 | μA |
| DLO-3900 Series | V _R = 6V | | 10 | 100 | μA |
| Dominant Wavelength | | | | | |
| DL-3400 Series | λ _d | | 640 | | nm |
| DLO-3900 Series | λ _d | | 625 | | nm |
| Rise and Fall Time | | | 10 | | ns |
| Temperature Coefficient of Forward Voltage | I _F = 20mA | | -1.5 | | mV/°C |

DL-4770/DL-4775 RED DLO-4770/DLO-4775 HIGH EFFICIENCY RED 7-SEGMENT 4-DIGIT DISPLAY



FEATURES

- DL & DLO-4770 Common Cathode
DL & DLO-4775 Common Anode
- 0.28 Inch (7 mm) Digit Height
- Rugged Encapsulated Package
- Filled Reflector Construction
- End Stackable Module
- Intensity Coded for Display Uniformity
- Right Hand Decimal
- Color Included for Clock Applications

DESCRIPTION

The DL/DLO-4770/4775 is a 0.28 inch (7 mm) four-digit display in a 0.39 × 1.26 inch (10mm × 32mm) package. The units are end stackable and offer a colon for time-keeping and other operations. The DL/DLO-4770/4775 is designed to serve a wide variety of industrial and consumer applications requiring medium-sized digits in a very small package.

Maximum Ratings @ 25°C

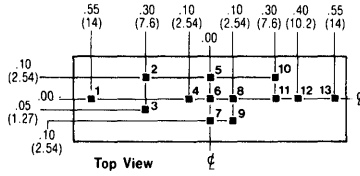
| | |
|-------------------------------|----------------|
| Power Dissipation (package) | 820 mW |
| Derate Linearly from @ 25°C | -13.7 mW/°C |
| Storage Temperature | -20°C to +85°C |
| Operating Temperature | -20°C to +85°C |
| Continuous Forward Current | |
| DL-4770/5 (per segment) | 30 mA |
| DL-4770/5 (all segments lit) | 12 mA/seg |
| DLO-4770/5 (per segment) | 25 mA |
| DLO-4770/5 (all segments lit) | 10 mA/seg |
| Peak Inverse Voltage | |
| DL-4770/5 | 3 V |
| DLO-4770/5 | 3 V |

Opto-Electronic characteristics Per Segment (@ 25°C)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|--|-----|-----|-----|---------------|-----------------------|
| Luminous Intensity/Segment (Digit Average) | | | | | |
| DL | .08 | .18 | | mcd | $I_F = 10 \text{ mA}$ |
| DLO | .25 | .40 | | mcd | $I_F = 10 \text{ mA}$ |
| Forward Voltage | | | | | |
| DL | | | 2.0 | V | $I_F = 20 \text{ mA}$ |
| DLO | | | 2.8 | V | $I_F = 20 \text{ mA}$ |
| Reverse Current | | | | | |
| DL | | | 100 | μA | $V_R = 3 \text{ V}$ |
| DLO | | | 100 | μA | $V_R = 3 \text{ V}$ |
| Peak Emission Wavelength | | | | | |
| DL | | 660 | | nm | |
| DLO | | 630 | | nm | |

Specifications are subject to change without notice.

Pin Location



Top View

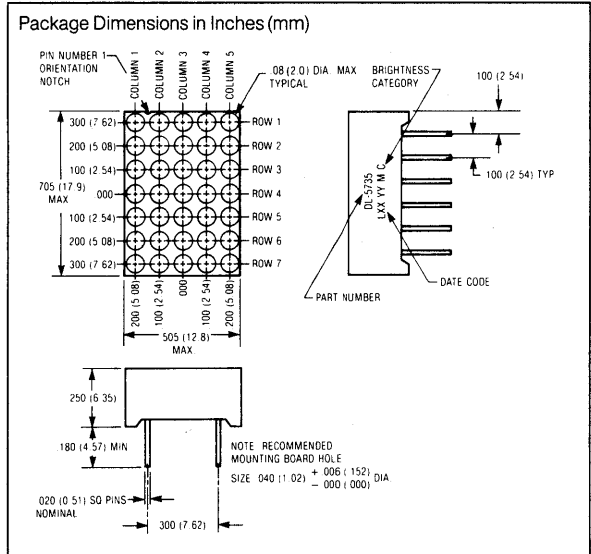
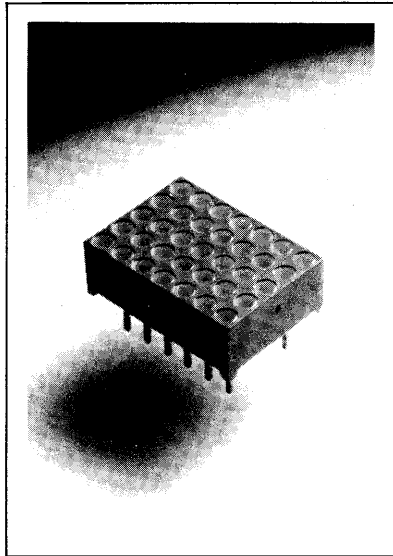
Pin Function

DL & DLO-4775

| PIN | FUNCTION |
|-----|-----------------------------|
| 1 | DIGIT 1 ANODE |
| 2 | SEGMENT B CATHODE |
| 3 | SEGMENT C CATHODE |
| 4 | DIGIT 2 & LOWER COLON ANODE |
| 5 | SEGMENT A CATHODE |
| 6 | SEGMENT D CATHODE |
| 7 | DECIMAL POINT CATHODE |
| 8 | DIGIT 3 & UPPER COLON ANODE |
| 9 | COLON CATHODE |
| 10 | SEGMENT F CATHODE |
| 11 | SEGMENT E CATHODE |
| 12 | SEGMENT G CATHODE |
| 13 | DIGIT 4 ANODE |

DL & DLO-4770

| PIN | FUNCTION |
|-----|-------------------------------|
| 1 | DIGIT 1 CATHODE |
| 2 | SEGMENT B ANODE |
| 3 | SEGMENT C ANODE |
| 4 | DIGIT 2 & LOWER COLON CATHODE |
| 5 | SEGMENT A ANODE |
| 6 | SEGMENT D ANODE |
| 7 | DECIMAL POINT ANODE |
| 8 | DIGIT 3 & UPPER COLON CATHODE |
| 9 | COLON ANODE |
| 10 | SEGMENT F ANODE |
| 11 | SEGMENT E ANODE |
| 12 | SEGMENT G ANODE |
| 13 | DIGIT 4 CATHODE |



FEATURES

- **DL-5735 Common Row Cathode**
DL-5736 Common Row Anode
- **5 × 7 Matrix Array with Row-column Select**
- **End & Side Stackable**
- **Rugged Encapsulation (Filled Reflector Construction)**
- **Compatible with ASCII and EBCDIC Format**
- **Standard 12 pin, 0.3" pin spacing, Dual-In-line-Package**
- **Good "OFF" Segment Contrast**
Grey face with clear segments.

DESCRIPTION

The DLR-573X Series, a gallium arsenide phosphide, and the DLG-573X Series, a gallium phosphide, is a 5x7 dot matrix Light emitting diode alphanumeric display. Compatible with ASCII and EBCDIC formats, the DL573X is well suited for use in keyboard verifiers, computer peripheral equipment, other applications requiring an alphanumeric display, and stackable both horizontally and vertically to generate large alphanumeric or even graphic displays.

Maximum Ratings @ 25°C

| | |
|--|----------------|
| Power Dissipation (Package) | 750 mW |
| Derate Linearly from 25°C | 11.5 mW/°C |
| Storage Temperature | -20°C to +70°C |
| Operating Temperature | -20°C to +70°C |
| Continuous Forward Current | |
| Per Segment | 20 mA |
| Pulse Peak Current/Segment | |
| 20% Duty Cycle | 100 mA |
| Reverse Voltage | 3 V |
| Solder Temperature | |
| 1/16 below seating plane for 5 seconds | 260°C |

Opto-Electronic Characteristics (@ 25°C)

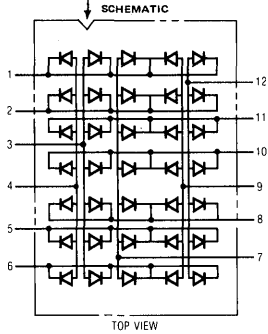
| Parameter | Min | Typ | Max | Unit | Test Condition |
|--------------------------|-----|-----|-----|---------------|-----------------------|
| Luminous Intensity | | | | | |
| Digit Average | | | | | |
| DLR-573X | 100 | 200 | | cd | $I_F = 20 \text{ mA}$ |
| DLG-573X | 320 | 650 | | cd | $I_F = 10 \text{ mA}$ |
| Forward Voltage | | | | | |
| DLR-573X | | 1.7 | 2.0 | V | $I_F = 20 \text{ mA}$ |
| DLG-573X | | 2.3 | 3.0 | μV | $I_F = 20 \text{ mA}$ |
| Reverse Current | | | 100 | μA | $V_R = 3 \text{ V}$ |
| Peak Emission Wavelength | | | | | |
| DLR-573X | | 650 | | nm | |
| DLG-573X | | 565 | | nm | |
| Spectral Line Half-Width | | | | | |
| DLR-573X | 40 | | | nm | |
| DLG-573X | 30 | | | nm | |
| Capacitance | | | | | |
| DLR-573X | | 115 | | pf | $V = 0$ |
| DLG-573X | | | | pf | $V = 0$ |

Specifications subject to change without notice.

PIN CONFIGURATIONS

DL-5735

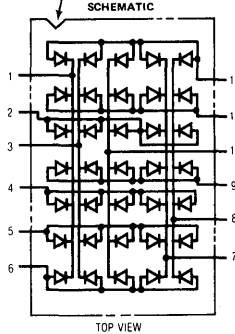
PIN NUMBER 1
ORIENTATION
NOTCH



| PIN | FUNCTION |
|-----|----------------|
| 1 | ROW 1 CATHODE |
| 2 | ROW 2 CATHODE |
| 3 | COLUMN 1 ANODE |
| 4 | COLUMN 2 ANODE |
| 5 | ROW 6 CATHODE |
| 6 | ROW 7 CATHODE |
| 7 | COLUMN 3 ANODE |
| 8 | ROW 5 CATHODE |
| 9 | COLUMN 4 ANODE |
| 10 | ROW 4 CATHODE |
| 11 | ROW 3 CATHODE |
| 12 | COLUMN 5 ANODE |

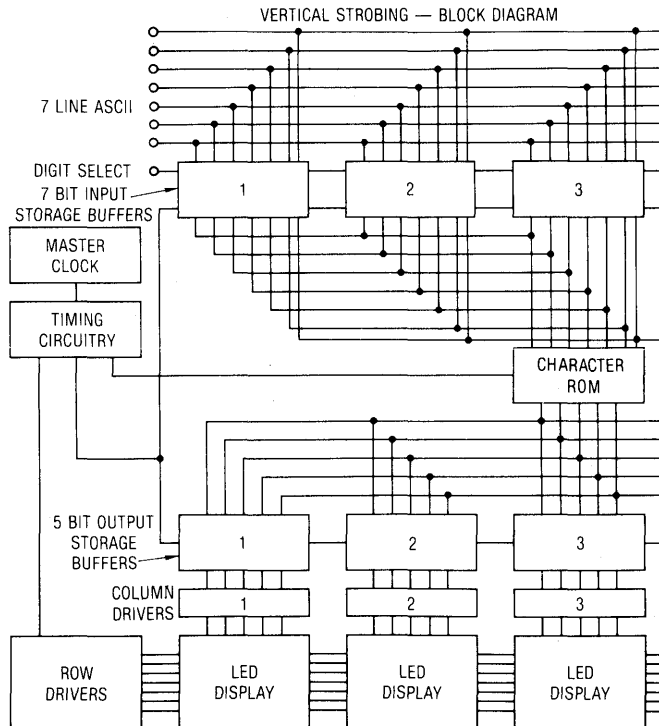
DL-5736

PIN NUMBER 1
ORIENTATION
NOTCH



| PIN | FUNCTION |
|-----|------------------|
| 1 | COLUMN 1 CATHODE |
| 2 | ROW 3 ANODE |
| 3 | COLUMN 2 CATHODE |
| 4 | ROW 5 ANODE |
| 5 | ROW 6 ANODE |
| 6 | ROW 7 ANODE |
| 7 | COLUMN 4 CATHODE |
| 8 | COLUMN 5 CATHODE |
| 9 | ROW 4 ANODE |
| 10 | COLUMN 3 CATHODE |
| 11 | ROW 2 ANODE |
| 12 | ROW 1 ANODE |

TYPICAL VERTICAL SCAN DISPLAY SYSTEM



SIEMENS

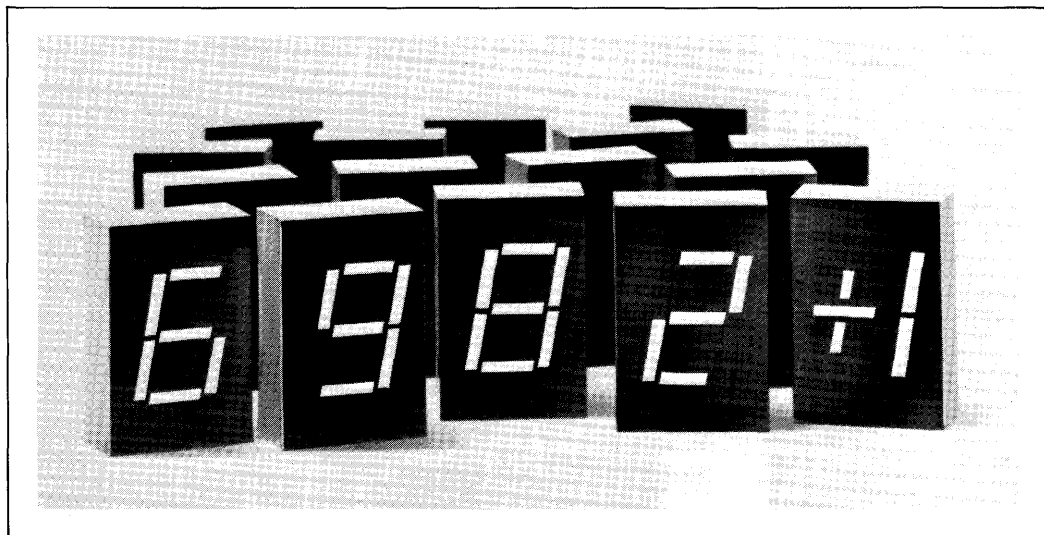
DL-7750R SERIES RED

DL-7660Y SERIES YELLOW

DL-7650O SERIES HIGH EFFICIENCY RED

DL-7670G SERIES GREEN

0.43 INCH SEVEN SEGMENT NUMERIC DISPLAY



FEATURES

- Rugged Encapsulated (Filled Reflector Construction)
- Choice of Colors (Including High Intensity Red) as well as Common Anode (D. P. Left & Right), Common Cathode and Universal Polarity Overflow
- Sharp, Clear .43 Inch Character for Viewing up to 20 Feet
- Intensity Coded for Matching Uniformity
- Standard 14 Pin, .3 Inch Pin Spacing, Dual-In-Line Package

DESCRIPTION

The DL-7750R, -7650O, -7660Y, -7670G series are large 0.43 inch (10.92 mm) Red; Hi-efficiency Red, Yellow, and Green seven segment displays. These displays are

designed for use in instruments, point-of-sale systems, clocks, and other general industrial & consumer applications.

| Part Number | Color | Description |
|-------------|---------------------|---------------------------------|
| DL-7750R | Standard Red | C.A. 7 Segment, D.P. Left |
| DL-7751R | " | C.A. 7 Segment, D.P. Right |
| DL-7756R | " | Univ. ± 1 Polarity Overflow |
| DL-7760R | " | C.C. 7 Segment, D.P. Right |
| DL-7650O | High Efficiency Red | C.A. 7 Segment, D.P. Left |
| DL-7651O | " | C.A. 7 Segment, D.P. Right |
| DL-7653O | " | C.C. 7 Segment, D.P. Right |
| DL-7656O | " | Univ. ± 1 Polarity Overflow |
| DL-7660Y | Yellow | C.A. 7 Segment, D.P. Left |
| DL-7661Y | " | C.A. 7 Segment D.P. Right |
| DL-7663Y | " | C.C. 7 Segment, D.P. Right |
| DL-7666Y | " | Univ. ± 1 Polarity Overflow |
| DL-7670G | Green | C.A. 7 Segment, D.P. Left |
| DL-7671G | " | C.A. 7 Segment, D.P. Right |
| DL-7673G | " | C.C. 7 Segment, D.P. Right |
| DL-7676G | " | Univ. ± 1 Polarity Overflow |

ELECTRICAL/OPTICAL CHARACTERISTICS AT T_A = 25°C

STANDARD RED DL-7750R/7751R/7756R/7760R

| Parameter | Symbol | Test Condition | Min. | Typ. | Max. | Units |
|---------------------------------|---------------------------------|------------------------|------|------|------|-------|
| Luminous Intensity/Segment | I _V | I _f = 10 mA | 120 | 350 | | μcd |
| | I _V | I _f = 25 mA | | 1000 | | μcd |
| Peak Wavelength | λ _{peak} | | | 665 | | nm |
| Dominant Wavelength | λ _d | | | 645 | | nm |
| Forward Voltage/Segment or D.P. | V _f | I _f = 10 mA | | 1.6 | 2.0 | V |
| Reverse Current/Segment or D.P. | I _R | V _R = 6V | | 0.01 | 10 | μA |
| Rise and Fall Time | t _r , t _f | | | 5 | | ns |

HIGH EFFICIENCY RED DL-7650O/7651O/7653O/7656O

| Parameter | Symbol | Test Condition | Min. | Typ. | Max. | Units |
|---------------------------------|---------------------------------|------------------------|------|------|------|-------|
| Luminous Intensity/Segment | I _V | I _f = 5 mA | 90 | 260 | | μcd |
| | | I _f = 15 mA | | 1000 | | μcd |
| Peak Wavelength | λ _{peak} | | | 645 | | nm |
| Dominant Wavelength | λ _d | | | 638 | | nm |
| Forward Voltage/Segment or D.P. | V _f | I _f = 5 mA | | 1.9 | 2.4 | V |
| Reverse Current/Segment or D.P. | I _R | V _R = 6V | | 0.01 | 10 | μA |
| Rise and Fall Time | t _r , t _f | | | 100 | | ns |

YELLOW DL-7660Y/7661Y/7663Y/7666Y

| Parameter | Symbol | Test Condition | Min. | Typ. | Max. | Units |
|---------------------------------|---------------------------------|------------------------|------|------|------|-------|
| Luminous Intensity/Segment | I _V | I _f = 5 mA | 90 | 200 | | μcd |
| | | I _f = 15 mA | | 900 | | μcd |
| Peak Wavelength | λ _{peak} | | | 590 | | nm |
| Dominant Wavelength | λ _d | | | 592 | | nm |
| Forward Voltage/Segment or D.P. | V _f | I _f = 5 mA | | 1.9 | 2.4 | V |
| Reverse Current/Segment or D.P. | I _R | V _R = 6V | | 0.01 | 10 | μA |
| Rise and Fall Time | t _r , t _f | | | 100 | | ns |

GREEN DL-7670G/7671G/7673G/7676G

| Parameter | Symbol | Test Condition | Min. | Typ. | Max. | Units |
|---------------------------------|---------------------------------|-----------------------------|------|------|------|-------|
| Luminous Intensity/Segment | I _V | I _f = 5 mA D.C. | 120 | 260 | | μcd |
| | | I _f = 15 mA D.C. | | 1000 | | μcd |
| Peak Wavelength | λ _{peak} | | | 560 | | nm |
| Dominant Wavelength | λ _d | | | 561 | | nm |
| Forward Voltage/Segment or D.P. | V _f | I _f = 5 mA | | 1.9 | 2.4 | V |
| Reverse Current/Segment or D.P. | I _R | V _R = 6V | | 0.01 | 10 | μA |
| Rise and Fall Time | t _r , t _f | | | 50 | | ns |

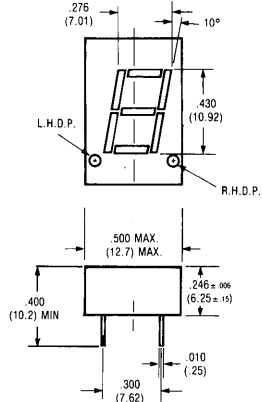
Maximum Ratings

Power Dissipation per Segment or D.P. @ 25°C
 Storage Temperature
 Operating Temperature
 Peak Forward Current per Segment or D.P.
 ($t \leq 10\mu\text{sec}$)
 Continuous Forward Current per Segment or D.P.
 Peak Inverse Voltage per Segment or D.P.
 Lead Soldering Temperature

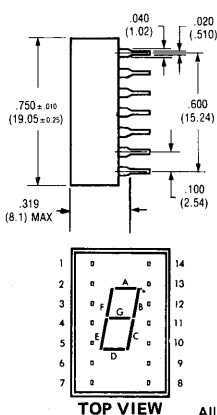
| Standard Red | All Others |
|--------------|----------------------|
| 50 mW | |
| -40 to +85°C | |
| -35 to +85°C | |
| 400 mA | 150 mA |
| 25 mA | 17.5 mA |
| | 6.0 V |
| | 230 °C for 3 seconds |

Package Dimensions in Inches (mm)

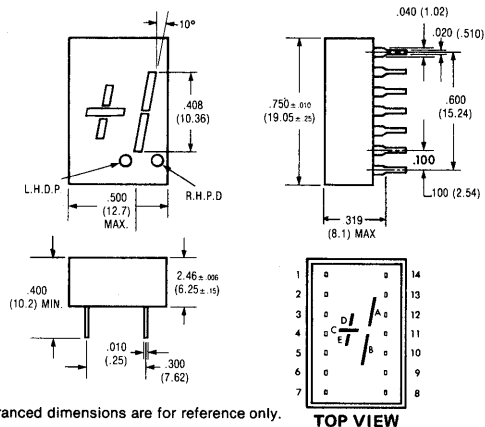
DL-7750/7751/7760R
DLO=7650/7651/7653O



DLG-7670/7671/7673G
DLY-7660/7661/7663Y



DL-7756R/DL-7676G/DL-7656O/DL-7666Y



DL-7650O/DL-7660Y
DL-7670G/DL-7750R

| Pin | Function |
|-----|---------------|
| 1 | Cathode -a |
| 2 | Cathode -f |
| 3 | Anode |
| 4 | No Pin |
| 5 | No Pin |
| 6 | Cathode -d.p. |
| 7 | Cathode -e |
| 8 | Cathode -d |
| 9 | No Conn. |
| 10 | Cathode -c |
| 11 | Cathode -g |
| 12 | No Pin |
| 13 | Cathode -b |
| 14 | Anode |

DL-7651O/DL-7661Y
DL-7671G/DL-7751R

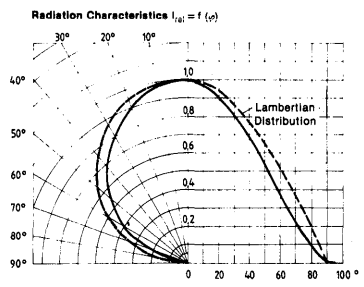
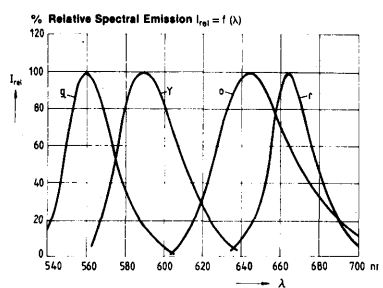
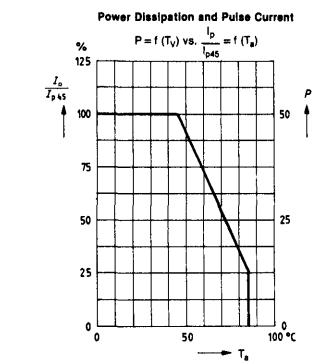
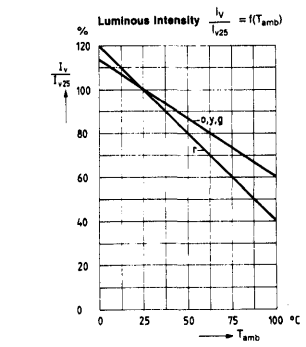
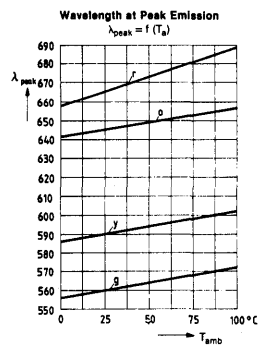
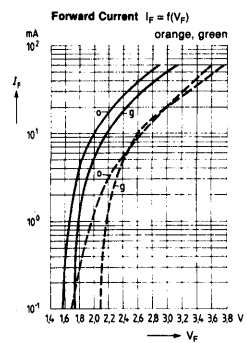
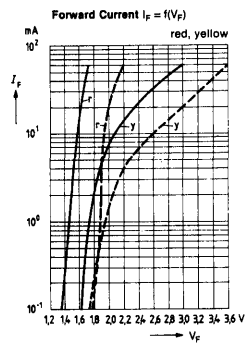
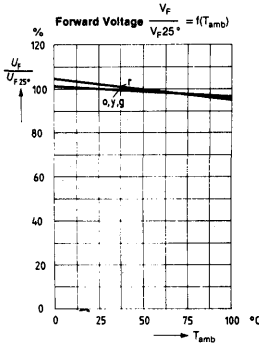
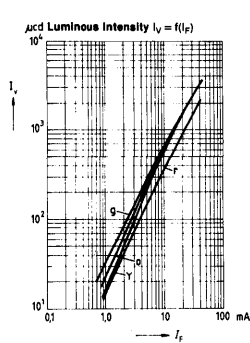
| Pin | Function |
|-----|---------------|
| 1 | Cathode -a |
| 2 | Cathode -f |
| 3 | Anode |
| 4 | No Pin |
| 5 | No Pin |
| 6 | No Conn. |
| 7 | Cathode -e |
| 8 | Cathode -d |
| 9 | Cathode -d.p. |
| 10 | Cathode -c |
| 11 | Cathode -g |
| 12 | No Pin |
| 13 | Cathode -b |
| 14 | Anode |

DL-7653O/DL-7663Y
DL-7673G/DL-7760R

| Pin | Function |
|-----|-------------|
| 1 | Anode -a |
| 2 | Anode -f |
| 3 | Cathode |
| 4 | No Pin |
| 5 | No Pin |
| 6 | No Conn. |
| 7 | Anode -e |
| 8 | Anode -d |
| 9 | Anode -d.p. |
| 10 | Anode -c |
| 11 | Anode -g |
| 12 | No Pin |
| 13 | Anode -b |
| 14 | Cathode |

DL-7756R/DL-7676G/DL-7656O/DL-7666Y

| Pin | Function | Pin | Function |
|-----|------------|-----|---------------|
| 1 | Cathode -d | 8 | Anode -d.p. |
| 2 | Anode -d | 9 | Cathode -d.p. |
| 3 | No Pin | 10 | Cathode -b |
| 4 | Cathode -c | 11 | Cathode -a |
| 5 | Cathode -e | 12 | No Pin |
| 6 | Anode -e | 13 | Anode -a |
| 7 | Anode -c | 14 | Anode -b |



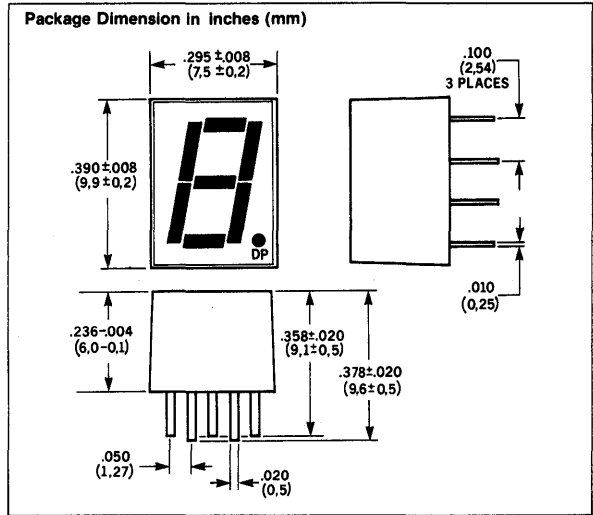
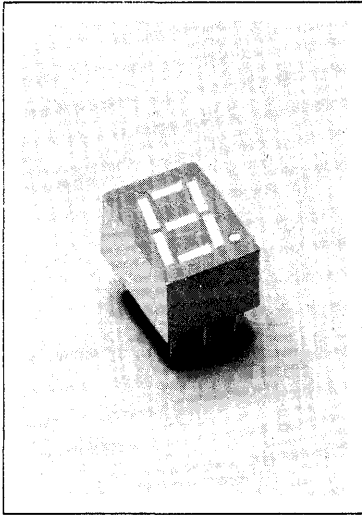
HD 1075 R, HD 1077 R
RED

HD 1075 O, HD 1077 O
HIGH EFFICIENCY RED

HD 1075 Y, HD 1077 Y
YELLOW

HG 1075 G, HG 1077 G
GREEN

0.28 INCH (7 mm) SEVEN SEGMENT NUMERIC DISPLAY



FEATURES

- Rugged Encapsulated Package
- 0.28 Inch (7 mm) Digit Height
- Choice of Colors
- Common Anode or Common Cathode
- Wide Viewing
- Intensity Coded for Display Uniformity

DESCRIPTION

The 0.28 inch (7 mm) Digit Height Series of HD & HG 1075/1077 Seven Segment Displays offers the choice of common anode or common cathode with right hand decimal point.

These displays have good viewing and can be used in electronic instruments, point-of-sale systems, clocks, and other general industrial and consumer applications. All displays have a light grey face.

Contrast enhancement filters are recommended for use with all displays.

Specifications are subject to change without notice.

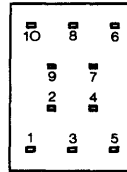
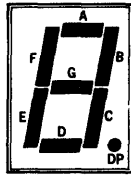
| Product | Color | Description |
|----------|---------------------|------------------------------|
| HD1075 R | Red | Common Anode Right Decimal |
| HD1077 R | Red | Common Cathode Right Decimal |
| HD1075 O | High Efficiency Red | Common Anode Right Decimal |
| HD1077 O | High Efficiency Red | Common Cathode Right Decimal |
| HD1075 Y | Yellow | Common Anode Right Decimal |
| HD1077 Y | Yellow | Common Cathode Right Decimal |
| HG1075 G | Green | Common Anode Right Decimal |
| HG1077 G | Green | Common Cathode Right Decimal |

MAXIMUM RATINGS

| | |
|--|---------------|
| Power Dissipation (Per Segment) | 40 mW |
| Operating Temperature | -35° to +85°C |
| Storage Temperature | -40° to +85°C |
| D.C. Forward Current per segment | |
| HD1075 R, HD1077 R | 20 mA |
| HD1075 O, HD1077 O, HG1075 G, HG1077 G, HD1075 Y, HD1077 Y | 15 mA |
| Peak Forward Current ($t \leq 10 \mu\text{s}$) | |
| HD1075 R, HD1077 R | 400 mA |
| HD1075 O, HD1077 O, HG1075 G, HG1077 G, HD1075 Y, HD1077 Y | 150 mA |
| Reverse Voltage | 6 V |
| Thermal Resistance (Junction to Air) | 170 K/W |
| Soldering Temperature (Less than 5 sec @ min distance of 2 mm) | 230°C |

Optoelectronic Characteristics @ 25°C

| Parameter | Min | Typ | Max | Units | Conditions |
|--|-----|------|-----|----------------|-------------------------------------|
| Luminous Intensity (Per Segment) | | | | | |
| HD1075 R, HD1077 R | 120 | 350 | | μcd | $I_F = 10 \text{ mA}$ |
| | | 800 | | μcd | $I_F = 20 \text{ mA}$ |
| HD1075 O, HD1077 O | 90 | 260 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1000 | | μcd | $I_F = 15 \text{ mA}$ |
| HD1075 Y, HD1077 Y | 90 | 200 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 900 | | μcd | $I_F = 15 \text{ mA}$ |
| HG1075 G, HG1077 G | 120 | 260 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1000 | | μcd | $I_F = 15 \text{ mA}$ |
| Forward Voltage | | | | | |
| HD1075 R, HD1077 R | | 1.6 | 2.0 | V | $I_F = 10 \text{ mA}$ |
| HD1075 O, HD1077 O, HG1075 G, HG1077 G | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| HD1075 Y, HD1077 Y | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| Reverse Current | | | | | |
| | | 0.01 | 10 | μA | $V_R = 6\text{V}$ |
| Peak Emission Wavelength | | | | | |
| HD1075 R, HD1077 R | | 665 | | nm | |
| HD1075 O, HD1077 O | | 645 | | nm | |
| HG1075 G, HG1077 G | | 560 | | nm | |
| HD1075 Y, HD1077 Y | | 590 | | nm | |
| Rise Time/Fall Time | | | | | |
| HD1075 R, HD1077 R | | 5 | | ns | |
| HD1075 O, HD1077 O, HD1075 Y, HD1077 Y | | 100 | | ns | |
| HG1075 G, HG1077 G | | 50 | | ns | |
| Capacitance | | | | | |
| HD1075 R, HD1077 R | | 40 | | pf | $V_R = 0\text{V}$ $f = 1\text{MHz}$ |
| HD1075 O, HD1077 O | | 12 | | pf | $V_R = 0\text{V}$ $f = 1\text{MHz}$ |
| HG1075 G, HG1077 G | | 45 | | pf | $V_R = 0\text{V}$ $f = 1\text{MHz}$ |
| HD1075 Y, HD1077 Y | | 10 | | pf | $V_R = 0\text{V}$ $f = 1\text{MHz}$ |



TOP VIEW

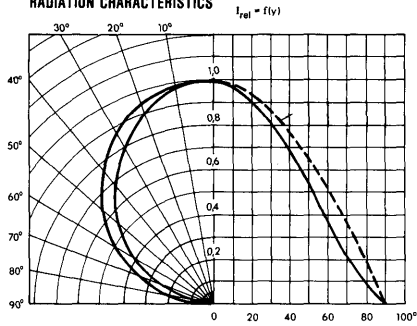
HD & HG 1075

| PIN | FUNCTION |
|-----|-----------------------|
| 1 | CATHODE SEGMENT E |
| 2 | CATHODE SEGMENT D |
| 3 | COMMON ANODE |
| 4 | CATHODE SEGMENT C |
| 5 | CATHODE DECIMAL POINT |
| 6 | CATHODE SEGMENT B |
| 7 | CATHODE SEGMENT A |
| 8 | COMMON ANODE |
| 9 | CATHODE SEGMENT G |
| 10 | CATHODE SEGMENT F |

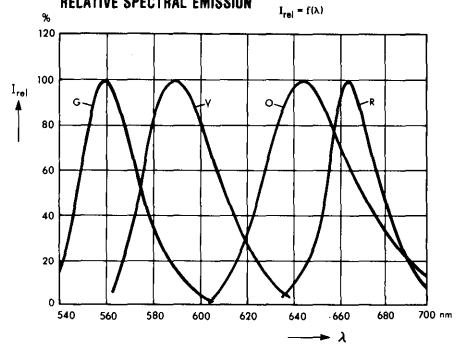
HD & HG 1077

| PIN | FUNCTION |
|-----|---------------------|
| 1 | ANODE SEGMENT E |
| 2 | ANODE SEGMENT D |
| 3 | COMMON CATHODE |
| 4 | ANODE SEGMENT C |
| 5 | ANODE DECIMAL POINT |
| 6 | ANODE SEGMENT B |
| 7 | ANODE SEGMENT A |
| 8 | COMMON CATHODE |
| 9 | ANODE SEGMENT G |
| 10 | ANODE SEGMENT F |

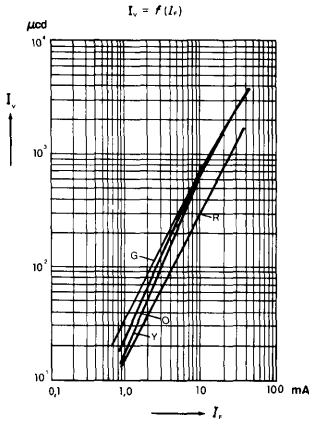
RADIATION CHARACTERISTICS



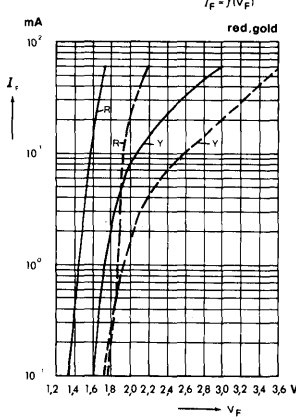
RELATIVE SPECTRAL EMISSION



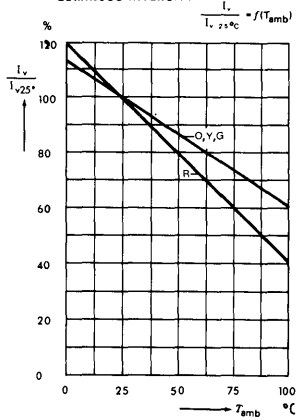
LUMINOUS INTENSITY



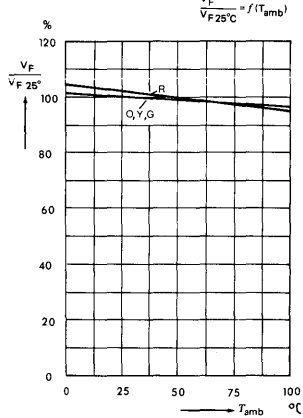
FORWARD VOLTAGE



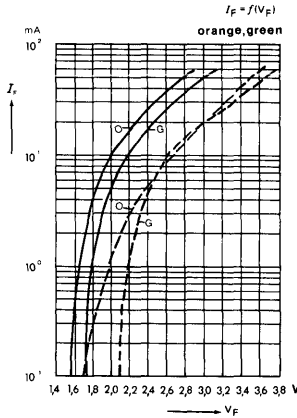
LUMINOUS INTENSITY



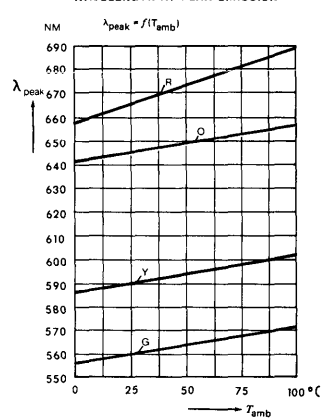
FORWARD VOLTAGE



FORWARD VOLTAGE

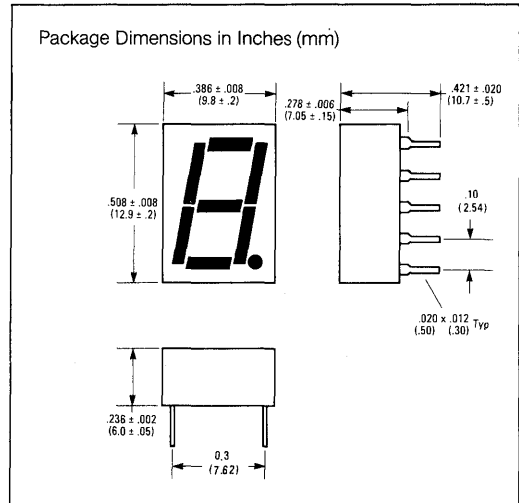
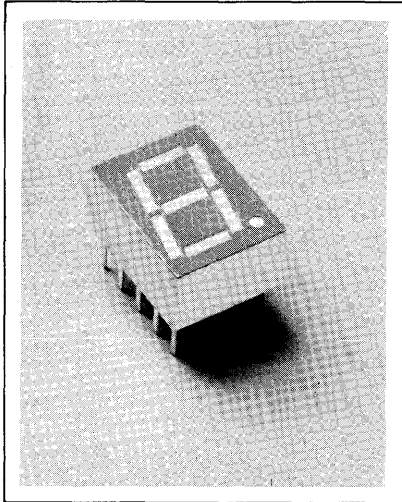


WAVELENGTH AT PEAK EMISSION



HD 1105 R, HD 1107 R
 RED
HD 1105 O, HD 1107 O
 HIGH EFFICIENCY RED
HD 1105 Y, HD 1107 Y
 YELLOW
HG 1105 G, HG 1107 G
 GREEN

0.39 INCH (10 mm) SEVEN SEGMENT NUMERIC DISPLAY



FEATURES

- Rugged Encapsulated Package
- Large 0.39 Inch (10 mm) Digit Height
- Choice of Colors
- Common Anode or Common Cathode
- Wide Viewing
- Intensity Coded for Display Uniformity
- ±1 Polarity Overflow

DESCRIPTION

The 0.39 inch (10 mm) Digit Height Series of HD & HG 1105/1107 Seven Segment Displays offers the choice of common anode or common cathode with right hand decimal point.

These displays were designed for viewing distances of up to 10 feet and can be used in electronic instruments, point-of-sale systems, clocks, and other general industrial and consumer applications. All displays have a light grey face.

Contrast enhancement filtered are recommended for use with all displays.

Specifications are subject to change without notice.

MAXIMUM RATINGS

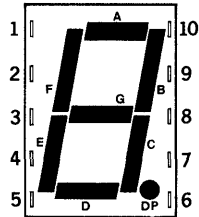
| | |
|---|--|
| Power Dissipation Per Segment ($T_{amb} = 45^{\circ}\text{C}$) | 50 mW |
| Operating Temperature | -35° to $+85^{\circ}\text{C}$ |
| Storage Temperature | -40° to $+85^{\circ}\text{C}$ |
| D.C. Forward Current Per Segment ($T_{amb} = 45^{\circ}\text{C}$) | |
| HD1105R, HD1107R | 25 mA |
| HD1105O, HD1107O | 17.5 mA |
| HG1105G, HG1107G | 17.5 mA |
| HD1105Y, HD1107Y | 17.5 mA |
| Peak Forward Current ($t \leq 10 \mu\text{s}$, $T_{amb} = 45^{\circ}\text{C}$) | |
| HD1105R, HD1107R | 400 mA |
| HD1105O, HD1107O | 150 mA |
| HG1105G, HG1107G | 150 mA |
| HD1105y, HD1107Y | 150 mA |
| Reverse Voltage | 6 V |
| Thermal Resistance (Junction to Air) | |
| HD & HG 1105/1107 series | 135 K/W |
| Soldering Temperature (Less than 5 sec @ min distance of 2 mm) | 230°C |

| Optoelectronic Characteristics @ 25°C | | | | | |
|---|-----|------|-----|----------------|---|
| Parameter | Min | Typ | Max | Units | Conditions |
| Luminous Intensity (Per Segment) | | | | | |
| HD1105R, HD1107R | 120 | 350 | | μcd | $I_F = 10 \text{ mA}$ |
| | | 1000 | | μcd | $I_F = 25 \text{ mA}$ |
| HD1105O, HD1107O | 90 | 260 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1000 | | μcd | $I_F = 15 \text{ mA}$ |
| HD1105G, HD1107G | 120 | 260 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1000 | | μcd | $I_F = 15 \text{ mA}$ |
| HD1105Y, HD1107Y | 90 | 200 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 900 | | μcd | $I_F = 15 \text{ mA}$ |
| Forward Voltage | | | | | |
| HD1105R, HD1107R | | 1.6 | 2.0 | V | $I_F = 10 \text{ mA}$ |
| HD1105O, HD1107O | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| HG1105G, HG1107G | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| HD1105Y, HD1107Y | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| Reverse Current | | | | | |
| | | 0.01 | 10 | μA | $V_R = 6 \text{ V}$ |
| Peak Emission Wavelength | | | | | |
| HD1105R, HD1107R | | 665 | | nm | |
| HD1105O, HD1107O | | 645 | | nm | |
| HG1105G, HG1107G | | 560 | | nm | |
| HD1105Y, HD1107Y | | 590 | | nm | |
| Rise Time/Fall Time | | | | | |
| HD1105R, HD1107R | | 5 | | ns | |
| HD1105O, HD1107O | | 100 | | ns | |
| HG1105G, HG1107G | | 50 | | ns | |
| HD1105Y, HD1107Y | | 100 | | ns | |
| Capacitance | | | | | |
| HD1105R, HD1107R | | 40 | | pf | $V_R = 0 \text{ V}$ $f = 1 \text{ MHz}$ |
| HD1105O, HD1107O | | 12 | | pf | $V_R = 0 \text{ V}$ $f = 1 \text{ MHz}$ |
| HG1105G, HG1107G | | 45 | | pf | $V_R = 0 \text{ V}$ $f = 1 \text{ MHz}$ |
| HD1105Y, HD1107Y | | 10 | | pf | $V_R = 0 \text{ V}$ $f = 1 \text{ MHz}$ |

Specifications subject to change without notice.

| Product | Color | Description |
|---------|---------------------|------------------------------|
| HD1105R | Red | Common Anode Right Decimal |
| HD1107R | Red | Common Cathode Right Decimal |
| HD1105O | High Efficiency Red | Common Anode Right Decimal |
| HD1107O | High Efficiency Red | Common Cathode Right Decimal |
| HG1105G | Green | Common Anode Right Decimal |
| HG1107G | Green | Common Cathode Right Decimal |
| HD1105Y | Yellow | Common Anode Right Decimal |
| HD1107Y | Yellow | Common Cathode Right Decimal |

HD & HG 1105/1107



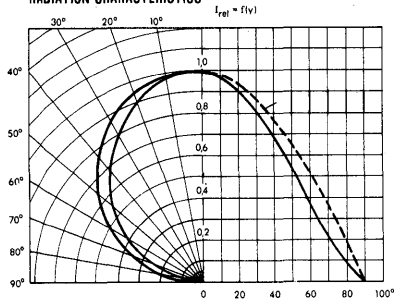
Top View

- | | |
|-----------|----------------|
| | 1 Cathode G |
| | 2 Cathode F |
| | 3 Common Anode |
| HD 1105 R | 4 Cathode E |
| HD 1105 O | 5 Cathode D |
| HG 1105 G | 6 Cathode DP |
| HD 1105 Y | 7 Cathode C |
| | 8 Common Anode |
| | 9 Cathode B |
| | 10 Cathode A |

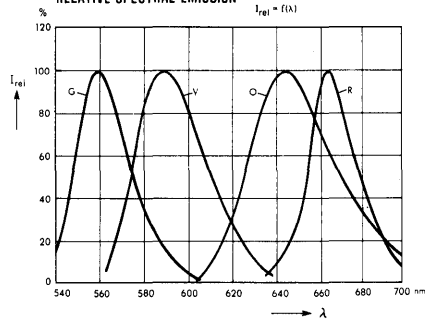
- | | |
|-----------|------------------|
| | 1 Anode G |
| | 2 Anode F |
| | 3 Common Cathode |
| HD 1107 R | 4 Anode E |
| HD 1107 O | 5 Anode D |
| HG 1107 G | 6 Anode DP |
| HD 1107 Y | 7 Anode C |
| | 8 Common Cathode |
| | 9 Anode B |
| | 10 Anode A |

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES

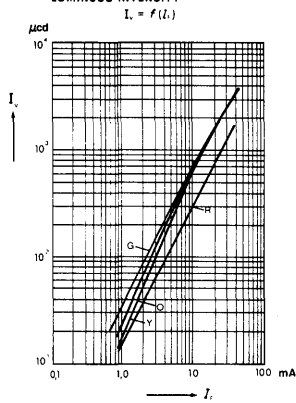
RADIATION CHARACTERISTICS



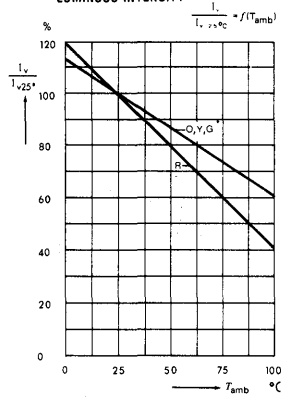
RELATIVE SPECTRAL EMISSION



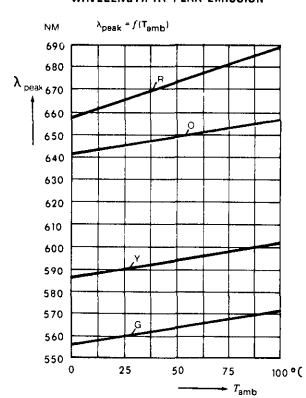
LUMINOUS INTENSITY



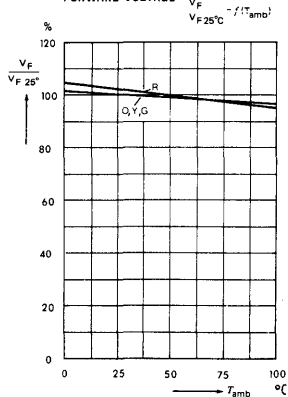
LUMINOUS INTENSITY



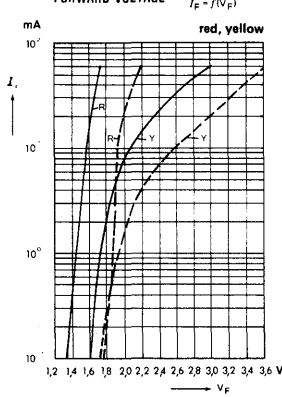
WAVELENGTH AT PEAK EMISSION



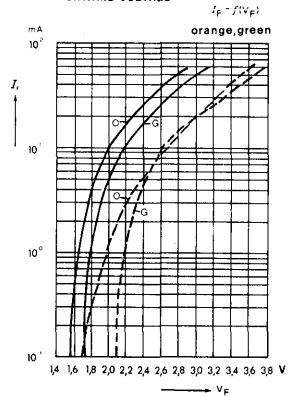
FORWARD VOLTAGE



FORWARD VOLTAGE



FORWARD VOLTAGE



SIEMENS

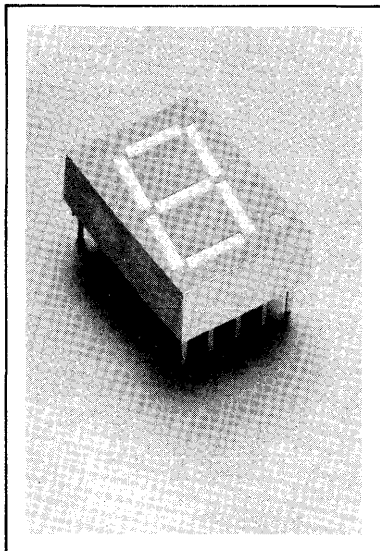
HD 1131 R, HD 1132 R, HD 1133 R, HD 1134 R
RED

HD 1131 O, HD 1132 O, HD 1133 O, HD 1134 O
HIGH EFFICIENCY RED

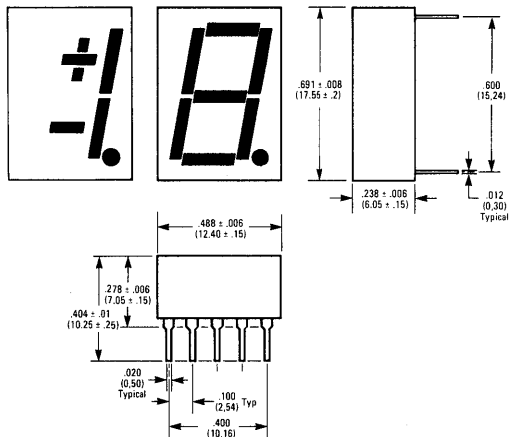
HD 1131 Y, HD 1132 Y, HD 1133 Y, HD 1134 Y
YELLOW

HG 1131 G, HG 1132 G, HG 1133 G, HG 1134 G
GREEN

0.53 (13.5 mm) SEVEN SEGMENT NUMERIC DISPLAY



Package Dimensions in Inches (mm)



FEATURES

- Rugged Encapsulated Package
- Large 0.53 Inch (13.5 mm) Digit Height
- Choice of Colors
- Common Anode or Common Cathode
- Wide Viewing
- Intensity Coded for Display Uniformity
- ±1 Polarity Overflow
- Pin for Pin Compatibility with DL500/DL507, FND500/FND507, MAN6680/MAN6660, TIL322/TIL321

DESCRIPTION

The 0.53 inch (13.5 mm) Digit Height Series of HD & HG1131/1133 Seven Segment Displays offer the choice of common anode or common cathode versions with right hand decimal point.

The HD & HG1132/1134 overflow displays also offer the choice of common anode or common cathode versions with right hand decimal point.

These displays were designed for viewing distances of up to 20 feet and can be used in electronic instruments, point-of-sale systems, clocks, and other general industrial and consumer applications. All displays have a light grey face.

Contrast enhancement filters are recommended for use with all displays.

Specifications subject to change without notice.

MAXIMUM RATINGS

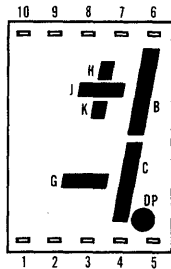
| | |
|---|--|
| Power Dissipation Per Segment ($T_{amb} = 45^{\circ}\text{C}$) | 60 mW |
| Operating Temperature | -35° to $+85^{\circ}\text{C}$ |
| Storage Temperature | -40° to $+85^{\circ}\text{C}$ |
| D.C. Forward Current Per Segment ($T_{amb} = 45^{\circ}\text{C}$) | |
| HD1131R, HD1132R, HD1133R, HD1134R | 35 mA |
| HD1131O, HD1132O, HD1133O, HD1134O | 20 mA |
| HG1131G, HG1132G, HG1133G, HG1134G | 20 mA |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | 20 mA |
| Peak Forward Current ($t \leq 10 \mu\text{s}$, $T_{amb} = 45^{\circ}\text{C}$) | |
| HD1131R, HD1132R, HD1133R, HD1134R | 400 mA |
| HD1131O, HD1132O, HD1133O, HD1134O | 150 mA |
| HG1131G, HG1132G, HG1133G, HG1134G | 150 mA |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | 150 mA |
| Reverse Voltage | 6 V |
| Thermal Resistance (Junction to Air) | |
| HD & HG 1131/1133 series | 115 K/W |
| HD & HG 1132/1134 series | 155 K/W |
| Soldering Temperature (Less than 5 sec @ min distance of 2 mm) | 230°C |

Optoelectronic Characteristics @ 25°C

| Parameter | Min | Typ | Max | Units | Conditions |
|------------------------------------|-----|------|-----|----------------|---|
| Luminous Intensity (Per Segment) | | | | | |
| HD1131R, HD1132R, HD1133R, HD1134R | 120 | 300 | | μcd | $I_F = 10 \text{ mA}$ |
| | | 1400 | | μcd | $I_F = 35 \text{ mA}$ |
| HD1131O, HD1132O, HD1133O, HD1134O | 90 | 260 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1400 | | μcd | $I_F = 20 \text{ mA}$ |
| HG1131G, HG1132G, HG1133G, HG1134G | 120 | 260 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1400 | | μcd | $I_F = 20 \text{ mA}$ |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | 90 | 200 | | μcd | $I_F = 5 \text{ mA}$ |
| | | 1300 | | μcd | $I_F = 20 \text{ mA}$ |
| Forward Voltage | | | | | |
| HD1131R, HD1132R, HD1133R, HD1134R | | 1.6 | 2.0 | V | $I_F = 10 \text{ mA}$ |
| HD1131O, HD1132O, HD1133O, HD1134O | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| HG1131G, HG1132G, HG1133G, HG1134G | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | | 1.9 | 2.4 | V | $I_F = 5 \text{ mA}$ |
| Reverse Current | | 0.01 | 10 | μA | $V_R = 6 \text{ V}$ |
| Peak Emission Wavelength | | | | | |
| HD1131R, HD1132R, HD1133R, HD1134R | | 665 | | nm | |
| HD1131O, HD1132O, HD1133O, HD1134O | | 645 | | nm | |
| HG1131G, HG1132G, HG1133G, HG1134G | | 560 | | nm | |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | | 590 | | nm | |
| Rise Time/Fall Time | | | | | |
| HD1131R, HD1132R, HD1133R, HD1134R | | 5 | | ns | |
| HD1131O, HD1132O, HD1133O, HD1134O | | 100 | | ns | |
| HG1131G, HG1132G, HG1133G, HG1134G | | 50 | | ns | |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | | 100 | | ns | |
| Capacitance | | | | | |
| HD1131R, HD1132R, HD1133R, HD1134R | | 40 | | pf | $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$ |
| HD1131O, HD1132O, HD1133O, HD1134O | | 12 | | pf | $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$ |
| HG1131G, HG1132G, HG1133G, HG1134G | | 45 | | pf | $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$ |
| HD1131Y, HD1132Y, HD1133Y, HD1134Y | | 10 | | pf | $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$ |

| Product | Color | Description |
|---------|---------------------|--------------------------------------|
| HD1131R | Red | Common Anode Right Decimal |
| HD1132R | Red | Common Anode ± 1 Right Decimal |
| HD1133R | Red | Common Cathode Right Decimal |
| HD1134R | Red | Common Cathode ± 1 Right Decimal |
| HD1131O | High Efficiency Red | Common Anode Right Decimal |
| HD1132O | High Efficiency Red | Common Anode ± 1 Right Decimal |
| HD1133O | High Efficiency Red | Common Cathode Right Decimal |
| HD1134O | High Efficiency Red | Common Cathode ± 1 Right Decimal |
| HG1131G | Green | Common Anode Right Decimal |
| HG1132G | Green | Common Anode ± 1 Right Decimal |
| HG1133G | Green | Common Cathode Right Decimal |
| HG1134G | Green | Common Cathode ± 1 Right Decimal |
| HD1131Y | Yellow | Common Anode Right Decimal |
| HD1132Y | Yellow | Common Anode ± 1 Right Decimal |
| HD1133Y | Yellow | Common Cathode Right Decimal |
| HD1134Y | Yellow | Common Cathode ± 1 Right Decimal |

HD & HG 1132/1134



TOP VIEW

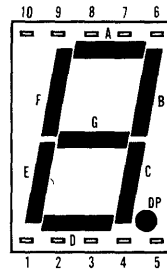
HD1132R
HD1132O
HG1132 G
HD1132Y

- 1 Cathode G
- 2 No Connection
- 3 Common Anode
- 4 Cathode C
- 5 Cathode DP
- 6 Cathode B
- 7 No Connection
- 8 Common Anode
- 9 Cathode HJK
- 10 No Connection

HD1134R
HD1134O
HG1134 G
HD1134Y

- 1 Anode G
- 2 No Connection
- 3 Common Cathode
- 4 Anode C
- 5 Anode DP
- 6 Anode B
- 7 No Connection
- 8 Common Cathode
- 9 Anode HJK
- 10 No Connection

HD&HG 1131/1133



TOP VIEW

HD1131 R
HD1131 O
HG1131G
HD1131 Y

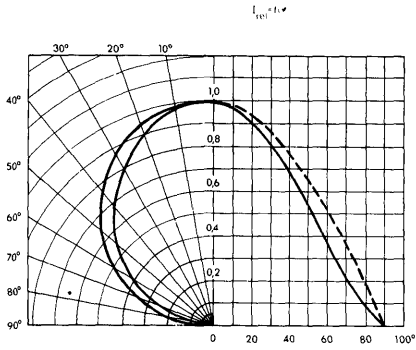
- 1 Cathode E
- 2 Cathode D
- 3 Common Anode
- 4 Cathode C
- 5 Cathode DP
- 6 Cathode B
- 7 Cathode A
- 8 Common Anode
- 9 Cathode F
- 10 Cathode G

HD1133 R
HD1133 O
HG1133 G
HD1133 Y

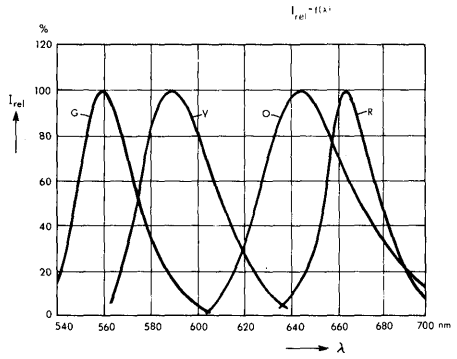
- 1 Anode E
- 2 Anode D
- 3 Common Cathode
- 4 Anode C
- 5 Anode DP
- 6 Anode B
- 7 Anode A
- 8 Common Cathode
- 9 Anode F
- 10 Anode G

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES

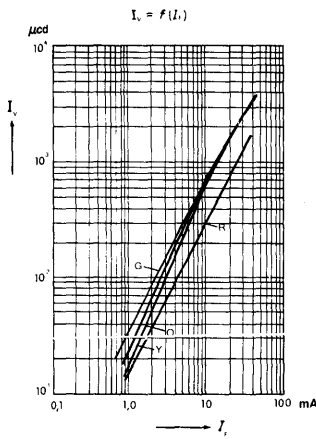
RADIATION CHARACTERISTICS



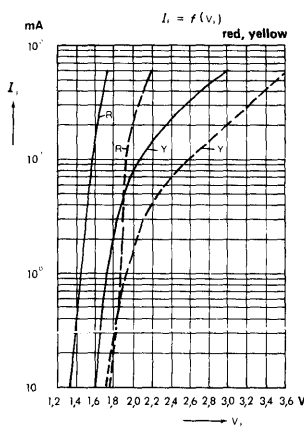
RELATIVE SPECTRAL EMISSION



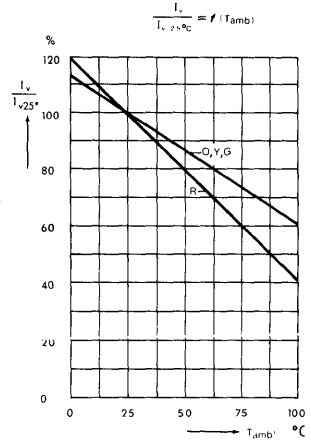
LUMINOUS INTENSITY



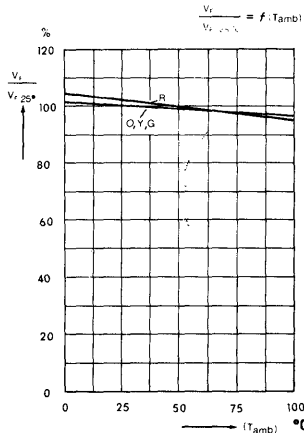
FORWARD VOLTAGE



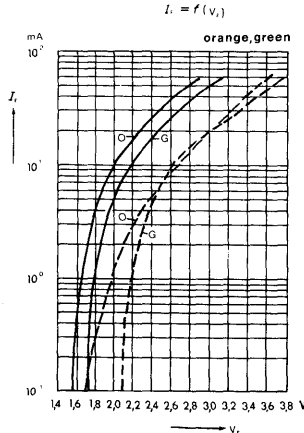
LUMINOUS INTENSITY



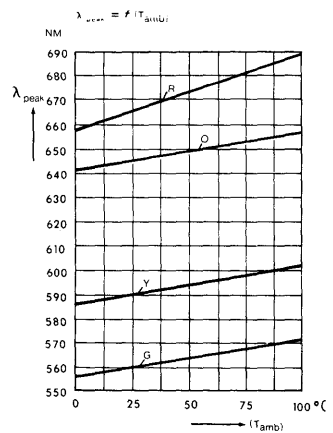
FORWARD VOLTAGE

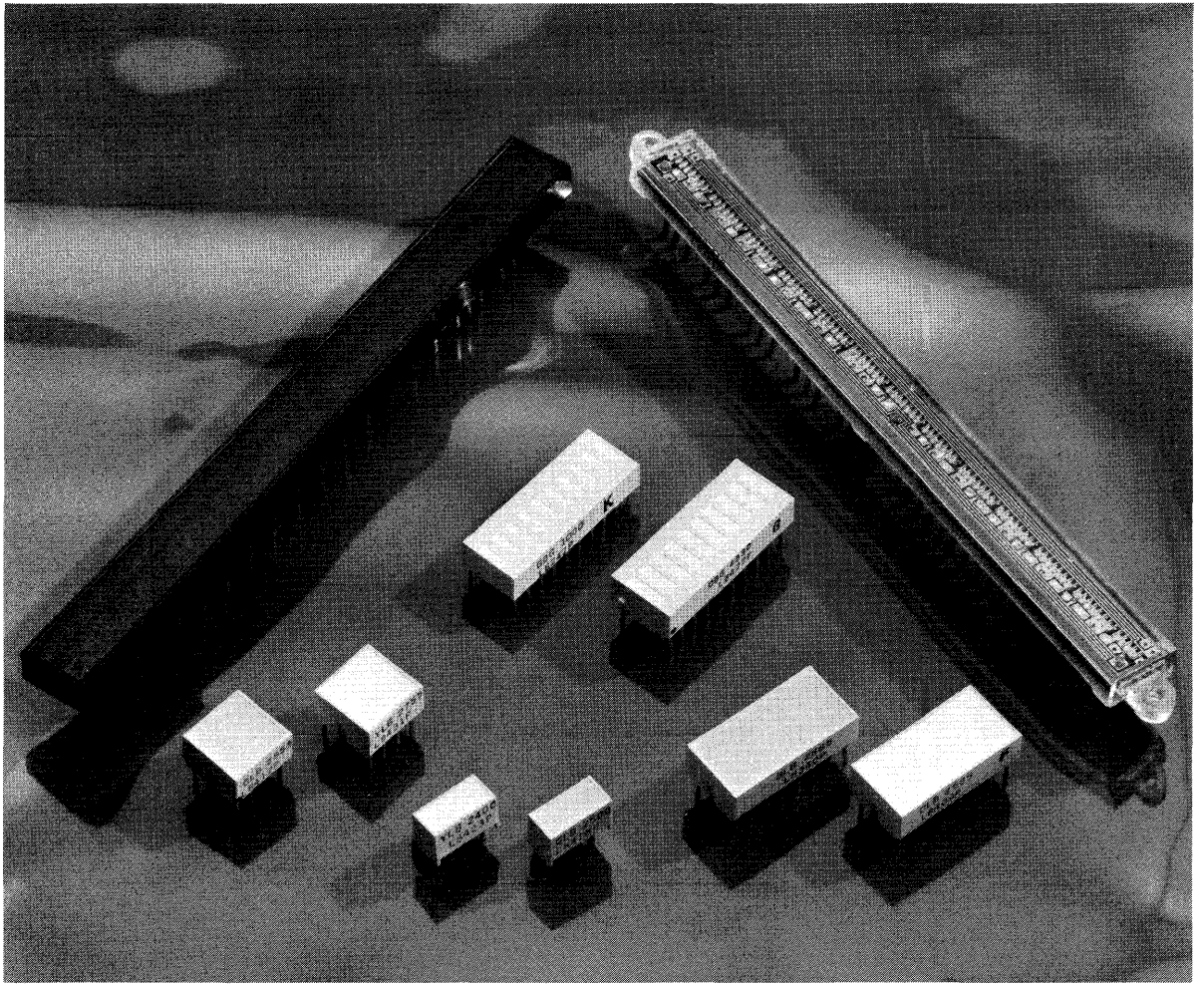


FORWARD VOLTAGE

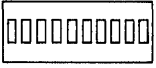
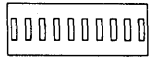


WAVELENGTH AT PEAK EMISSION




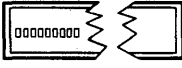


Bar Graphs



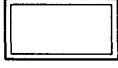
| Package Type | Package Outline | Part Number | Light Emitting Area | Description | Polarity | Color | Luminous Intensity Per Segment | | Page |
|--|---|-------------|---------------------|---------------------------------------|--|--------------|--------------------------------|--------|------|
| | | | | | | | Typ | @ (mA) | |
| 10 Element Encapsulated (Filled Reflector) DIP |  | RBG-4820 | .06 x .15" | 10 element bar graph standard package | Separately addressable anode and cathode | Red | 500 μ cd | 20 | 44 |
| | | OBG-4830 | | | | Hi. Eff. Red | 2500 μ cd | 20 | |
| | | YBG-4840 | | | | Yellow | 2000 μ cd | 20 | |
| | | GBG-4850 | | | | Green | 2000 μ cd | 20 | |
| | H .400" W 1.0" D .240" | | | | | | | | |
| 10 Element Encapsulated (Filled Reflector) DIP |  | RBG-1000 | .04 x .15" | 10 element bar graph small package | Separately addressable anode and cathode | Red | 500 μ cd | 20 | 42 |
| | | OBG-1000 | | | | Hi. Eff. Red | 2500 μ cd | 20 | |
| | | YBG-1000 | | | | Yellow | 2000 μ cd | 20 | |
| | | GBG-1000 | | | | Green | 2000 μ cd | 20 | |
| | H .360" W .990" D .180" | | | | | | | | |

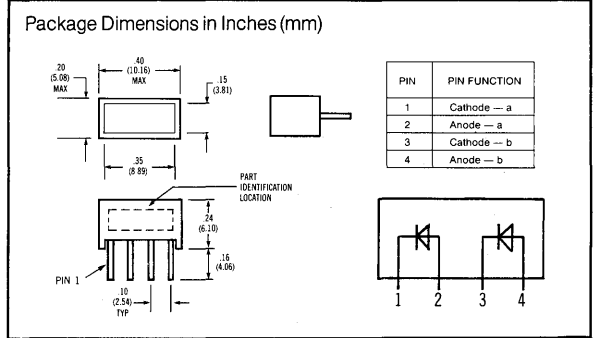
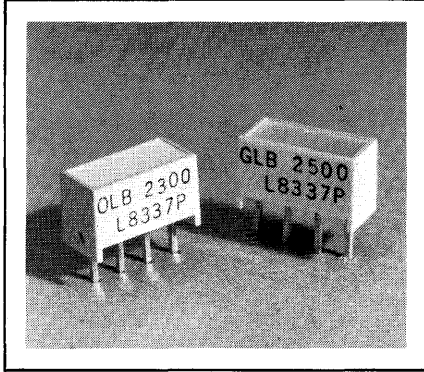
PACKAGE DIMENSIONS: H (HEIGHT), W (WIDTH), D (DEPTH - WITHOUT LEADS OR STANDOFFS)

Linear Arrays

| Package Type | Package Outline | Part Number | Light Emitting Area | Description | Drive Scheme | Color | Luminous Intensity | | Page |
|--|--|-------------|---|---|---|---|--------------------------------------|--------|------|
| | | | | | | | Min. | @ (mA) | |
| 112 Element clear epoxy backfilled cover Single-in line 100 mil pin centers |  | RBG-112 | 5 x 60 mil 8 per group in 13 groups 13 x 13 mil 11 yellow LEDs, common cathode | 101 red elements spaced 1mm C. to C. 11 Yellow scale marks spaced every 10 red LEDs. | 8 x 13 multiplexed common cathode (red) 11 C.C. (yellow) 38 pins | Red bars with yellow scale dots (chips) | 240 μ cd (for both red & yellow) | 10 mA | 46 |
| | H .392" W 4.165" D .235" | | | | | | | | |
| 101 Element red epoxy backfilled cover (clear on special order) Single-in line 100 mil pin centers |  | RBG-8820 | 5 x 60 mil 10 per group in 10 groups with one separate element | 101 red elements spaced 1mm C. to C. | 10 x 10 multiplexed group is selected by the cathode & the individual bar by the anode, addressed by 22 pins. | Red | 240 μ cd | 10 mA | 48 |
| | H .392" W 3.60" D .235" | | | | | | | | |

Light Bars

| Package Type | Package Outline | Part Number | Light Emitting Area | Description | Color | Luminous Intensity | | Page |
|---------------------------------------|---|-------------|---------------------|--|--------------|--------------------|------|------|
| | | | | | | Typ | @ mA | |
| Small rectangular Rugged encapsulated |  | OLB-2300 | .15 x .35" | Small rectangular two die light bar. For back lighting legends or indicators. | Hi. Eff. Red | 10 mcd | 20 | 39 |
| | | YLB-2400 | | | Yellow | 6 mcd | 20 | |
| | | GLB-2500 | | | Green | 10 mcd | 20 | |
| | H .2" W .4" D .24" | | | | | | | |
| Square Rugged encapsulated |  | OLB-2655 | .35 x .35" | Square four die light bar. For back lighting legends or indicators. | Hi. Eff. Red | 20 mcd | 20 | 40 |
| | | YLB-2755 | | | Yellow | 12 mcd | 20 | |
| | | GLB-2855 | | | Green | 20 mcd | 20 | |
| | H .4" W .4" D .24" | | | | | | | |
| Large rectangular Rugged encapsulated |  | OLB-2685 | .35 x .75" | Large rectangular eight die light bar. For back lighting legends or indicators. | Hi. Eff. Red | 40 mcd | 20 | 41 |
| | | YLB-2785 | | | Yellow | 24 mcd | 20 | |
| | | GLB-2885 | | | Green | 40 mcd | 20 | |
| | H .4" W .8" D .24" | | | | | | | |



FEATURES

- Small Rectangular Package
- Uniform Light Emitting Area
- Excellent ON/OFF Contrast
- Choice of Three Colors
- Categorized for Light Output
- Yellow and Green Categorized for Dominant Wavelength
- Panel or Legend Mountable
- Can be Mounted on P.C. Boards or SIP/DFP Sockets
- X-Y Stackable
- Suitable for Multiplexing
- IC Compatible

APPLICATIONS

- These devices are ideally suited for:
- Message Annunciators
 - Positions/Status Indicators
 - Telecommunications Indicators
 - Bar Graphs

DESCRIPTION

The OLB 2300/YLB 2400/GLB 2500 series light bars are rectangular displays designed for application requiring a large light emitting area. They are configured in a single in-line package and contain a single light emitting area. The OLB 2300 and YLB 2400 devices utilize two LED chips which are made from GaAsP on a transparent GaP substrate. The GLB 2500 device utilizes two chips made from GaP on a transparent GaP substrate.

Maximum Ratings

| | OLB 2300 & GLB 2500 | YLB 2400 |
|---|--|----------|
| Average Power Dissipation per LED chip | 135mW | 85mW |
| Peak Forward Current per LED chip | 90mA | 60mA |
| $T_a = 50^\circ\text{C}$ (max pulse width = 2ms) | | |
| Average Forward Current per LED | 25mA | 20mA |
| Pulsed conditions ($T_a = 50^\circ\text{C}$) | | |
| DC Forward Current Per LED ($T_a = 50^\circ\text{C}$) | 30mA | 25mA |
| Reverse Voltage per LED chip | 6V | |
| Operating Temperature | -40°C to $+85^\circ\text{C}$ | |
| Storage Temperature | -40°C to $+85^\circ\text{C}$ | |
| Lead Soldering Temperature, 1/16 inch below seating plane | 260°C for 3 sec. | |
| Junction Temperature | 100°C | |

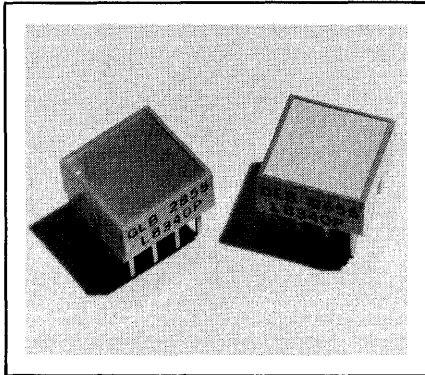
Electrical/Optical Characteristics (@ 25°C)

| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|---------------------|------|------|------|-------|------------------------|
| Luminous Intensity | | | | | |
| OLB2300 | 4.5 | 10 | | mcd | 20mA DC |
| YLB2400 | 4 | 6 | | mcd | 20mA DC |
| GLB2500 | 3.7 | 10 | | mcd | 20mA DC |
| Peak Wavelength | | | | nm | |
| OLB2300 | | 635 | | nm | |
| YLB2400 | | 583 | | nm | |
| GLB2500 | | 565 | | nm | |
| Dominant Wavelength | | | | nm | |
| OLB2300 | | 626 | | nm | |
| YLB2400 | | 585 | | nm | |
| GLB2500 | | 572 | | nm | |
| Forward Voltage | | | | V | |
| OLB2300 | | 1.9 | 2.6 | V | $I_f = 20\text{mA}$ |
| YLB2400 | | 2 | 2.6 | V | $I_f = 20\text{mA}$ |
| GLB2500 | | 2.1 | 2.6 | V | $I_f = 20\text{mA}$ |
| Reverse Voltage | | | | V | |
| OLB2300 | 6 | 15 | | V | $I_R = 100\mu\text{A}$ |
| YLB2400 | 6 | 15 | | V | $I_R = 100\mu\text{A}$ |
| GLB2500 | 6 | 15 | | V | $I_R = 100\mu\text{A}$ |

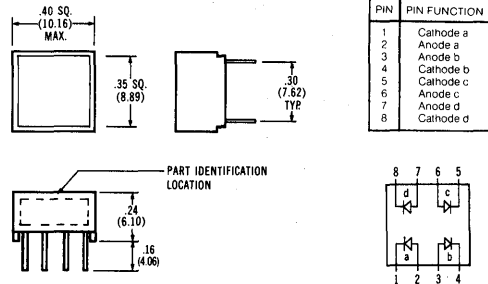
Specifications are subject to change without notice.

SIEMENS

HIGH EFFICIENCY RED **OLB 2655** YELLOW **YLB 2755** GREEN **GLB 2855** **LIGHT BARS** Advance Data Sheet



Package Dimensions in Inches (mm)



FEATURES

- Square Package
- Uniform Light Emitting Area
- Excellent ON/OFF Contrast
- Choice of Three Colors
- Categorized for Light Output
- Yellow and Green Categorized for Dominant Wavelength
- Panel or Legend Mountable
- Can be Mounted on P.C. Boards or DIP Sockets
- X-Y Stackable
- Suitable for Multiplexing
- IC Compatible

APPLICATIONS

These devices are ideally suited for:

- Message Annunciators
- Positions/Status Indicators
- Telecommunications Indicators
- Bar Graphs

DESCRIPTION

The OLB 2655/YLB 2755/GLB 2855 series light bars are square displays designed for application requiring a large light emitting area. They are configured in a dual in-line package and contain a single light emitting area. The OLB 2655 and YLB 2755 devices utilize four LED chips which are made from GaAsP on a transparent GaP substrate. The GLB 2855 device

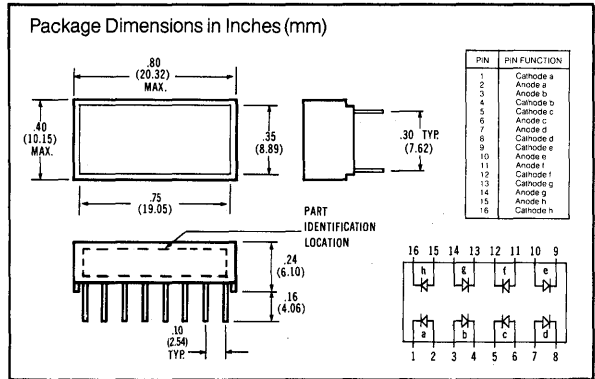
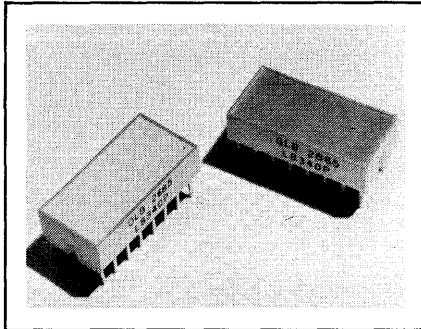
Maximum Ratings

| | OLB 2655 & GLB 2855 | YLB 2755 |
|---|---------------------|----------|
| Average Power Dissipation per LED chip | 135mW | 85mW |
| Peak Forward Current per LED chip | 90mA | 60mA |
| Ta = 50°C (max pulse width = 2ms) | | |
| Average Forward Current per LED | 25mA | 20mA |
| Pulsed conditions (Ta = 50°C) | | |
| DC Forward Current Per LED (Ta = 50°C) | 30mA | 25mA |
| Reverse Voltage per LED chip | 6V | |
| Operating Temperature | 40°C to 135°C | |
| Storage Temperature | -40°C to +85°C | |
| Lead Soldering Temperature, 1/16 inch below seating plane | 260°C for 3 sec. | |
| Junction Temperature | 100°C | |

Electrical/Optical Characteristics (@ 25°C)

| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|---------------------|------|------|------|-------|-----------------|
| Luminous Intensity | | | | | |
| OLB2655 | 9 | 20 | | mcd | 20mA DC |
| YLB2755 | 8 | 12 | | mcd | 20mA DC |
| GLB2855 | 7.5 | 20 | | mcd | 20mA DC |
| Peak Wavelength | | | | | |
| OLB2655 | | 635 | | nm | |
| YLB2755 | | 583 | | nm | |
| GLB2855 | | 565 | | nm | |
| Dominant Wavelength | | | | | |
| OLB2655 | | 626 | | nm | |
| YLB2755 | | 585 | | nm | |
| GLB2855 | | 572 | | nm | |
| Forward Voltage | | | | | |
| OLB2655 | | 2.1 | 2.6 | V | If = 20mA |
| YLB2755 | | 2.2 | 2.6 | V | If = 20mA |
| GLB2855 | | 2.2 | 2.6 | V | If = 20mA |
| Reverse Voltage | | | | | |
| OLB2655 | 6 | 15 | | V | If = 100µA |
| YLB2755 | 6 | 15 | | V | If = 100µA |
| GLB2855 | 6 | 15 | | V | If = 100µA |

Specifications are subject to change without notice.



FEATURES

- Large Rectangular Package
- Uniform Light Emitting Area
- Excellent ON/OFF Contrast
- Choice of Three Colors
- Categorized for Light Output
- Yellow and Green Categorized for Dominant Wavelength
- Panel or Legend Mountable
- Can be Mounted on P.C. Boards or DIP Sockets
- X-Y Stackable
- Suitable for Multiplexing
- IC Compatible

APPLICATIONS

These devices are ideally suited for:

- Message Annunciators
- Positions/Status Indicators
- Telecommunications Indicators
- Bar Graphs

DESCRIPTION

The OLB 2685/YLB 2785/GLB 2885 series light bars are rectangular displays designed for application requiring a large light emitting area. They are configured in a dual in-line package and contain a single light emitting area. The OLB 2685 and YLB 2785 devices utilize eight LED chips which are made from GaAsP on a transparent GaP substrate. The GLB 2885 device utilizes eight chips made from GaP on a transparent GaP substrate.

Maximum Ratings

| | OLB 2685 & GLB 2885 | YLB 2785 |
|---|---------------------|------------------|
| Average Power Dissipation per LED chip | 135mW | 85mW |
| Peak Forward Current per LED chip | 90mA | 60mA |
| Ta = 50°C (max pulse width = 2ms) | | |
| Average Forward Current per LED | 25mA | 20mA |
| Pulsed conditions (Ta = 50°C) | | |
| DC Forward Current Per LED | 30mA | 25mA |
| (Ta = 50°C) | | |
| Reverse Voltage per LED chip | 6V | 6V |
| Operating Temperature | -40°C to +85°C | -40°C to +85°C |
| Storage Temperature | -40°C to +85°C | -40°C to +85°C |
| Lead Soldering Temperature, 1/16 inch below seating plane | 260°C for 3 sec. | 260°C for 3 sec. |
| Junction Temperature | 100°C | 100°C |

Electrical/Optical Characteristics (@ 25°C)

| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|---------------------|------|------|------|-------|-----------------|
| Luminous Intensity | | | | | |
| OLB2685 | 18 | 40 | | mcd | 20mA DC |
| YLB2785 | 16 | 24 | | mcd | 20mA DC |
| GLB2885 | 15 | 40 | | mcd | 20mA DC |
| Peak Wavelength | | | | nm | |
| OLB2685 | | 635 | | nm | |
| YLB2785 | | 583 | | nm | |
| GLB2885 | | 565 | | nm | |
| Dominant Wavelength | | | | nm | |
| OLB2685 | | 626 | | nm | |
| YLB2785 | | 585 | | nm | |
| GLB2885 | | 572 | | nm | |
| Forward Voltage | | | | V | |
| OLB2685 | | 2.1 | 2.6 | V | If = 20mA |
| YLB2785 | | 2.2 | 2.6 | V | If = 20mA |
| GLB2885 | | 2.2 | 2.6 | V | If = 20mA |
| Reverse Voltage | | | | V | |
| OLB2685 | 6 | 15 | | V | Ir = 100µA |
| YLB2785 | 6 | 15 | | V | Ir = 100µA |
| GLB2885 | 6 | 15 | | V | Ir = 100µA |

Specifications are subject to change without notice.

SIEMENS

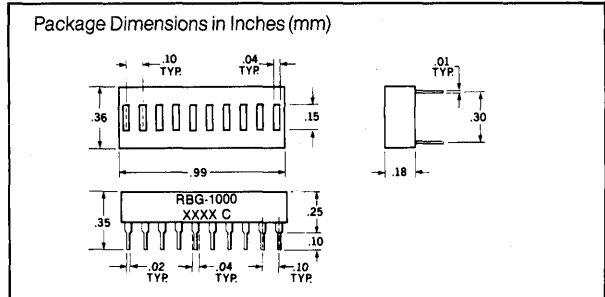
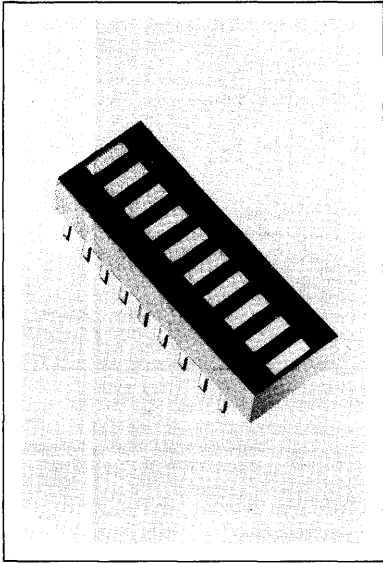
RBG-1000 RED

YBG-1000 YELLOW

OBG-1000 HIGH EFFICIENCY RED

GBG-1000 GREEN

10 ELEMENT LINEAR DISPLAY



Maximum Ratings

| | |
|----------------------------------|---------------|
| Storage Temperature | -20° to +85°C |
| Operating Temperature | 20° to +85°C |
| Power Dissipation @ 25°C | 450 mW |
| Derating Factor from 25°C | 7.5 mW/°C |
| Continuous Forward Current | |
| RBG-1000 per display | 200 mA |
| per element | 20 mA |
| OBG-1000 | |
| YBG-1000 per display | 156 mA |
| GBG-1000 per element | 20 mA |
| Peak Inverse Voltage per Element | 3 V |

Opto-Electronic Characteristics (@25°C)

| Parameter | Test | | Unit | Condition |
|--|------|-----|------|---------------------------|
| | Typ | Max | | |
| Luminous Intensity/ Element (Display Average) | | | | |
| RBG-1000 | .5 | | mcd | $I_F = 20$ mA/ Segment |
| OBG-1000 | 2.5 | | mcd | $I_F = 20$ mA/ Segment |
| YBG-1000 | 2.0 | | mcd | $I_F = 20$ mA/ Segment |
| GBG-1000 | 2.0 | | mcd | $I_F = 20$ mA/ Segment |
| Forward Voltage | | | | |
| RBG-1000 | 1.7 | 2.0 | V | $I_F = 20$ mA |
| OBG-1000 | 2.2 | 2.8 | V | $I_F = 20$ mA |
| YBG-1000 | 2.4 | 3.0 | V | $I_F = 20$ mA |
| GBG-1000 | 2.4 | 3.0 | V | $I_F = 20$ mA |
| Reverse Leakage | 0.1 | 100 | μA | $V_R = 3$ V |
| Emission Peak Wavelength | | | | |
| RBG-1000 | 660 | | nm | |
| OBG-1000 | 630 | | nm | |
| YBG-1000 | 585 | | nm | |
| GBG-1000 | 565 | | nm | |

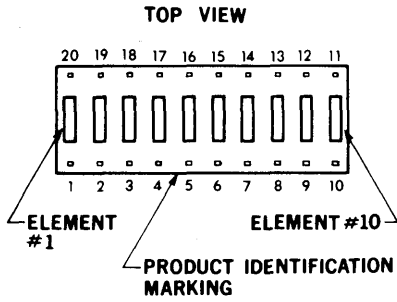
FEATURES

- 10 Element Display
- End Stackable Module
- Individual Addressable Anode and Cathode
- Intensity Coded for Display Uniformity
- Rugged Encapsulation
- Choice of Colors

DESCRIPTION

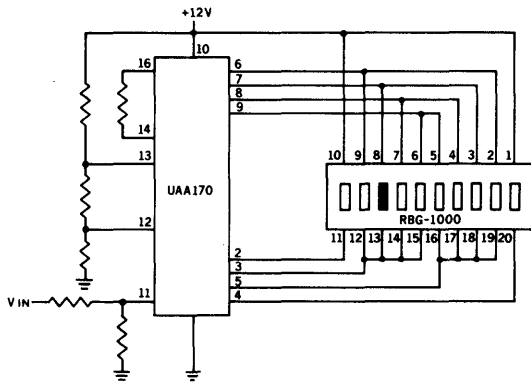
The Red RBG-1000, Hi-efficiency Red OBG-1000, Yellow YBG-1000, and Green GBG-1000 are 10 individual element linear bar displays. They are contained in a 1 inch long, 20 pin dual-in-line package that can be end stacked as bar-graph displays of various lengths. Applications include: bar graph, solid-state meter movement, position indicator, etc.

RBG-1000, OBG-1000, YBG-1000 AND GBG-1000



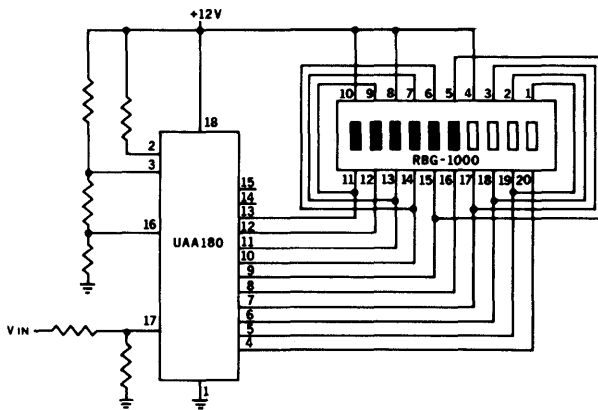
| PIN | FUNCTION | PIN | FUNCTION |
|-----|----------|-----|------------|
| 1 | ANODE 1 | 11 | CATHODE 10 |
| 2 | ANODE 2 | 12 | CATHODE 9 |
| 3 | ANODE 3 | 13 | CATHODE 8 |
| 4 | ANODE 4 | 14 | CATHODE 7 |
| 5 | ANODE 5 | 15 | CATHODE 6 |
| 6 | ANODE 6 | 16 | CATHODE 5 |
| 7 | ANODE 7 | 17 | CATHODE 4 |
| 8 | ANODE 8 | 18 | CATHODE 3 |
| 9 | ANODE 9 | 19 | CATHODE 2 |
| 10 | ANODE 10 | 20 | CATHODE 1 |

TYPICAL APPLICATIONS



LIGHT SPOT DISPLAY

LINEAR DISPLAY DRIVERS
 Siemens UAA170
 Siemens UAA180
 National LM3914
 National LM3915
 Sharp IR2406



LIGHT BAND DISPLAY

No endorsement or warranty of other manufacturer's products is intended by Litronix

SIEMENS

RBG-4820

RED

YBG-4840

YELLOW

OBG-4830

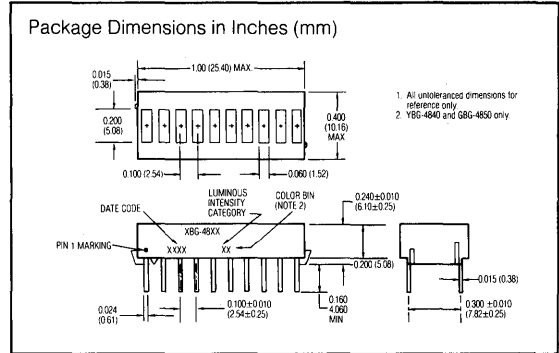
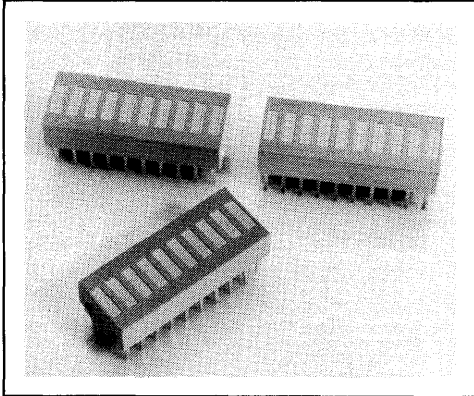
HIGH EFFICIENCY RED

GBG-4850

GREEN

10 ELEMENT LINEAR DISPLAY

Preliminary



FEATURES

- 10 Element Array
- End Stackable With Package Interlock to Assure Alignment
- Matched LED's for Uniform Display
- Individually Addressable Anode and Cathode
- Intensity Coded for Display Uniformity
- Wide Viewing Angle
- Rugged Encapsulated Construction
- Standard Dual-In-Line Package
- High On-Off Contrast, Segment to Segment Hue Coded For Uniformity
- Choice of Colors

DESCRIPTION

The Red RBG-4820, Hi-efficiency Red, OBG-4830, Yellow YBG-4840 and Green GBG-4850 are 10 individual element linear bar displays and are designed to display information in easily recognizable bar graph form. They are end stackable for expanded display lengths. The package interlock ensures that each bargraph will align accurately and correctly with the next one. Applications include solid state meters, position indicators, and instrumentation.

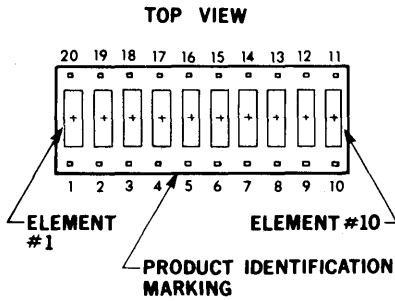
Maximum Ratings

| | |
|---|------------------|
| Storage Temperature | -20°C to +70°C |
| Operating Temperature | -20°C to +70°C |
| Power Dissipation @ 25°C per LED | 125mW |
| Derating Factor from 25°C | 1.67mW/°C |
| Lead Soldering Temperature (1/16 below seating plane) | 260°C for 3 sec. |
| Peak Reverse Voltage Per LED | 3V |
| Continuous Forward Current | |
| RBG-4820 | 30mA |
| OBG-4830 | 30mA |
| YBG-4840 | 20mA |
| GBG-4850 | 30mA |

Optoelectronic Characteristics (@ 25°C)

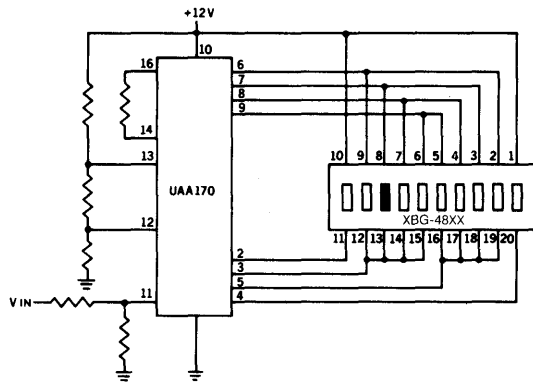
| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|--------------------------------|------|------|------|-------|-----------------------|
| Luminous Intensity Per Element | | | | | |
| RBG-4820 | | 500 | | μcd | I _F =20mA |
| OBG-4830 | | 2500 | | μcd | I _F =20mA |
| YBG-4840 | | 2000 | | μcd | I _F =20mA |
| GBG-4850 | | 2000 | | μcd | I _F =20mA |
| Peak Wavelength | | | | | |
| RBG-4820 | | 655 | | nm | |
| OBG-4830 | | 635 | | nm | |
| YBG-4840 | | 583 | | nm | |
| GBG-4850 | | 566 | | nm | |
| Dominant Wavelength | | | | | |
| RBG-4820 | | 645 | | nm | |
| OBG-4830 | | 626 | | nm | |
| YBG-4840 | | 585 | | nm | |
| GBG-4850 | | 571 | | nm | |
| Forward Voltage Per LED | | | | | |
| RBG-4820 | | 1.6 | 2.0 | V | I _F =20mA |
| OBG-4830 | | 2.1 | 2.5 | V | I _F =20mA |
| YBG-4840 | | 2.2 | 2.6 | V | I _F =20mA |
| GBG-4850 | | 2.1 | 2.5 | V | I _F =10mA |
| Reverse Voltage Per LED | | | | | |
| RBG-4820 | 3 | 12 | | V | I _R =100μA |
| OBG-4830 | 3 | 30 | | V | I _R =100μA |
| YBG-4840 | 3 | 50 | | V | I _R =100μA |
| GBG-4850 | 3 | 50 | | V | I _R =100μA |

RBG-4820 OBG-4830 YBG-4840 and GBG-4850



| PIN | FUNCTION | PIN | FUNCTION |
|-----|----------|-----|------------|
| 1 | ANODE 1 | 11 | CATHODE 10 |
| 2 | ANODE 2 | 12 | CATHODE 9 |
| 3 | ANODE 3 | 13 | CATHODE 8 |
| 4 | ANODE 4 | 14 | CATHODE 7 |
| 5 | ANODE 5 | 15 | CATHODE 6 |
| 6 | ANODE 6 | 16 | CATHODE 5 |
| 7 | ANODE 7 | 17 | CATHODE 4 |
| 8 | ANODE 8 | 18 | CATHODE 3 |
| 9 | ANODE 9 | 19 | CATHODE 2 |
| 10 | ANODE 10 | 20 | CATHODE 1 |

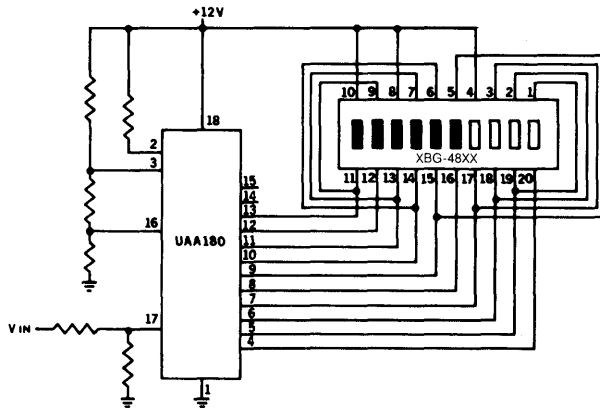
TYPICAL APPLICATIONS



LIGHT SPOT DISPLAY

LINEAR DISPLAY DRIVERS

- Siemens UAA170
- Siemens UAA180
- National LM3914
- National LM3915
- Sharp IR2406

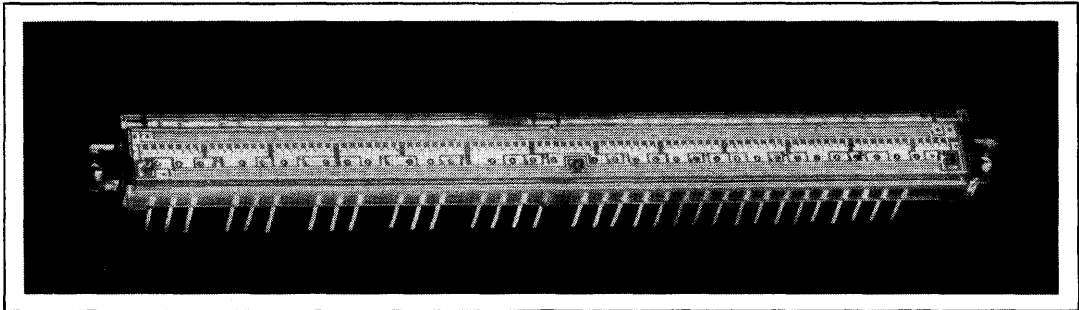


LIGHT BAND DISPLAY

No endorsement or warranty of other manufacturer's products is intended

SIEMENS

RBG-112 112 ELEMENT LINEAR ARRAY WITH SCALE PRELIMINARY



FEATURES

- Instrumentation resolution - 1%
- Clearly Visible Rectangular Red Elements
5 mil x 60 mil light emitting areas
1 mm center to center spacing
- Yellow LED scale marks spaced every 10 red LEDs
- All LEDs of the same color matched for brightness
- Excellent Alignment
- Sturdy Construction, epoxy backfilled cover
- Single-in-line Package
25 mil square pins
100 mil Industry Standard centers
- Specifically designed for multiplexed operation
- Clear polycarbonate cover standard

DESCRIPTION:

The RBG-112 is an instrumentation quality 101 element rectangular red LED linear array accompanied by an 11 element yellow linear array which can be used as a programmable scale. It provides a simple high resolution display of digital data when used as an expanding bar or as a position indicator when used as a moving dot.

The RBG-112 is provided with a clear polycarbonate cover which performs two functions; first the cover is backfilled with an epoxy seal resulting in a rugged, environmentally sound package; and second, the clear cover allows the use of a neutral filter of the customer's choice since LEDs of different colors (yellow and red) are used in the assembly.

The LEDs are arranged in a multiplexed arrangement. Red LEDs are in a common cathode array of 8 elements to a group, 13 groups. Yellow LEDs are in a common cathode configuration of 11 elements. Both groups of arrays are addressed through the 38 single-in-line pins extending from the back of the printed cir-

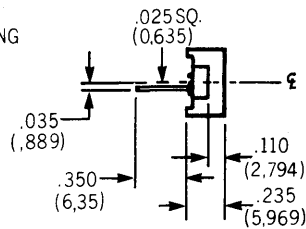
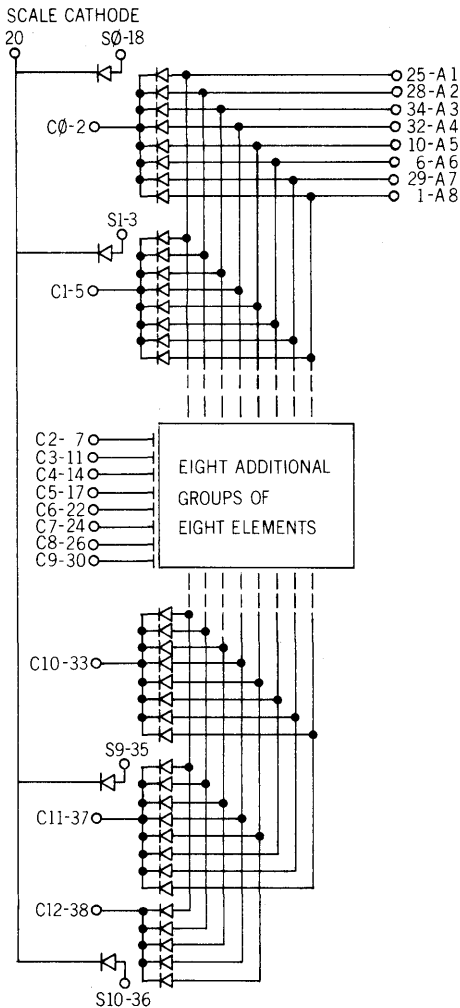
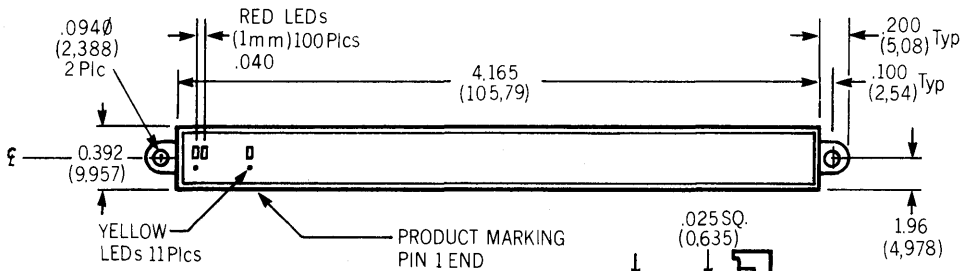
MAXIMUM RATINGS @25° C

| Parameter | Min. | Max. | Units |
|---|------------|------------------|-------|
| Average Power per Segment | | 15 | mW |
| Average DC Forward Current per Segment (Red) | | 7 | mA |
| Average DC Forward Current per Segment (Yellow) | | 7 | mA |
| Derating Factor From 70°C | | 0.16 | mA/°C |
| Peak Forward Current per Seg. Pulse Width-300µs | | 200 | mA |
| Reverse Voltage/Seg. | | 5.0 | V |
| Storage Temperature | -40 to +85 | | Deg C |
| Operating Temperature | -40 to +85 | | Deg C |
| Lead Soldering Temperature | | 260°C for 3 sec. | |

OPTOELECTRONIC CHARACTERISTICS (@25 DEG. C):

| Parameter | Min. | Typ. | Max. | Units | Test Condition |
|---|------|------|-------|-------|----------------|
| Forward Voltage (Red) | | 1.7 | 2.1 | V | IF = 20mA |
| (Yellow) | | 1.9 | 2.4 | V | IF = 20mA |
| Reverse Voltage (Red) | 3.0 | | | V | IR = 100µA |
| (Yellow) | 3.0 | | | V | IR = 100µA |
| Luminous Intensity (Red) | 240 | | | µcd | IF = 10mADC |
| (Yellow) | 240 | | | µcd | IF = 10mADC |
| Peak Wavelength (Red) | | 655 | | nm | IF = 20mA |
| (Yellow) | | 575 | | nm | IF = 20mA |
| Luminous Intensity Segment Matching Adjacent Segments | | | 1.6:1 | | IF = 10mA |
| All Other Segments | | | 1.8:1 | | IF = 10mA |

Package Dimensions in Inches (mm)



ADDITIONAL SCALE ANODES

| ANODES | PIN |
|--------|-----|
| S2 | 9 |
| S3 | 13 |
| S4 | 15 |
| S5 | 19 |
| S6 | 23 |
| S7 | 27 |
| S8 | 31 |

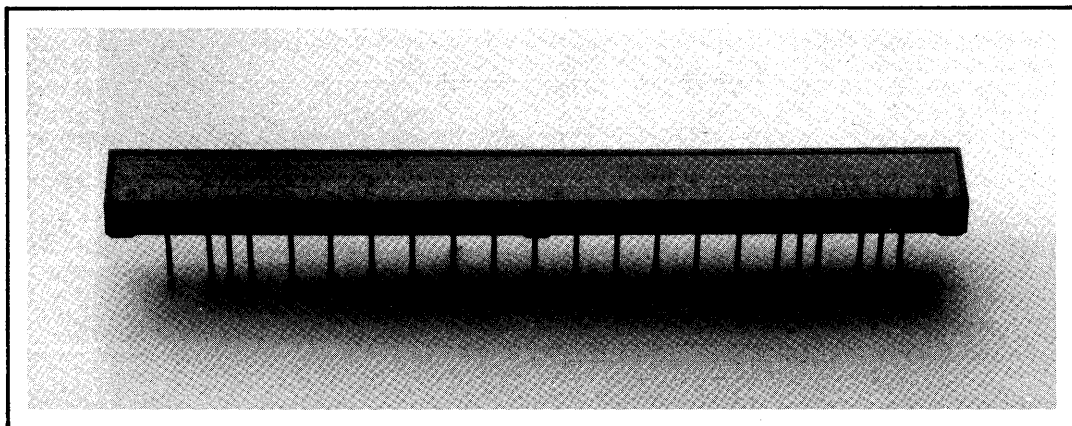
| Pin | Function | Pin | Function |
|-----|----------|-----|------------|
| 1 | A8 | 20 | SCALE CATH |
| 2 | C0 | 21 | NC |
| 3 | S1 | 22 | C6 |
| 4 | NC | 23 | S6 |
| 5 | C1 | 24 | C7 |
| 6 | A6 | 25 | A1 |
| 7 | C2 | 26 | C8 |
| 8 | NC | 27 | S7 |
| 9 | S2 | 28 | A2 |
| 10 | A5 | 29 | A7 |
| 11 | C3 | 30 | C9 |
| 12 | NC | 31 | S8 |
| 13 | S3 | 32 | A4 |
| 14 | C4 | 33 | C10 |
| 15 | S4 | 34 | A3 |
| 16 | NC | 35 | S9 |
| 17 | C5 | 36 | S10 |
| 18 | S0 | 37 | C11 |
| 19 | S5 | 38 | C12 |

A = Anodes
 C = Cathodes
 S = Scale Anodes

SIEMENS

RBG-8820

101 ELEMENT LINEAR ARRAY PRELIMINARY



FEATURES

- Instrumentation Resolution - 1%
- Clearly Visible Rectangular Red Elements
5 mil x 60 mil light emitting area
1 mm center to center spacing
- All LEDs matched for brightness
- Excellent Alignment
- Sturdy Construction, epoxy backfilled cover
- Single-in-line Package
25 mil square pins
100 mil industry Standard centers
- Specifically designed for multiplexed operation
- Red polycarbonate cover standard

DESCRIPTION

The RBG-8820 is an instrumentation quality 101 element red LED linear array. It provides a simple, high resolution analog representation of digital data when used as an expanding bar or as a position indicator when used as a moving dot. The RBG-8820 can be provided either with a red or a clear polycarbonate cover. The clear cover is advantageous when the array is used in conjunction with other LED devices and a front panel filter is placed over all displays. The cover is backfilled with an epoxy seal resulting in a rugged, environmentally sound package. The LEDs are connected in a common cathode configuration with 10 LEDs to a group, and 10 groups total. One additional element is brought out separately.

The RBG-8820 is designed for multiplexed operation, the desired group being selected by the cathode, the individual bar by the anode. The array is addressed by 22 single-in-line pins extending from the back of the circuit board.

MAXIMUM RATINGS (at 25°C)

| | |
|-------------------------------------|-----------------------------------|
| Average power per segment | 15 mw |
| Peak forward current per element | 200 ma, pulse width 300 μ sec |
| Average forward current per element | 7 ma |
| Operating temperature range | -40° to +85°C |
| Storage temperature range | -40° to +85°C |
| Reverse voltage per element | 5.0 volts |
| Lead solder temperature | 260° for 3 sec 1/16" from body |

OPTO-ELECTRONIC CHARACTERISTICS (at 25°C)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|--|-----|-----|-----|----------|-----------------------------|
| Peak wavelength | | 665 | | nM | |
| Forward voltage | | 1.7 | 2.1 | V | If = 20 ma |
| Reverse voltage | 3.0 | | | V | I _R = 100 ua |
| Average luminous intensity per element | 8 | 20 | | μ cd | 100 ma pk, 1/110 duty cycle |

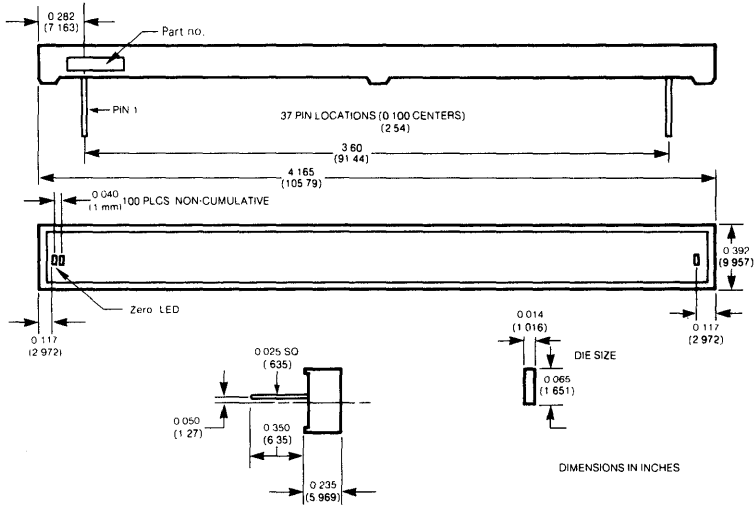
OPTIONS

- Colors available from the factory on special order:
 - Orange
 - High efficiency red*
 - Yellow*
 - Green*
- RBG-8820C clear cover

*Note: These colors have a larger light emitting area.

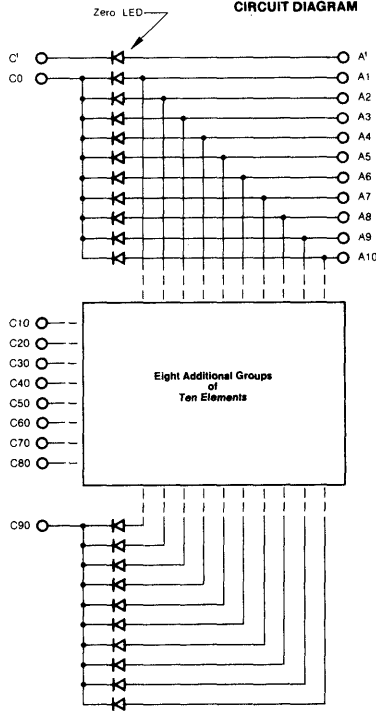
Specifications subject to change without notice

PACKAGE DIMENSIONS



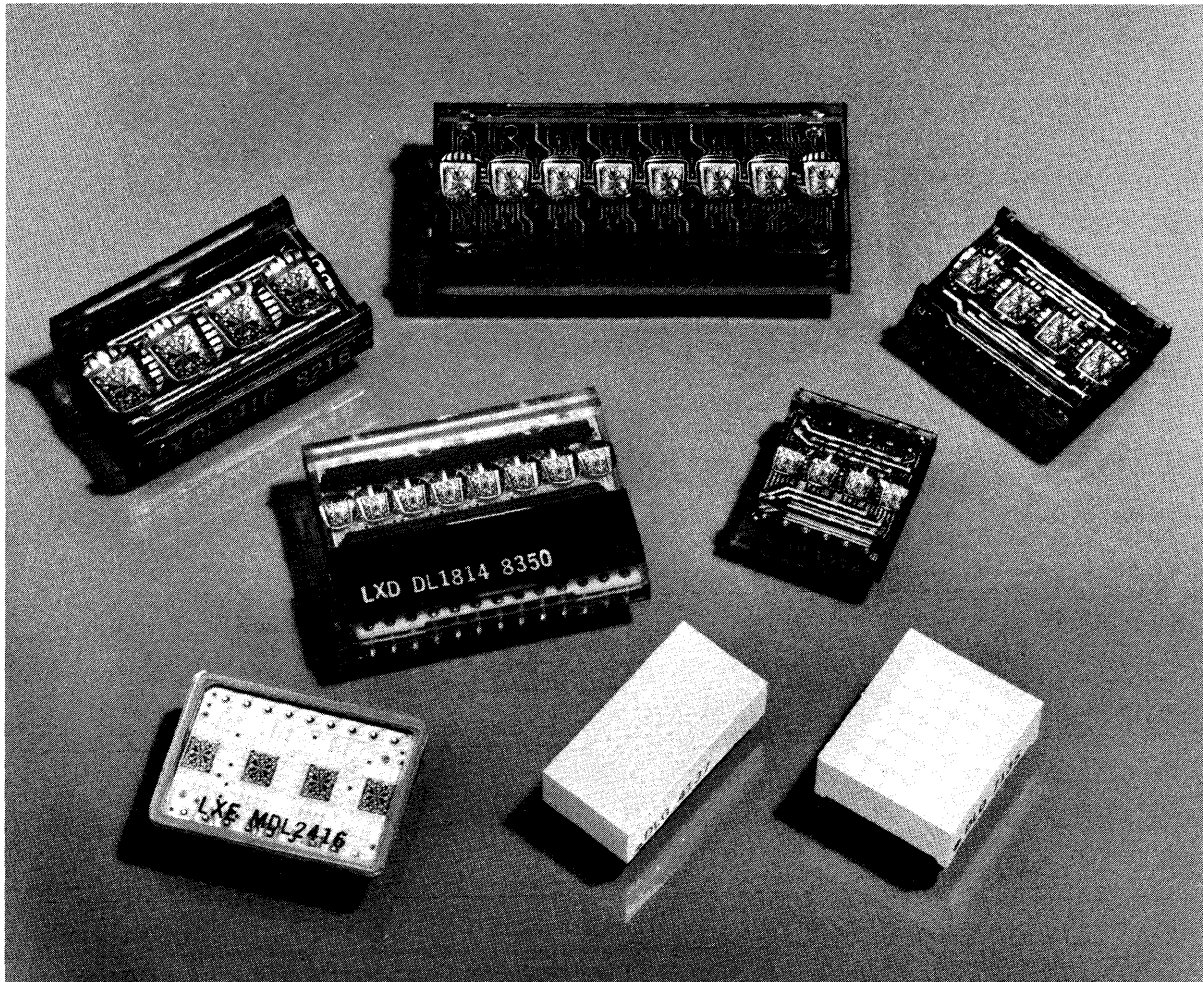
DIMENSIONS IN INCHES

CIRCUIT DIAGRAM

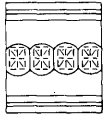
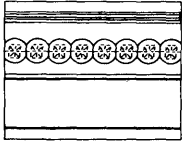
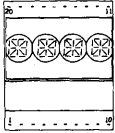
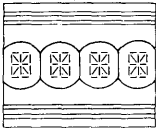
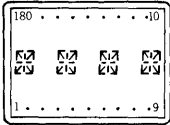
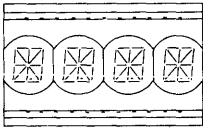
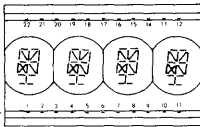


| Pin Location | Designation |
|--------------|-------------|
| 1 | C0 |
| 2 | A4 |
| 3 | C' |
| 4 | C10 |
| 5 | A1 |
| 6 | A8 |
| 7 | C20 |
| 9 | A' |
| 11 | C30 |
| 13 | A7 |
| 15 | C40 |
| 17 | A2 |
| 19 | A2 |
| 21 | C50 |
| 23 | A3 |
| 25 | C60 |
| 27 | A10 |
| 29 | C70 |
| 31 | A9 |
| 33 | C80 |
| 34 | A5 |
| 35 | A6 |
| 37 | C90 |

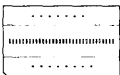
Note: A particular element is selected by the common cathode number and the anode number.
For example, element 56 is lighted by addressed C50 and A6.



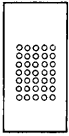
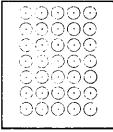
LED Intelligent Displays®

| Package Type | Package Outline | Part Number | Character Height | Description | Page |
|------------------------------|---|-----------------------|--------------------------------------|---|------|
| 4 Char. Module Encapsulated |  | DL-1414 | .112" | 17 segment, 4 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. | 54 |
| 8 Char. Module Encapsulated |  | DL-1814 | .112" | 17 segment, 8 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. | 66 |
| 4 Char. Module Encapsulated |  | DL-1416B | .160" | 16 segment, 4 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. | 58 |
| | | DL-1416T | | | 62 |
| 4 Char. Module Hermetic Seal |  | DL-2416T | .150" | 17 segment, 4 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. Hi-Rel Military Type. | 70 |
| | | DL-2416H | | | |
| 4 Char. Module Hermetic Seal |  | MDL-2416 MDL-2416B | .150" | 17 segment, 4 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. Hi-Rel Military Type. | 92 |
| 4 Char. Module Encapsulated |  | DL-3416 | .225" | 17 segment, 4 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. | 74 |
| | | DL-3416H | | | |
| 4 Char. Module Encapsulated |  | DL-3422 | .170" upper case .100" lower case | 22 segment, 4 character display, upper and lower case letters with built-in CMOS ASCII decoder, multiplexer, memory and driver. Red. Phasing out—Not recommended for new designs. | 78 |

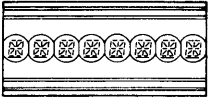
Bar Graph (Linear Array) On Board Intelligence

| Package Type | Package Outline | Part Number | Light Emitting Area | Description | Color | Luminous Typ | Intensity @ V | Page |
|-----------------------------|---|-------------|---------------------|---|-------|--------------|---------------|------|
| 32 Element Encapsulated DIP |  | IBR-3 | 12 x 24 mils | Hi resolution 50 mil spacing. On board; storage, decoding, multiplexing + drive electronics | Red | 0.1 mcd | + 5 V | 90 |

LED Intelligent Displays®

| Package Type | Package Outline | Part Number | Character Height | Description | Page |
|---------------------------|---|-------------|------------------|---|------|
| Single Char. Encapsulated |  | DLO-4135 | .430" | 5x7 Dot Matrix, single character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Orange. 5x7 Dot Matrix, single character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Green. | 82 |
| | | DLG-4137 | | | |
| Single Char. Encapsulated |  | DLO-7135 | .68" | 5x7 Dot Matrix, single character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Orange. 5x7 Dot Matrix, single character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Green. | 86 |
| | | DLG-7137 | | | |

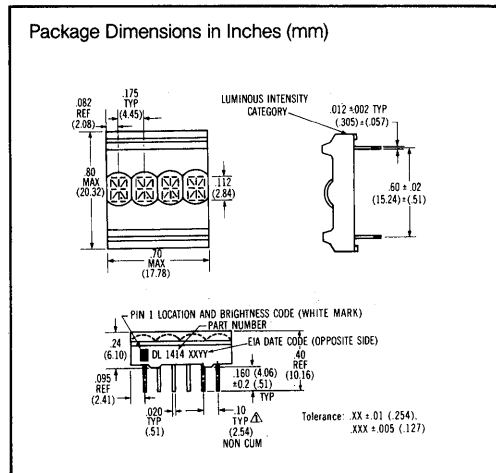
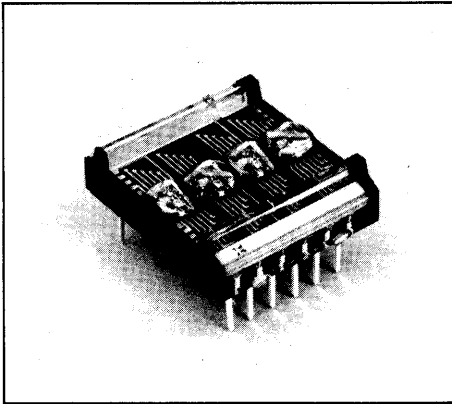
LED Programmable Display™

| Package Type | Package Outline | Part Number | Character Height | Description | Page |
|-----------------------------|---|-------------|------------------|--|------|
| 8 Char. Module Encapsulated |  | PD-2816 | .160" | 18 segment (including decimal and character underline), 8 character display with built-in CMOS ASCII decoder, multiplexer, memory and driver. Software driven—true microprocessor peripheral, some additional features over Intelligent Displays include: control and display memory read/write, dimming (3 levels) and blanking, blinking cursor/character, lamp test and digit underline. Red. | 96 |

SIEMENS

DL-1414

.112" RED, 4-DIGIT 17-SEGMENT ALPHANUMERIC Intelligent Display® WITH MEMORY/DECODER/DRIVER



FEATURES

- 112 Mil High, Magnified Monolithic Char.
- Wide Viewing Angle, $\pm 40^\circ$
- Close Vertical Row Spacing, .800 Inches
- Rugged Solid Plastic Encapsulated Package
- Fast Access Time, 450 nSEC
- Compact Size For Hand Held Equipment
- Built-In Memory
- Built-In Character Generator
- Built-In Multiplex and LED Drive Circuitry
- Direct Access To Each Digit Independently and Asynchronously
- TTL Compatible, 5 Volt Power
- 17th Segment For Improved Punctuation Marks
- Low Power Consumption, Typically 10 mA per character
- Intensity Coded For Display Uniformity
- End-Stackable, 4-Character Package

DESCRIPTION

The DL1414 is a four digit display module having 16 bar segments plus a decimal segment and a built-in CMOS integrated circuit.

The integrated circuit contains memory, ASCII character generator, and LED multiplexing and drive circuitry.

Inputs are TTL compatible. A single 5-volt power supply is required. Data entry is asynchronous and random access. A display system can be built using any number of DL1414's since each character in any DL1414 can be addressed independently and will continue to display the character last written until it is replaced by another.

LOADING DATA

Loading data into the DL1414 is straightforward. The desired data code (D_0-D_6) and digit address (A_0, A_1) is presented in parallel and held stable during a write cycle. Data entry may be asynchronous and in random order. (Digit 0 is defined as right hand digit with $A_1 = A_0 = 0 = \text{low}$).

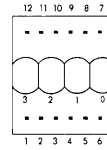
System interconnection is also straightforward. The least significant two address bits (A_0, A_1) are normally connected to the like named inputs of all DL1414's in the system. Data lines are connected to all DL1414's directly and in parallel. Multiple DL1414 systems usually use an external one-of-N decoder chip. The "write" pulse is connected to the CE of the decoder. A 3-to-8 line decoder multiplexer (74138) or a 4-to-16 line decoder/multiplexer (74154) are possible choices. All higher-order address bits (above A_1) become inputs to the decoder.

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays". Since this is a CMOS device, normal precautions should be taken to avoid static damage.

Specifications are subject to change without notice.

| Pin | Function | Pin | Function |
|-----|-----------------|-----|---------------------|
| 1 | D5 Data Input | 7 | Gnd |
| 2 | D4 Data Input | 8 | D0 Data Input (LSB) |
| 3 | WR Write | 9 | D1 Data Input |
| 4 | A1 Digit Select | 10 | D2 Data Input |
| 5 | A0 Digit Select | 11 | D3 Data Input |
| 6 | V _{CC} | 12 | D6 Data Input (MSB) |

TOP VIEW



Product Identification Markings on Front Surface

OPTO-ELECTRONIC CHARACTERISTICS @ 25°C

| MAXIMUM RATINGS | |
|------------------------------------|---------------|
| Voltage, Any Pin | -.5 to +6 VDC |
| Respect to GND | -.5 to +6 VDC |
| Operating Temperature | -20°C to 65°C |
| Storage Temperature | -20°C to 70°C |
| Relative Humidity (non condensing) | @ 65°C, 85% |

| OPTICAL CHARACTERISTICS (TYPICAL) | |
|--|----------|
| Luminous Intensity per digit/8 segments @ 5V | 0.4 mcd |
| Off Axis Viewing Angle (Note 1) | ±40° |
| Digit Size | 112 mils |
| Spectral Peak Wavelength | 660 nm |

DC CHARACTERISTICS

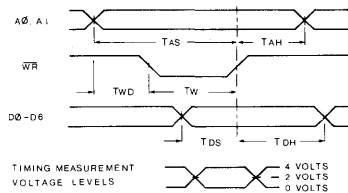
| Parameter | -20°C Typ | +25°C (Note 6) | +65°C Typ | Conditions |
|--|-----------|------------------------|-----------|--|
| I _{CC} 4 Digits on (10 seg/Digit) | 100 mA | 90 mA Max | 70 mA | V _{CC} = 5.0 V |
| I _{CC} Blank | | 2.7 mA Max | | V _{IN} = 0 V _{CC} = 5.0 V WR = 5.0 V |
| I _{IL} | 180 μA | 160 μA Max | 100 μA | V _{IN} = .8 V V _{CC} = 5.0 V |
| V _{IL} | | .8 V Max | | V _{CC} = 4.5 V |
| V _{IH} (Note 4) | | 2.7 V Min 3.3 V Min | | V _{CC} = 4.5 V V _{CC} = 5.5 V |

TIMING CHARACTERISTICS

| AC CHARACTERISTICS MINIMUM TIMING PARAMETERS @ 4.5 V (nanoseconds) | | | |
|---|-----------|----------|-----------|
| Parameter | -20°C Typ | 25°C Min | +65°C Typ |
| T _{AS} | 300 | 400 | 500 |
| T _{WD} | 50 | 75 | 125 |
| T _W | 250 | 325 | 375 |
| T _{DS} | 200 | 250 | 300 |
| T _{DH} | 50 | 50 | 100 |
| T _{AH} | 50 | 50 | 100 |

Access time = 450 ns

WRITE CYCLE WAVEFORMS



- Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any segment in the display is not visible".
- Note 2: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.
- Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).
- Note 4: V_{CC} ≥ V_{IH} ≥ 0.6 V_{CC}.
- Note 5: **Warning** – Do not use solvents containing alcohol.
- Note 6: V_{CC} = +5.0 VDC ±10%
- Note 7: Access time is defined as T_{AS} + T_{DH} (sum of address set up and data hold times).

CHARACTER SET

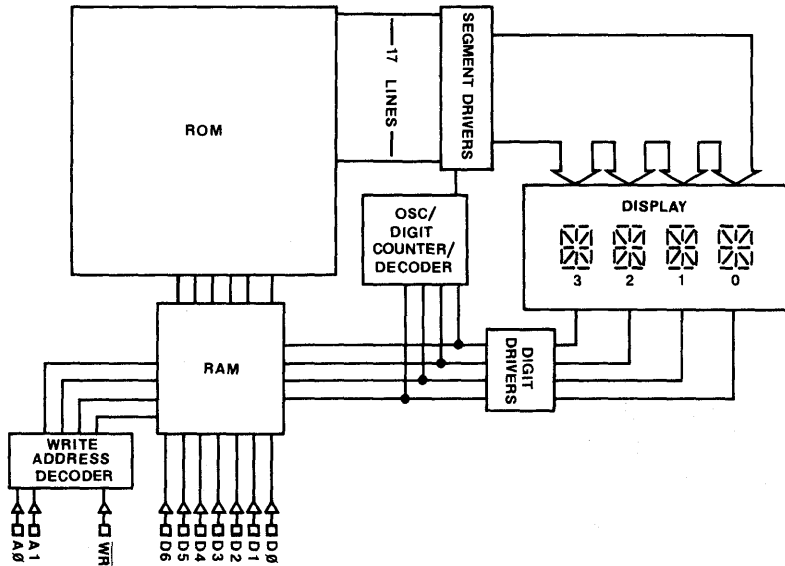
| | | | | | | | | | |
|---------|-------------|---|---|---|----|---|----|---|---|
| | D0 | L | H | L | H | L | H | L | H |
| | D1 | L | L | H | H | L | L | H | H |
| | D2 | L | L | L | L | H | H | H | H |
| | D6 D5 D4 D3 | | | | | | | | |
| L H L L | | ! | " | # | \$ | % | & | ' | |
| L H L H | | < | > | * | + | , | -- | . | |
| L H H L | | 0 | 1 | 2 | 3 | 4 | 5 | 6 | |
| L H H H | | 8 | 9 | : | / | ∠ | = | ∧ | |
| H L L L | | Q | R | S | T | U | V | W | |
| H L L H | | H | I | J | K | L | M | N | |
| H L H L | | P | Q | R | S | T | U | V | |
| H L H H | | X | Y | Z | [| \ |] | ^ | |

All Other Input Codes Display "Blank"

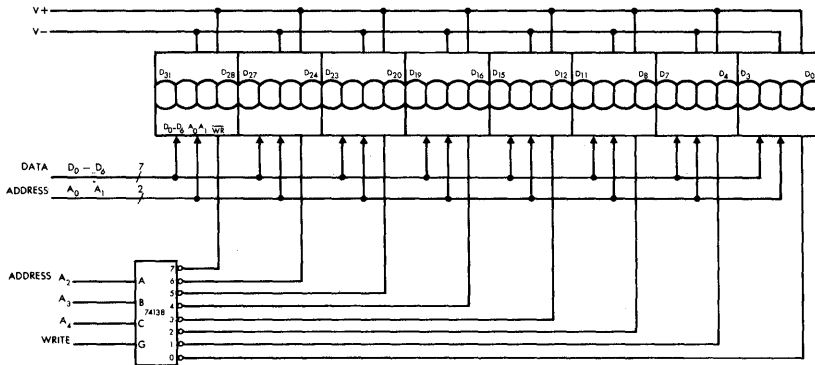
LOADING DATA STATE TABLE

| WR | A1 | A0 | PREVIOUSLY LOADED DISPLAY | | | | | | | DIGIT | | | | |
|----|----|----|---------------------------|----|----|----|----|----|----|-------------------|---|---|---|---|
| | | | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 3 | 2 | 1 | 0 | |
| H | | | L | H | L | L | L | H | L | H | G | R | E | Y |
| L | L | | L | H | L | L | L | H | L | H | G | R | E | E |
| L | L | H | H | L | H | L | H | L | H | | G | R | U | E |
| L | H | L | H | L | L | H | H | L | L | | G | L | U | E |
| L | H | H | H | L | L | L | L | H | L | | B | L | U | E |
| L | L | H | H | L | L | L | L | H | L | H | B | L | E | E |
| L | L | L | H | L | H | L | L | H | H | | B | L | E | W |
| L | X | X | SEE CHARACTER CODE | | | | | | | SEE CHARACTER SET | | | | |

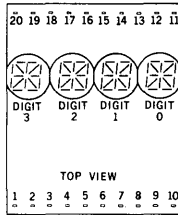
X = DON'T CARE



DL-1414 Block Diagram



TYPICAL INTERCONNECTION
FOR 32 DIGITS



| Pin | Function | Pin | Function |
|-----|----------|-----|-----------------|
| 1 | D5 | 11 | A1 Digit Select |
| 2 | D4 | 12 | Unused |
| 3 | D0 | 13 | Unused |
| 4 | D1 | 14 | Unused |
| 5 | D2 | 15 | Unused |
| 6 | D3 | 16 | Unused |
| 7 | CE | 17 | Unused |
| 8 | W | 18 | V+ |
| 9 | CU | 19 | V- |
| 10 | A0 | 20 | D6 Data Input |

OPTO-ELECTRONIC CHARACTERISTICS @ 25°C

MAXIMUM RATINGS

| | | |
|-------------------------|-------|-----------------|
| Voltage, Any Pin | | - .5 to 6.0 VDC |
| Respect to GND | | |
| Operating Temperature | | - 20° to 65°C |
| Storage Temperature | | - 20° to 70°C |
| Relative Humidity | | |
| (non condensing) @ 65°C | | 85% |

OPTICAL CHARACTERISTICS (TYPICAL)

| | | |
|---|-------|----------|
| Luminous Intensity per digit/8 segments | | 0.75 mcd |
| Off Axis Viewing Angle (Note 1) | | ± 30° |
| Digit Size | | 160 mils |
| Spectral Peak Wavelength | | 660 nm |

DC CHARACTERISTICS @ 25°C [4]

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|--|--|------|------|------|-------|
| I _{CC} Blank | V _{CC} = 5V WR = V _{CC} VIN = 0V | | .5 | 1.0 | mA |
| I _{CC} (10 segs/ Char. 4 digits) [1] | V _{CC} = 5V | | 80 | 125 | mA |
| I _{CC} (All seg on Cursor in 4 digits) [2] | V _{CC} = 5V 5 sec. max. | | 110 | | mA |
| V _{IL} (All inputs) [3] | V _{CC} = 5V | | | .8 | V |
| V _{IH} (All inputs) [3] | V _{CC} = 4.5V | 2.7 | | | V |
| I _{IL} (All inputs) [3] | V _{IN} = .8V | | | 400 | uA |

[1] Measured at 5 seconds.

[2] 60 sec. max. duration.

[3] V_{CC} ≥ V_{IH} ≥ 0.6 V_{CC}

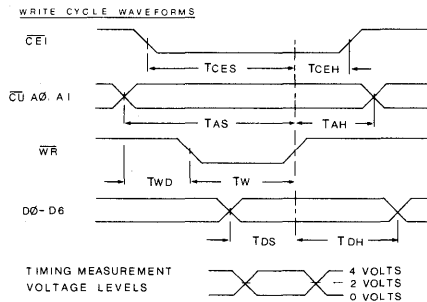
[4] V_{CC} = +5.0 VDC ± 10%

AC CHARACTERISTICS @ 25°C

MINIMUM TIMING PARAMETERS @ 4.5 V (nanoseconds)

| | |
|------------------|-----|
| T _{AS} | 450 |
| T _{WD} | 150 |
| T _W | 300 |
| T _{DS} | 250 |
| T _{DH} | 50 |
| T _{AH} | 50 |
| T _{CEH} | 50 |
| T _{CES} | 450 |

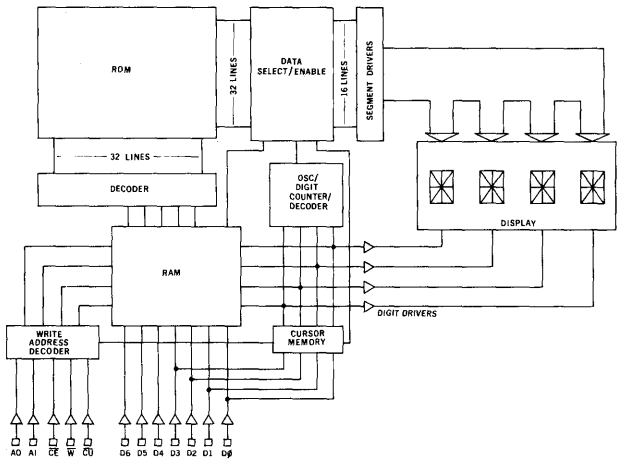
TIMING CHARACTERISTICS



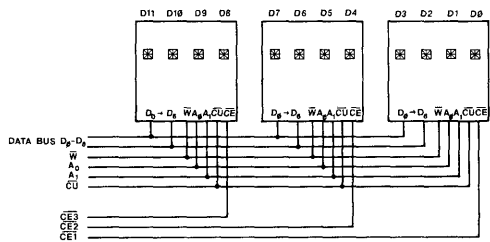
Note 1: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.

Note 2: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).

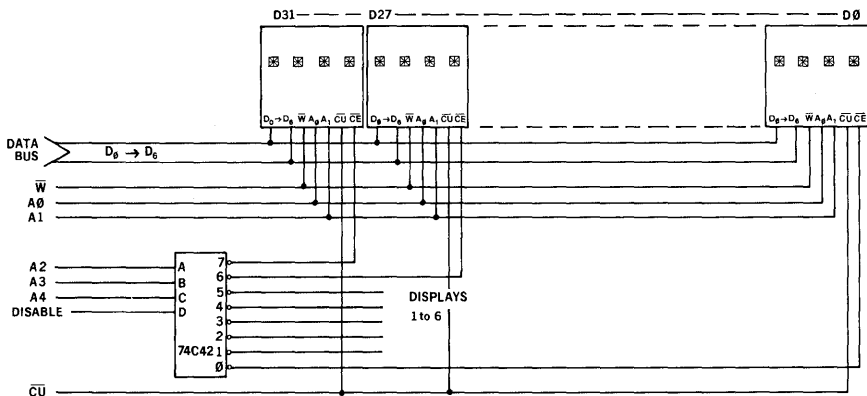
Note 3: **Warning** — Do not use solvents containing alcohol.



INTERNAL SCHEMATIC

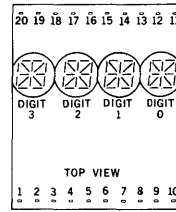


Typical interconnect for small systems, 12 digits



Typical schematic for 32 digit systems

| Pin | Function | Pin | Function |
|-----|-----------------|-----|-----------------|
| 1 | D5 Data Input | 11 | A1 Digit Select |
| 2 | D4 Data Input | 12 | Unused |
| 3 | D0 Data Input | 13 | Unused |
| 4 | D1 Data Input | 14 | Unused |
| 5 | D2 Data Input | 15 | Unused |
| 6 | D3 Data Input | 16 | Unused |
| 7 | CE Chip Enable | 17 | Unused |
| 8 | W Write | 18 | V+ |
| 9 | CU Cursor Input | 19 | V- |
| 10 | A0 Digit Select | 20 | D6 Data Input |



OPTO-ELECTRONIC CHARACTERISTICS @ 25°C

| MAXIMUM RATINGS | |
|---|--|
| Voltage, Any Pin | Respect to GND (V-) . . . -0.5 to V _{CC} +0.5 VDC |
| Operating Temperature | -20 to +65°C |
| Storage Temperature | -20 to +70°C |
| Relative Humidity (non condensing) @ 65°C | 85% |

| OPTICAL CHARACTERISTICS (TYPICAL) | |
|---|--------------------|
| Luminous Intensity per digit/8 segments @ 5V, | 0.5 mcd |
| Viewing Angle | ±20° |
| Digit Size | 160 mils |
| Spectral Peak Wavelength | 660 nm |

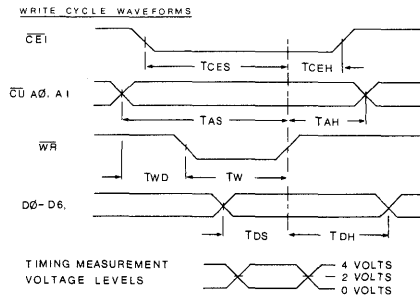
| DC CHARACTERISTICS | | | | |
|--|-----------|-------------------------|-----------|--|
| Parameter | -20°C Typ | +25°C ⁴ | +65°C Typ | Conditions |
| I _{CC} 4 digits on (10 seg/digit) | | 75 mA max ¹ | | V _{CC} = 5.0 V |
| I _{CC} Cursor ² | | 100 mA max ¹ | | V _{CC} = 5.0 V |
| I _{CC} Blank | 5.0 mA | 5 mA max | 2.0 mA | V _{IN} = 0 V _{CC} = 5.0 V WR = 5.0 V |
| I _{IL} | 20 μA | 160 μA max | 10 μA | V _{IN} = .8 V V _{CC} = 5.0 V |
| V _{IL} | | .8 V Max | | V _{CC} = 4.5 V |
| V _{IH} ³ | | 2.7 V Min | | V _{CC} = 4.5 V |
| | | 3.3 V Min | | V _{CC} = 5.5 V |

- 1 Measured at 5 seconds.
- 2 60 sec. max. duration.
- 3 V_{CC} ≥ V_{IH} ≥ 0.6 V_{CC}
- 4 V_{CC} = +5.0 VDC ±10%

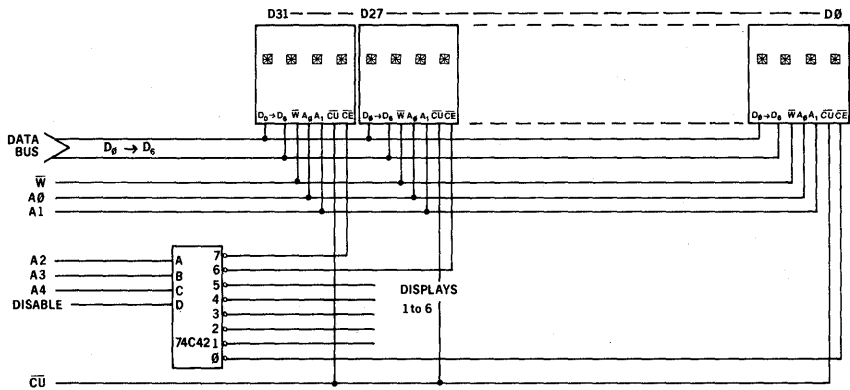
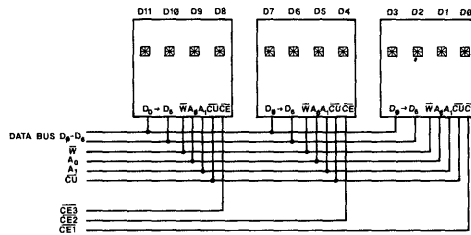
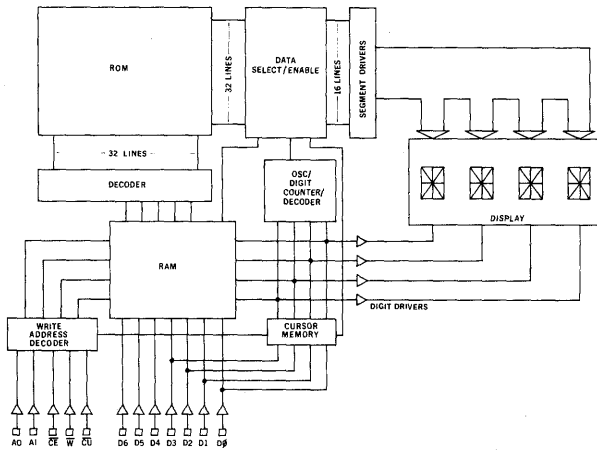
| AC CHARACTERISTICS @ 25°C | |
|---|------|
| MINIMUM TIMING PARAMETERS @ 4.5 V (nanoseconds) | |
| T _{AS} | 1000 |
| T _{WD} | 500 |
| T _W | 500 |
| T _{DS} | 1000 |
| T _{DH} | 400 |
| T _{AH} | 400 |
| T _{CEH} | 400 |
| T _{CES} | 1000 |

Access time = 1400 ns

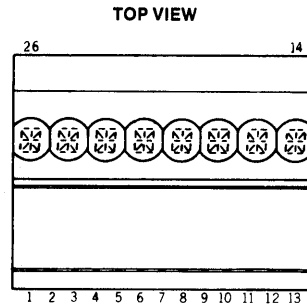
TIMING CHARACTERISTICS



- Note 1: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.
- Note 2: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).
- Note 3: **Warning** — Do not use solvents containing alcohol.
- Note 4: Access time is defined as T_{AS} + T_{DH} (sum of address set up and data hold times).



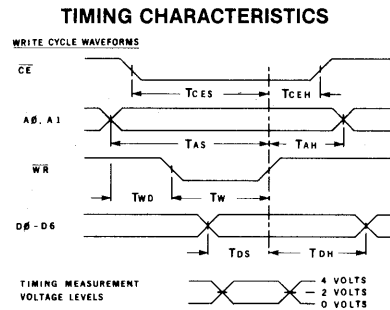
| Pin | Function | Pin | Function |
|-----|---------------|-----|------------------|
| 1 | D0 Data input | 14 | BL (Blank) |
| 2 | D1 Data input | 15 | NO PIN |
| 3 | D2 Data input | 16 | NO PIN |
| 4 | D3 Data input | 17 | NO PIN |
| 5 | D4 Data input | 18 | NO PIN |
| 6 | D5 Data input | 19 | NO PIN |
| 7 | D6 Data input | 20 | NO PIN |
| 8 | GND | 21 | NO PIN |
| 9 | A0 Address | 22 | NO PIN |
| 10 | A1 Address | 23 | NO PIN |
| 11 | A2 Address | 24 | NO PIN |
| 12 | WR Write | 25 | NO PIN |
| 13 | VCC | 26 | CE (Chip Enable) |



| OPTOELECTRONIC CHARACTERISTICS @ 25°C | |
|---|---|
| <p style="text-align: center;">MAXIMUM RATINGS:</p> <p>Voltage, Any Pin Respect to GND..... - 5 to +6VDC Operating Temperature -20°C to 65°C Storage Temperature -20°C to 70°C Relative Humidity (non-condensing).....@65°C, 85%</p> | <p style="text-align: center;">OPTICAL CHARACTERISTICS (TYPICAL)</p> <p>Luminous Intensity per digit/8 segments @ 5V 5 mcd Viewing angle (note 1) ±33° Digit Size 122° Spectral peak wavelength (typ) 660 nm</p> |

| DC CHARACTERISTICS | | | | | |
|-----------------------------------|---|------|------|------|-------|
| PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| $I_{CC}(\text{Blank})$ | $V_{CC} = 5V$ $V_{IN} = 0V$ $WR = V_{CC}$ | | 2.0 | 3.7 | mA |
| I_{CC} (10 seg 8 digits on) | $V_{CC} = 5V$ | | 80 | 120 | mA |
| I_{IL} (All inputs) | $V_{CC} = 5V$ | | | 160 | uA |
| V_{IL} (All inputs) | $V_{CC} = 5V$ | | | 1.0 | V |
| V_{IH} (note 4) (All inputs) | $V_{CC} = 5V$ | 3.0 | | | V |

| AC CHARACTERISTICS MINIMUM TIMING PARAMETERS @ 4.5 V | | |
|---|----------------|-------|
| Parameter | Min @ +25°C | Units |
| T_{WD} | 150 | ns |
| T_{CES} | 450 | ns |
| T_{DS} | 250 | ns |
| T_w | 300 | ns |
| T_{DH} | 50 | ns |
| T_{AS} | 450 | ns |
| T_{CEH} | 50 | ns |
| T_{AH} | 50 | ns |
| Access time = 500 ns | | |



- Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any segment in the display is not visible."
- Note 2: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields. SEE APPNOTE 18.
- Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).
- Note 4: $V_{CC} > V_{IH} \geq 0.6 V_{CC}$.
- Note 5: **Warning** - Do not use solvents containing alcohol.
- Note 6: $V_{CC} = \pm 5.0 \text{ VDC} \pm 10\%$
- Note 7: Access time is defined as $T_{AS} + T_{DH}$ (sum of address set up and data hold times).

LOADING DATA

Loading data into the DL1814 is straightforward. The desired data and chip enable should be present and stable during a write pulse. No synchronization is necessary, and each character will continue to be displayed until it is replaced with another. Multiple displays will require an external decoder IC connected to the chip enable input.

Setting the chip enables \overline{CE} to its true state will enable data loading. The desired data code (D0-D6) and digit address (A_0, A_1, A_2) must be held stable during the write cycle for storing new data. Data entry may be asynchronous and random. (Digit 0 is defined as right hand digit with $A_2 = A_1 = A_0 = 0$.)

BLANKING THE DISPLAY

Blanking the display may be accomplished by loading a blank or space into each digit of the display or by using the \overline{BL} display blank input.

Setting the \overline{BL} input low does not affect the contents of either data. A flashing display can be realized by pulsing \overline{BL} .

CHARACTER SET

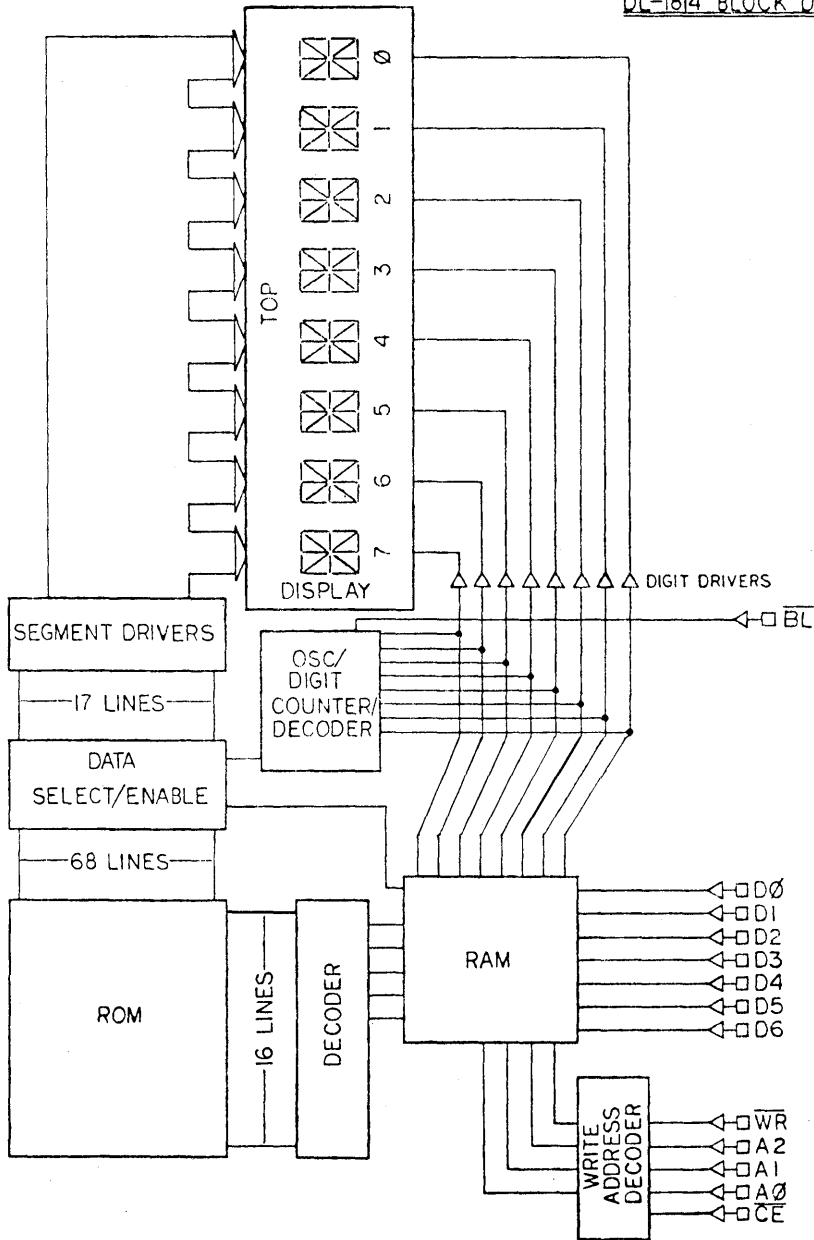
| | | | | | | | | |
|-------------|---|---|---|---|----|---|---|---|
| D0 | L | H | L | H | L | H | L | H |
| D1 | L | L | H | H | L | L | H | H |
| D2 | L | L | L | L | H | H | H | H |
| D6 D5 D4 D3 | L | H | L | L | L | L | L | L |
| L H L L | | 9 | " | # | \$ | % | & | ' |
| L H L H | | < | > | * | + | / | - | . |
| L H H L | | 0 | 1 | 2 | 3 | 4 | 5 | 6 |
| L H H H | | 8 | 9 | : | ; | ^ | = | > |
| H L L L | | a | A | B | C | D | E | F |
| H L L H | | H | I | J | K | L | M | N |
| H L H L | | P | Q | R | S | T | U | V |
| H L H H | | X | Y | Z | [| \ |] | ^ |

All Other Input Codes Display "Blank"

TYPICAL LOADING DATA STATE TABLE

| BL | CE | WR | A2 | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | DIGIT | | | | | | | |
|----|----|----|----|----|----|---------------------------|----|----|----|----|----|-------------------|-------|---|---|---|---|---|---|---|
| | | | | | | | | | | | | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| H | X | H | X | X | X | PREVIOUSLY LOADED DISPLAY | | | | | | L | I | T | R | O | N | I | X | |
| H | H | X | X | X | X | X | X | X | X | X | X | X | L | I | T | R | O | N | | |
| H | L | L | L | L | L | H | H | L | L | H | L | H | L | I | T | R | O | N | | |
| H | L | L | L | L | H | L | H | L | L | H | H | L | L | I | T | R | O | N | | |
| H | L | L | L | L | H | H | L | L | L | L | L | H | L | I | T | R | E | B | | |
| H | L | L | L | H | L | H | L | L | L | L | H | L | H | L | I | T | E | B | | |
| H | L | L | L | H | L | H | L | L | H | L | H | L | H | L | I | U | E | B | | |
| H | L | L | L | H | L | H | L | L | L | L | L | L | L | L | I | U | E | B | | |
| H | L | L | L | H | H | H | L | L | L | L | L | H | L | B | L | U | E | B | | |
| L | X | H | X | X | X | BLANK DISPLAY | | | | | | B | L | U | E | G | L | U | E | |
| H | L | L | L | H | X | H | L | L | L | H | H | H | H | B | L | U | E | G | | |
| H | L | L | X | X | X | SEE CHARACTER CODE | | | | | | SEE CHARACTER SET | | | | | | | | |

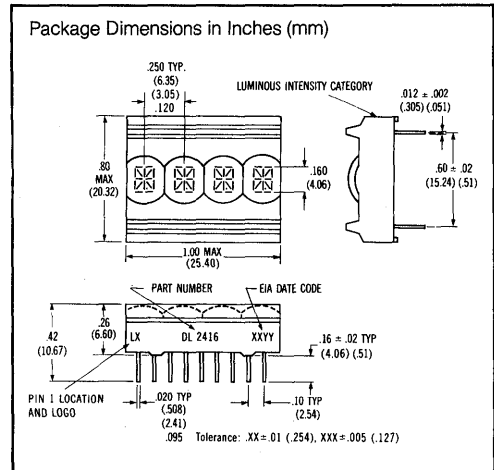
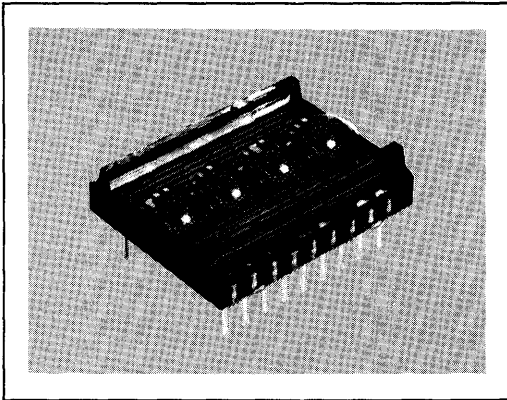
DL-1814 BLOCK DIAGRAM



SIEMENS

DL-2416T, DL-2416 H

**.160" RED, 4-DIGIT 16-SEGMENT PLUS DECIMAL
ALPHANUMERIC Intelligent Display®
WITH MEMORY/DECODER/DRIVER**



FEATURES

- 160 Mil High, Magnified Monolithic Char.
- Wide Viewing Angle $\pm 40^\circ$
- Close Vertical Row Spacing, .800 Inches
- Rugged Solid Plastic Encapsulated Package
- Fast Access Time
DL-2416 500 nSEC
DL-2416H 300 nSEC
- Full Size Display for Stationary Equipment
- Built-in Memory
- Built-in Character Generator
- Built-in Multiplex and LED Drive Circuitry
- Direct Access to Each Digit Independently & Asynchronously
- TTL Compatible, 5 Volt Power
- Independent Cursor Function
- 17th Segment for Improved Punctuation Marks
- Memory Clear Function
- Display Blank Function
- End-Stackable, 4-Character Package
- Intensity Coded for Display Uniformity

DESCRIPTION

The DL 2416 is a four digit display module having 16 segments plus decimal and a built-in CMOS integrated circuit.

The integrated circuit contains memory, ASCII ROM decoder, multiplexing circuitry, and drivers. Data entry is asynchronous and can be random. A display system can be built using any number of DL 2416's since each digit of any DL 2416 can be addressed independently and will continue to display the character last stored until replaced by another.

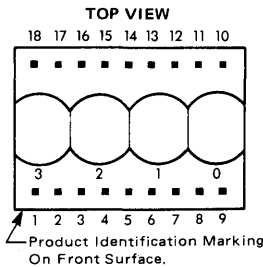
System interconnection is very straightforward. The least significant two address bits (A_0 , A_1) are normally connected to the like named inputs of all DL 2416's in the system. With two chip enables ($\overline{CE1}$, and $\overline{CE2}$) two DL 2416's (16 characters) can easily be interconnected without a decoder.

Alternatively, one-of-n decoder IC's can be used to extend the address for large displays.

Data lines are connected to all DL 2416's directly and in parallel, as is the write line (\overline{WR}). The display will then behave as a write-only memory.

The cursor function causes all segments of a digit position to illuminate. The cursor is *not* a character, however, and upon removal the previously displayed character will reappear.

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays". Since this is a CMOS device, normal precautions should be taken to avoid static damage.



| Pin | Function | Pin | Function |
|-----|-------------------------------|-----|------------------|
| 1 | $\overline{CE1}$ Chip Enable | 10 | Gnd |
| 2 | $\overline{CE2}$ Chip Enable | 11 | D0 Data Input |
| 3 | \overline{CLR} Clear | 12 | D1 Data Input |
| 4 | CUE Cursor Enable | 13 | D2 Data Input |
| 5 | \overline{CS} Cursor Select | 14 | D3 Data Input |
| 6 | WR Write | 15 | D6 Data Input |
| 7 | A1 Digit Select | 16 | D5 Data Input |
| 8 | A0 Digit Select | 17 | D4 Data Input |
| 9 | VCC | 18 | BL Display Blank |

OPTO-ELECTRONIC CHARACTERISTICS @ 25°C

MAXIMUM RATINGS

Voltage, Any Pin
 Respect to GND -5 to 6.0 VDC
 Operating Temperature -20° to 65°C
 Storage Temperature -20° to 70°C
 Relative Humidity
 (non condensing) @ 65°C 85%

OPTICAL CHARACTERISTICS (TYPICAL)

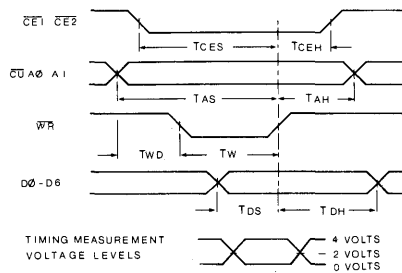
Luminous Intensity per digit/8 segments 0.5 mcd
 Off Axis Viewing Angle (Note 1) ±50°
 Digit Size 160 mils
 Spectral Peak Wavelength 660 nm

DC CHARACTERISTICS DL-2416 AND DL-2416 H

| Parameter | -20°C Typ | +25°C ⁴ | +65°C Typ | Conditions |
|--|-----------|-------------------------|-----------|--|
| I _{CC} 4 digits on (10 seg/digit) | 135 mA | 125 mA max ¹ | 100 mA | V _{CC} = 5.0 V |
| I _{CC} Cursor ² | 160 mA | 140 mA max ¹ | 120 mA | V _{CC} = 5.0 V |
| I _{CC} Blank | | 3.7 mA max | | V _{IN} = 0 V _{CC} = 5.0 V WR = 5.0 V |
| I _{IL} | 200 μA | 160 μA max | 100 μA | V _{IN} = .8 V V _{CC} = 5.0 V |
| V _{IL} | | .8 V max | | V _{CC} = 4.5 V |
| V _{IH} ³ | | 2.7 V min | | V _{CC} = 4.5 V |
| | | 3.3 V min | | V _{CC} = 5.5 V |

1. Measured at 5 sec.
2. 60 sec max duration.
3. V_{CC} ≥ V_{IH} ≥ 0.6 V_{CC}.
4. V_{CC} = +5.0 VDC ±10%

TIMING CHARACTERISTICS WRITE CYCLE WAVEFORMS



| AC CHARACTERISTICS Timing Parameters @ 4.5 V (nanoseconds) | | | | | | |
|---|-----------------|-----------|-----------|-----------------|-----------|-----------|
| Parameter | -20°C Typ | | +25°C Min | | +65°C Typ | |
| | DL-2416 | DL-2416 H | DL-2416 | DL-2416 H | DL-2416 | DL-2416 H |
| T _{AS} | 300 | 200 | 450 | 250 | 600 | 400 |
| T _{WD} | 50 | 50 | 150 | 50 | 175 | 75 |
| T _W | 250 | 150 | 300 | 200 | 475 | 325 |
| T _{DS} | 150 | 100 | 250 | 150 | 350 | 250 |
| T _{DH} | 50 | 50 | 50 | 50 | 100 | 100 |
| T _{AH} | 50 | 50 | 50 | 50 | 100 | 100 |
| T _{CEH} | 50 | 50 | 50 | 50 | 100 | 100 |
| T _{CES} | 300 | 150 | 450 | 250 | 600 | 400 |
| T _{CLR} | 15 milliseconds | | | 16 milliseconds | | |
| | access time | | | | | |
| | 500 ns | | 300 ns | | | |

Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any segment in the display is not visible".

Note 2: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.

Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).

Note 4: **Warning** — Do not use solvents containing alcohol.

Note 5: Access time is defined as T_{AS} + T_{DH} (sum of address set up and data hold times.)

LOADING DATA

Setting the chip enables ($\overline{CE1}$, $\overline{CE2}$) to their true state will enable data loading. The desired data code (D0-D6) and digit address (A_0 , A_1) must be held stable during the write cycle for storing new data.

Data entry may be asynchronous and random. (Digit 0 is defined as right hand digit with $A_1 = A_0 = 0$.)

Clearing of the entire internal four-digit memory can be accomplished by holding the clear (\overline{CLR}) low for one complete display multiplex cycle, 15 mS minimum. Loading an illegal data code will display a blank. Clear (\overline{CLR}) is inactive during \overline{BL} .

LOADING CURSOR

Setting the chip enables ($\overline{CE1}$, $\overline{CE2}$) and cursor select (\overline{CU}) to their true state will enable cursor loading. A write (\overline{WR}) pulse will now store or remove a cursor into the digit location addressed by A_0 , A_1 ; as defined in data entry. A cursor will be stored if $D0 = 1$; and will be removed if $D0 = 0$. Cursor will

not be cleared by the \overline{CLR} signal. The cursor (\overline{CU}) pulse width should not be less than the write (\overline{WR}) pulse or erroneous data may appear in the display.

For those users not requiring the cursor, the cursor enable signal (CUE) may be tied low to disable display of the cursor function. A flashing cursor can be realized by simply pulsing CUE. If cursor has been loaded to any or all positions in the display, then CUE will control whether the cursor(s) or the characters appear. CUE does not affect the contents of cursor memory.

DISPLAY BLANKING

Blanking the display may be accomplished by loading a blank or space into each digit of the display or by using the (\overline{BL}) display blank input.

Setting the (\overline{BL}) input low does not affect the contents of either data or cursor memory. A flashing display can be realized by pulsing (\overline{BL}).

TYPICAL LOADING DATA STATE TABLE

| CONTROL | | | | | | | | ADDRESS | | DATA | | | | | | | | DISPLAY DIGIT | | | |
|-----------------|------------------|------------------|-----|-----------------|-----------------|------------------|---------------------------|---------|---------------------------|------|----|----|----|----|----|---|-------------------|---------------|---|---|--|
| \overline{BL} | $\overline{CE1}$ | $\overline{CE2}$ | CUE | \overline{CU} | \overline{WR} | \overline{CLR} | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 3 | 2 | 1 | 0 | | |
| H | X | X | L | X | H | H | PREVIOUSLY LOADED DISPLAY | | | | | | | | G | R | E | Y | | | |
| H | H | X | L | X | X | H | X | X | X | X | X | X | X | X | X | G | R | E | Y | | |
| H | X | H | L | X | X | H | X | X | X | X | X | X | X | X | X | G | R | E | Y | | |
| H | L | L | L | H | L | H | L | L | H | L | L | L | H | L | H | G | R | E | E | | |
| H | L | L | L | H | L | H | L | H | H | L | H | L | H | L | H | G | R | U | E | | |
| H | L | L | L | H | L | H | H | L | H | L | L | H | H | L | L | G | L | U | E | | |
| H | L | L | L | H | L | H | H | H | H | L | L | L | L | H | L | B | L | U | E | | |
| L | X | X | X | X | H | H | X | X | BLANK DISPLAY | | | | | | | | G | L | U | E | |
| H | L | L | L | H | L | H | H | H | H | L | L | L | H | H | H | G | L | U | E | | |
| H | X | X | L | X | H | L | X | X | CLEARS CHARACTER DISPLAYS | | | | | | | | SEE CHARACTER SET | | | | |
| H | L | L | L | H | L | H | X | X | SEE CHARACTER CODE | | | | | | | | SEE CHARACTER SET | | | | |

X = DON'T CARE

LOADING CURSOR STATE TABLE

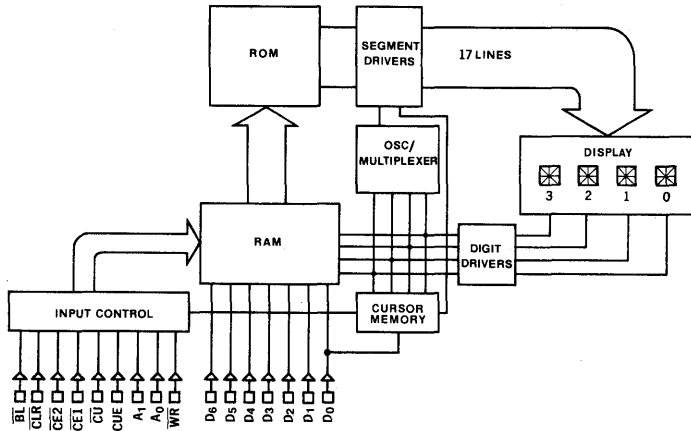
| CONTROL | | | | | | | | ADDRESS | | DATA | | | | | | | | DISPLAY DIGIT | | | |
|-----------------|------------------|------------------|-----|-----------------|-----------------|------------------|-----------------------------------|---------|----|------|----|----|----|----|----|---|---|---------------|---|--|--|
| \overline{BL} | $\overline{CE1}$ | $\overline{CE2}$ | CUE | \overline{CU} | \overline{WR} | \overline{CLR} | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 3 | 2 | 1 | 0 | | |
| H | X | X | L | X | H | H | PREVIOUSLY LOADED DISPLAY | | | | | | | | B | E | A | R | | | |
| H | X | X | H | X | H | H | DISPLAY PREVIOUSLY STORED CURSORS | | | | | | | | B | E | A | R | | | |
| H | L | L | H | L | L | H | L | L | X | X | X | X | X | X | H | B | E | A | ⊗ | | |
| H | L | L | H | L | L | H | L | H | X | X | X | X | X | X | H | B | E | ⊗ | ⊗ | | |
| H | L | L | H | L | L | H | H | L | X | X | X | X | X | X | H | B | ⊗ | ⊗ | ⊗ | | |
| H | L | L | H | L | L | H | H | H | X | X | X | X | X | X | H | ⊗ | ⊗ | ⊗ | ⊗ | | |
| H | L | L | H | L | L | H | H | L | X | X | X | X | X | X | L | ⊗ | E | ⊗ | ⊗ | | |
| H | X | X | L | X | H | H | DISABLE CURSOR DISPLAY | | | | | | | | B | E | A | R | | | |
| H | L | L | L | L | L | H | H | H | X | X | X | X | X | X | L | B | E | A | R | | |
| H | X | X | H | X | H | H | DISPLAY STORED CURSOR | | | | | | | | B | E | ⊗ | ⊗ | | | |

X = DON'T CARE

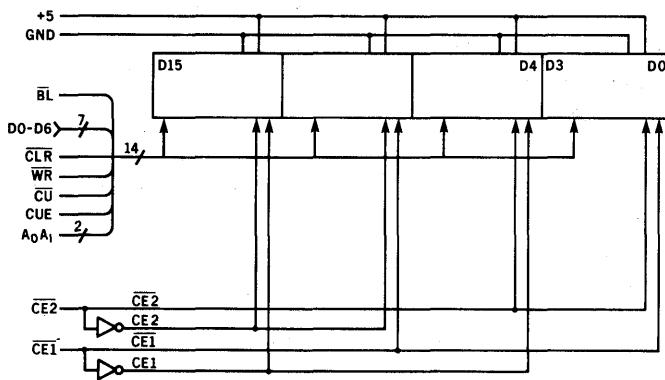
CHARACTER SET

| | | D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | | | |
|----|----|----|-----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| D1 | L | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H | | |
| D2 | L | L | L | L | L | H | H | H | H | L | L | L | L | H | H | H | H | | |
| D3 | L | L | L | L | L | L | L | L | L | H | H | H | H | H | H | H | H | | |
| D6 | D5 | D4 | HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| L | H | L | 2 | | . | " | 8 | 9 | % | & | ' | < | > | * | + | , | - | . | / |
| L | H | H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | : | / | = | \ | ? |
| H | L | L | 4 | a | A | B | C | D | E | F | G | H | I | J | K | L | M | N | O |
| H | L | H | 5 | P | Q | R | S | T | U | V | W | X | Y | Z | [| \ |] | ^ | _ |

All other input codes display "blank"



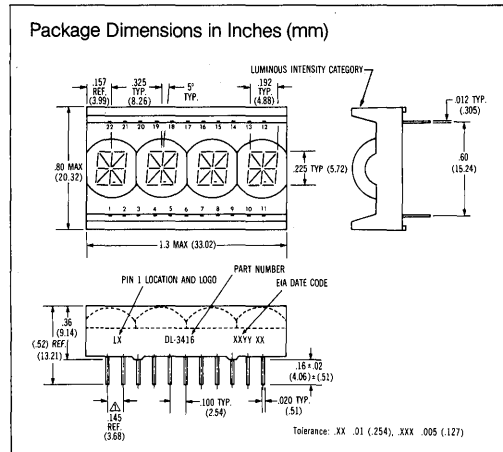
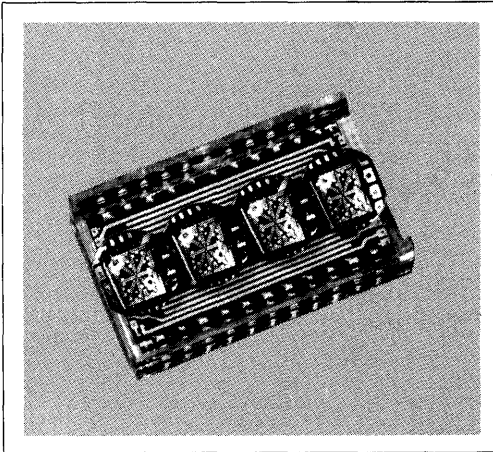
Internal Block Diagram



Typical Schematic for 16 Digit System

SIEMENS

DL-3416, DL-3416 H .225" RED, 4-DIGIT 16-SEGMENT PLUS DECIMAL ALPHANUMERIC Intelligent Display® WITH MEMORY/DECODER/DRIVER



FEATURES

- 225 Mil High, Magnified Monolithic Char.
- Wide Viewing Angle $\pm 40^\circ$
- Close Vertical Row Spacing, 0.8 Inches
- Rugged Solid Plastic Encapsulated Package
- Fast Access Time
 - DL-3416 500 nSEC
 - DL-3416H 300 nSEC
- Full Size Display for Stationary Equipment
- Built-in Memory
- Built-in Character Generator
- Built-in Multiplex and LED Drive Circuitry
- Each Digit Independently Addressed
- TTL Compatible, 5 Volt Power
- Independent Cursor Function
- 17th Segment for Improved Punctuation Marks
- Memory Clear Function
- Display Blank Function
- End Stackable, 4-Character Package
- Intensity Coded for Display Uniformity

DESCRIPTION

The DL 3416 is a four digit display module having 16 segments plus decimal and a built-in CMOS integrated circuit.

The integrated circuit contains memory, ASCII ROM decoder, multiplexing circuitry, and drivers. Data entry is asynchronous and can be random. A display system can be built using any number of DL 3416's since each digit of any DL 3416 can be addressed independently and will continue to display the character last stored until replaced by another.

System interconnection is very straightforward. The least significant two address bits (A_0 , A_1) are normally connected to the like named inputs of all DL 3416's in the system. With four chip enables four DL 3416's (16 characters) can easily be interconnected without a decoder.

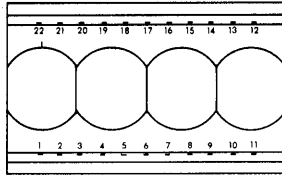
Alternatively, one-of-n decoder IC's can be used to extend the address for large displays.

Data lines are connected to all DL 3416's directly and in parallel, as in the write line (WR). The display will then behave as a write-only memory.

The cursor function causes all segments of a digit position to illuminate. The cursor is *not* a character, however, and upon removal the previously displayed character will reappear.

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays". Since this is a CMOS device, normal precautions should be taken to avoid static damage.

TOP VIEW



Product Identification
Marking on Front Surface

| Pin | Function | Pin | Function |
|-----|--------------------|-----|---------------|
| 1 | CE1 Chip Enable | 12 | Gnd |
| 2 | CE2 Chip Enable | 13 | N/C |
| 3 | CE3 Chip Enable | 14 | BL Blanking |
| 4 | CE4 Chip Enable | 15 | N/C |
| 5 | CLR Clear | 16 | D0 Data Input |
| 6 | VCC | 17 | D1 Data Input |
| 7 | A0 Digit Select | 18 | D2 Data Input |
| 8 | A1 Digit Select | 19 | D3 Data Input |
| 9 | WR Write | 20 | D4 Data Input |
| 10 | CU Cursor Select | 21 | D5 Data Input |
| 11 | CUE Cursor Enables | 22 | D6 Data Input |

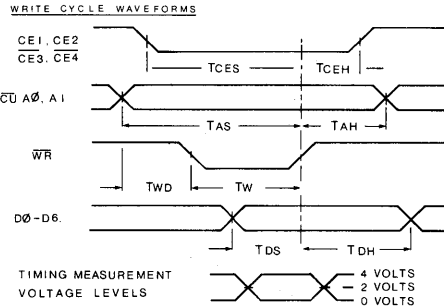
OPTO-ELECTRONIC CHARACTERISTICS @ 25°C

| MAXIMUM RATINGS | OPTICAL CHARACTERISTICS (TYPICAL) |
|--|---|
| Voltage, any pin respect to GND . . . -5 to 6.0 VDC | Luminous Intensity 8 segments/digit @ 5V, 0.5 mcd |
| Operating Temperature -20° to +65°C | Off Axis Viewing Angle (Note 1) ±40° |
| Storage Temperature -20° to +70°C | Digit Size 225 mils |
| Relative Humidity (non condensing) @ 65°C 85% | Spectral Peak Wavelength 660 nm |

| DC CHARACTERISTICS DL-3416 AND DL-3416H | | | | |
|--|-----------|-------------------------|-----------|--|
| Parameter | -20°C Typ | +25°C ⁴ | +65°C Typ | Conditions |
| I _{CC} 4 digits on (10 seg/digit) | 190 mA | 150 mA max ¹ | 120 mA | V _{CC} = 5.0 V |
| I _{CC} Cursor ² | 225 mA | 175 mA max ¹ | 150 mA | V _{CC} = 5.0 V |
| I _{CC} Blank | | 19 mA max | | V _{IN} = 0 V _{CC} = 5.0 V WR = 5.0 V |
| I _{IL} | 225 μA | 160 μA max | 150 μA | V _{IN} = .8 V V _{CC} = 5.0 V |
| V _{IL} | | .8 V max | | V _{CC} = 4.5 V |
| V _{IH} ³ | | 2.7 V min | | V _{CC} = 4.5 V |
| | | 3.3 V min | | V _{CC} = 5.5 V |

1. Measured at 5 sec.
2. 60 sec max duration.
3. V_{CC} ≥ V_{IH} ≥ 0.6 V_{CC}.
4. V_{CC} = +5.0 VDC ±10%

TIMING CHARACTERISTICS



| AC CHARACTERISTICS Timing Parameters @ 4.5 V (nanoseconds) | | | | | | |
|---|-----------|----------|-----------------|----------|-----------|----------|
| Parameter | -20°C Typ | | +25°C Min | | +65°C Typ | |
| | DL-3416 | DL-3416H | DL-3416 | DL-3416H | DL-3416 | DL-3416H |
| TAS | 300 | 200 | 450 | 250 | 600 | 400 |
| TWD | 50 | 50 | 150 | 50 | 175 | 75 |
| TW | 250 | 150 | 300 | 200 | 425 | 325 |
| TDS | 150 | 100 | 250 | 150 | 350 | 250 |
| TDH | 50 | 50 | 50 | 50 | 100 | 100 |
| TAH | 50 | 50 | 50 | 50 | 100 | 100 |
| TCEH | 50 | 50 | 50 | 50 | 100 | 100 |
| TCEs | 300 | 150 | 450 | 250 | 600 | 400 |
| TCLR | | | 15 milliseconds | | | |
| | | | access time | | | |
| | | | 500 ns | 300 ns | | |

- Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any segment in the display is not visible".
- Note 2: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.
- Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).
- Note 4: **Warning** – Do not use solvents containing alcohol.
- Note 5: Access time is defined as T_{AS} + T_{DH} (sum of address set up and data hold times).

LOADING DATA

Setting the chip enables (CE1, CE2, $\overline{CE3}$, $\overline{CE4}$) to their true state will enable data loading. The desired data code (D0-D6) and digit address (A₀, A₁) should be held stable during the write cycle for storing new data.

Data entry may be asynchronous and random. (Digit 0 is defined as right hand digit with A₁ = A₀ = 0.)

Clearing of the entire internal four-digit memory can be accomplished by holding the clear (CLR) low for one complete display multiplex cycle, 15 mS minimum.

LOADING CURSOR

Setting the chip enables (CE1, CE2, $\overline{CE3}$, $\overline{CE4}$) and cursor select (\overline{CU}) to their true state will enable cursor loading. A write (\overline{WR}) pulse will now store or remove a cursor into the digit location addressed by A₀, A₁; as defined in data entry. A cursor will be stored if D0 = 1; and will be removed if D0 = 0. Cursor will not be cleared by the CLR signal. The

cursor (\overline{CU}) pulse width should not be less than the write pulse (\overline{WR}) width or erroneous data may appear in the display.

For those users not requiring the cursor, the cursor enable signal (CUE) may be tied low to disable display of the cursor function. A flashing cursor can be realized by simply pulsing CUE. If cursor has been loaded to any or all positions in the display, then CUE will control whether the cursor(s) or the characters appear. CUE does not affect the contents of cursor memory.

DISPLAY BLANKING

Blanking the display may be accomplished by loading a blank or space into each digit of the display or by using the (\overline{BL}) display blank input.

Setting the (\overline{BL}) input low does not affect the contents of either data or cursor memory. A flashing display can be realized by pulsing (\overline{BL}).

TYPICAL LOADING DATA STATE TABLE

| \overline{BL} | CE1 | CE2 | $\overline{CE3}$ | $\overline{CE4}$ | CUE | \overline{CU} | \overline{WR} | CLR | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | DIGIT | | | | | | | | |
|-----------------|-----|-----|------------------|------------------|-----|-----------------|-----------------|-----|----|----|---------------------------|----|----|----|----|----|----|-------|---|---|---|---|--|--|--|--|
| | | | | | | | | | | | | | | | | | | 3 | 2 | 1 | 0 | | | | | |
| H | X | X | X | X | L | X | H | H | | | PREVIOUSLY LOADED DISPLAY | | | | | | | G | R | E | Y | | | | | |
| H | L | X | X | X | L | X | X | H | X | X | X | X | X | X | X | X | X | X | G | R | E | Y | | | | |
| H | X | L | X | X | L | X | X | H | X | X | X | X | X | X | X | X | X | X | G | R | E | Y | | | | |
| H | X | X | H | X | L | X | X | H | X | X | X | X | X | X | X | X | X | X | G | R | E | Y | | | | |
| H | X | X | X | H | L | X | X | H | X | X | X | X | X | X | X | X | X | X | G | R | E | Y | | | | |
| H | X | X | X | X | L | X | H | H | X | X | X | X | X | X | X | X | X | X | G | R | E | Y | | | | |
| H | H | H | L | L | L | H | L | H | L | L | H | L | L | L | H | L | H | L | G | R | E | E | | | | |
| H | H | H | L | L | L | H | L | H | L | H | L | H | L | H | L | H | L | H | G | R | U | E | | | | |
| H | H | H | L | L | L | H | L | H | H | L | L | L | L | H | H | L | L | L | G | L | U | E | | | | |
| H | H | H | L | L | L | H | L | H | H | H | L | L | L | L | H | L | L | L | B | L | U | E | | | | |
| L | X | X | X | X | X | X | H | H | X | X | BLANK DISPLAY | | | | | | | | | | | | | | | |
| H | H | H | L | L | L | H | L | H | H | H | H | L | L | L | L | H | H | H | G | L | U | E | | | | |
| H | X | X | X | X | L | X | X | L | | | CLEARS CHARACTER DISPLAY | | | | | | | | | | | | | | | |
| H | H | H | L | L | L | H | L | H | X | X | SEE CHARACTER CODE | | | | | | | | | | | | | | | |

X = DON'T CARE

LOADING CURSOR STATE TABLE

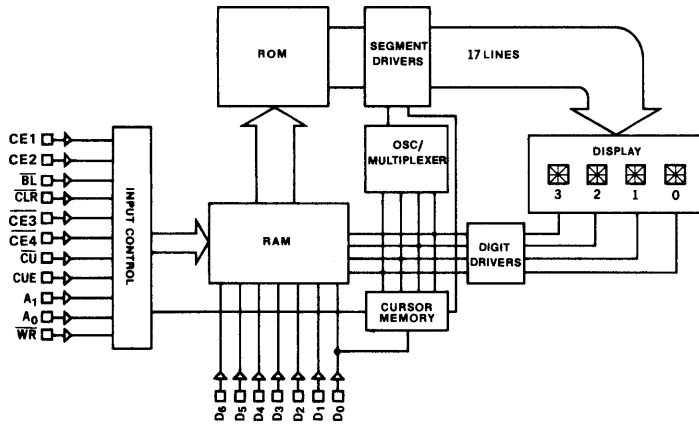
| \overline{BL} | CE1 | CE2 | $\overline{CE3}$ | $\overline{CE4}$ | CUE | \overline{CU} | \overline{WR} | CLR | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | DIGIT | | | | |
|-----------------|-----|-----|------------------|------------------|-----|-----------------|-----------------|-----|----|----|-----------------------------------|----|----|----|----|----|----|-------|---|---|---|---|
| | | | | | | | | | | | | | | | | | | 3 | 2 | 1 | 0 | |
| H | X | X | X | X | L | X | H | H | | | PREVIOUSLY LOADED DISPLAY | | | | | | | B | E | A | R | |
| H | X | X | X | X | H | X | H | H | | | DISPLAY PREVIOUSLY STORED CURSORS | | | | | | | B | E | A | R | |
| H | H | H | L | L | L | L | L | H | L | L | X | X | X | X | X | X | H | H | B | E | A | R |
| H | H | H | L | L | L | L | L | H | L | H | X | X | X | X | X | X | H | H | B | E | A | R |
| H | H | H | L | L | L | L | L | H | H | H | X | X | X | X | X | X | H | H | B | E | A | R |
| H | H | H | L | L | L | L | L | H | H | L | X | X | X | X | X | X | L | H | B | E | A | R |
| H | X | X | X | X | L | X | H | H | | | DISABLE CURSOR DISPLAY | | | | | | | B | E | A | R | |
| H | H | H | L | L | L | L | L | H | H | H | X | X | X | X | X | X | L | L | B | E | A | R |
| H | X | X | X | X | H | X | H | H | | | DISPLAY STORED CURSORS | | | | | | | B | E | A | R | |

X = DON'T CARE

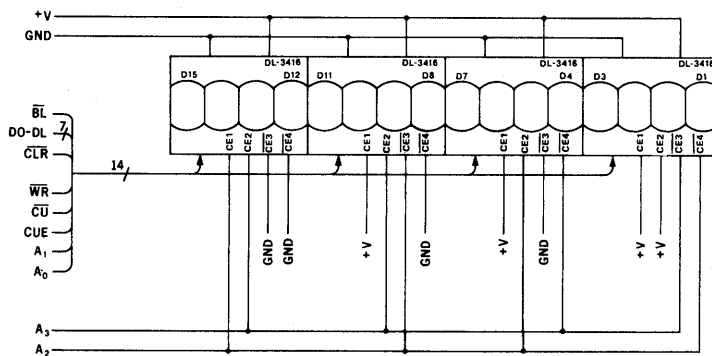
CHARACTER SET

| | | | | | | | | | | | | | | | | | |
|----------|-----|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|
| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | |
| D1 | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H | |
| D2 | L | L | L | L | H | H | H | H | L | L | L | L | H | H | H | H | |
| D3 | L | L | L | L | L | L | L | H | H | H | H | H | H | H | H | H | |
| D6 D5 D4 | HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| L H L | 2 | | ! | " | # | \$ | % | & | ' | < | > | * | + | , | - | . | / |
| L H H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? |
| H L L | 4 | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | |
| H L H | 5 | p | q | r | s | t | u | v | w | x | y | z | [| \ |] | ^ | _ |

ALL OTHER CODES DISPLAY BLANK



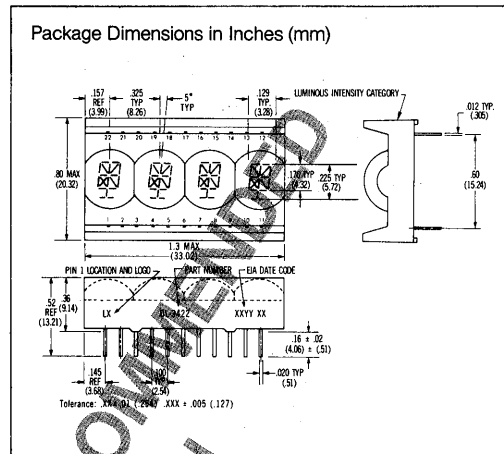
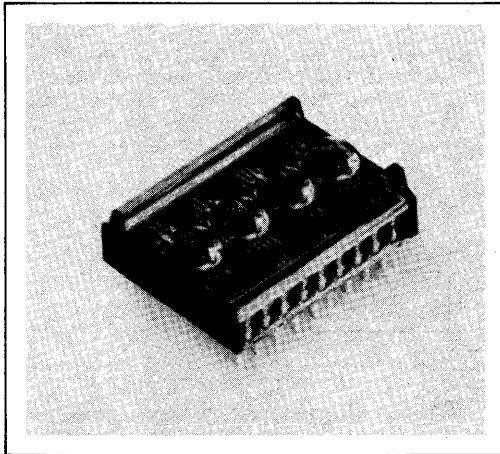
Internal Block Diagram



Typical Schematic for 16 Digits

SIEMENS

.170"/.100" (Nom.) UPPER AND LOWER CASE 4-DIGIT 22-SEGMENT ALPHANUMERIC Intelligent Display® WITH MEMORY/DECODER/DRIVER



FEATURES

- 170Mil/100Mil (Nom.) Upper & Lower Case Letters
- Wide Viewing Angle $\pm 40^\circ$
- Close Vertical Row Spacing, .800 Inches
- Rugged Solid Plastic Encapsulated Package
- Fast Access Time, 500 nSEC
- Full Size Display for Stationary Equipment
- Built-in Memory
- Built-in Character Generator
- Built-in Multiplex and LED Drive Circuitry
- Direct Access to Each Digit Independently & Asynchronously
- TTL Compatible, 5 Volt Power
- Independent Cursor Function
- 22 Segment for 96 Character ASCII Format Upper & Lower Case Letters
- Memory Clear Function
- Display Blank Function

DESCRIPTION

The DL 3422 is a four digit display module having 22 segments and a built-in CMOS integrated circuit.

The integrated circuit contains memory, ASCII ROM decoder, multiplexing circuitry, and drivers. Data entry is asynchronous and can be random. A display system can be built using any number of DL 3422's since each digit of any DL 3422 can be addressed independently and will continue to display the character last stored until replaced by another.

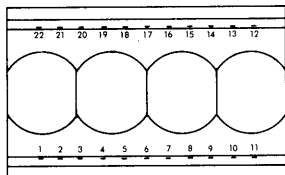
System interconnection is very straightforward. The least significant two address bits (A_0 , A_1) are normally connected to the like named inputs of all DL 3422's in the system. With two chip enables (CE_1 , and CE_2) four DL 3422's (16 characters) can easily be interconnected without a decoder.

Alternatively, one-of-n decoder IC's can be used to extend the address for large displays.

Data lines are connected to all DL 3422's directly and in parallel, as is the write line (WR). The display will then behave as a write-only memory.

The cursor function causes all segments of a digit position to illuminate. The cursor is *not* a character, however, and upon removal the previously displayed character will reappear.

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays". Since this is a CMOS device, normal precautions should be taken to avoid static damage.



| Pin | Function | Pin | Function |
|-----|-------------------|-----|---------------|
| 1 | CE1 Chip Enable | 12 | Gnd |
| 2 | N/C | 13 | N/C |
| 3 | CE2 Chip Enable | 14 | BL Blanking |
| 4 | N/C | 15 | N/C |
| 5 | CLR Clear | 16 | D0 Data Input |
| 6 | VCC | 17 | D1 Data Input |
| 7 | A0 Digit Select | 18 | D2 Data Input |
| 8 | A1 Digit Select | 19 | D3 Data Input |
| 9 | WR Write | 20 | D4 Data Input |
| 10 | CU Cursor Select | 21 | D5 Data Input |
| 11 | CUE Cursor Enable | 22 | D6 Data Input |

OPTO-ELECTRONIC CHARACTERISTICS @ 25°C

MAXIMUM RATINGS

Voltage, any pin respect to GND . . . -5 to 6.0 VDC
 Operating Temperature -20° to +65° C
 Storage Temperature -20° to +70° C
 Relative Humidity
 (non condensing) @ 65° C 85%

OPTICAL CHARACTERISTICS

Luminous Intensity 8 Segments @ 5 V . . . 0.5mcd
 Off Axis Viewing Angle (Note 1) ±50°
 Digit Size 160 mils
 Spectral Peak Wavelength 660 nm

DC CHARACTERISTICS

| Parameter | -20°C Typ | +25°C ⁴ | +65°C Typ | Conditions |
|---|-----------|-------------------------|-----------|--|
| I _{CC} 4 digits on (10 seg/digit) | 135 mA | 125 mA max ¹ | 100 mA | V _{CC} = 5.0 V |
| I _{CC} 4 digits or Cursor ² | 160 mA | 140 mA max ¹ | 120 mA | V _{CC} = 5.0 V |
| I _{CC} Blank | | 3.7 mA max | | V _{IN} = 0 V _{CC} = 5.0 V WR = 5.0 V |
| I _{IL} | 200 μA | 160 μA max | 100 μA | V _{IN} = .8 V V _{CC} = 5.0 V |
| V _{IL} | | .8 V max | | V _{CC} = 4.5 V |
| V _{IH} ³ | | 2.7 V min | | V _{CC} = 4.5 V |
| | | 3.3 V min | | V _{CC} = 5.5 V |

1. Measured at 5 sec.
2. 60 sec max duration.
3. V_{CC} ≥ V_{IH} ≥ 0.6 V_{CC}.
4. V_{CC} = +5.0 VDC ±10%

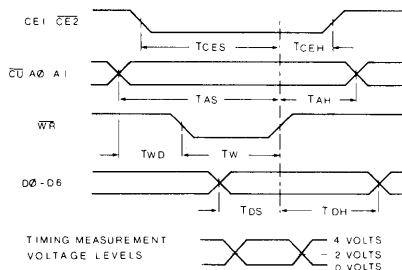
AC CHARACTERISTICS

Timing Parameter @ 4.5 V (nanoseconds)

| | -20°C Typ | +25°C Min | +65°C Typ |
|------------------|-----------|-----------------|-----------|
| T _{AS} | 300 | 450 | 600 |
| T _{WD} | 50 | 150 | 175 |
| T _W | 250 | 300 | 425 |
| T _{DS} | 150 | 250 | 350 |
| T _{DH} | 50 | 50 | 100 |
| T _{AH} | 50 | 50 | 100 |
| T _{CEH} | 50 | 50 | 100 |
| T _{CES} | 300 | 450 | 600 |
| T _{CLR} | | 15 milliseconds | |

TIMING CHARACTERISTICS

Write Cycle Waveforms



Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of the segment in the display is not visible".

Note 2: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.

Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).

Note 4: **Warning** – Do not use solvents containing alcohol.

LOADING DATA

Setting the chip enables (CE1, $\overline{CE2}$) to their true state will enable data loading. The desired data code (D0-D6) and digit address (A0, A1) should be held stable during the write cycle for storing new data.

Data entry may be asynchronous and random. (Digit 0 is defined as right hand digit with A1 = A0 = 0.)

Clearing of the entire internal four-digit memory can be accomplished by holding the clear (CLR) low for one complete display multiplex cycle, 15 mS minimum. Clear (CLR) is inactive during BL.

LOADING CURSOR

Setting the chip enables (CE1, $\overline{CE2}$) and cursor select (\overline{CU}) to their true state will enable cursor loading. A write (WR) pulse will now store or remove a cursor into the digit location addressed by A0, A1; as defined in data entry. A cursor will be stored if DO = 1; and will be removed if DO = 0. Cursor will

not be cleared by the \overline{CLR} signal.

For those users not requiring the cursor, the cursor enable signal (CUE) may be tied low to disable display of the cursor function. A flashing cursor can be realized by simply pulsing CUE. If cursor has been loaded to any or all positions in the display, then CUE will control whether the cursor(s) or the characters appear. CUE does not affect the contents of cursor memory.

DISPLAY BLANKING

Blanking the display may be accomplished by loading a blank or space into each digit of the display or by using the (BL) display blank input.

Setting the (\overline{BL}) input low does not affect the contents of either data or cursor memory. A flashing display can be realized by pulsing (BL).

TYPICAL LOADING DATA STATE TABLE

| \overline{BL} | CE1 | $\overline{CE2}$ | CUE | \overline{CU} | WR | CLR | DIGIT | | | | | | | | | | | | |
|-----------------|-----|------------------|-----|-----------------|----|-----|---------------------------|----|--------------------|----|----|----|----|----|-------------------|---|---|---|---|
| | | | | | | | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 3 | 2 | 1 | 0 |
| H | X | X | L | X | H | H | PREVIOUSLY LOADED DISPLAY | | | | | | | | G | R | E | Y | |
| H | L | X | L | X | X | H | X | X | X | X | X | X | X | X | X | G | R | E | Y |
| H | X | X | L | X | X | H | X | X | X | X | X | X | X | X | X | G | R | E | Y |
| H | X | H | L | X | X | H | X | X | X | X | X | X | X | X | X | G | R | E | Y |
| H | X | X | L | X | X | H | X | X | X | X | X | X | X | X | X | G | R | E | Y |
| H | X | X | L | X | H | H | X | X | X | X | X | X | X | X | X | G | R | E | Y |
| H | H | L | L | H | L | H | L | L | H | L | L | H | L | H | L | G | R | E | Y |
| H | H | L | L | H | L | H | L | H | H | L | H | L | H | L | H | G | R | U | E |
| H | H | L | L | H | L | H | H | L | H | L | L | H | H | L | L | G | L | U | E |
| H | H | L | L | H | L | H | H | H | H | L | L | L | L | L | L | B | L | U | E |
| O | X | X | X | X | H | H | BLANK DISPLAY | | | | | | | | G | L | U | E | |
| H | H | L | L | H | L | H | H | H | L | L | L | L | H | H | H | G | L | U | E |
| H | X | X | L | X | X | L | CLEARS CHARACTER DISPLAY | | | | | | | | G | L | U | E | |
| H | H | L | L | H | L | H | X | X | SEE CHARACTER CODE | | | | | | SEE CHARACTER SET | | | | |

X = DON'T CARE

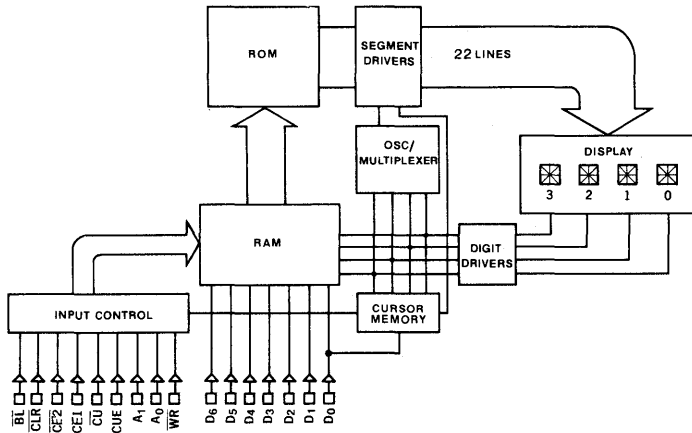
LOADING CURSOR STATE TABLE

| \overline{BL} | CE1 | $\overline{CE2}$ | CUE | \overline{CU} | WR | CLR | DIGIT | | | | | | | | | | | | |
|-----------------|-----|------------------|-----|-----------------|----|-----|-----------------------------------|----|----|----|----|----|----|----|----|---|---|---|---|
| | | | | | | | A1 | A0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 3 | 2 | 1 | 0 |
| H | X | X | L | X | H | H | PREVIOUSLY LOADED DISPLAY | | | | | | | | B | E | A | R | |
| H | X | X | H | X | H | H | DISPLAY PREVIOUSLY STORED CURSORS | | | | | | | | B | E | A | R | |
| H | H | L | H | L | L | H | L | L | X | X | X | X | X | X | H | B | E | A | R |
| H | H | L | H | L | L | H | L | H | X | X | X | X | X | X | H | B | E | A | R |
| H | H | L | H | L | L | H | H | L | X | X | X | X | X | X | H | B | E | A | R |
| H | H | L | H | L | L | H | H | H | X | X | X | X | X | X | H | B | E | A | R |
| H | H | L | H | L | L | H | H | L | X | X | X | X | X | X | L | B | E | A | R |
| H | X | X | L | X | H | H | DISABLE CURSOR DISPLAY | | | | | | | | B | E | A | R | |
| H | H | L | L | L | L | H | H | H | X | X | X | X | X | X | L | B | E | A | R |
| H | X | X | H | X | H | H | DISPLAY STORED CURSORS | | | | | | | | B | E | A | R | |

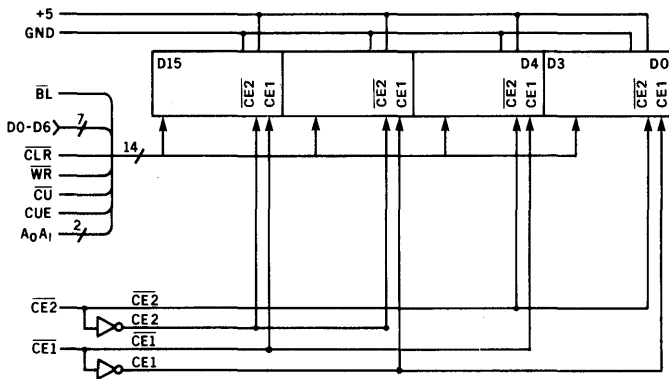
X = DON'T CARE

CHARACTER SET

| | | | | | | | | | | | | | | | | | | | | |
|----------|-----|---|---|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|---|
| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | | | | |
| D1 | L | L | H | H | L | L | H | H | L | L | L | H | H | L | L | H | | | | |
| D2 | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | | | | |
| D3 | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | | | | |
| D6,D5,D4 | hex | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F | | | |
| L | H | L | 2 | | ! | " | # | \$ | % | & | ' | (|) | * | + | , | - | . | / | |
| L | H | H | 3 | | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? |
| H | L | L | 4 | | W | A | B | C | D | E | F | G | H | I | J | K | L | M | N | O |
| H | L | H | 5 | | P | Q | R | S | T | U | V | W | X | Y | Z | [| \ |] | ^ | _ |
| H | H | L | 6 | | \ | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o |
| H | H | H | 7 | | p | q | r | s | t | u | v | w | x | y | z | { | | } | ~ | |



Internal Block Diagram



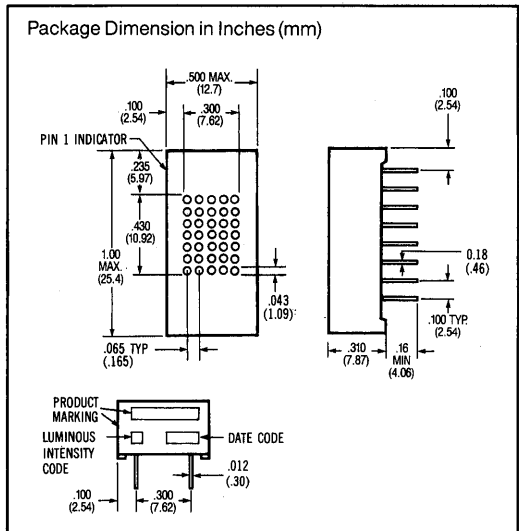
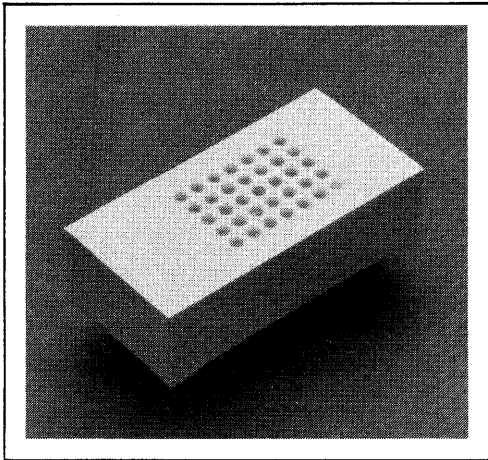
Typical Schematic for 16 Digit System

SIEMENS

DLO-4135 ORANGE

DLG-4137 GREEN

.43" SINGLE CHARACTER 5 x 7 DOT MATRIX Intelligent Display® WITH MEMORY/DECODER/DRIVER PRELIMINARY



FEATURES

- .43" High, Hybrid Character
- Wide Viewing Angle, $\pm 50^\circ$
- Fully Encapsulated, Rugged Solid Plastic Package
- Built-In Memory
- Built-In Character Generator
- Built-In Multiplex and LED Drive Circuitry
- Built-In Lamp Test
- Intensity Control (4 levels)
- 96 Character ASCII Format
- Microprocessor Buss Compatible
- Intensity Coded for Display Uniformity
- Single 5-volt power supply required
- X/Y stackable
- Available in High efficiency red (orange) and green

DESCRIPTION

The DLX-4135/4137 are single digit 5×7 dot matrix Intelligent Displays with .43" character height. The built-in CMOS integrated circuit contains memory, ASCII character generator, LED multiplexing and drive circuitry; thereby eliminating the need for additional circuitry. They will display the 96 ASCII characters.

These devices are TTL and microprocessor compatible and offer the possibility of cascading the displays, allowing for multi-character messages. These displays were designed for viewing distances of up to 20 feet. They require a single 5-volt power supply and parallel ASCII input.

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays". Since this is a CMOS device, normal precautions should be taken to avoid static damage.

OPTOELECTRONIC CHARACTERISTICS @ 25°C

Maximum Ratings

Voltage, Any Pin
 Respect to GND - 0.5 to + 6.0 VDC
 Operating Temperature - 20°C to 65°C
 Storage Temperature - 20°C to 70°C
 Relative Humidity @ 65°C
 (non-condensing) 85%

Optical Characteristics (Typical)

Luminous Intensity/Dot (Average) @ 5V
 DLO-4135 500 μ cd
 DLG-4137 500 μ cd
 Digit Size 0.43"
 Viewing Angle (Note 1) \pm 50°
 Spectral Peak Wavelength
 DLO-4135 640 nm
 DLG-4137 565 nm

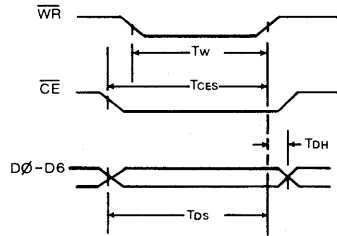
ELECTRICAL PARAMETERS

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|-------------------------|---|------|------|------|---------|
| $I_{CC}(\text{Blank})$ | $\overline{BL0} = \overline{BL1} = 0, V_{CC} = 5V$ | | 4.5 | 8 | mA |
| I_{CC} | $\overline{BL0} = \overline{BL1} = 1, V_{CC} = 5V$ | | 160 | 200 | mA |
| I_{CC} | $\overline{BL0} = 0, \overline{BL1} = 1, V_{CC} = 5V$ | | 80 | | mA |
| I_{CC} | $\overline{BL0} = 1, \overline{BL1} = 0, V_{CC} = 5V$ | | 40 | | mA |
| I_{IL} (any input) | $V_{IN} = 0.8V, V_{CC} = 5V$ | | | 160 | μ A |
| V_{IL} (Any input) | $V_{CC} = 5V$ | | | 1 | V |
| V_{IH} (Any input) | $V_{CC} = 5V$ | 3.0 | | | V |

AC CHARACTERISTICS @ $V_{CC} = 4.5V$

| Parameter | Min @ + 25°C | Units |
|-----------|-----------------|-------|
| T_W | 200 | ns |
| T_{CES} | 200 | ns |
| T_{DS} | 200 | ns |
| T_{DH} | 100 | ns |

TIMING CHARACTERISTICS



Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any dot in the display is not visible."

Note 2: **This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields. SEE APPNOTE 18.**

Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or GND).

Note 4: $V_{CC} = 5.0 \text{ VDC} \pm 10\%$.

Note 5: Clean only in water, isopropyl alcohol, freon TF, or TE (or equivalent)

LOADING DATA

Loading data into the DLX-4135/4137 is straightforward. Chip enable (\overline{CE}) should be present and stable during a write pulse (\overline{WR}). Parallel data information should be stable for the minimum time (T_{W}) and held for T_{DH} after write has gone high. No synchronization is necessary and each character will continue to be displayed until it is replaced with another. Multiple displays may be stacked together with only an additional decoder IC for chip enable decoding.

Note 6: Either $\overline{BL0}$ or $\overline{BL1}$ should be held high for display to light up.

LAMP TEST

The lamp test (\overline{LT}) when activated causes all dots on the display to be illuminated at half brightness. The lamp test function is independent of write (\overline{WR}) and the settings of the blanking inputs ($\overline{BL0}$, $\overline{BL1}$).

This convenient test gives a visual indication that all dots are functioning properly. Lamp test may also be used as a cursor function or pointer which does not destroy previously displayed characters.

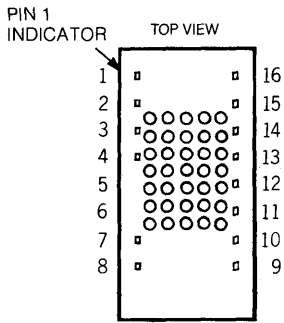
DIMMING AND BLANKING THE DISPLAY

| Brightness Level | $\overline{BL1}$ | $\overline{BL0}$ |
|------------------|------------------|------------------|
| Blank | 0 | 0 |
| ¼ Brightness | 0 | 1 |
| ½ Brightness | 1 | 0 |
| Full Brightness | 1 | 1 |

DATA LOADING EXAMPLE

| \overline{CE} | \overline{WR} | $\overline{BL0}$ | $\overline{BL1}$ | \overline{LT} | DATA INPUT | | | | | | | | |
|-----------------|-----------------|------------------|------------------|-----------------|------------|----|----|----|----|----|----|---|----------|
| | | | | | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | |
| H | X | H | X | H | X | X | X | X | X | X | X | X | NC |
| X | X | L | L | H | X | X | X | X | X | X | X | X | BLANK |
| X | X | X | X | L | X | X | X | X | X | X | X | X | LMP TEST |
| L | L | X | H | H | H | L | X | L | L | L | H | H | A |
| L | L | H | H | H | H | H | H | L | L | H | L | L | r |
| L | L | H | H | H | L | H | H | L | L | H | H | H | 3 |
| L | L | H | H | H | L | H | L | H | L | H | H | H | + |

X = Don't Care

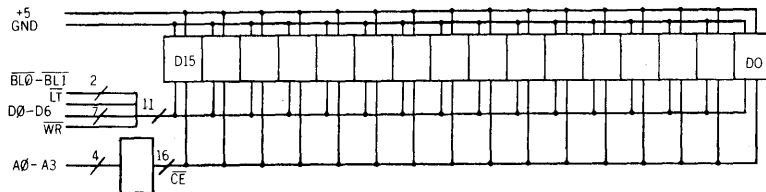


| DL-4135 PIN FUNCTIONS | | | |
|-----------------------|-----------------------------|-----|-------------|
| PIN | FUNCTION | PIN | FUNCTION |
| 1 | \overline{LT} LAMP TEST | 9 | D0 DATA LSB |
| 2 | \overline{WR} WRITE | 10 | D1 DATA |
| 3 | $\overline{BL1}$ BRIGHTNESS | 11 | D2 DATA |
| 4 | $\overline{BL0}$ BRIGHTNESS | 12 | D3 DATA |
| 5 | NO PIN | 13 | D4 DATA |
| 6 | NO PIN | 14 | D5 DATA |
| 7 | \overline{CE} CHIP ENABLE | 15 | D6 DATA MSB |
| 8 | GND | 16 | + VCC |

CHARACTER SET

| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H |
|--------------|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| D1 | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H |
| D2 | L | L | L | L | H | H | H | H | L | L | L | L | H | H | H | H |
| D3 | L | L | L | L | L | L | L | L | H | H | H | H | H | H | H | H |
| D6 D5 D4 HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| L L L 0 | | | | | | | | | | | | | | | | |
| L L H 1 | | | | | | | | | | | | | | | | |
| L H L 2 | : | : | : | : | : | : | : | : | : | : | : | : | : | : | : | : |
| L H H 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| H L L 4 | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | |
| H L H 5 | P | Q | R | S | T | U | V | W | X | Y | Z | [|] | ^ | _ | |
| H H L 6 | · | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o |
| H H H 7 | P | Q | R | S | T | U | V | W | X | Y | Z | [|] | ^ | _ | · |

16 Digits Interconnection



OPTOELECTRONIC CHARACTERISTICS @25°C

Maximum Ratings

| | |
|--------------------------|--------------------|
| Voltage, Any Pin | |
| Respect to GND | - 0.5 to + 6.0 VDC |
| Operating Temperature | - 20°C to 65°C |
| Storage Temperature | - 20°C to 70°C |
| Relative Humidity @ 65°C | |
| (non-condensing) | 85% |

Optical Characteristics (Typical)

| | |
|--------------------------------------|----------------|
| Luminous Intensity/Dot (Average) @5V | |
| DLO-7135 | 500 μ cd |
| DLG-7137 | 500 μ cd |
| Digit Size | 0.68" |
| Viewing Angle (Note 1) | $\pm 50^\circ$ |
| Spectral Peak Wavelength | |
| DLO-7135 | 640 nm |
| DLG-7137 | 565 nm |

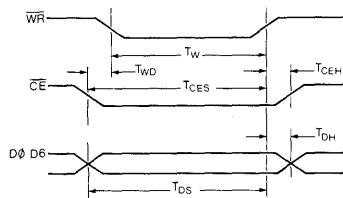
ELECTRICAL PARAMETERS

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|-------------------------|---|------|------|------|---------|
| $I_{CC}(\text{Blank})$ | $\overline{BL0} = \overline{BL1} = 0, V_{CC} = 5V$ | | 4.5 | 8 | mA |
| I_{CC} | $\overline{BL0} = \overline{BL1} = 1, V_{CC} = 5V$ | | 160 | 200 | mA |
| I_{CC} | $\overline{BL0} = 0, \overline{BL1} = 1, V_{CC} = 5V$ | | 80 | | mA |
| I_{CC} | $\overline{BL0} = 1, \overline{BL1} = 0, V_{CC} = 5V$ | | 40 | | mA |
| I_{IL} (any input) | $V_{IN} = 0.8V, V_{CC} = 5V$ | | | 160 | μ A |
| V_{IL} (Any input) | $V_{CC} = 5V$ | | | 1 | V |
| V_{IH} (Any input) | $V_{CC} = 5V$ | 3.0 | | | V |

TIMING PARAMETERS @25°C $V_{CC} = 4.5V$

| Symbol | Parameter | Min. | Units |
|-----------|--------------------|------|-------|
| T_{CES} | CHIP ENABLE SET-UP | 200 | nS |
| T_{DS} | DATA SET-UP | 200 | nS |
| T_W | WRITE PULSE | 200 | nS |
| T_{DH} | DATA HOLD | 100 | nS |
| T_{WD} | WRITE DELAY | 20 | nS |
| T_{CEH} | CHIP ENABLE HOLD | 100 | nS |

TIMING CHARACTERISTICS



Note 1: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any dot in the display is not visible."

Note 2: **This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields. SEE APPNOTE 18.**

Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V+ or GND).

Note 4: $V_{CC} = 5.0VDC \pm 10\%$.

Note 5: Clean only in water, isopropyl alcohol, freon TF, or TE (or equivalent)

LOADING DATA

Loading data into the DLX7135/7137 is straightforward. Chip enable (\overline{CE}) should be present and stable during a write pulse (\overline{WR}). Parallel data information should be stable for the minimum time (T_W) and held for T_{DH} after write has gone high. No synchronization is necessary and each character will continue to be displayed until it is replaced with another. Multiple displays may be stacked together with only an additional decoder IC for chip enable decoding.

Note 6: Either $\overline{BL0}$ or $\overline{BL1}$ should be held high for display to light up.

LAMP TEST

The lamp test (\overline{LT}) when activated causes all dots on the display to be illuminated at half brightness. The lamp test function is independent of write (\overline{WR}) and the settings of the blanking inputs ($\overline{BL0}$, $\overline{BL1}$).

This convenient test gives a visual indication that all dots are functioning properly. Lamp test may also be used as a cursor function or pointer which does not destroy previously displayed characters.

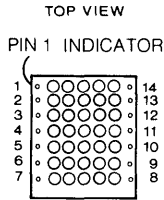
DIMMING AND BLANKING THE DISPLAY

| Brightness Level | $\overline{BL1}$ | $\overline{BL0}$ |
|------------------|------------------|------------------|
| Blank | 0 | 0 |
| ¼ Brightness | 0 | 1 |
| ½ Brightness | 1 | 0 |
| Full Brightness | 1 | 1 |

DATA LOADING EXAMPLE

| \overline{CE} | \overline{WR} | $\overline{BL0}$ | $\overline{BL1}$ | \overline{LT} | DATA INPUT | | | | | | | | |
|-----------------|-----------------|------------------|------------------|-----------------|------------|----|----|----|----|----|----|---|----------|
| | | | | | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | |
| H | X | H | X | H | X | X | X | X | X | X | X | X | NC |
| X | X | L | L | H | X | X | X | X | X | X | X | X | BLANK |
| X | X | X | X | L | X | X | X | X | X | X | X | X | LMP TEST |
| L | L | X | H | H | H | L | X | L | L | L | L | H | A |
| L | L | H | H | H | H | H | H | L | L | H | L | L | r |
| L | L | H | H | H | L | H | H | L | L | H | H | H | 3 |
| L | L | H | H | H | L | H | L | H | L | H | H | H | + |

X = DONT CARE

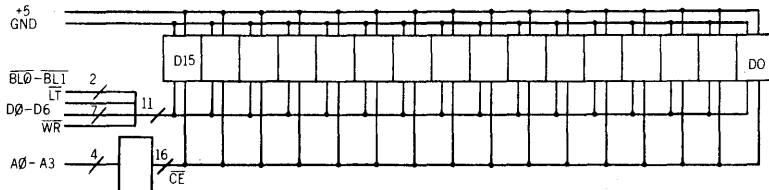


| Pin | Function | Pin | Function |
|-----|-----------------------------|-----|-------------------|
| 1 | VCC | 14 | D6 Data input MSB |
| 2 | \overline{LT} Lamp test | 13 | D5 Data input |
| 3 | \overline{CE} Chip enable | 12 | D4 Data input |
| 4 | \overline{WR} Write | 11 | D3 Data input |
| 5 | \overline{BLI} Brightness | 10 | D2 Data input |
| 6 | \overline{BLO} Brightness | 9 | D1 Data input |
| 7 | GND | 8 | D0 Data input LSB |

CHARACTER SET

| D6 | D5 | D4 | HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
|----|----|----|-----|---|----|---|----|---|---|---|---|---|---|---|---|---|---|---|---|
| L | L | L | 0 | | | | | | | | | | | | | | | | |
| L | L | H | 1 | | | | | | | | | | | | | | | | |
| L | H | L | 2 | ! | :" | # | \$ | % | & | ' | (|) | * | + | , | - | . | / | |
| L | H | H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? |
| H | L | L | 4 | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | |
| H | L | H | 5 | p | q | r | s | t | u | v | w | x | y | z | [| \ |] | ^ | _ |
| H | H | L | 6 | | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o |
| H | H | H | 7 | p | q | r | s | t | u | v | w | x | y | z | { | | } | ~ | |

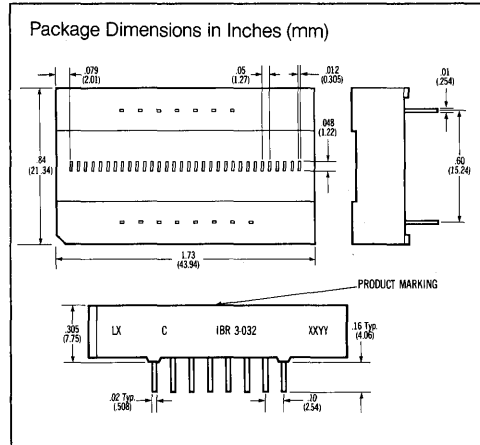
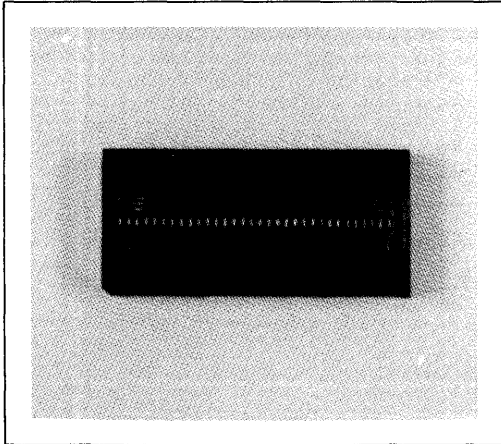
16 Digits Interconnection



SIEMENS

IBR-3 Series 32 DATA ELEMENT LED INTELLIGENT BAR GRAPH

Preliminary



FEATURES

- 32 Elements
- High resolution 50 mil spacing
- Red rectangular LEDs
- On board intelligence:
 - Storage
 - Decoding
 - Multiplexing
 - Drive Electronics
- Binary Data Input
- CMOS low power controller
- TTL compatible input
- Microprocessor interface
- Single 5-volt power supply
- Built-in:
 - Lamp test
 - 3 level dimming
 - Blanking
- Dual in-line packaging

OPTIONS:

- Available on special order:
 - High Efficiency Red
 - Yellow
 - Green
- Factory expandable in 32 element increments up to 128

DESCRIPTION

The IBR-3 is a high resolution instrumentation quality, intelligent bar graph. It is a completely self-contained display subsystem with on-board electronics for data storage, display management and LED Multiplexing. The 32 element unit is less than 1 3/4" long and is easily viewable at 10' to 20' from broad, off axis, angles.

The design makes it easy to incorporate the Bar Graph into almost any equipment. Encapsulated with dual in-line mounting, it requires standard mounting hardware. The IBR-3 is TTL compatible and requires a single 5 volt power supply. A built-in lamp test provides a quick check of LED operation.

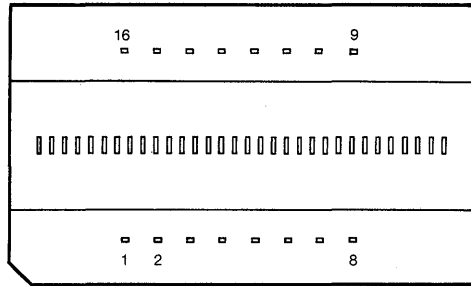
DATA ENTRY - Parallel

Loading data into the IBR-3-032 is simple and straightforward. There are two modes of operation, either expanding bar or dot mode. D5 controls the mode; 0 equals bar mode, and 1 equals dot mode. The desired binary value is presented in parallel to the inputs D0 through D4 and held stable during a write cycle. D6 must be held high or the display will be blank regardless of data inputs. The display is an expanding bar or moving dot from left to right with respect to pin 1.

OPTICAL CHARACTERISTICS (Std Red):

| | |
|----------------------------|--------------|
| Luminous Intensity/segment | 0.1 mcd |
| Off axis viewing angle | ± 60° |
| Segment size | 12 × 42 mils |
| Spectral peak wavelength | 660 nm |

| INPUT PIN FUNCTIONS: | | |
|----------------------|-----------------|--------------------|
| Pin | Signal | Function |
| 1 | D6 | Binary data input |
| 2 | D5 | Binary data input |
| 3 | D4 | Binary data input |
| 4 | D3 | Binary data input |
| 5 | D2 | Binary data input |
| 6 | D1 | Binary data input |
| 7 | D0 | Binary data input |
| 8 | GND | Ground |
| 9 | NC | No connection |
| 10 | V _{CC} | + 5 volts |
| 11 | BL0 | Brightness control |
| 12 | BL1 | Brightness control |
| 13 | WR | Write input |
| 14 | CE0 | Chip enable |
| 15 | CE1 | Chip enable |
| 16 | LT | Lamp test |



| MAXIMUM RATINGS: | |
|--------------------------|-----------------|
| Voltage, any pin to GND | -0.5 to + 6 VDC |
| Power Dissipation @ 25°C | 2.25 W |
| Operating Temperature | -20°C to + 65°C |
| Storage Temperature | -20°C to + 70°C |

| SWITCHING CHARACTERISTICS (25°C, 4.5V) | | |
|--|---------------|---------|
| Symbol | Parameter | Minimum |
| T _{WR} | Write Pulse | 200ns |
| T _{CE1} | Chip Enable 1 | 200ns |
| T _{CE0} | Chip Enable 0 | 200ns |
| T _H | Data Hold | 100ns |

DC CHARACTERISTICS (@V_{CC} = 5.0V @ 25°C)

| PARAMETER | CONDITIONS | MIN. | MAX. | UNITS |
|----------------------------------|------------------------|------|---------------------|-------|
| V _{CC} | | 4.5 | 5.5 | V |
| V _{IL} | V _{CC} = 4.5V | | .8 | V |
| V _{IH} | V _{CC} = 5.0V | 3.0 | | V |
| V _{IN} , Any Pin | | -5 | V _{CC} + 5 | V |
| I _{CC} Blank Display | V _{IN} = 0 | | | |
| | V _{CC} = 5.0V | | 5.5 | mA |
| | WR, LT = 5.0V | | 150 | mA |
| I _{CC} , 32 Segments On | V _{CC} = 5.0V | | | |
| I _{IL} | V _{CC} = 5.5V | | | |
| | V _{IN} = .8V | | 160 | uA |

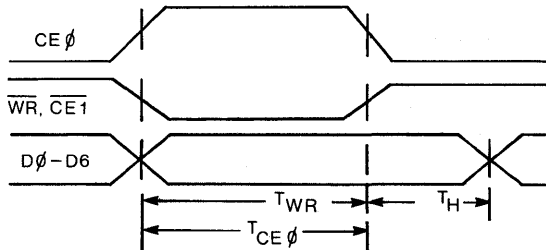
LOAD DATA STATE TABLE (X= Don't Care)

| D6 | D5 | D4 | D3 | D2 | D1 | D0 | D5 controls dot or bar mode 0=bar mode 1=dot mode. |
|----|----|----|----|----|----|----|---|
| 0 | 0 | X | X | X | X | X | No display; D6 must be 1 to display any information. |
| 0 | 1 | X | X | X | X | X | |
| 1 | 0 | D | D | D | D | D | Normal operating mode; 1 to 32 segments lit depending on binary code. |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | For Example: One segment lit (with the exception of the segment 8 option which lights during zero display as a signal the bargraph module is functional). Two segments lit Note 1 Three segments lit Note 1 Four segments lit Note 1 Five segments lit Note 1 Thirty one segments lit Note 1 Thirty two segments lit. Floating Dot Mode will display on lamp if the 0 to 31 position depending on the data in D0-D4. Displays dot in 0 position Note 1 Displays dot in 1 position Note 1 Displays dot in 311 position Note 1 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 1 | 0 | 0 | 0 | 0 | 1 | 1 | |
| 1 | 0 | 0 | 0 | 1 | 0 | 0 | |
| 1 | 0 | 0 | 1 | 1 | 1 | 0 | |
| 1 | 0 | 1 | 1 | 1 | 1 | 0 | |
| 1 | 0 | 1 | 1 | 1 | 1 | 1 | |
| 1 | 1 | D | D | D | D | D | |
| 1 | 1 | 0 | 0 | 0 | 0 | 0 | |
| 1 | 1 | 0 | 0 | 0 | 0 | 1 | |
| 1 | 1 | 1 | 1 | 1 | 1 | 1 | |

BLANKING & LT STATE TABLE

| BL0 | BL1 | LT | |
|-----|-----|----|---------------------------------------|
| 1 | 1 | 1 | NORMAL BRIGHTNESS |
| 0 | 1 | 1 | 3/7 NORMAL BRIGHTNESS |
| 1 | 0 | 1 | 1/7 NORMAL BRIGHTNESS |
| 0 | 0 | 1 | BLANK |
| X | X | 0 | ALL ELEMENTS ON 1/7 NORMAL BRIGHTNESS |

TIMING CHARACTERISTICS - Write Cycle



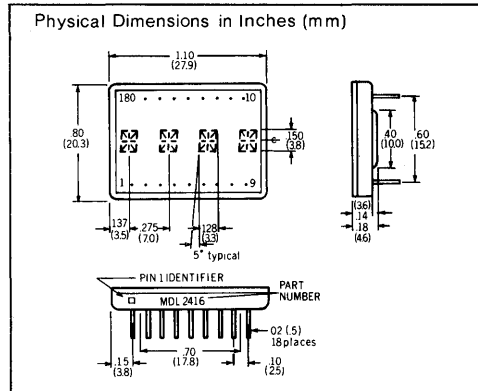
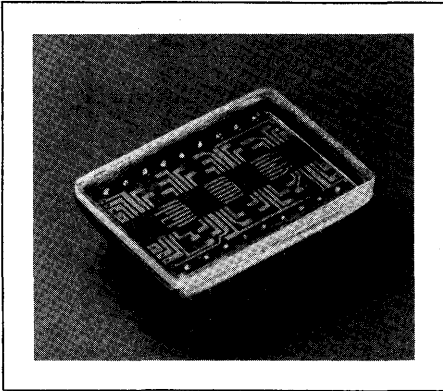
Note 1) From left to right with respect to pin #1, viewed from the top.

SIEMENS

MDL-2416 MDL-2416/B

.15" RED, 4-DIGIT, 16 SEGMENT PLUS DECIMAL
HI-REL/MILITARY ALPHANUMERIC Intelligent Display®
WITH MEMORY/DECODER/DRIVER

ADVANCE DATA SHEET



FEATURES

- MDL-2416B Fully Processed to MIL Standard 883/Level B
- 150 Mil High, Non-Magnified Monolithic Character
- Rugged Metal Can With Hermetic Sealed Flat Quartz Lens
- Close Vertical Row Spacing, .800 Inches
- Wide Viewing Angle $\pm 50^\circ$
- Wide Temperature Operating Range For High Reliability Industrial and Military Use
- Fully Integrated CMOS Drive Electronics
- Direct Access to Each Digit Independently & Asynchronously
- TTL Compatible, 5 Volt Power
- Independent Cursor Function
- 17th Segment for Improved Punctuation Marks
- Two Chip Enables
- Interdigit Blanking
- Display Blank Function
- Memory Clear Function
- End-Stackable, Four Character Package
- Intensity Coded for Display Uniformity
- Full dimming capability.

DESCRIPTION

The MDL-2416 is a Hi-Reliability four digit display having a 17 segment font and built-in CMOS drive circuitry that is TTL and microprocessor compatible. The integrated circuit contains memory, ASCII ROM decoder, multiplexing circuitry, and drivers. Data entry is asynchronous and can be random. A display system can be built using any number of MDL-2416's since each digit of any MDL-2416 can be addressed independently and will continue to display the character last stored until replaced by another.

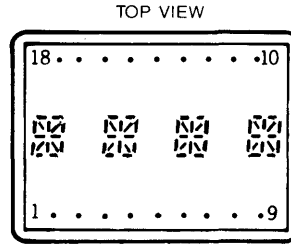
LOADING DATA

System interconnection is straight-forward. The least significant two address bits (A_0 , A_1) are normally connected to the like named inputs of all MDL-2416's in the system. With two chip enables, ($CE1$, $CE2$), two MDL-2416's (8 characters) can easily be interconnected without an external decoder.

Important/Refer to Appnote 18. "Using Intelligent Displays"

Specifications subject to change without notice

| Pin | Function | Pin | Function |
|-----|-------------------|-----|------------------|
| 1 | CE1 Chip Enable | 18 | BL Display Blank |
| 2 | CE2 Chip Enable | 17 | D4 Data input |
| 3 | CL Clear | 16 | D5 Data input |
| 4 | CUE Cursor Enable | 15 | D6 Data input |
| 5 | CU Cursor Select | 14 | D3 Data input |
| 6 | WR Write | 13 | D2 Data input |
| 7 | A1 Digit Select | 12 | D1 Data input |
| 8 | A0 Digit Select | 11 | D0 Data input |
| 9 | VCC | 10 | GND |



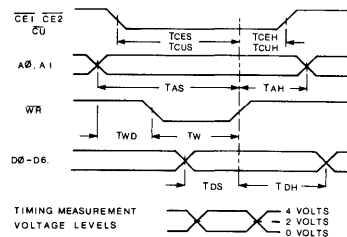
| OPTOELECTRONIC CHARACTERISTICS @ 25°C | |
|---|--|
| MAXIMUM RATINGS | OPTICAL CHARACTERISTICS (TYPICAL) |
| Voltage, Any Pin Respect to GND - .5 to + 6VDC Operating Temp (Note 1) - 55°C to + 100°C Storage Temp. - 55°C to + 125°C Relative Humidity (non-condensing) @ 85°C, 85% | Luminous Intensity (@ VCC = 5V)1 mcd/seg Viewing Angle (Note 2) ± 50° Digit Size 150 mils Spectral Peak Wavelength (Typ.) 660nm |

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|--|--|------|------|------|-------|
| I _{CC} Blank | V _{CC} = 5V WR = V _{CC} VIN = ∅V | | 12.0 | 19.0 | mA |
| I _{CC} (10 segs/ Char. 4 digits) | V _{CC} = 5V | | 125 | 150 | mA |
| I _{CC} (All seg on Cursor in 4 digits) | V _{CC} = 5V 5 sec. max. | | 150 | 175 | mA |
| V _{IL} (All inputs) | V _{CC} = 5V | | | .08 | V |
| V _{IH} (All inputs) | V _{CC} = 5V | 3.0 | | | V |
| I _{IL} (All inputs) | V _{IN} = .8V | | | 160 | uA |

| AC CHARACTERISTICS MINIMUM TIMING PARAMETERS @ 4.5V | | | | |
|--|----------|----------|-----------|-------|
| Parameter | Min | Min | Min | Units |
| | @ - 55°C | @ - 25°C | @ + 100°C | |
| TWD | TBD | 150 | 175 | ns |
| TAS | TBD | 450 | 600 | ns |
| TCES | TBD | 450 | 600 | ns |
| TCEH | TBD | 50 | 50 | ns |
| TDS | TBD | 250 | 350 | ns |
| TW | TBD | 300 | 425 | ns |
| TAH | TBD | 50 | 50 | ns |
| TDH | TBD | 50 | 50 | ns |
| TCLR | TBD | 15 | 15 | ms |
| TCUS | TBD | 450 | 600 | ns |
| TCUH | TBD | 50 | 50 | ns |

Access time = 500 ns

TIMING CHARACTERISTICS WRITE CYCLE WAVEFORMS



LOADING DATA

Setting the chip enables ($\overline{CE1}$, $\overline{CE2}$) to their true state will enable data loading. The desired data code (D0-D6) and digit address (A_0 , A_1) must be held stable during the write cycle for storing new data. Data entry may be asynchronous and random. (Digit 0 is defined as right hand digit with $A_1 = A_0 = 0$.)

Clearing of the entire internal four digit memory can be accomplished by holding the clear (\overline{CLR}) low for one complete display multiplex cycle, 15mS minimum.

Loading an illegal data code will display a blank.

For those users not requiring the cursor, the cursor enable signal (CUE) may be tied low to disable display of the cursor function. A flashing cursor can be realized by simply pulsing CUE. If cursor has been loaded to any or all positions in the display, then CUE will control whether the cursor(s) or the characters appear. CUE does not affect the contents of the cursor memory.

LOADING CURSOR

Setting the chip enables ($\overline{CE1}$, $\overline{CE2}$) and cursor select (\overline{CU}) to their true state will enable cursor loading. A write (\overline{WR}) pulse will now store or remove a cursor into the digit location addressed by A_0 , A_1 ; as defined in data entry. A cursor will be stored if $D0 = 1$; and will be removed if $D0 = 0$. Cursor will not be cleared by the \overline{CLR} signal. The cursor (\overline{CU}) pulse width should not be less than the write (\overline{WR}) pulse or erroneous data may appear in the display.

BLANKING DISPLAY

Blanking the display may be accomplished by loading a blank or space into each digit of the display or by using the (\overline{BL}) display blank input.

Setting the (\overline{BL}) input low does not affect the contents of either data or cursor memory. A flashing display can be realized by pulsing (\overline{BL}). For dimming, see note 6.

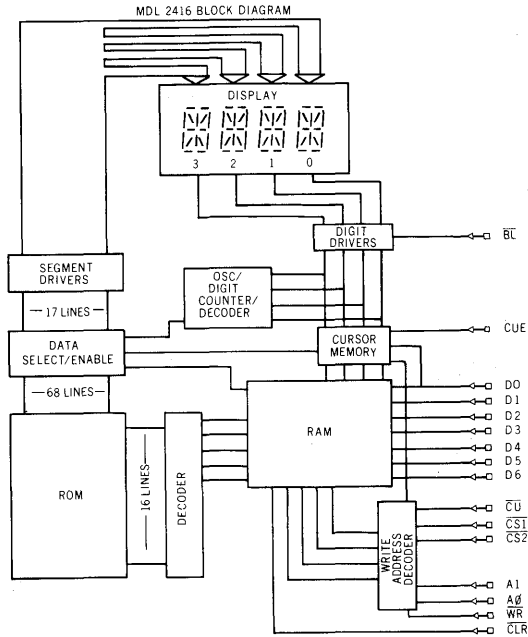
CHARACTER SET

| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H |
|----------|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|
| D1 | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H |
| D2 | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| D3 | L | L | L | L | L | L | L | L | L | H | H | H | H | H | H | |
| D6/D5/D4 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| L H L 2 | | ! | " | # | \$ | % | & | ' | < | > | * | + | / | - | . | / |
| L H H 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? |
| H L L 4 | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | |
| H L H 5 | p | q | r | s | t | u | v | w | x | y | z | [| \ |] | ^ | _ |

All other input codes display "blank"

- Note 1: Present operating temperature is 100°C. After evaluation, operating temperature may be raised to 125°C.
- Note 2: "Off Axis Viewing Angle" is here defined as: "the minimum angle in any direction from the normal to the display surface at which any part of any segment in the display is not visible."
- Note 3: This display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields. SEE APPNOTE 18.
- Note 4: Unused inputs must be tied to an appropriate logic voltage level (either V+ or V-).
- Note 5: Cursors displayed in all character positions should not remain on any longer than 60 seconds.
- Note 6: Dimming is accomplished by varying a pulse width on the blanking pin.
- Note 7: Access

MDL-2416 BLOCK DIAGRAM



Appendix "G" for Class B (Mil-M-38510) (Mil-Std-883B Method 5008)

| Screen | Group B Tests | | Comments |
|--------------------------------|---------------|--------|---------------------------------------|
| | Method | Reqmt. | |
| Physical Dimensions | 2016 | 100% | |
| Resistance to Solvents | 2015 | Sample | |
| Internal Visual and Mechanical | 2014 | 100% | |
| Bond Strength | 2011 | Sample | |
| Die Shear Strength | 2019 | Sample | |
| Solderability | 2003 | Sample | Soldering Temperature of 280°C ± 10°C |

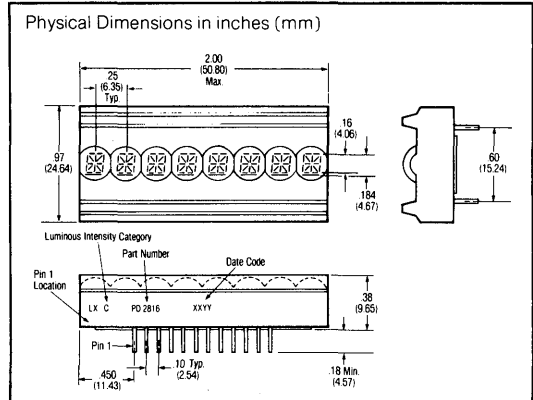
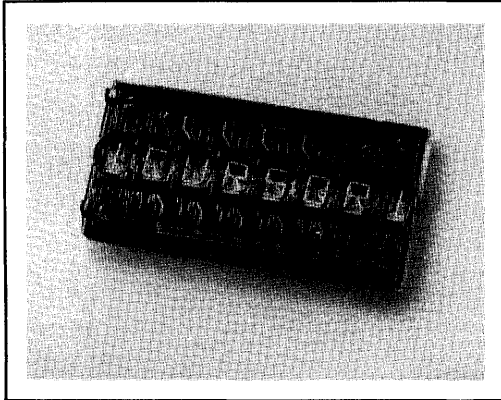
| Screen | Group C Tests | | Comments |
|---------------------------------|---------------------------|--------|--|
| | Method | Reqmt. | |
| Temperature Cycling | 1010, Test Condition C | 100% | 10 cycles -65°C to +150°C 10 min. at each extreme |
| Constant Acceleration | 2001, Test Condition A | 100% | Y1 & Y2 Orientation |
| Seal (a) Fine (b) Gross | 1014 Cond A1 Cond C | 100% | 60 PSIG 2 hr. FC-40 @ 125°C 30 sec |
| Visual examination | For Catastrophic Failures | 100% | |
| End Point Electrical Parameters | (Group A Tests) | 100% | As specified in the applicable device specification. |
| Burn-in | 1015 Cond B | 100% | Test Condition to be specified is the applicable procurement document (160 hr. @ 100°C-See Note 1) |

SIEMENS

PD-2816

.160" RED, 8 DIGIT, 18 SEGMENT INCLUDING DECIMAL ALPHANUMERIC Programmable Display™ With Built In CMOS Control Functions

Preliminary



FEATURES

- Microprocessor Compatible
- End Stackable, 8-Character Package
160 Mil High, Magnified Monolithic Char.
- Viewing Angle $\pm 32^\circ$
- 64 Character ASCII Format
- 18-Segment Including Underline and Decimal
- Control & Display Memory Read/Write
- Total Read/Write Time: 200 ns min.
- Built-in Character Generator
- Built-in Multiplex and LED Drive Circuitry
- Software Controlled Features:
 - Programmable Highlight Attribute (Blinking, Non-blinking, Underline)
 - Asynchronous Memory Clear Function
 - Lamp Test
 - Display Blank Function
 - Single or Multiple Character Blinking Function
 - Character Underline Function
 - Programmable Intensity, 3 Brightness Levels
- Intensity Coded For Display Uniformity
- TTL Compatible, Single 5 Volt Power
- Asynchronous Access to Each Digit
- Easily Cascaded
- Internal Or External Clock Source
- Lower CPU Overhead

GENERAL DESCRIPTION

The PD-2816 is an 8 digit 18 segment Intelligent Display.* It is designed to ease the job of interfacing to microcomputer systems by allowing all internal memory and registers to be addressable through the 8 bit bi-directional data bus. A control register accessible through the data bus controls all features of the display. Some of these features include the Highlight Attribute (Blinking, Non-blinking, Underline) blinking display and programmable intensity.

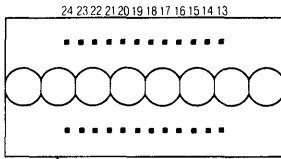
The heart of the display device is a built-in CMOS integrated circuit. This integrated circuit contains memory, ASCII ROM character generator, multiplexing circuitry, display drivers, and bus control circuitry. Each display digit is directly addressable and includes a Highlight Attribute control bit. A display system can be built using any number of PD-2816's cascaded together.

The display itself consists of eight 18 segment, 160 mil high characters. Each character contains a decimal point and an underline segment. All displays are intensity coded for ease of matching in multiple module designs.

For further information, refer to application note 27, "Applying the PD-2816".

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays". Since this is a CMOS device, normal precautions should be taken to avoid static damage.

TOP VIEW

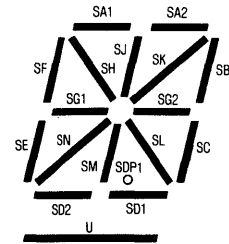


Product Identification Marking on side surface

PIN ASSIGNMENTS

| Pin | Function | Pin | Function |
|-----|------------------------|-----|-----------------|
| 1 | RST RESET | 13 | DIM DIMMER |
| 2 | A0 ADDRESS LSB | 14 | WR WRITE |
| 3 | A1 ADDRESS | 15 | D0 DATA I/O LSB |
| 4 | A2 ADDRESS MSB | 16 | D1 DATA I/O |
| 5 | A3 MODE SELECT | 17 | D2 DATA I/O |
| 6 | CE0 D0, D7 CHIP SELECT | 18 | D3 DATA I/O |
| 7 | CE1 CHIP SELECT | 19 | D4 DATA I/O |
| 8 | CLK CLOCK I/O | 20 | D5 DATA I/O |
| 9 | CSK READ CLOCK SELECT | 21 | D6 DATA I/O |
| 10 | RD READ | 22 | D7 DATA I/O MSB |
| 11 | OSC ADJ | 23 | VCC |
| 12 | GND | 24 | VCC |

DISPLAY SEGMENT FORMAT



OPTOELECTRONIC CHARACTERISTICS AT 25°C

MAXIMUM RATINGS

| | |
|--|----------------------|
| DC Supply | -0.5 to +6.0 Vdc |
| Input Voltage Relative to Gnd (all inputs) | -0.5 to VCC +0.5 Vdc |
| Operating Temperature | -20°C to 70°C |
| Storage Temperature | -20°C to 70°C |

OPTICAL CHARACTERISTICS

| | |
|------------------------------|---------------------------------|
| Spectral Peak Wavelength | 655nm Typ |
| Spectral Line Half-Width | 40nm Typ |
| Viewing Angle | +/- 32° |
| Digit Height | 160 mils |
| Luminous Intensity@ VCC = 5V | 0.15 mcd/Seg (@ 100% Intensity) |
| Intensity matching | |
| Seg to Seg @ VCC = 5V | 1.8:1 |

D.C. CHARACTERISTICS

| Parameters | Conditions | Min. | Typ. | Max. | Units |
|----------------------------------|----------------------------------|------|------|------|-------------------|
| VCC | | 4.5 | | 5.5 | Volts |
| ICC (Display Blank) | VCC = 5V WR = VCC VIN = 0V | 2.0 | 5 | 10 | mA |
| ICC (10 segs./char. 8 digits on) | @ VCC = 5V | | 125 | 150 | mA |
| VIL (All inputs) | @ VCC = 5V | | | 0.8 | Volts |
| VIH (All inputs) 1) | @ VCC = 5V | 3.0 | | | Volts |
| IIL (All inputs) | @ VCC = 5V VIN = 8V | | | 400 | µA |
| CLK Drive CLK I/O Output 2) | @ CIN 15pF / Input | 1 | | 6 | Devices (PD 2816) |

1) VIH Min = 60% VCC

2) See "CASCADED" for explanation

SWITCHING SPECIFICATIONS (@25°C AND VCC = 4.5V)

| READ CYCLE TIMING | | |
|-------------------|--------------------------------------|--------------------|
| Parameter | Description | Specification (ns) |
| TAD | Address Delay after CE0, CE1, WR, RD | 0 |
| TRD | Read pulse | 100 min |
| TDD | Delay before data is valid | 75 max |
| TDH | Data hold valid after RD | 50 max |
| TRC | Total cycle time | 200 min |

| WRITE CYCLE TIMING | | |
|--------------------|--|--------------------|
| Parameter | Description | Specification (ns) |
| TWD | Write delay after CE0, CE1, RD and Data Stable | 50 min |
| TWR | Write pulse | 100 min |
| TDH | Data hold valid after WR | 50 min |
| TWC | Total write cycle | 200 min |

FUNCTIONAL DESCRIPTION

The PD-2816 block diagram includes the major logic blocks and internal registers. Display memory consists of an 8 × 9 bit RAM block. Each of the eight 8-bit words holds the 7-bit ASCII data (bits D0-D7) and 1-bit (bit D7) for underlining each character. The ninth 8-bit memory word is used as control register. A detailed description of the control register and its functions can be found under the heading Control Word Register. Each 8-bit word is addressable and can be read or written.

There are five major blocks in addition to the memory. The first is the control word decoder and control logic which dictates all of the special features of the display device. These are discussed under the various headings on the next page.

The second block is the character generator ROM. This ROM converts the 7-bit ASCII data into the proper segment configuration for the 64 characters as shown in the character set chart.

The third block is the display multiplexer and timing logic. The clock source can be either from the internal clock or from an external source (usually from the output of another PD-2816 in a multiple module display). The multiplexer controls all display output to the digit drivers so no additional logic is required for a display system.

The fourth block is the display drivers themselves. The segment drivers are located on the CMOS IC and connected directly to the LEDs.

The fifth block is the LEDs. Each of the eight digits is comprised of 16 segments which make up the alpha-numeric characters, one decimal point, and an underline segment. The intensity of the display can be varied by the control word in steps of Blank, 25%, 50%, and full brightness.

DATA INPUT

The eight words of memory corresponding to the eight display digits are addressed through the address lines (A0-A3) and the chip enable lines (CE0 and CE1). Address bits A0-A2 address the digits 0 (right most digit) to digit 7

(left most digit). Address bit A3 is held high to address display memory, a low on A3 accesses the control word. Display data is in the 7-bit ASCII format (bits D0-D6). The character set chart shows the resulting font. With the Highlight Attributes (bits D2, D3, & D4) a combination of nonblinking, blinking and underline can be controlled independent of the digit position.

The underline (cursor) is written into the display memory by adding bit D7 to the 6 bit ASCII code of the character. To display the underline, one of the Highlight Attribute control words has to be used see control word truth table below.

GENERAL FUNCTION

| A3 | D7 | Function |
|----|----|--|
| L | L | Various display functions – control word |
| L | H | Clear |
| H | L | ASCII character set |
| H | H | ASCII character set plus underline |

Note: Table also applies to control word register.

CONTROL WORD REGISTER

The control word is addressed by holding line A3 low. The states of the other 3 address lines (A0-A2) do not matter. The control word can be read from or written to. The truth table defines each of the bits and their functions.

Bits D0 and D1 control the display brightness. Bits D2, D3 and D4 control the Highlight Attribute function. Bit D5 controls blinking. Bit D6 is a lamp test bit. Bit D7 clears the memory display.

TRUTH TABLE (CONTROL WORD)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | OPERATION |
|----|----|----|----|----|----|----|----|------------------------------------|
| L | L | X | X | X | X | L | L | BLANK |
| L | L | X | X | X | X | L | H | 25% Brightness |
| L | L | X | X | X | X | H | L | 50% Brightness |
| L | L | X | X | X | X | H | H | FULL Brightness |
| L | L | L | H | L | L | B | B | SOLID CHARACTER SOLID UNDERLINE |
| L | L | L | H | L | H | B | B | BLINK CHARACTER SOLID UNDERLINE |
| L | L | L | H | H | L | B | B | SOLID CHARACTER BLINK UNDERLINE |
| L | L | L | H | H | H | B | B | BLINK CHARACTER BLINK UNDERLINE |
| L | L | L | L | X | X | B | B | DISABLE HIGHLIGHT ATTRIBUTE |
| L | L | H | X | X | X | B | B | BLINKING DISPLAY (8 Digits) |
| L | H | L | X | X | X | X | X | LAMP TEST (50% Brightness) |
| H | L | L | L | L | L | L | L | CLEAR |

X = DON T CARE B = Depending on the selected brightness

HIGHLIGHT ATTRIBUTE FUNCTION

In the control word bits D2, D3, and D4 control, the Highlight Attribute (Blinking, Non-blinking, Underline).

To control this function, a high must be present on D4.

DISPLAY BLINKING

The designer has the option of displaying several message priorities by blinking either the character or the underline or both. The entire display can be blinked by writing a high into bit D5 of the control word. This function is independent of the bits D2, D3, & D4. Any character can be blinked by loading the underline and using the proper Highlight Attribute code. Display blinking is approximately at 2Hz.

DISPLAY BLANKING

The display can be blanked in one of two ways. The first is to clear all display memory locations by writing a high to bit D7 of the control word. This will "clean the slate" and prepare for new data to be displayed. The data in the RAM is cleared. The bit is automatically cleared after the display is cleared.

The second method is a non-destructive method where the display is blanked temporarily and restored again. This is accomplished by writing low in bits D0 and D1 of the control register. The display will be off until a high is written to either or both bits.

DISPLAY BRIGHTNESS

The display can be programmed to vary between 25%, 50%, and full brightness. Bits D0 and D1 control the brightness.

LAMP TEST

In the control word bit D6 is the Lamp Test bit. In order to limit peak power this sets all segments to a 50% brightness level regardless of what is in the display memory. Setting this bit has no effect on the display memory and clearing it will restore the display to its original condition.

CASCADING

Cascading PD2816's is a simple operation. The requirements for cascading are: 1) decoding the correct address to determine the chip select for each additional device. 2) Selecting one display as the clock source and setting all others to accept clock input (the reason for cascading the clock is to synchronize the flashing of multiple displays). One display as a source is capable of driving 6 other PD2816's (with each input having 15pf input capacitance). If more displays are required a buffer will be necessary.

MICROPROCESSOR INTERFACE

The interface to the microprocessor is through the address lines (A0-A3), the data bus (D0-D7), two chip select lines (CE0, CE1), and the read (RD) and write (WR) lines.

Two chip enable lines are provided to simplify address decoding. CE0 must be low, while CE1 must be high for any read or write operation to take place.

The read and write lines are both active low. During a valid read (ie: chip enable and read low) the data input lines (D0-D7) become output. A valid write will enable the data as input lines.

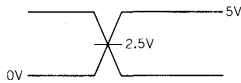
The address lines determine which RAM or register position will be read or written. If A3 is high then A0-A2 determine the display RAM position. If A3 is low then the operation will be to the control register regardless of the A0-A2 address lines.

READ/WRITE CONTROL ADDRESS TABLE

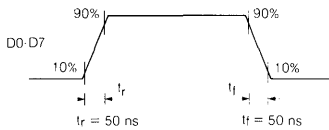
| SIGNALS | | | | | | | | OPERATION |
|---------|-----|----|----|----|----|----|----|--------------------------|
| CE0 | CE1 | RD | WR | A3 | A2 | A1 | A0 | |
| L | H | H | H | X | X | X | X | NO OPERATION |
| X | X | L | L | X | X | X | X | ILLEGAL |
| L | H | L | H | H | L | L | L | DIGIT 0 (RIGHT) |
| L | H | L | H | H | . | . | . | } READ DISPLAY DATA RAM |
| L | H | L | H | H | . | . | . | |
| L | H | L | H | H | H | H | H | DIGIT 7 (LEFT) |
| L | H | L | H | L | X | X | X | READ CONTROL REGISTER |
| L | H | H | L | H | L | L | L | DIGIT 0 (RIGHT) |
| L | H | H | L | H | . | . | . | } WRITE DISPLAY DATA RAM |
| L | H | H | L | H | . | . | . | |
| L | H | H | L | H | H | H | H | DIGIT 7 (LEFT) |
| L | H | H | L | L | X | X | X | WRITE CONTROL REGISTER |

X = DONT CARE

TIMING MEASUREMENT LEVELS

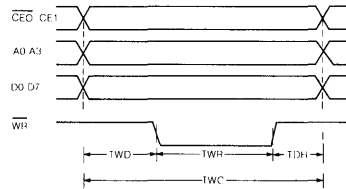


DATA BUS OUTPUT TRANSITIONS AT 25°C CL=150pF.

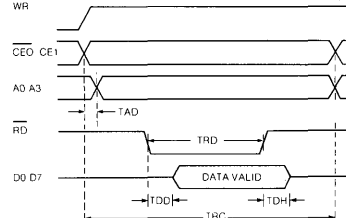


TIMING AT 25°C

DATA 'WRITE' CYCLE



DATA 'READ' CYCLE



NOTES

- Note 1: Off Axis Viewing Angle is here defined as the minimum angle in any direction from the normal to the display surface at which any part of any segment in the display is not visible.
- Note 2: The display contains a CMOS integrated circuit. Normal CMOS handling precautions should be taken to avoid damage due to high static voltages or electric fields.
- Note 3: Unused inputs must be tied to an appropriate logic voltage level (either V_{CC} or GND).
- Note 4: **Warning** — Do not use solvents containing alcohol.

PIN DEFINITIONS

| Pin | Function | Description | Pin | Function | Description |
|-----|-------------------------|--|-------|------------------------|--|
| 1 | $\overline{\text{RST}}$ | Active low reset input. Initializes multiplex counter. | 12 | GND | Ground |
| 2-4 | A0-A2 | Address inputs for display memory RAM. | 13 | DIM | Hardware display brightness control. When connected through external resistor to V _{CC} , can dim display brightness. For normal operation leave open. |
| 5 | A3 | Selects whether read/write from/to display memory (high) or the control register (low). | 14 | $\overline{\text{WR}}$ | Active low write enable input. If the display is selected a low will write the data on the data bus into the selected register or memory. |
| 6 | $\overline{\text{CE0}}$ | Active low chip enable input | 15-22 | D0-D7 | Data Bus. The data bus lines are bidirectional tri state signals connected to the system data bus. The outputs are enabled during a read operation of the display memory or the control register. The outputs are disabled and the inputs read during a write cycle to the display memory or the control register. |
| 7 | CE1 | Active high chip enable input. | | | |
| 8 | CLK I/O | If CLK SEL is low then this pin inputs external clock source. If CLK SEL is high then this pin outputs internal clock pulses | 23-24 | V _{CC} | +5 volt supply — both must be connected. |
| 9 | CLK SEL | Clock select input. When low selects external clock source. When high selects internal clock source | | | |
| 10 | $\overline{\text{RD}}$ | Active low read enable input if the display is selected, a low will enable the output drivers of the data bus. | | | |
| 11 | OSC. ADJ. | Oscillating Frequency can be adjusted by connecting this pin to V _{CC} through an external resistor. | | | |

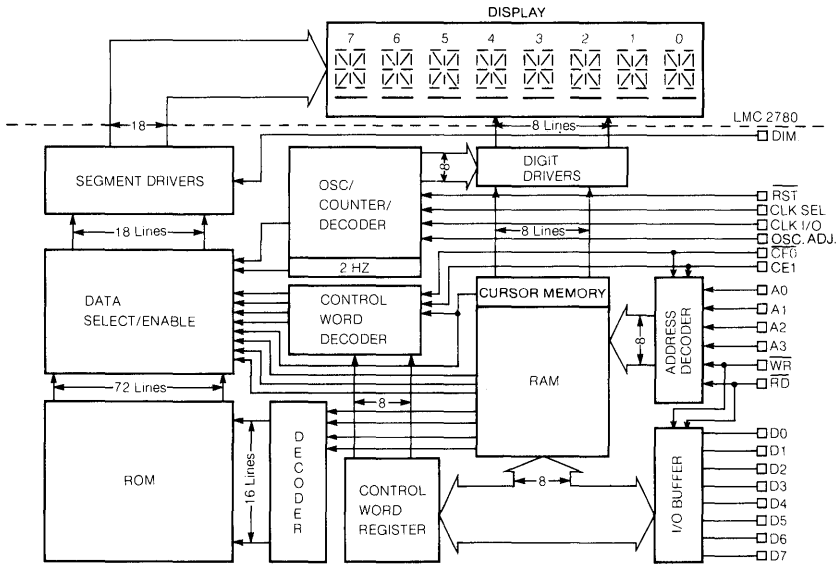
CHARACTER SET

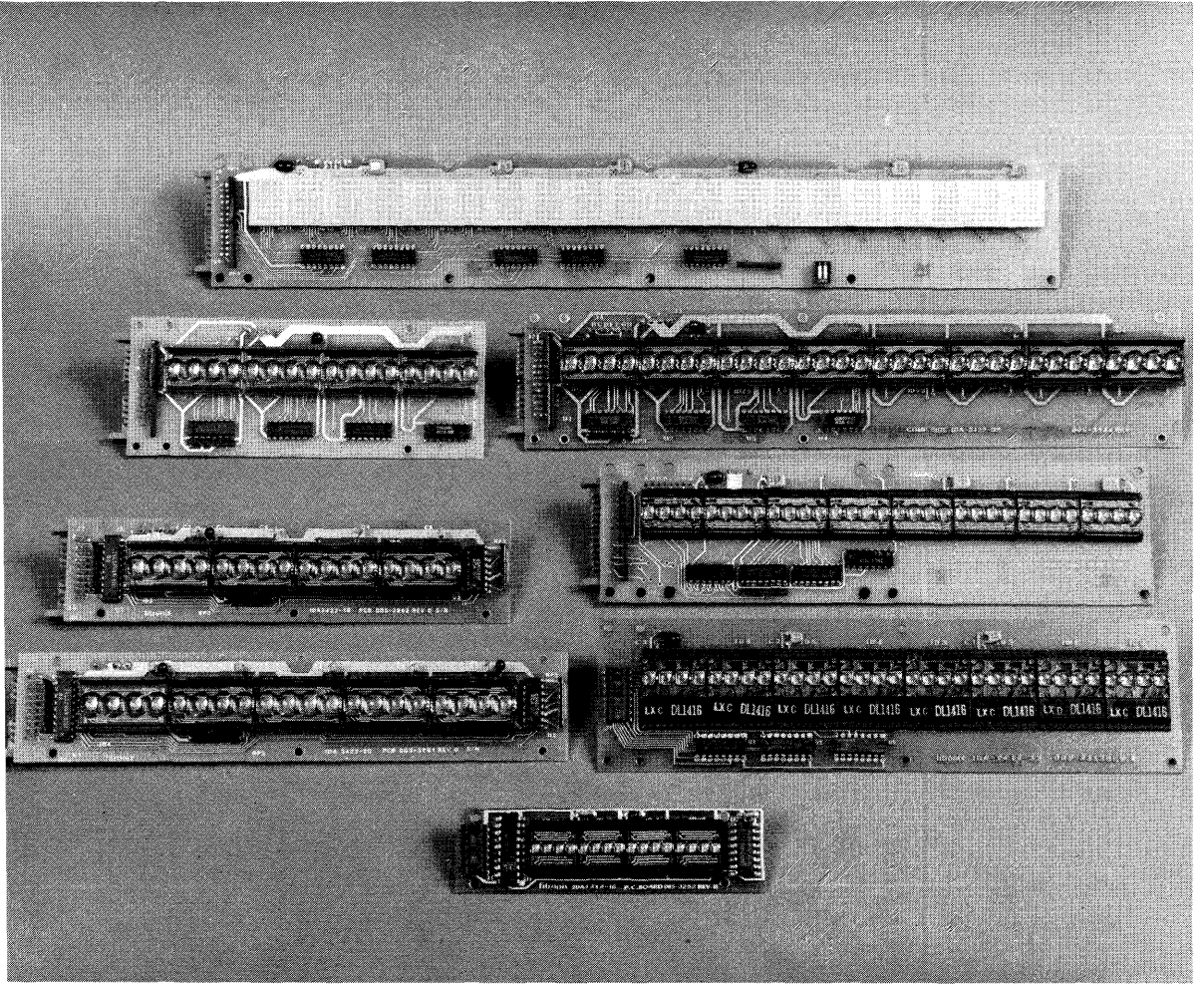
| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | |
|-------------|-----|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|
| D1 | L | L | L | H | L | L | H | H | L | L | H | H | L | L | H | H | |
| D2 | L | L | L | L | H | H | H | L | L | L | H | H | H | H | H | H | |
| D3 | L | L | L | L | L | L | L | L | H | H | H | H | H | H | H | H | |
| D7 D6 D5 D4 | HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
| L L L H L | 2 | | ! | " | # | \$ | % | & | ' | < | > | * | + | , | - | . | / |
| L L L H H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? |
| L H L L L | 4 | a | A | B | C | D | E | F | G | H | I | J | K | L | M | N | O |
| L H L H H | 5 | P | Q | R | S | T | U | V | W | X | Y | Z | [| \ |] | ^ | _ |

NOTES

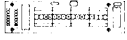



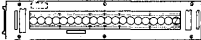

- 1) A3 Must be held high to get into character set.
- 2) All other inputs display "Blank".
- 3) When D7 is high, underline is enabled.

PD 2816 BLOCK DIAGRAM



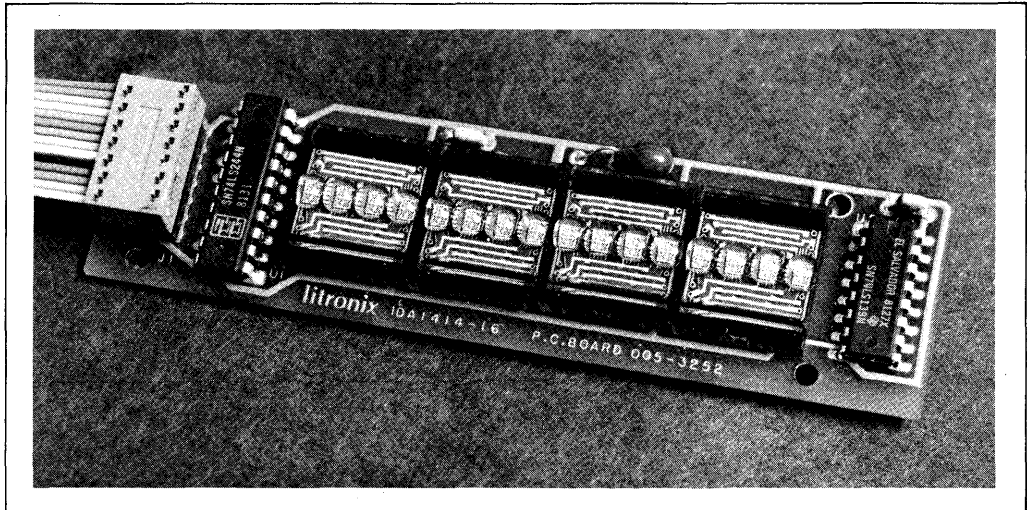


LED Intelligent Display Assemblies

| Package Type | Package Outline | Part Number | Character Height | Description | Page |
|----------------------------|---|-------------|------------------|--|------|
| 16 Char. Assembly |  | IDA-1414-16 | .112" | 16 character assembly containing four DL-1414 displays | 105 |
| 32 Char. Assembly |  | IDA-1416-32 | .160" | 32 character assembly containing eight DL-1416 displays | 109 |
| 16 & 32 Char. Assembly |  | IDA-2416-16 | .160" | 16 character assembly containing four DL-2416 displays | 113 |
| | | IDA-2416-32 | | 32 character assembly containing eight DL-2416 displays | |
| 16, 20 & 32 Char. Assembly |  | IDA-3416-16 | .225" | 16 character assembly containing four DL-3416 displays | 117 |
| | | IDA-3416-20 | | 20 character assembly containing five DL-3416 displays | |
| | | IDA-3416-32 | | 32 character assembly containing eight DL-3416 displays | |
| 16 & 32 Char. Assembly |  | IDA-3422-16 | .170"/ .100" | 16 character assembly containing four DL-3422 displays | 121 |
| | | IDA-3422-32 | | 32 character assembly containing eight DL-3422 displays. Phasing out—Not recommended for new designs. | |
| 16 & 20 Char. Assembly |  | IDA-7135-16 | .68" | 16 character, 5x7 dot matrix assembly containing 16 DL-713X displays. Orange. | 125 |
| | | IDA-7137-16 | | 16 character, 5x7 dot matrix assembly containing 16 DL-713X displays. Green. | |
| | | IDA-7135-20 | | 20 character, 5x7 dot matrix assembly containing 20 DL-713X displays. Orange. | |
| | | IDA-7137-20 | | 20 character, 5x7 dot matrix assembly containing 20 DL-713X displays. Green. | |

.112" Red, 17 Segment, 16 Character DL-1414 Intelligent Display ASSEMBLY

IDA-1414-16-1 Input Data Lines are Buffered
IDA-1416-16-2 Input Data Lines are Not Buffered



FEATURES

- 112 Mil High, Magnified Monolithic Character
- Wide Viewing Angle, $\pm 40^\circ$
- Complete Alphanumeric Display Assembly Utilizing the DL-1414
 - Built-in Multiplex and LED Drive Circuitry
 - Built-in Memory
 - Built-in Character Generator
- Displays 64 Character ASCII Set
- Direct Access to Each Digit Independently
- Single 5.0 Volt Power Supply
- TTL Compatible
- Easily Interfaced to a Microprocessor
- IDA-1414-16-1 Input Data Lines Are Buffered
- IDA-1414-16-2 Input Lines Are Not Buffered

DESCRIPTION

The IDA-1414-16 Assembly is an extension of the very easy-to-use DL-1414 Intelligent Display™. This product provides the designer with circuitry for display maintenance. It also minimizes interaction and interface normally required between the user's system and a multiplexed alphanumeric display.

The assembly consists of four DL-1414's in a single row, together with decoder and interface buffer on a single printed circuit board. Each DL-1414 provides its own memory, ASCII ROM character decoder, multiplexing circuitry, and drivers for its four 17-segment LED's.

Intelligent Display Assemblies can be used for applications such as data terminals, controllers, instruments, and other products which require an easy to use alpha-numeric display.

IDA 1414-16

Maximum Ratings

| | |
|---|--------------------------|
| V_{CC} | 6.0 V |
| Voltage applied to any input | -0.5 to $V_{CC}+0.5$ VDC |
| Operating Temperature | .0 to +65°C |
| Storage Temperature | -20 to +70°C |
| Relative Humidity (non-condensing) @ 65°C | 85% |

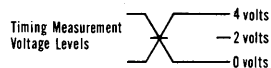
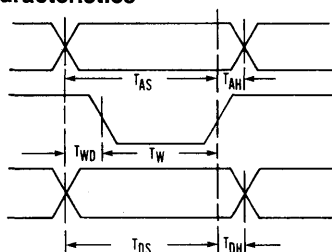
Optoelectronic Characteristics @ 25°C

| Parameter | Symbol | Min | Typ | Max | Units | Test Conditions |
|--|----------------|------|----------|------|---------|------------------------------------|
| Supply Voltage | V_{CC} | 4.75 | | 5.25 | V | |
| Supply Current (Total) | I_{CC} | | | | | $V_{CC}=5.0$ V (10 Segments/Digit) |
| Supply Current -1 | | | | 400 | mA | |
| Supply Current -2 | | | | 380 | mA | |
| Supply Current (Display Blank) | $I_{CCBLANK}$ | | | | | $V_{CC}=5.0$ V $V_{IN}=0$ |
| Supply Current -1 | | | | 75 | mA | |
| Supply Current -2 | | | | 25 | mA | |
| Input Voltage — High | V_{IH} | | | | | |
| -1 (D_0 - D_6 , A_2 , A_3 , \overline{WR}) | | 2.0 | | | V | $V_{CC}=4.5$ V |
| -1 (A_0 , A_1) | | 2.7 | | | V | $V_{CC}=5.5$ V |
| | | 3.5 | | | V | $V_{CC}=4.5$ V |
| -2 (D_0 - D_6 , A_0 , A_1) | V_{IH} | 2.7 | | | V | $V_{CC}=4.5$ V |
| | | 3.5 | | | V | $V_{CC}=5.5$ V |
| -2 (A_2 , A_3 , \overline{WR}) | | 2.0 | | | V | |
| Input Voltage — Low | V_{IL} | | | | | |
| All inputs | | | | 0.8 | V | $V_{CC}=4.5$ V |
| Input Current — High | I_{IH} | | | | | |
| Any input | | | | 20 | μ A | $V_{CC}=5.5$ V, $V_I=2.7$ V |
| Input Current — Low | I_{IL} | | | | | |
| Any input | | | | 400 | μ A | $V_{CC}=5.5$ V, $V_I=0.4$ V |
| Luminous Intensity | | | | | | |
| Average Per Digit | I_V | | 0.5 | | mcd | $V_{CC}=5.0$ V (8 Segments/Digit) |
| Peak Emission Wavelength | λ_{pk} | | 660 | | nm | |
| Viewing Angle | | | ± 40 | | Deg | |

Switching Characteristics @ 5 V

| Parameter | Symbol | (Typ) @ 0°C | (Min) @ 25°C | (Typ) @ 65°C | Units |
|-----------------------|----------|----------------|-----------------|-----------------|-------|
| Write Pulse | T_W | 300 | 325 | 350 | nS |
| Address/DE Setup Time | T_{AS} | 350 | 400 | 450 | nS |
| Data Setup Time | T_{DS} | 350 | 400 | 450 | nS |
| Write Setup | T_{WD} | 50 | 75 | 100 | nS |
| Data Hold Time | T_{DH} | 50 | 75 | 100 | nS |
| Address/DE Hold Time | T_{AH} | 50 | 75 | 100 | nS |

Timing Characteristics



System Overview

The Intelligent Display Assembly offers the designer 16 alphanumeric characters and operates from just a 5V supply. Based on the previously introduced Litronix DL-1414 four character intelligent display, the IDA 1414-16 adds all the support logic required for direct connection to most microprocessor buses. The system interface takes place through a 14 hole dual in line pattern. The user may solder wires directly into these holes or use a ribbon cable and connectors.

System Power Requirements

Operating from a single +5V power supply, the IDA-1414-16 requires a maximum operating current of 400 mA with ten of the segments lit on each character. With the display blanked, the board circuitry draws 75 mA maximum.

Display Interface

The display interface available on the 14 pin dual in line hole pattern consists of seven data lines (D0 to D6), four address lines (A0 to A3), write pulse, V_{CC} , and Gnd.

\overline{WR} (Write, active low): To store a character in the display memory, this line must be pulsed low for a minimum of 325 ns. See timing diagram for timing and relationships to other signals.

Address lines A0 to A3 are set up so that the right-most character is the lowest address. The left-most character is the highest address. Data lines are set up so that D0 is the least significant bit and D6 is the most significant bit.

Using the Display Interface

Through the use of memory-mapped I/O techniques, the IDA can be treated almost like a memory location—supply the data, address and proper control signals and the characters appear, with each character location in-

dependently addressable. The basic signal flow sequence to load a character would start with the address lines going to the desired address. After the address has stabilized, the data can change to the desired values. After the data have stabilized, the \overline{WR} pulse is started, and must remain low for at least 325 ns.

Signals must be held stable for 75 ns, minimum, after the rising edge of the \overline{WR} pulse to ensure correct loading, while the addresses must be stable for 400 ns preceding the same rising edge of the \overline{WR} pulse. See the timing diagram for a pictorial explanation.

System Design Considerations

It is often necessary, because of the nature of displays, to use ribbon cable from the CPU board. We have provided a 14 pin dual-in-line hole pattern for this purpose. In those circumstances for cables over 12 inches, use IDA 1414-16-1 (buffered version) instead of IDA 1414-16-2 (non-buffered version). Voltage transients from noisy systems may couple through the cables into the Intelligent Display and can cause serious damage.

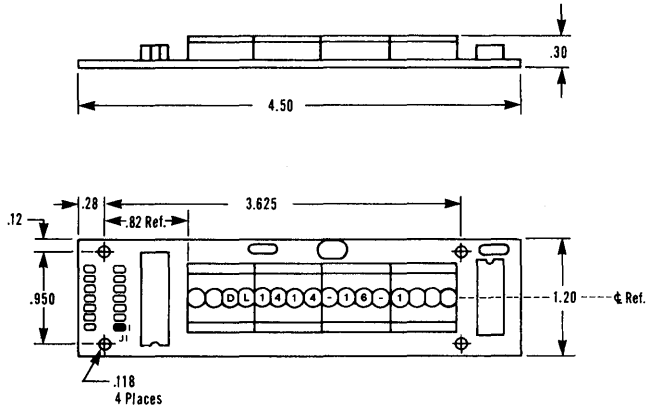
Avoid handling the assembly other than by the edges of the PCB. Static damage can still be a problem, so take the necessary precautions. Keep in conductive material, grounded work areas, etc.

The IDA 1414 assemblies should need minimal cleaning. A gentle wiping with a soft damp cloth should be its only requirement. The solvent that cannot be used on any Intelligent Display product is alcohol. Therefore, if a solvent is used, first check chemical composition before application.

CHARACTER SET

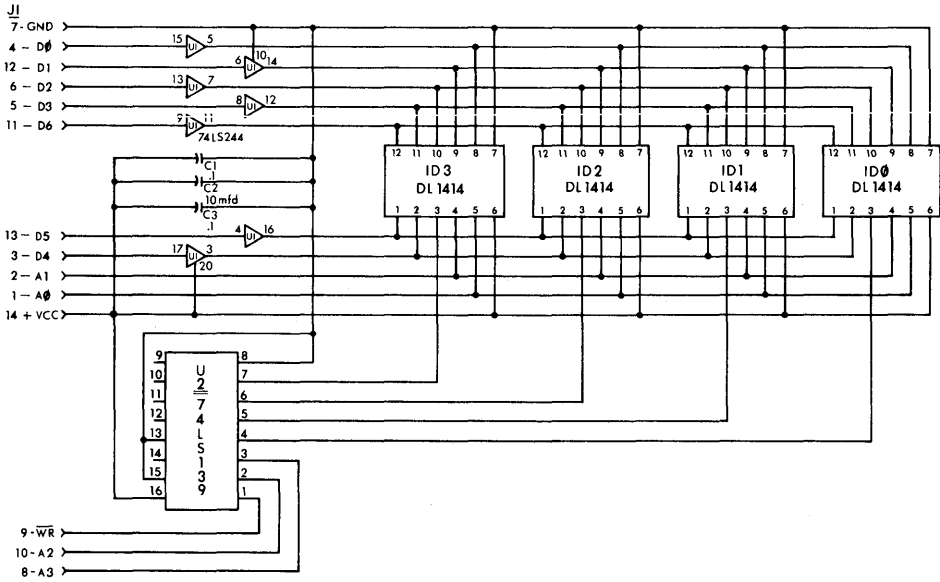
| D6 | D5 | D4 | HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
|----|----|----|-----|---|---|---|---|----|---|---|---|---|---|---|---|---|----|---|---|
| L | H | L | 2 | | ! | " | # | \$ | % | & | ' | < | > | * | + | , | -- | . | / |
| L | H | H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? |
| H | L | L | 4 | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | |
| H | L | H | 5 | p | q | r | s | t | u | v | w | x | y | z | [| \ |] | ^ | _ |

Physical Dimensions (in inches)

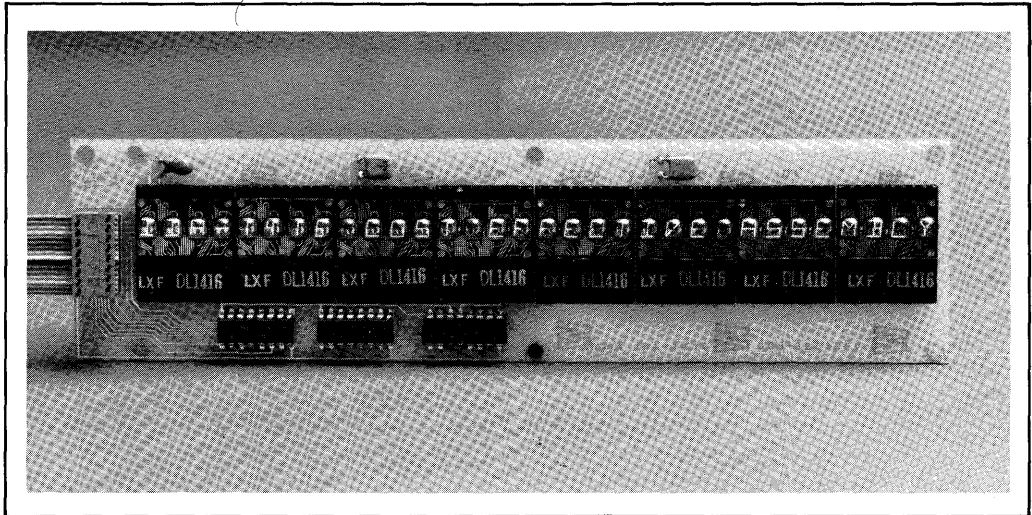


Wires may be soldered direct to 14 hole dual in line position or contact can be made with ribbon cable and connector such as Berg 65493-006 or Amp 86838-1/86838-2.

| PIN | FUNCTION |
|-----|---------------------|
| 1 | A0 DIGIT SELECT |
| 2 | A1 DIGIT SELECT |
| 3 | D4 DATA INPUT |
| 4 | D0 DATA INPUT (LSB) |
| 5 | D3 DATA INPUT |
| 6 | D2 DATA INPUT |
| 7 | GND |
| 8 | A3 DIGIT SELECT |
| 9 | WR WRITE |
| 10 | A2 DIGIT SELECT |
| 11 | D6 DATA INPUT (MSB) |
| 12 | D1 DATA INPUT |
| 13 | D5 DATA INPUT |
| 14 | +VCC |



.160", Red, 16 Segment, 32 Character DL-1416 Intelligent Display ASSEMBLY with Memory/Decoder/Driver



FEATURES

- **160 MIL High Magnified Monolithic Character**
- **Complete Alphanumeric Display Assembly Utilizing the DL-1416**
 - **Built-in Multiplex and LED Drive Circuitry**
 - **Built-in Memory**
 - **Built-in Character Generator**
- **Displays 64 Character ASCII Set**
- **Direct Access to Each Digit Independently**
- **All Inputs are Buffered**
- **Cursor Function**
- **Single 5.0 Volt Power Supply**
- **TTL Compatible**
- **Easily Interfaced to a Microprocessor**

DESCRIPTION

The IDA-1416-32 Assembly is an extension of the very easy-to-use DL-1416 Intelligent Display™. This product provides the designer with circuitry for display maintenance. It also minimizes interaction and interface normally required between the user's system and a multiplexed alphanumeric display.

The assembly consists of eight DL-1416's in a single row together with decoder and interface buffers on a single printed circuit board. Each DL-1416 provides its own memory, ASCII ROM character decoder, multiplexing circuitry, and drivers for its four 16-segment LED's.

Intelligent Display Assemblies can be used for applications such as data terminals, controllers, instruments, and other products which require an easy to use alphanumeric display.

System Overview

The IDA-1416-32 Intelligent Display Assembly offers the designer 32 alphanumeric characters and operates from just a +5 volt supply. Based on the previously introduced Litronix DL-1416 four character Intelligent Display. The IDA-1416-32 adds all the support logic required for direct connection to a host system.

System Power Requirements

Operating from a single +5 volt power supply, the IDA-1416-32 requires a typical operating current of 390mA with ten segments lit for each digit. The maximum operating current with all segments lit for all digits will be 900mA maximum.

Display Interface Signals

The system interface takes place through a 16 hole dual-in-line pattern. The user may solder wires directly into these holes or use a ribbon cable connector. The interface signals available at the 16 holes consist of seven data lines (D0 to D6), five address (A0-A4), write and cursor input.

\overline{WR} (Write, active low): To store a character in the display memory must meet minimum write cycle waveform.

\overline{CU} (Cursor select, active low): This input must be held high during a write cycle to load ASCII data into memory; and held low during a write cycle to load cursor data into memory. The cursor (\overline{CU}) should *not* be hardwired high (off). During the power-up of the DL-1416's the cursor memory will be in a random state. Therefore, it is recommended for the host system to initialize or write out all possible cursors during system initialization. Also, the cursor display will be overridden by a blank from an undefined code in that digit position.

Address lines A0 to A4 are set up so that the right-most character is the lowest address location. The left-most character is the highest address. Data lines are set up so that D0 is the least significant bit and D6 is the most significant bit.

Using the Display Assembly

Through the use of memory-mapped I/O techniques, the IDA can be treated almost like a memory location—supply the data, address, proper control signals and the characters appear, with each character location independently addressable. The basic signal flow sequence to load a character would start with the address lines going to the desired address. Data can change to the desired values (including cursor). After the data has stabilized, the write (\overline{WR}) pulse is started. See specifications and timing diagram for times and pictorial explanation.

System Design Considerations

It is often necessary, because of the nature of displays, to use cables. Avoid excessively long cables; try to keep them short. Because of current steps due to internal multiplexing, wire length and size will affect load regulation which may cause an incorrect display.

Avoid handling the assembly other than by the edges of the PCB. Static damage can still be a problem, so take the necessary precautions. Keep in conductive material, grounded work areas, etc.

The IDA-1416-32 requires minimal cleaning. A gentle wiping with a soft damp cloth should be its only requirement. The solvent that *cannot* be used on any Intelligent Display product is alcohol, therefore, if a solvent is used, first check chemical composition before application.

CHARACTER SET

| | | D0 | | D1 | | D2 | | D3 | | D4 | | D5 | | D6 | |
|---|---|----|---|----|---|----|---|----|---|----|---|----|---|----|---|
| | | L | H | L | H | L | H | L | H | L | H | L | H | L | H |
| L | H | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| L | H | L | H | L | L | L | L | L | L | L | L | L | L | L | L |
| L | H | H | L | L | L | L | L | L | L | L | L | L | L | L | L |
| L | H | H | H | L | L | L | L | L | L | L | L | L | L | L | L |
| H | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| H | L | L | H | L | L | L | L | L | L | L | L | L | L | L | L |
| H | L | H | L | L | L | L | L | L | L | L | L | L | L | L | L |
| H | L | H | H | L | L | L | L | L | L | L | L | L | L | L | L |

NOTE: All undefined data codes that are loaded or occur on power-up will cause a blank display state.

IDA-1416-32

Maximum Ratings

| | |
|------------------------------------|---------------------------|
| V_{CC} | 6.0V |
| Voltage applied to any input | -0.5 V to $V_{CC} + 0.5V$ |
| Operating Temperature | 0° to +65°C |
| Storage Temperature | -20° to +70°C |

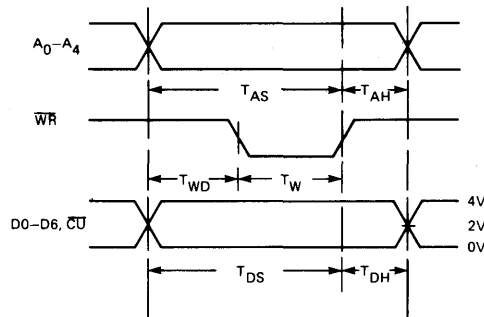
Optoelectronic Characteristic @ 25°C

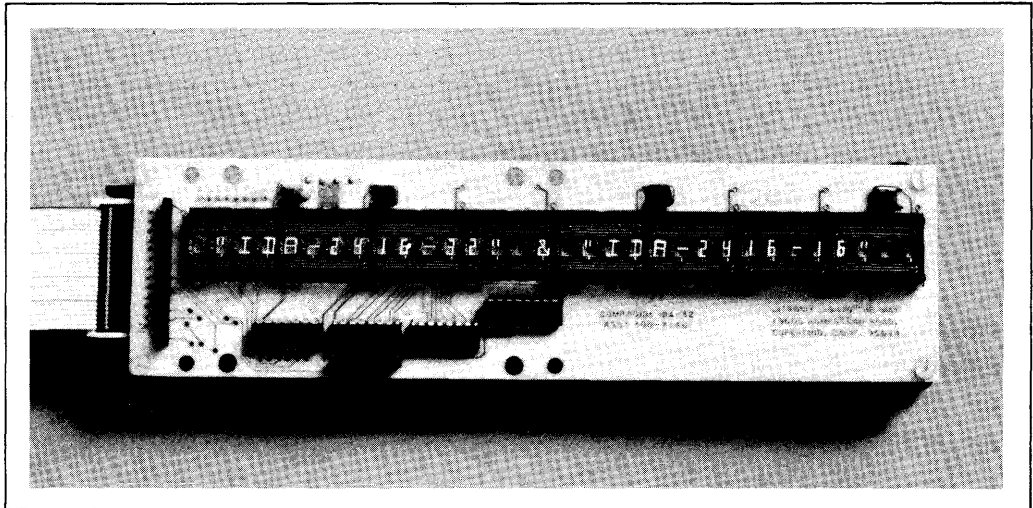
| Parameter | Symbol | Min | Typ | Max | Units | Test Conditions |
|--------------------------|----------|------|----------|------|---------|-----------------------------------|
| Supply Voltage | V_{CC} | 4.75 | | 5.25 | V | |
| Supply Current | I_{CC} | | | 900 | mA | $V_{CC} = 5V$ -All segments on. |
| Cursor | | | | 50 | mA | $V_{CC} = 5V$ Inputs low. |
| Blank (Total) | | | 390 | | mA | $V_{CC} = 5V$ (10 segments/digit) |
| Typical/Digit | | | | | | |
| Input Voltage High | V_{IH} | 2 | | | V | $V_{CC} = 5V$ |
| Input Voltage Low | V_{IL} | | | 0.8 | V | $V_{CC} = 5V$ |
| Input Current High | I_{IH} | | | 40 | μA | $V_{CC} = 5.25 V_I = 2.4V$ |
| Input Current Low | I_{IL} | | | -1.6 | mA | $V_{CC} = 5.25 V_I = 0.4V$ |
| Luminous Intensity | I_V | | 0.5 | | mcd | $V_{CC} = 5V$ (8 segment digit) |
| Average per digit | | | | | | |
| Peak Emission Wavelength | | | 660 | | nm | |
| Viewing Angle | | | ± 20 | | Deg | |

Switching Characteristics

| Parameters | Symbol | 0°C (Typ) | 25°C (Min) | 65°C (Typ) | Units |
|--------------------|----------|-----------|------------|------------|-------|
| Write Pulse | T_W | 475 | 560 | 675 | nS |
| Data Setup time | T_{DS} | 950 | 1100 | 1300 | nS |
| Data hold time | T_{DH} | 400 | 500 | 600 | nS |
| Address setup time | T_{AS} | 950 | 1100 | 1300 | nS |
| Address hold time | T_{AH} | 400 | 500 | 600 | nS |
| Write delay time | T_{WD} | 475 | 540 | 625 | nS |

TIMING CHARACTERISTICS





FEATURES

- 160 Mil High Magnified Monolithic Character
Wide Viewing Angle $\pm 40^\circ$
- Complete Alphanumeric Display Assembly Utilizing the DL-2416
 - Built-in Multiplex and LED Drive Circuitry
 - Built-in Memory
 - Built-in Character Generator
- Displays 64 Character ASCII Set
- Direct Access to Each Digit Independently
- Display Blank Function
- Memory Clear Function
- Cursor Function
- Choice of 16 or 32 Character Display Length
(Other lengths optional)
- Single 5.0 Volt Power Supply
- TTL Compatible
- Easily Interfaced to a Microprocessor
- Tri-State or Open-Collector Input Circuitry
- Schmitt Trigger Inputs on Control Lines

The IDA-2416 Series Assembly is an extension of the very easy-to-use DL-2416 Intelligent Display™. This product provides the designer with circuitry for display maintenance. It also minimizes interaction and interface normally required between the user's system and a multiplexed alphanumeric display.

The assembly consists of DL-2416's in a single row together with decoder and interface buffers on a single printed circuit board. Each DL-2416 provides its own memory, ASCII ROM character decoder, multiplexing circuitry, and drivers for its four 17-segment LED's.

Intelligent Display Assemblies can be used for applications such as data terminals, controllers, instruments, and other products which require an easy to use alphanumeric display.

| Part Number | Description |
|--|---|
| IDA-2416-16 | Single Line 16 Character Alphanumeric Display Utilizing the DL-2416 |
| IDA-2416-32 | Single Line 32 Character Alphanumeric Display Utilizing the DL-2416 |
| For custom lengths in increments of four characters, consult factory | |

System Overview

The Intelligent Display Assembly offers the designer a choice of either 16 or 32 alphanumeric characters (the IDA-2416-16 and IDA-2416-32, respectively), and operates from just a +5-V supply. Based on the previously introduced Litronix DL-2416 four-character intelligent display, the IDA-2416 adds all the support logic required for direct connection to most microprocessor buses. The system interface takes place through a 26-pin connector, which has available on it the data and address lines as well as the control signals needed. Two additional connectors are included on the IDA-2416 — one of them is used for the power and ground connections, and the other is used to implement display enable selection.

System Power Requirements

Operating from a single +5-V power supply, the IDA-2416-16 requires a typical operating current of 450 mA with eight of the segments lit on each character. For the 32 character display, the current increases to 850 mA, typical. For the worst-case condition with all segments lit, the 16 character display draws 650 mA and the 32 character display requires 1250 mA. With the display blanked, the board circuitry draws about 70 mA.

Display Interface

The display interface available on the 26-pin connector consists of seven data lines (D0 to D6), five address lines (A0 to A4), four display-enable lines ($\overline{DE1}$ to $\overline{DE4}$), several unused pins, and various control signals. All address, data, and control lines have either pull-up or pull-down 1K ohm resistors.

\overline{BL} (Blanking, active low): When this line is pulled low, it causes the entire IDA display to go blank without affecting the contents of the display memory on the DL-2416s. \overline{BL} is active regardless of address or display enable lines. A flashing display can be realized by pulsing this line.

\overline{WR} (Write, active low): To store a character in the display memory, this line must be pulsed low for a minimum of 350 ns. See timing diagram for timing & relationships to other signals. The \overline{WR} input drives a schmitt-trigger.

CUE (Cursor Enable, active high): When high, this line permits the cursor to be displayed, and when brought low, it disables the cursor function without affecting the stored value. CUE is active regardless of address or display enable lines. A flashing cursor can be created by pulsing the CUE line low.

\overline{CU} (Cursor Select, active low): The cursor function (character with all segments lit) is loaded by selecting the digit address and holding \overline{CU} true. A "1" on D0

writes the cursor. A "0" on D0 removes the cursor. The change occurs during the next write pulse per the timing diagram.

\overline{CLR} (Clear, active low): When held low for one display multiplex cycle (see DL-2416 data sheet for more information) of 15 ms, this line will cause all stored characters in the display, except for the cursor, to be cleared. \overline{CLR} is active regardless of address or display enable lines. The \overline{CLR} input drives a schmitt-trigger.

$\overline{DE1}$ to $\overline{DE4}$ (Display Enable, active low): There are four jumper selectable lines, any one of which can be selected to provide one of four board addresses that can be used when multiple IDAs are built into a system. When low, this line enables the selected display to permit data loading. The display enable input drives a schmitt-trigger.

Address lines A0 to A4 are set up so that the right-most character is the lowest address. The left-most character is the highest address. Data lines are set up so that D0 is the least significant bit and D6 is the most significant bit.

Using the Display Interface

Through the use of memory-mapped I/O techniques, the IDA can be treated almost like a memory location — supply the data, address and proper control signals and the characters appear, with each character location independently addressable. The basic signal flow sequence to load a character would start with the address lines going to the desired address while the \overline{CLR} and \overline{BL} lines are high to permit the data to be loaded in and displayed. After the address has stabilized, the data can change to the desired values (including the cursor). After the data have stabilized, the \overline{WR} pulse is started, and must remain low for at least 350 ns. Signals must be held stable for 75 ns, minimum, after the rising edge of the \overline{WR} pulse to ensure correct loading, while the addresses must be stable for 650 ns preceding the same rising edge of the \overline{WR} pulse. See the timing diagram for a pictorial explanation.

Enable Selection

For board enable (the $\overline{DE1}$ through $\overline{DE4}$ lines) the user can choose any one of the four enable signals he has provided on the cable. This signal will be used to provide a master enable to each IDA. All that need be done is to insert the shorting plug in the appropriate position on the pins provided. This allows the user to make the system display the same information on two or more different IDAs or display different information on each of up to four groups of IDA's.

IDA-2416 Series

Maximum Ratings

| | |
|---|----------------------------------|
| V _{CC} | 6.0 V |
| Voltage applied to any input | -0.5 to V _{CC} +0.5 VDC |
| Operating Temperature | 0 to +65°C |
| Storage Temperature | 0 to +70°C |
| Relative Humidity (non condensing) @ 65°C | 85% |

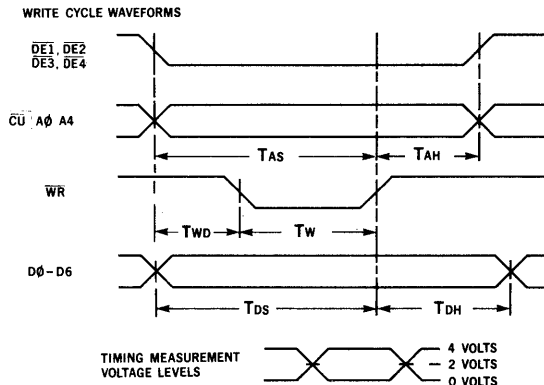
Optoelectronic Characteristics @ 25°C

| Parameter | Symbol | Min | Typ | Max | Units | Test Conditions |
|---|-------------------|------|------|------|-------|---|
| Supply Current/Digit | I _{CC} | | 25 | | mA | V _{CC} = 5.0 V (8 Segments/Digit) |
| Total (IDA-2416-16) | I _{CCO} | | | 650 | mA | V _{CC} = 5.0 V (All Segments/Digit) |
| Total (IDA-2416-32) | I _{CC} | | | 1250 | mA | V _{CC} = 5.0 V (All Segments/Digit) |
| Supply Voltage | V _{CC} | 4.75 | 5.00 | 5.25 | V | |
| Input Voltage – High (All inputs) | V _{IH} | 2 | | | V | V _{CC} = 5.0 V ± .25 V |
| Input Voltage – Low (All inputs) | V _{IL} | | | 0.8 | V | V _{CC} = 5 |
| Input Current – High (All inputs) | I _{IH} | | | 40 | μA | V _{CC} = 5.5 V, V _I = 2.4 V |
| Input Current – Low (All inputs) | I _{IL} | | | 2.2 | mA | V _{CC} = 5.5 V, V _I = 0.4 V |
| Luminous Intensity Average Per Digit | I _V | | 0.5 | | mcd | V _{CC} = 5.0 V (8 Segments/Digit) |
| Peak Wavelength | λ _{peak} | | 660 | | nm | |
| Viewing Angle | | | ±45 | | Deg | Vertical & Horizontal From Normal To Display Plane |

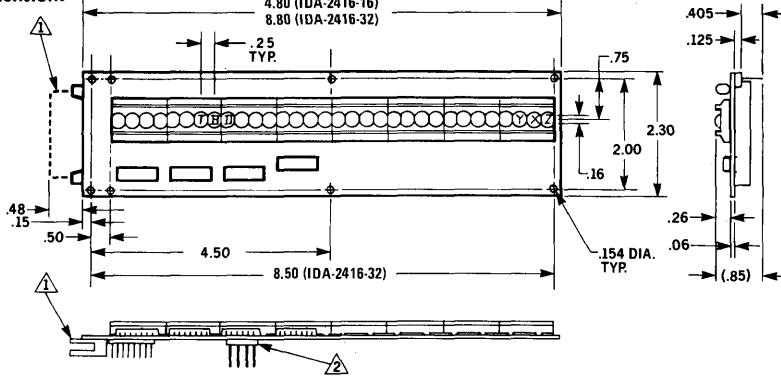
Switching Characteristics @ 5 V

| Parameter @ 25°C | Symbol | Min | Units |
|-----------------------|------------------|-----|-------|
| Write Pulse | T _W | 350 | nS |
| Address/DE Setup Time | T _{AS} | 550 | nS |
| Data Setup Time | T _{DS} | 550 | nS |
| Write Setup | T _{WD} | 200 | nS |
| Data Hold Time | T _{DH} | 75 | nS |
| Address/DE Hold Time | T _{AH} | 75 | nS |
| Clear Time | T _{CLR} | 15 | mS |

TIMING CHARACTERISTICS



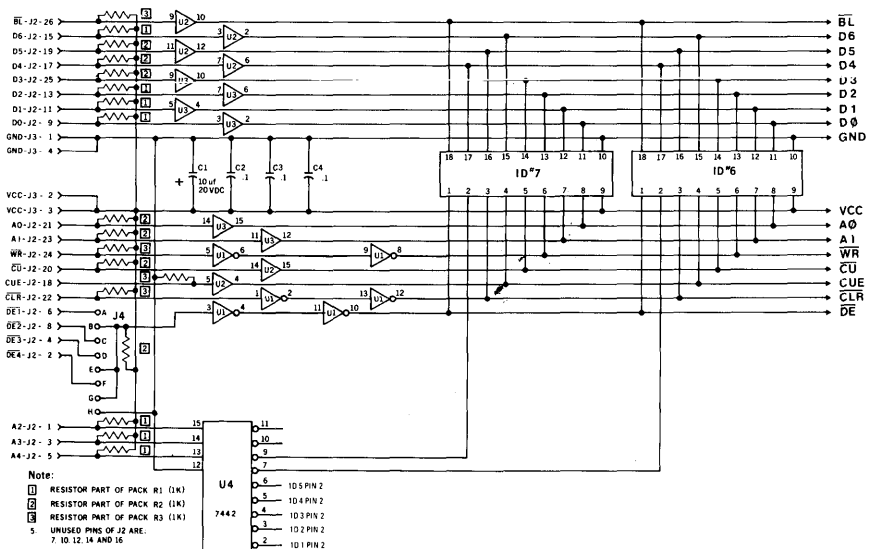
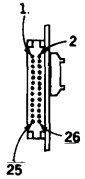
Physical Dimensions

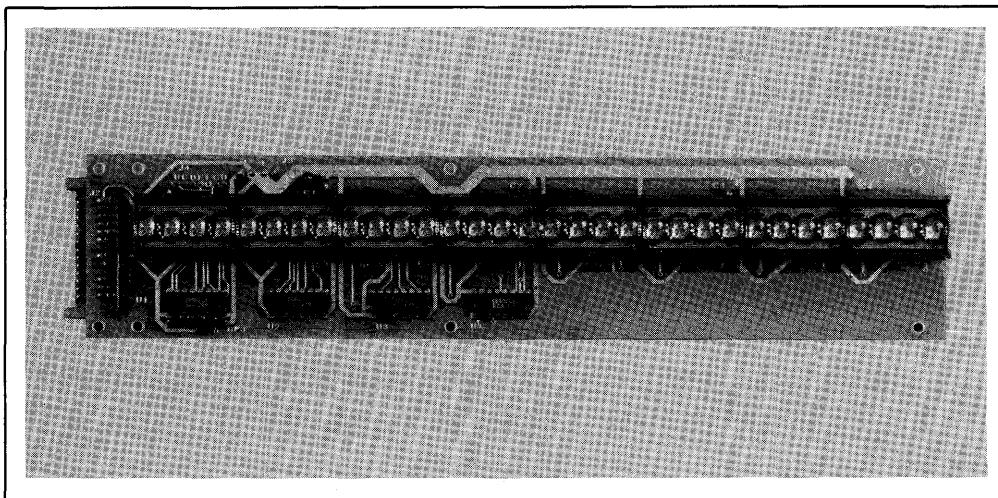


RECOMMENDED MATING CONNECTOR

| Connector | Function | Type | Suggested Mfg. |
|-----------|--------------|---------------|--|
| ▲ J2 | Control/Data | 26-Pin Ribbon | BERG P/N 65484-011 |
| ▲ J3 | Power | Molex | AMP P/N 1-87025-3 HOUSING P/N 87026-2 |

| PIN | FUNCTION | PIN | FUNCTION |
|-------|--------------------|-------|-------------------|
| J2-1 | A2 ADDRESS LINE | J2-14 | NO CONNECTION |
| J2-2 | DE4 DISPLAY ENABLE | J2-15 | D6 DATA LINE |
| J2-3 | A3 ADDRESS LINE | J2-16 | NO CONNECTION |
| J2-4 | DE3 DISPLAY ENABLE | J2-17 | D4 DATA LINE |
| J2-5 | A4 ADDRESS LINE | J2-18 | CUE CURSOR ENABLE |
| J2-6 | DE1 DISPLAY ENABLE | J2-19 | D5 DATA LINE |
| J2-7 | NO CONNECTION | J2-20 | CU CURSOR SELECT |
| J2-8 | DE2 DISPLAY ENABLE | J2-21 | A0 ADDRESS LINE |
| J2-9 | D0 DATA LINE | J2-22 | CLR CLEAR |
| J2-10 | NO CONNECTION | J2-23 | A1 ADDRESS LINE |
| J2-11 | D1 DATA LINE | J2-24 | WR WRITE |
| J2-12 | NO CONNECTION | J2-25 | D3 DATA LINE |
| J2-13 | D2 DATA LINE | J2-26 | BL BLANKING |
| J3-1 | GND | J3-5 | VCC |
| J3-2 | VCC | J3-4 | GND |





FEATURES

- 225 Mil High Magnified Monolithic Character
- Wide Viewing Angle $\pm 40^\circ$
- Complete Alphanumeric Display Assembly Utilizing the DL-3416
 - Built-in Multiplex and LED Drive Circuitry
 - Built-in Memory
 - Built-in Character Generator
- Displays 64 Character ASCII Set
- Direct Access to Each Digit Independently
- Display Blank Function
- Memory Clear Function
- Cursor Function
- Choice of 16, 20 or 32 Character Display Length (Other lengths optional)
- Single 5.0 Volt Power Supply
- TTL Compatible
- Easily Interfaced to a Microprocessor
- Schmitt Trigger Inputs on Data and Write Lines

The IDA-3416 Series Assembly is an extension of the very easy-to-use DL-3416 Intelligent Display™. This product provides the designer with circuitry for display maintenance. It also minimizes interaction and interface normally required between the user's system and a multiplexed alphanumeric display.

The assembly consists of DL-3416's in a single row together with decoder and interface buffers on a single printed circuit board. Each DL-3416 provides its own memory, ASCII ROM character decoder, multiplexing circuitry, and drivers for its four 17-segment LED's.

Intelligent Display Assemblies can be used for applications such as data terminals, controllers, instruments, and other products which require an easy to use alphanumeric display.

Specifications are subject to change without notice.

| Part Number | Description |
|-------------|---|
| IDA-3416-16 | Single Line 16 Character Alphanumeric Display Utilizing the DL-3416 |
| IDA-3416-20 | Single Line 20 Character Alphanumeric Display Utilizing the DL-3416 |
| IDA-3416-32 | Single Line 32 Character Alphanumeric Display Utilizing the DL-3416 |

For Custom Lengths, in Increments of 4 Characters, Consult the Factory.

IDA-3416 Series

Maximum Ratings

| | |
|--|----------------------------------|
| V _{CC} | 6.0 V |
| Voltage applied to any input | -0.5 to V _{CC} +0.5 VDC |
| Operating Temperature | 0 to +65°C |
| Storage Temperature | -20 to +70°C |

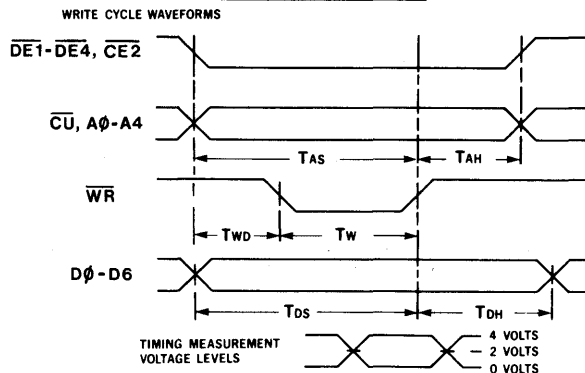
Optoelectronic Characteristics @ 25°C

| Parameter | Symbol | Min | Typ | Max | Units | Test Conditions |
|---|-------------------|------|------|------|-------|--|
| Supply Current/Digit | I _{CC} | | 25 | | mA | V _{CC} = 5.0 V (8 Segments/Digit) |
| Supply Current/Digit | I _{CC} | | | 6 | mA | V _{CC} = 5.0 V (Display Blank) VIN = 0V, WR = 5V |
| Total (IDA-3416-16) | I _{CC} | | | 850 | mA | V _{CC} = 5.0 V (All Segments/Digit) (See Note 2) |
| Total (IDA-3416-20) | I _{CC} | | | 1050 | | V _{CC} = 5.0 V (All Segments/Digit) (See Note 2) |
| Total (IDA-3416-32) | I _{CC} | | | 1680 | mA | V _{CC} = 5.0 V (All Segments/Digit) (See Note 2) |
| Supply Voltage | V _{CC} | 4.75 | 5.00 | 5.25 | V | |
| Input Voltage – High (All inputs) | V _{IH} | 3.5 | | | V | V _{CC} = 5.0 V ± .25 V |
| Input Voltage – Low (All inputs) | V _{IL} | | | 0.8 | V | V _{CC} = 5 |
| Input Current – High (All inputs) | I _{IH} | | | 40 | μA | V _{CC} = 5.5 V, V _I = 2.4 V |
| Input Current – Low (All inputs) | I _{IL} | | | 6.4 | mA | V _{CC} = 5.5 V, V _I = 0.4 V |
| Luminous Intensity Average Per Digit | I _V | | 0.8 | | mcd | V _{CC} = 5.0 V (8 Segments/Digit) |
| Peak Wavelength | λ _{peak} | | 660 | | nm | |
| Viewing Angle | | | ±40 | | Deg | Vertical & Horizontal From Normal To Display Plane |

Switching Characteristics @ 5 V

| Parameter @ 25°C | Symbol | Min | Units |
|-----------------------|------------------|-----|-------|
| Write Pulse | T _W | 350 | nS |
| Address/DE Setup Time | T _{AS} | 550 | nS |
| Data Setup Time | T _{DS} | 550 | nS |
| Write Setup | T _{WD} | 200 | nS |
| Data Hold Time | T _{DH} | 75 | nS |
| Address/DE Hold Time | T _{AH} | 75 | nS |
| Clear Time | T _{CLR} | 15 | mS |

TIMING CHARACTERISTICS



System Overview

The Intelligent Display Assembly offers the designer a choice of either 16, 20 or 32 alphanumeric characters and operates from just a +5-V supply. Based on the previously introduced Litronix DL-3416 four-character intelligent display, the IDA-3416 adds all the support logic required for direct connection to most microprocessor buses. The system interface takes place through a 20 or 26-pin connector, which has available on it the data and address lines as well as the control signals needed. One additional connector is used for the power and ground connections.

System Power Requirements

Operating from a single +5-V power supply, the IDA-3416 Series Assembly requires a typical operating current of 30 mA per digit with eight of the segments lit on each character. For the worst case condition with all segments lit, the current is 52 mA per digit and with the display blank the current is 6 mA per digit.

Display Interface

The display interface available on the 20 or 26-pin connector consists of seven data lines (D0 to D6), five address lines (A0 to A4), and various control signals. All address, data, and control lines have either pull-up or pull-down 1K ohm resistors. \overline{BL} (Blanking, active low): When this line is pulled low, it causes the entire IDA display to go blank without affecting the contents of the display memory on the DL-3416s. \overline{BL} is active regardless of address or display enable lines. A flashing display can be realized by pulsing this line. \overline{WR} (Write, active low): To store a character in the display memory, this line must be pulsed low for a minimum write time. See timing diagram for timing & relationships to other signals.

CUE (Cursor Enable, active high): When high, this line permits the cursor to be displayed (see Note 2), and when brought low, it disables the cursor function without affecting the stored value. CUE is active regardless of address or display enable lines. A flashing cursor can be created by pulsing the CUE line low.

\overline{CU} (Cursor Select, active low): The cursor function (character with all segments lit) is loaded by selecting the digit address and holding \overline{CU} true. A "1" on D0 inserts the cursor. A "0" on D0 removes the cursor. The change occurs during a write pulse per the timing diagram.

\overline{CLR} (Clear, active low): When held low for one display multiplex cycle (see DL-3416 data sheet for more information) of 15 ms, this line will cause all stored characters in the display, except for the cursor, to be cleared. \overline{CLR} is active regardless of address or display enable lines.

$\overline{CE2}$ (Chip Enable, Active Low): To store a character in the display memory, this line must be held low at least 550 nanoseconds preceding the leading edge of the \overline{WR} pulse.

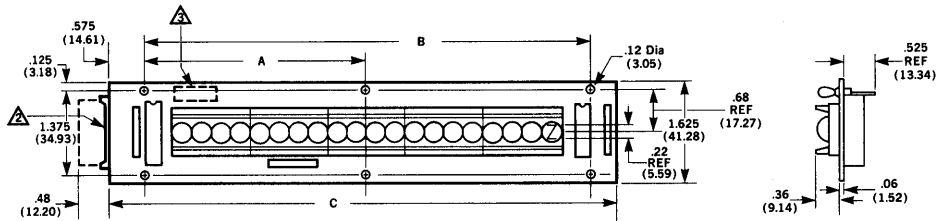
Address lines A0 to A4 are set up so that the right-most character is the lowest address. The left-most character is the highest address. Data lines are set up so that D0 is the least significant bit and D6 is the most significant bit.

Using the Display Interface

Through the use of memory-mapped I/O techniques, the IDA can be treated almost like a memory location — supply the data, address and proper control signals and the characters appear, with each character location independently addressable. The basic signal flow sequence to load a character would start with the address lines going to the desired address while the \overline{CLR} and \overline{BL} lines are high to permit the data to be loaded in and displayed. After the address has stabilized, the data can change to the desired values (including the cursor). After the data have stabilized, the \overline{WR} pulse is started, and must remain low for at least 350 ns. Signals must be held stable for 75 ns, minimum, after the rising edge of the \overline{WR} pulse to ensure correct loading, while the addresses must be stable for 550 ns preceding the same rising edge of the \overline{WR} pulse. See the timing diagram for a pictorial explanation.

- Notes: 1) CMOS Handling precaution — App Note 18
2) Cursor should not be on longer than 60 sec.
3) Cleaning solvents — use NO alcohol

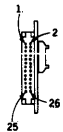
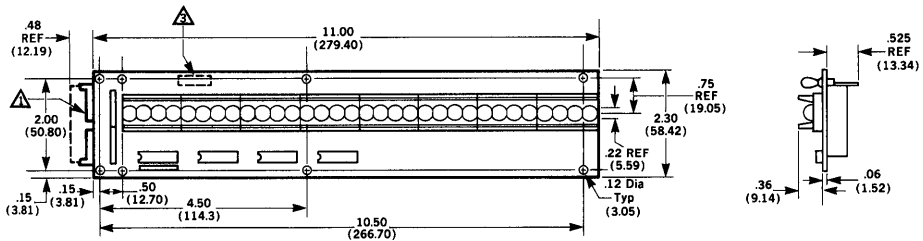
IDA3416 Physical Dimensions



| PRODUCT | A | B | C |
|-------------|-----------------|------------------|------------------|
| IDA 3416-16 | 3.00 (76.20) | 6.00 (152.40) | 6.95 (176.58) |
| IDA 3416-20 | 3.65 (92.71) | 7.30 (185.42) | 8.25 (209.55) |



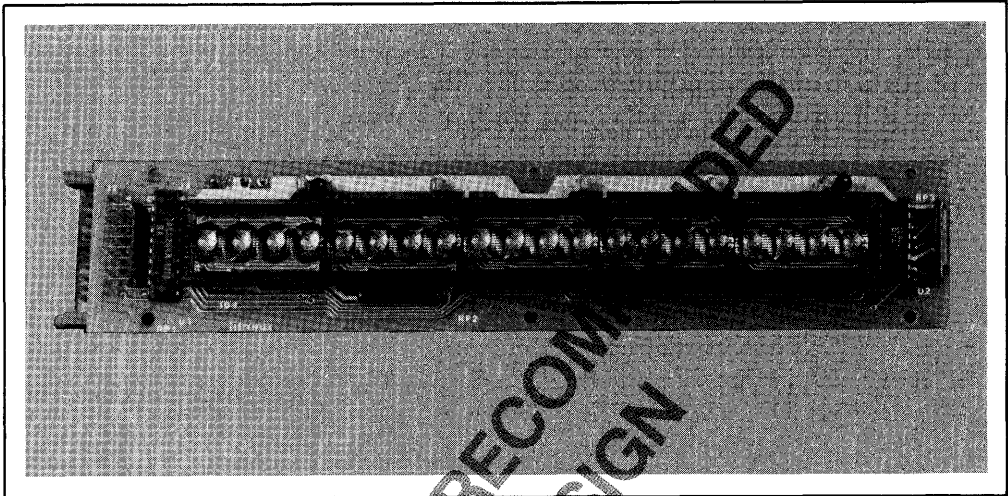
| PIN | FUNCTION | PIN | FUNCTION |
|-------|-----------------|-------|------------------|
| J2-1 | D6 DATA LINE | J2-11 | DI DATA LINE |
| J2-2 | BL BLANKING | J2-12 | CE2 CHIP ENABLE |
| J2-3 | D5 DATA LINE | J2-13 | D8 DATA LINE |
| J2-4 | UNUSED | J2-14 | CU CURSOR SELECT |
| J2-5 | D4 DATA LINE | J2-15 | WR WRITE |
| J2-6 | A1 ADDRESS LINE | J2-16 | CUE CUSOR ENABLE |
| J2-7 | D3 DATA LINE | J2-17 | A3 ADDRESS LINE |
| J2-8 | A0 ADDRESS LINE | J2-18 | UNUSED |
| J2-9 | D2 DATA LINE | J2-19 | A4 ADDRESS LINE |
| J2-10 | CLR CLEAR | J2-20 | A2 ADDRESS LINE |
| J3-1 | GND | J3-3 | VCC |
| J3-2 | VCC | J3-4 | GND |



| PIN | FUNCTION | PIN | FUNCTION |
|-------|--------------------|-------|-------------------|
| J2-1 | A2 ADDRESS LINE | J2-14 | NO CONNECTION |
| J2-2 | DE4 DISPLAY ENABLE | J2-15 | D6 DATA LINE |
| J2-3 | A3 ADDRESS LINE | J2-16 | NO CONNECTION |
| J2-4 | DE3 DISPLAY ENABLE | J2-17 | D4 DATA LINE |
| J2-5 | A4 ADDRESS LINE | J2-18 | CUE CURSOR ENABLE |
| J2-6 | DE1 DISPLAY ENABLE | J2-19 | DE DATA LINE |
| J2-7 | NO CONNECTION | J2-20 | CU CURSOR SELECT |
| J2-8 | DE2 DISPLAY ENABLE | J2-21 | A0 ADDRESS LINE |
| J2-9 | D6 DATA LINE | J2-22 | CLR CLEAR |
| J2-10 | NO CONNECTION | J2-23 | A1 ADDRESS LINE |
| J2-11 | D1 DATA LINE | J2-24 | WR WRITE |
| J2-12 | NO CONNECTION | J2-25 | D3 DATA LINE |
| J2-13 | D2 DATA LINE | J2-26 | BL BLANKING |
| J3-1 | GND | J3-3 | VCC |
| J3-2 | VCC | J3-4 | GND |

RECOMMENDED MATING CONNECTOR

| Connector | Function | Type | Suggested Mfg. |
|-----------|--------------|---------------|--|
| J2 | Control/Data | 20 Pin Ribbon | BERG P/N 65496-007 |
| J2 | Control Data | 26 Pin Ribbon | BERG P/N 65484-011 |
| J3 | Power | Molex | AMP P/N 1-87205-3 HOUSING P/N 87026-2 |



FEATURES

- 170 Mil/100 Mil (NOM) Magnified Monolithic Character
- Wide Viewing Angle $\pm 50\%$
- Complete Alphanumeric Display Assembly Utilizing the DL-3422
 - Built-in Multiplex and LED Drive Circuitry
 - Built-in Memory
 - Built-in Character Generator
- Displays 96 Character ASCII Set
- Direct Access to Each Digit Independently
- Display Blank Function
- Memory Clear Function
- Cursor Function
- Choice of 16 or 20 Character Display Length (Other lengths optional)
- Single 5.0 Volt Power Supply
- TTL Compatible
- Easily Interfaced to a Microprocessor
- Schmitt Trigger Inputs on Data and Write Lines

The IDA-3422 Series Assembly is an extension of the very easy-to-use DL-3422 Intelligent Display™. This product provides the designer with circuitry for display maintenance. It also minimizes interaction and interface normally required between the user's system and a multiplexed alphanumeric display.

The assembly consists of DL-3422's in a single row together with decoder and interface buffers on a single printed circuit board. Each DL-3422 provides its own memory, ASCII ROM character decoder, multiplexing circuitry, and drivers for its four 22-segment LED's.

Intelligent Display Assemblies can be used for applications such as data terminals, controllers, instruments, and other products which require an easy to use alphanumeric display.

Specifications are subject to change without notice.

| Part Number | Description |
|-------------|---|
| IDA-3422-16 | Single Line 16 Character Alphanumeric Display Utilizing the DL-3422 |
| IDA-3422-20 | Single Line 20 Character Alphanumeric Display Utilizing the DL-3422 |

For Custom Lengths, in Increments of 4 Characters, Consult the Factory.

IDA-3422 Series

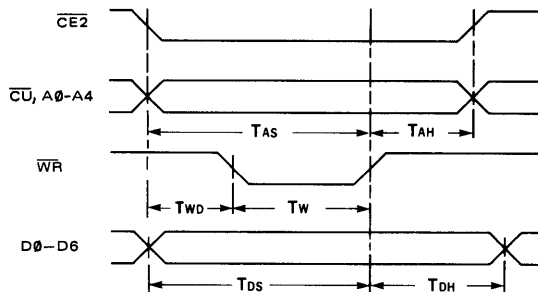
| Maximum Ratings | |
|------------------------------------|----------------------------|
| V_{CC} | 6.0 V |
| Voltage applied to any input | -0.5 to $V_{CC} + 0.5$ VDC |
| Operating Temperature | 0 to +65°C |
| Storage Temperature | -20 to +70°C |

| Optoelectronic Characteristics @ 25°C | | | | | | |
|---|------------------|------|----------|------|---------|--|
| Parameter | Symbol | Min | Typ | Max | Units | Test Conditions |
| Supply Current/Digit | I_{CC} | | 20 | | mA | $V_{CC} = 5.0$ V (8 Segments/Digit) |
| Supply Current/Digit | I_{CC} | | | 1 | mA | $V_{CC} = 5.0$ V (Display Blank) $V_{IN} = 0$ V, $WR = 5$ V |
| Total (IDA-3422-16) | I_{CC} | | | 640 | mA | $V_{CC} = 5.0$ V (All Segments/Digit) (See Note 2) |
| Total (IDA-3422-20) | I_{CC} | | | 800 | mA | $V_{CC} = 5.0$ V (All Segments/Digit) (See Note 2) |
| Supply Voltage | V_{CC} | 4.75 | 5.00 | 5.25 | V | |
| Input Voltage – High (All inputs) | V_{IH} | 3.5 | | | V | $V_{CC} = 5.0$ V \pm .25 V |
| Input Voltage – Low (All inputs) | V_{IL} | | | 0.8 | V | $V_{CC} = 5$ |
| Input Current – High (All inputs) | I_{IH} | | | 40 | μ A | $V_{CC} = 5.5$ V, $V_I = 2.4$ V |
| Input Current – Low (All inputs) | I_{IL} | | | 6.4 | mA | $V_{CC} = 5.5$ V, $V_I = 0.4$ V |
| Luminous Intensity Average Per Digit | I_V | | 0.8 | | mcd | $V_{CC} = 5.0$ V (8 Segments/Digit) |
| Peak Wavelength | λ_{peak} | | 660 | | nm | |
| Viewing Angle | | | ± 50 | | Deg | Vertical & Horizontal From Normal To Display Plane |

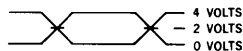
| Switching Characteristics @ 5 V | | | |
|---------------------------------|-----------|-----|-------|
| Parameter @ 25°C | Symbol | Min | Units |
| Write Pulse | T_W | 350 | nS |
| Address/ Setup Time | T_{AS} | 550 | nS |
| Data Setup Time | T_{DS} | 550 | nS |
| Write Setup | T_{WD} | 200 | nS |
| Data Hold Time | T_{DH} | 75 | nS |
| Address/ Hold Time | T_{AH} | 75 | nS |
| Clear Time | T_{CLR} | 15 | mS |

TIMING CHARACTERISTICS

WRITE CYCLE WAVEFORMS



TIMING MEASUREMENT
VOLTAGE LEVELS



System Overview

The Intelligent Display Assembly offers the designer a choice of either 16 or 20 alphanumeric characters and operates from just a +5-V supply. Based on the previously introduced Litronix DL-3422 four-character intelligent display, the IDA-3422 adds all the support logic required for direct connection to most microprocessor buses. The system interface takes place through a 20-pin connector, which has available on it the data and address lines as well as the control signals needed. One additional connector is used for the power and ground connections.

System Power Requirements

Operating from a single +5-V power supply, the IDA-3422 Series Assembly requires a typical operating current of 20 mA per digit with eight of the segments lit on each character. For the worst case condition with all segments lit, the current is 52 mA per digit and with the display blank the current is 1 mA per digit.

Display Interface

The display interface available on the 20-pin connector consists of seven data lines (D0 to D6), five address lines (A0 to A4), two unused pins, and various control signals. All address, data, and control lines have either pull-up or pull-down 1K ohm resistors.

\overline{BL} (Blanking, active low): When this line is pulled low, it causes the entire IDA display to go blank without affecting the contents of the display memory on the DL-3422s. \overline{BL} is active regardless of address or display enable lines. A flashing display can be realized by pulsing this line.

\overline{WR} (Write, active low): To store a character in the display memory, this line must be pulsed low for a minimum write time. See timing diagram for timing & relationships to other signals.

CUE (Cursor Enable, active high): When high, this line permits the cursor to be displayed (see Note 2), and when brought low, it disables the cursor function without affecting the stored value. CUE is active regardless of address or display enable lines. A flash-

ing cursor can be created by pulsing the CUE line low.

\overline{CU} (Cursor Select, active low): The cursor function (character with all segments lit) is loaded by selecting the digit address and holding \overline{CU} true. A "1" on D0 inserts the cursor. A "0" on D0 removes the cursor. The change occurs during a write pulse per the timing diagram.

\overline{CLR} (Clear, active low): When held low for one display multiplex cycle (see DL-3422 data sheet for more information) of 15 ms, this line will cause all stored characters in the display, except for the cursor, to be cleared. \overline{CLR} is active regardless of address or display enable lines.

$\overline{CE2}$ (Chip Enable, Active Low): To store a character in the display memory, this line must be held low at least 550 nanoseconds preceding the leading edge of the \overline{WR} pulse.

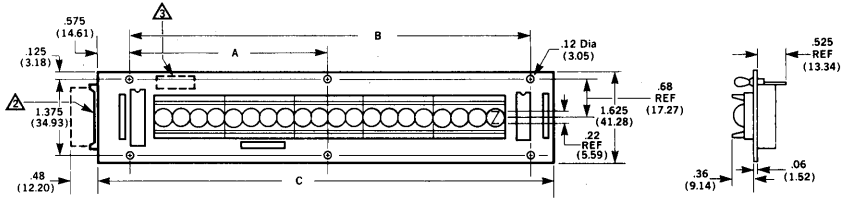
Address lines A0 to A4 are set up so that the right-most character is the lowest address. The left-most character is the highest address. Data lines are set up so that D0 is the least significant bit and D6 is the most significant bit.

Using the Display Interface

Through the use of memory-mapped I/O techniques, the IDA can be treated almost like a memory location — supply the data, address and proper control signals and the characters appear, with each character location independently addressable. The basic signal flow sequence to load a character would start with the address lines going to the desired address while the \overline{CLR} and \overline{BL} lines are high to permit the data to be loaded in and displayed. After the address has stabilized, the data can change to the desired values (including the cursor). After the data have stabilized, the \overline{WR} pulse is started, and must remain low for at least 350 ns. Signals must be held stable for 75 ns, minimum, after the rising edge of the \overline{WR} pulse to ensure correct loading, while the addresses must be stable for 550 ns preceding the same rising edge of the \overline{WR} pulse. See the timing diagram for a pictorial explanation.

- Notes: 1) CMOS Handling Precautions — App Note 18
2) Cursor should not be on any longer than 60 sec.
3) Cleaning solvents — use NO alcohol

Physical Dimensions

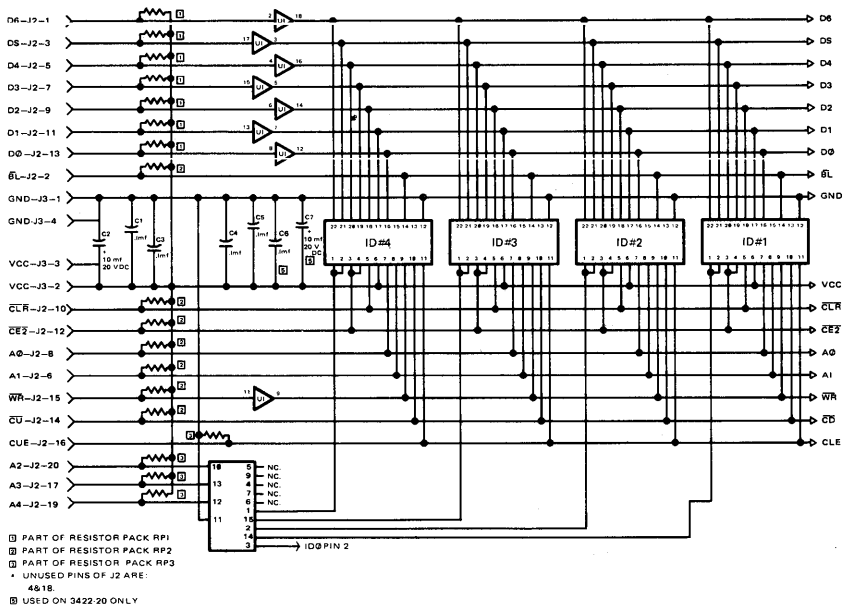
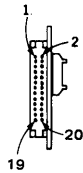


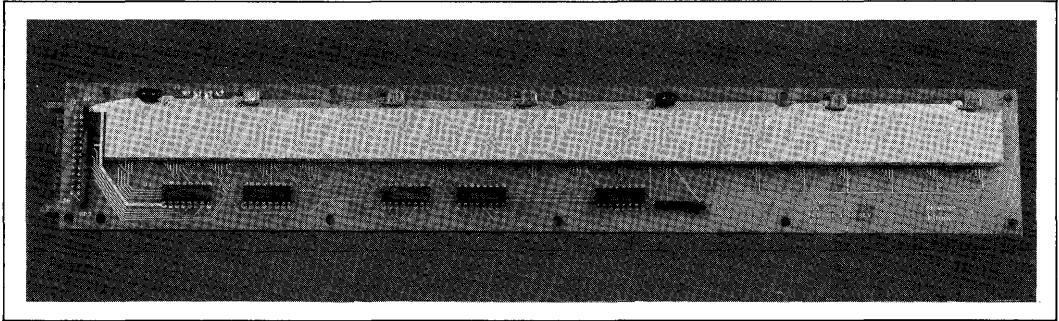
| PRODUCT | A | B | C |
|-------------|-----------------|------------------|------------------|
| IDA 3416-16 | 3.00 (76.20) | 6.00 (152.40) | 6.95 (176.58) |
| IDA 3416-20 | 3.65 (92.71) | 7.30 (185.42) | 8.25 (209.55) |

RECOMMENDED MATING CONNECTOR

| Connector | Function | Type | Suggested Mfg. |
|-----------|--------------|---------------|--|
| △ J2 | Control/Data | 20 Pin Ribbon | BERG P/N 65496-007 |
| △ J3 | Power | Molex | AMP P/N 1-87025-3 HOUSING P/N 87026-2 |

| PIN | FUNCTION | PIN | FUNCTION |
|-------|-----------------|-------|-------------------|
| J2-1 | D6 DATA LINE | J2-11 | DI DATA LINE |
| J2-2 | BL BLANKING | J2-12 | CE2 CHIP ENABLE |
| J2-3 | D5 DATA LINE | J2-13 | D0 DATA LINE |
| J2-4 | UNUSED | J2-14 | CU CURSOR SELECT |
| J2-5 | D4 DATA LINE | J2-15 | WR WRITE |
| J2-6 | A1 ADDRESS LINE | J2-16 | CUE CURSOR ENABLE |
| J2-7 | D3 DATA LINE | J2-17 | A3 ADDRESS LINE |
| J2-8 | A0 ADDRESS LINE | J2-18 | UNUSED |
| J2-9 | D2 DATA LINE | J2-19 | A4 ADDRESS LINE |
| J2-10 | CLR CLEAR | J2-20 | A2 ADDRESS LINE |
| J3-1 | GND | J3-3 | VCC |
| J3-2 | VCC | J3-4 | GND |





FEATURES

- A Complete Alphanumeric Display Assembly Utilizing the DLX-713X Series 5 x 7 Dot Matrix Display
 - Built-in Multiplex and LED Drive Circuitry
 - Built-in Memory
 - Built-in Character Generator
- Displays 96 Character ASCII Set, Including Both Upper and Lower Case Characters
- Direct Access to Each Digit Independently
- Three Brightness Levels
- Display Blank Function
- Lamp Test Function
- Wide Viewing Angle, $\pm 50^\circ$
- Readable in High Ambient Lighting
- Available in Orange and Green
- Choice of 16 or 20 Character Display Lengths
- Single 5.0 Volt Power Supply Requirement
- Easily Interfaced to a Microprocessor
- TTL Compatible
- Fully Buffered Inputs

DESCRIPTION

The IDA-713X Series Assembly is an extension of the single character DLX-713X, 5 x 7 fully intelligent dot matrix display. This display assembly provides the designer with circuitry for display maintenance, while minimizing the interaction and interface normally required between the user's system and a multiplexed alphanumeric display.

The assembly consists of DLX-713X's in a single row, together with the necessary address decoders and interface buffers, on a single printed circuit board. Each DLX-713X provides its own memory, ASCII ROM character generator, multiplexing circuitry, and drivers for the 35 LED dots.

Intelligent Display Assemblies can be used for applications such as P.O.S. terminals, message systems, industrial equipment, instrumentation, and any other products requiring a large, easily readable, "user friendly", alphanumeric display.

For additional information refer to Appnote 25. For cleaning we recommend De-ionized water, Isopropyl Alcohol, Freon TE or Freon TF.

Important: Refer to Appnote 18, "Using and Handling Intelligent Displays." Since this is a CMOS device, normal precautions should be taken to avoid static damage.

Specifications are subject to change without notice.

| Part Number | COLOR | Description |
|-------------|--------|---|
| IDA-7135-16 | Orange | Single Line, 16 Character Alphanumeric Display Utilizing the DLO-7135 |
| IDA-7137-16 | Green | Single Line, 16 Character Alphanumeric Display Utilizing the DLG-7137 |
| IDA-7135-20 | Orange | Single Line, 20 Character Alphanumeric Display Utilizing the DLO-7135 |
| IDA-7137-20 | Green | Single Line, 20 Character Alphanumeric Display Utilizing the DLG-7137 |

MAXIMUM RATINGS

| | |
|---|-----------------------------------|
| V _{CC} | 6.0 V |
| Voltage applied to any input | - 0.5 to V _{CC} + 0.5VDC |
| Operating Temperature | 0°C to + 65°C |
| Storage Temperature | - 20°C to + 65°C |
| Relative Humidity (non condensing) @ 65°C | 85% |

SWITCHING CHARACTERISTICS @ 5V

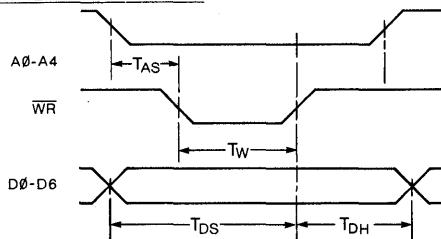
| Parameter @ 25°C | Symbol | Minimum | Units |
|------------------|-----------------|---------|-------|
| Write Pulse | T _w | 200 | ns |
| Data Setup Time | T _{DS} | 230 | ns |
| Hold Time | T _{DH} | 100 | ns |
| Address Setup | T _{AS} | 30 | ns |

OPTOELECTRONIC CHARACTERISTICS AT 25°C

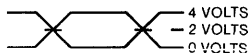
| Parameter | Symbol | Min | Typ | Max | Units | Test Conditions |
|---------------------------------|-----------------|------|--------------|------|-------|---|
| Supply Current/Digit | I _{CC} | | 170 | 220 | mA | V _{CC} = 5.0 V, $\overline{BL0} = \overline{BL1} = 1$ |
| Supply Current/Digit (Blank) | I _{CC} | | 5 | 10 | mA | V _{CC} = 5.0 V, $\overline{BL0} = \overline{BL1} = 0$ |
| Supply Current/Digit | I _{CC} | | 85 | | mA | V _{CC} = 5.0 V, $\overline{BL0} = 0, \overline{BL1} = 1$ |
| Supply Current/Digit | I _{CC} | | 42 | | mA | V _{CC} = 5.0 V, $\overline{BL0} = 1, \overline{BL1} = 0$ |
| Supply Voltage | V _{CC} | 4.75 | | 5.25 | VDC | |
| Input Voltage-High (All inputs) | V _{IH} | 2.7 | | | VDC | V _{CC} = 5.0V ± .25V |
| Input Voltage-Low (All inputs) | V _{IL} | | | 1.0 | VDC | V _{CC} = 5.0V |
| Input Current | I _{IL} | | | 160 | uA | V _{CC} = 5.0V |
| Luminous Intensity/Dot Average | I _v | | 250 | | μCD | V _{CC} = 5.0V |
| Peak Wave Length | | | | | | |
| IDA-7137 | | | 565 (Green) | | nm | |
| IDA-7135 | | | 640 (Orange) | | nm | |
| Viewing Angle | | | ± 50° | | Deg | |

TIMING CHARACTERISTICS

WRITE CYCLE WAVEFORMS



TIMING MEASUREMENT VOLTAGE LEVELS



SYSTEM OVERVIEW

The Intelligent Display Assembly offers the designer a choice of either 16 (IDA-713X-16) or 20 (IDA-713X-20) alphanumeric characters. Based on the DLX-713X intelligent dot matrix display, the IDA-713X adds all the support logic required for direct connection to most microprocessor buses. The system interface takes place through a 26 pin connector, which has the data and address lines as well as the control signals available on it. One additional connector is used for the power and ground connections.

SYSTEM POWER REQUIREMENTS

Operating from a single +5V power supply, the IDA-713X-16 requires a typical operating current of 2720 mA at brightest level. For the 20 character assembly, typical operating current is 3400 mA. For worst case conditions, the 16 character assembly draws 3520 mA, while the 20 character assembly draws 4400 mA. With the display blanked, the board circuitry for the 16 character assembly draws 80 mA, and the 20 character assembly draws 100 mA.

DISPLAY INTERFACE

The display interface available on the 26 pin connector consists of seven data lines (D0 to D6)* five address lines (A0 to A4, see Note 3), two brightness inputs ($\overline{BL0}$ to $\overline{BL1}$), lamp test (LT), the Chip Enable (CE), and the Write line (WR). All address and data lines have 1K ohm pull up resistors.

$\overline{BL0}$ and $\overline{BL1}$ (Brightness, active low): When both of these are pulled low, it causes the entire IDA display to go blank without affecting the contents of the display memory on the DLX-713X's. BL is active regardless of address or display enable lines. These two lines are used to vary the intensity of the display to one of four levels.

WR (Write, active low): To store a character in the display memory, this line must be pulsed low for a minimum of 200 ns. See timing diagram for timing and relationships to other signals.

LT (Lamp test, active low): This line can be pulsed to light all display dots.

*For IDA 713X-16 only.

Four address bits are used.

DIMMING AND BLANKING THE DISPLAY

| Brightness Level | $\overline{BL1}$ | $\overline{BL0}$ |
|------------------|------------------|------------------|
| Blank | 0 | 0 |
| ¼ Brightness | 0 | 1 |
| ½ Brightness | 1 | 0 |
| Full Brightness | 1 | 1 |

USING THE DISPLAY INTERFACE

Through the use of memory-mapped I/O techniques, the IDA can be treated almost like a memory location—supply the data, address and proper control signals and the characters appear, with each character location independently addressable. The basic signal flow sequence to load a character would start with the address lines going to the desired address. After the address has stabilized, the data can change to the desired values. After the data has stabilized, the WR pulse is started and must remain low for at least 200 ns to ensure correct loading. See the timing diagram for a pictorial explanation. Either BL0 or BL1 should be held high for displays to light up.

LAMP TEST

The lamp test (\overline{LT}) when activated causes all dots on the display to be illuminated at half brightness. The lamp test function is independent of write (WR) and the settings of the blanking inputs (BL0, BL1).

This convenient test gives a visual indication that all dots are functioning properly. Lamp test may also be used as a cursor function or pointer which does not destroy previously displayed characters.

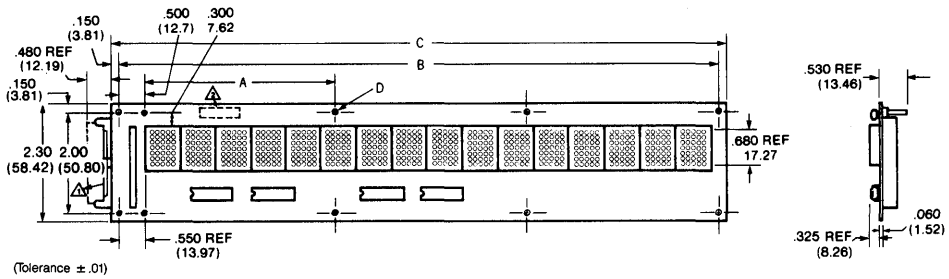
IDA 713X-XX* DIGIT ADDRESSING TRUTH TABLE

| Address Bit | | | | | Intelligent Display Device Number | | | | | | | | | | | | | | | | | | | |
|-------------|----|----|----|----|-----------------------------------|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|----|----|----|
| A4 | A3 | A2 | A1 | A0 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 |
| 0 | 0 | 0 | 0 | 0 | L | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 0 | 0 | 1 | H | L | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 0 | 1 | 0 | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 0 | 1 | 1 | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 1 | 0 | 0 | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 1 | 0 | 1 | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 1 | 1 | 0 | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 0 | 1 | 1 | 1 | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 1 | 0 | 0 | 0 | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 1 | 0 | 0 | 1 | H | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H | H |
| 0 | 1 | 0 | 1 | 0 | H | H | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H | H |
| 0 | 1 | 0 | 1 | 1 | H | H | H | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H | H |
| 0 | 1 | 1 | 0 | 0 | H | H | H | H | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H | H |
| 0 | 1 | 1 | 0 | 1 | H | H | H | H | H | H | H | H | H | H | H | H | L | H | H | H | H | H | H | H |
| 0 | 1 | 1 | 1 | 0 | H | H | H | H | H | H | H | H | H | H | H | H | H | L | H | H | H | H | H | H |
| 0 | 1 | 1 | 1 | 1 | H | H | H | H | H | H | H | H | H | H | H | H | H | H | L | H | H | H | H | H |
| 1 | 0 | 0 | 0 | 0 | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | L | H | H | H | H |
| 1 | 0 | 0 | 0 | 1 | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | L | L | H | H |
| 1 | 0 | 0 | 1 | 0 | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | L | L | H |
| 1 | 0 | 0 | 1 | 1 | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | H | L | L |

*Entire area is for 20 characters, smaller portion is for 16 characters.

CHARACTER SET

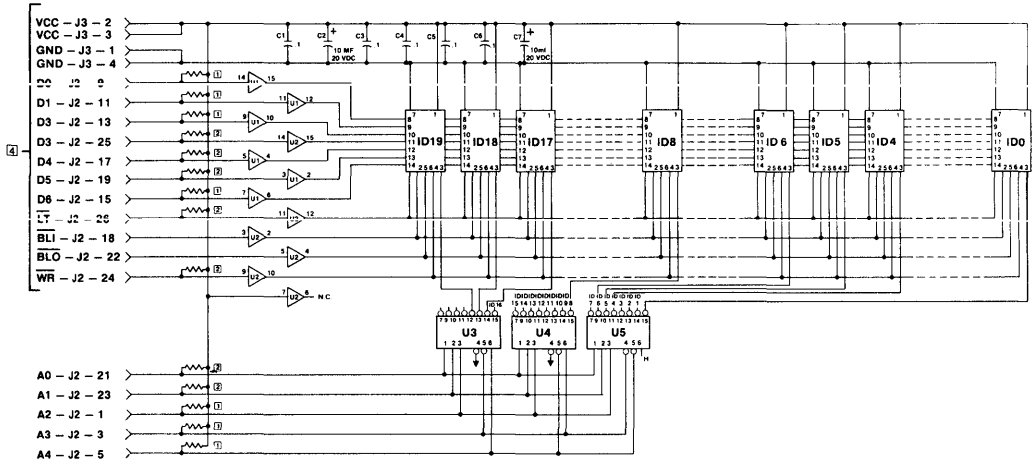
| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | L | H | |
|-----------|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| D1 | L | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H | H |
| D2 | L | L | L | L | L | H | H | H | H | L | L | L | L | L | L | H | H | H | H | L | L | L | L | L | L |
| D3 | L | L | L | L | L | L | L | L | L | L | L | H | H | H | H | H | H | H | L | L | L | L | L | L | |
| 0B0D04HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F | | | | | | | | | |
| L L L L | 0 | | | | | | | | | | | | | | | | | | | | | | | | |
| L L H | 1 | | | | | | | | | | | | | | | | | | | | | | | | |
| L H L | 2 | ! | " | # | \$ | % | & | ' | (|) | * | + | , | - | . | / | | | | | | | | | |
| L H H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > | ? | | | | | | | | |
| H L L | 4 | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | | | | | | | | | |
| H L H | 5 | p | q | r | s | t | u | v | w | x | y | z | [| \ |] | ^ | _ | | | | | | | | |
| H H L | 6 | " | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | | | | | | | | |
| H H H | 7 | " | a | b | c | d | e | f | g | h | i | j | k | l | m | n | o | | | | | | | | |



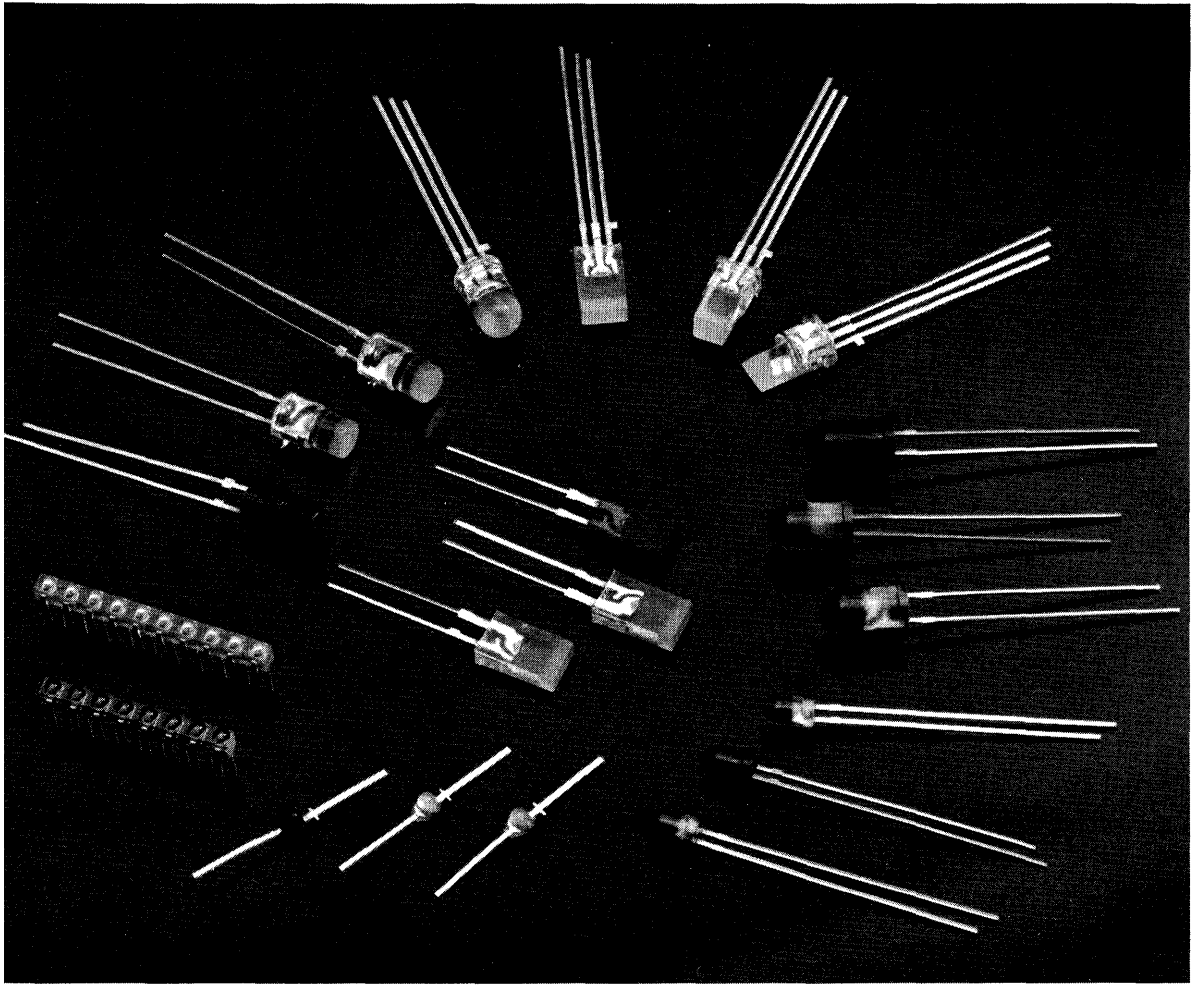
| Pin | Function | Pin | Function |
|-------|-----------------|-------|-----------------|
| J2-1 | A2 Address Line | J2-14 | No Connection |
| J2-2 | No Connection | J2-15 | D6 Data Line |
| J2-3 | A3 Address Line | J2-16 | No Connection |
| J2-4 | No Connection | J2-17 | D4 Data Line |
| J2-5 | A4 Address Line | J2-18 | BL1 Brightness |
| J2-6 | No Connection | J2-19 | D5 Data Line |
| J2-7 | No Connection | J2-20 | No Connection |
| J2-8 | No Connection | J2-21 | A0 Address Line |
| J2-9 | D0 Data Line | J2-22 | BLO Brightness |
| J2-10 | No Connection | J2-23 | A1 Address Line |
| J2-11 | D1 Data Line | J2-24 | WR Write |
| J2-12 | No Connection | J2-25 | D3 Data Line |
| J2-13 | D2 Data Line | J2-26 | LT Lamp Test |
| J3-1 | GND Ground | J3-3 | VCC |
| J3-2 | VCC | J3-4 | GND Ground |

| Product | A | B | C | D |
|-------------|-----------|----------|----------|---------------------------|
| IDA-7135-16 | 3.80 Typ. | 11.90 | 12.05 | .120 Typ 10 places (3.05) |
| IDA-7137-16 | (96.52) | (302.26) | (306.07) | |
| IDA-7135-20 | 3.55 Typ | 14.70 | 14.85 | .155 Typ 12 places (3.94) |
| IDA-7137-20 | (90.17) | (373.38) | (377.19) | |


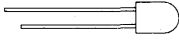



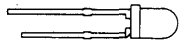

| RECOMMENDED MATING CONNECTOR | | | |
|------------------------------|--------------|---------------|--------------------|
| Connector | Function | Type | Suggest Mfg. |
| △ J2 | Control/Data | 26-Pin Ribbon | BERG P/N 65948-011 |
| △ J3 | Power | Molex | AMP P/N 87066-4 |



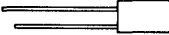





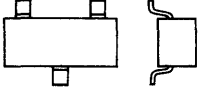
NOTE: ① Part of Resistor Pack RP1 (1K SIP)
 ② Part of Resistor Pack RP2 (1K SIP)
 ③ Address bits A0-A4 are decoded by ICs, U3-U5 to enable ID0-ID19.
 ④ All like lines on all displays are tied together; e.g., LT, WR, BL1, BLO, etc.



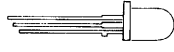

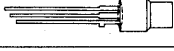
LED LAMPS

| Package Type and Spacing | Package Outline | Color | Part Number | Lens | Viewing Angle | Luminous Intensity | | Max Fwd. Current (mA) | Page | | | | |
|---|---|--|---|---------------------|---------------|--------------------|------|-----------------------|------|--------------|-----|-----|----|
| | | | | | | (mcd) | (mA) | | | | | | |
| T1 1/4 5mm 1" Leads 100 mil lead spacing No standoffs |  | Red | LDR5101 | Red Diffused | 70° | 1.0 | 20 | 100 | 173 | | | | |
| | | | LDR5102 | | | 2.5 | | | | | | | |
| | | | LDR5103 | | | 4.0 | | | | | | | |
| | | High Efficiency Red | LDH5121 | | | 2.0 | | | | | | | |
| | | | LDH5122 | | | 4.0 | | | | | | | |
| | | | LDH5123 | | | 6.0 | | | | | | | |
| | | Yellow | LDY5161 | Yellow Diffused | | 1.0 | 10 | 60 | | | | | |
| | | | LDY5162 | | | 2.5 | | | | | | | |
| | | | LDY5163 | | | 4.0 | | | | | | | |
| | | Green | LDG5171 | Green Diffused | | 2.5 | | | | 20 | 60 | | |
| | | | LDG5172 | | | 6.0 | | | | | | | |
| | | T1 1/4 5mm 1" Leads 100 mil lead spacing No standoffs Low profile Flangeless |  | Red | | LDR1201 | | | | Red Diffused | 70° | 1.0 | 20 |
| Yellow | LDY1231 | | | Yellow Diffused | 1.0 | 20 | 60 | | | | | | |
| Green | LDG1251 | | | Green Diffused | 2.5 | 20 | 60 | | | | | | |
| T1 1/4 5mm 1" Leads 100 mil lead spacing With standoffs |  | Red | LDR5001 | Red Diffused | 70° | 1.0 | 20 | 100 | 165 | | | | |
| | | | LDR5002 | | | 2.5 | | | | | | | |
| | | | LDR5003 | | | 4.0 | | | | | | | |
| | | High Efficiency Red | LDH5021 | | | 20 | | | | | | | |
| | | | LDH5022 | | | 4.0 | | | | | | | |
| | | | LDH5023 | | | 6.0 | | | | | | | |
| | | Yellow | LDY5061 | Yellow Diffused | | 1.0 | 10 | 60 | | | | | |
| | | | LDY5062 | | | 2.5 | | | | | | | |
| | | | LDY5063 | | | 4.0 | | | | | | | |
| | | Green | LDG5071 | Green Diffused | | 2.5 | | | | 20 | 60 | | |
| | | | LDG5072 | | | 6.0 | | | | | | | |
| | | T1 1/4 5mm 1" leads 100 mil lead spacing No standoffs |  | Red | | LDR5091 | | | | Red Clear | 24° | 2.5 | 20 |
| LDR5092 | 4.0 | | | | | | | | | | | | |
| LDR5093 | 10 | | | | | | | | | | | | |
| High Efficiency Red | LDH5191 | | | Orange Clear | 10 | 10 | 60 | | | | | | |
| | LDH5192 | | | | 20 | | | | | | | | |
| | LDH5193 | | | | 30 | | | | | | | | |
| Yellow | LDY5301 | | | Yellow Clear | 10 | | | 20 | 60 | | | | |
| | LDY5392 | | | | 20 | | | | | | | | |
| | LDY5393 | | | | 30 | | | | | | | | |
| Green | LDG5591 | | | Water Clear | 40 | 20 | 60 | | | | | | |
| | LDG5592 | | | | 80 | | | | | | | | |
| T1 1/4 5mm 1" leads 100 mil lead spacing No standoffs |  | | | Blue | SFH710 | Water Clear | 16° | | | .05 | | 20 | 40 |
| | | T1 3mm 1" leads 100 mil lead spacing No standoffs |  | Red | LDR1101 | Red Diffused | 70° | 1.0 | 20 | 100 | 149 | | |
| | | | | | LDR1102 | | | 2.0 | | | | | |
| | | | | | LDR1103 | | | 4.0 | | | | | |
| | | | | High Efficiency Red | LDH1111 | | | 2.5 | | | | | |
| | | | | | LDH1112 | | | 4.0 | | | | | |
| | | | | | LDH1113 | | | 6.0 | | | | | |
| | | | | Yellow | LDY1131 | Yellow Diffused | | 1.0 | 10 | 60 | | | |
| | | | | | LDY1132 | | | 2.0 | | | | | |
| | | | | | LDY1133 | | | 4.0 | | | | | |
| | | | | Green | LDG1151 | Green Diffused | | 2.5 | | | | 20 | 60 |
| | | | | | LDG1152 | | | 6.0 | | | | | |
| LDG1153 | 10 | | | | | | | | | | | | |
| T1 3mm 1" leads 50 mil lead spacing No standoffs |  | Red | LDR3501 | Red Diffused | 70° | 1.0 | 20 | 100 | 157 | | | | |
| | | | LDR3502 | | | 2.0 | | | | | | | |
| | | | LDR3503 | | | 4.0 | | | | | | | |
| | | High Efficiency Red | LDH3521 | | | 2.5 | | | | | | | |
| | | | LDH3522 | | | 4.0 | | | | | | | |
| | | | LDH3523 | | | 6.0 | | | | | | | |
| | | Yellow | LDY3561 | Yellow Diffused | | 1.0 | 10 | 60 | | | | | |
| | | | LDY3562 | | | 2.5 | | | | | | | |
| | | | LDY3562 | | | 4.0 | | | | | | | |
| | | Green | LDG3571 | Green Diffused | | 2.5 | | | | 20 | 60 | | |
| | | | LDG3572 | | | 6.0 | | | | | | | |

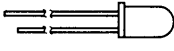


LED LAMPS

| Package Type and Spacing | Package Outline | Color | Part Number | Lens | Viewing Angle | Luminous Intensity | | Max Fwd. Current (mA) | Page |
|---|---|------------------------|----------------|-----------------|---------------|--------------------|------|--------------------------------|-------|
| | | | | | | (mcd) | (mA) | | |
| 5mm Rectangular 1" Leads |  | Red | LDR3701 | Red Diffused | 100° | 20 | 60 | 161 | |
| | | | LDR3702 | | | | | | |
| | | | LDR3702 | | | | | | |
| | | High Efficiency Red | LDH3601 | | | | | | |
| | | LDH3602 | | | | | | | |
| | | LDH3603 | | | | | | | |
| | | Yellow | LDY3801 | Yellow Diffused | | | | | |
| | | | LDY3802 | | | | | | |
| | | | LDY3803 | | | | | | |
| | | Green | LDG3901 | Green Diffused | | | | | |
| | | | LDG3902 | | | | | | |
| | | | LDG3903 | | | | | | |
| 5mm Cylindrical 1" Leads |  | Red | LDR5701 | Red Diffused | 100° | 20 | 60 | 177 | |
| | | | LDR5702 | | | | | | |
| | | | LDR5702 | | | | | | |
| | | High Efficiency Red | LDH5601 | | | | | | |
| | | LDH5602 | | | | | | | |
| | | LDH5602 | | | | | | | |
| | | Yellow | LDY5801 | Yellow Diffused | | | | | |
| | | | LDY5802 | | | | | | |
| | | | LDY5803 | | | | | | |
| | | Green | LDG5901 | Green Diffused | | | | | |
| | | | LDG5902 | | | | | | |
| | | | LDG5903 | | | | | | |
| Miniature Axial Lead |  | Red | RL-50 | Water Clear | 90° | 10 | 40 | 181 | |
| | | | RL-54 | Red Diffused | | | | 183 | |
| Miniature Axial Lead High dome lens |  | Red | RL-55 | Red Diffused | 50° | 10 | 40 | 185 | |
| | | | YL-56 | Yellow Diffused | 40° | | | 187 | |
| | | GL-56 | Green Diffused | 1.0 | 25 | | | | |
| Miniature Radial Lead 100 mil lead spacing |  | Red | LDR461 | Red Diffused | 100° | 0.6 | 20 | 35 | |
| | | Yellow | LDY481 | Yellow Diffused | | | | 143 | |
| | | Green | LDG471 | Green Diffused | | | | 25 | |
| 2-Element Array |  | Red | LDR462 | Red Diffused | 100° | 0.6 | 20 | 35 | |
| 3-Element Array | | | LDR463 | | | | | | |
| 4-Element Array | | | LDR464 | | | | | | |
| 5-Element Array | | | LDR465 | | | | | | |
| 6-Element Array | | | LDR466 | | | | | | |
| 7-Element Array | | | LDR467 | | | | | | |
| 8-Element Array | | | LDR468 | | | | | | |
| 9-Element Array | | | LDR469 | | | | | | |
| 10-Element Array | | | LDR460 | | | | | | |
| 2-Element Array | | | LDG472 | | | | | | Green |
| 3-Element Array | | LDG473 | | | | | | | |
| 6-Element Array | | LDG476 | | | | | | | |
| 8-Element Array | | LDG478 | | | | | | | |
| 10-Element Array | | LDG470 | | | | | | | |
| SOT23 Subminiature 1.3mm by 3mm by 1mm high |  | H.E. Red | LDH2310 | Water Clear | 140° | 1.0 | 20 | 12.5 (30 on ceramic substrate) | |
| | | High Efficiency Yellow | LDY2320 | | | | | | |
| | | Green | LDG2330 | | | | | | |
| | | Red and Green | LDRG2340 | | | | | | |



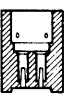

MULTICOLOR LED LAMPS

| Package Type and Spacing | Package Outline | Color | Part Number | Lens | Viewing Angle | Luminous Intensity | | Max Fwd. Current (mA) | Page |
|-----------------------------|---|---------------|-------------|-------------|---------------|--------------------|------|-----------------------|------|
| | | | | | | (mcd) | (mA) | | |
| T1½ 5mm 1" Leads |  | Red and Green | LD1005 | Water Clear | 100° | 2.5 | 20 | 60 | 133 |
| | | | LD1006 | | | 4.0 | | | |
| | | | LD1007 | | | 6.3 | | | |
| 5mm Rectangular 1" Leads |  | Red and Green | LD1103 | Water Clear | 100° | 1.0 | 20 | 60 | 135 |
| | | | LD1104 | | | 1.6 | | | |
| | | | LD1105 | | | 2.5 | | | |
| 5mm Cylindrical 1" Leads |  | Red and Green | LD1133 | Water Clear | 100° | | 20 | 60 | 137 |
| | | | LD1134 | | | | | | |
| | | | LD1135 | | | | | | |

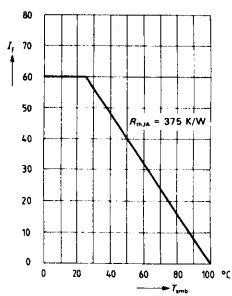
RESISTOR LED LAMPS

| Package Type and Spacing | Package Outline | Color | Part Number | Lens | Viewing Angle | Luminous Intensity | | Max Fwd. Voltage | Page |
|--|---|----------------|-------------|-----------------|---------------|--------------------|---------|------------------|------|
| | | | | | | (mcd) | (Volts) | | |
| T1½ 5mm 1" Leads No standoff |  | Red | RRL-3105 | Red Diffused | 70° | 1.0 | 5 | 15 | 191 |
| | | | RRL-3112 | | | 1.0 | 12 | | |
| T1 3mm 1" Leads |  | Red | RRL-1100 | Red Diffused | 70° | 1.0 | 5 | 15 | 189 |
| Miniature Axial Lead High Dome Lens |  | Red | RRL-5601 | Red Diffused | 40° | 0.3 | 5 | 6 | 193 |
| | | | RRL-5621 | | | 0.6 | | | |
| | | | RRL-5641 | | | 1.0 | | | |
| | | Yellow | RYL-5621 | Yellow Diffused | | 0.3 | | | 195 |
| Green | RGL-5621 | Green Diffused | 0.2 | | | | | | |

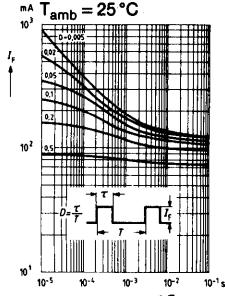
LAMP ACCESSORIES

| Type | Package | Part Number | Color | Description | Page |
|---------------------------|---|----------------------|----------------|--|------|
| T1½ Clip |  | 004-9002 004-9003 | Black Clear | Mounting Clip and Collar for T1½ LED's | 199 |
| T1 Clip |  | 004-9015 006-9016 | Clear Black | Mounting Clip and Collar for T1 LED's | |
| Right Angle Mounting Part |  | 004-9019 | Black | Allows right angle mounting of lamps to PC boards and other surfaces | |
| Reflector |  | 004-9020 | Polished | Increases lighted area of T1½ LED's | |

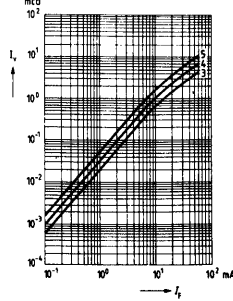
MAX. PERMISSIBLE FORWARD CURRENT
 $I_F = f(T_{amb})$



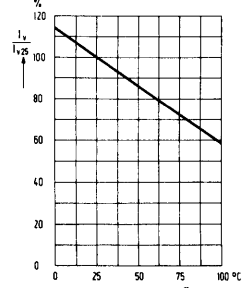
PERM. PULSE HANDLING CAPABILITY $I_F = f(t)$
 Duty Cycle $D = \text{Parameter}$;
 $T_{amb} = 25^\circ\text{C}$



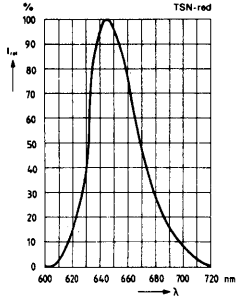
LUMINOUS INTENSITY
 $I_V = f(I_F)$



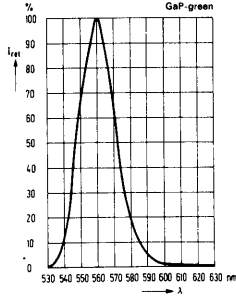
LUMINOUS INTENSITY
 $\frac{I_V}{I_{V25}} = f(T_{amb})$



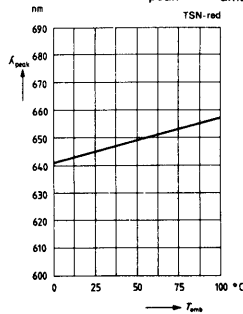
RELATIVE SPECTRAL EMISSION $I_{rel} = f(\lambda)$
 TSN-red



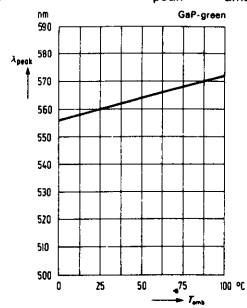
RELATIVE SPECTRAL EMISSION $I_{rel} = f(\lambda)$
 GaP-green



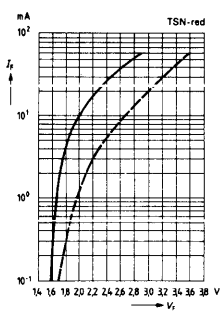
WAVELENGTH OF PEAK EMISSION $\lambda_{peak} = f(T_{amb})$
 TSN-red



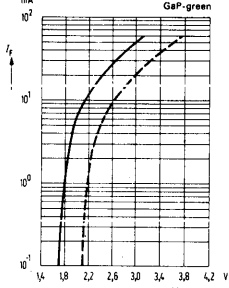
WAVELENGTH OF PEAK EMISSION $\lambda_{peak} = f(T_{amb})$
 GaP-green



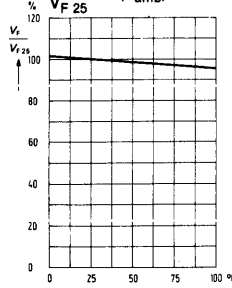
FORWARD CURRENT $I_F = f(V_F)$
 TSN-red



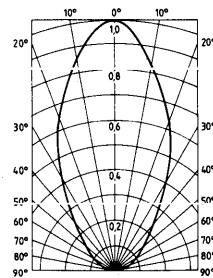
FORWARD CURRENT $I_F = f(V_F)$
 GaP-green



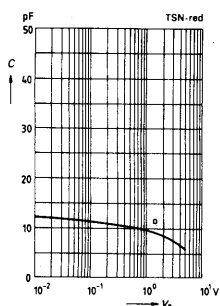
FORWARD VOLTAGE
 $\frac{V_F}{V_{F25}} = f(T_{amb})$



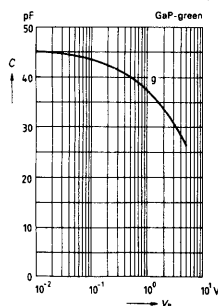
RADIATION CHARACTERISTIC
 $I_{rel} = f(\varphi)$



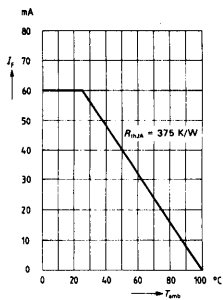
CAPACITANCE $C = f(V_F)$
 TSN-red



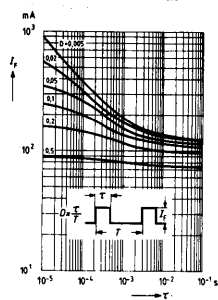
CAPACITANCE $C = f(\varphi)$
 GaP-green



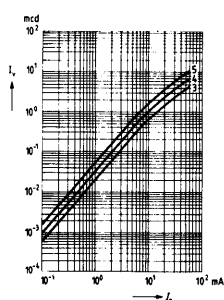
Max. permissible forward current
 $I_f = f(T_{amb})$



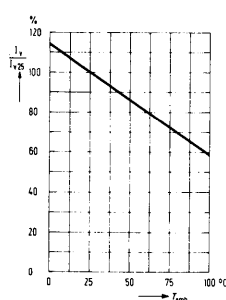
Perm. pulse handling capability
 $I_f = f(\tau)$
 Duty cycle $D = \text{parameter}$; $T_{amb} = 25^\circ\text{C}$



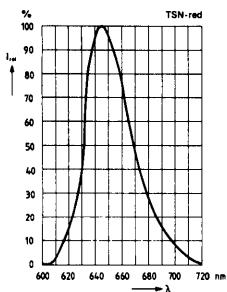
Luminous intensity $I_v = f(I_f)$



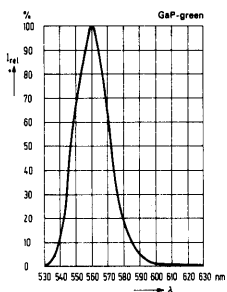
Luminous intensity $\frac{I_v}{I_{v25}} = f(T_{amb})$



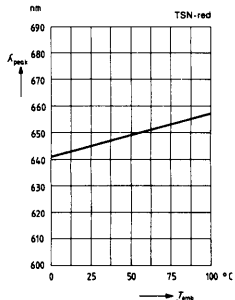
Relative spectral emission $I_{rel} = f(\lambda)$



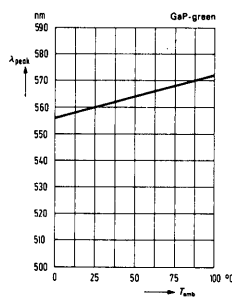
Relative spectral emission $I_{rel} = f(\lambda)$



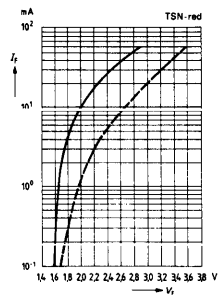
Wavelength of peak emission $\lambda_{peak} = f(T_{amb})$



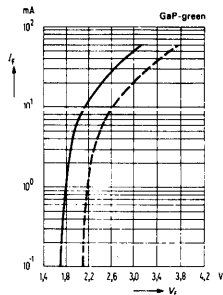
Wavelength of peak emission $\lambda_{peak} = f(T_{amb})$



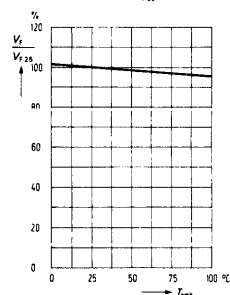
Forward current $I_f = f(V_f)$



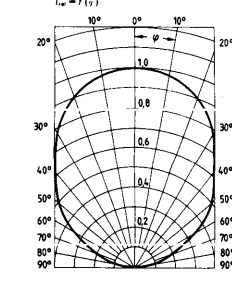
Forward current $I_f = f(V_f)$



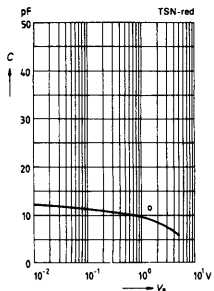
Forward voltage $\frac{V_f}{V_{f25}} = f(T_{amb})$



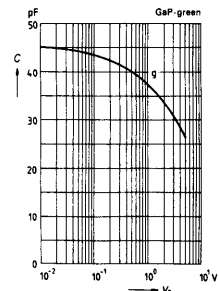
Radiation characteristic $I_{rel} = f(\psi)$



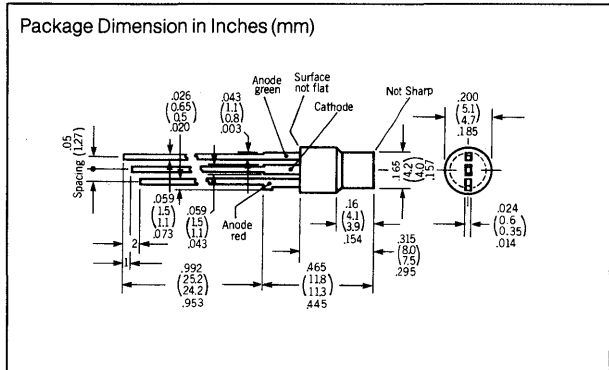
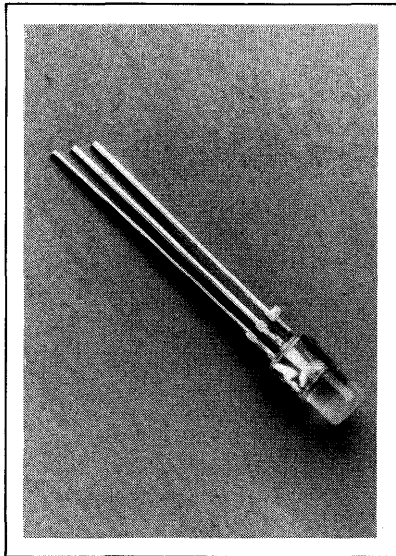
Capacitance $C = f(V_f)$



Capacitance $C = f(V_f)$



TWO COLOR RED AND GREEN CYLINDER LED LAMP



FEATURES

- Cylinder Shape
- Colorless Lens
- Two Color Operation, Red and Green
- Three Leads, One of Which Is Common Cathode
- Minimum Lead Length 1"
- .05" Lead Spacing

DESCRIPTION

The LD 1133 series has a colorless case with square, luminous area and a diffuser layer. Two chips (GaP-green and TSN-red) allow use as optical indicator with two functions.

Because of its very low current consumption and hence low inherent heating as well as high vibration resistance and long service life, this LED is suitable for applications where signal lamps are not or only inadequately useful. Moreover, the LED can be driven by TTL ICs.

Maximum Ratings

| | |
|---|---------------|
| Reverse Voltage (V_R) | 5 V |
| Forward Current* (I_F) | 60 mA |
| Surge Current (I_{FS}), $t \leq 10 \mu s$ * | 1 A |
| Storage Temperature (T_{stg}) | -55 to +100°C |
| Junction Temperature (T_J) | 100°C |
| Power Dissipation (P_{tot}), $T_{amb} = 25^\circ C$ | 200 mW |
| Thermal Resistance Junction-Air (R_{thJA}) | 375 K/W |

Characteristics ($T_{amb} = 25^\circ C$)

| Parameter | Symbol | TSN-red | GaP-green | Unit |
|--|------------------|-------------|-----------|---------|
| Wavelength of the Emitted Light | λ_{peak} | 645 ± 15 | 560 ± 15 | nm |
| Dominant Wavelength | λ_{dom} | 638 | 561 | nm |
| Aperture Cone (Half Angle) (Limits for 50% of Luminous Intensity I_v) | φ | 50 | | degrees |
| Lateral Emission of Light Screened | | | | |
| Forward Voltage ($I_F = 20$ mA) | V_F | 2.4 (≤ 3.0) | | V |
| Reverse Current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | | μA |
| Rise Time | t_r | 100 | 50 | ns |
| Fall Time | t_f | 100 | 50 | ns |
| Capacitance ($V_R = 0$ V, $f = 1$ MHz) | C_O | 12 | 45 | pF |

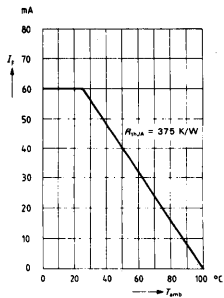
Luminous Intensity

| Type | Min | Unit | Test Condition |
|---------|-----|------|----------------|
| LD 1133 | 1.0 | mcd | 20 mA |
| LD 1134 | 1.6 | mcd | 20 mA |
| LD 1135 | 2.5 | mcd | 20 mA |

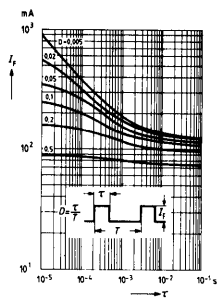
*The ratings indicated for the forward current I_F or the surge current I_{FS} , respectively, are maximum ratings of the component. If both chips are operated simultaneously, the sum of the forward current ratings is not allowed to exceed the indicated maximum value.

Specifications are subject to change without notice.

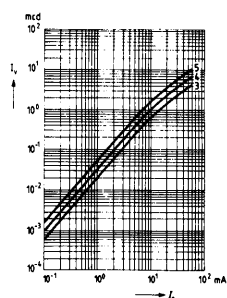
Max. permissible forward current
 $I_f = f(T_{amb})$



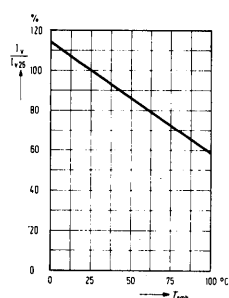
Perm. pulse handling capability
 $I_f = f(\tau)$
 Duty cycle D = parameter; $T_{amb} = 25^\circ\text{C}$



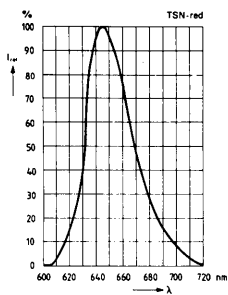
Luminous intensity $I_v = f(I_f)$



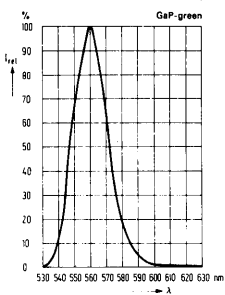
Luminous intensity $\frac{I_v}{I_{v,25}} = f(T_{amb})$



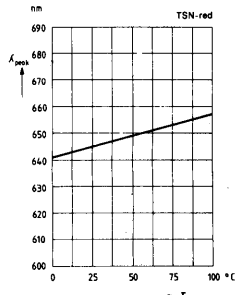
Relative spectral emission $I_{rel} = f(\lambda)$



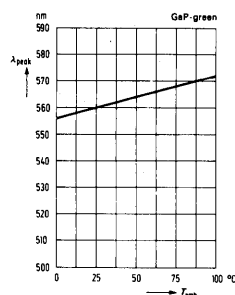
Relative spectral emission $I_{rel} = f(\lambda)$



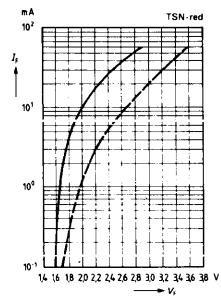
Wavelength of peak emission
 $\lambda_{peak} = f(T_{amb})$



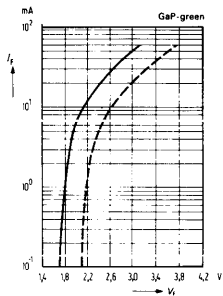
Wavelength of peak emission
 $\lambda_{peak} = f(T_{amb})$



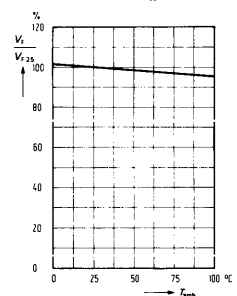
Forward current $I_f = f(V_f)$



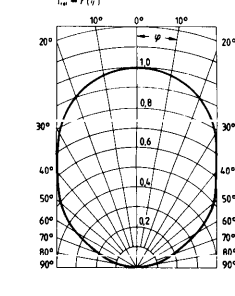
Forward current $I_f = f(V_f)$



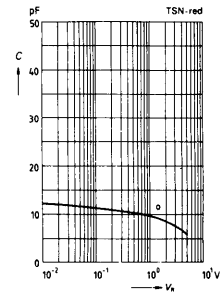
Forward voltage $\frac{V_f}{V_{f,25}} = f(T_{amb})$



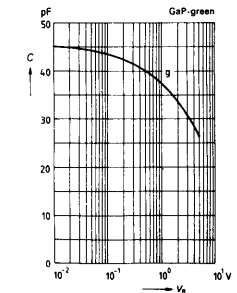
Radiation characteristic
 $I_v = f(\psi)$

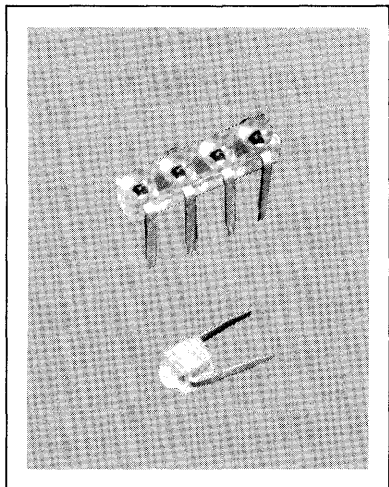


Capacitance $C = f(V_f)$



Capacitance $C = f(V_f)$





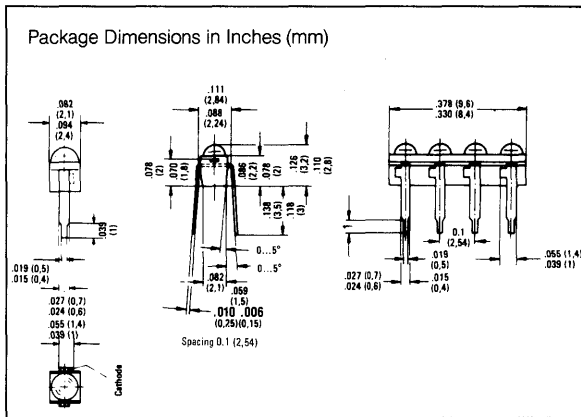
FEATURES

- Green Clear Lens
- Miniature Size
- Selection of 2 thru 10 Diode Arrays As Well As A Single Device
- 1/10" Lead Spacing
- End Stackable to Arrays of Any Length
- I/C Compatible

DESCRIPTION

The LDG 470 Series are green gallium phosphide LED solid state lamps. They have a green plastic encapsulation formed as a lens where the light is emitted. The single lamps or arrays may be used individually or stacked together to form lines of any lengths. Typical applications are position indicators such as meters and scales.

Package Dimensions in Inches (mm)



Maximum Ratings (Individual Diode)

| | | | |
|--|--------------|------------|-------------|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 25 | mA |
| Surge current ($t \leq 10 \mu s$) | I_{FS} | 0.5 | A |
| Storage temperature | T_{ster} | -30 to +80 | $^{\circ}C$ |
| Junction temperature | T_j | 80 | $^{\circ}C$ |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3 s$) | T_s | 230 | $^{\circ}C$ |
| Power dissipation ($T_{amb} = 25^{\circ}C$) | P_{tot} | 85 | mW |
| Thermal resistance | R_{thJamb} | 750 | K/W |
| Junction to air | R_{thJA} | 650 | K/W |
| Junction to solder pin | | | |

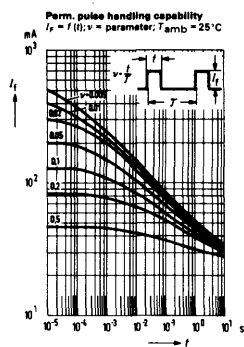
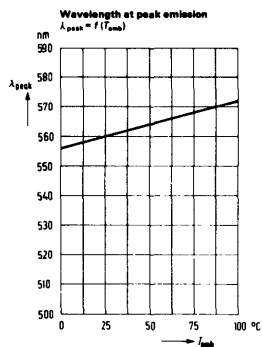
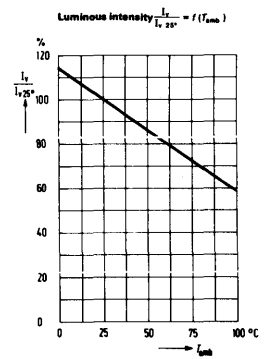
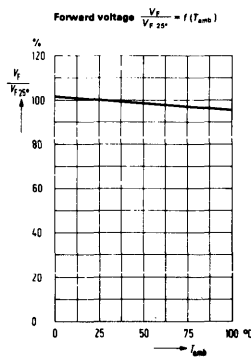
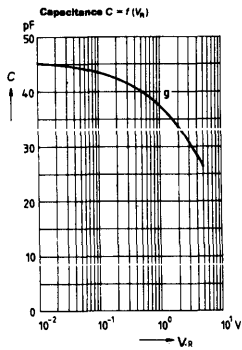
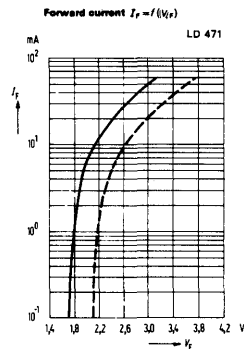
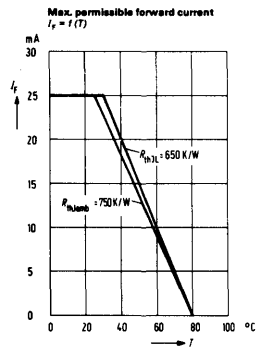
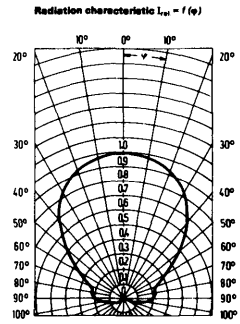
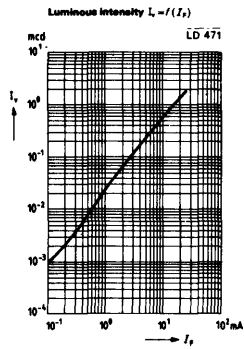
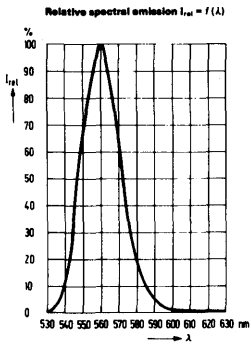
Characteristics ($T_{amb} = 25^{\circ}C$)

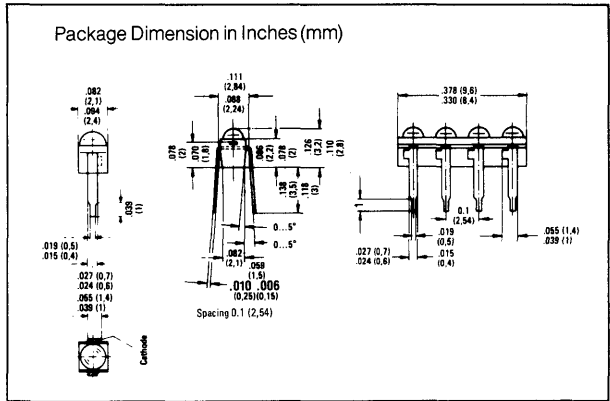
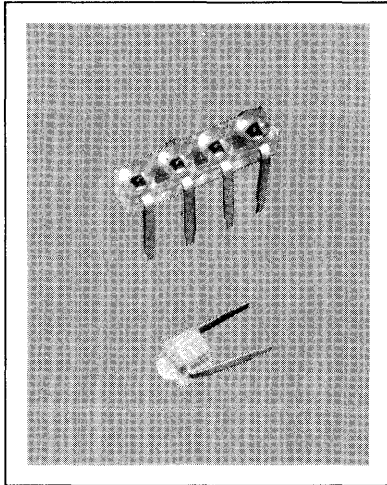
| | | | |
|--|------------------|--------------|---------|
| Wavelength at peak emission | λ_{peak} | 560 \pm 15 | nm |
| Dominant wavelength | λ_{dom} | 561 | nm |
| Viewing Angle (limits for 50% of luminous intensity I_v) | ψ | 100 | degree |
| Forward voltage ($I_F = 20 mA$) | V_F | 2.4 (~ 3.0) | V |
| Reverse current ($V_R = 3 V$) | I_R | 0.1 (~ 10) | μA |
| Capacitance ($V_R = 0 V$) | C_0 | 45 | pF |
| Rise time | t_r | 50 | ns |
| Fall time | t_f | 50 | ns |

Luminous Intensity

| New P/N | Replaces P/N | Number of LEDs | mcd (Min.) | Test Condition |
|---------|--------------|----------------|------------|----------------|
| LDG 471 | LD 471 | 1 | .6 | 20 mA |
| LDG 472 | LD 472 | 2 | .6 | 20 mA |
| LDG 473 | LD 473 | 3 | .6 | 20 mA |
| LDG 476 | LD 476 | 6 | .6 | 20 mA |
| LDG 478 | LD 478 | 8 | .6 | 20 mA |
| LDG 470 | LD 470 | 10 | .6 | 20 mA |

Specifications are subject to change without notice.





FEATURES

- Red Clear Lens, Emits Red Light
- Miniature Size
- Selection of 2 thru 10 Diode Arrays As Well As A Single Device
- 1/10" Lead Spacing
- End Stackable to Arrays of Any Length
- I/C Compatible

DESCRIPTION

The LDR 460 Series are red gallium arsenide phosphide LED solid state lamps. They have red plastic encapsulation formed as a lens where the light is emitted. The single lamps or arrays may be used individually or stacked together to form lines of any lengths. Typical applications are position indicators such as meters and scales.

Maximum Ratings (Individual Diode)

| | | | |
|--|--------------|------------|--------------|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 35 | mA |
| Surge current (t: 10 μ s) | I_{FS} | 1.0 | A |
| Storage temperature | T_{stor} | -30 to +80 | $^{\circ}$ C |
| Junction temperature | T_j | 80 | $^{\circ}$ C |
| Soldering temperature in a 2 mm distance from the case bottom (t: 3 s) | T_s | 230 | $^{\circ}$ C |
| Power dissipation ($T_{amb} = 25^{\circ}$ C) | P_{tot} | 85 | mW |
| Thermal resistance | | | |
| Junction to air | $R_{th,amb}$ | 750 | K/W |
| Junction to solder pin | $R_{th,jL}$ | 650 | K/W |

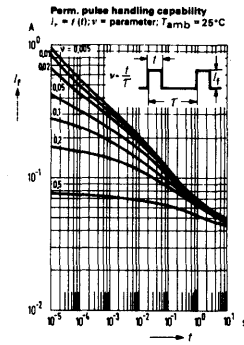
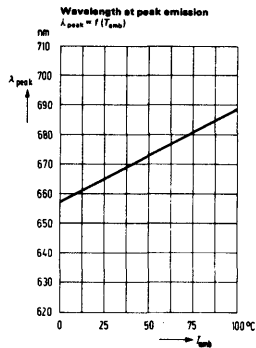
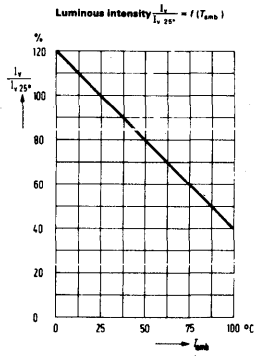
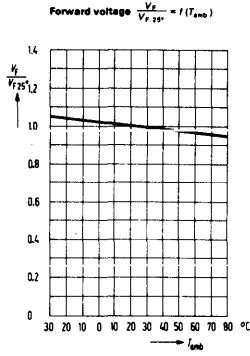
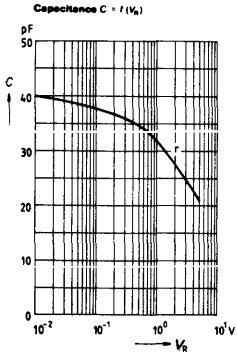
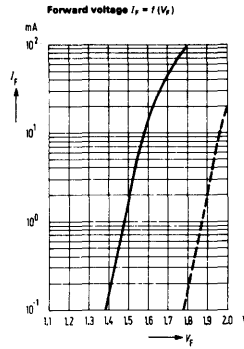
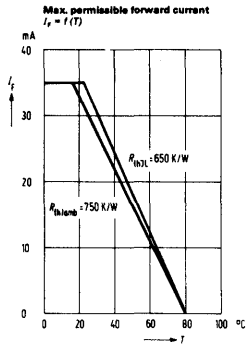
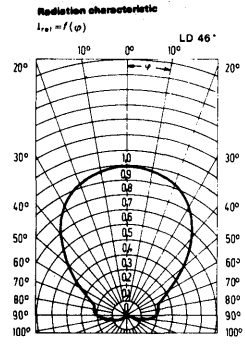
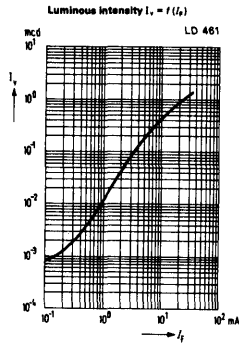
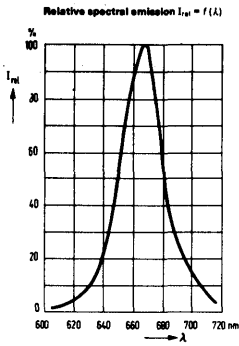
Characteristics ($T_{amb} = 25^{\circ}$ C)

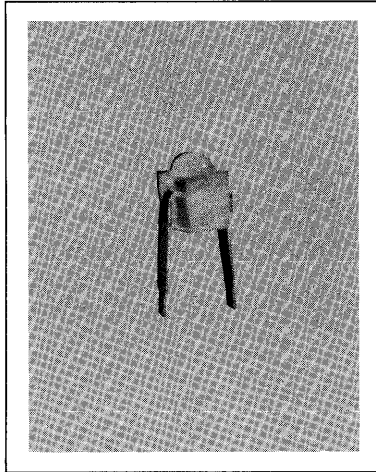
| | | | |
|---|------------------|----------------|---------|
| Wavelength at peak emission | λ_{peak} | 665 \cdot 15 | nm |
| Dominant wavelength | λ_{dom} | 645 | nm |
| Viewing angle (limits for 50% of luminous intensity I_v) | η | 100 | degree |
| Forward voltage ($I_F = 20$ mA) | V_F | 1.6 (2.0) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (10) | μ A |
| Rise time | t_r | 5 | ns |
| Fall time | t_f | 5 | ns |
| Capacitance ($V_R = 0$ V) | C_0 | 40 | pF |

Luminous Intensity

| New P/N | Replaces P/N | Number of LEDs | md (Min.) | Test Condition |
|---------|--------------|----------------|-----------|----------------|
| LDR 461 | LD 461 | 1 | .6 | 20 mA |
| LDR 462 | LD 462 | 2 | .6 | 20 mA |
| LDR 463 | LD 463 | 3 | .6 | 20 mA |
| LDR 464 | LD 464 | 4 | .6 | 20 mA |
| LDR 465 | LD 465 | 5 | .6 | 20 mA |
| LDR 466 | LD 466 | 6 | .6 | 20 mA |
| LDR 467 | LD 467 | 7 | .6 | 20 mA |
| LDR 468 | LD 468 | 8 | .6 | 20 mA |
| LDR 469 | LD 469 | 9 | .6 | 20 mA |
| LDR 460 | LD 460 | 10 | .6 | 20 mA |

Specifications are subject to change without notice.



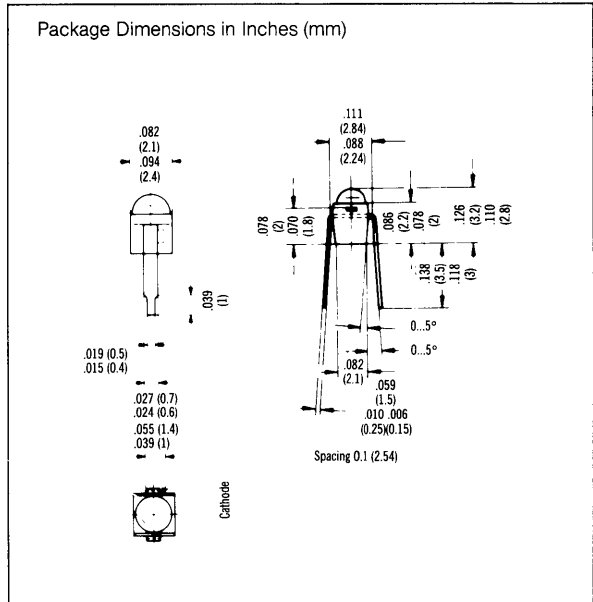


FEATURES

- Yellow Clear Lens
- Miniature Size
- 1/10" Lead Spacing
- End Stackable to Arrays of Any Length
- I/C Compatible

DESCRIPTION

The LDY 481 is a yellow gallium phosphide LED solid state lamp. It has a yellow plastic encapsulation formed to a lens where the light is emitted. (Previous P/N was LD 480)



Maximum Ratings

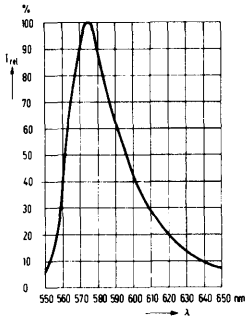
| | | | |
|--|--------------|------------|-----|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 25 | mA |
| Surge current ($t \leq 10 \mu s$) | I_{FS} | 0.5 | A |
| Storage temperature | T_{stor} | -30 to +80 | °C |
| Junction temperature | T_j | 80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3 s$) | T_s | 230 | °C |
| Power dissipation ($T_L = 25^\circ C$) | P_{tot} | 85 | mW |
| Thermal resistance | R_{thJamb} | 750 | K/W |
| Junction to air | R_{thJL} | 650 | K/W |
| Junction to solder pin | | | |

Characteristics ($T_{amb} = 25^\circ C$)

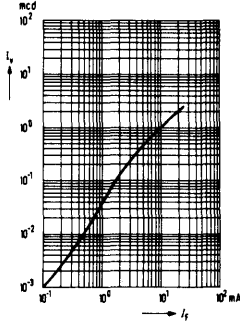
| | | | |
|---|------------------|-------------|-------------|
| Wavelength at peak emission | λ_{peak} | 575 ± 15 | nm |
| Dominant wavelength | λ_{dom} | 573 | nm |
| Viewing angle | ϕ | 100 | degree |
| (limits for 50% of luminous intensity I_v) | | | |
| Forward voltage ($I_F = 20 mA$) | V_F | 2.4 (≅ 3.0) | V |
| Reverse current ($V_R = 3 V$) | I_R | 0.1 (≅ 10) | μA |
| Capacitance ($V_R = 0 V$) | C_o | 45 | pF |
| Rise time | t_r | 50 | ns |
| Fall time | t_f | 50 | ns |
| Luminous intensity | I_v | > 6 | mcd @ 20 mA |

Specifications are subject to change without notice.

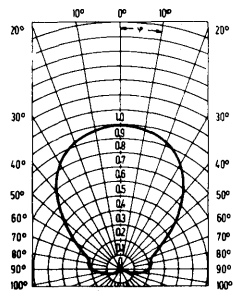
Relative spectral emission $I_{rel} = f(\lambda)$



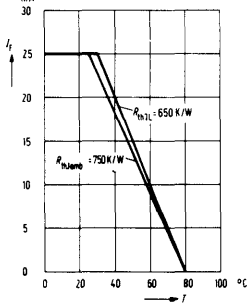
Luminous intensity $I_v = f(I_f)$



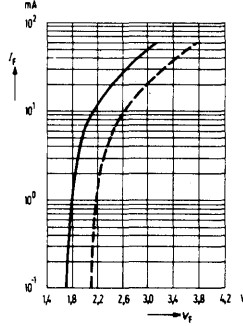
Radiation characteristic $I_{rad} = f(\rho)$



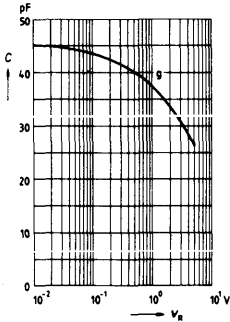
Max. permissible forward current $I_F = f(T)$



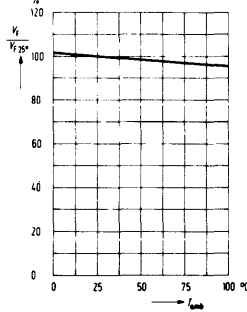
Forward voltage $I_F = f(V_F)$



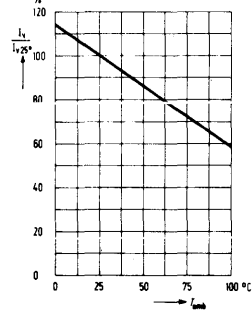
Capacitance $C = f(V_F)$ LD 48*



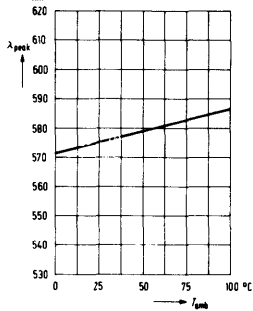
Forward voltage $\frac{V_{F-}}{V_{F-25^{\circ}}} = f(T_{amb})$



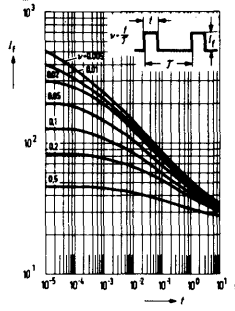
Luminous intensity $\frac{I_v}{I_{v-25^{\circ}}} = f(T_{amb})$

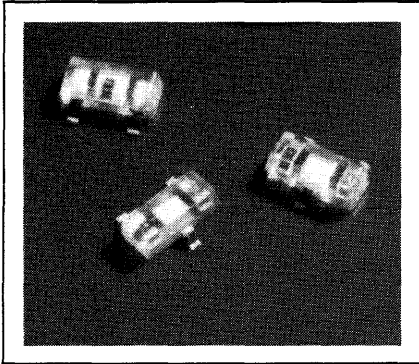


Wavelength at peak emission $\lambda_{peak} = f(T_{amb})$



Perm. pulse handling capability $I_F = f(t)$; $v = \text{parameter}$; $T_L = 25^{\circ}\text{C}$





FEATURES

- Available in...
 - High Efficiency Red, LDH 2310
 - Yellow, LDY 2320
 - Green, LDG 2330
 - Red & Green (two chip), LDRG 2340
- Subminiature Clear Plastic Rectangular Package, 1.3mm by 3mm by 1mm thick
- Wide Viewing Angle, 140°
- Ideal for use as failure indicators mounted on printed circuit boards
- IC compatible

DESCRIPTION

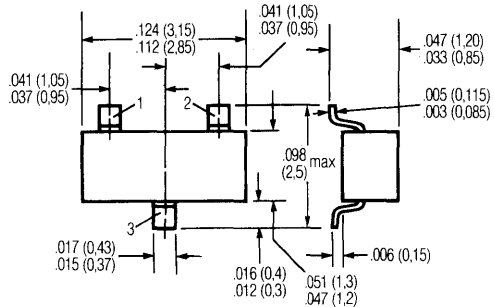
This series consists of LED's in subminiature plastic packages 23A3 DIN 41869 (TO236/SOT-23). In the double diode LDRG2340, two LED chips are situated next to each other, one high efficiency red and the other green.

These packages are very suitable for mounting on the wiring side of printed circuit boards. The way the leads are bent makes surface mounting without drilling possible. The LED's can be soldered to the wiring side using the chip mounting technique (iron or reflow soldering). If the LED's are attached with glue beforehand, wave or dip soldering can be used (detailed description concludes this data sheet).

Due to the small dimensions (rectangular SOT23 housing, 1.3 mm X 3 mm, height 1 mm), this subminiature package is excellent for use in touch keyboards as optical failure indicators on printed circuit boards. The flat surface of the housing permits the attachment of optical fiber systems without problems and low loss.

These LED's can be supplied on 8 mm wide film reels according to IEC STANDARDS, 2000 pieces on a 18 cm reel. These tapes can be used on all commercial automatic insertion equipment (special versions of 33 cm reels with 10,000 pieces per reel are available upon special order).

Package Dimensions in Inches (mm)



Pinouts (top view)

| Pin | LDH2310, LDY2320, LDG2330 | LDRG2340 |
|-----|---------------------------|--------------|
| 1 | NC | Red |
| 2 | Anode | Green |
| 3 | Cathode | Common anode |

Maximum Ratings

For double diodes (LDRG 2340), apply the following operating condition

1 system on (lit up), 1 system off (dark)

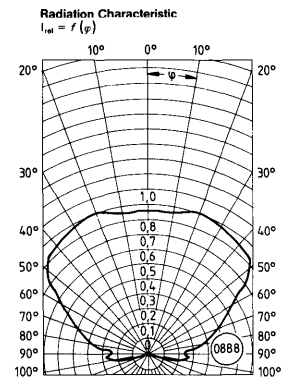
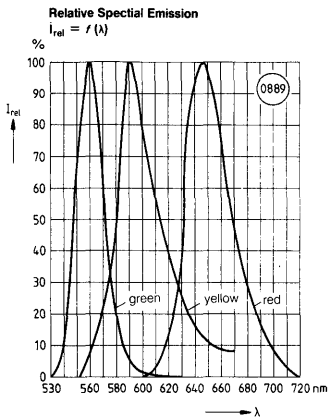
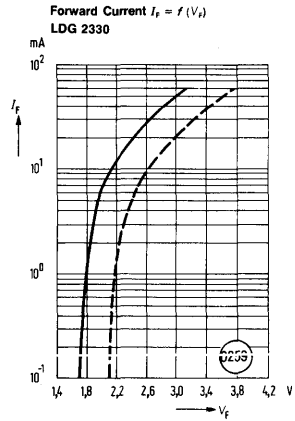
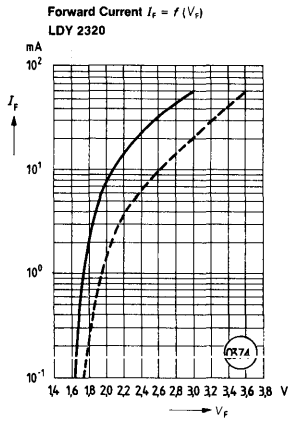
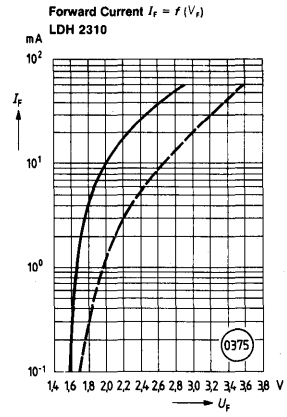
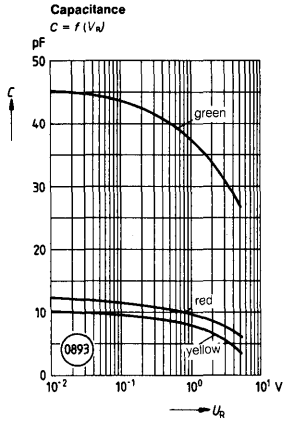
| | | | |
|--|-------------|--------------|-----|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 12.5 | mA |
| ceramic substrate ¹ | I_F | 30 | mA |
| Surge current ($\tau = 10 \mu s$) | I_{FS} | 1 | A |
| ceramic substrate ¹ ($\tau = 10 \mu s$) | I_{FS} | 1 | A |
| Junction temperature | T_J | 100 | °C |
| Storage temperature | T_S | -55... + 100 | °C |
| Power dissipation | P_{tot} | 70 | mW |
| ceramic substrate ¹ | P_{tot} | 200 | mW |
| Thermal resistance junction to air | R_{thJA} | 1050 | K/W |
| to ceramic ¹ | R_{thJSR} | 375 | K/W |

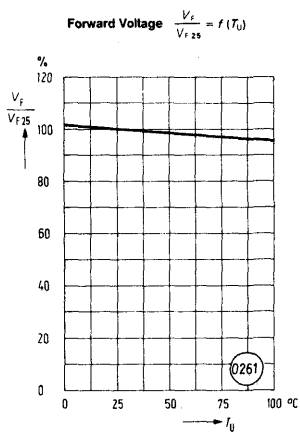
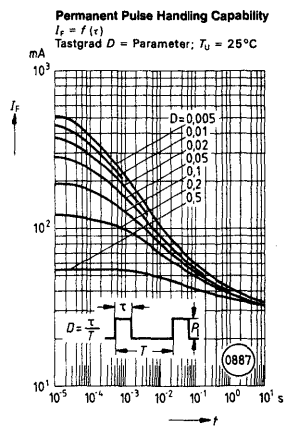
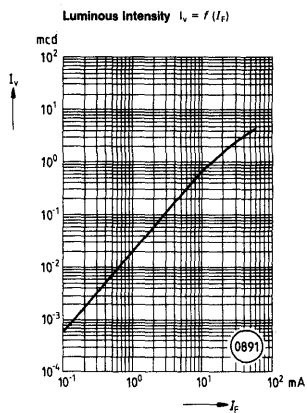
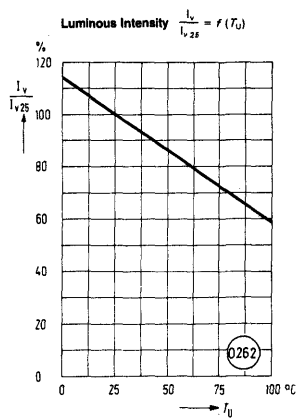
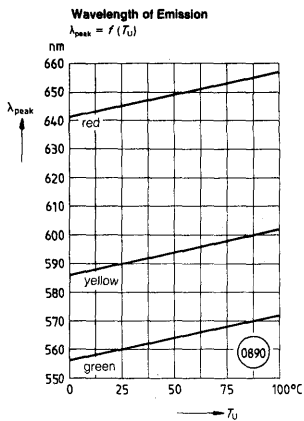
Characteristics ($T_{amb}=25^\circ C$)

| | LDH2310 | LDY2320 | LDG2330 | |
|--|---------------------------|---------------|----------|---------|
| Wavelength of emitted light | λ_{peak} 645 ± 15 | 590 ± 10 | 560 ± 15 | nm |
| Dominant wavelength | λ_{dom} 638 | 592 | 561 | nm |
| Aperture cone ($1/2 \angle$) | ϕ | 70 | | degrees |
| (Limits for 50% of luminous intensity (IV) shielded against lateral emission of light) | | | | |
| Forward voltage ($I_F = 20mA$) | V_F | 2.4 (≤3.0) | | V |
| Reverse current ($V_R = 5V$) | I_R | 0.1 (≤10) | | μA |
| Luminous intensity ($I_F = 20mA$) | I_V | typ. 1.8 (≥1) | | mcd |

¹Ceramic substrate 2.5cm² surface area, 0.7mm thick

Specifications are subject to change without notice.





SOLDERING CONSIDERATIONS

Semiconductor components in plastic packages (SOT-23) are designated as active components for thin and thick film integrated circuits. These soldering directions refer to the use of resistors and LED lamps on PCB substrates with interconnecting conductors which are tin-lead plated through dip soldering.

To achieve reliable bonding, the following criteria should be considered:

1. The right soldering temperature and appropriate soldering flux are important. The soldering flux is not to affect or attack the plastic package. The solvents should easily remove the flux residues and not affect or attack the plastic package.
2. Temperature (240 degree C max for 5 sec max) and rapid temperature changes during the soldering apply high mechanical stress to the substrate and should be avoided to prevent breaking or cracking of the substrate.
3. Placement of the semiconductor components onto the substrate is to be done with the highest precision. The soldering pads must be placed exactly on the conductor traces because there is a high risk of cracking if the hot soldering pads touch the package.

SOLDERING METHODS

The soldering method selection should be made according to production volume, amount of semiconductor components per circuit board, required precision placement, and possibility of exchanging/replacing semiconductor components. Listed below are four mounting methods.

METHOD 1 Wave or Dip Soldering

The components in the SOT-23 housing are first glued onto the thick film substrate (glass, ceramic) or the etched printed circuit board (glass fiber) with silicon glue. The glue can be applied by silk screen printing. Care should be taken that the glue does not cover the contact surfaces. The components are pressed onto the substrate. A film of 60-80 um glue results in excellent adhesion, and when the components are attached, the contact surfaces are not contaminated. Soldering can be done through wave or dip soldering. A good soldering material is Sn-Pb mixture in eutectic proximity with a 3.5-4% Ag additive agent, i.e. Soldanol (170 Sn/Pb/Ag:60/35/4). The bath temperature is to be 225 +/- 10 degrees C and the maximum soldering time of 5 seconds. The recommended soldering flux is a non-activated colophonium resin 45%, dissolved in the ethyl alcohol 55% plus glycerin additive agent. After soldering the components, the solder flux residues are to be removed; cleaning baths containing isopropyl alcohol as a washing agent are suitable.

METHOD 2 Reflow Soldering

Here soldering flux is added to the powdered solder and then applied in paste form to the printed circuit board. This procedure is most effective using silk screenprinting. The thickness should be 80um. The substrate with the components is heated for 5 seconds to 240 degrees C by means of a conveyor band or a heating plate. The paste is melted and the soldering process takes place. Further information can be obtained from the reflow soldering paste manufacturer's instructions.

METHOD 3 Pin Soldering

The substrate is placed on a heating plate with a temperature of 100 degrees C. A magnified view of the semiconductor component is used to place it into the right position. It is placed on the substrate by means of a minimum pressure valve. Simultaneously three (still cold) micro soldering pins are placed under pressure on the leads of the component to improve thermal resistance. The soldering pins have to be structured in a way that the thermal conductance takes place only on its peak. The soldering pins will be briefly charged (8 seconds) with 20W each. Within this time span the solder becomes liquid for about 3 seconds which achieves a complete covering. Because of the low thermal capacity the soldering pins cool off rapidly after turn-off. The flux can, while soldering pins are still attached, cool off below their melting temperature. The soldering pins should be made of steel (18% Cr, 8% N) because this material will not be adhesive to solder and has a good resistance against corrosion. Flux colophonium is suitable, which residues have to be removed after soldering with isopropyl alcohol. Using this method, the plastic package will not be heated more than the preheating plate. Provided the preheating plate temperature does not exceed 100 degrees C and the soldering time is not longer than 5 seconds, the risk of substrate cracking beneath the conductor wiring is lowered. The junction temperature will increase to about 250 degrees C with this method.

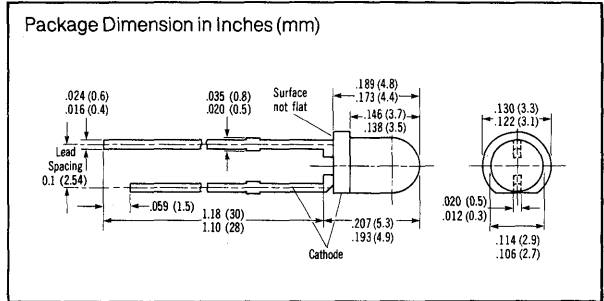
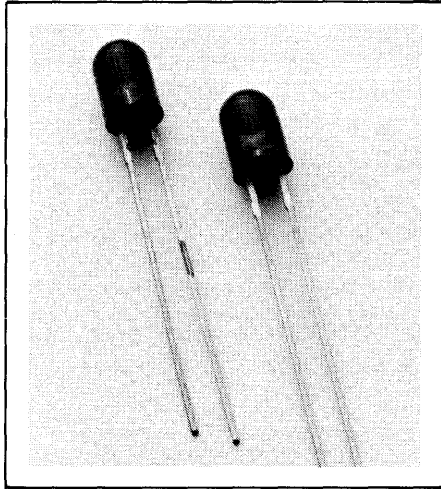
METHOD 4 Iron Soldering

Manual soldering using a miniature soldering has the following disadvantages.

The placement of the component cannot be done very accurately in places where its leads directly touch the substrate as substrate cracks during soldering can occur. Because of the sequential soldering of the leads, mechanical stress can cause substrate damage and consequently disrupt interconnections inside a component. Furthermore, the plastic package can be damaged by the soldering iron. Therefore, this method is only suitable for inserting single semiconductor components.

RED LDR 110X SERIES HIGH EFFICIENCY RED LDH 111X SERIES HIGH EFFICIENCY YELLOW LDY 113X SERIES HIGH EFFICIENCY GREEN LDG 115X SERIES T1 LED LAMP

Preliminary



Maximum Ratings

| | | LDR 110X | LDH 111X LDY 113X LDG 115X | |
|--|------------|-------------|----------------------------------|-------------|
| Reverse voltage | V_R | 5 | 5 | V |
| Forward current | I_F | 100 | 60 | mA |
| Surge current ($\leq 10\mu s$) | i_{FS} | 2 | 1 | A |
| Storage temperature range | T_{stg} | -55 to +100 | | $^{\circ}C$ |
| Junction temperature | T_j | 100 | 100 | $^{\circ}C$ |
| Total power dissipation ($T_{amb}=25^{\circ}C$) | P_{tot} | 200 | 200 | mW |
| Thermal resistance junction to air | R_{thJA} | 375 | 375 | K/W |

FEATURES

- High Light Output
- Diffused Lens
- Wide Viewing Angle 70°
- T 1 Size
- No Standoffs
- 1" Lead Length
- Front Panel Mounting
Snap-in Mounting Clips Available
Clip/Collar #004-9016 Clear
#004-9015 Black
- I/C Compatible

DESCRIPTION

The LDR 110X Series is a standard red gallium arsenide phosphide (GaAsP) LED lamp. The LDH111X high efficiency red and LDY113X yellow are premium high efficiency light emitting diode lamps fabricated with TSN (transparent substrate nitrogen) technology. The LDG 115X green Series is a gallium phosphide (GaP) lamp. All have a diffused plastic lens which emits a full flooded intense light.

Characteristics ($T_{amb}=25^{\circ}$)

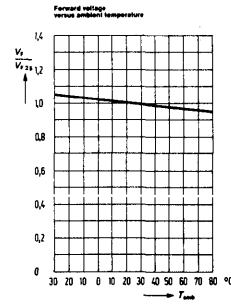
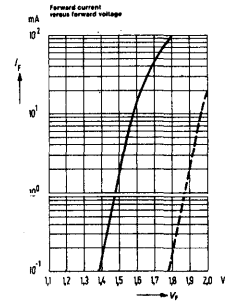
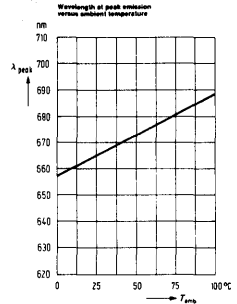
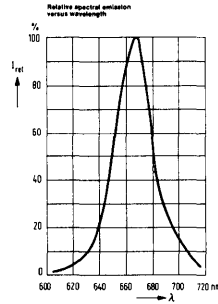
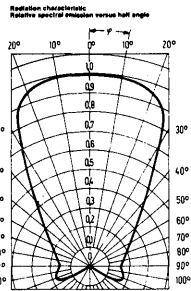
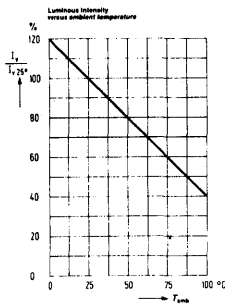
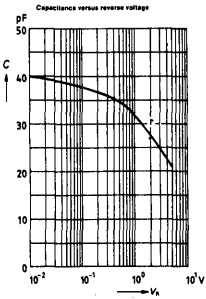
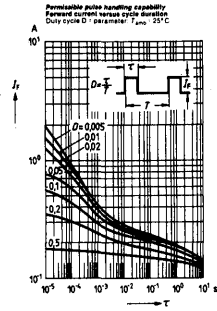
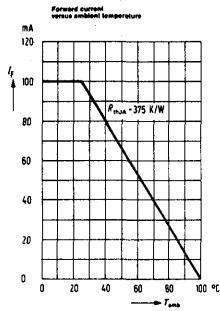
| | LDR 110X | LDH 111X | LDY 113X | LDG 115X | |
|---|-------------------------------|--------------------|--------------|--------------|---------|
| Wavelength at peak emission | λ_{peak} 665 \pm 15 | 645 \pm 15 | 590 \pm 10 | 560 \pm 15 | nm |
| Dominant wavelength | λ_{dom} 645 | 638 | 592 | 561 | nm |
| Viewing angle | ϕ 70 | 70 | 70 | 70 | degrees |
| (Limits for 50% of luminous intensity I_v) | | | | | |
| Forward voltage ($I_F = 20mA$) | V_F 1.6(≤ 2.0) | 2.4(≤ 3.0) | | | V |
| Reverse current ($V_R = 5V$) | I_R | 0.01 (≤ 10) | | | μA |
| Rise time | t_r 5 | 100 | 200 | 50 | ns |
| Fall time | t_f 5 | 100 | 200 | 50 | ns |
| Capacitance ($V_R = 0V; f = 1MHz$) | C_0 40 | 12 | 10 | 45 | pF |

Luminous Intensity

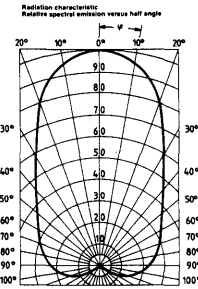
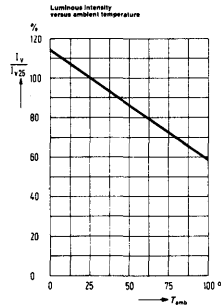
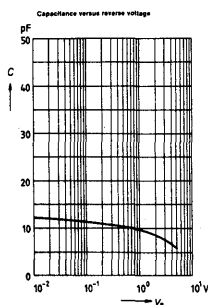
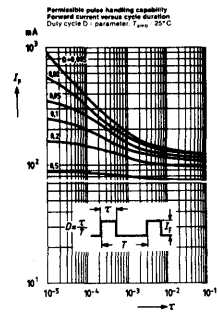
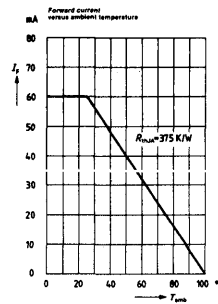
| P/N | Replaces | mcd (MIN) | Test conditions |
|----------|------------------|-----------|-----------------|
| LDR 1101 | CQV10-3 | 1.0 | 20mA |
| LDR 1102 | CQV10-4, 5 | 2.0 | 20mA |
| LDR 1103 | ----- | 4.0 | 20mA |
| LDH 1111 | CQV11-4, 5, 6, 7 | 2.5 | 10mA |
| LDH 1112 | CQV11-8 | 4.0 | 10mA |
| LDH 1113 | CQV11-9 | 6.0 | 10mA |
| LDY 1131 | CQV13-4, 5 | 1.0 | 10mA |
| LDY 1132 | CQV13-6 | 2.0 | 10mA |
| LDY 1133 | CQV13-7 | 4.0 | 10mA |
| LDG 1151 | CQV15-3, 4, 5 | 2.5 | 20mA |
| LDG 1152 | CQV15-6, 7 | 6.0 | 20mA |
| LDG 1153 | ----- | 10 | 20mA |

Specifications are subject to change without notice.

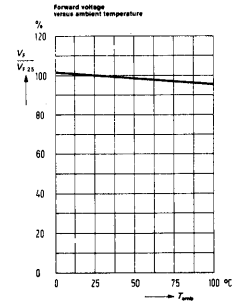
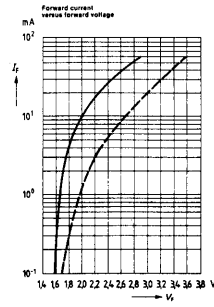
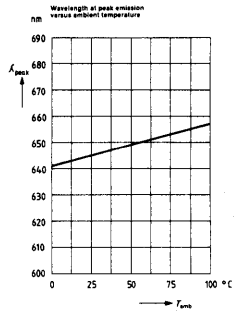
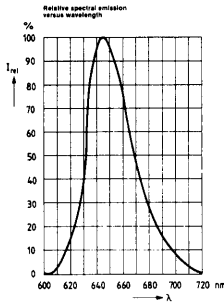
LDR 110X SERIES



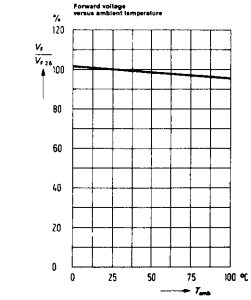
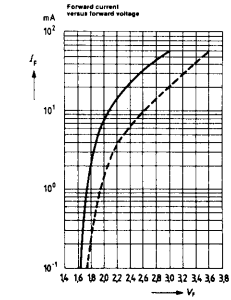
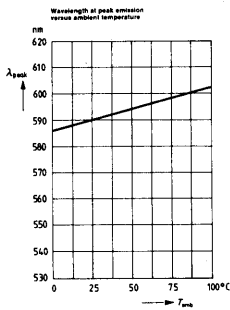
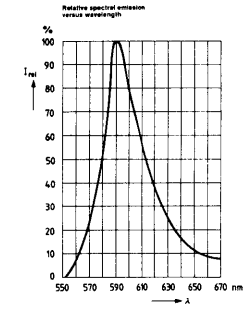
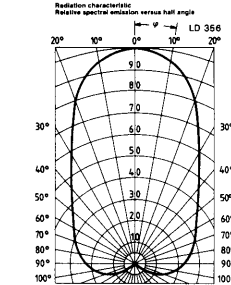
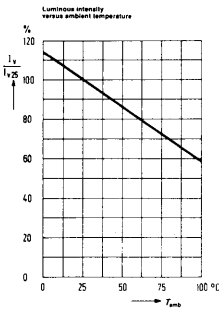
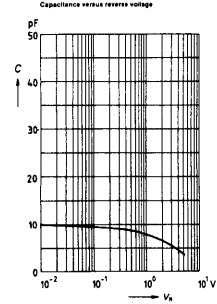
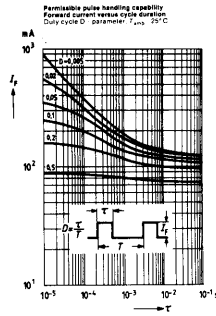
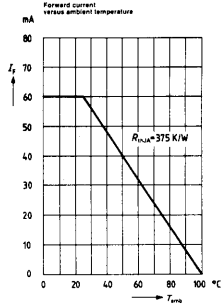
LDH 111X SERIES



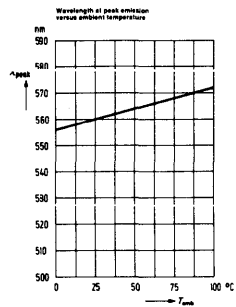
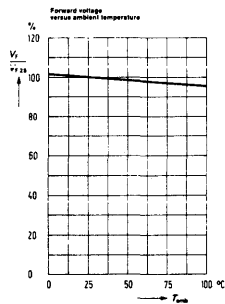
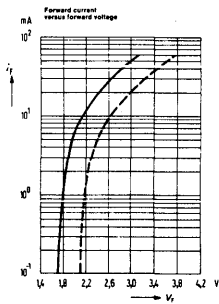
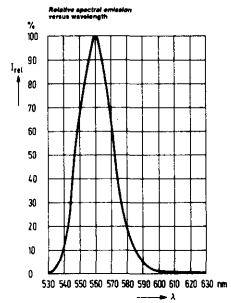
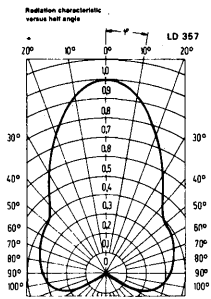
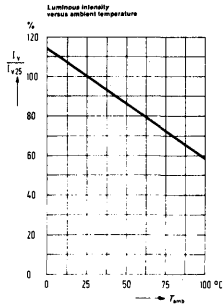
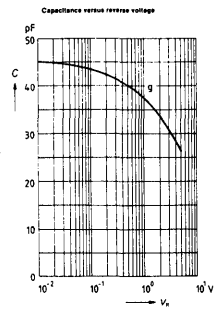
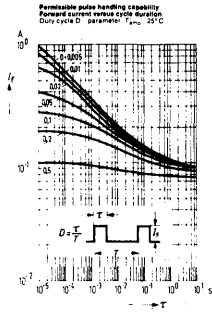
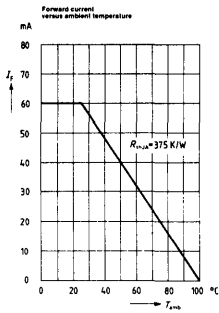
LDH 111X SERIES (Continued)



LDY 113X SERIES

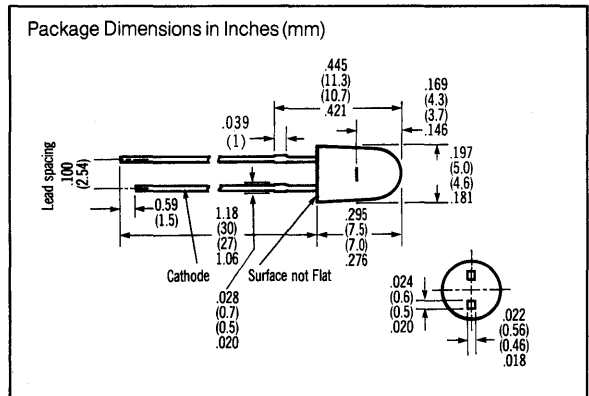
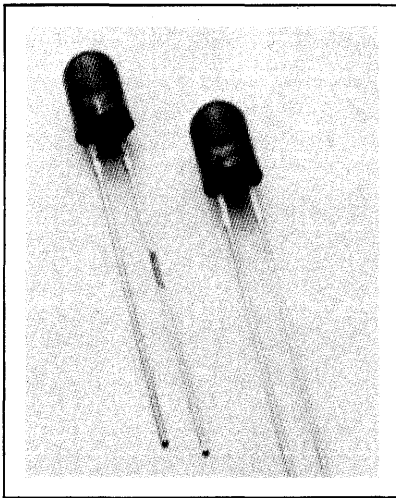


LDG 115X SERIES



T-1 3/4 FLANGELESS LOW PROFILE LED LAMP

Preliminary



FEATURES

- Low Profile
- T-1 3/4 Flangeless Package
- 1-inch Leads
- Diffused Lens
- Wide Viewing Angle, 70°
- I/C Compatible

DESCRIPTION

The LDR 1201 is a Gallium Arsenide Phosphide (GaASP) red light emitting diode.

The LDG 1251 is a Gallium Phosphide (GaP) green light emitting diode.

The LDY 1231 is a TSN (Transparent Substrate Nitrogen) yellow light emitting diode.

This is a flangeless LED lamp for applications where a lower seating (clearance) is desirable.

Maximum Ratings

| | LDR1201 | LDG1251 | LDY1231 | |
|--|------------|-------------|---------|-----|
| Reverse voltage | V_R | 5 | 5 | V |
| Forward current | I_F | 100 | 60 | mA |
| Surge current ($\tau \leq 10 \mu s$) | I_{FS} | 2 | 1 | A |
| Storage temperature range | T_S | -55 to +100 | | °C |
| Junction temperature | T_J | 100 | 100 | °C |
| Total power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} | 200 | 200 | mW |
| Thermal resistance, junction to air | R_{thJA} | 375 | 375 | K/W |

Characteristics ($T_{amb} = 25^\circ C$)

| | LDR1201 | LDY1231 | LDG1251 | | |
|---|------------------|-----------|-----------|-----------|---------|
| Wavelength at peak emission | λ_{peak} | 665 ± 15 | 590 ± 10 | 560 ± 15 | nm |
| Dominant wavelength | λ_{dom} | 645 | 592 | 561 | nm |
| Viewing angle (Limits for 50% of luminous intensity I_v) | ϕ | 70 | 70 | 70 | degrees |
| Forward voltage ($I_F = 20$ mA) | V_F | 1.6(±2.0) | 2.4(±3.0) | 2.4(±3.0) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01(±10) | 0.01(±10) | 0.01(±10) | µA |
| Rise time | t_r | 5 | 100 | 50 | ns |
| Fall time | t_f | 5 | 100 | 50 | ns |
| Capacitance ($V_i = 0$ V; $f = 1$ MHz) | C_o | 40 | 10 | 45 | pF |

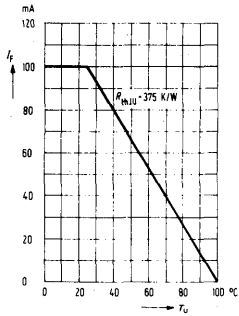
Luminous Intensity Grouping

| P/N | Min Mcd | Test Conditions |
|----------|---------|-----------------|
| LDR 1201 | 1.0 | 20 mA |
| LDG 1251 | 2.5 | 20 mA |
| LDY 1231 | 1.0 | 20 mA |

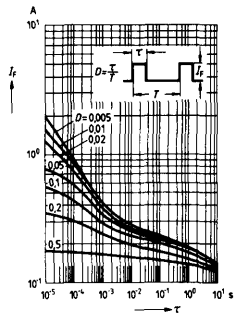
Specifications are subject to change without notice.

LDR 1201

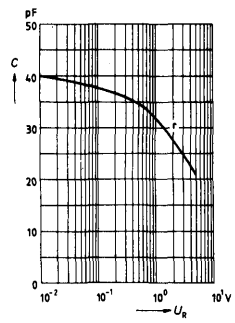
Forward current versus ambient temperature



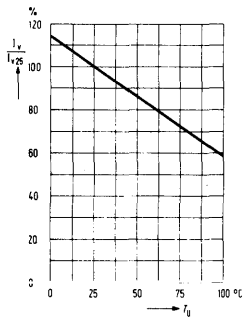
Permissible pulse handling capability
Forward current versus cycle duration
Duty cycle $D = \frac{\tau}{T}$ parameter, $T_{amb} = 25^\circ\text{C}$



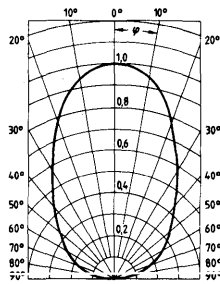
Capacitance versus reverse voltage



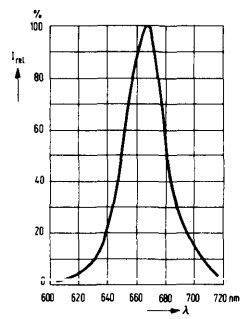
Luminous intensity versus ambient temperature



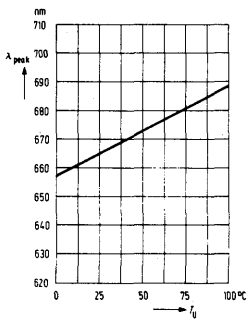
Radiation characteristic
Relative spectral emission versus half angle



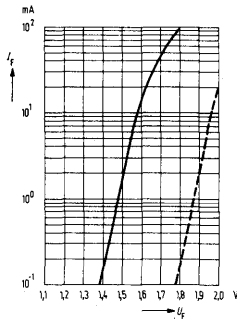
Relative spectral emission versus wavelength



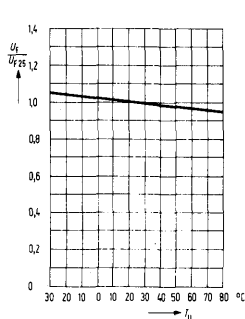
Wavelength at peak emission versus ambient temperature

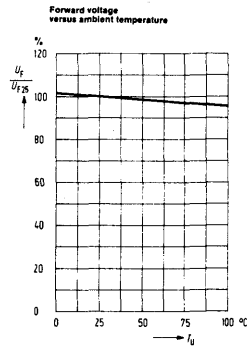
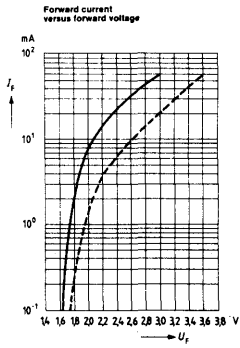
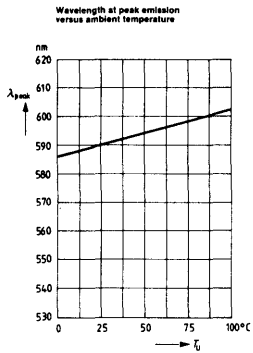
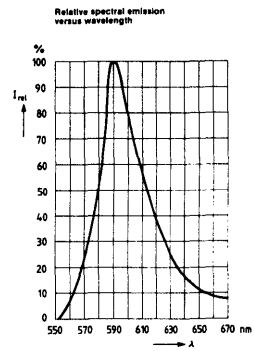
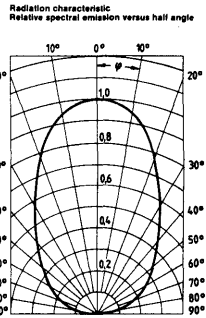
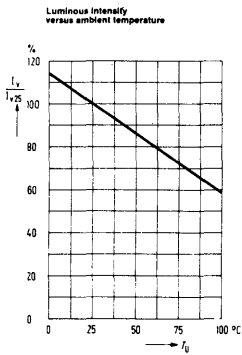
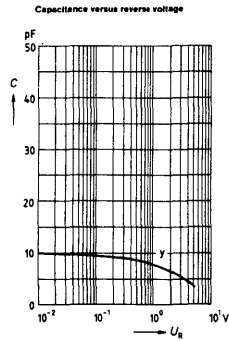
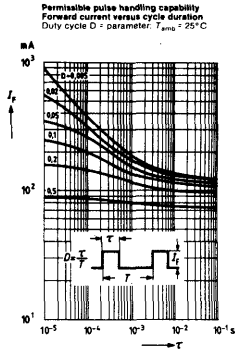
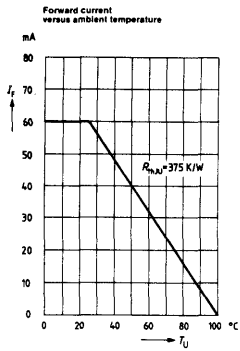


Forward current versus forward voltage



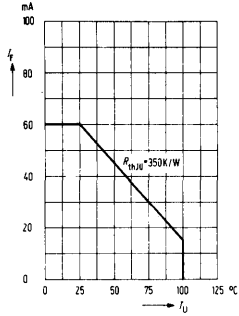
Forward voltage versus ambient temperature



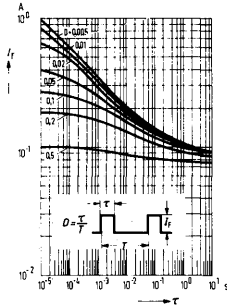


LDG 1251

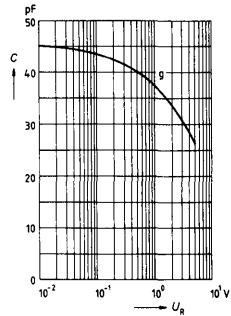
Forward current versus ambient temperature



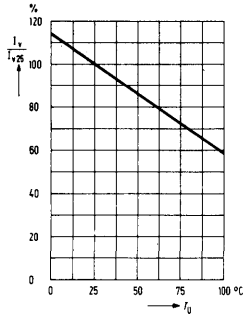
Permissible pulse handling capability
Forward current versus cycle duration
Duty cycle $D < 1$; parameter: $T_{amb} = 25^\circ C$



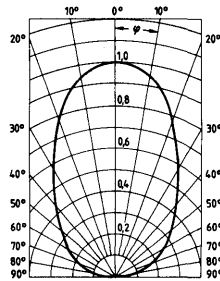
Capacitance versus reverse voltage



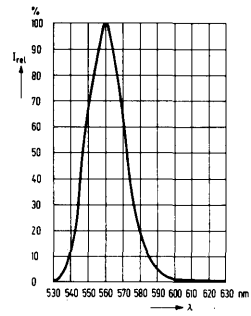
Luminous intensity versus ambient temperature



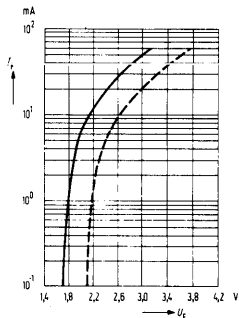
Radiation characteristic
Relative spectral emission versus half angle



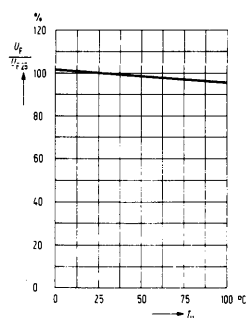
Relative spectral emission versus wavelength



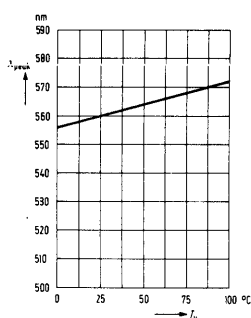
Forward current versus forward voltage



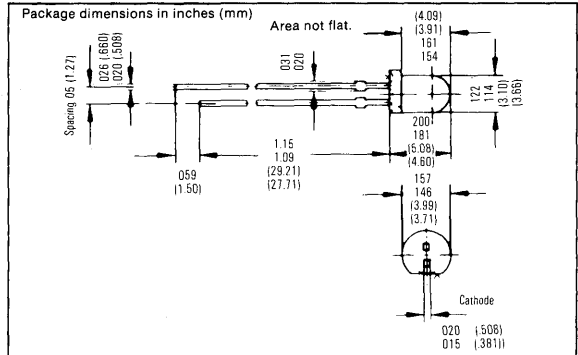
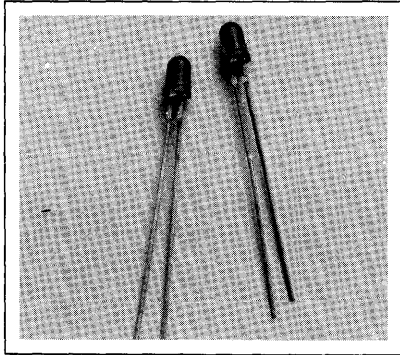
Forward voltage versus ambient temperature



Wavelength at peak emission versus ambient temperature



T1 LED LAMP



FEATURES

- High Light Output
- Diffused Lens
- Wide Viewing Angle 70°
- T 1 Size
- No Standoffs
- 1" Lead Length
- 50 ml Lead Spacing
- Front Panel Mounting
Snap-in Mounting Clips Available
Clip/Collar #004-9016 Clear
#004-9015 Black
- I/C Compatible

DESCRIPTION

The LDR 350X Series is a standard red gallium arsenide phosphide (GaAsP) LED lamp. The LDH 352X high efficiency red and LDY 356X yellow are premium high efficiency light emitting diode lamps fabricated with TSN (transparent substrate nitrogen) technology. The LDG 357X green is a gallium phosphide (GaP) lamp. All have a diffused plastic lens which emits a full flooded intense light.

Maximum ratings

| | LDR 350X | LDH 352X | LDY 356X | LDG 357X |
|---|------------|----------|-------------|----------|
| Reverse voltage | V_R | 5 | 5 | V |
| Forward current | I_F | 100 | 60 | mA |
| Surge current ($\leq 10\mu s$) | I_{FS} | 2 | 1 | A |
| Storage temperature range | T_{stg} | | -55 to +100 | °C |
| Junction temperature | T_j | 100 | 100 | °C |
| Total power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} | 200 | 200 | mW |
| Thermal resistance junction to air | R_{thJA} | 375 | 375 | K/W |

Characteristics ($T_{amb} = 25^\circ$)

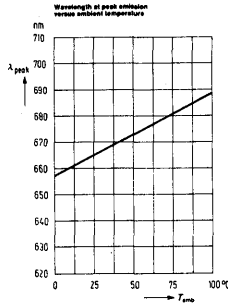
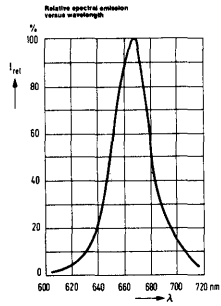
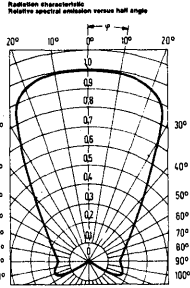
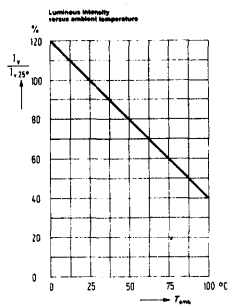
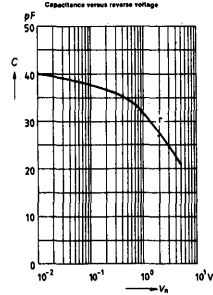
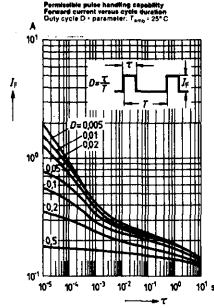
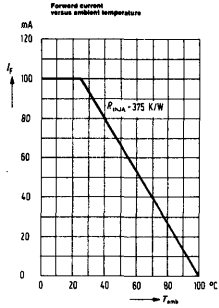
| | LDR 350X | LDH 352X | LDY 356X | LDG 357X | | |
|---|------------------|-----------|----------|-----------|--------|---------|
| Wavelength at peak emission | λ_{peak} | 665±15 | 645±15 | 590±10 | 560±15 | nm |
| Dominant wavelength | λ_{dom} | 645 | 638 | 592 | 561 | nm |
| Viewing angle | φ | 70 | 70 | 70 | 70 | degrees |
| (Limits for 50% of luminous intensity I_v) | | | | | | |
| Forward voltage ($I_F = 20mA$) | V_F | 1.6(≤2.0) | | 2.4(≤3.0) | | V |
| Reverse current ($V_R = 5 V$) | I_R | | | 0.01(≤10) | | μA |
| Rise time | t_r | 5 | 100 | 200 | 50 | ns |
| Fall time | t_f | 5 | 100 | 200 | 50 | ns |
| Capacitance ($V_R = 0 V$; $f = 1MHz$) | C_0 | 40 | 12 | 10 | 45 | pF |

Luminous Intensity grouping

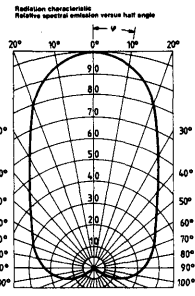
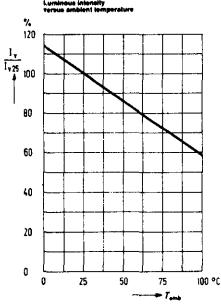
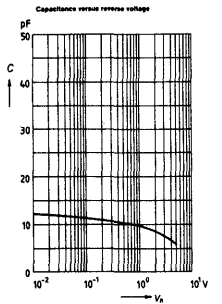
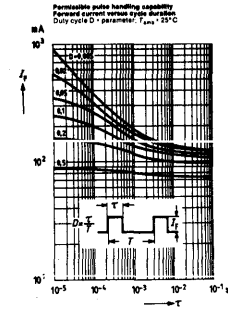
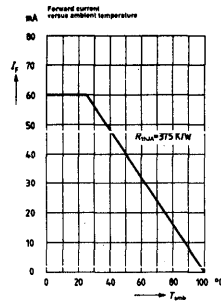
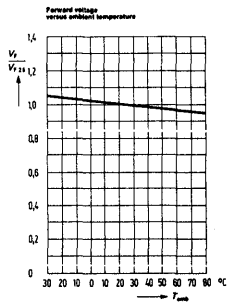
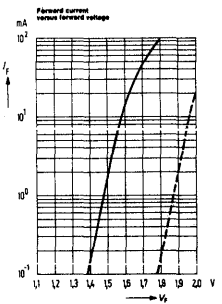
| P/N | Replaces | mcd (Min) | Test conditions |
|----------|---------------------------------|-----------|-----------------|
| LDR 3501 | LD 350-3, RL-209A & -1, RL-4484 | 1.0 | 20mA |
| LDR 3502 | LD 350-4, RL-209-2 | 2.0 | 20mA |
| LDR 3503 | ————— | 4.0 | 20mA |
| LDH 3521 | LD 352-1-6 | 2.5 | 10mA |
| LDH 3522 | LD 352-7 & 8 | 4.0 | 10mA |
| LDH 3523 | ————— | 6.0 | 10mA |
| LDY 3561 | LD 356-4, YL-212, YL-4484 | 1.0 | 10mA |
| LDY 3562 | ————— | 2.5 | 10mA |
| LDG 3571 | LD 357-5, GL-211, GL-4484 | 2.5 | 20mA |
| LDG 3572 | LD 357-6 | 6.0 | 20mA |

Specifications are subject to change without notice.

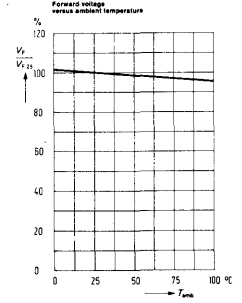
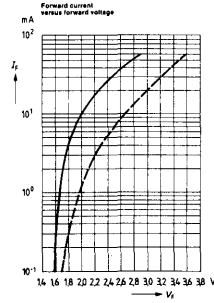
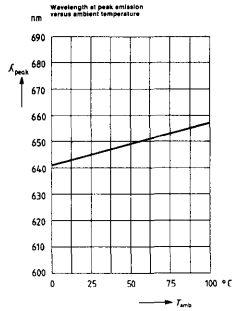
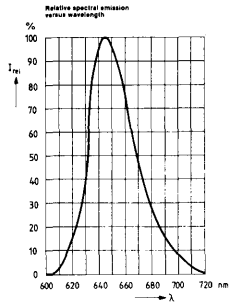
LDR 3500 SERIES



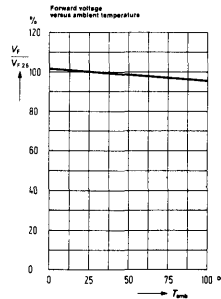
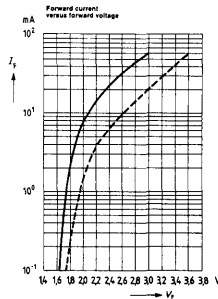
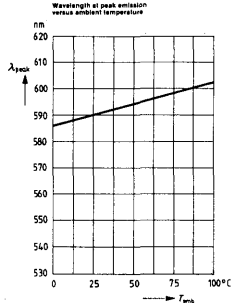
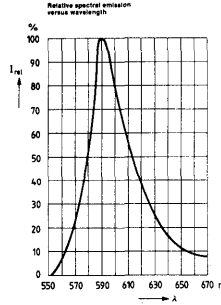
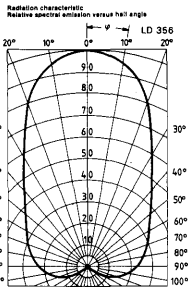
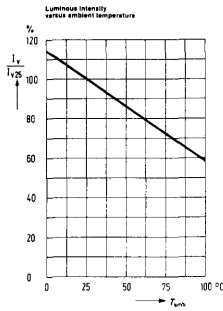
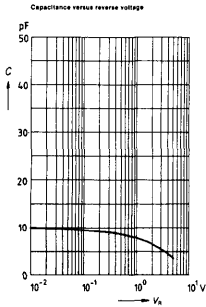
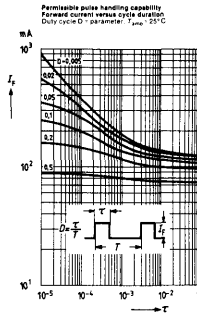
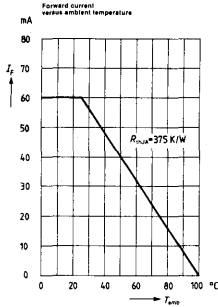
LDH 3520 SERIES



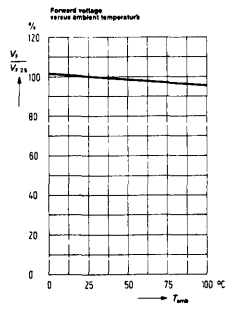
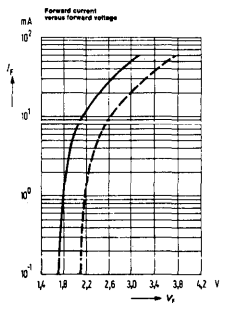
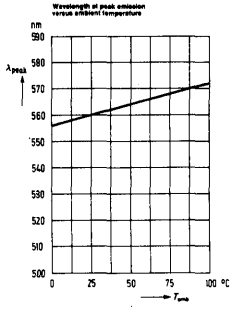
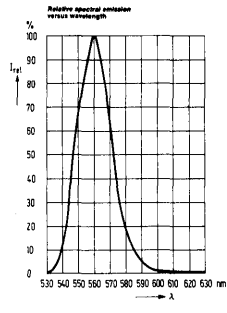
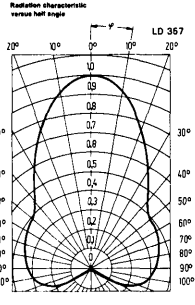
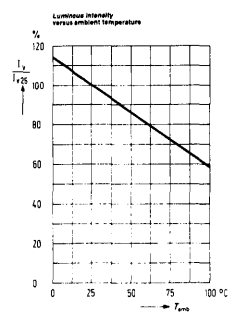
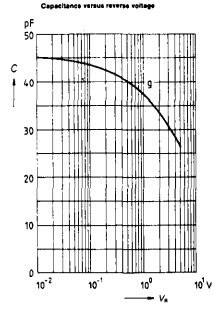
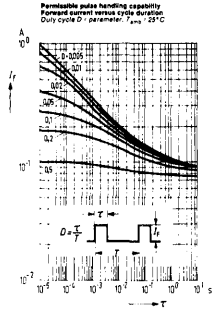
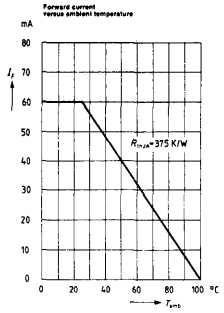
LDH 3520 (Continued)



LDY 3560 SERIES



LDG 3570 SERIES

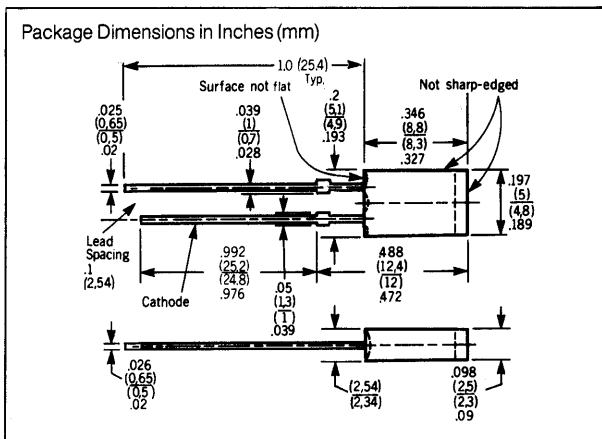
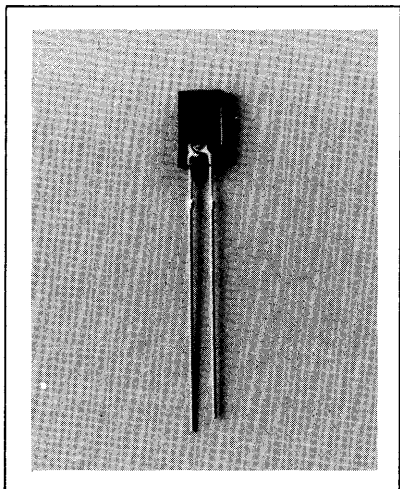


SIEMENS

RED
HIGH EFFECIENCY RED
YELLOW
GREEN

LDR 3700 SERIES
LDH 3600 SERIES
LDY 3800 SERIES
LDG 3900 SERIES

RECTANGULAR LED LAMP



FEATURES

- Red Diffused Lens, LDR 370X
- Red Diffused Lens, LDH 360X
- Yellow Diffused Lens, LDY 380X
- Green Diffused Lens, LDG 390X
- T1 ¼ Size Rectangular Shape
- Minimum Lead Length 1"
- 1/10" Lead Spacing
- I/C Compatible

DESCRIPTION

The LDR 370X is a standard red GaAsP LED lamp. The LDH 360X high efficiency red and LDY 380X yellow are light emitting diode lamps fabricated with TSN (transparent substrate nitrogen) technology. The LDG 390X green is a gallium phosphide LED lamp. All three series have a diffused lens which forms an evenly dispersed rectangular head-on light. They can be used singly as indicators or stacked together to form arrays.

Maximum Ratings

| | | | |
|--|-------------------|-------------|-----|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 60 | mA |
| Surge current ($t \leq 10$ s) | I_{FS} | 1 | A |
| Storage temperature | T_S | -55 to +100 | °C |
| Junction temperature | T_J | 100 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 200 | mW |
| Thermal resistance junction to air | θ_{thJamb} | 375 | K/W |

Characteristics $T_{amb} = 25^\circ\text{C}$

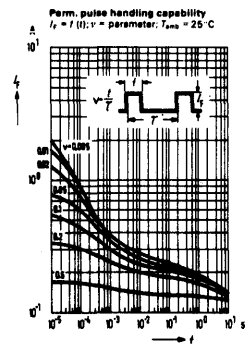
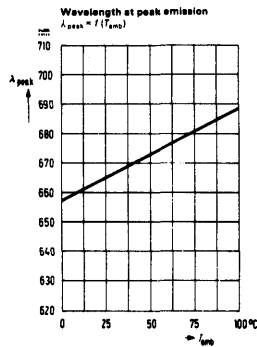
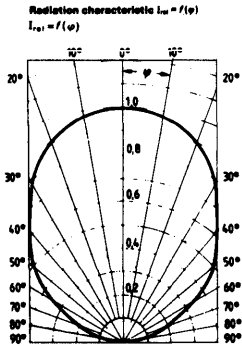
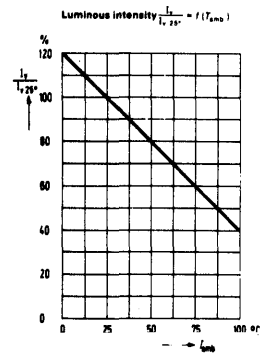
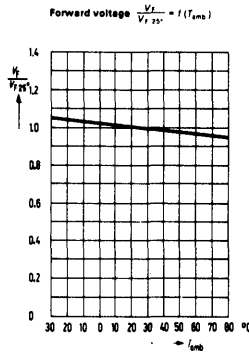
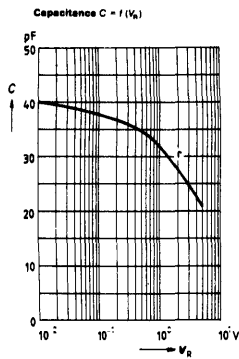
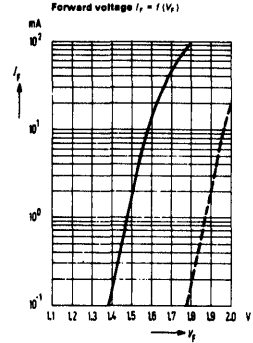
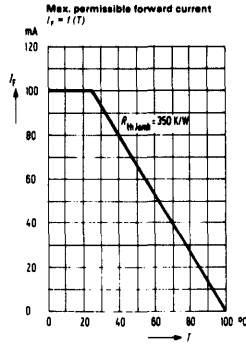
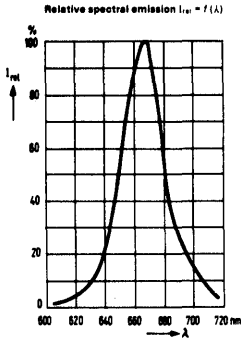
| | LDR 370X | LDH 360X | LDY 380X | LDG 390X | |
|---|---------------------------|------------|------------|------------|-------|
| Wave length of emitted light | λ_{peak} 665 ± 15 | 645 ± 15 | 590 ± 10 | 560 ± 15 | nm |
| Dominant wave length | λ_{dom} 645 | 638 | 592 | 561 | nm |
| Viewing Angle | ϕ 100 | 100 | 100 | 100 | deg. |
| (Limits for 50% of luminous intensity I_V shielded against lateral emission of light) | | | | | |
| Forward voltage ($I_F = 20$ mA) | V_F | 1.6 (≤2.0) | | 2.4 (≤3.0) | V |
| Reverse current ($V_R = 5$ V) | I_R | | 0.01 (≤10) | | μA |
| Rise time | t_r | 5 | 100 | 50 | ns |
| Fall time | t_f | 5 | 100 | 50 | ns |
| Capacitance ($V_R = 0$ V) | C_o | 40 | 40 | 10 | 45 pF |

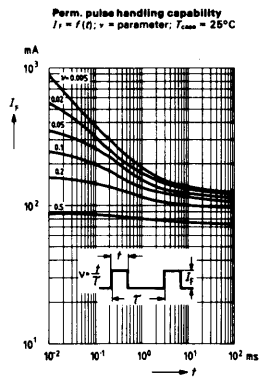
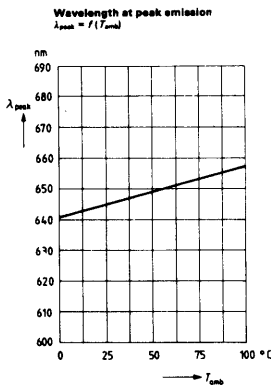
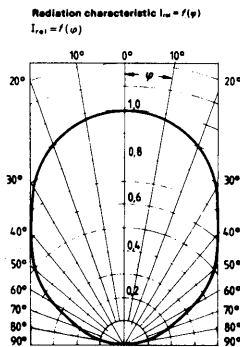
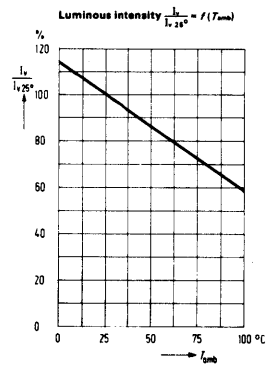
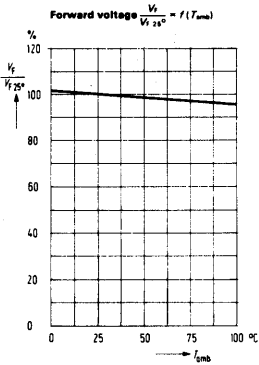
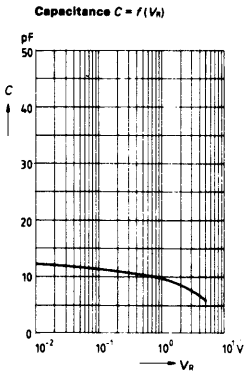
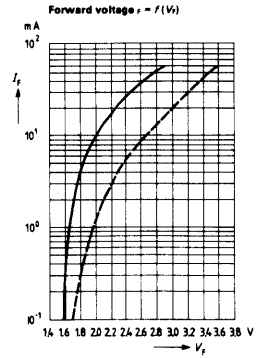
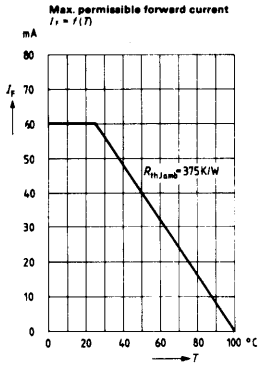
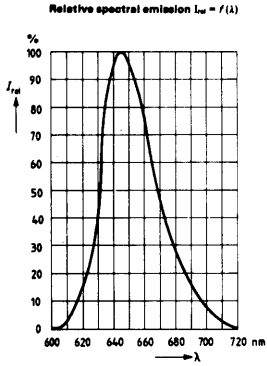
Luminous Intensity

| New P/N | Replaces | Min. | Unit | Test Condition |
|----------|----------|------|------|----------------|
| LDR 3701 | — | .4 | mcad | 20 mA |
| LDR 3702 | — | .63 | mcad | 20 mA |
| LDH 3601 | CQV36-4 | 1.6 | mcad | 20 mA |
| LDH 3602 | CQV36-5 | 2.5 | mcad | 20 mA |
| LDH 3603 | CQV36-6 | 4.0 | mcad | 20 mA |
| LDY 3801 | CQV38-3 | 1.0 | mcad | 20 mA |
| LDY 3802 | CQV38-4 | 1.6 | mcad | 20 mA |
| LDY 3803 | CQV38-5 | 2.5 | mcad | 20 mA |
| LDG 3901 | CQV39-3 | 1.0 | mcad | 20 mA |
| LDG 3902 | CQV39-4 | 1.6 | mcad | 20 mA |
| LDG 3903 | CQV39-5 | 2.5 | mcad | 20 mA |

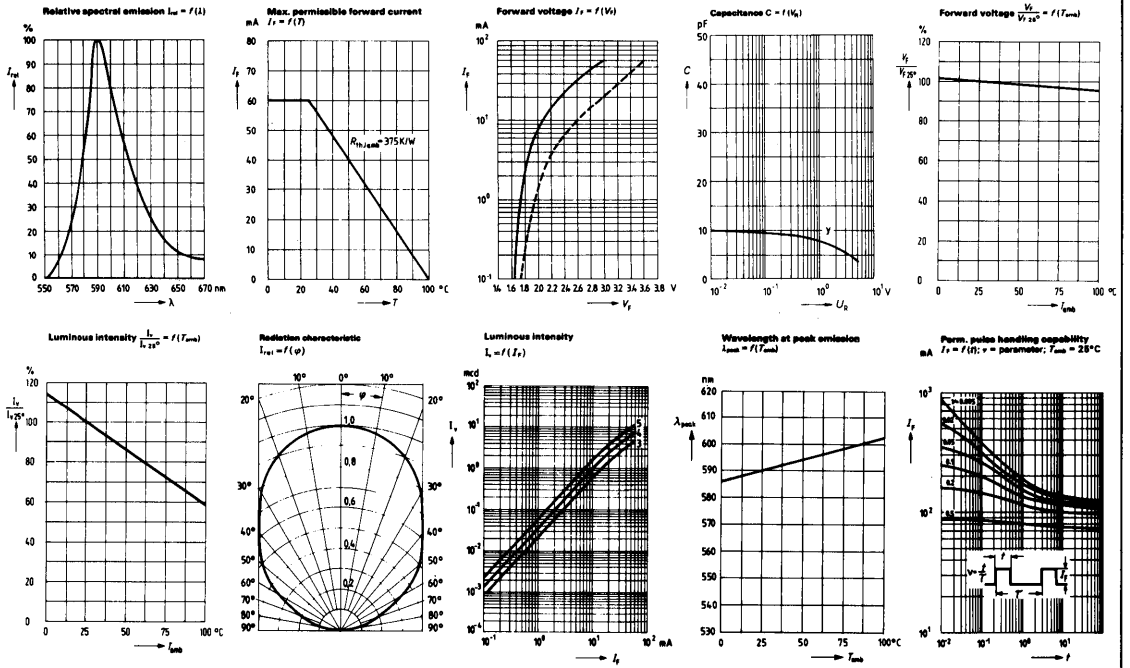
Specifications are subject to change without notice.

LDR 370X

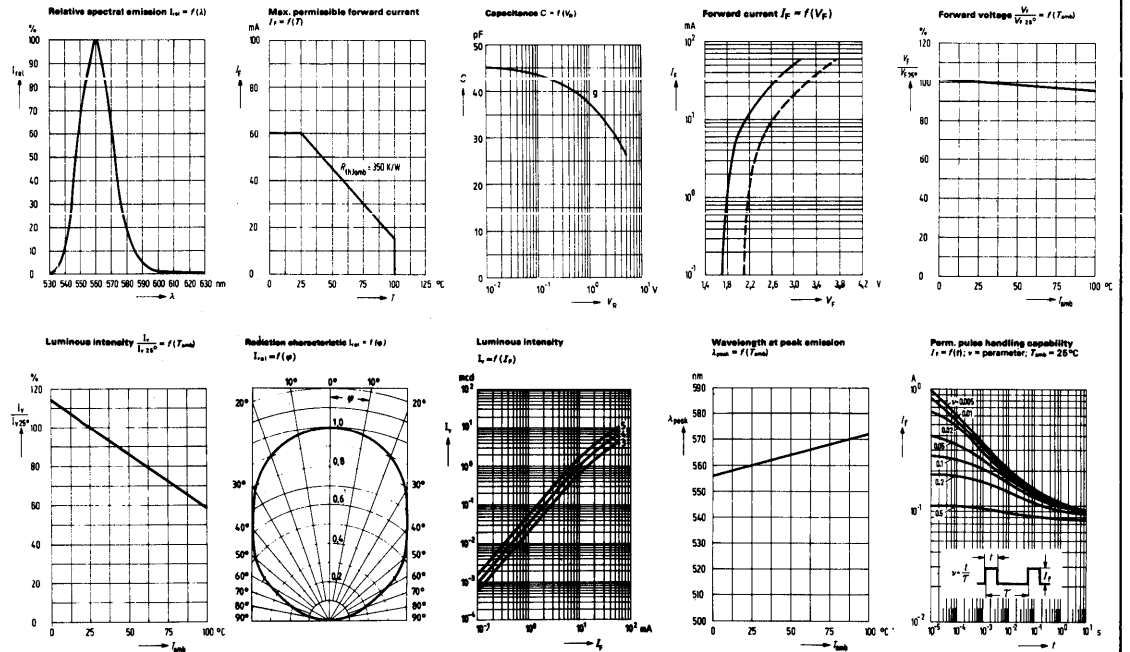




LDY 380X

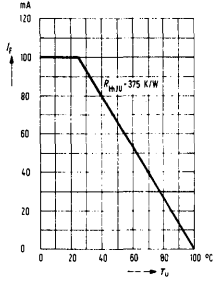


LDG 390X

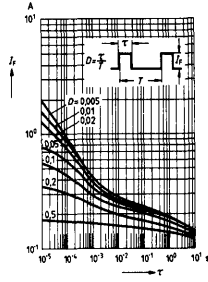


LDR 5000 SERIES

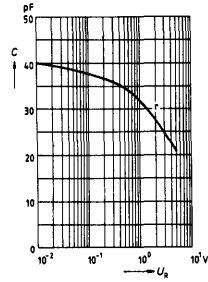
Forward current versus ambient temperature



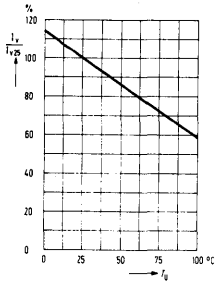
Permissible pulse handling capability
Forward current versus cycle duration
Duty cycle $D = \tau / T$; parameter: $T_{amb} = 25^\circ\text{C}$



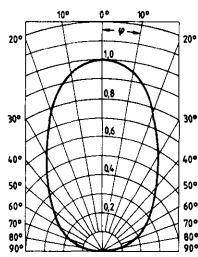
Capacitance versus reverse voltage



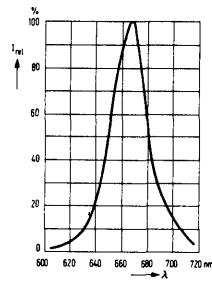
Luminous intensity versus ambient temperature



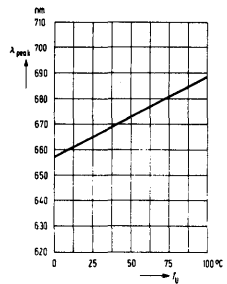
Radiation characteristic
Relative spectral emission versus half angle



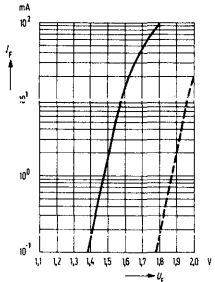
Relative spectral emission versus wavelength



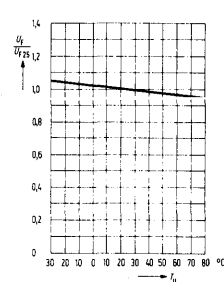
Wavelength of peak emission versus ambient temperature



Forward current versus forward voltage

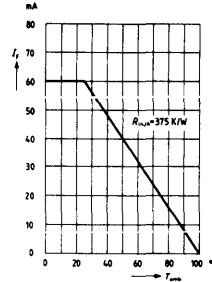


Forward voltage versus ambient temperature

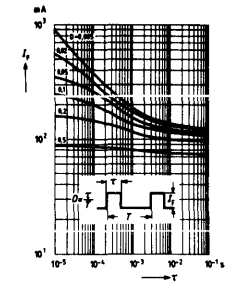


LDH 5020 SERIES

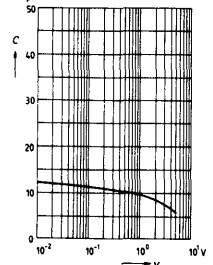
Forward current versus ambient temperature



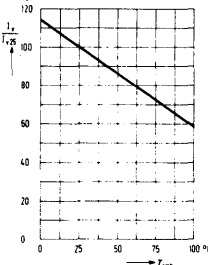
Permissible pulse handling capability
Forward current versus cycle duration
Duty cycle $D = \tau / T$; parameter: $T_{amb} = 25^\circ\text{C}$



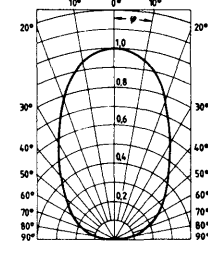
Capacitance versus reverse voltage



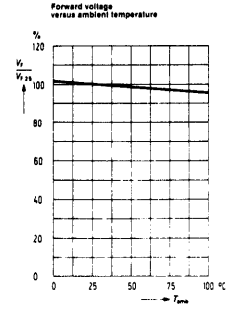
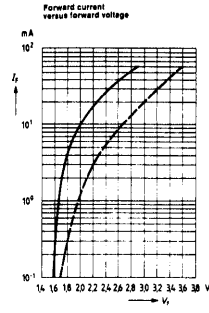
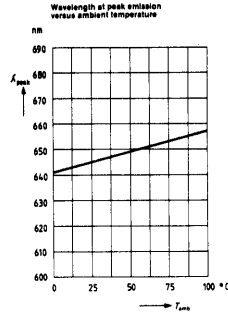
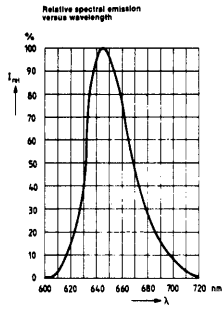
Luminous intensity versus ambient temperature



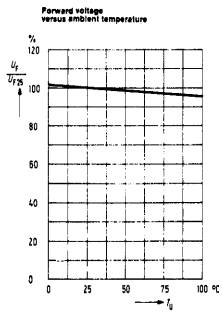
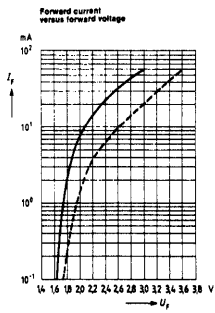
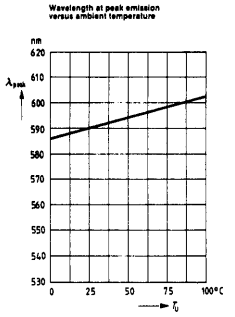
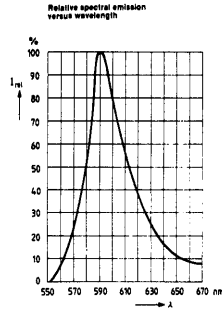
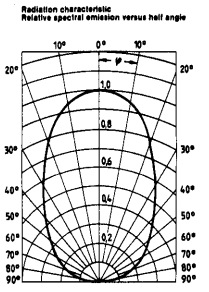
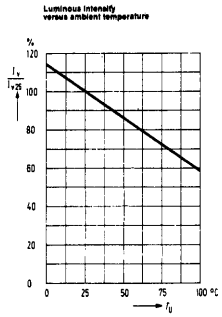
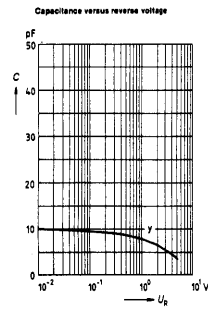
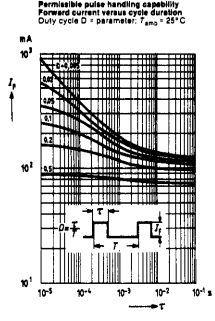
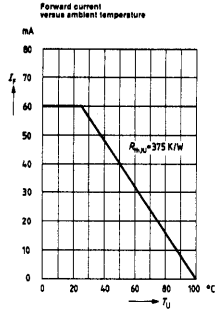
Radiation characteristic
Relative spectral emission versus half angle



LDH 5020 SERIES (Continued)

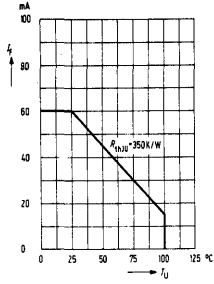


LDY 5060 SERIES

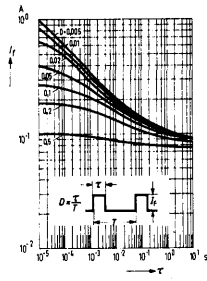


LDG 5070 SERIES

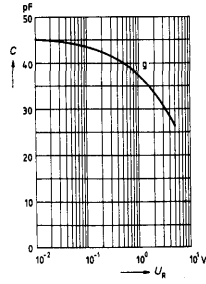
Forward current versus ambient temperature



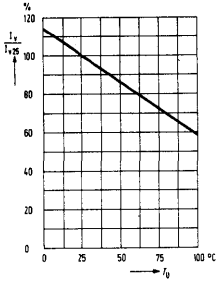
Permissible pulse handling capability
Forward current versus pulse duration
Duty cycle $D = 0.1$; parameter: $T_{amb} = 25^\circ\text{C}$



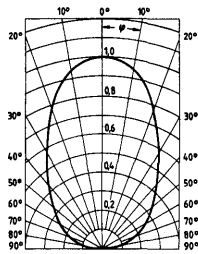
Capacitance versus reverse voltage



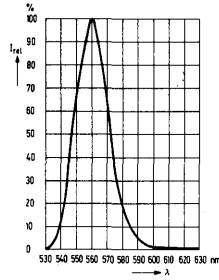
Luminous intensity versus ambient temperature



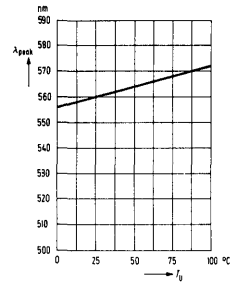
Radiation characteristic
Relative spectral emission versus half angle



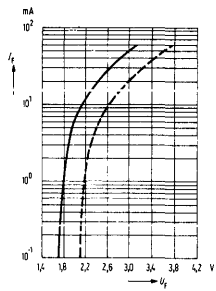
Relative spectral emission versus wavelength



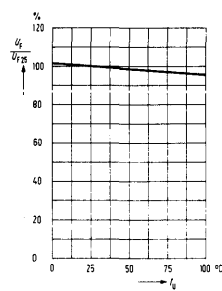
Wavelength at peak emission versus ambient temperature



Forward current versus forward voltage



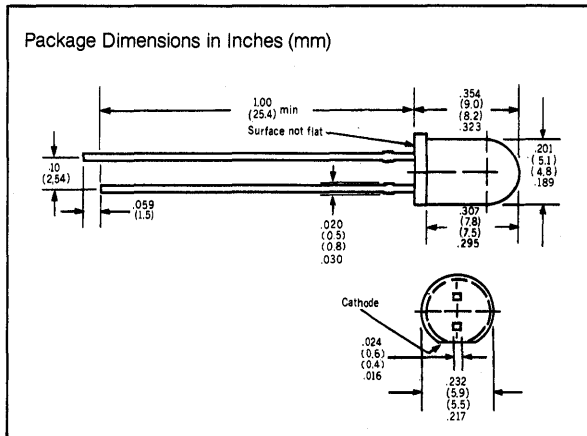
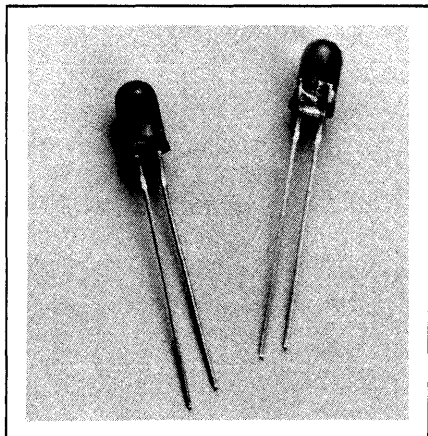
Forward voltage versus ambient temperature



SIEMENS

RED **LDR 5091 SERIES**
 HIGH EFFICIENCY RED **LDH 5191 SERIES**
 YELLOW **LDY 5391 SERIES**
 GREEN **LDG 5591 SERIES**

T1 3/4 LED LAMP



FEATURES

- High Light Output
- Lightly tinted clear lens
- Viewing Angle, 24°
- T1 3/4 Package Size
- 1" Lead Length
- Front Panel Mounting

Snap-in Mounting Clips Available
 Clip/Collar #004-9002 Black
 #004-9003 Clear

- I/C Compatible

DESCRIPTION

The LDR 509X is a standard red GaAsP light emitting diode lamp. The LDH 519X high efficiency red and LDY 539X yellow lamps are fabricated with TSN (transparent substrate nitrogen) technology. The LDG 559X is a gallium phosphide LED lamp. All four have a lightly tinted clear lens with a narrow viewing angle for the concentration of intense brightness in a head-on position. This is particularly desirable for legend back lighting applications.

Maximum Ratings

| | LDR 509X | LDH 519X | LDY 539X | LDG 559X | |
|--|------------|-------------|----------|----------|-----|
| Reverse voltage | V_R | 5 | 5 | | V |
| Forward current | I_F | 100 | 60 | | mA |
| Surge current ($\tau \leq 10 \mu s$) | I_{FS} | 2 | 1 | | A |
| Storage temperature range | T_{stg} | -55 to +100 | | | °C |
| Junction temperature | T_j | 100 | | | °C |
| Total power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} | 200 | | | mW |
| Thermal resistance, junction to air | R_{thJA} | 375 | | | K/W |

Characteristics ($T_{amb} = 25^\circ C$)

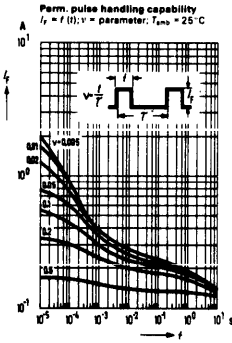
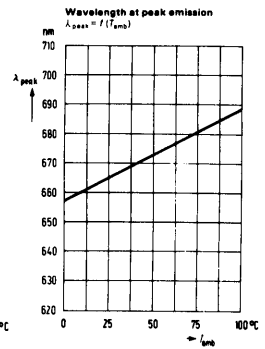
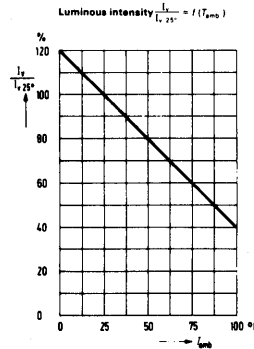
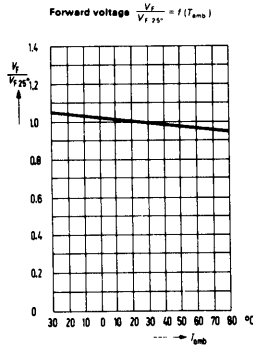
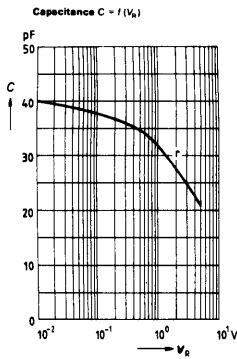
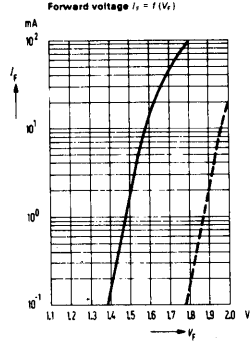
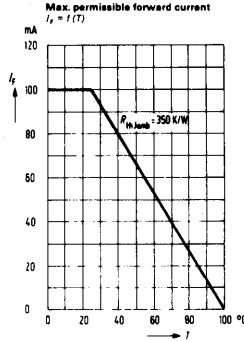
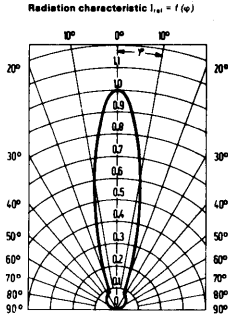
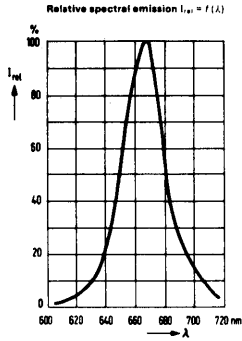
| | LDR 509X | LDH 519X | LDY 539X | LDG 559X | |
|---|------------------|-----------|----------|-----------|-------------|
| Wavelength at peak emission | λ_{peak} | 665 ± 15 | 645 ± 15 | 590 ± 10 | 560 ± 15 nm |
| Dominant wavelength | λ_{dom} | 645 | 638 | 592 | 561 nm |
| Viewing angle (Limits for 50% of luminous intensity I_v) | ϕ | 24 | 24 | 24 | 24 degrees |
| Forward voltage ($I_F = 20mA$) | V_F | 1.6(≤2.0) | | 2.4(≤3.0) | V |
| Reverse current ($V_R = 5 V$) | I_R | | | 0.01(≤10) | μA |
| Rise time | t_r | 5 | 100 | 100 | 50 ns |
| Fall time | t_f | 5 | 100 | 100 | 50 ns |
| Capacitance ($V_r = 0 V; f = 1 MHz$) | C_o | 40 | 12 | 10 | 45 pF |

Luminous Intensity Grouping

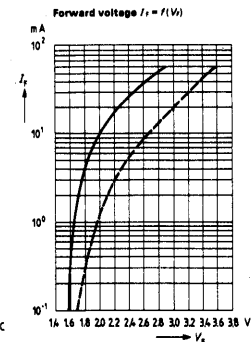
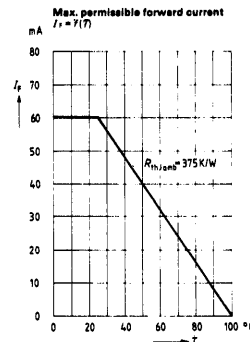
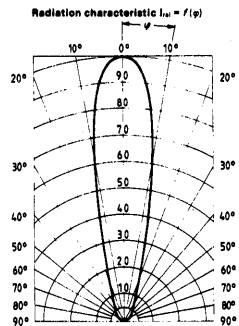
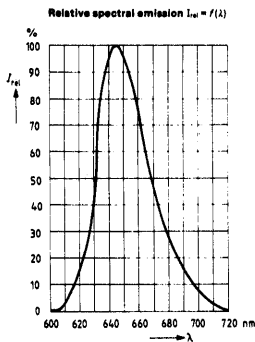
| New P/N | Replaces | Min Mcd | Test Current |
|----------|-----------------|---------|--------------|
| LDR 5091 | CQV50-5, LD50-2 | 2.5 | 20 mA |
| LDR 5092 | CQV50-6 & -7 | 4.0 | 20 mA |
| LDR 5093 | CQV50-8 | 10 | 20 mA |
| LDH 5191 | CQV51-H | 10 | 10 mA |
| LDH 5192 | CQV51-J | 20 | 10 mA |
| LDH 5193 | CQV51-K | 30 | 10 mA |
| LDY 5391 | CQV53-H | 10 | 10 mA |
| LDY 5392 | CQV53-J | 20 | 10 mA |
| LDY 5393 | CQV53-K | 30 | 10 mA |
| LDG 5591 | CQV55-J & -K | 40 | 20 mA |
| LDG 5592 | — | 80 | 20 mA |

Specifications are subject to change without notice.

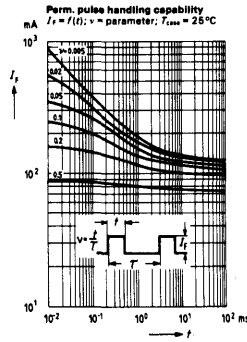
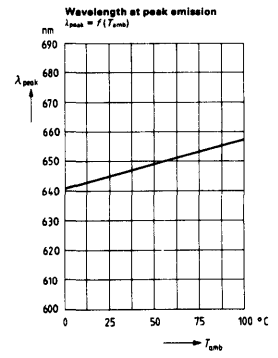
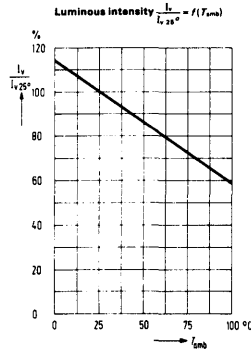
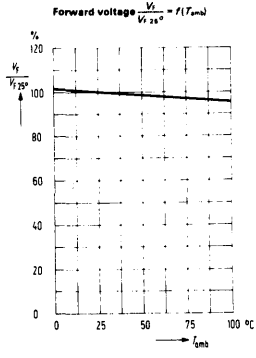
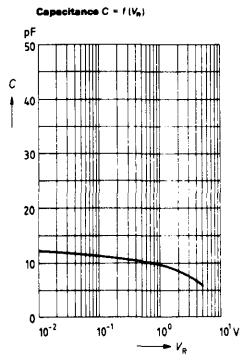
LDR 5091



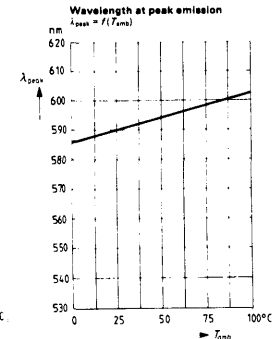
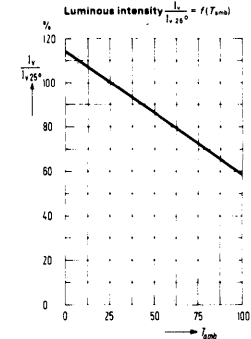
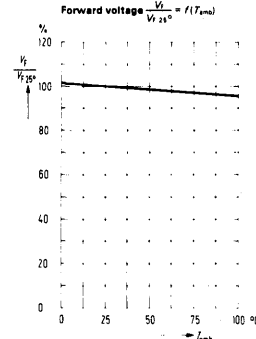
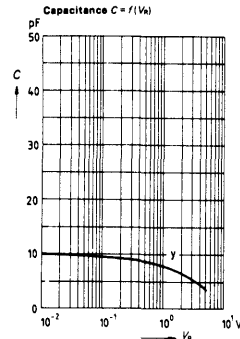
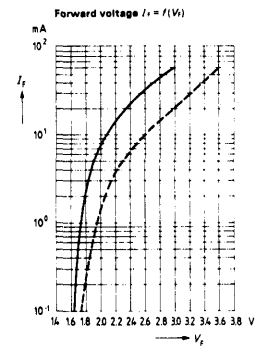
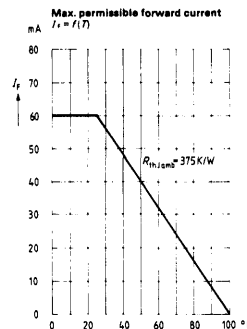
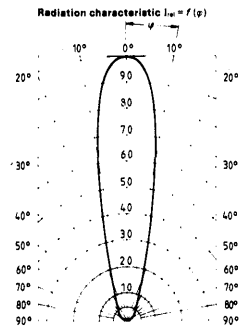
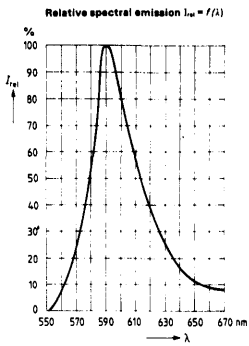
LDH 5191



LDH 5191 (CONTINUED)

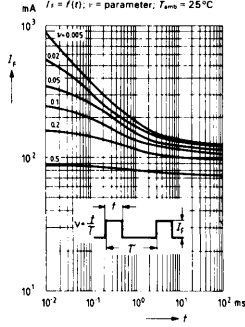


LDY 5391



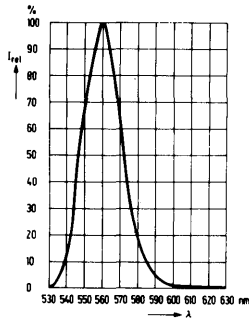
LDY 5391 (CONTINUED)

Permissible pulse handling capability
 $I_F = f(t)$; r parameter; $T_{amb} = 25^\circ\text{C}$

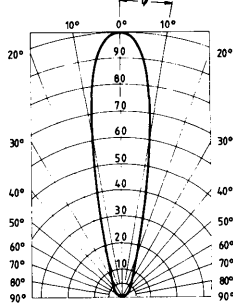


LDG 5591

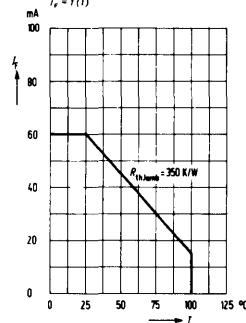
Relative spectral emission $I_{rel} = f(\lambda)$



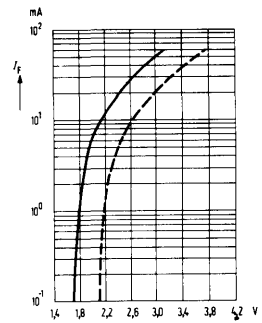
Radiation characteristic $I_{rel} = f(\varphi)$



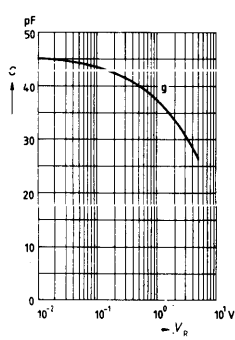
Max. permissible forward current $I_F = f(T)$



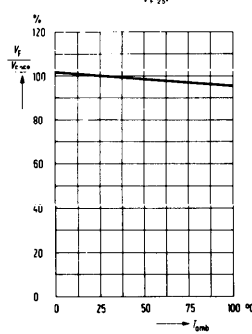
Forward voltage $I_F = f(V_F)$



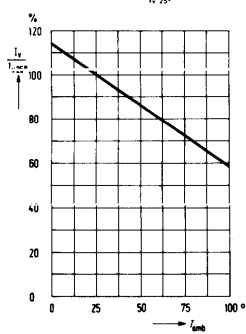
Capacitance $C = f(V_R)$



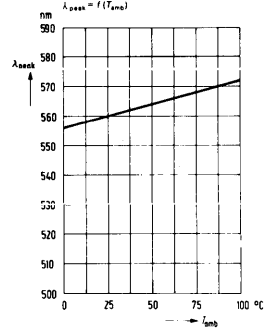
Forward voltage $V_F = f(T_{amb})$



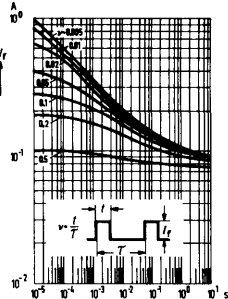
Luminous intensity $I_{lm} = f(T_{amb})$



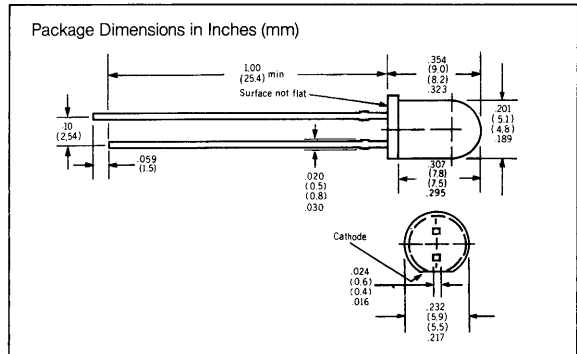
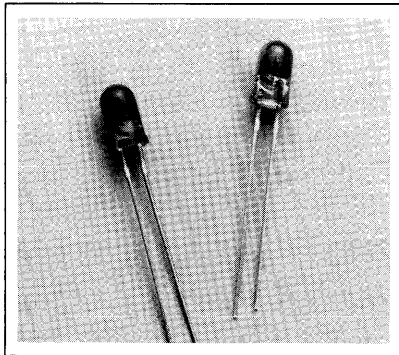
Wavelength at peak emission $\lambda_{peak} = f(T_{amb})$



Perm. pulse handling capability
 $I_F = f(t)$; r parameter; $T_{amb} = 25^\circ\text{C}$



T 1 $\frac{3}{4}$ LED LAMP



FEATURES

- High Light Output
- Diffused Lens
- Wide Viewing Angle 70°
- No Standoffs
- T 1 $\frac{3}{4}$ Package Size
- 1" Lead Length
- Front Panel Mounting
Snap-in Mounting Clips Available
Clip/Collar #004-9002 Black
#004-9003 Clear
- I/C Compatible

DESCRIPTION

The LDR 510X Series is a standard red gallium arsenide phosphide (GaAsP) LED lamp. The LDH 512X high efficiency red and LDY 516X yellow are premium high efficiency light emitting diode lamps fabricated with TSN (transparent substrate nitrogen) technology. The LDG 517X green is a gallium phosphide (GaP) lamp. All have a diffused plastic lens which emits a full flooded intense light.

Maximum ratings

| | LDR 510X | LDH 512X | LDY 516X | LDG 517X | |
|---|------------|-------------|----------|----------|-----|
| Reverse voltage | V_R | 5 | 5 | | V |
| Forward current | I_F | 100 | 60 | | mA |
| Surge current ($\tau \leq 10\mu s$) | I_{FS} | 2 | 1 | | A |
| Storage temperature range | T_{stg} | -55 to +100 | | | °C |
| Junction temperature | T_j | 100 | 100 | | °C |
| Total power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} | 200 | 200 | | mW |
| Thermal resistance junction to air | R_{thJA} | 375 | 375 | | K/W |

Characteristics ($T_{amb} = 25^\circ$)

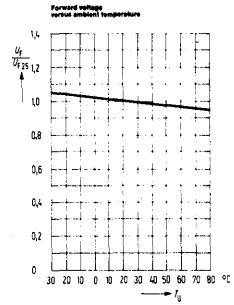
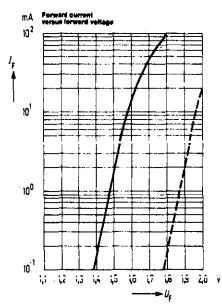
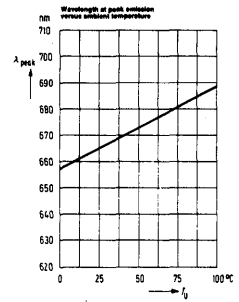
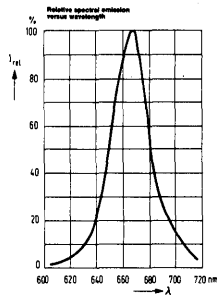
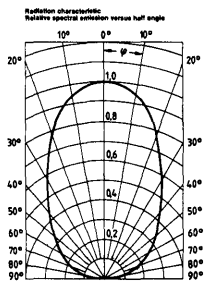
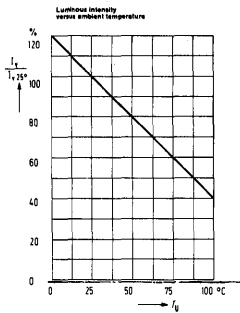
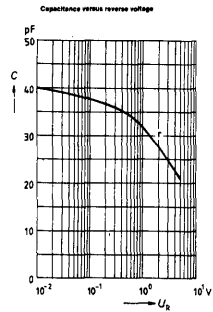
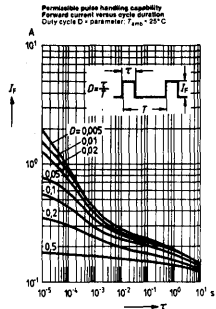
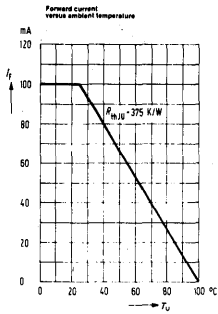
| | LDR 510X | LDH 512X | LDY 516X | LDG 517X | | |
|---|------------------|-----------|----------|------------|--------|---------|
| Wavelength at peak emission | λ_{peak} | 665±15 | 645±15 | 590±10 | 560±15 | nm |
| Dominant wavelength | λ_{dom} | 645 | 638 | 592 | 561 | nm |
| Viewing angle | φ | 70 | 70 | 70 | 70 | degrees |
| (Limits for 50% of luminous intensity I_v) | | | | | | |
| Forward voltage ($I_F = 20mA$) | V_F | 1.6(≤2.0) | | 2.4(≤3.0) | | V |
| Reverse current ($V_R = 5V$) | I_R | | | 0.01 (≤10) | | μA |
| Rise time | t_r | 5 | 100 | 200 | 50 | ns |
| Fall time | t_f | 5 | 100 | 200 | 50 | ns |
| Capacitance ($V_R = 0V, f = 1MHz$) | C_0 | 40 | 12 | 10 | 45 | pF |

Luminous Intensity grouping

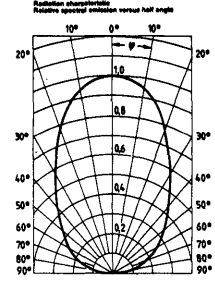
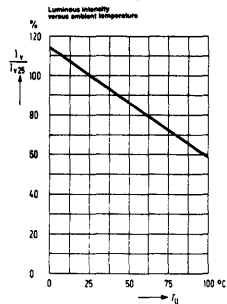
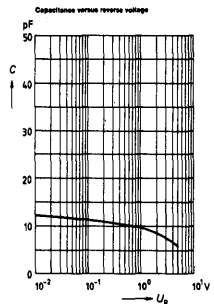
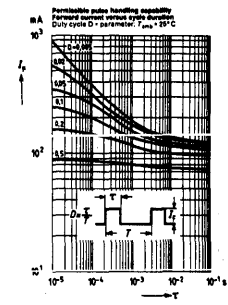
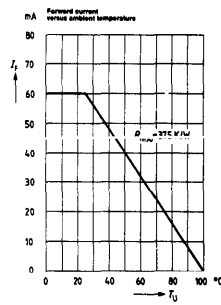
| P/N | Replaces | mcd (Min) | Test conditions |
|----------|-------------------------------|-----------|-----------------|
| LDR 5101 | LD 510-3, RL-5053A & -1 | 1.0 | 20mA |
| LDR 5102 | LD 510-4 & -5, RL-5053-2 & -3 | 2.5 | 20mA |
| LDR 5103 | ----- | 4.0 | 20mA |
| LDH 5121 | LD 512-4-7 | 2.0 | 10mA |
| LDH 5122 | LD 512-8 | 4.0 | 10mA |
| LDH 5123 | ----- | 6.0 | 10mA |
| LDY 5161 | LD 516-4, YL-4550, YL-4850 | 1.0 | 10mA |
| LDY 5162 | LD 516-5 & -6 | 2.5 | 10mA |
| LDY 5163 | ----- | 4.0 | 10mA |
| LDG 5171 | LD 517-5, GL-4850, GL-4950 | 2.5 | 20mA |
| LDG 5172 | LD 517-6 & -7 | 6.0 | 20mA |

Specifications are subject to change without notice.

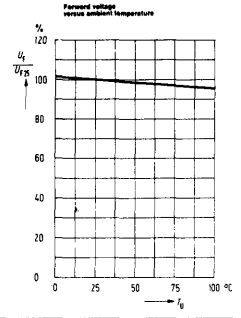
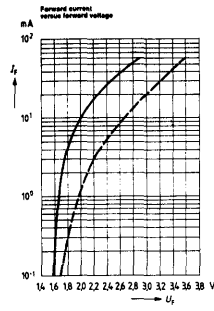
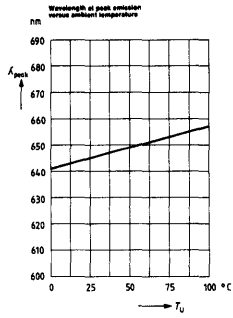
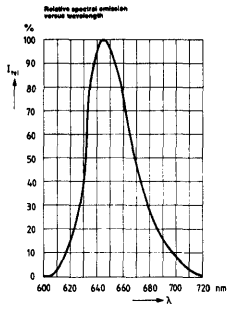
LDR 5100 SERIES



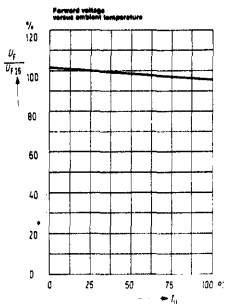
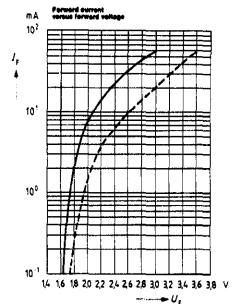
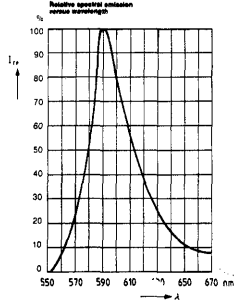
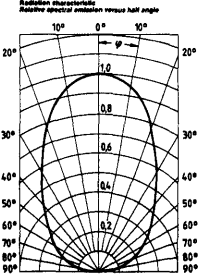
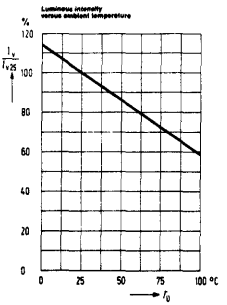
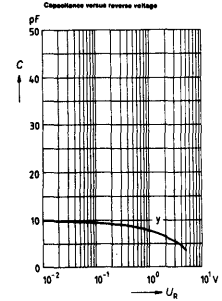
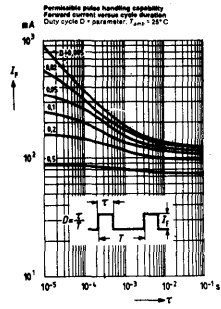
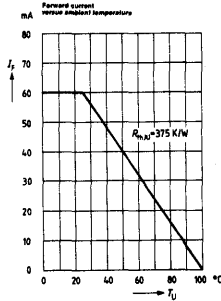
LDH 5120 SERIES



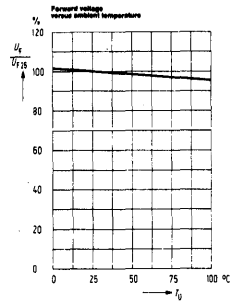
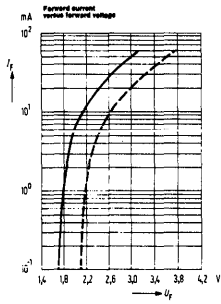
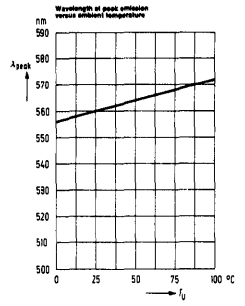
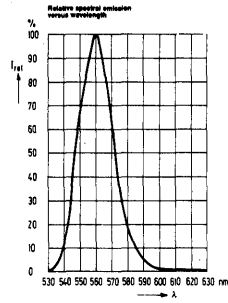
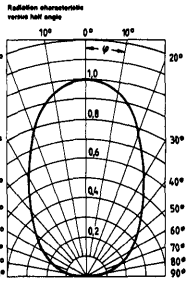
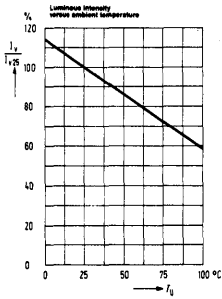
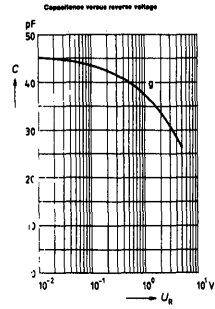
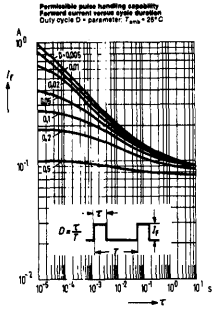
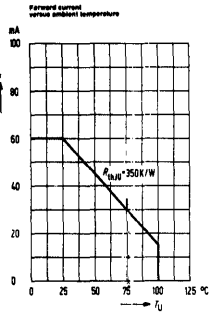
LDH 5120 (Continued)



LDY 5160 SERIES



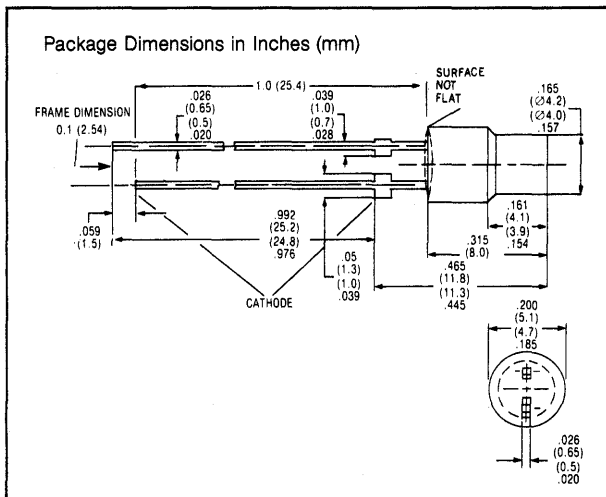
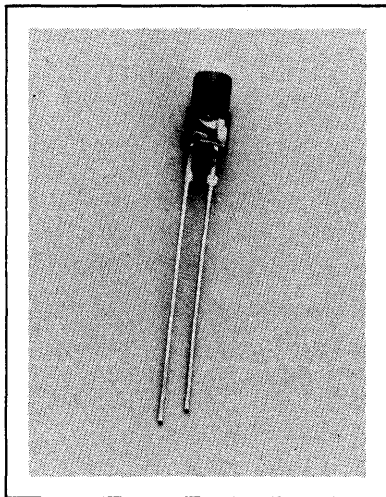
LDG 5170 SERIES



SIEMENS

RED LDR 5700 SERIES
HIGH EFFICIENCY RED LDH 5600 SERIES
YELLOW LDY 5800 SERIES
GREEN LDG 5900 SERIES

CYLINDRICAL LED LAMP



FEATURES

- Red Diffused Lens, LDR 570X
- Red Diffused Lens, LDH 560X
- Yellow Diffused Lens, LDY 580X
- Green Diffused Lens, LDG 590X
- Cylindrical Shape
- Minimum Lead Length 1"
- 1/10" Lead Spacing
- I/C Compatible

DESCRIPTION

The LDR 570X is a standard red GaAsP LED lamp. The LDH 560X & LDY 580X are light emitting diode lamps fabricated with TSN (transparent substrate nitrogen) technology. The LDG 590X is a gallium phosphate LED lamp. All the series have a diffused lens which forms an evenly dispersed circular head on light.

Maximum

| | | | |
|--|---------------|-------------|-----|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 60 | mA |
| Surge current ($t \leq 10 \mu s$) | I_{FS} | 1 | A |
| Storage temperature | T_s | -55 to +100 | °C |
| Junction temperature | T_j | 100 | °C |
| Power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} | 200 | mW |
| Thermal resistance junction to air | $R_{th,Jamb}$ | 375 | K/W |

Characteristics ($T_{AMB} = 25^\circ C$)

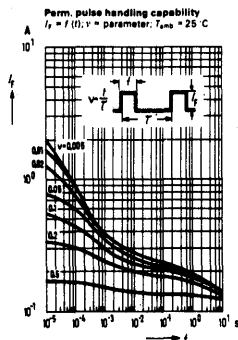
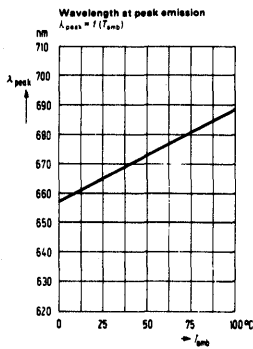
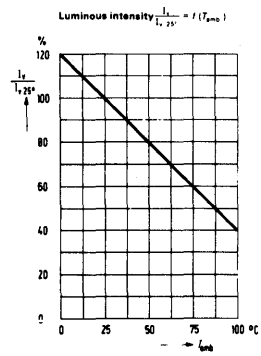
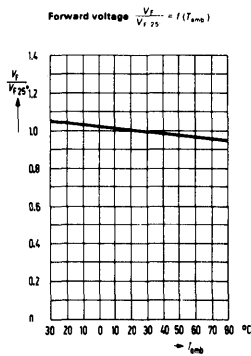
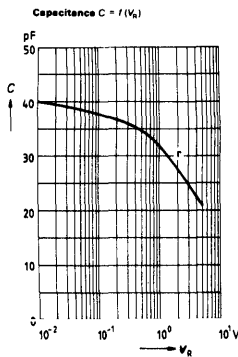
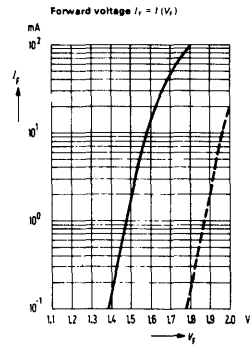
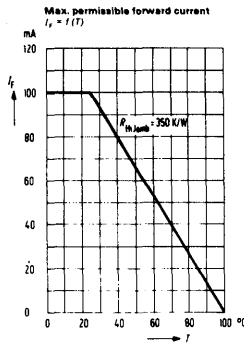
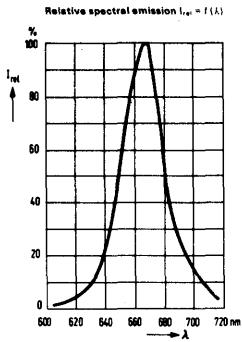
| | LDH 570X | LDH 560X | LDY 580X | LDG 590X | |
|---|------------------|----------|------------|----------|------|
| Wave length of emitted light | 665 ± 15 | 645 ± 15 | 590 ± 10 | 560 ± 15 | nm |
| Dominant wave length | 645 | 638 | 592 | 561 | nm |
| Viewing Angle | 100 | 100 | 100 | 100 | deg. |
| (Limits for 50% of luminous intensity I_v shielded against lateral emission of light) | | | | | |
| Forward voltage ($I_F = 20 \text{ mA}$) | V_F 1.6 (≤2.0) | | 2.4 (≤3.0) | | V |
| Reverse current ($V_R = 5 \text{ V}$) | I_R 0.01 (≤10) | | 0.01 (≤10) | | μA |
| Rise time | t_r 5 | 100 | 100 | 50 | nS |
| Fall time | t_f 5 | 100 | 100 | 50 | nS |
| Capacitance ($V_R = 0 \text{ V}$) | C_0 40 | 12 | 10 | 45 | pF |

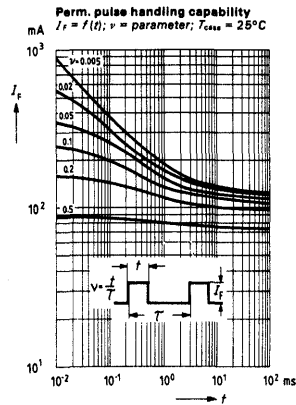
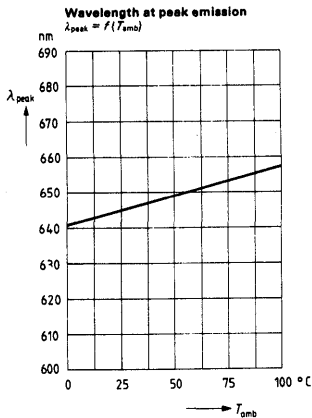
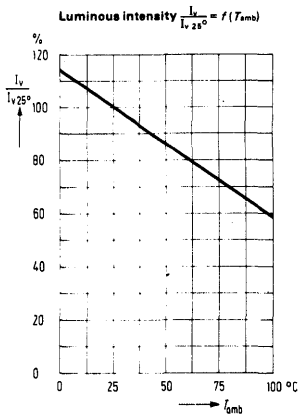
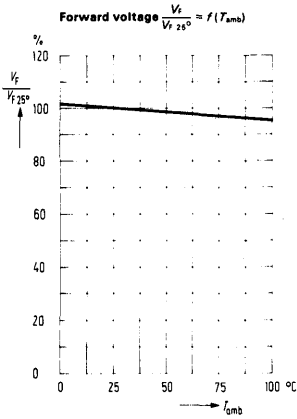
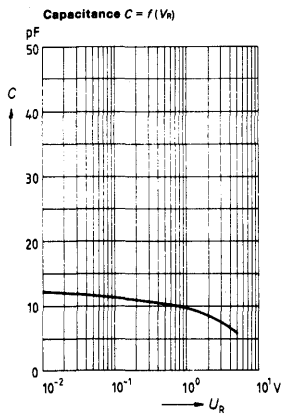
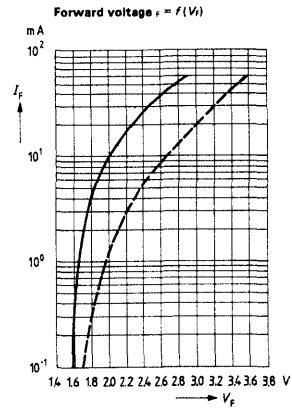
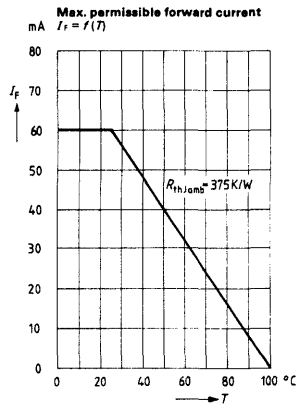
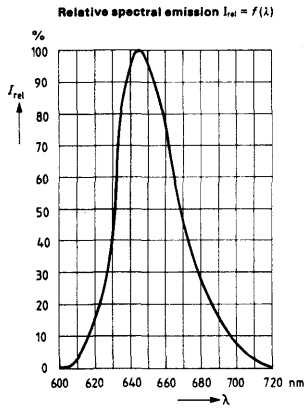
Luminous Intensity

| New P/N | Replaces | Min. | Unit | Test Condition |
|----------|----------|------|------|----------------|
| LDR 5701 | — | 0.4 | mcd | 20 mA |
| LDR 5702 | — | .63 | mcd | 20 mA |
| LDH 5601 | CQV56-4 | 1.6 | mcd | 20 mA |
| LDH 5602 | — | 2.5 | mcd | 20 mA |
| LDY 5801 | CQV58-3 | 1.0 | mcd | 20 mA |
| LDY 5802 | CQV58-4 | 1.6 | mcd | 20 mA |
| LDY 5803 | — | 2.5 | mcd | 20 mA |
| LDG 5901 | CQV59-3 | 1.0 | mcd | 20 mA |
| LDG 5902 | CQV59-4 | 1.6 | mcd | 20 mA |
| LDG 5903 | — | 2.5 | mcd | 20 mA |

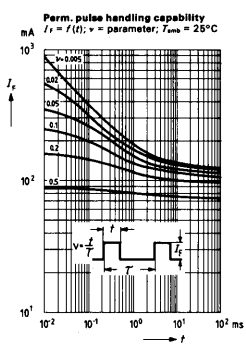
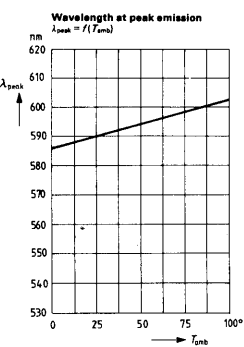
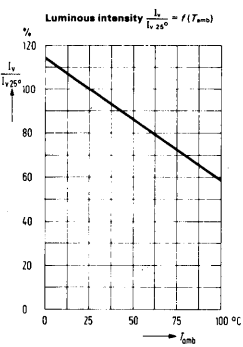
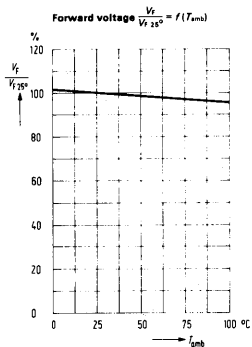
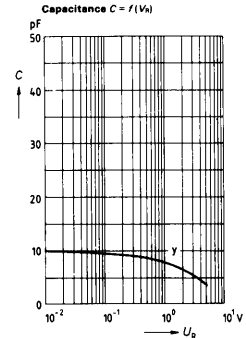
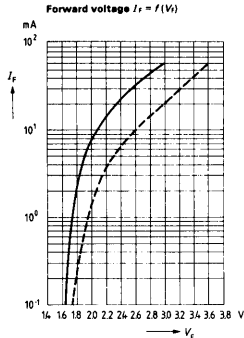
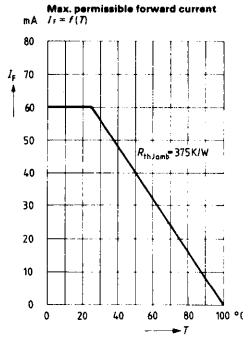
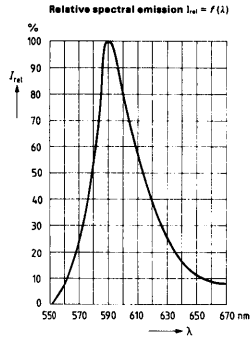
Specifications are subject to change without notice.

LDR 570X

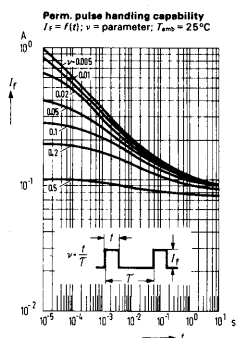
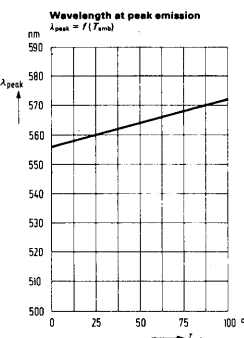
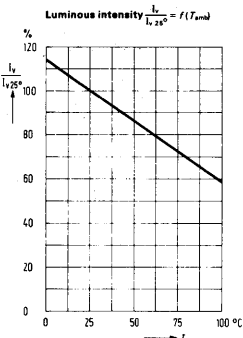
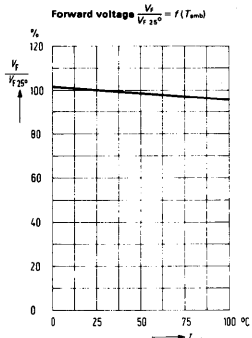
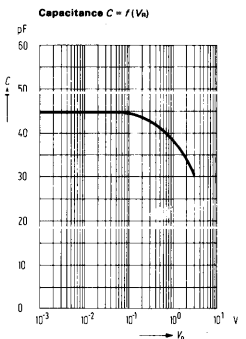
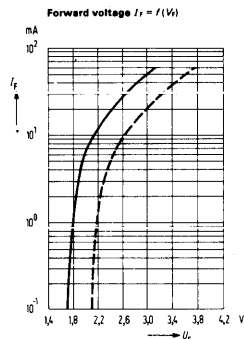
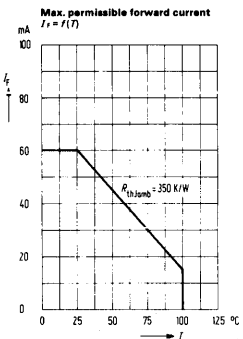
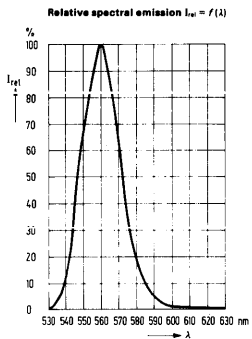




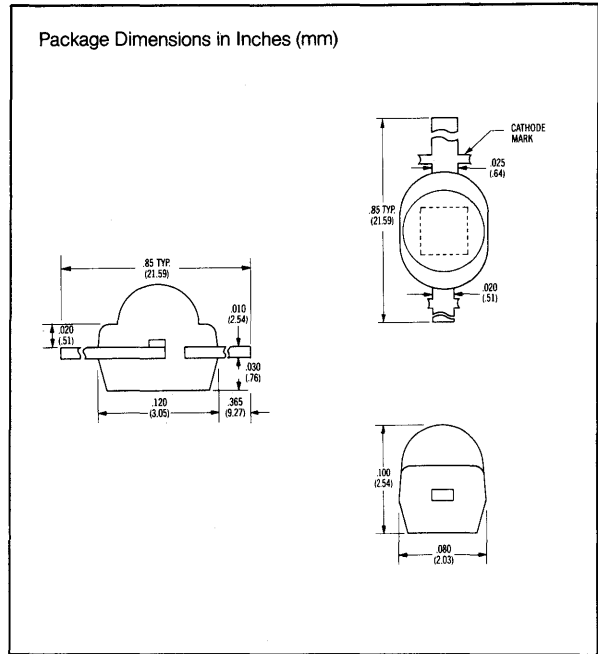
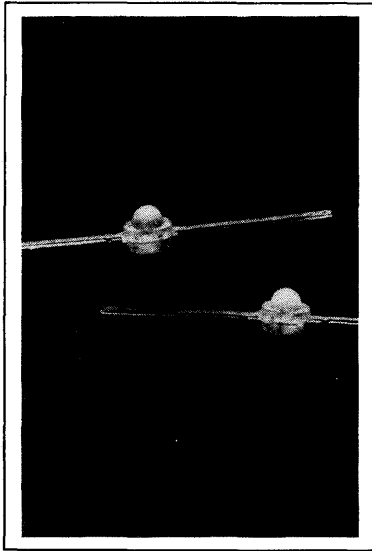
LDY 580X



LDG 590X



RED MINIATURE AXIAL LEAD LED LAMP



FEATURES

- High Luminance—typically 1.0 mcd @ 10mA
- Optimum Packaging Design for Maximum Strength at Minimum Linear Spacing
- Operates from 5 V IC Logic Supply
- Small Size
- High Reliability
- Water clear lens

DESCRIPTION

The RL-50 is intended for high volume usage in array and indicator light applications. Major advantages of this device are high luminance at lower currents, long life and low cost.

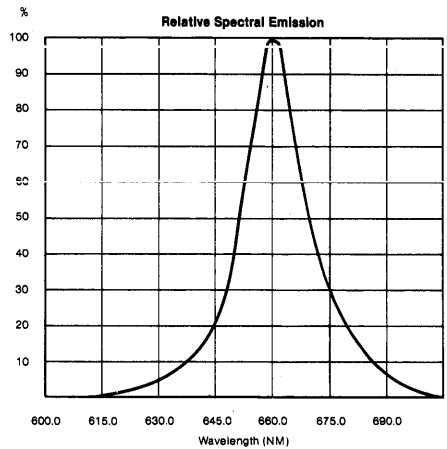
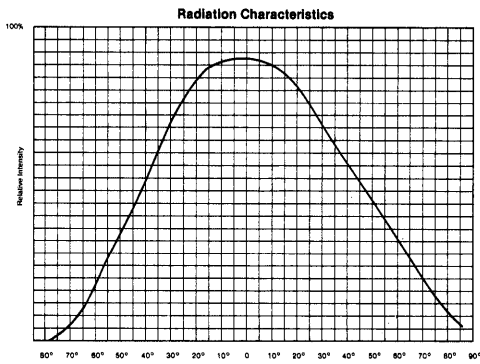
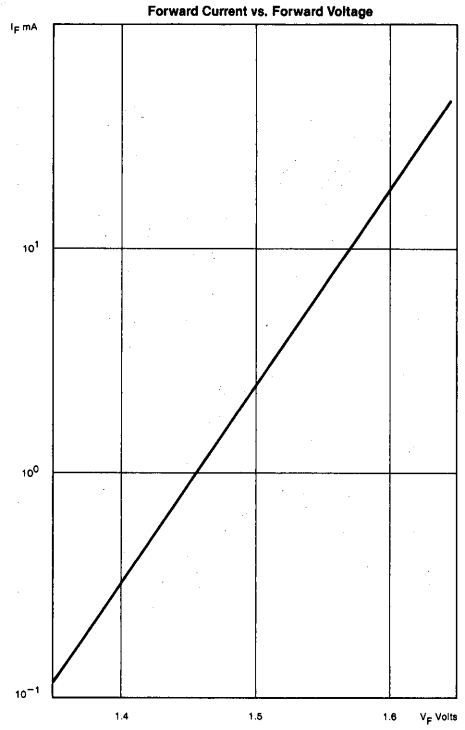
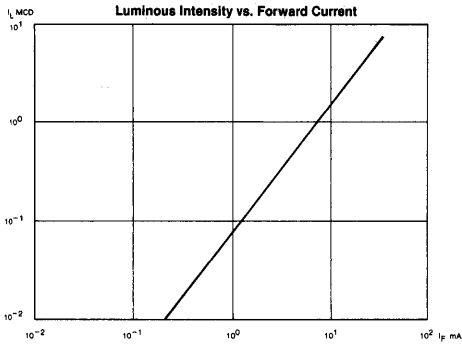
Maximum Ratings

| | |
|--|-------------------|
| Power Dissipation @ 25°C Ambient | 80 mW |
| Derate Linearly from 25°C | - 1.1 mW/°C |
| Storage and Operating Temp. Range | - 55°C to + 100°C |
| Continuous Forward Current | 40 mA |
| Lead Solder Time @ 260°C (1/16" from lens) | 5 sec. |
| Peak Inverse Voltage | 3.0 V |

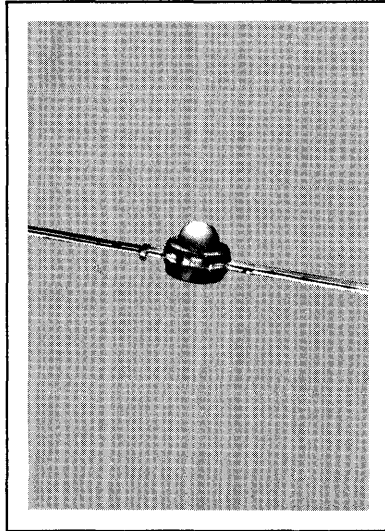
Opto-Electronic Characteristics (@ 25°C)

| Parameter | Min | Typ | Max | Units | Test |
|--------------------------|-----|-----|-----|---------|------------------------|
| | | | | | Condition |
| Reverse Current | | | 100 | μA | -3.0 V |
| Forward Voltage | | 1.6 | 2.0 | V | I _F = 20 mA |
| Luminous Intensity | 0.5 | 1.0 | | mcd | I _F = 10 mA |
| Viewing Angle | | 90 | | degrees | |
| Peak emission wavelength | | 660 | | nm | |

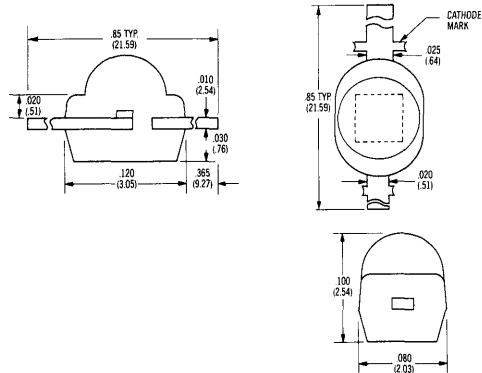
Specifications subject to change without notice.



RED MINIATURE AXIAL LEAD LED LAMP



Package Dimensions in Inches (mm)



FEATURES

- **High Luminance**—Typically 1.0 mcd @ 10mA
- **Optimum Packaging Design for Maximum Strength at Minimum Linear Spacing**
- **Operates from 5 V IC Logic Supply**
- **Small Size**
- **High Reliability**
- **Red Diffused lens**

DESCRIPTION

The RL-54 is intended for high volume usage in array and indicator light applications. Major advantages of this device are high luminance at lower currents, long life and low cost.

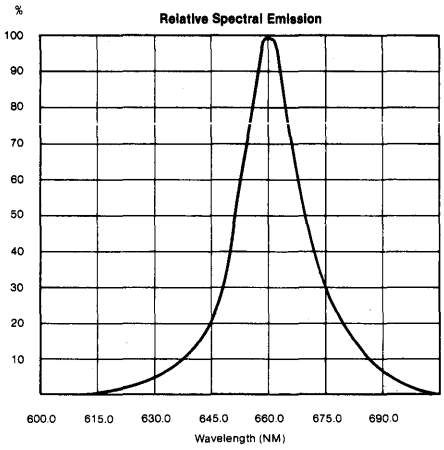
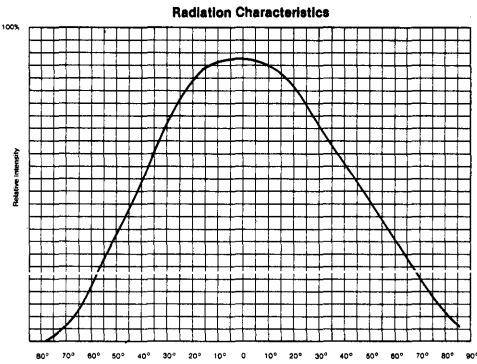
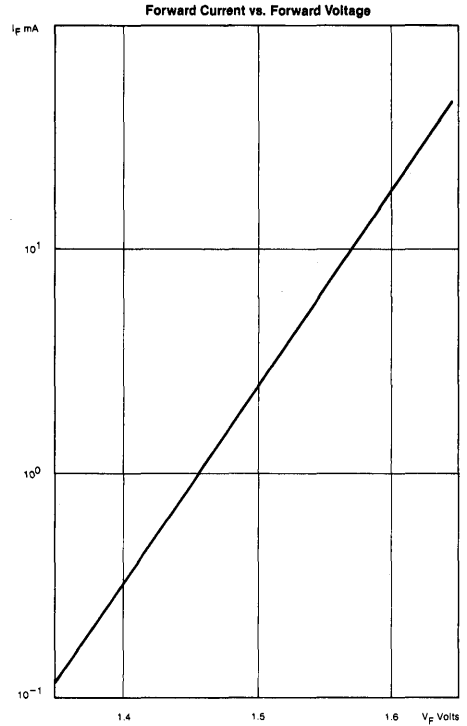
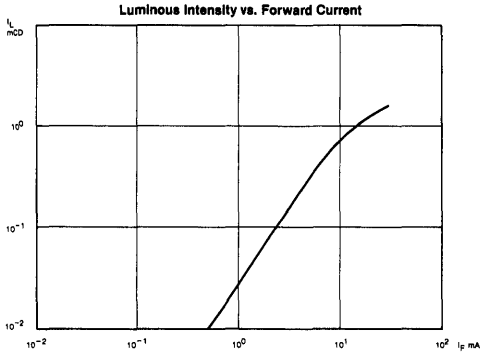
Maximum Ratings

| | |
|--|-----------------|
| Power Dissipation @ 25°C Ambient | 80 mW |
| Derate Linearly from 25°C | -1.1 mW/°C |
| Storage & Operating Temp. Range | -55°C to +100°C |
| Continuous Forward Current | 40 mA |
| Lead Solder Time @ 260°C (1/16" from lens) | 5 sec. |
| Peak Inverse Voltage | 3.0 V |

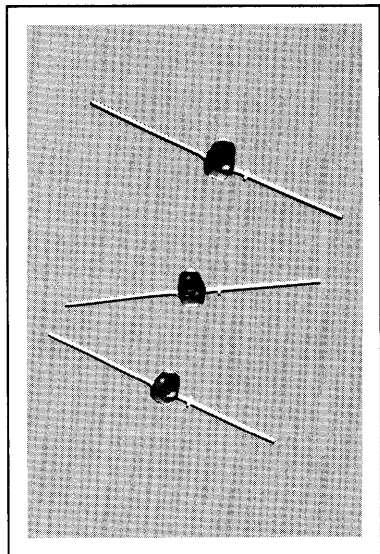
Opto-Electronic Characteristics (@ 25°C)

| Parameter | Min | Typ | Max | Units | Test Condition |
|------------------------------|-----|-----|-----|---------|------------------------|
| Reverse Current | | | 100 | μA | -3.0 V |
| Forward Voltage | | 1.6 | 2.0 | V | I _F = 20 mA |
| Luminous Intensity | 0.4 | 0.6 | | mcd | I _F = 10 mA |
| Viewing Angle | | 90 | | degrees | |
| Peak emission wavelength ... | | 660 | | nm | |

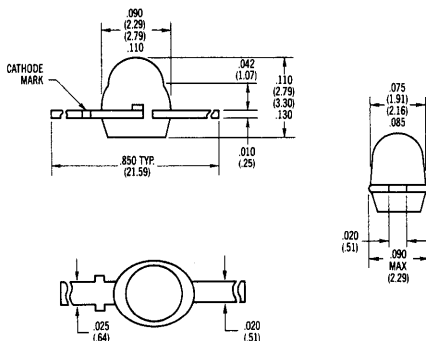
Specifications subject to change without notice.



RED MINIATURE AXIAL LEAD LED LAMP



Package Dimensions in Inches (mm)



FEATURES

- **2 Gate Load Bright Light**—.4 mcd at 3 mA
- **High on Axis Intensity, typically 2.2 mcd 10 mA**
- **Optimum Packaging Design for Maximum Strength at Minimum Linear Spacing**
- **Operates from 5 V IC Logic Supply**
- **Miniature Axial Lead**
- **High Reliability**
- **RL-55-5—Low Cost Version**

DESCRIPTION

The RL-55 is a Gallium Arsenide Phosphide LED lamp that has high on-axis intensity at low current (3 mA), long life and low cost. It uses a dark red diffused lens and provides a full .080" flooded light with good contrast. When operated at high current (10 mA) the RL-55 has a very high on-axis intensity of 2.2 mcd @ 10 mA. Applications include mounting on PC boards at low current as diagnostic and circuit status indicators. Function and low voltage indicator on battery powered equipment such as calculators, watches and portable DVMS and in the higher current mode as a back light.

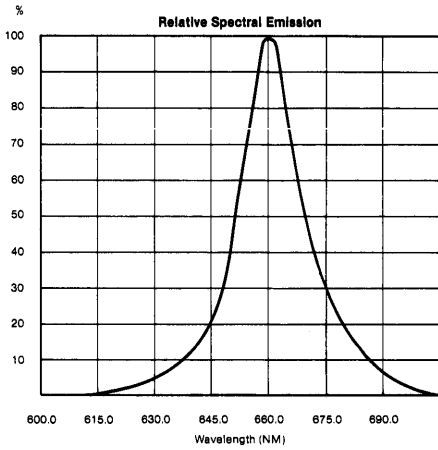
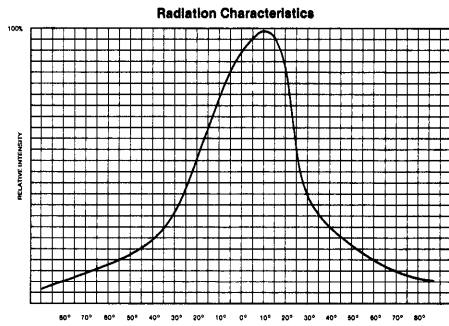
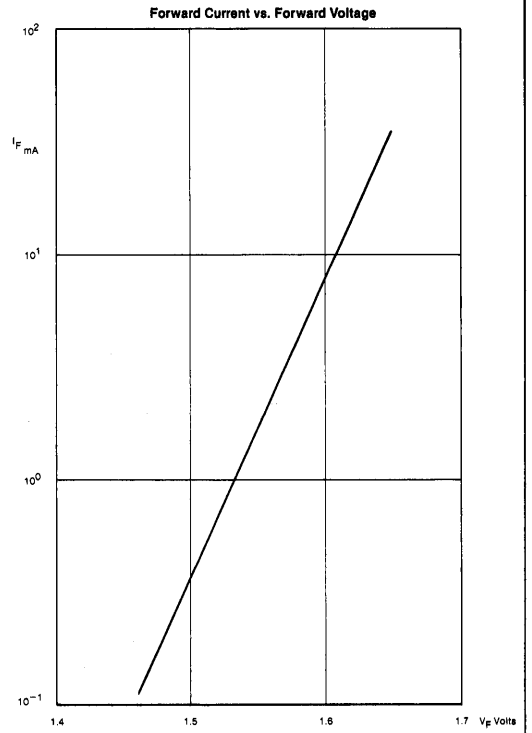
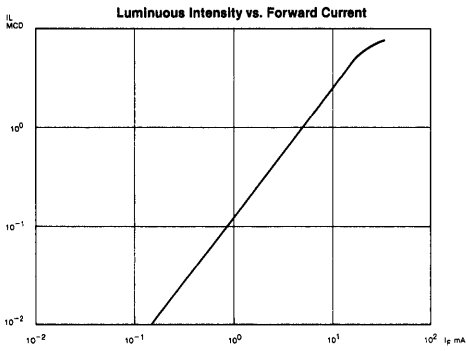
Maximum Ratings:

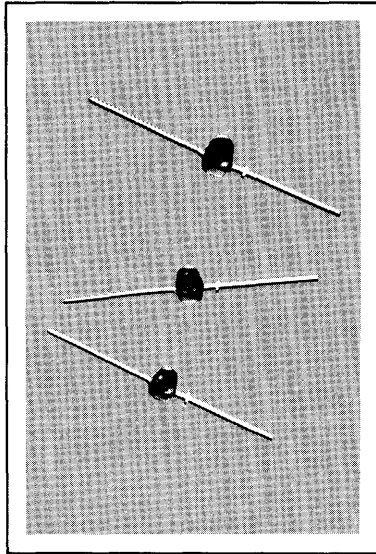
| | |
|--|-------------------|
| Power Dissipation @ 25°C Ambient | 80 mW |
| Derate Linearly From 25°C | - 1.1 mW/°C |
| Storage and Operating Temperature | - 55°C to + 100°C |
| Continuous Forward Current | 40 mA |
| Lead Solder Time @ 260°C (1/16" from case) | 5 sec |
| Peak Inverse Voltage | 3V |
| Peak Forward Current (1µs pulse, 0.1% duty cycle) | 400 mA |

Opto-Electronic Characteristics (@ 25°C)

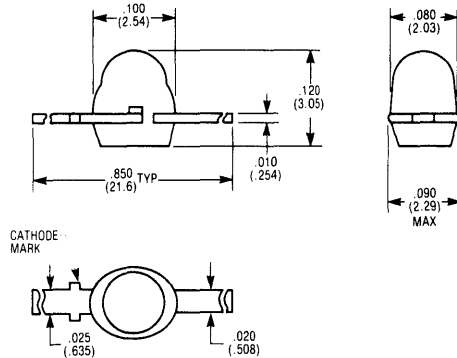
| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|--------------------------|------|------|------|---------|------------------------|
| Reverse Current | | | 10 | µA | V _R = 3 V |
| Forward Voltage | 1.6 | | 2.0 | V | I _F = 20 mA |
| Viewing Angle | | 50 | | degrees | |
| Luminous Intensity | | | | | |
| RL-55 | 2 | 2.2 | | mcd | I _F = 10 mA |
| Capacitance | | 20 | | pF | V = 0 |
| Peak Emission Wavelength | | 660 | | nm | |
| Spectral Line Half-Width | | 40 | | nm | |

Specifications are subject to change without notice.





Package Dimensions in Inches (mm)



FEATURES

- High on Axis Intensity
- Optimum Packaging Design for Maximum Strength at Minimum Linear Spacing
- Operates from 5 V IC Logic Supply
- Miniature Axial Lead
- High Reliability

DESCRIPTION

The GL-56/YL-56 are Gallium Phosphide LED lamps that have high on-axis intensity, long life and low cost. They are diffused lenses and provide a full 0.080" flooded light with good contrast. When operated at high current (10 mA) they have high on-axis intensity. Applications include mounting on PC boards at low current as diagnostic and circuit status indicators.

Maximum Ratings

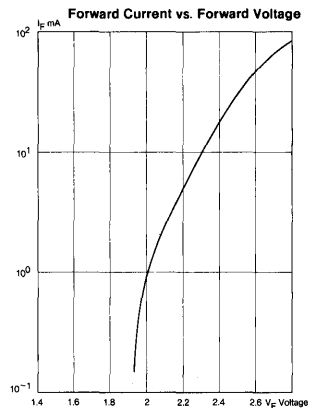
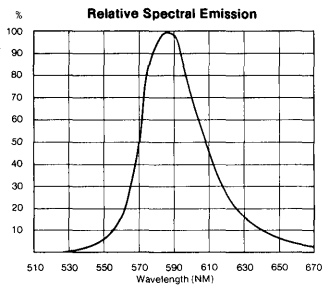
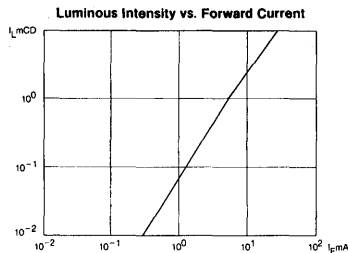
| | |
|---|---------------------|
| Power Dissipation @ 25° C Ambient | 80 mW |
| Derate Linearly From 25° C | - 1.1 mW/°C |
| Storage and Operating Temperature | - 55° C to + 100° C |
| Continuous Forward Current | 25 mA |
| Lead Solder Time @ 260° C (1/16" from case) | 5 sec |
| Peak Inverse Voltage | 3V |
| Peak Forward Current (1µs pulse, 0.1% duty cycle) | 250 mA |

Opto-Electronic Characteristics (@ 25° C)

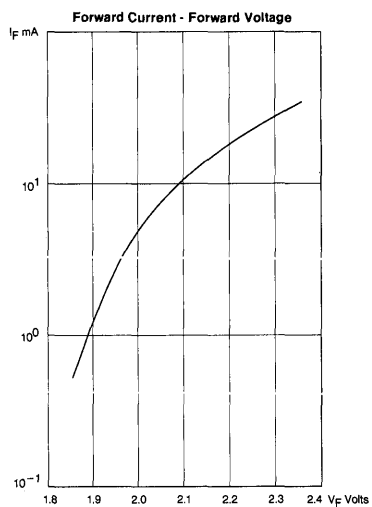
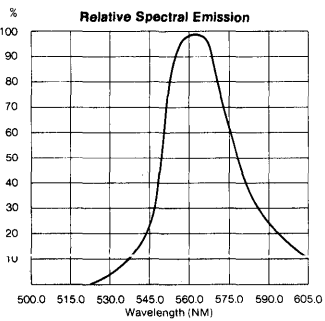
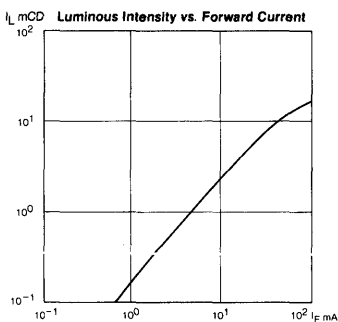
| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|--------------------------|------|------|------|---------|------------------------|
| Luminous Intensity | | | | | |
| YL-56 | 2.0 | 2.2 | | mcd | I _F = 10 mA |
| GL-56 | 1.0 | 1.3 | | mcd | I _F = 10 mA |
| Forward Voltage | | | | | |
| YL-56 | | 2.4 | 3.5 | V | I _F = 20 mA |
| GL-56 | | 2.2 | 3.5 | V | I _F = 20 mA |
| Viewing Angle | | 40 | | degrees | |
| Reverse Current | | 0.15 | 10 | µA | V _R = 3 V |
| Peak Emission Wavelength | | | | | |
| YL-56 | | 585 | | nm | |
| GL-56 | | 565 | | nm | |

Specifications subject to change without notice.

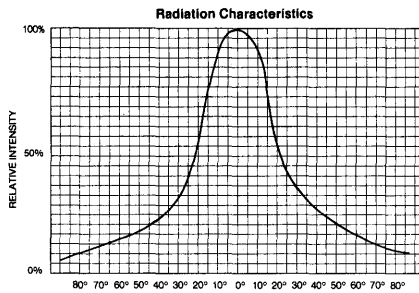
YL-56



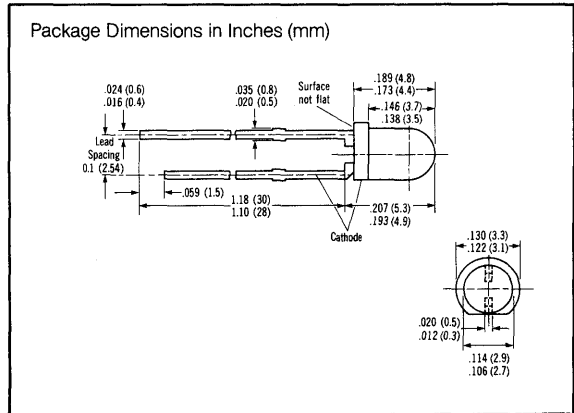
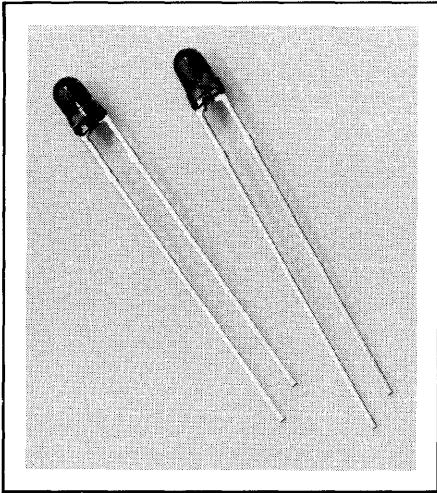
GL-56



YL-56 & GL-56



Preliminary



FEATURES

- Integral Current Limiting Resistor
- No External Resistor Required with 5 Volt Supply
- Red Diffused Lens
- High Reliability
- T-1 Package Style
- 1-Inch Leads
- Wide Viewing Angle, 70°

DESCRIPTION

The RRL-1100 is a gallium arsenide phosphide LED red lamp containing an integral resistor chip in series with the LED. This allows operation from a 5 volt source without an external current limiting resistor. Applications include mounting on PC boards as diagnostic and circuit status indicators.

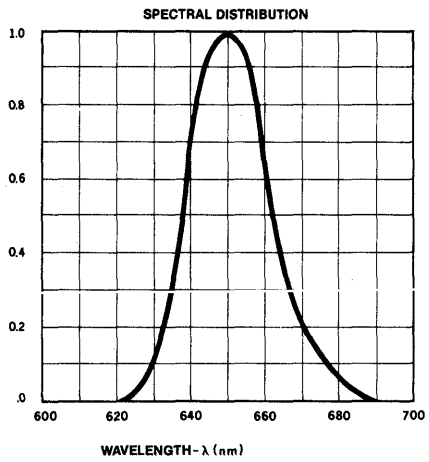
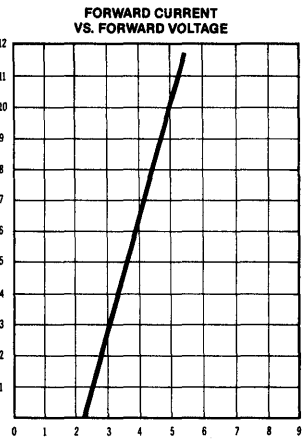
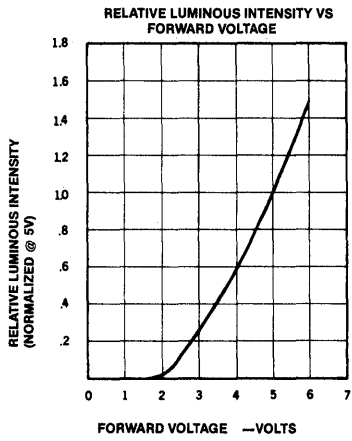
Maximum Ratings

| | |
|----------------------------|---------------------------------|
| Power Dissipation | 100 mW |
| DC Forward Voltage | 15 Volts |
| Reverse Voltage | 9.0 Volts |
| Storage Temperature | -55°C to 100°C |
| Operating Temperature | -40°C to 85°C |
| Lead Soldering Temperature | 260°C |
| | (1/16" from lens for 5 seconds) |

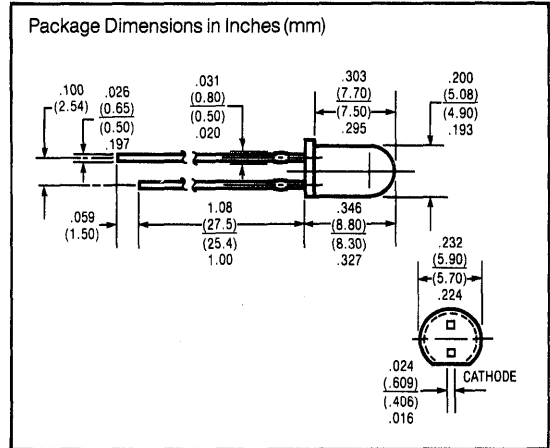
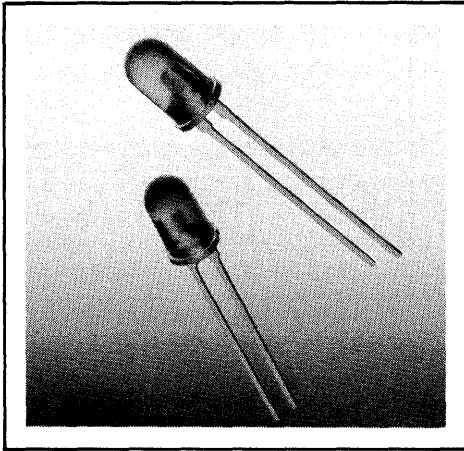
Opto-Electrical Characteristics (@ 25°C)

| Parameter | Min. | Typ. | Max. | Units | Test Conditions |
|--------------------|------|------|------|---------|-----------------------|
| Luminous Intensity | 1.0 | 2.0 | — | MCD | $V_f = 5.0 \text{ V}$ |
| Forward Current | | 10 | 15 | mA | $V_f = 5.0 \text{ V}$ |
| Reverse Current | 7.0 | | | mA | $V_R = 5 \text{ V}$ |
| Viewing Angle | | 70 | | degrees | |
| Peak Wavelength | | 650 | | nm | |

Specifications are subject to change without notice.



Preliminary



FEATURES

- **Integral Current Limiting Resistor**
- **No External Resistor Required with 5 Volt (RRL-3105) or 12 Volt Supply (RRL-3112)**
- **T1 3/4 Package**
- **Red Diffused Lens**
- **High Reliability**

DESCRIPTION

The RRL31XX is a Gallium Arsenide Phosphide LED red lamp containing an integral resistor chip in series with the LED. This allows operation from a 5 volt RRL-3105 or 12 volt RRL-3112 source without an external current limiting resistor. Applications include mounting on PC boards as diagnostic and circuit status indicators.

Maximum Ratings

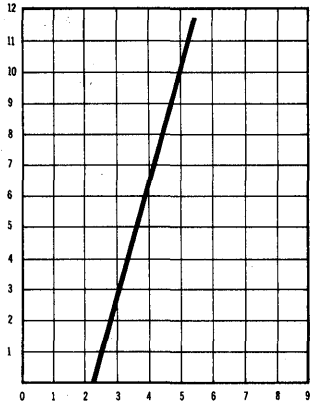
| | |
|-----------------------------------|---------------------------------|
| Power Dissipation @ 25° C Ambient | 100 mW |
| DC Forward Voltage | 15 Volts |
| Reverse Voltage | 9.0 Volts |
| Storage Temperature | -55°C to +100°C |
| Operating Temperature | -40°C to +85°C |
| Lead Solder Temperature | 260° |
| | (1/16" from lens for 5 seconds) |

Characteristics (T_{amb} = 25°C)

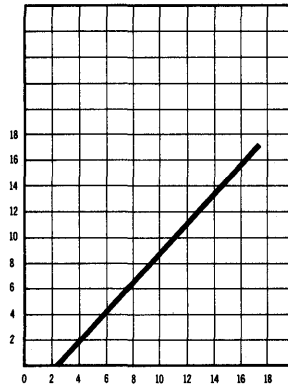
| Parameters | Min. | Typ. | Max. | Units | Test Conditions |
|--------------------------|------|------|------|---------|-----------------------|
| Dominant Wavelength peak | | 655 | | nm | |
| Viewing Angle | | 70 | | degrees | |
| Forward Current | | | | | |
| RRL-3105 | | 10 | 15 | mA | V _F = 5 V |
| RRL-3112 | | 10 | 15 | mA | V _F = 12 V |
| Reverse Current | | 0.1 | 10 | µA | 6 Volts |
| Luminous Intensity | | | | | |
| RRL-3105 | 1.0 | 2.0 | mcd | | V _F = 5 V |
| RRL-3112 | 1.0 | 2.0 | mcd | | V _F = 12 V |

Specifications are subject to change without notice.

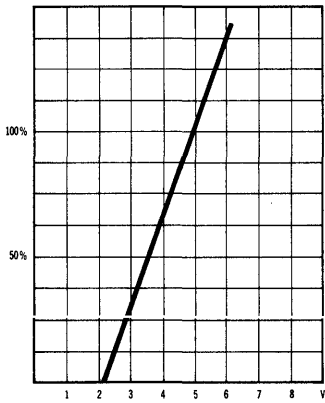
**FORWARD CURRENT
VS. FORWARD VOLTAGE
RRL-3105**



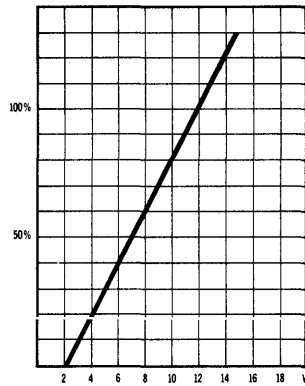
**FORWARD CURRENT
VS. FORWARD VOLTAGE
RRL-3112**



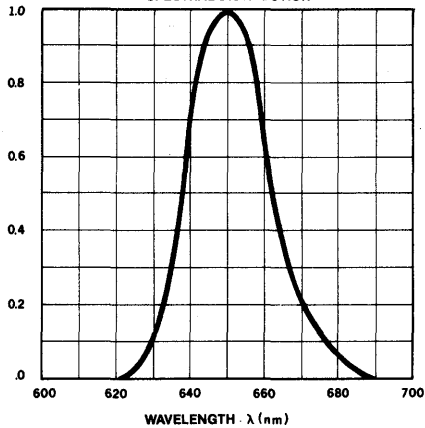
**RELATIVE LUMINOUS INTENSITY VS.
FORWARD VOLTAGE (DC)
RRL-3105**



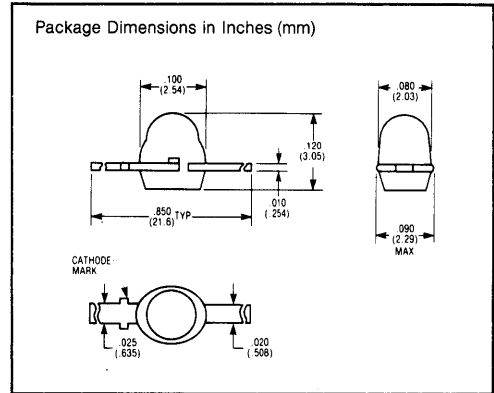
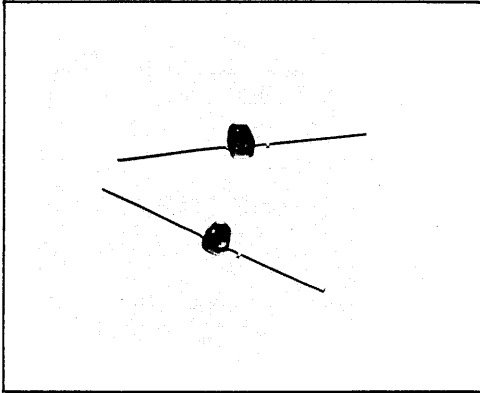
**RELATIVE LUMINOUS INTENSITY VS.
FORWARD VOLTAGE (DC)
RRL-3112**



**RRL-3105 & RRL-3112
SPECTRAL DISTRIBUTION**



RED LED RESISTOR LAMP MINIATURE AXIAL LEAD



FEATURES

- Integral current limiting resistor
- No external resistor required with 5 volt supply
- Miniature axial lead package
- Red diffused lens
- Three light intensity ranges
- High reliability

DESCRIPTION:

The RRL-56XX is a gallium arsenide phosphide LED red lamp containing an integral resistor chip in series with the LED. This allows operation from a 5 volt source without an external current limiting resistor. Applications include mounting on PC boards as diagnostic and circuit status indicators.

Maximum Ratings

| | |
|---------------------------|-----------------|
| DC Forward Voltage | 6 volts |
| Reverse Voltage | 6 volts |
| Operating Temp | -55°C to +100°C |
| Storage Temp | -40°C to +85°C |
| Soldering Time | |
| (260°C @ 1/16" from case) | 5 sec |

Specifications are subject to change without notice.

| Opto Electronic Characteristics | | | | | |
|---------------------------------|------|------|------|---------|-----------------|
| Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
| Luminous Intensity | | | | | |
| RRL 5601 | .3 | | | mcd | 5 volts |
| RRL 5621 | .6 | 1.2 | | mcd | 5 volts |
| RRL 5641 | 1.0 | 2.0 | | mcd | 5 volts |
| Forward Current | | | | | |
| RRL 5601 | 2.0 | 3.0 | 4.0 | mA | 5 volts |
| RRL 5621 | 4.0 | 6.0 | 8.0 | mA | 5 volts |
| RRL 5641 | 13.0 | 16.0 | 21.0 | mA | 5 volts |
| Reverse Current | | 0.1 | 10 | uA | 6 volts |
| Half Angle | | 20 | | degrees | |
| Peak Emission Wavelength | | 650 | | nM | |

FIG 1. FORWARD CURRENT VS FORWARD VOLTAGE

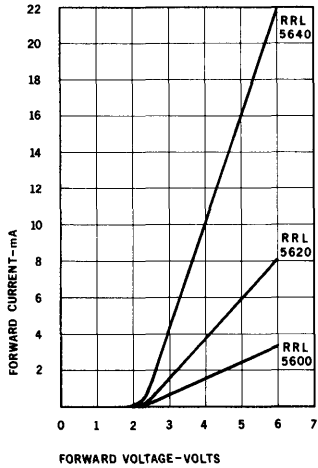


FIG 2. RELATIVE LUMINOUS INTENSITY VS FORWARD VOLTAGE

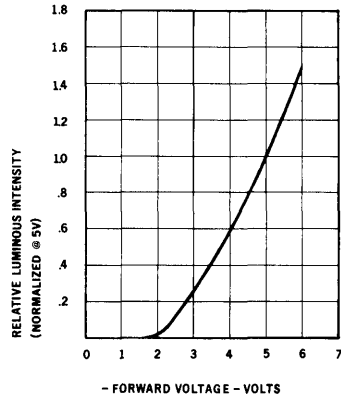
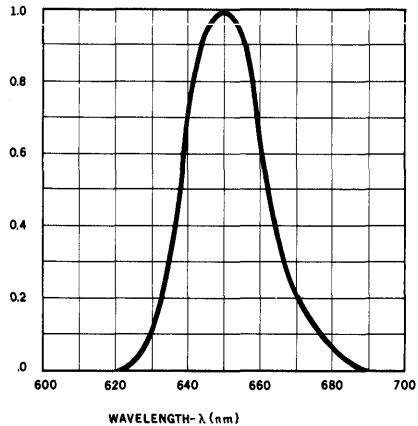
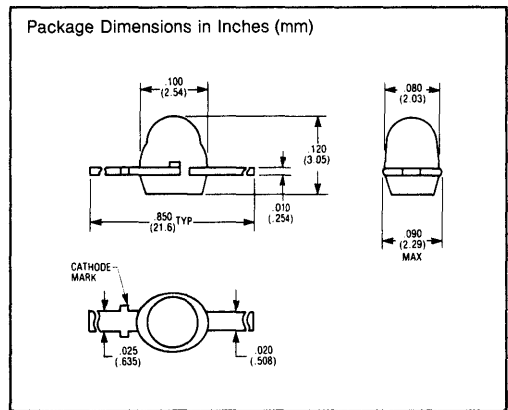
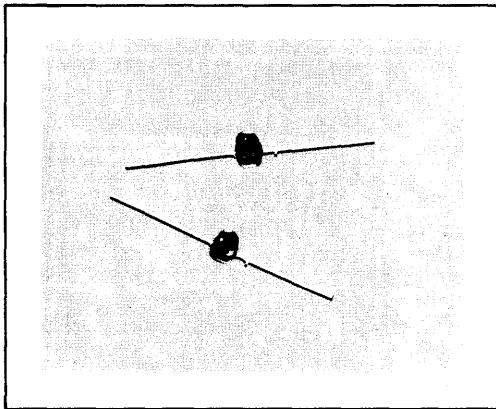


FIG 3. SPECTRAL DISTRIBUTION



MINIATURE AXIAL LEAD LED RESISTOR LAMP



FEATURES

- Integral current limiting resistor lamp (no exterior resistor required)
- Miniature axial lead package ideal for diagnostic indicator
- Operates from 5V IC Logic
- RGL-5621 green diffused lens
RYL-5621 yellow diffused lens
- High reliability

DESCRIPTION:

The RGL-5621 green and RYL-5621 yellow are gallium phosphide LED lamps containing integral resistor chips in series with the LED. This allows operation from a 5V source without an external resistor. Applications include mounting on PC boards as diagnostic and circuit status indicators.

Maximum Ratings:

DC Forward Voltage 6V
 Reverse Voltage 6V
 Operating Temperature -55°C to +100°C
 Storage Temperature -55°C to +100°C
 Lead solder time
 (260°C @ 1/16" from case) . . . 3 sec.

Opto Electronic Characteristics

| Parameters | Min. | Typ. | Max. | Unit | Test Conditions |
|---|------|------|------|---------|-----------------|
| Luminous Intensity | | | | | |
| RGL-5621 | .2 | .5 | | mcd | 5V |
| RYL-5621 | .3 | .6 | | mcd | 5V |
| Forward Current | 2.8 | 5.0 | 6.7 | mA | 5V |
| Reverse Current | | 0.1 | 10 | uA | 6V |
| Half Angle (limits for 50% of luminous intensity) | | 20 | | degrees | 5V |
| Peak Emission Wavelength | | | | | |
| RGL-5621 | | 565 | | nm | |
| RYL-5621 | | 583 | | nm | |

FIG 1 FORWARD CURRENT VS FORWARD VOLTAGE

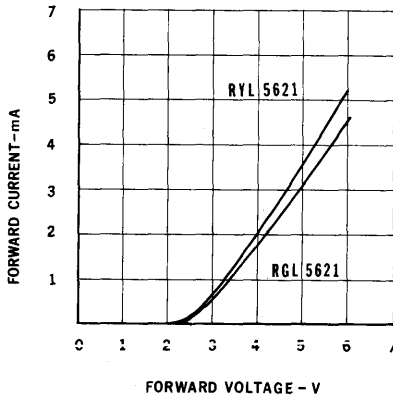


FIG 2 LUMINOUS INTENSITY VS FORWARD VOLTAGE

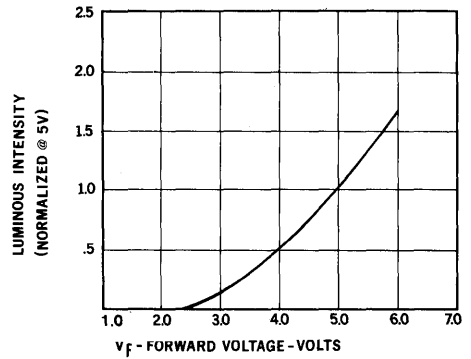
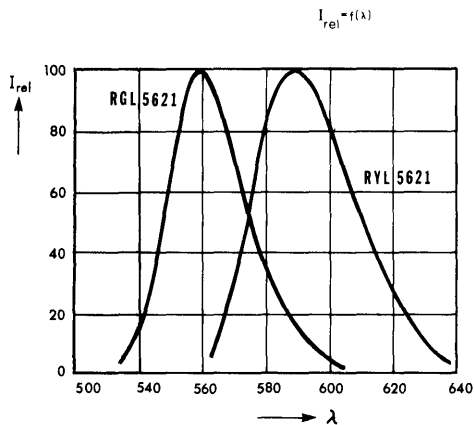
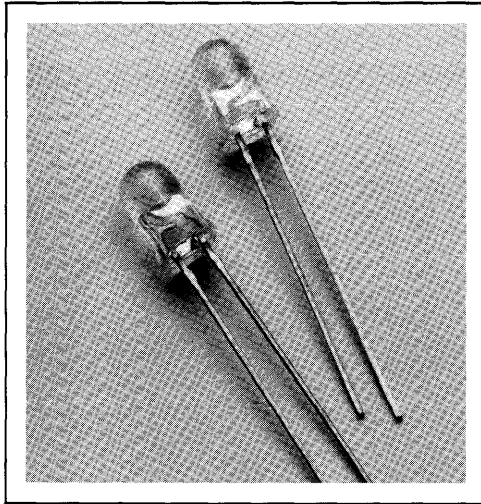


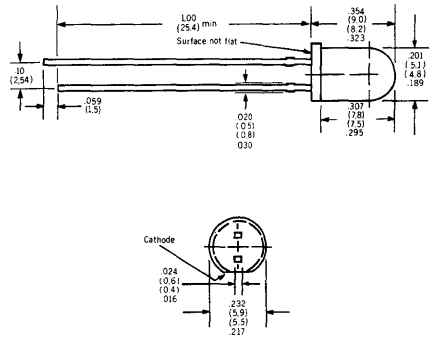
FIG 3 RELATIVE SPECTRAL EMISSION



Advance Data Sheet



Package Dimensions in Inches (mm)



FEATURES

- Pure Blue Light (480 nm)
- Clear T-1 $\frac{3}{4}$ Plastic Package
- 1" Min. Lead Length
- High Brightness
- TTL Compatible

DESCRIPTION

The SFH710 is a Silicon Carbide, Aluminum, Nitride (SiC:Al,N) LED, emitting a pure blue light from a clear T-1 $\frac{3}{4}$ plastic package. The SFH710 is suitable for measurement equipment, consumer application, and control apparatus.

Maximum Ratings

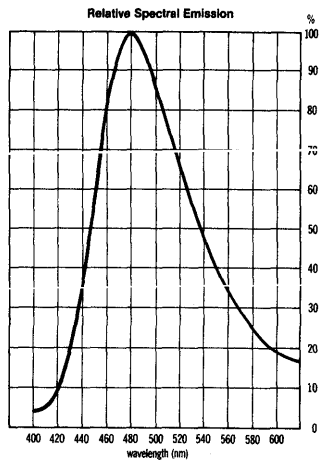
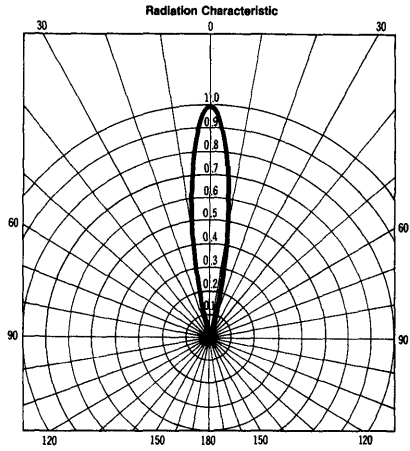
| | | | |
|---|-----------------|------------|-----|
| Reverse voltage | V_R | 1 | V |
| Forward current | I_F | 40 | mA |
| Storage temperature range | T_{stor} | -40 to +80 | °C |
| Junction temperature | T_J | 80 | °C |
| Total power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 170 | mW |
| Thermal resistance Junction to Air | $R_{thJ_{amb}}$ | 325 | K/W |

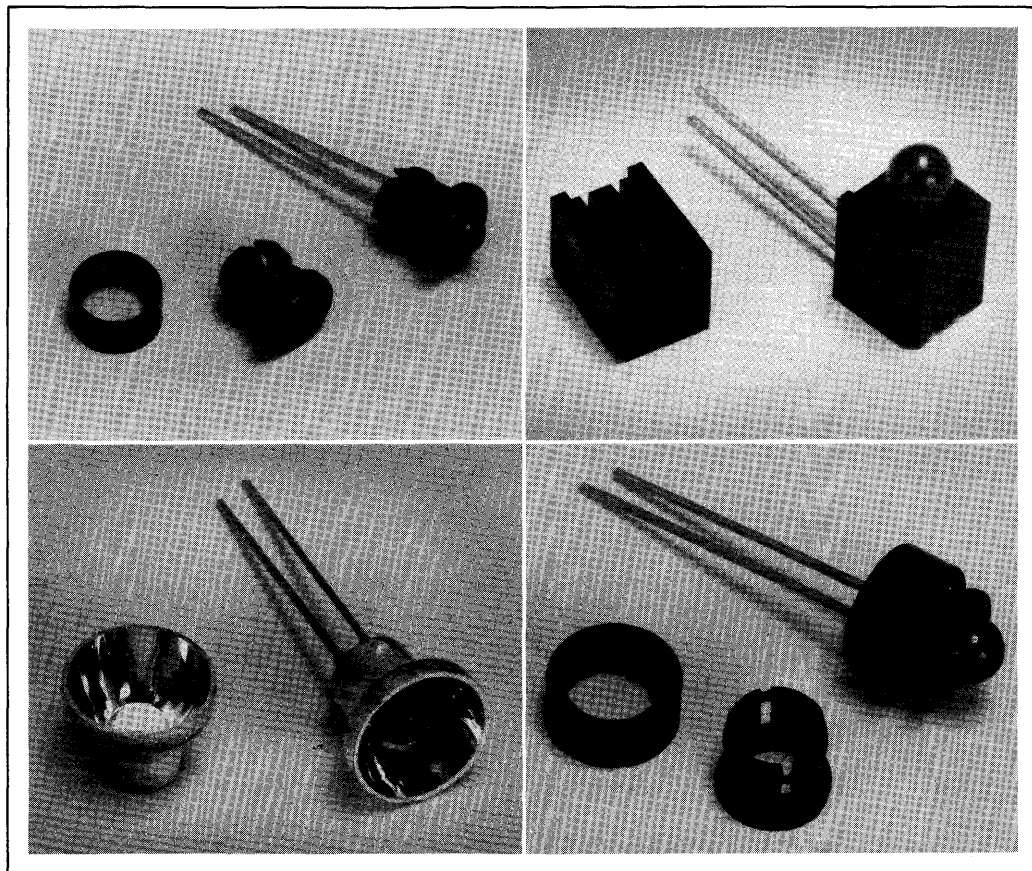
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | Min. | Typ. | Unit | Test Condition |
|--|------------------|---------------|---------|----------------|
| Wavelength at peak emission | λ_{peak} | 480 | nm | |
| Dominant wavelength | dom | 480 | nm | |
| Viewing angle | | 16 | degrees | |
| Forward voltage ($I_F = 20\text{mA}$) | V_F | 4(≤ 6) | V | |
| Reverse breakdown voltage ($I_R = 1\text{A}$) | V_R | 2(≤ 1) | V | |
| Spectral half bandwidth | | ± 45 | nm | |
| Luminous intensity | .5 | 1.6 | mc d | 20 mA |

CAUTION: Because of low reverse voltage, the LED connections may not be reversed.

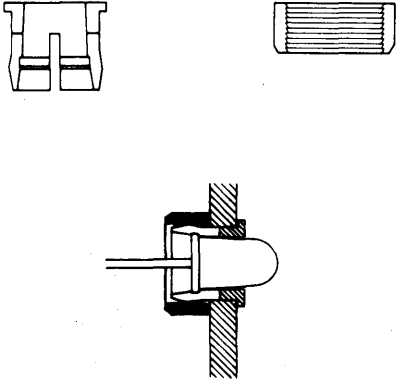
Specifications are subject to change without notice.



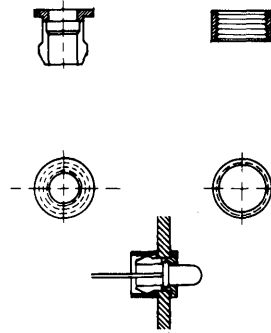


| Part Number | Description | Color |
|-------------|---|----------|
| 2004-9002 | Mounting Clip & Collar for T- $\frac{3}{4}$ LED's | Black |
| 2004-9003 | | Clear |
| 2004-9015 | Mounting Clip & Collar for T-1 LED's | Black |
| 2004-9016 | | Clear |
| 2004-9019 | Right Angle Mounting Part Designed to allow right angle mounting of lamps to PC Boards and other surfaces. | Black |
| 2004-9020 | Reflector This highly polished reflector greatly increases lighted area and enhances overall brightness of low profile and T-1 $\frac{1}{4}$ LED's | Polished |

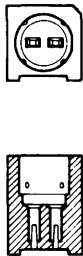
004-9002
004-9003



004-9015
004-9016

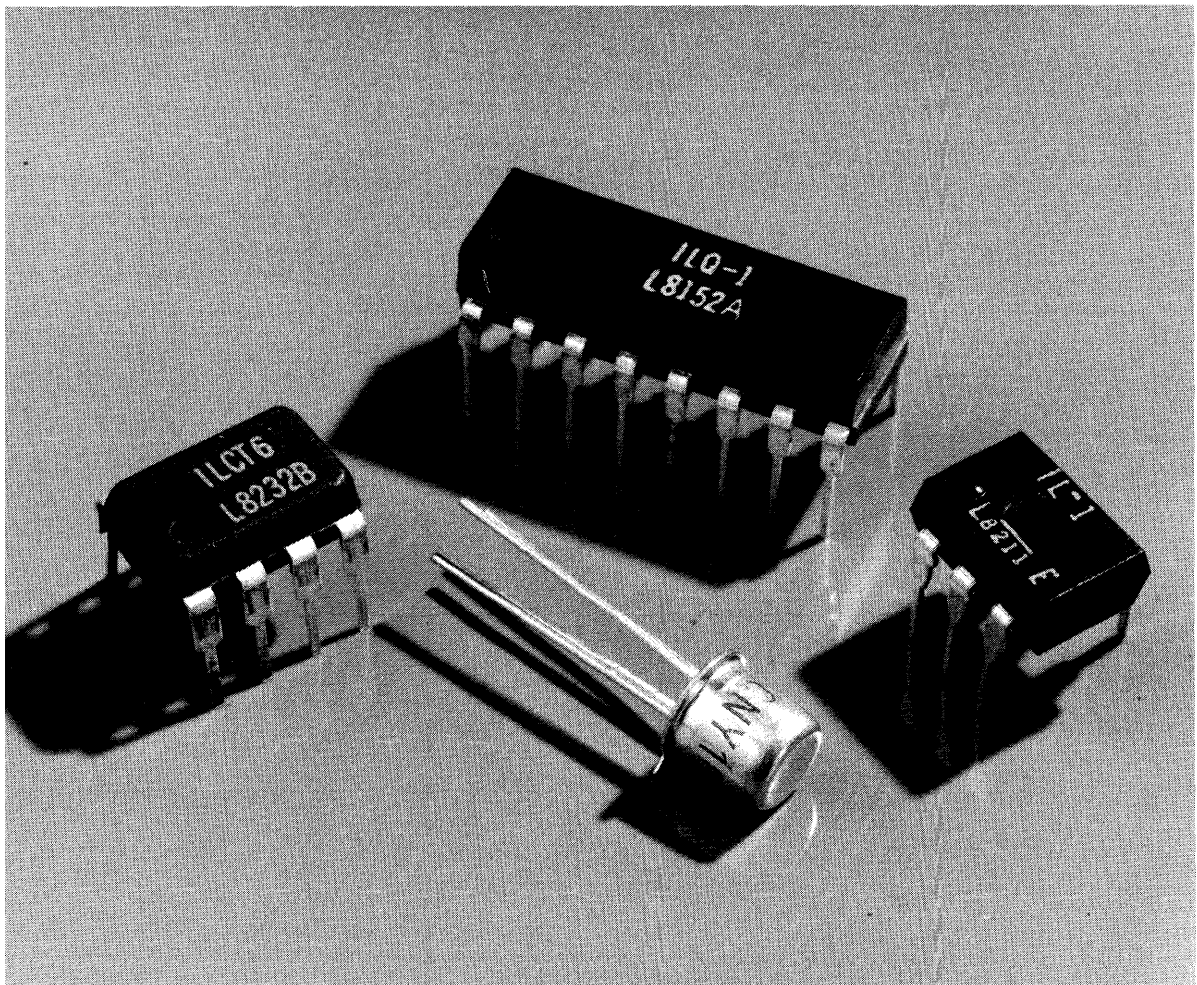


004-9019 Right Angle Mounting Part



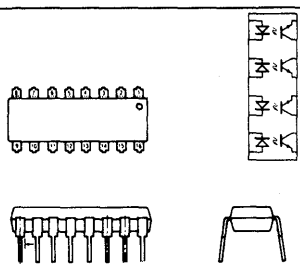
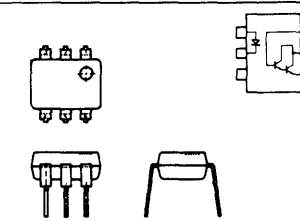
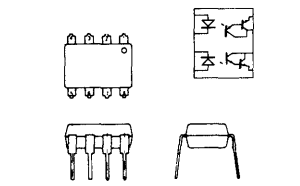
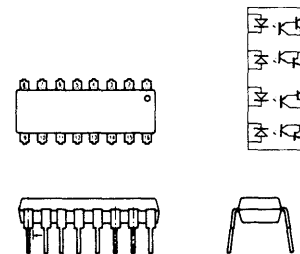
004-9020 Reflector



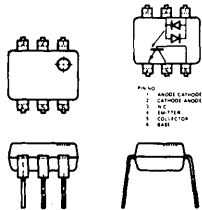
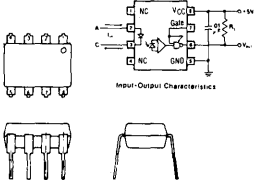
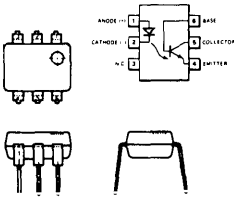
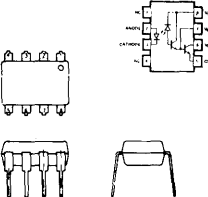


OPTO-COUPLERS

| Package and Type | Package Outline | Part Number | Features | Current Transfer Ratio (%) I _F = 10mA | Isolation Breakdown Voltage | BV _{CEO} | Page | | |
|--|---|---|--|---|-----------------------------|-------------------|----------|----|-----|
| High Reliability | | | | | | | | | |
| 6 PIN DIP Single channel Photo-transistor output | | SFH600-0 | High reliability High current transfer ratios | 40-80 | 2800 | 70 | 255 | | |
| | | SFH600-1 | | 63-125 | | | | | |
| | | SFH600-2 | | 100-200 | | | | | |
| | | SFH600-3 | | 160-320 | | | | | |
| | | SFH601-1 | Very high reliability High current transfer ratios Pre-conditioned VDE approved #0883 | 40-80 | 5300 | 259 | | | |
| | | SFH601-2 | | 63-125 | | | | | |
| | | SFH601-3 | | 100-200 | | | | | |
| | | SFH601-4 | | 160-320 | | | | | |
| | | SFH609-1 | Very high reliability High current transfer ratios High BV _{CEO} VDE approved #0883 | 40-80 | 5300 | 90 | 263 | | |
| | | SFH609-2 | | 63-125 | | | | | |
| SFH609-3 | 100-200 | | | | | | | | |
| CNY17-1 | High reliability High current transfer ratios | 40-80 | | 4400 | | | | 70 | 212 |
| CNY17-2 | | 63-125 | | | | | | | |
| CNY17-3 | | 100-200 | | | | | | | |
| CNY17-4 | | 160-320 | | | | | | | |
| Miniature 4 Lead DIP Single channel Photo-transistor output | | SFH610-1 | Miniature size, High Reliability High Current transfer ratios | 40-80 | 2800 | 70 | 267 | | |
| | | SFH610-2 | | 63-125 | | | | | |
| | | SFH610-3 | | 100-200 | | | | | |
| | | SFH610-4 | | 160-320 | | | | | |
| | | SFH611-1 | Miniature size, High Reliability High Current transfer ratios | 40-80 | 2800 | 70 | 267 | | |
| | | SFH611-2 | | 63-125 | | | | | |
| | | SFH611-3 | | 100-200 | | | | | |
| | | SFH611-4 | | 160-320 | | | | | |
| | | TO-72 Metal Case Single channel Photo-transistor output | <p style="text-align: center;">C connected to case</p> | CNY18-2 | Hermetic seal | 16-32 | 500 | 32 | 216 |
| | | | | CNY18-3 | | 25-50 | | | |
| CNY18-4 | 40-80 | | | | | | | | |
| CNY18-5 | 63-125 | | | | | | | | |
| | | | | | | | | | |
| General Purpose, Single Channel | | | | | | | | | |
| 6 PIN DIP Single channel Photo-transistor output | | IL-1B | Low cost | 20 Min. | 6000 | 30 | 218 | | |
| | | IL-5B | | 50 Min. | | | | | |
| | | IL-74B | | 12.5 Min. | | | | | |
| | | 4N25 | Low cost Industry standard | 20 Min. | 30 | 206 | | | |
| | | 4N26 | | 10 Min. | | | | | |
| | | 4N27 | | | | | | | |
| | | 4N28 | | | | | | | |
| | | 4N35 | | | | | 100 Min. | | |
| | | 4N36 | | | | | | | |
| | | 4N37 | 209 | | | | | | |
| General Purpose, Multi Channel | | | | | | | | | |
| 8 PIN DIP Two channel Photo-transistor output | <p style="text-align: center;">LED CHIPS ON PINS 2 AND 3 PT CHIPS ON PINS 5 AND 7</p> | ILCT-6 | Dual coupler | 20 Min. | 6000 | 30 | 249 | | |
| | | ILD-1 | | 20 Min. | | | | | |
| | | ILD-2 | | 12.50 Min. | | | | | |
| | | ILD-74A | | 100 Min. | | | | | |
| | | ILD-506 | | 20 Min. | | | | | |
| | | | | 252 | | | | | |

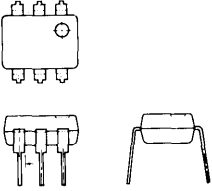
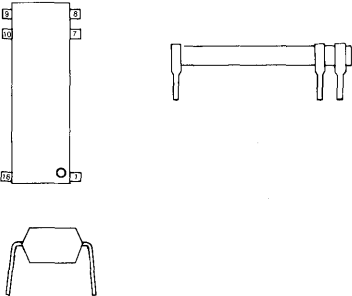
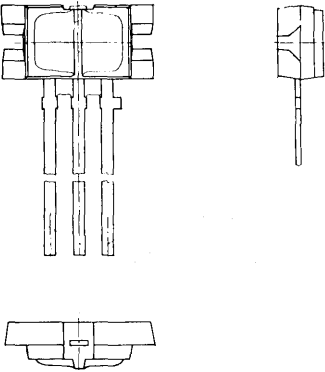
| Package and Type | Package Outline | Part Number | Features | Current Transfer Ratio (%) $I_F = 10\text{mA}$ | Isolation Breakdown Voltage | BVCEO | Page |
|---|---|----------------------------------|---------------------------|---|-----------------------------|-------|------|
| General Purpose, Multi Channel (cont.) | | | | | | | |
| 16 PIN DIP Four channel Photo-transistor output |  | ILQ-1 | Quad coupler | 20 | 6000 | 30 | 218 |
| | | ILQ-2 | | 100 | | 30 | 222 |
| | | ILQ-74A | | 12.5 | | 20 | 230 |
| Special, Photodarlington, Single Channel | | | | | | | |
| 6 PIN DIP Single channel Photo-darlington output |  | IL-30 (formerly ILCA-2-30) | High gain | 100 Min. | 6000 | 30 | 228 |
| | | IL-55 (formerly ILCA-2-55) | | 100 Min. | | 55 | |
| | | 4N32 | | 500 Min. | | 30 | 208 |
| | | 4N33 | | 500 Min. | | | |
| | | | | | | | |
| Special, Photodarlington, Multi Channel | | | | | | | |
| 8 PIN DIP Two Channel Photo-darlington output |  | ILD-30 | High gain Dual coupler | 100 Min. | 6000 | 30 | 234 |
| | | ILD-55 | | | | 55 | |
| 16 PIN DIP Four Channel Photo-darlington output |  | ILQ-30 | High gain Quad coupler | 100 Min. | 6000 | 30 | 234 |
| | | ILQ-55 | | | | 55 | |

All couplers are Underwriters Lab approved #E52744

| Package and Type | Package Outline | Part Number | Features | Current Transfer Ratio (%) $I_F = 10\text{mA}$ | Isolation Breakdown Voltage | BV_{CEO} | Page |
|--|---|---------------------|---|---|-----------------------------|------------|------|
| Special, Twin IR Emitter | | | | | | | |
| 6 PIN DIP Bidirectional INPUT |  | IL-250 | AC/DC Bidirectional input | 50 Min. | 1500 | 30 | 243 |
| | | IL-251/ (H11AA1) | | 20 Min. | 5000 | | 245 |
| Special, High Speed | | | | | | | |
| 8 PIN DIP Single channel |  | IL-100 | High speed | 65 Typ. | 2500 | 5 | 236 |
| | | IL-101 | | 100 Typ. | 1500 | 5 | 240 |
| Special, Low Input Current (C-MOS type) | | | | | | | |
| 6 PIN DIP Single channel |  | IL-201 | Low input forward current | 10 Min. | 6000 | 1 | 242 |
| | | IL-202 | | 30 Min. | | | |
| | | IL-203 | | 50 Min. | | | |
| 8 PIN DIP Single channel |  | 6N138 | High gain Low input forward current | 300 Min. | 6000 | 1.6 | 210 |
| | | 6N139 | | Low saturation voltage | | 400 Min. | |

All couplers are Underwriters Lab approved #E52744

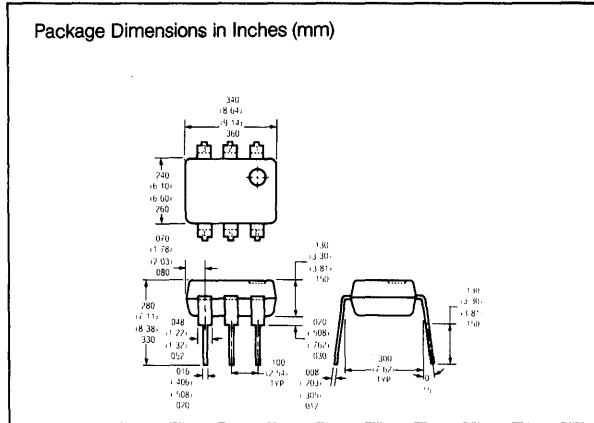
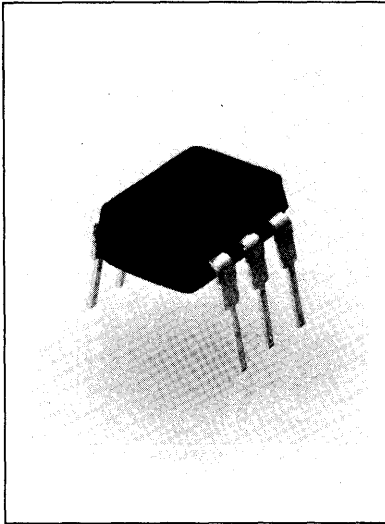
Package dimensions are in inches (mm)

| Package and Type | Package Outline | Part Number | Features | Current Transfer Ratio (%) IF = 10mA | Isolation Breakdown Voltage | BVCEO | Page |
|---|--|-------------|---|---|-----------------------------|-------------------------------|------|
| Special, SCR | | | | | | | |
| 6 PIN DIP Single channel SCR output |  | IL-400 | Optically Coupled SCR UL approved #E52744 | Gate trigger Current 20uA | 6000 | Fwd. blocking voltage Vdm 400 | 247 |
| Special, High Voltage | | | | | | | |
| 4 & 6 PIN DIP Single channel |  | IL-8 | Very high voltage VDE #0730-2P applied for (4 PIN) | 20 Min. | | | 226 |
| | | IL-9 | Very high voltage VDE #0730-2P applied for (4 PIN) | 20 Min. | | | |
| | | IL-10 | Very high voltage VDE #0730-2P applied for (4 PIN) | 50 Min. | 8 KVRMS (1 min.) | 30 | |
| | | IL-11 | Very high voltage VDE #0730-2P applied for (6 PIN) All UL approved #E52744 | 50 Min. | | | 227 |
| Special, Reflective Sensor | | | | | | | |
| Miniature side by side emitter detector pair Plastic package |  | SFH900 | | Coupling factor $\left(\begin{array}{l} I_F = 10 \text{ mA} \\ V_{CE} = 5V \\ d = 1 \text{ mm} \\ I_{CE} \geq 0.5 \text{ mA} \end{array} \right)$ 5.6 mm leads | | | |
| | | SFH900-1 | Reflective interrupter High sensitivity Designed for short distances up to 5 mm | $I_{CE} \geq 0.3 \text{ mA}$ 14.3 mm leads | | Power dissipation 150mW | 271 |
| | | SFH900-2 | | $I_{CE} \geq 0.5 \text{ mA}$ | | | |

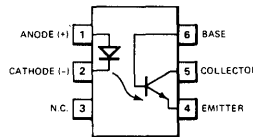
SIEMENS

4N25, 4N26, 4N27, 4N28

PHOTOTRANSISTOR OPTO-ISOLATORS



CONNECTION DIAGRAM DIP (TOP VIEW)



PIN NUMBERS

- | | | |
|---|-------------|------------------------------|
| 1 | Anode (+) | } Input Diode |
| 2 | Cathode (-) | |
| 3 | NC | } Output npn Phototransistor |
| 4 | Emitter | |
| 5 | Collector | |
| 6 | Base | |

FEATURES

- 6000 Volt Isolation Voltage
- High DC Current Transfer Ratio
- I/O Compatible with Integrated Circuits
- 0.5pF Coupling Capacitance
- Underwriter Lab Approval #E52744

DESCRIPTION

The 4N25, 4N26, 4N27, and 4N28 series are optically coupled pairs, each consisting of a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. They can be used to replace relays and transformers in many digital interface applications. They have excellent frequency response when used in analog applications.

Absolute Maximum Ratings:

Gallium Arsenide LED:

- *Power Dissipation @ 25°C 150mW
- *Derate Linearly from 25°C 2.0 mW/°C
- *Continuous Forward Current 80mA
- *Forward Current Peak (1μs pulse, 300 pps) 3.0 A
- *Peak Inverse Voltage 3.0V

Detector (Silicon Photo-Transistor)

- *Power Dissipation @ 25°C 150mW
- *Derate Linearly from 25°C 2.0mW/°C
- *Collector-Emitter Breakdown Voltage (BV_{CEO}) 30V
- *Emitter-Collector Breakdown Voltage (BV_{ECO}) 7.0 V
- *Collector-Base Breakdown Voltage . . (BV_{CBO}) 70V

Package

- *Total Package Dissipation @ 25°C Ambient (equal power in each element) 250mW
- *Derate Linearly from 25°C 3.3mW/°C
- *Storage Temperature -55°C to +150°C
- *Operating Temperature -55°C to +100°C
- *Lead Soldering Time @ 260°C 10 sec.

* indicates JEDEC registered values

Specifications subject to change without notice.

ELECTRICAL CHARACTERISTICS

PARAMETERS (at 25° Ambient)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|--|------|-----|-----|------------------|----------------------|
| Gallium Arsenide LED | | | | | |
| * Forward Voltage | | 1.3 | 1.5 | V | $I_F=50\text{mA}$ |
| * Reverse Current | | 0.1 | 100 | μA | $V_R=3.0\text{V}$ |
| Capacitance | | 100 | | pF | $V_R=0$ |
| Photo-transistor Detector | | | | | |
| HFE | | 150 | | | $V_{CE}=5.0\text{V}$ |
| * V_{CE0} | 30 | | | V | $I_C=1\text{mA}$ |
| * V_{ECO} | 7 | | | V | $I_E=100\mu\text{A}$ |
| * V_{CBO} | 70 | | | V | $I_C=100\mu\text{A}$ |
| * I_{CEO} (dark) 4N25, | | | | nA | $V_{CE}=10\text{V}$ |
| 4N26, 4N27 | | 5 | 50 | nA | (base open) |
| 4N28 | | 10 | 100 | nA | $V_{CB}=10\text{V}$ |
| * I_{CBO} (dark) | | 2 | 20 | nA | (emitter open) |
| Collector-Emitter Capacitance | | 2 | | pF | $V_{CE}=0$ |
| Coupled Characteristics | | | | | |
| * DC Current Transfer Ratio | | | | | |
| 4N25, | | | | | $I_F=10\text{mA}$ |
| 4N26 | 0.2 | 0.5 | | | $V_{CE}=10\text{V}$ |
| 4N27, 4N28 | 0.1 | 0.3 | | | $I_F=10\text{mA}$ |
| | | | | | $V_{CE}=10\text{V}$ |
| Capacitance, Input to Output | | 0.5 | | pF | |
| Breakdown Voltage | | | | | |
| * 4N25 | 2500 | | | V | Peak, 60 Hz |
| * 4N26, 4N27 | 1500 | | | V | Peak, 60 Hz |
| * 4N28 | 500 | | | V | Peak, 60 Hz |
| * All types | 7500 | | | VDC | |
| * Resistance, Input to Output | 100 | | | $\text{G}\Omega$ | |
| Rise and Fall Times | | 2 | | μs | $I_F=10\text{mA}$ |
| | | | | | $V_{CE}=10\text{V}$ |
| * Collector-Emitter Saturation Voltage | | | 0.5 | V | $I_F=50\text{mA}$ |
| | | | | | $I_C=2.0\text{mA}$ |

* indicates JEDEC registered values

TYPICAL CURVES

FIGURE 1. RELATIVE OUTPUT VS TEMPERATURE

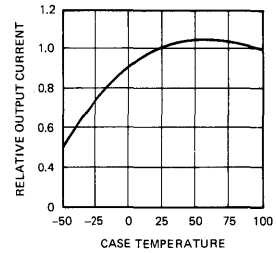


FIGURE 2. DARK CURRENT VS TEMPERATURE

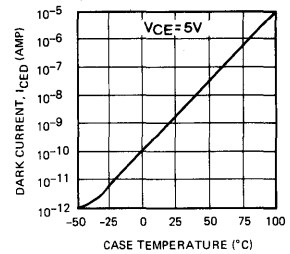


FIGURE 3. TRANSFER CHARACTERISTICS

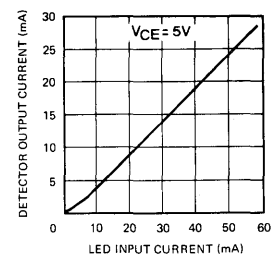
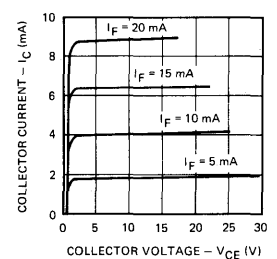


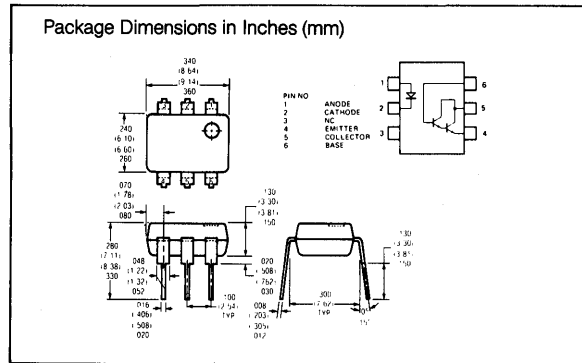
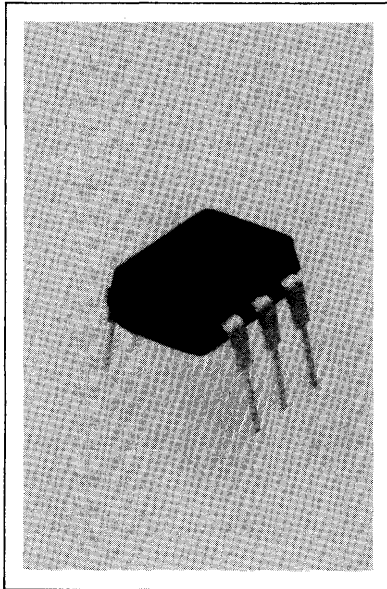
FIGURE 4. DETECTOR OUTPUT CHARACTERISTICS



SIEMENS

4N32, 4N33

PHOTO DARLINGTON OPTO-ISOLATOR



Maximum Ratings: (At 25°C)

| | |
|---|-----------------|
| Gallium Arsenide LED (Drive Circuit) | |
| Power Dissipation at 25°C | 150 mW |
| Derate Linearly From 55°C | 2 mW/°C |
| Continuous Forward Current | 80 mA |
| Peak Reverse Voltage | 3 V |
| Photodarlington Sensor (Load Circuit) | |
| Power Dissipation at 25°C Ambient | 150 mW |
| Derate Linearly From 25°C | 2.0 mW/°C |
| Collector (load) Current | 125 mA |
| Collector-Emitter Breakdown Voltage (BV _{CEO}) | 30 V |
| Collector-Base Breakdown Voltage (BV _{CBO}) | 50 V |
| Emitter-Base Breakdown Voltage (BV _{EBO}) | 8 V |
| Emitter-Collector Breakdown Voltage (BV _{ECCO}) | 5 V |
| Package | |
| Total Dissipation at 25°C | 250 mW |
| Derate Linearly From 25°C | 3.3 mW/°C |
| Storage Temperature* | -55°C to +150°C |
| Operating Temperature | -55°C to +100°C |
| Lead Soldering Time at 260°C | 10 sec |

FEATURES

- 6000 Volt Isolation Voltage
- Very High Current Transfer Ratio (500% Min.)
- High Isolation Resistance (10¹¹ Ω Typical)
- Low Coupling Capacitance
- Standard Plastic Dip Package
- Underwriters Lab Approval #E52744

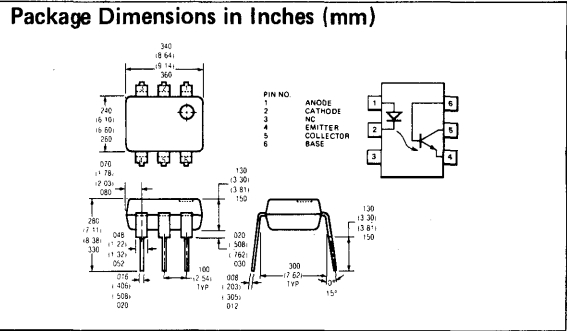
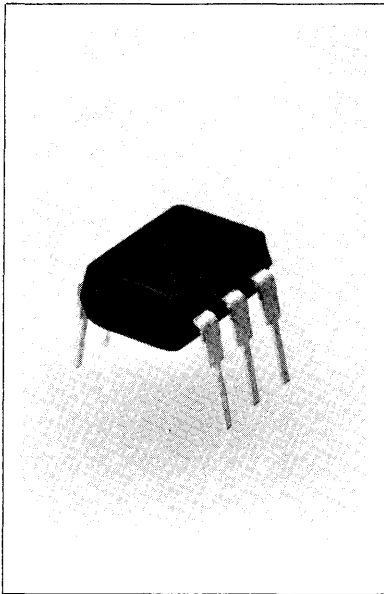
DESCRIPTION

The 4N32 and 4N33 are optically coupled isolators employing a gallium arsenide infrared emitter and a silicon photo darlington sensor. Switching can be accomplished while maintaining a high degree of isolation between driving and load circuits. They can be used to replace reed and mercury relays with advantages of long life, high speed switching and elimination of magnetic fields.

Electrical Characteristics (T_{amb} = 25°C)

| Parameter | Min | Typ | Max | Unit | Condition |
|--------------------------------|------------------|-----|-----|------|---|
| GaAs Emitter | | | | | |
| Forward Voltage* | 1.25 | 1.5 | | V | I _F = 50 mA |
| Reverse Current* | 0.01 | 100 | | μA | V _R = 3.0 V |
| Capacitance | 100 | | | pF | V _R = 0 |
| Sensor | | | | | |
| H _{FE} | | 13K | | | V _{CE} = 5 V I _C = 0.5mA I _E = 100μA I _F = 0 |
| BV _{CEO} * | 30 | | | V | I _C = 100μA I _E = 0 |
| BV _{CBO} * | 50 | | | V | I _C = 100μA I _E = 0 |
| BV _{EBO} * | 8 | | | V | I _C = 100μA I _E = 0 |
| BV _{ECCO} * | 5 | | | V | I _E = 100μA V _{CE} = 10 V I _F = 0 |
| I _{CEO} * | 1.0 | 100 | | nA | |
| Coupled Characteristics | | | | | |
| Current Transfer Ratio* | 500 | | | % | I _F = 10mA V _{CE} = 10 V I _C = 2 mA I _F = 8 mA |
| V _{CE(SAT)} | | 1.0 | | V | I _F = 8 mA V _{IO} = 500 V |
| Isolation Resistance* | 10 ¹¹ | | | ohm | |
| Isolation Capacitance | 1.5 | | | pf | |
| Turn-on Time | | 5 | | μs | V _{CC} = 10 V I _C = 50 mA I _F = 200 mA |
| Turn-off Time | | 100 | | μs | R _L = 180 Ω Pulse Width = 8ms |
| Isolation Voltage | 2500 | | | V | |
| 4N32* | 1500 | | | V | Peak, 60 Hz |
| 4N33* | 6000 | | | V | Peak, 60 Hz |
| 4N32 & 4N33 | 7500 | | | VDC | |

*Indicates JEDEC Registered Data



Maximum Ratings:

| | |
|--|---------------|
| Gallium Arsenide LED | |
| Power Dissipation @ 25°C | 100 mW |
| Derate Linearly from 25°C | 1.33 mW/°C |
| Continuous Forward Current | 60 mA |
| Peak Inverse Voltage | 6.0 V |
| Detector (Silicon Phototransistor) | |
| Power Dissipation @ 25°C | 300 mW |
| Derate Linearly from 25°C | 4.0 mW/°C |
| Collector-Emitter Breakdown Voltage (BV _{CEO}) | 30 V |
| Emitter-Collector Breakdown Voltage (BV _{ECO}) | 7 V |
| Collector-Base Breakdown Voltage (BV _{CBO}) | 70 V |
| Package | |
| Storage Temperature* | -55 to +150°C |
| Operating Temperature* | -55 to +100°C |
| Lead Soldering Time @ 260°C* | 10 sec |
| Relative Humidity @ 85°C* | 85% |

FEATURES

- 6000 Volt Isolation Voltage
- High Current-Transfer-Ratio (100% Min)
- Industry Standard Dual-In-Line
- 0.5 pF Coupling Capacitance
- Underwriters Lab Approval #E52744

DESCRIPTION

4N35, 4N36, 4N37 are optically coupled pairs employing a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The 4N35, 4N36, 4N37 can be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

Electrical Characteristics (at 25°C Ambient)

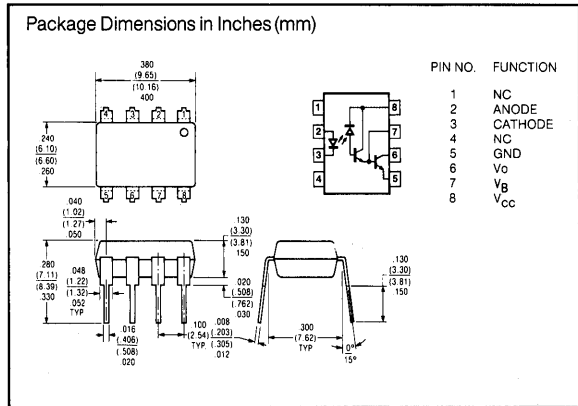
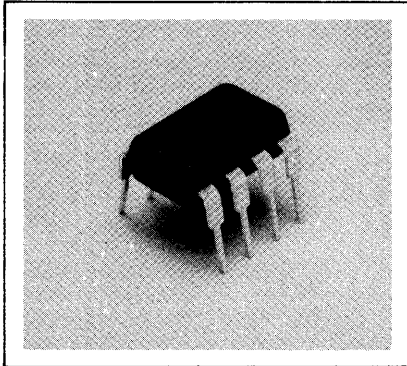
| Parameter | Min | Typ | Max | Unit | Test Condition |
|---|------|------------------|-----|------|---|
| Gallium Arsenide LED | | | | | |
| Forward Voltage* | 0.9 | 1.3 | 1.5 | V | I _F = 10 mA |
| | | | 1.7 | V | I _F = 10 mA T _A = -55°C |
| | 0.7 | | 1.4 | V | I _F = 10 mA T _A = 100°C |
| Reverse Current* | | .1 | 10 | μA | V _R = 6.0 V |
| Capacitance | | | 100 | pF | V _R = 0 f = 1 MHz |
| Phototransistor Detector | | | | | |
| HFE | 100 | 150 | | | V _{CE} = 5.0 V I _C = 100 μA |
| BV _{CEO} * | 30 | | | V | I _C = 1 mA |
| BV _{ECO} * | 7 | | | V | I _E = 100 μA |
| I _{CEO} (dark) | | 5 | 50 | nA | V _{CE} = 10 V, I _F = 0 |
| I _{CEO} (dark)* | | | 500 | μA | V _{CE} = 30 V, I _F = 0 T _A = 100°C |
| BV _{CBO} * | 70 | | | V | I _C = 100 μA |
| Collector-Emitter Capacitance | | 2 | | pF | V _{CE} = 0 |
| Coupled Characteristics | | | | | |
| DC Current Transfer | | | | | |
| Ratio* | 100 | | | % | I _F = 10 mA T _A = 25°C V _{CE} = 10 V |
| DC Current Transfer | | | | | |
| Ratio* | 40 | | | % | I _F = 10 mA V _{CE} = 10 V T _A = 55° to 100°C |
| Capacitance, Input to Output* | | | 2.5 | pF | f = 1.0 MHz |
| Resistance, Input to Output* | | 10 ¹¹ | | Ω | V _{IO} = 500 V I _C = 2 mA |
| T _{on} , T _{off} * | | | 10 | μs | R _E = 100Ω V _{CC} = 10 V |
| Collector-Emitter Saturation Voltage V _{CE(sat)} * | | | 0.3 | V | I _F = 10 mA I _C = 0.5 mA |
| Input to Output Isolation | | | | | |
| Current (Pulse Width = 8 m. sec)* | | | | | |
| 4N35 | | | 100 | μA | V _{IO} = 2500 VRMS |
| 4N36 | | | 100 | μA | V _{IO} = 1750 VRMS |
| 4N37 | | | 100 | μA | V _{IO} = 1050 VRMS |
| Isolation Voltage | 7500 | | | VDC | |

*Indicates JEDEC Registered Data
Specifications subject to change without notice.

SIEMENS

6N138 6N139

LOW INPUT CURRENT, HIGH GAIN OPTOISOLATORS Advance Data Sheet



FEATURES

- 6000 Volt Isolation Voltage
- High Current Transfer Ratio 800%
- Low Input Current Requirement - 0.5mA
- TTL Compatible Output - 0.1V V_{OL}
- High Common Mode Rejection - 500V/μsec.
- High Output Current - 60mA
- DC to 1 Megabit / Sec. Operation
- Adjustable Bandwidth - Access to Base
- Standard Molded Dip Plastic Package
- UL Approval # E52744

DESCRIPTION

High common mode transient immunity and very high current transfer ratio together with 6000 volts DC insulation are achieved by coupling an LED with an integrated high gain photon detector in an 8 pin dual inline package. Separate pins for the photodiode and output stage enable TTL compatible saturation voltages with high speed operation. Photo Darlington operation is achieved by tying the V_{CC} and V_o terminals together. Access to the base terminal allows adjustment to the gain bandwidth.

The 6N138 is ideal for TTL applications since the 300% minimum current transfer ratio with an LED current of 1.6mA enables operation with 1 unit load in and 1 unit load out with a 2.2K Ω pull-up resistor.

The 6N139 is best suited for low power logic applications involving CMOS and low power

APPLICATIONS

- Logic ground isolation - TTL/TTL, TTL/CMOS, CMOS/CMOS, CMOS/TTL
- EIA RS 232C Line Receiver
- Low Input Current Line Receiver - Long Lines, Party Lines
- Telephone Ring Detector
- 117 VAC Line Voltage Status Indication-Low Input Power Dissipation
- Low Power Systems - Ground Isolation

Maximum Ratings

| | |
|---|--------------------|
| Maximum Temperatures | |
| Storage Temperatures | - 55 ° to + 125 °C |
| Operating Temperatures | 0 °C to + 70 °C |
| Lead Temperature (soldering, 10 sec.) | 260 °C |
| Average Input Current (I _F) | 20mA |
| Peak Input Current (I _F) | |
| (50% Duty Cycle - 1ms pulse width) | 40mA |
| Reverse Input Voltage (V _R) | 5v |
| Input Power Dissipation | 35mW |
| (Derate linearly above 50% in free air temperature at 0.7mW/°C) | |
| Output Current - I _O (Pin 6) | 60mA |
| (Derate linearly above 25 °C in free air temperature at 0.7mA/°C) | |
| Emitter-Base Reverse Voltage (Pin 5-7) | 0.5V |
| Supply and Outage Voltage - V _{CC} (Pin 8-5), V _o (Pin 6-5) | |
| 6N138 | - 0.5 to 7V |
| 6N139 | - 0.5 to 18V |
| Output Power Dissipation | 100mW |
| (Derate Linearly Above 25 °C in Free Air Temperature at 2.0mW/°C) | |

Caution:

Due to the small geometries of this device it should be handled with Electrostatic Discharge (ESD) precautions. Proper grounding would further prevent damage and/or degradation which may be induced by ESD.

Electro-Optical Characteristics (T_A = 0°C to 70°C, Unless Otherwise Specified)

| Parameter | Device | Min | Typ | Max | Units | Test Conditions | Note |
|---|--------|------------|------------------|-----|-------|--|------|
| Current Transfer Ratio (CTR) | 6N139 | 400 500 | 800 900 | | % | I _F = 0.5mA, V _O = 0.4V, V _{CC} = 4.5V I _F = 1.6mA, V _O = 0.4V, V _{CC} = 4.5V | 5,6 |
| | 6N138 | 300 | 600 | | % | I _F = 1.6mA, V _O = 0.4V, V _{CC} = 4.5V | |
| Logic Low Output Voltage (VOL) | 6N139 | | 0.1 | 0.4 | V | I _F = 1.6mA, I _O = 6.4mA, V _{CC} = 4.5V | 6 |
| | 6N139 | | 0.1 | 0.4 | | I _F = 5mA, I _O = 15mA, V _{CC} = 4.5V | |
| | 6N139 | | 0.2 | 0.4 | | I _F = 12mA, I _O = 24mA, V _{CC} = 4.5V | |
| | 6N138 | | 0.1 | 0.4 | V | I _F = 1.6mA, I _O = 4.8mA, V _{CC} = 4.5V | 6 |
| Logic High Output Current (I _{OH}) | 6N139 | | 0.05 | 100 | μA | I _F = 0mA, V _O = V _{CC} = 18V | 6 |
| Output Current (I _{OH}) | 6N138 | | 0.1 | 250 | μA | I _F = 0mA, V _O = V _{CC} = 7V | |
| Logic Low Supply Current (ICCL) | | | | 0.2 | mA | I _F = 1.6mA, V _O = OPEN, V _{CC} = 5v | 6 |
| Logic High Supply Current (ICCH) | | | | 10 | mA | I _F = 0mA, V _O = OPEN, V _{CC} = 5v | 6 |
| Input Forward Voltage (VF) | | | 1.4 | 1.7 | V | I _F = 1.6mA, T _A = 25°C | |
| Input Reverse Breakdown Voltage (BVR) | | 5 | | | V | I _R = 10μA, T _A = 25°C | |
| Temperature Coefficient of Forward Voltage | | | -1.8 | | mV/°C | I _F = 1.6mA | |
| Input Capacitance (C _{IN}) | | | 60 | | pF | f = 1MHz, V _F = 0 | |
| Input-Output Insulation Leakage Current (I _{1,0}) | | | | 1.0 | μA | 45% Relative Humidity, T _A = 25°C t = 5s, V _{1,0} = 3000VDC | 7 |
| Resistance Input-Output (R _{1,0}) | | | 10 ¹² | | Ω | V _{1,0} = 500VDC | 7 |
| Capacitance (Input-Output) (C _{1,0}) | | | 0.6 | | pF | f = 1MHz | 7 |

Switching Specifications (T_A = 25°C)

| Parameter | Device | Min | Typ | Max | Units | Test Conditions | Note |
|--|--------|-----|----------|---------|-------|--|------|
| Propagation Delay Time | 6N139 | — | 5 0.2 | 25 1 | μs | I _F = 0.5mA, R _L = 4.7kΩ I _F = 12mA, R _L = 270Ω | 6,8 |
| | 6N138 | | 1 | 10 | μs | I _F = 1.6mA, R _L = 2.2kΩ | |
| Propagation Delay Time | 6N139 | | 5 1 | 60 7 | μs | I _F = 0.5mA, R _L = 4.7kΩ I _F = 12mA, R _L = 270mΩ | 6,8 |
| | 6N138 | | 4 | 35 | μs | I _F = 1.6mA, R _L = 2.2kΩ | |
| Common Mode Transient Immunity at Logic High Level (CM _H) Output | | | 500 | | v/μs | I _F = 0mA, R _L = 2.2kΩ R _{CC} = 0, V _{CM} = 10V _{pp} | 9,10 |
| Common Mode Transient Immunity at Logic Low Level (CM _L) Output | | | -500 | | v/μs | I _F = 1.6mA, R _L = 2.2kΩ R _{CC} = 0, V _{CM} = 10V _{pp} | 9,10 |

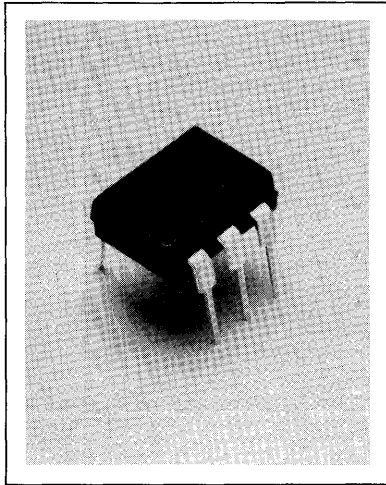
Notes

- Derate linearly above 50°C free-air temperature at a rate of 0.4mA/°C.
- Derate linearly above 50°C free-air temperature at a rate of 0.7mW/°C.
- Derate linearly above 25°C free-air temperature at a rate of 0.7mA/°C.
- Derate linearly above 25°C free-air temperature at a rate of 2.0mW/°C.
- DC current transfer ratio is defined as the ratio of output collector current, I_O, to the forward LED input current, I_F times 100%
- Pin 7 open.
- Device considered a two-terminal device: pins 1,2,3 and 4 shorted together and pins 5,6,7, and 8 shorted together.
- Use of a resistor between pin 5 and 7 will decrease gain and delay time.
- Common mode transient immunity in logic high level is the maximum tolerable (positive) dVcm/dt on the leading edge of the common mode pulse, V_{cm}, to assure that the output will remain in a logic high state (i.e. V_O > 2.0V) common mode transient immunity in logic low level is the maximum tolerable (negative) dVcm/dt on the trailing edge of the common mode pulse signal, V_{cm}, to assure that the output will remain in a logic low state (i.e. V_O < 0.8V).
- In applications where dv/dt may exceed 50,000v/us (such as state discharge) a series resistor, R_{cc} should be included to protect I_c from destructively high surge currents. The recommended value is $R_{cc} \approx \frac{IV}{0.15 I_F \text{ (mA)}} \text{ k}\Omega$.

SIEMENS

CNY 17 SERIES

SINGLE CHANNEL PHOTOTRANSISTOR OPTO-ISOLATOR



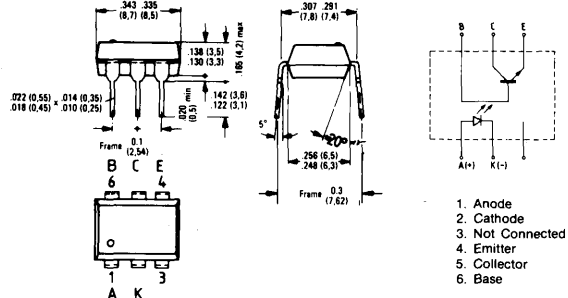
FEATURES

- 4400 Volt Breakdown Voltage
- High Current Transfer Ratio, 4 Groups
 CNY 17-1, 40 to 80%
 CNY 17-2, 63 to 125%
 CNY 17-3, 100 to 200%
 CNY 17-4, 160 to 320%
- Long Term Stability
- Industry Standard Dual-in-Line
- Underwriters Lab Approval #E52744
- VDE Approval #0883

DESCRIPTION

The CNY 17 is an optically coupled pair employing a gallium arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The CNY 17 can be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

Package Dimensions in Inches (mm)



Maximum Ratings

Emitter (GaAs infrared emitting diode)

| | | | |
|-------------------------------------|-----------|-----|----|
| Reverse voltage | V_R | 6 | V |
| Forward current | I_F | 60 | mA |
| Surge current ($t \leq 10 \mu s$) | I_{FS} | 1.5 | A |
| Power dissipation | P_{tot} | 100 | mW |

Detector (Si phototransistor)

| | | | |
|-----------------------------------|-----------|-----|----|
| Collector-emitter reverse voltage | V_{CE0} | 70 | V |
| Emitter-base reverse voltage | V_{EBO} | 7 | V |
| Collector current | I_C | 50 | mA |
| Collector current ($t < 1 ms$) | I_{CSM} | 100 | mA |
| Power dissipation | P_{tot} | 150 | mW |

Coupler

| | | | |
|--|------------|-------------|-------------|
| Storage temperature | T_{stor} | -40 to +150 | $^{\circ}C$ |
| Operating temperature | T_{amb} | -40 to +100 | $^{\circ}C$ |
| Junction temperature | T_j | 100 | $^{\circ}C$ |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3 s$) | T_s | 260 | $^{\circ}C$ |
| Isolation voltage | V_{is} | 4400 | V |

(between emitter and detector referred to standard climate 23/50 DIN 50014;

leakage path: DIN 57883, 6.80

air path: VDE 0883, 6.80

Tracking resistance: Group III ($KC \geq 600$ in accordance with VDE 110 § 6, table 3 and DIN 53 480/VDE 0330, part 1.

Isolation voltage @ $V_{is} = 500 V$

| | | |
|----------|--------|----------|
| R_{is} | 10^7 | Ω |
|----------|--------|----------|

Characteristics ($T_{amb} = 25^{\circ}C$)

Emitter (GaAs infrared emitting diode)

| | | | |
|---|--------------|----------------------|---------|
| Forward voltage ($I_F = 60 mA$) | V_F | 1.25 (≤ 1.65) | V |
| Breakdown voltage ($I_R = 100 \mu A$) | V_{BR} | 30 (≥ 6) | V |
| Reverse current ($V_R = 3 V$) | I_R | 0.01 (≤ 10) | μA |
| Capacitance ($V_R = 0 V; f = 1 MHz$) | C_0 | 40 | pF |
| Thermal Resistance | R_{thJamb} | 750 | K/W |

Detector (Si phototransistor)

| | | | |
|---|--------------|-----|-----|
| Capacitance ($V_{CE} = 0 V; f = 1 MHz$) | C_{CE} | 6.8 | pF |
| | C_{CB} | 8.5 | pF |
| | C_{EB} | 11 | pF |
| Thermal Resistance | R_{thJamb} | 500 | K/W |

Coupler

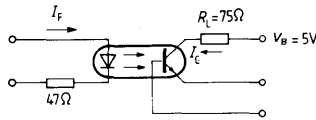
| | | | |
|--|-------------|-----------------|----|
| Collector-emitter saturation voltage ($I_F = 10 mA; I_C = 2.5 mA$) | V_{CEsat} | 25 (≤ 4) | V |
| Coupling capacitance | C_K | 30 | pF |

The couplers are grouped in accordance with their current ratio I_C/I_F at $I_E = 10 mA$ and $V_{CE} = 5 V$ and marked by Roman numerals.

Specifications subject to change.

| Group | CNY 17-1 | CNY 17-2 | CNY 17-3 | CNY 17-4 | |
|---|-----------|-----------------|------------------|------------------|----|
| I_C/I_F | 40 to 80 | 63 to 125 | 100 to 200 | 160 to 320 | % |
| Collector-emitter leakage current ($V_{CE} = 10 V$) | I_{CEO} | 2 (≤ 50) | 5 (≤ 100) | 5 (≤ 100) | nA |

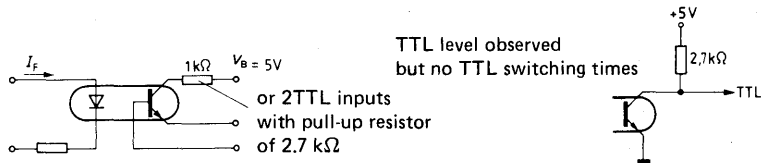
Linear operation (without saturation)



| | | | |
|-------------------|-------|--------------------|----------|
| Load resistance | R_L | 75 | Ω |
| Delay time | t_d | 3,0 ($\leq 5,6$) | μs |
| Rise time | t_r | 2,0 ($\leq 4,0$) | μs |
| Storage time | t_s | 2,3 ($\leq 4,1$) | μs |
| Fall time | t_f | 2,0 ($\leq 3,5$) | μs |
| Cut-off frequency | f_g | 250 | kHz |

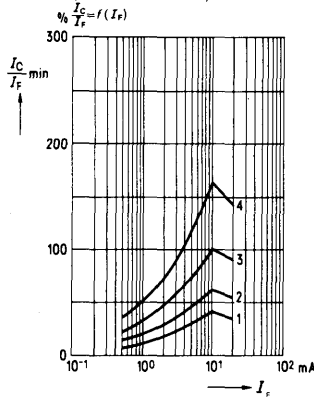
$I_F = 10 \text{ mA}$
 $V_B = 5 \text{ V}$
 $T_{amb} = 25^\circ \text{C}$

Switching operation (with saturation)

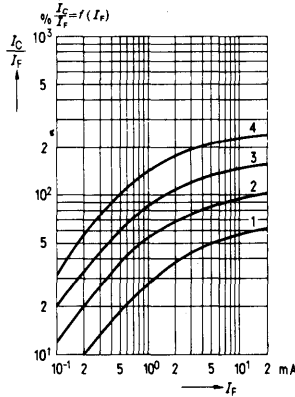


| Group | 1 | 2 and 3 | 4 | | |
|--------------|-----------------------|-----------------------|----------------------|---------------------|---------|
| | $I_F = 20 \text{ mA}$ | $I_F = 10 \text{ mA}$ | $I_F = 5 \text{ mA}$ | | |
| Delay time | t_d | 3,0 ($\leq 5,5$) | 4,2 ($\leq 8,0$) | 6,0 ($\leq 10,5$) | μs |
| Rise time | t_r | 2,0 ($\leq 4,0$) | 3,0 ($\leq 6,0$) | 4,6 ($\leq 8,0$) | μs |
| Storage time | t_s | 18 (≤ 34) | 23 (≤ 39) | 25 (≤ 43) | μs |
| Fall time | t_f | 11 (≤ 20) | 14 (≤ 24) | 15 (≤ 26) | μs |
| | $V_{CE sat}$ | 0,25 ($\leq 0,4$) | | V | |

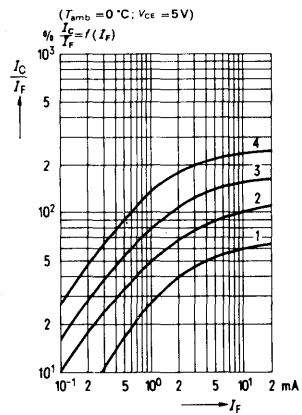
Minimum current transfer ratio as a function of diode current
 ($T_{amb} = 25^\circ \text{C}$, $V_{CE} = 5 \text{ V}$)



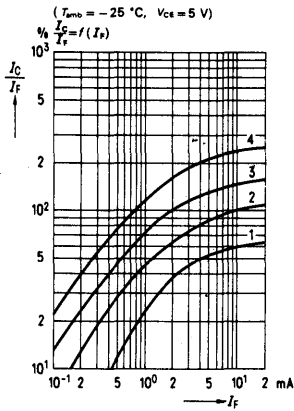
Current transfer ratio as a function of diode current
 ($T_{amb} = -25^\circ \text{C}$, $V_{CE} = 5 \text{ V}$)



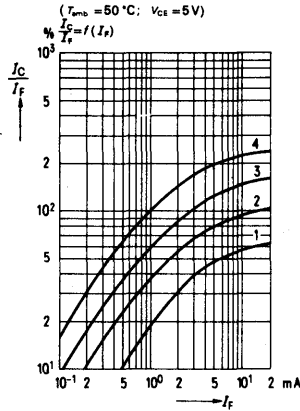
Current transfer ratio as a function of diode current
 ($T_{amb} = 0^\circ \text{C}$, $V_{CE} = 5 \text{ V}$)



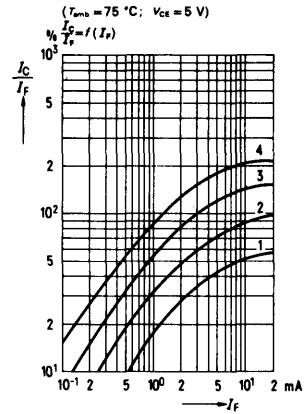
Current transfer ratio as a function of diode current



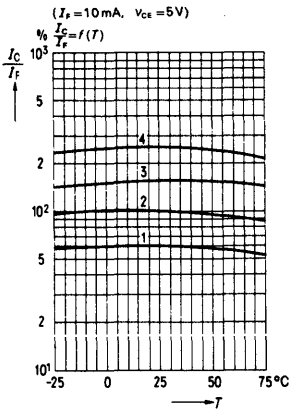
Current transfer ratio as a function of diode current



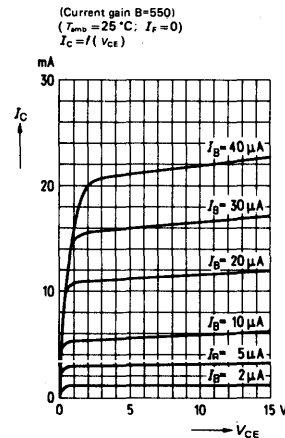
Current transfer ratio as a function of diode current



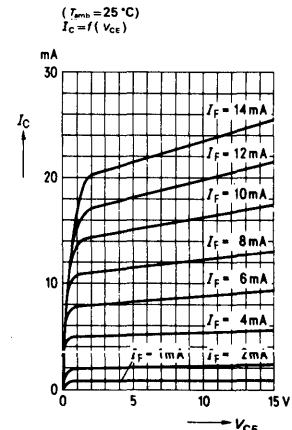
Current transfer ratio as a function of temperature



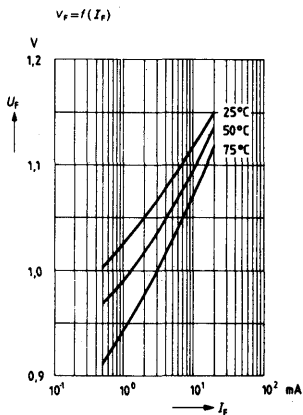
Transistor characteristics



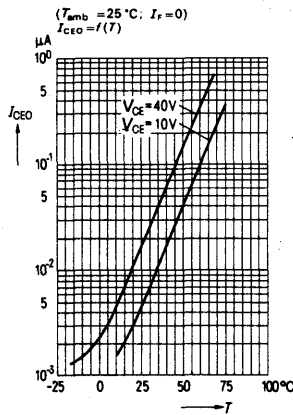
Output characteristics



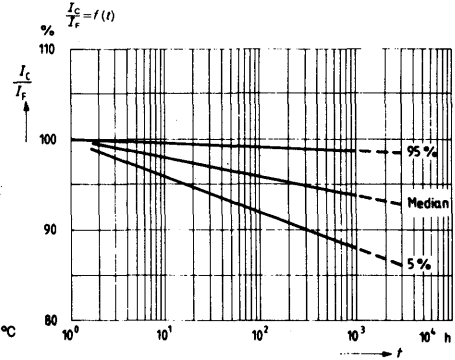
Forward voltage



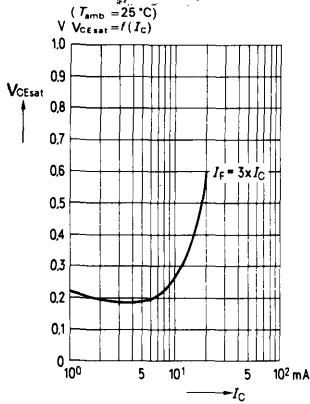
Collector-emitter off-state current



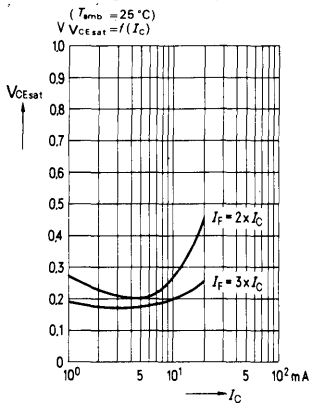
Variation of current transfer ratio as a function of load time



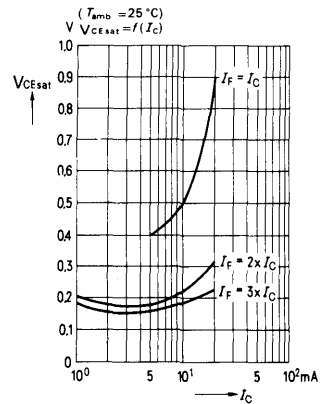
Saturation voltage as a function of collector current and modulation depth for CNY17-1



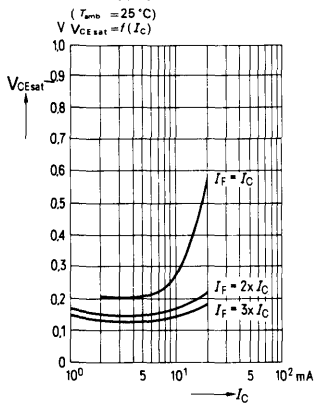
Handling same except for CNY17-2



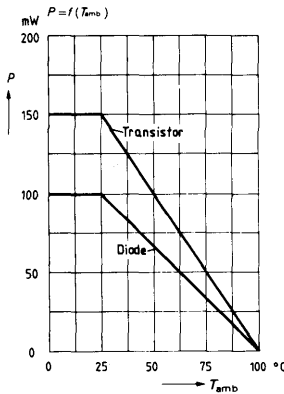
CNY17-3



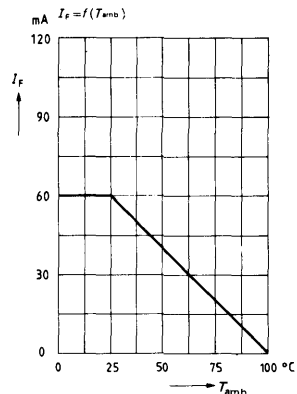
CNY17-4



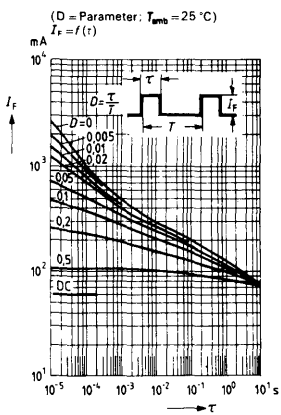
Permissible loss transistor and diode



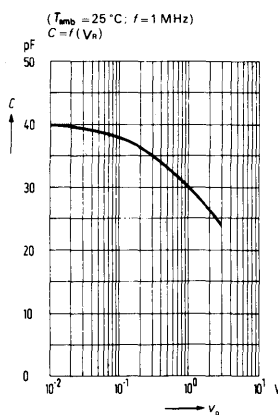
Permissible loss diode



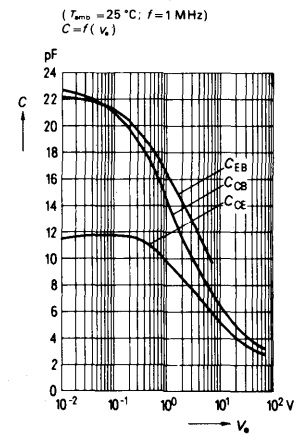
Permissible pulse load



Diode capacitance



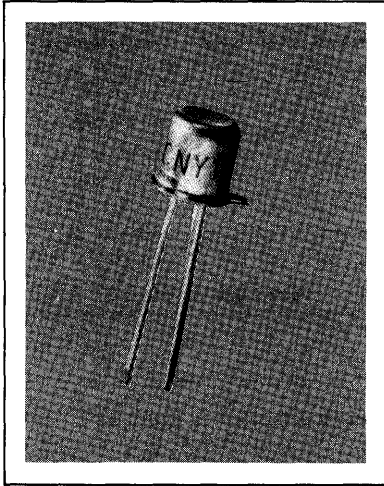
Transistor capacitances



SIEMENS

CNY 18 SERIES

SINGLE CHANNEL PHOTOTRANSISTOR OPTO-ISOLATOR



FEATURES

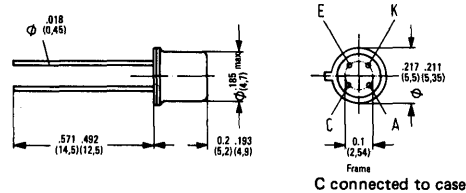
- TO-72 Metal Case Package
- Current Transfer Ratio, 4 Groups
 CNY 18-2, 16 to 32%
 CNY 18-3, 25 to 50%
 CNY 18-4, 40 to 80%
 CNY 18-5, 63 to 125%

DESCRIPTION

The optically coupled isolator CNY 18 uses as emitter a GaAs infrared emitting diode which is optically coupled with a silicon planar phototransistor acting as detector. The component is incorporated in an 18 A DIN 41876 (TO-72) case. The collector of the phototransistor is electrically connected to the metal case.

The coupling device is suitable for signal transmission between two electrically separated circuits. The potential difference between the circuits to be coupled is not allowed to exceed the maximum permissible insulating voltage.

Package Dimensions in Inches (mm)



C connected to case

Maximum Ratings

Emitter (GaAs infrared emitting diode)

| | | | |
|-------------------------------------|-----------|-----|----|
| Reverse voltage | V_R | 3 | V |
| Forward current | I_F | 60 | mA |
| Surge current ($t \leq 10 \mu s$) | I_{FS} | 1.5 | A |
| Power dissipation | P_{tot} | 100 | mW |

Detector (Si phototransistor)

| | | | |
|-----------------------------------|-----------|-----|----|
| Collector-emitter reverse voltage | V_{CEO} | 32 | V |
| Collector current | I_C | 100 | mA |
| Power dissipation | P_{tot} | 150 | mW |

Coupler

| | | | |
|--|------------|-------------|----|
| Storage temperature | T_{stor} | -55 to +125 | °C |
| Operating temperature | T_{amb} | -55 to +100 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3 s$) | T_s | 230 | °C |
| isolation voltage (between emitter and detector referred to standard climate 23/50 DIN 50014; leakage path 0.35 mm min; air path 0.35 mm min) | V_{is} | 500 | V |

Tracking resistance: Group III (KC ≥ 600) in accordance with VDE 110 § 6, table 3 and DIN 53 450; VDE 0330, part 1.

DIN standard specification and/or VDE instructions under consideration; as to the nominal isolation voltage: VDE decision 69 or VDE 010 and 0160 applies.

Characteristics ($T_{amb} = 25^\circ C$)

Emitter (GaAs infrared emitting diode)

| | | | |
|---|----------|---------------------|---------|
| Forward voltage ($I_F = 60 mA$) | V_F | 1.25 (≤ 1.7) | V |
| Breakdown voltage ($I_R = 100 \mu A$) | V_{BR} | 30 (≥ 4) | V |
| Reverse current ($V_R = 3 V$) | I_R | 0.01 (≤ 10) | μA |
| Capacitance ($V_R = 0 V; f = 1 MHz$) | C_D | 50 | pF |

Detector (Si phototransistor)

| | | | |
|---|-----------|------------------|----|
| Collector-emitter leakage current ($V_{CE} = 10 V$) | I_{CEO} | 2 (≤ 100) | nA |
| Collector-emitter capacitance ($V_{CE} = 0 V; f = 1 MHz$) | C_{CE} | 10 | pF |

Coupler

| | | | |
|--|-------------|--------------------|---|
| Collector-emitter saturation voltage ($I_F = 10 mA; I_C = 1 mA$) | V_{CEsat} | 0.1 (≤ 0.2) | V |
|--|-------------|--------------------|---|

Coupling capacitances ($f = 1 MHz$)

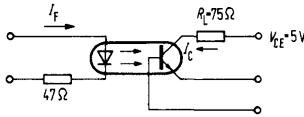
Infrared emitting diode

| | | | | |
|-------------------------------|------------------------------------|-------|-----|----|
| Anode-cathode short-circuited | Emitter-collector short-circuited | C_X | 1.4 | pF |
| Anode-cathode short-circuited | Collector (emitter conn. to frame) | C_X | 1.1 | pF |
| Anode-cathode short-circuited | Emitter (collector conn. to frame) | C_X | 0.1 | pF |

The couplers are grouped in accordance with their current ratio $\frac{I_C}{I_F}$ at $I_F = 10 mA$ and $V_{CE} = 5 V$.

| Group | CNY 18-2 | CNY 18-3 | CNY 18-4 | CNY 18-5 |
|-------------------|----------|----------|----------|-------------|
| $\frac{I_C}{I_F}$ | 16 to 32 | 25 to 50 | 40 to 80 | 63 to 125 % |

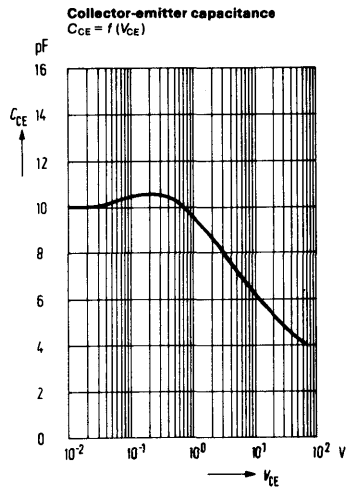
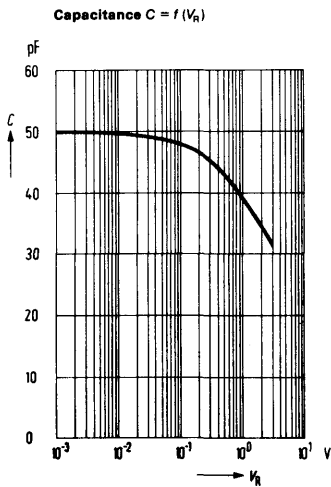
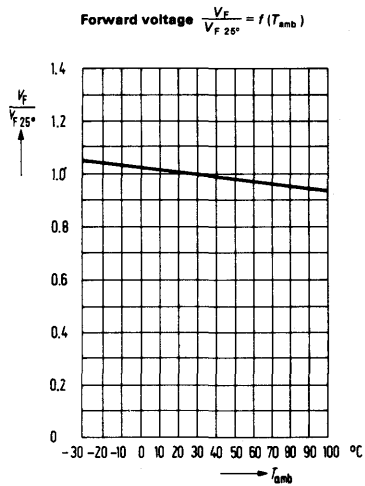
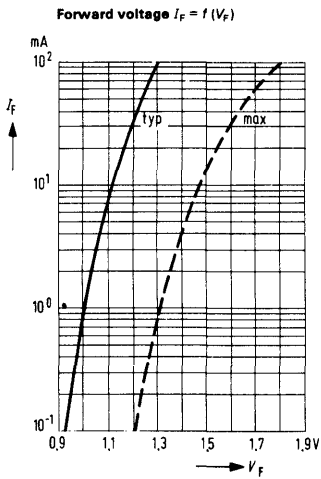
Specifications are subject to change without notice.



$I_F = 10 \text{ mA}$
 $V_{CE} = 5 \text{ V}$
 $T_{amb} = 25^\circ \text{C}$

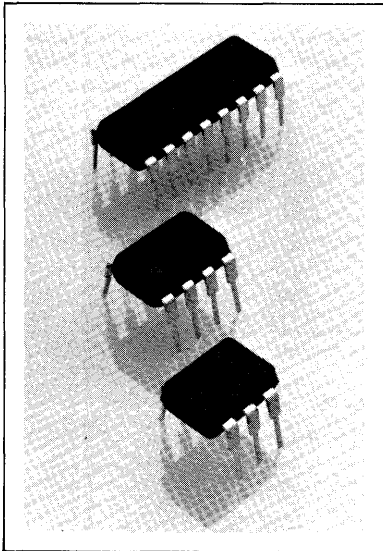
Switching Times

| | |
|-----------------------------|----------------------------------|
| Load Resistance (R_L) | 75 Ω |
| Delay Time (t_d) | 3.2 (≤ 4.6) μs |
| Rise Time (t_r) | 2 (≤ 3) μs |
| Storage Time (t_s) | 3.0 (≤ 4.0) μs |
| Fall Time (t_f) | 2.5 (≤ 3.3) μs |
| Cut Off Frequency (f_Q) | 250 kHz |



SIEMENS

IL-1B SINGLE CHANNEL ILD-1 DUAL CHANNEL ILQ-1 QUAD CHANNEL PHOTOTRANSISTOR OPTO-ISOLATOR



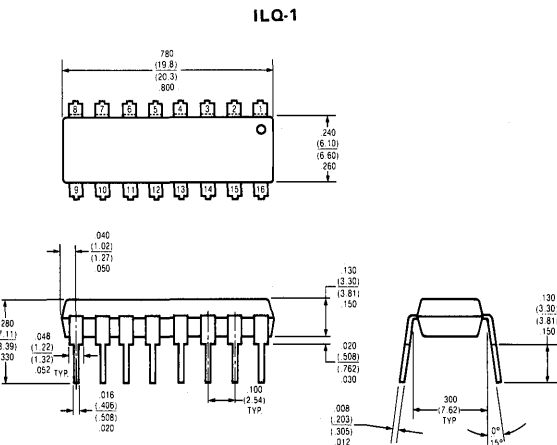
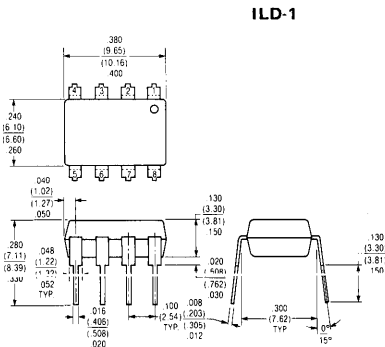
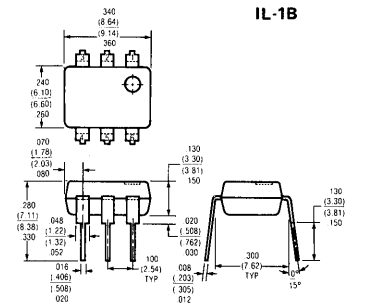
FEATURES

- 7400 Series T²L Compatible
- 6000 Volt Isolation Voltage
- 0.5 pF Coupling Capacitance
- Industry Standard Dual-In-Line Package
- Single Channel, Dual, and Quad Configurations
- Underwriters Lab Approval #E52744

DESCRIPTION

IL-1B is an optically coupled pair employing a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-1B is especially designed for driving medium-speed logic, where it may be used to eliminate troublesome ground loop and noise problems. It can also be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation. The ILD-1 offers two isolated channels in a single DIP package while the ILQ-1 provides four isolated channels per package.

Package Dimensions in Inches (mm)



Specifications subject to change without notice.

MAXIMUM RATINGS

Gallium Arsenide LED (each channel)

Power Dissipation @ 25°C

| | |
|-------|--------|
| IL-1B | 200 mW |
| ILD-1 | 150 mW |
| ILQ-1 | 150 mW |

Derate Linearly from 25°C

| | |
|-------|------------|
| IL-1B | 2.6 mW/°C |
| ILD-1 | 1.33 mW/°C |
| ILQ-1 | 1.33 mW/°C |

Continuous Forward Current

| | |
|-------|--------|
| IL-1B | 100 mA |
| ILD-1 | 100 mA |
| ILQ-1 | 100 mA |

Detector Silicon Phototransistor (each channel)

Power Dissipation @ 25°C

| | |
|-------|--------|
| IL-1B | 200 mW |
| ILD-1 | 150 mW |
| ILQ-1 | 150 mW |

Derate Linearly from 25°C

| | |
|-------|-----------|
| IL-1B | 2.6 mW/°C |
| ILD-1 | 2.0 mW/°C |
| ILQ-1 | 2.0 mW/°C |

Collector-Emitter Breakdown Voltage 30 V

Emitter-Collector Breakdown Voltage 7 V

Collector-Base Breakdown Voltage (IL-1) 70 V

Package

Total Package Dissipation at 25°C Ambient (LED Plus Detector)

| | |
|-------|--------|
| IL-1B | 250 mW |
| ILD-1 | 400 mW |
| ILQ-1 | 500 mW |

Derate Linearly from 25°C

| | |
|-------|------------|
| IL-1B | 3.3 mW/°C |
| ILD-1 | 5.33 mW/°C |
| ILQ-1 | 6.67 mW/°C |

Storage Temperature -55°C to +150°C

Operating Temperature -55°C to +100°C

Lead Soldering Time @ 260°C 10 sec

ELECTRICAL CHARACTERISTICS PER CHANNEL (at 25°C Ambient)

| Parameter | Min | Typ | Max | Units | Test Conditions |
|---------------------------------|------|------|-----|---------------|--|
| Gallium Arsenide LED | | | | | |
| Forward Voltage | | 1.3 | 1.5 | V | $I_F = 60 \text{ mA}$ |
| Reverse Current | | 0.1 | 10 | μA | $V_R = 3.0 \text{ V}$ |
| Capacitance | | 100 | | pF | $V_R = 0$ |
| Phototransistor Detector | | | | | |
| BV_{ECO} | 7 | 10 | | V | $I_E = 100 \mu\text{A}$ |
| BV_{CEO} | 30 | 50 | | V | $I_C = 1 \text{ mA}$ |
| I_{CEO} | | 5.0 | 50 | nA | $V_{CE} = 10 \text{ V}, I_F = 0$ |
| Collector-Emitter Capacitance | | 2.0 | | pF | $V_{CE} = 0$ |
| Coupled Characteristics | | | | | |
| DC Current Transfer Ratio | 20 | 35 | | % | $I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V}$ |
| V_{SAT} | | 0.25 | 0.5 | V | $I_C = 1.6 \text{ mA}, I_F = 16 \text{ mA}$ |
| Capacitance, Input to Output | | 0.5 | | pF | |
| Breakdown Voltage | 6000 | 7500 | | VDC | $t = 1 \text{ sec.}$ |
| Resistance, Input to Output | | 100 | | $G\Omega$ | |
| Switching Times | | | | | |
| t_{ON} | | 2.5 | | μs | $R_E = 100\Omega, V_{CE} = 10\text{V}$ |
| t_{OFF} | | 2.5 | | μs | $I_C = 2 \text{ mA}$ |

TYPICAL OPTOELECTRONIC CHARACTERISTIC CURVES FOR EACH CHANNEL

FIGURE 1. RELATIVE OUTPUT VS TEMPERATURE

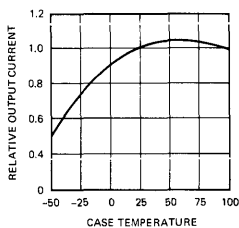


FIGURE 2. DARK CURRENT VS TEMPERATURE

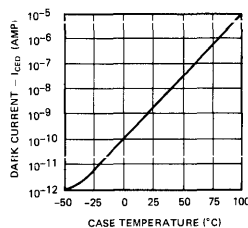


FIGURE 3. TRANSFER CHARACTERISTICS

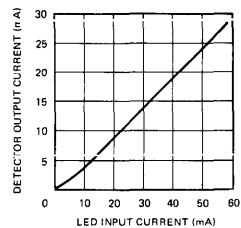


FIGURE 4. DETECTOR OUTPUT CHARACTERISTICS

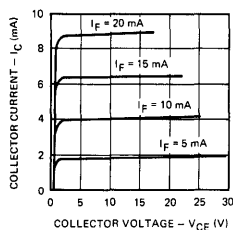
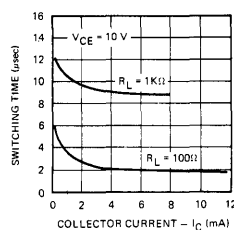


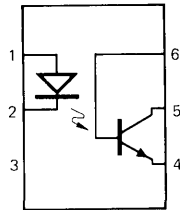
FIGURE 5. SWITCHING TIME VS COLLECTOR CURRENT



PIN CONFIGURATIONS

IL-1B

(TOP VIEW)

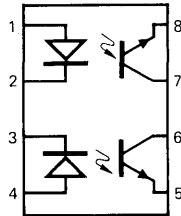


LED CHIP ON PIN 2
PT CHIP ON PIN 5

| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | NC |
| 4 | EMITTER |
| 5 | COLLECTOR |
| 6 | BASE |

ILD-1

(TOP VIEW)

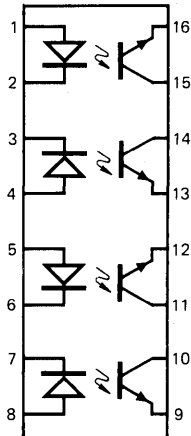


LED CHIPS ON PINS 2 AND 3
PT CHIPS ON PINS 6 AND 7

| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | CATHODE |
| 4 | ANODE |
| 5 | EMITTER |
| 6 | COLLECTOR |
| 7 | COLLECTOR |
| 8 | EMITTER |

ILQ-1

(TOP VIEW)



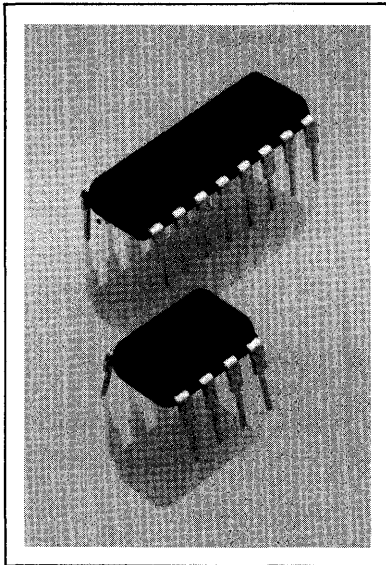
LED CHIPS ON PINS 2, 3, 6, 7
PT CHIPS ON PINS 10, 11, 14, 15

| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | CATHODE |
| 4 | ANODE |
| 5 | ANODE |
| 6 | CATHODE |
| 7 | CATHODE |
| 8 | ANODE |
| 9 | EMITTER |
| 10 | COLLECTOR |
| 11 | COLLECTOR |
| 12 | EMITTER |
| 13 | EMITTER |
| 14 | COLLECTOR |
| 15 | COLLECTOR |
| 16 | EMITTER |

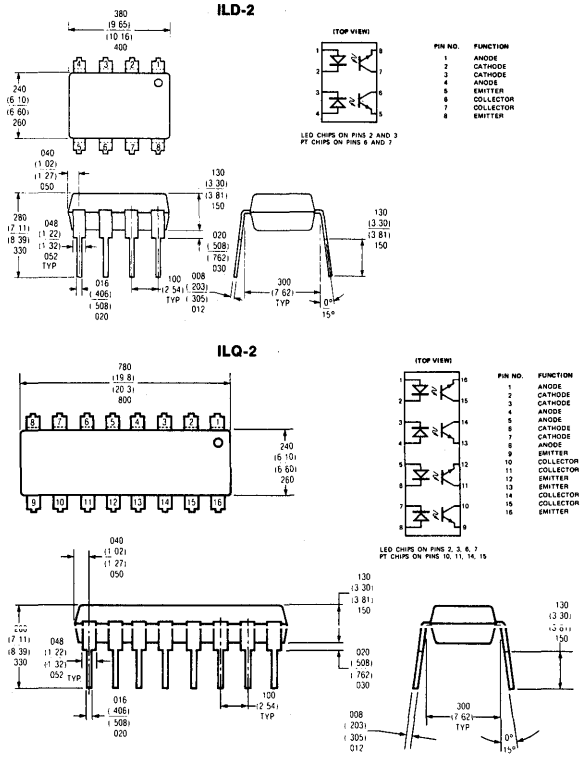
SIEMENS

ILD-2 DUAL CHANNEL ILQ-2 QUAD CHANNEL

PHOTOTRANSISTOR OPTO-ISOLATOR



Package Dimensions in Inches (mm)



FEATURES

- 100% Minimum Current Transfer Ratio
- 7400 Series T²L Compatible
- 7500 Volt Isolation Voltage
- 0.5 pF Coupling Capacitance
- Industry Standard Dual In-Line Package
- Single Channel, Dual, and Quad Configurations
- Underwriters Lab Approval #E52744

DESCRIPTION

ILD2/ILQ2 are optically coupled pairs employing Gallium Arsenide infrared LEDs and silicon NPN phototransistors. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The ILD2/ILQ2 are especially designed for driving medium-speed logic, where they may be used to eliminate troublesome ground loop and noise problems. They can also be used to replace relays and transformers in many digital interface applications such as CRT modulation. The ILD-2 offers two isolated channels in a single DIP package while the

Maximum Ratings

Gallium Arsenide LED (each channel)

Power Dissipation @ 25°C

| | |
|-------|--------|
| ILD-2 | 150 mW |
| ILQ-2 | 150 mW |

Derate Linearly from 25°C

| | |
|-------|------------|
| ILD-2 | 1.33 mW/°C |
| ILQ-2 | 1.33 mW/°C |

Continuous Forward Current

| | |
|-------|--------|
| ILD-2 | 100 mA |
| ILQ-2 | 100 mA |

Detector Silicon Phototransistor (each channel)

Power dissipation @ 25°C

| | |
|-------|--------|
| ILD-2 | 150 mW |
| ILQ-2 | 150 mW |

Derate Linearly from 25°C

| | |
|-------|-----------|
| ILD-2 | 2.0 mW/°C |
| ILQ-2 | 2.0 mW/°C |

| | |
|---|------|
| Collector-Emitter Breakdown Voltage | 30 V |
| Emitter-Collector Breakdown Voltage | 7 V |
| Collector-Base Breakdown Voltage (IL-1) | 70 V |

Maximum Ratings

(Continued From the Previous Page)

Package

| | |
|---|-------|
| Total Package Dissipation at 25°C Ambient (LED Plus Detector) | |
| ILD-2 | 400mW |
| ILQ-2 | 500mW |

Derate Linearly from 25°C

| | |
|-----------------------------|-----------------|
| ILD-2 | 5.33 mW/°C |
| ILQ-2 | 6.67 mW/°C |
| Storage Temperature | -55°C to +150°C |
| Operating Temperature | -55°C to +100°C |
| Lead Soldering Time @ 260°C | 10 sec |

ELECTRICAL CHARACTERISTICS PER CHANNEL (at 25°C Ambient)

| Parameter | Min | Typ | Max | Units | Test Conditions |
|-------------------------------|------|------|-----|---------------|--|
| Gallium Arsenide LED | | | | | |
| Forward Voltage | 1.3 | 1.5 | | V | $I_F = 60 \text{ mA}$ |
| Reverse Current | 0.1 | 10 | | μA | $V_R = 3.0 \text{ V}$ |
| Capacitance | 100 | | | pF | $V_R = 0$ |
| Phototransistor Detector | | | | | |
| BV_{FEO} | 7 | 10 | | V | $I_C = 100 \mu\text{A}$ |
| BV_{CEO} | 30 | 50 | | V | $I_C = 1 \text{ mA}$ |
| I_{CEO} | | 5.0 | 50 | nA | $V_{CE} = 10 \text{ V}, I_F = 0$ |
| Collector-Emitter Capacitance | 2.0 | | | pF | $V_{CE} = 0$ |
| Coupled Characteristics | | | | | |
| DC Current Transfer Ratio | 100 | | | % | $I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V}$ |
| V_{SAT} | | 0.25 | 0.5 | V | $I_C = 1.6 \text{ mA}, I_F = 16 \text{ mA}$ |
| Capacitance, Input to Output | | 0.5 | | pF | |
| Breakdown Voltage | 7500 | | | VDC | $t = 1 \text{ sec.}$ |
| Resistance, Input to Output | | 100 | | $G\Omega$ | |
| Switching Times | | | | | |
| t_r | | 2.5 | | μs | $R_E = 100\Omega, V_{CE} = 10\text{V}$ |
| t_f | | 2.5 | | μs | $I_C = 2 \text{ mA}$ |

TYPICAL OPTOELECTRONIC CHARACTERISTIC CURVES FOR EACH CHANNEL

FIGURE 1. RELATIVE OUTPUT VS TEMPERATURE

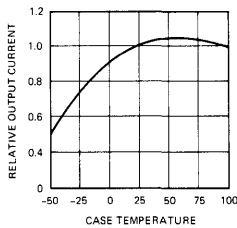


FIGURE 2. DARK CURRENT VS TEMPERATURE

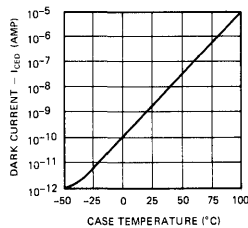


FIGURE 3. TRANSFER CHARACTERISTICS

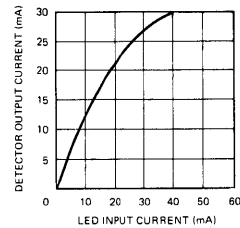


FIGURE 4. DETECTOR OUTPUT CHARACTERISTICS

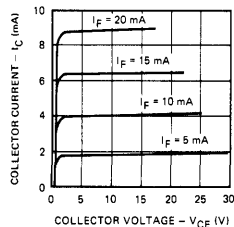
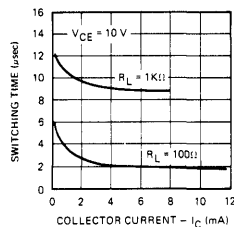


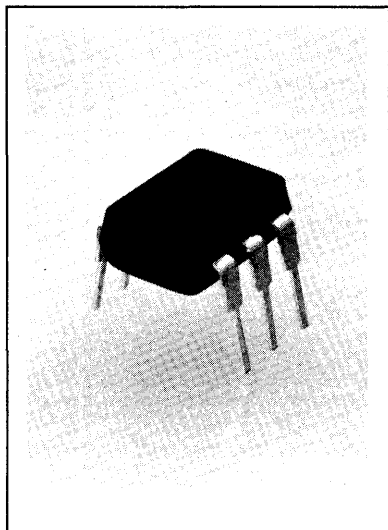
FIGURE 5. SWITCHING TIME VS COLLECTOR CURRENT



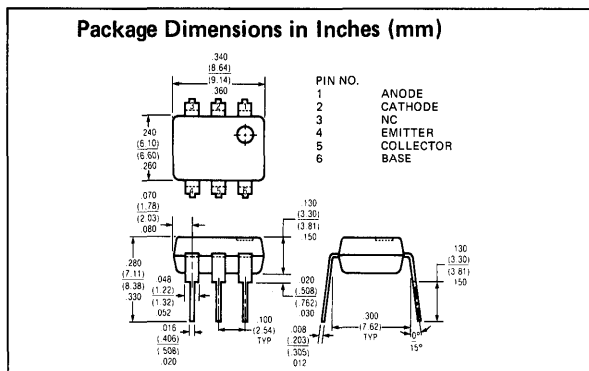
SIEMENS

IL-5

PHOTOTRANSISTOR OPTO-ISOLATOR



Package Dimensions in Inches (mm)



Maximum Ratings

Gallium Arsenide LED

| | |
|----------------------------|-----------|
| Power Dissipation @ 25°C | 200 mW |
| Derate Linearly from 25°C | 2.6 mW/°C |
| Continuous Forward Current | 100 mA |
| Peak Inverse Voltage | 3.0 V |

Detector (Silicon Phototransistor)

| | |
|--|-----------|
| Power Dissipation @ 25°C | 200 mW |
| Derate Linearly From 25°C | 2.6 mW/°C |
| Collector-Emitter Breakdown Voltage (BV _{CEO}) | 30 V |
| Emitter-Collector Breakdown Voltage (BV _{ECO}) | 7 V |
| Collector-Base Breakdown Voltage (BV _{CBO}) | 70 V |

Package

| | |
|---|---------------|
| Total Package Dissipation at 25°C Ambient (LED Plus Detector) | 250 mW |
| Derate Linearly From 25°C | 3.3 mW/°C |
| Storage Temperature | -55 to +150°C |
| Operating Temperature | -55 to +100°C |
| Lead Soldering Time @ 260°C | 10 sec |

Electrical Characteristics (at 25°C Ambient)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|---|-----|------|-----|------|--|
| Gallium Arsenide LED | | | | | |
| Forward Voltage | 1.3 | 1.5 | | V | I _F = 60 mA |
| Reverse Current | .1 | 10 | | μA | V _R = 3.0 V |
| Capacitance | 100 | | | pF | V _R = 0 |
| Phototransistor Detector | | | | | |
| H _{FE} | | 450 | | | V _{CE} = 5.0 V I _C = 100 μA |
| BV _{CEO} | 30 | 50 | | V | I _C = 1 mA |
| BV _{ECO} | 7 | 10 | | V | I _E = 100 μA |
| I _{CEO} (dark) | | 5 | 50 | nA | V _{CE} = 10 V I _F = 0 |
| Collector-Emitter Capacitance | | 2 | | pF | V _{CE} = 0 |
| Coupled Characteristics | | | | | |
| DC Current Transfer | 50 | 70 | | % | I _F = 10 mA, V _{CE} = 10V |
| Collector-Emitter Saturation Voltage V _{CE(sat)} | .35 | 0.5 | | V | I _F = 16 mA I _C = 1.6 mA |
| Capacitance, Input to Output | | .5 | | pF | |
| Breakdown Voltage | | 7500 | | VDC | |
| Resistance, Input to Output | | 100 | | GΩ | |
| Output Rise and Fall Times | | 2.8 | | μs | I _C = 2mA, R _E = 100Ω V _{CC} = 10V |

FEATURES

- 6000 Volt Isolation Voltage
- 70% Typical Transfer Ratio
- Industry Standard Dual-In-Line
- 0.5 pF Coupling Capacitance
- Underwriters Lab Approval #E52744

DESCRIPTION

IL-5 is an optically coupled pair employing a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-5 can be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

Specifications subject to change without notice.

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES

FIGURE 1. RELATIVE OUTPUT VS TEMPERATURE

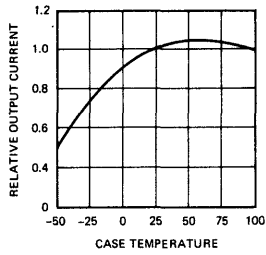


FIGURE 2. DARK CURRENT VS TEMPERATURE

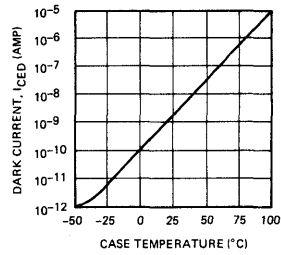


FIGURE 3. TRANSFER CHARACTERISTICS

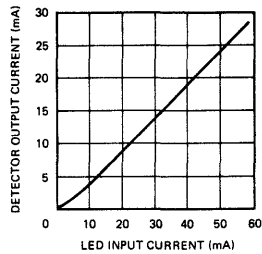


FIGURE 4. DETECTOR OUTPUT CHARACTERISTICS

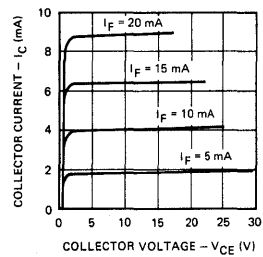
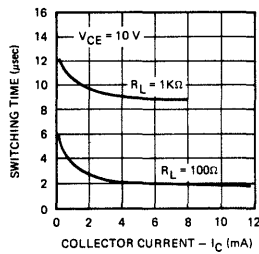
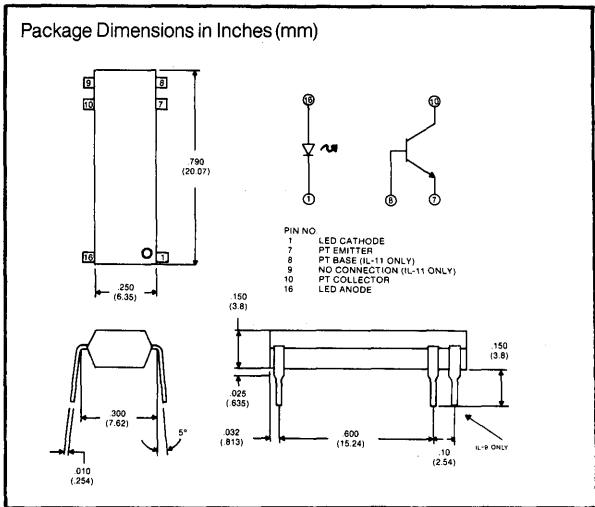
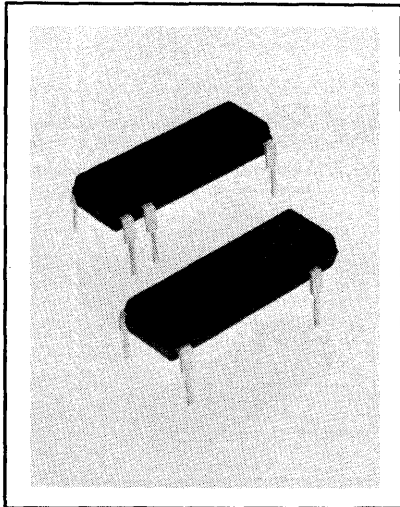


FIGURE 5. SWITCHING TIME VS COLLECTOR CURRENT



SIEMENS

IL-8/IL-9 PHOTOTRANSISTOR OPTO-ISOLATORS ADVANCE DATA SHEET



FEATURES:

- High Isolation Voltage of 8K VRMS
- Minimum internal separation of 2.0mm between conductive parts.
- Minimum external separation of leads and creepage distance of 13mm.
- Standard DIP profile on leads and package.
- Machine insertable on PCB
- IL-8 is four lead product
- IL-9 is six lead with base contact.
- VDE applied for
- Underwriters Lab approval #E52744

ABSOLUTE MAXIMUM RATINGS

Storage Temperature -55°C to 150°C
 Operating Temperature -55°C to 100°C
 Lead Solder Temperature 260°C
 (1.6mm from cast for t = 5 sec)
 Isolation Voltage 8KVRMS
 (t = 1 minute)

LED

Forward DC Current 60mA
 Peak Forward Current 3.0A
 (1μ sec pulse, 300pps)
 Reverse Voltage 5.0V
 Power Dissipation 100mW
 Derate linearly from 25°C 1.33mw/°C

Phototransistor

Collector Emitter Voltage 30V
 Emitter Base Voltage 7V
 Collector Current 100ma
 Power Dissipation 300mW

DESCRIPTION:

The IL-8 and IL-9 are optically coupled isolators employing a gallium arsenide infrared emitter and a silicon phototransistor. The package is designed to meet or exceed all requirements of VDE standard 0883/6.80 and 730-2.

ELECTRICAL CHARACTERISTICS

(25°C unless otherwise noted)

LED

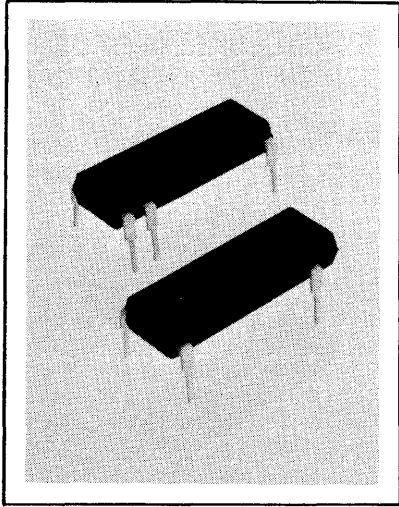
V_F (I_F = 10mA) 1.5V Max.
 I_R (V_R = 5V) 10μA Max.

Phototransistor

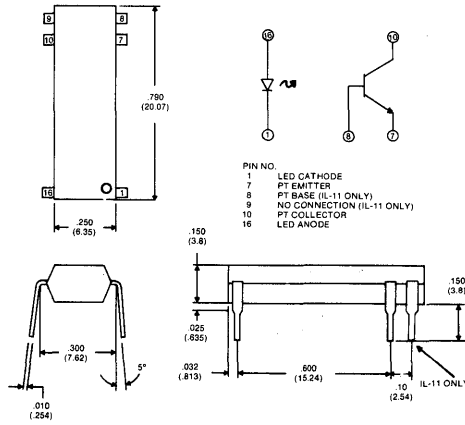
BV_{CEO} (I_C = 1.0mA) 30V Min.
 BV_{EBO} (I_E = 10μA) 7V Min.
 I_{CEO} (V_{CE} = 10V) 50 nA Max.

Coupled

DC Current Transfer Ratio
 (I_F = 10mA, V_{CE} = 10V) 20% Min.
 Saturation Voltage-Collector to Emitter
 (I_F = 20mA I_C = 2.0mA) 0.4V Max.
 T_{ON} = (I_C = 2mA, R_E = 100Ω,
 100μs Pulsewidth, 1% Duty-cycle) 14μs Typ.
 T_{OFF} = (I_C = 2mA, R_E = 100Ω,
 100μs Pulsewidth, 1% Duty-cycle) 11μs Typ.



Package Dimensions in Inches (mm)



FEATURES:

- High Isolation Voltage of 8K VRMS
- Minimum internal separation of 2.0mm between conductive parts.
- Minimum external separation of leads and creepage distance of 13mm.
- Standard DIP profile on leads and package.
- Machine insertable on PCB
- IL-10 is four lead product
- IL-11 is six lead with base contact.
- VDE applied for
- Underwriters Lab Approval #E52744

ABSOLUTE MAXIMUM RATINGS

| | |
|--|----------------|
| Storage Temperature | -55°C to 150°C |
| Operating Temperature | -55°C to 100°C |
| Lead Solder Temperature (1.6mm from cast for t = 5 sec) | 260°C |
| Isolation Voltage (t = 1 minute) | 8KVRMS |

LED

| | |
|--|-----------|
| Forward DC Current | 60mA |
| Peak Forward Current (1μ sec pulse, 300pps) | 3.0A |
| Reverse Voltage | 5.0V |
| Power Dissipation | 100mW |
| Derate linearly from 25°C | 1.33mW/°C |

Phototransistor

| | |
|---------------------------|----------|
| Collector Emitter Voltage | 30V |
| Emitter Base Voltage | 7V |
| Collector Current | 100mA |
| Power Dissipation | 300mW |
| Derate linearly from 25°C | 4.0mW/°C |

DESCRIPTION:

The IL-10 and IL-11 are optically coupled isolators employing a gallium arsenide infrared emitter and a silicon phototransistor. The package is designed to meet or exceed all requirements of VDE standard 0883/6.80 and 730-2.

ELECTRICAL CHARACTERISTICS

(25°C unless otherwise noted)

LED

| | |
|--|-----------|
| V _F (I _F = 10mA) | 1.5V Max. |
| I _R (V _R = 5V) | 10μA Max. |

Phototransistor

| | |
|--|------------|
| BV _{CEO} (I _C = 1.0mA) | 30V Min. |
| BV _{EBO} (I _E = 10μA) | 7V Min. |
| I _{CEO} (V _{CE} = 10V) | 50 nA Max. |

Coupled

| | |
|--|-----------|
| DC Current Transfer Ratio (I _F = 10mA, V _{CE} = 10V) | 50% Min. |
| Saturation Voltage-Collector to Emitter (I _F = 20mA I _C = 2.0mA) | 0.4V Max. |
| T _{ON} = (I _C = 2mA, R _E = 100Ω, 100μs Pulsewidth, 1% Duty-cycle) | 14μs Typ. |
| T _{OFF} = (I _C = 2mA, R _E = 100Ω, 100μs Pulsewidth, 1% Duty-cycle) | 11μs Typ. |

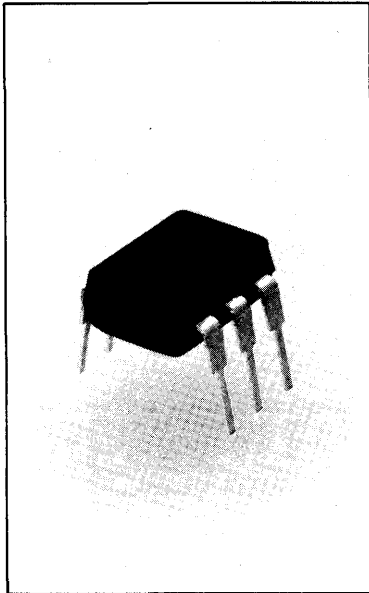
Specifications are subject to change without notice.

SIEMENS

IL-30 SINGLE CHANNEL (Formerly ILCA2-30)

IL-55 SINGLE CHANNEL (Formerly ILCA2-55)

PHOTO DARLINGTON OPTO-ISOLATORS



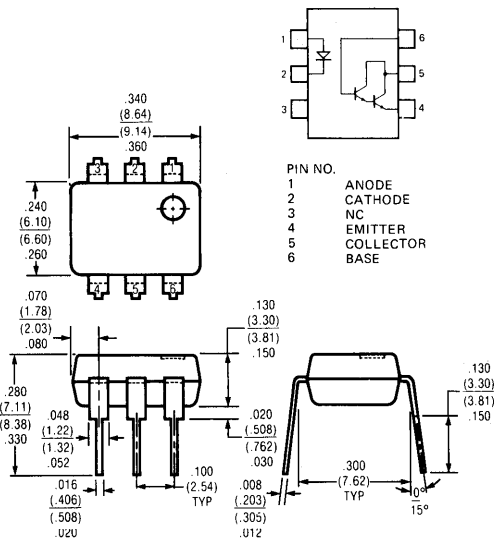
FEATURES

- 6000 Volt Isolation Voltage
- Equivalent to MCA2-30/MCA2-55
- 125 mA Load Current Rating
- Fast Turn On Time — 10 μ s
- Fast Turn Off Time — 35 μ s
- Solid State Reliability
- Standard Plastic DIP Package
- Underwriter Lab Approval #E52744

DESCRIPTION

The IL-30 and IL-55 are coupled isolators employing a gallium arsenide infrared emitter and a silicon photo darlington sensor. Switching can be accomplished while maintaining a high degree of isolation between driving and load circuits. They can be used to replace reed and mercury relays with advantages of long life, high speed switching and elimination of magnetic fields.

Package Dimensions in Inches (mm)



Maximum Ratings

| Gallium Arsenide LED | |
|--|--------------------------|
| Power Dissipation at 25°C | 80 mW |
| Derate Linearly From 25°C | 1.2 mW/°C |
| Continuous Forward Current | 60 mA |
| Peak Reverse Voltage | 3V |
| Photodarlington Sensor | |
| | IL-30 IL-55 |
| Power Dissipation at 25°C Ambient | 210 mW 210 mW |
| Derate Linearly From 25°C | 2.8 mW/°C 2.8 mW/°C |
| Collector (load) Current | 125 mA 125 mA |
| Collector-Emitter Breakdown Voltage (BV _{CE0}) | 30V 55V |
| Collector-Base Breakdown Voltage (BV _{CB0}) | 30V 55V |
| Emitter-Base Breakdown Voltage (BV _{EB0}) | 8V 8V |
| Package | |
| Total Dissipation at 25°C | 250 mW |
| Derate Linearly From 25°C | 3.3 mW/°C |
| Storage Temperature | -55°C to +150°C |
| Operating Temperature | -55°C to +100°C |
| Lead Soldering Time at 260°C | 10 sec |

Specifications are subject to change without notice.

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES

| Electrical Characteristics (at 25° Ambient) | | | | Test |
|---|-----------|-----|-----|--|
| Parameter | Min | Typ | Max | Unit Condition |
| GaAs Emitter | | | | |
| Forward Voltage | 1.25 | 1.5 | | V $I_F = 20\text{mA}$ |
| Reverse Current | 0.01 | 10 | | μA $V_R = 3.0\text{V}$ |
| Capacitance | 50 | | | pF $V_R = 0$ |
| Sensor | | | | |
| H_{fe} | | 13K | | $V_{CE} = 5\text{V}$ $I_C = 0.5\text{mA}$ |
| BV_{CEO} | 30/55 | | | V $I_C = 100\mu\text{A}$ $I_F = 0$ |
| BV_{CBO} | 30/55 | | | V $I_C = 10\mu\text{A}$ $I_F = 0$ |
| BV_{EBO} | 8 | | | V $I_E = 1\mu\text{A}$ $I_F = 0$ |
| I_{CEO} | 1.0 | 100 | | nA $V_{CE} = 10\text{V}$ $I_F = 0$ |
| Capacitance | | | | |
| Collector-Emitter | 3.4 | | | pF $V_{CE} = 10\text{V}$ |
| Collector-Base | 10 | | | pF $V_{CB} = 10\text{V}$ |
| Emitter-Base | 10 | | | pF $V_{EB} = 0.5\text{V}$ |
| Coupled Characteristics | | | | |
| Current Transfer Ratio | 100 | 400 | | % $I_F = 10\text{mA}$ $V_{CE} = 5\text{V}$ |
| $V_{CE(SAT)}$ | 0.9 | 1.0 | | V $I_C = 50\text{mA}$ $I_F = 50\text{mA}$ |
| Rise Time | 10 | | | μs $V_{CC} = 13.5\text{V}$ |
| Fall Time | 35 | | | μs $I_F = 50\text{mA}$ $R_C = 100\Omega$ |
| Isolation Voltage | 6000 | | | VDC $t = 1\text{sec.}$ |
| Isolation Resistance | 10^{12} | | | ohm |
| Isolation Capacitance | 0.5 | | | pF |

FIGURE 1. GaAs EMITTER: FORWARD CURRENT - VOLTAGE CHARACTERISTICS

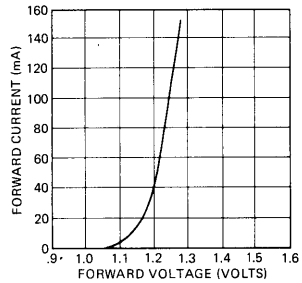


FIGURE 2. DARLINGTON TRANSISTOR OUTPUT CURRENT VS VOLTAGE

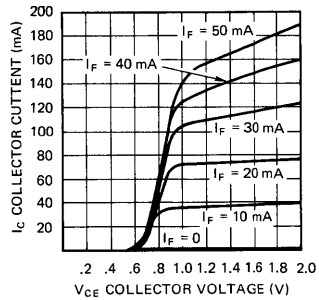


FIGURE 3. DARLINGTON TRANSISTOR CURRENT VS VOLTAGE

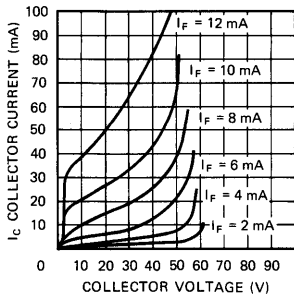
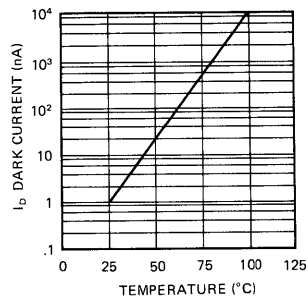
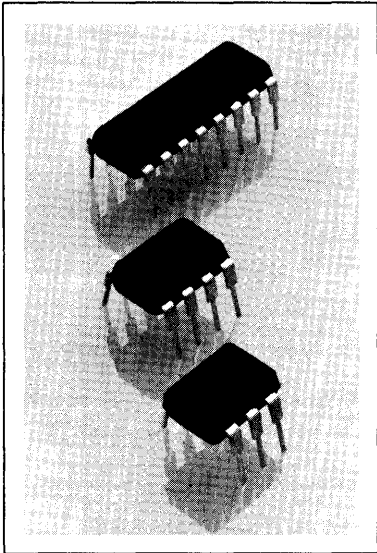


FIGURE 4. DARK CURRENT VS TEMPERATURE



SIEMENS

IL-74 SINGLE CHANNEL ILD-74 DUAL CHANNEL ILQ-74 QUAD CHANNEL PHOTOTRANSISTOR OPTO-ISOLATOR



FEATURES

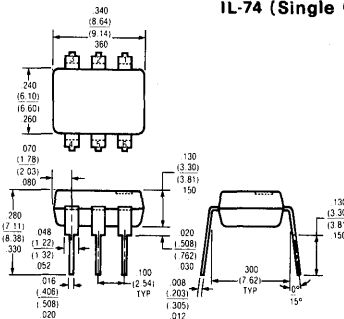
- 7400 Series T²L Compatible
- 6000 Volt Isolation Voltage
- 35% typical transfer ratio
- 0.5 pF coupling capacitance
- Industry standard dual-in-line package
- Single channel, dual, and quad configurations
- Underwriters Lab Approval #E52744

DESCRIPTION

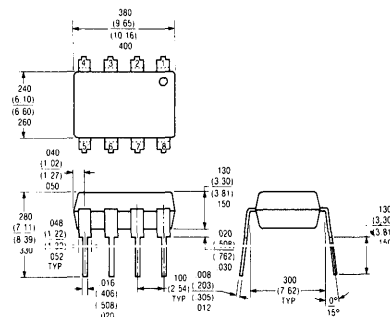
IL-74 is an optically coupled pair employing a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-74 is especially designed for driving medium-speed logic, where it may be used to eliminate troublesome ground loop and noise problems. It can also be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation. The ILD-74 offers two isolated channels in a single DIP package while the ILQ-74 provides four isolated channels per package.

Package Dimensions in Inches (mm)

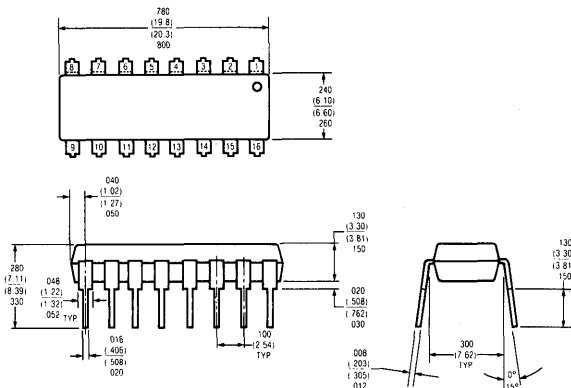
IL-74 (Single Channel)



ILD-74 (Dual Channel)



ILQ-74 (Quad Channel)



Specifications subject to change without notice.

MAXIMUM RATINGS

Gallium Arsenide LED (each channel)

| | |
|----------------------------|------------|
| Power Dissipation @ 25°C | 150 mW |
| Derate Linearly from 25°C | 1.33 mW/°C |
| Continuous Forward Current | 60 mA |
| Peak Inverse Voltage | 3.0V |

Detector-Silicon Phototransistor (each channel)

| | |
|--|-----------|
| Power Dissipation @ 25°C | 150 mW |
| Derate Linearly from 25°C | 2.0 mW/°C |
| Collector-Emitter Breakdown Voltage (BV _{CEO}) | 20V |

Package

Total Package Dissipation at 25°C Ambient (LED Plus Detector)

| | |
|--------|--------|
| 1L-74 | 200 mW |
| 1LD-74 | 400 mW |
| 1LQ-74 | 500 mW |

Derate Linearly From 25°C

| | |
|--------|------------|
| 1L-74 | 3.3 mW/°C |
| 1LD-74 | 5.33 mW/°C |
| 1LQ-74 | 6.67 mW/°C |

| | |
|-----------------------------|-----------------|
| Storage Temperature | -55°C to +150°C |
| Operating Temperature | -55°C to +100°C |
| Lead Soldering Time @ 260°C | 10 sec |

ELECTRICAL CHARACTERISTICS PER CHANNEL (at 25°C Ambient)

| Parameter | Min | Typ | Max | Units | Test Conditions |
|---------------------------------|------|-----|-----|-------|---|
| Gallium Arsenide LED | | | | | |
| Forward Voltage | | 1.3 | 1.5 | V | I _F = 20 mA |
| Reverse Current | | 0.1 | 100 | μA | V _R = 3.0V |
| Capacitance | | 100 | | pF | V _R = 0 |
| Phototransistor Detector | | | | | |
| BV _{CEO} | 20 | 50 | | V | I _C = 1 mA |
| I _{CEO} | | 5.0 | 500 | nA | V _{CE} = 5V, I _F = 0 |
| Collector-Emitter Capacitance | | 2.0 | | pF | V _{CE} = 0 |
| Coupled Characteristics | | | | | |
| DC Current Transfer Ratio | 12.5 | 35 | | % | I _F = 16 mA, V _{CE} = 5V |
| V _{SAT} | | 0.3 | 0.5 | V | I _C = 2 mA, I _F = 16 mA |
| Capacitance, Input to Output | | 0.5 | | pF | |
| Breakdown Voltage | 7500 | | | VDC | |
| Resistance, Input to Output | | 100 | | GΩ | |
| Switching Times | | | | | |
| t _{ON} | | 2 | | μs | R _E = 100 Ω, V _{CE} = 10V |
| t _{OFF} | | 2 | | μs | I _C = 2 mA |

Specifications subject to change without notice.

TYPICAL OPTOELECTRONIC CHARACTERISTIC CURVES FOR EACH CHANNEL

FIGURE 1. RELATIVE OUTPUT OUTPUT VS TEMPERATURE

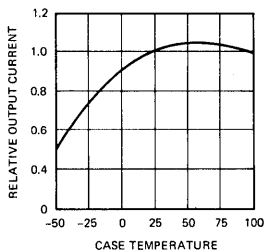


FIGURE 2. DARK CURRENT VS TEMPERATURE

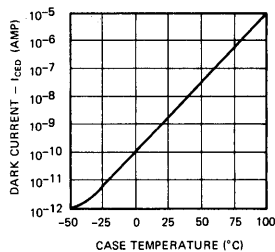


FIGURE 3. TRANSFER CHARACTERISTICS

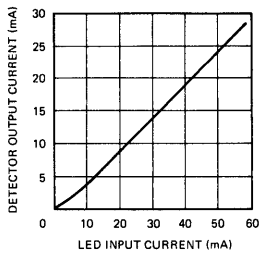


FIGURE 4. DETECTOR OUTPUT CHARACTERISTICS

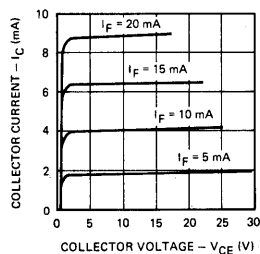
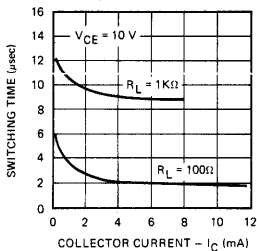


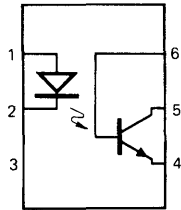
FIGURE 5. SWITCHING TIME VS COLLECTOR CURRENT



PIN CONFIGURATIONS

IL-74

(TOP VIEW)

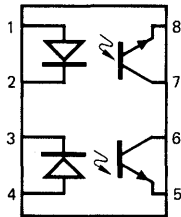


LED CHIP ON PIN 2
PT CHIP ON PIN 5

| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | NC |
| 4 | EMITTER |
| 5 | COLLECTOR |
| 6 | BASE |

ILD-74

(TOP VIEW)

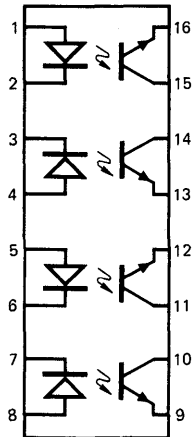


LED CHIPS ON PINS 2 AND 3
PT CHIPS ON PINS 6 AND 7

| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | CATHODE |
| 4 | ANODE |
| 5 | EMITTER |
| 6 | COLLECTOR |
| 7 | COLLECTOR |
| 8 | EMITTER |

ILQ-74

(TOP VIEW)



LED CHIPS ON PINS 2, 3, 6, 7
PT CHIPS ON PINS 10, 11, 14, 15

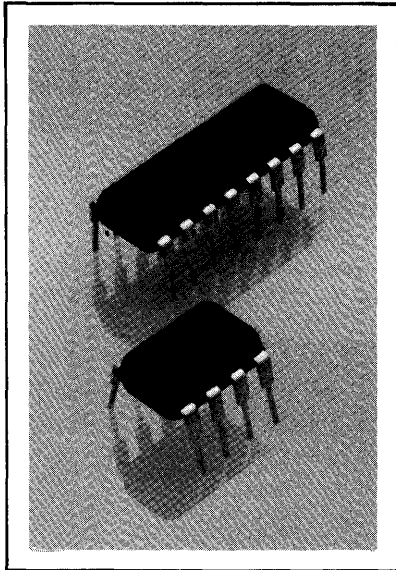
| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | CATHODE |
| 4 | ANODE |
| 5 | ANODE |
| 6 | CATHODE |
| 7 | CATHODE |
| 8 | ANODE |
| 9 | EMITTER |
| 10 | COLLECTOR |
| 11 | COLLECTOR |
| 12 | EMITTER |
| 13 | EMITTER |
| 14 | COLLECTOR |
| 15 | COLLECTOR |
| 16 | EMITTER |

SIEMENS

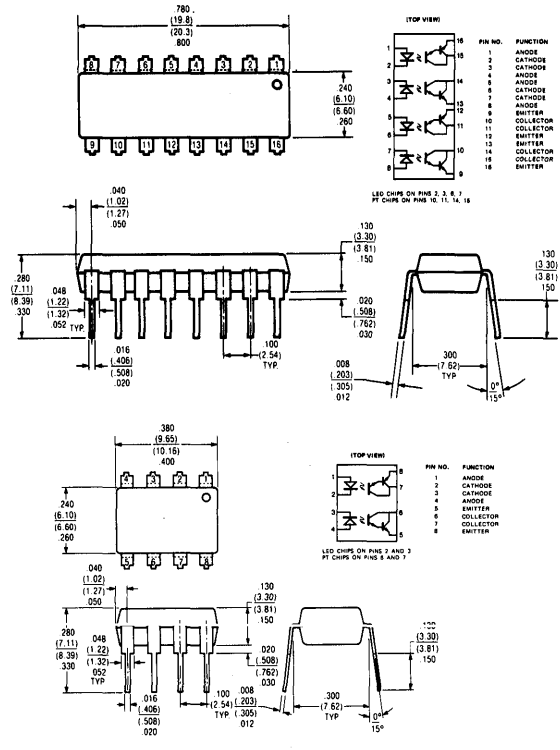
ILD-30, ILD-55 DUAL CHANNEL ILQ-30, ILQ-55 QUAD CHANNEL

PHOTO DARLINGTON OPTO-ISOLATORS

Preliminary



Package Dimensions in Inches (mm)



FEATURES

- 6000 volt isolation voltage
- 125 mA load current rating
- Fast rise time — 10 μ s
- Fast fall time — 35 μ s
- Solid state reliability
- Standard dip package
- Underwriter Lab approval #E52744

DESCRIPTION

The ILD-30/ILD-55 and ILQ-30/ILQ-55 are optically coupled isolators employing a gallium arsenide infrared emitter and a silicon photo darlington sensor. Switching can be accomplished while maintaining a high degree of isolation between driving and load circuits, with no crosstalk between channels. They can be used to replace reed and mercury relays with advantages of long life, high speed switching and elimination of magnetic fields.

Maximum Ratings

| | |
|-------------------------------------|-----------|
| Gallium Arsenide LED (Each Channel) | |
| Power Dissipation at 25 °C | 75 mW |
| Derate Linearly From 25 °C | 1.0 mW/°C |
| Continuous Forward Current | 50 mA |
| Peak Reverse Voltage | 3V |

| | | |
|--|-----------|-----------|
| Photodarlington Sensor (Each Channel) | ILD-30 | ILD-55 |
| | ILQ-30 | ILQ-55 |
| Power Dissipation at 25 °C Ambient | 150 mW | 150 mW |
| Derate Linearly From 25 °C | 2.0 mW/°C | 2.0 mW/°C |
| Collector (load) Current | 125 mA | 125 mA |
| Collector Emitter Breakdown Voltage (BV _{CEO}) | 30V | 55V |

| | |
|-------------------------------|-------------------|
| Package | |
| Storage Temperature | -55 °C to +125 °C |
| Operating Temperature | -55 °C to +100 °C |
| Lead Soldering Time at 260 °C | 10 sec |

| | |
|---|------------|
| Total Package Power Dissipation @ 25 °C | |
| ILD-30/ILD-55 | 400 mW |
| ILQ-30/ILQ-55 | 500 mW |
| Derate Linearly From 25 °C | |
| ILD-30/ILD-55 | 5.33 mW/°C |

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES

| Electrical Characteristics (at 25° Ambient) | | | | Test Condition | |
|---|-------|-----------|-----|----------------|---|
| Parameter | Min | Typ | Max | Unit | Condition |
| GaAs Emitter | | | | | |
| Forward Voltage | | 1.25 | 1.5 | V | $I_F = 20\text{mA}$ |
| Reverse Current | 0.01 | | 10 | μA | $V_R = 3.0\text{V}$ |
| Capacitance | | 50 | | pF | $V_R = 0$ |
| Sensor | | | | | |
| BV_{CEO} | 30/55 | | | V | $I_C = 100\mu\text{A}$ $I_F = 0$ |
| I_{CEO} | | 1.0 | 100 | nA | $V_{CE} = 10\text{V}$ $I_F = 0$ |
| Capacitance | | | | | |
| Collector-Emitter | | 3.4 | | pF | $V_{CE} = 10\text{V}$ |
| Coupled Characteristics | | | | | |
| Current Transfer Ratio | 100 | 400 | | % | $I_F = 10\text{mA}$ $V_{CE} = 5\text{V}$ $I_C = 50\text{mA}$ $I_F = 50\text{mA}$ |
| $V_{CE(SAT)}$ | | 0.9 | 1.0 | V | $V_{CC} = 13.5\text{V}$ $I_F = 50\text{mA}$ $R_C = 100\Omega$ |
| Rise Time | | 10 | | μs | |
| Fall Time | | 35 | | μs | |
| Isolation Voltage | 6000 | | | VDC | $t = 1\text{ sec.}$ |
| Isolation Resistance | | 10^{12} | | ohm | |
| Isolation Capacitance | | 0.5 | | pf | |

FIGURE 1. GaAs EMITTER: FORWARD CURRENT - VOLTAGE CHARACTERISTICS

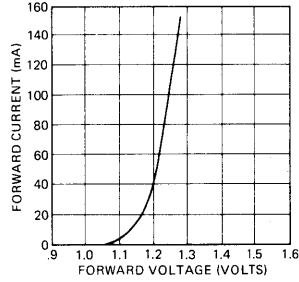


FIGURE 2. DARLINGTON TRANSISTOR OUTPUT CURRENT VS VOLTAGE

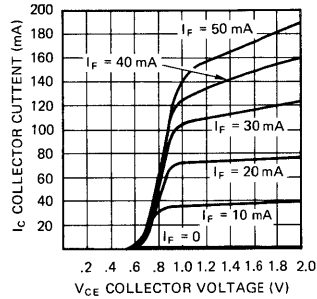


FIGURE 3. DARLINGTON TRANSISTOR CURRENT VS VOLTAGE

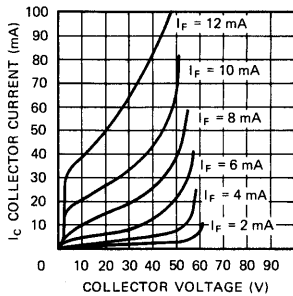
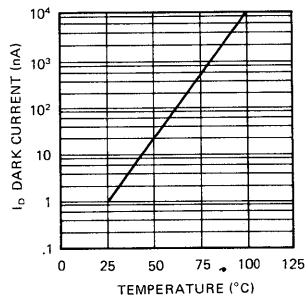


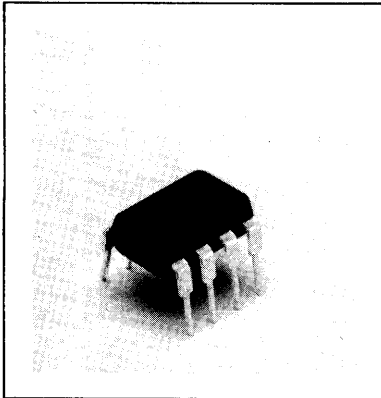
FIGURE 4. DARK CURRENT VS TEMPERATURE



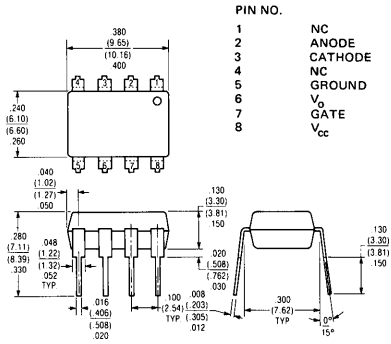
SIEMENS

IL-100

VERY HIGH SPEED THREE STATE OPTO-ISOLATOR



Package Dimensions (inches/mm)



| PIN NO. | FUNCTION |
|---------|-----------------|
| 1 | NC |
| 2 | ANODE |
| 3 | CATHODE |
| 4 | NC |
| 5 | GROUND |
| 6 | V _O |
| 7 | GATE |
| 8 | V _{CC} |

FEATURES

- Very High Speed – 65 n-sec typ. prop. delay
- Faraday Shielded Photodetector for Improved Common Mode Rejection
- DTL/TTL Compatible –5V supply
- Three State Output Logic for Multiplexing
- Built-in Schmitt Trigger to Avoid Oscillation
- Underwriters Lab Approval #E52744

DESCRIPTION

IL-100 is an optically coupled pair employing a Gallium Arsenide Phosphide LED and a silicon monolithic integrated circuit including a photodetector. High speed digital information can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-100 can be used to replace pulse transformers in many digital interface applications. A built-in Schmitt Trigger provides hysteresis to reduce the possibility of oscillation.

Absolute Maximum Ratings

| | |
|---|---|
| Storage Temperature | -55°C to +125°C |
| Operating Temperature | 0°C to +70°C |
| Lead Solder Temperature | 260°C for 10 Sec. |
| Input Diode | |
| Forward DC Current | 10 mA |
| Reverse Voltage | 5V |
| Output - IC | |
| Supply Voltage - V _{CC} | 7V |
| Enable Input Voltage - V _E | 5.5V |
| | (Not to exceed V _{CC} by more than 500 mV) |
| Output Collector Current - I _C | 100 mA |
| Output Collector Power Dissipation | 100 mW |
| Output Collector Voltage - V _{OUT} | 7V |
| Isolation Voltage (Input-Output) | 6000V |

Electrical Characteristics

Over Recommended Temperature (T_A = 0°C – 70°C)

| Parameter | Min. Typ. Max. Units | Test | | Fig. | Note |
|--|----------------------|---------------------------|----|------|------|
| | | Conditions | | | |
| I _{in} (1): Logic (1) Input Current to Ensure | | | | | |
| Logic (0) Output | 5 | | mA | 1, 2 | — |
| I _{in} (0): Logic (0) Input Current to Ensure | | | | | |
| Logic (1) Output | | 250 | μA | 1, 2 | — |
| V _G (1): Logic (1) Gate Voltage | 2.0 | | V | — | — |
| V _G (0): Logic (0) Gate Voltage | | .8 | V | — | — |
| I _{out} (off) | -100μA + 100μA | | | | |
| | | V _{CC} = 5.5V, | | | |
| | | V _O = 1.5V | | | |
| | | V _G = 0V | | | |
| | | I _{in} = 0, 10mA | | | |

Specifications subject to change without notice.

Electrical Characteristics (Continued)
Over Recommended Temperature ($T_A = 0^\circ\text{C} - 70^\circ\text{C}$)

| Parameter | Test | | | Units | Conditions | Fig. | Note |
|---|------|------|------|-------|---|------|------|
| | Min. | Typ. | Max. | | | | |
| $V_{out}(0)$: Logic (0) Output Voltage | .35 | .6 | | V | $V_{CC} = 5.5\text{V}$, $V_G = 2.4\text{V}$, $I_{in} = 5\text{ mA}$, $I_{out}(\text{Sinking}) = 16\text{ mA}$ | — | — |
| $I_G(0)$: Logic (0) Gate Current | -1.6 | -2.0 | | mA | $V_{CC} = 5.5\text{V}$, $V_G = 0.5\text{V}$ | — | — |
| $I_G(1)$: Logic (1) Gate Current | 0 | | | mA | $V_{CC} = 5.5\text{V}$, $V_G = 2.4\text{V}$ | — | — |
| $I_{CC}(1)$: Logic (1) Supply Current | 18 | 22 | | mA | $V_{CC} = 5.5\text{V}$, $V_G = 0.5\text{V}$, $I_{in} = 0$ | — | — |
| $I_{CC}(0)$: Logic (0) Supply Current | 18 | 22 | | mA | $V_{CC} = 5.5\text{V}$, $V_G = 0.5\text{V}$, $I_{in} = 10\text{ mA}$ | — | — |
| I_{CC} | 13 | 16 | | | $V_{CC} = 5.5\text{V}$, $V_G = 2.4\text{V}$, $I_{in} = 0$ | — | — |
| I_{CC} | 17 | 21 | | | $V_{CC} = 5.5\text{V}$, $V_G = 2.4\text{V}$, $I_{in} = 10\text{ mA}$ | — | — |

Switching Characteristics at $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$

| Parameter | Test | | | Units | Conditions | Fig. | Note |
|---|------|------|------|-------|---|------|------|
| | Min. | Typ. | Max. | | | | |
| $t_{pd}(1)$: Propagation Delay Time to Logical (1) Level | 65 | 75 | | ns | $R_L = 350\Omega$, $C_L = 15\text{ pF}$, $I_{in} = 7.5\text{ mA}$ | — | 1 |
| $t_{pd}(0)$: Propagation Delay Time to Logical (0) Level | 65 | 75 | | ns | $R_L = 350\Omega$, $C_L = 15\text{ pF}$, $I_{in} = 7.5\text{ mA}$ | — | 2 |
| t_{R-F} : Output Rise-Fall Time (10-90%) | 15 | | | ns | $R_L = 350\Omega$, $C_L = 15\text{ pF}$, $I_{in} = 7.5\text{ mA}$ | — | — |
| $t_G(1)$: Propagation Delay Time of Gate from $V_G(1)$ to $V_G(0)$ | 15 | | | ns | $R_L = 350\Omega$, $C_L = 15\text{ pF}$, $I_{in} = 7.5\text{ mA}$, $V_G(1) = 2\text{V}$, $V_G(0) = 0.5\text{V}$ | — | 3 |
| $t_G(0)$: Propagation Delay Time of Gate from $V_G(0)$ to $V_G(1)$ | 15 | | | ns | $R_L = 350\Omega$, $C_L = 15\text{ pF}$, $I_{in} = 7.5\text{ mA}$, $V_G(1) = 2\text{V}$, $V_G(0) = 0.5\text{V}$ | — | 4 |

Electrical Characteristics—Input-Output at $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Test | | | Units | Conditions | Fig. | Note |
|--|------------|------------------|------|------|----------|--|------|------|
| | | Min. | Typ. | Max. | | | | |
| Insulation Voltage (Input-Output) | BV_{I-0} | 6000 | 7500 | | VDC | $t = 1\text{ Sec.}$ | — | 5 |
| Resistance (Input-Output) | R_{I-0} | 10 ¹² | | | Ω | $V_{I-0} = 500\text{V}$ | — | 5 |
| Capacitance (Input-Output) | C_{I-0} | 0.5 | 0.8 | | pF | $f = 1\text{ MHz}$ | — | 5 |
| Common Mode Rejection Voltage to Logical (0) Level | CMRV (1) | 60 | | | VAC p-p | $f = 10\text{ MHz}$, $R_L = 350\Omega$, $V_{out}(\text{min.}) = 2\text{V}$, $I_{in} = 0\text{ mA}$ | — | 6 |
| Common Mode Rejection Voltage to Logical (1) Level | CMRV (0) | 60 | | | VAC p-p | $f = 10\text{ MHz}$, $R_L = 350\Omega$, $V_{out}(\text{max.}) = 0.6\text{V}$, $I_{in} = 7.5\text{ mA}$ | — | 6 |
| Current Transfer Ratio | CTR | 1000 | | | % | $I_{in} = 5.0\text{ mA}$, $V_{CC} = 5\text{V}$, $R_L = 100\Omega$ | — | 7 |

Electrical Characteristics—Input Diode at $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Test | | | Units | Conditions | Fig. | Note |
|----------------------------|----------|------|------|------|-------|---------------------------------|------|------|
| | | Min. | Typ. | Max. | | | | |
| Forward Voltage | V_F | 1.2 | 1.5 | 1.75 | V | $I_{in} = 10\text{ mA}$ | 1 | 8 |
| Reverse Break-down Voltage | V_{BR} | 5 | | | V | $I_R = 10\mu\text{A}$ | — | — |
| Capacitance | C_{in} | 25 | | | pF | $V = 0$, $f = 1\text{ MHz}$ | — | — |

Operating Procedures and Definitions

Logic Convention. The 1L-100 is defined in terms of positive logic.

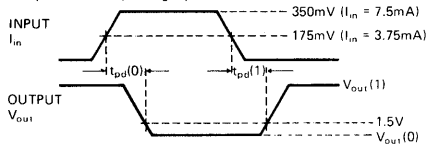
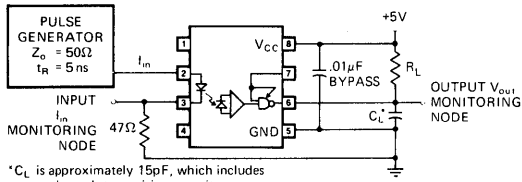
Bypassing. A ceramic capacitor (.01 μF min.) should be connected from pin 8 to pin 5. Its purpose is to stabilize the operation of the switching amplifier. Failure to provide the bypassing may impair the switching properties.

Polarities. All voltages are referenced to network ground (pin 5). Current flowing toward a terminal is considered positive.

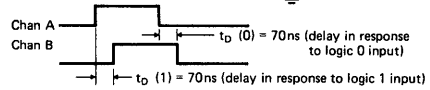
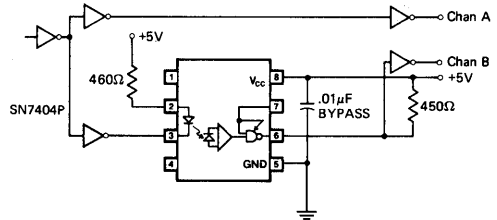
Gate Input. No external pull-up required for a logic (1).

NOTES:

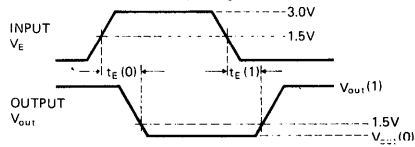
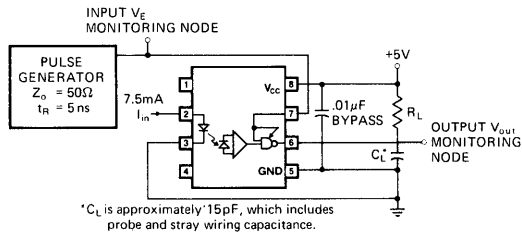
- The $t_{pd}(1)$ propagation delay is measured from the 3.75 mA point on the trailing edge of the input pulse to the 1.5V point on the trailing edge of the output pulse.
- The $t_{pd}(0)$ propagation delay is measured from the 3.75 mA point on the input pulse to the 1.5V point on the leading edge of the output pulse.
- The $t_G(1)$ gate propagation delay is measured from the 1.5V point of the trailing edge of the input pulse to the 1.5V point on the trailing edge of the output pulse.
- The $t_G(0)$ gate propagation delay is measured from the 1.5V point on the input pulse to the 1.5V point on the leading edge of the output pulse. The input diode is DC biased to 10 mA ($I_{in}(1)$).
- Pins 2 and 3 shorted together, and pins 5, 6, 7, and 8 shorted together.
- CMRV (1) is the maximum tolerable common mode voltage to assure that the output will remain in a logic (1) state ($V_{out} > 2.0\text{V}$). CMRV (0) is the maximum tolerable common mode voltage to assure that the output will remain in a logic (0) state ($V_{out} < 0.6\text{V}$).
- DC Current Transfer Ratio is defined as the ratio of the output collector current to the forward bias input current times 100%.
- At 10 mA V_F decreases with increasing temperature at the rate of 1.6mV/ $^\circ\text{C}$.



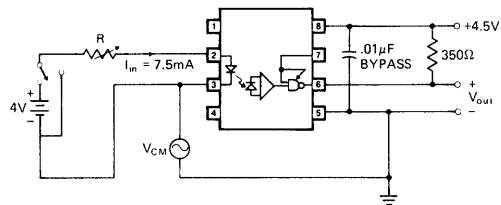
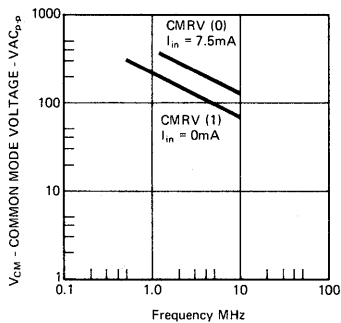
Test Circuit for $t_{pd}(0)$ and $t_{pd}(1)$.



Response Delay Between TTL Gates.



Test Circuit for $t_E(0)$ and $t_E(1)$.



Typical Common Mode Rejection Characteristics/Circuit

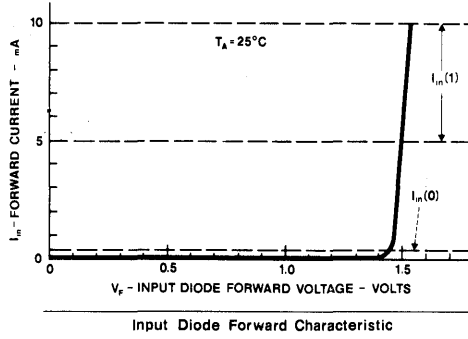
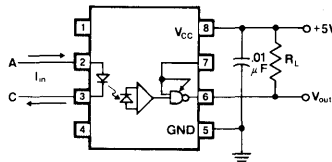
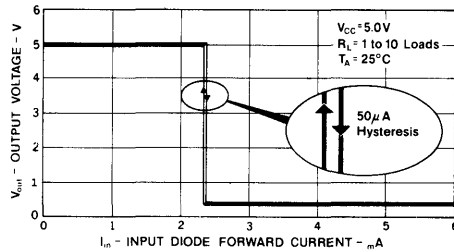


Figure 1

TRUTH TABLE (Positive Logic)

| Input* | Enable | Output |
|--------|--------|--------|
| 1 | 1 | 0 |
| 0 | 1 | 1 |
| 1 | 0 | off |
| 0 | 0 | off |

*See definition of terms for logic state.



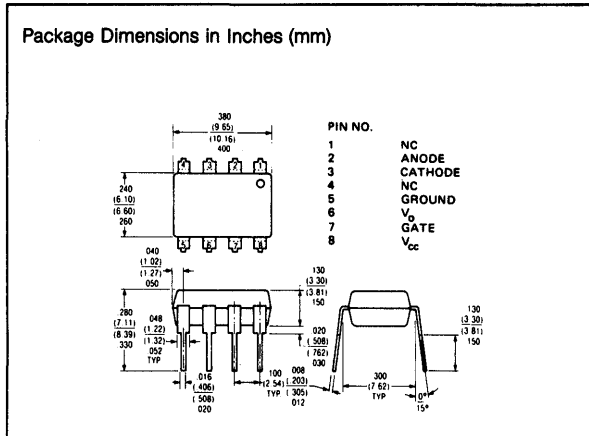
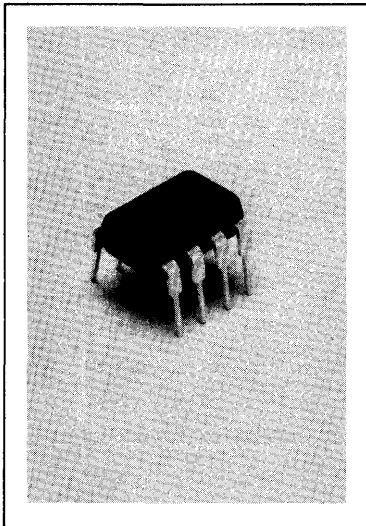
Input-Output Characteristics

Figure 2

SIEMENS

IL-101

HIGH SPEED THREE STATE OPTO-ISOLATOR



FEATURES

- High Speed
- Faraday Shielded Photodetector for Improved Common Mode Rejection
- DTL/TTL Compatible -5V supply
- Three State Output Logic for Multiplexing
- Built-in Schmitt Trigger to Avoid Oscillation
- Underwriters Lab Approval #E52744

DESCRIPTION

IL-101 is an optically coupled pair employing a Gallium Arsenide Phosphide LED and a silicon monolithic integrated circuit including a photodetector. High speed digital information can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-101 can be used to replace pulse transformers in many digital interface applications. A built-in Schmitt Trigger provides hysteresis to reduce the possibility of oscillation.

Absolute Maximum Ratings

| | |
|---------------------------------------|--|
| Storage Temperature | -55°C to +125°C |
| Operating Temperature | 0°C to +70°C |
| Lead Solder Temperature | 260°C for 10 Sec. |
| Input Diode | |
| Forward DC Current | 10 mA |
| Reverse Voltage | 5V |
| Output - IC | |
| Supply Voltage - V_{CC} | 7V |
| Enable Input Voltage - V_E | 5.5V |
| | (Not to exceed V_{CC} by more than 500 mV) |
| Output Collector Current - i_C | 100 mA |
| Output Collector Power Dissipation | 100 mW |
| Output Collector Voltage - V_{OUT} | 7V |
| Isolation Voltage (Input-Output) - DC | 6000V |

Electrical Characteristics

Over Recommended Temperature ($T_A = 0^\circ\text{C} - 70^\circ\text{C}$)

| Parameter | Min. | Typ. | Max. | Units | Test | | | |
|---|------|------|------|---------------|---|------|------|--|
| | | | | | Conditions | Fig. | Note | |
| I_{in} (1): Logic (1) Input Current to Ensure | | | | | | | | |
| Logic (0) Output | 5 | | | mA | | 1 | - | |
| I_{in} (0): Logic (0) Input Current to Ensure | | | | | | | | |
| Logic (1) Output | | | 250 | μA | | 1 | - | |
| V_G (1): Logic (1) Gate Voltage | 2.0 | | | V | | - | - | |
| V_G (0): Logic (0) Gate Voltage | | | .8 | V | | - | - | |
| V_{out} (0): Logic (0) Output Voltage | .35 | .6 | | V | $V_{CC} = 5.5V$, $V_G = 2.4V$, $I_{in} = 5\text{ mA}$, I_{out} (Sinking) = 16 mA | - | - | |
| I_{CC} | 18 | 22 | | mA | $V_{CC} = 5.5V$ $V_G = 0.5V$ $I_{in} = 0, 10\text{ mA}$ | | | |

Specifications are subject to change without notice.

Switching Characteristics at $T_A = 25^\circ$, $V_{CC} = 5V$

| Parameter | Min. | Typ. | Max. | Test | | Fig. | Note |
|---|------|------|------|-------|---|------|------|
| | | | | Units | Conditions | | |
| $t_{pd}(1)$: Propagation Delay Time to Logical (1) Level | 175 | 300 | | ns | $R_L = 350\Omega$, $C_L = 15pF$, $I_{in} = 7.5mA$ | 1 | 1 |
| $t_{pd}(0)$: Propagation Delay Time to Logical (0) Level | 70 | 100 | | ns | $R_L = 350\Omega$, $C_L = 15pF$, $I_{in} = 7.5mA$ | 1 | 2 |
| t_{R-F} : Output Rise-Fall Time (10-90%) | 15 | | | ns | $R_L = 350\Omega$, $C_L = 15pF$, $I_{in} = 7.5mA$ | - | - |

Electrical Characteristics—Input-Output at $T_A = 25^\circ C$

| Parameter | Symbol | Min. | Typ. | Max. | Test | | Fig. | Note |
|-----------------------------------|------------|-----------|------|------|----------|------------------|------|------|
| | | | | | Units | Conditions | | |
| Insulation Voltage (Input-Output) | BV_{1-0} | 6000 | 7500 | | VDC | $t = 1$ Sec. | - | 3 |
| Resistance (Input-Output) | R_{1-0} | 10^{12} | | | Ω | $V_{1-0} = 500V$ | - | 3 |
| Capacitance (Input-Output) | C_{1-0} | 0.5 | 0.8 | | pF | $f = 1MHz$ | - | 3 |

Electrical Characteristics—Input Diode at $T_A = 25^\circ C$

| Parameter | Symbol | Min. | Typ. | Max. | Test | | Fig. | Note |
|---------------------------|----------|------|------|------|-------|-------------------------|------|------|
| | | | | | Units | Conditions | | |
| Forward Voltage | V_F | 1.5 | 1.75 | | V | $I_{in} = 10mA$ | - | 4 |
| Reverse Breakdown Voltage | V_{BR} | 5 | | | V | $I_R = 10\mu A$ | - | - |
| Capacitance | C_{in} | 10 | | | pF | $V = 0$, $f = 1MHz$ | - | - |

Operating Procedures and Definitions

Logic Convention. The 1L-101 is defined in terms of positive logic.

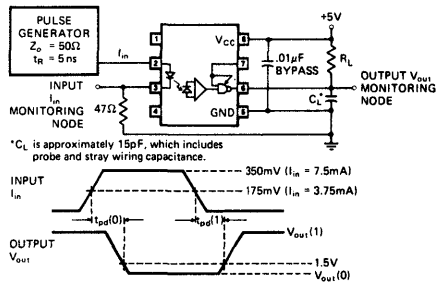
Bypassing. A ceramic capacitor (.01 μF min.) should be connected from pin 8 to pin 5. Its purpose is to stabilize the operation of the switching amplifier. Failure to provide the bypassing may impair the switching properties.

Polarities. All voltages are referenced to network ground (pin 5). Current flowing toward a terminal is considered positive.

Gate Input. No external pull-up required for a logic (1).

NOTES:

- The $t_{pd}(1)$ propagation delay is measured from the 3.75 mA point on the trailing edge of the input pulse to the 1.5V point on the trailing edge of the output pulse.
- The $t_{pd}(0)$ propagation delay is measured from the 3.75 mA point on the input pulse to the 1.5V point on the leading edge of the output pulse.
- Pins 2 and 3 shorted together, and pins 5, 6, 7, and 8 shorted together.
- At 10 mA V_F decreases with increasing temperature at the rate of 1.6mV/ $^\circ C$.



Test Circuit for $t_{pd}(0)$ and $t_{pd}(1)$.

Fig. 1

TRUTH TABLE (Positive Logic)

| Input* | Enable | Output |
|--------|--------|--------|
| 1 | 1 | 0 |
| 0 | 1 | 1 |
| 1 | 0 | off |
| 0 | 0 | off |

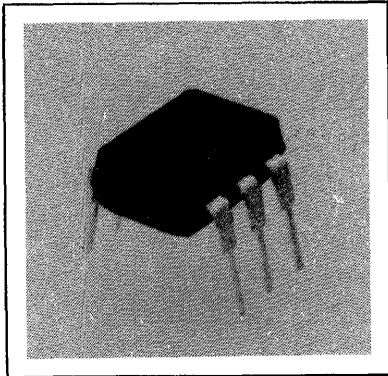
*See definition of terms for logic state.

For further details refer to pages 3 & 4 of 1L-100 data sheet.

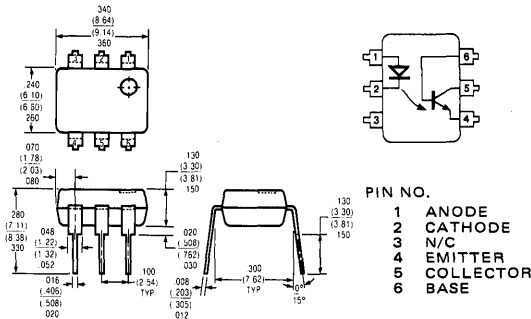
SIEMENS

IL-201, IL-202, IL-203

PHOTOTRANSISTOR OPTO-ISOLATOR



Package Dimensions in Inches (mm)



FEATURES

- 6000 Volt Isolation Voltage
- High Current Transfer-Ratio (75%-450%)
- Long Term Stability
- Industry Standard Dual-In-Line
- Min 10% Current-Transfer-Ratio
Guaranteed @ $I_F = 1 \text{ mA}$
- Underwriters Lab Approval #E52744

DESCRIPTION

IL-201, IL-202, IL-203 are optically coupled pairs employing a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-201, IL-202, IL-203 can be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

Maximum Ratings

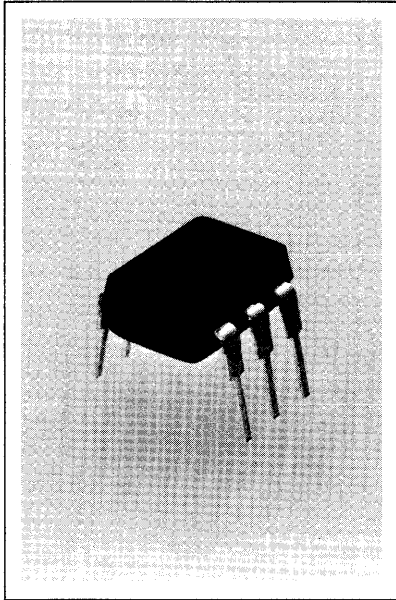
| | |
|--|---------------|
| Gallium Arsenide LED | |
| Power Dissipation @ 25°C | .200 mW |
| Derate Linearly from 25°C | 2.6 mW/°C |
| Continuous Forward Current | 100 mA |
| Peak Inverse Voltage | 6.0 V |
| Detector (Silicon Phototransistor) | |
| Power Dissipation @ 25°C | .200 mW |
| Derate Linearly From 25°C | 2.6 mW/°C |
| Collector-Emitter Breakdown Voltage (BV _{CEO}) | .30 V |
| Emitter-Collector Breakdown Voltage (BV _{EEO}) | 7 V |
| Collector-Base Breakdown Voltage (BV _{CBO}) | .70 V |
| Package | |
| Total Package Dissipation at 25°C Ambient (LED Plus Detector) | .250 mW |
| Derate Linearly From 25°C | 3.3 mW/°C |
| Storage Temperature | -55 to +150°C |
| Operating Temperature | -55 to +100°C |
| Lead Soldering Time @ 260°C | 10 sec |

Electrical Characteristics (0°C - 70°C unless otherwise specified)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|----------------------------------|------|------|-----|------|--|
| Gallium Arsenide LED | | | | | |
| Forward Voltage V _F | | 1.2 | 1.5 | V | I _F = 20 mA |
| Forward Voltage V _F | | 1.0 | 1.2 | V | I _F = 1 mA |
| Reverse Current I _R | | 0.01 | 10 | μA | V _R = 6 V T _A = 25°C |
| Breakdown Voltage V _R | 6 | 20 | | V | I _R = 10 μA |
| Phototransistor Detector | | | | | |
| H _{FE} | 100 | 200 | | | V _{CE} = 5V, I _C = 100 μA |
| BV _{CEO} | 30 | 50 | | V | I _C = 1 mA |
| BV _{EEO} | 7 | 10 | | V | I _E = 100 μA |
| BV _{CBO} | 70 | 90 | | V | I _C = 10 μA |
| I _{CEO} | | 5 | 50 | NA | V _{CE} = 10 V, T _A = 25°C |
| Coupled Characteristics | | | | | |
| Base Current | | | | | |
| Transfer Ratio (BTR) | 0.15 | | | % | I _F = 10 mA V _{CB} = 10 V |
| V _{CE (sat)} | | | 0.4 | V | I _F = 10 mA I _C = 2 mA |
| DC Current Transfer Ratio (CTR) | | | | | |
| IL-201 | 75 | 100 | 150 | % | I _F = 10 mA |
| IL-202 | 125 | 200 | 250 | % | V _{CE} = 10 V |
| IL-203 | 225 | 300 | 450 | % | |
| DC Current Transfer Ratio (CTR) | | | | | |
| IL-201 | 10 | | | % | I _F = 1 mA |
| IL-202 | 30 | | | % | V _{CE} = 10 V |
| IL-203 | 50 | | | % | |
| Input to Output | | | | | |
| Isolation Voltage | 7500 | | | VDC | |

Specifications subject to change without notice.

BIDIRECTIONAL INPUT OPTO-ISOLATOR



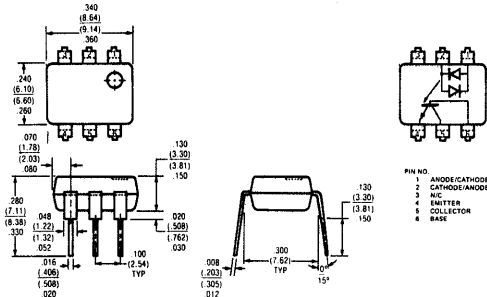
FEATURES

- AC or Polarity Insensitive Input
- 5000 Volt Breakdown Voltage
- High Current-Transfer-Ratio (>50% min.)
- Industry Standard Dual-In-Line
- Built-in Reverse Polarity Input Protection
- Underwriters Lab Approval #E52744

DESCRIPTION

The IL250 is a bidirectional input opto-isolator. It consists of two gallium arsenide infrared emitting diodes coupled to a silicon NPN phototransistor in a 6 pin dual in-line plastic package.

Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|--|-----------|
| Gallium Arsenide LED | |
| Power Dissipation @ 25°C | 200 mW |
| Derate Linearly from 25°C | 2.6 mW/°C |
| Continuous Forward Current | 100 mA |
| Peak Inverse Voltage | 3.0 V |
| Detector (Silicon Phototransistor) | |
| Power Dissipation @ 25°C | 200 mW |
| Derate Linearly From 25°C | 2.6 mW/°C |
| Collector-Emitter Breakdown Voltage (BV _{CEO}) | 30 V |
| Emitter-Base Breakdown Voltage (BV _{ECO}) | 5 V |
| Collector-Base Breakdown Voltage (BV _{CBO}) | 70 V |

Package

| | |
|--|---------------|
| Total Package Dissipation at 25°C Ambient (LED Plus Detector) | |
| | 250 mW |
| Derate Linearly From 25°C | 3.3 mW/°C |
| Storage Temperature | -55 to +150°C |
| Operating Temperature | -55 to +100°C |
| Lead Soldering Time @ 260°C | 10 sec |

Electrical Characteristics (25°C unless otherwise specified)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|--|------|-----|-----|------|--|
| Gallium Arsenide LED | | | | | |
| Forward Voltage V _F | | 1.2 | 1.5 | V | I _F = ± 10 mA |
| Phototransistor Detector | | | | | |
| H _{FE} | 100 | 200 | | | V _{CE} = 5V I _C = 100 μA |
| BV _{CEO} | 30 | 50 | | V | I _C = 1 mA |
| BV _{ECO} | 7 | 10 | | V | I _C = 100 μA |
| BV _{CBO} | 70 | 90 | | V | I _C = 10 μA |
| I _{CEO} | | 5 | 50 | nA | V _{CE} = 10 V |
| Coupled Characteristics | | | | | |
| V _{CE(set)} | | | 0.4 | V | I _F = ± 16 mA I _C = 2 mA |
| DC Current Transfer Ratio (CTR) | | | | | |
| | 50 | 150 | | % | I _F = ± 10 mA V _{CE} = 10 V |
| Symmetry | | | | | |
| CTR @ +10 mA | | | | | |
| CTR @ -10 mA | 0.33 | 1.0 | 3.0 | | |
| Input to Output | | | | | |
| Isolation Voltage | 5000 | | | V | D.C. |

TYPICAL OPTO-ISOLATOR CHARACTERISTIC CURVES

FIGURE 1. INPUT CHARACTERISTICS

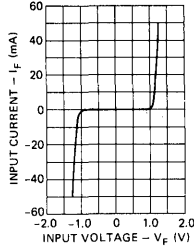


FIGURE 2. TRANSFER CHARACTERISTICS

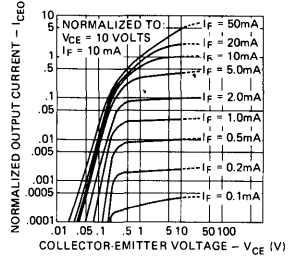


FIGURE 3. OUTPUT VS. INPUT CURRENT

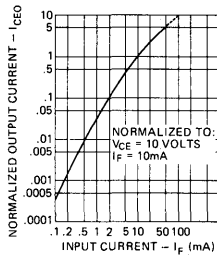


FIGURE 4. OUTPUT CHARACTERISTICS

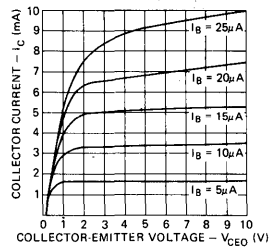


FIGURE 5. DARK CURRENT VS. TEMPERATURE

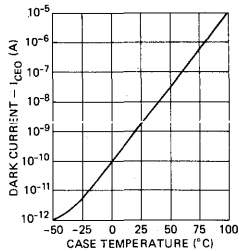
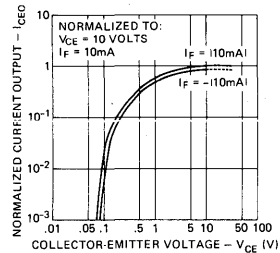
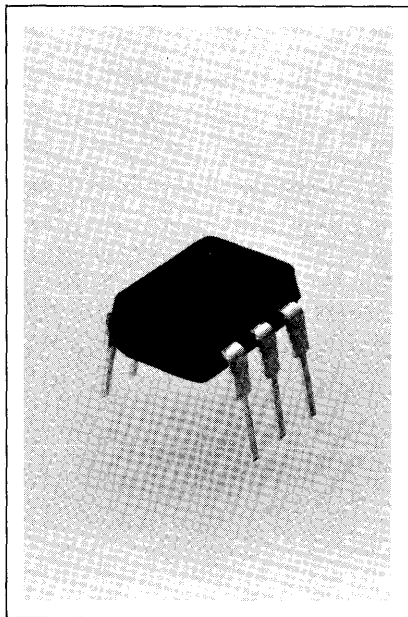


FIGURE 6. SYMMETRY CHARACTERISTICS



AC INPUT OPTO-ISOLATOR



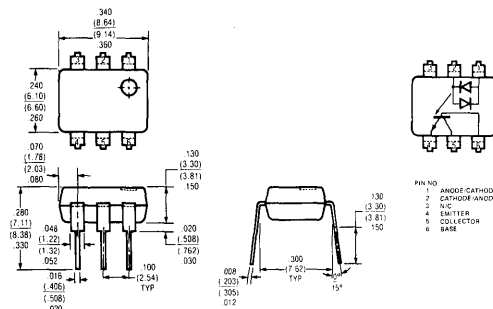
FEATURES

- 1500 Volt Isolation Voltage
- AC or Polarity Insensitive Input
- High Current Transfer Ratio (20% min.)
- Built-in Reverse Polarity Input Protection
- I/O compatible with integrated circuits
- Underwriters Lab Approval #E52744

DESCRIPTION

The IL-251 is a direct electrical and mechanical replacement of the General Electric series. This bi-directional input optoisolator consists of two gallium arsenide infrared emitting diodes connected in inverse parallel coupled to a silicon NPN phototransistor in a 6 pin dual in-line plastic package.

Package Dimensions in Inches (mm)



Maximum Ratings

- Gallium Arsenide LED**
- Power Dissipation @ 25°C 100 mW
 - Derate Linearly from 25°C 1.33 mW/°C
 - Continuous Forward Current (RMS) 60 mA
- Detector (Silicon Phototransistor)**
- Power Dissipation @ 25°C 300 mW
 - Derate Linearly From 25°C 4.0 mW/°C
 - Collector-Emitter Breakdown Voltage (BV_{CEO}) 30 V
 - Emitter-Base Breakdown Voltage (BV_{EBO}) 5 V
 - Collector-Base Breakdown Voltage (BV_{CBO}) 70 V

Package

- Storage Temperature -55 to +150°C
- Operating Temperature -55 to +100°C
- Lead Soldering Time @ 260°C 10.0 sec

Electrical Characteristics (25°C unless otherwise specified)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|----------------------------------|------|------|-----|------|---|
| Gallium Arsenide LED | | | | | |
| Forward Voltage V _F | — | 1.2 | 1.5 | V | I _F = ± 10 mA |
| Phototransistor Detector | | | | | |
| BV _{CEO} | 30 | 50 | — | V | I _C = 10 mA |
| BV _{EBO} | 5 | 9 | — | V | I _E = 100 μA |
| BV _{CBO} | 70 | 90 | — | V | I _C = 100 μA |
| I _{CEO} | — | 5 | 100 | nA | V _{CE} = 10 V |
| Coupled Characteristics | | | | | |
| V _{CE(set)} | — | 0.2 | 0.4 | V | I _F = ± 10 mA I _C = 0.5 mA |
| DC Current Transfer Ratio | | | | | |
| CTR | 20 | 80 | — | % | I _F = ± 10 mA V _{CE} = 10 V |
| Symmetry | | | | | |
| CTR @ + 10 mA | 0.33 | 1.0 | 3.0 | — | |
| CTR @ - 10 mA | | | | | |
| Input to Output | | | | | |
| Isolation Voltage | 1500 | 4000 | — | V | D.C. |

Specifications subject to change without notice.

TYPICAL OPTO-ISOLATOR CHARACTERISTIC CURVES

FIGURE 1. INPUT CHARACTERISTICS

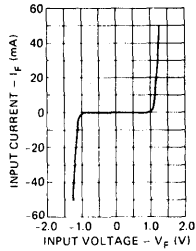


FIGURE 2. TRANSFER CHARACTERISTICS

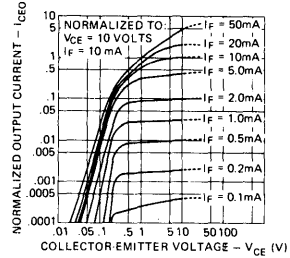


FIGURE 3. OUTPUT VS. INPUT CURRENT

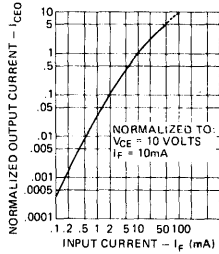


FIGURE 4. OUTPUT CHARACTERISTICS

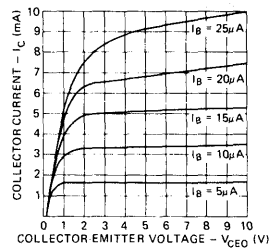


FIGURE 5. DARK CURRENT VS. TEMPERATURE

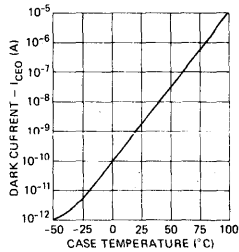
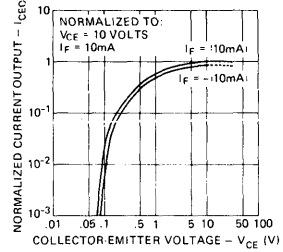
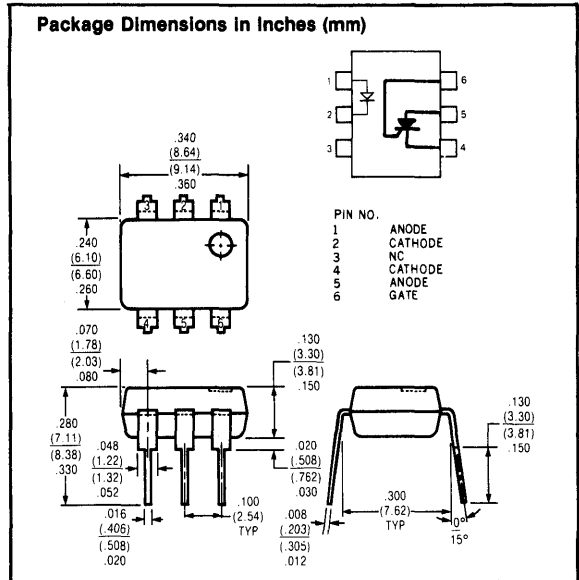
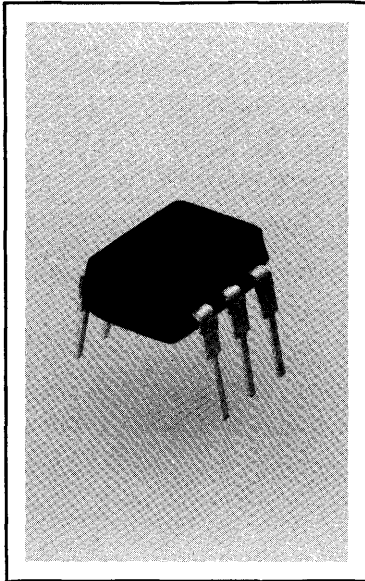


FIGURE 6. SYMMETRY CHARACTERISTICS



ADVANCE DATA SHEET



FEATURES:

- 400 volts blocking voltage
- Turn on current (I_{ft}) 5.0mA typical
- Gate trigger current (I_{GT}) — 20 μ A
- Gate trigger voltage (t_{GT}) — 0.6 volt
- 6000 volt isolation voltage
- Surge anode current — 1.0 amp
- Solid state reliability
- Standard dip package
- Underwriters Lab Approval #E52744

DESCRIPTION:

The IL-400 is an optically coupled SCR employing a GaAs infrared emitter and a silicon photo SCR sensor. Switching can be accomplished while maintaining a high degree of isolation between triggering and load circuits. It can be used in SCR triac and solid state relay applications where high blocking voltages and low input current sensitivity is required.

Maximum Ratings

Gallium Arsenide LED (Drive Circuit)

| | |
|---|-----------|
| Power dissipation @ 25°C | 100mW |
| Derate linearly from 25°C | 1.05mW/°C |
| Continuous forward current | 60mA |
| Peak reverse voltage | 6v |
| Peak forward current (100 μ s, 1% duty cycle) | 1.0A |

SCR Detector (Load circuit):

| | |
|--|-----------|
| Power dissipation @ 25°C ambient | 200mW |
| Derate linearly from 25°C | 2.11mW/°C |
| Anode current | 100mA |
| Surge anode current (5ms duration) | 1.0A |
| Surge gate current (5ms duration) | 200mA |
| Reverse gate voltage | 6.0v |
| Anode voltage (DC or AC peak) | 400v |

Coupled:

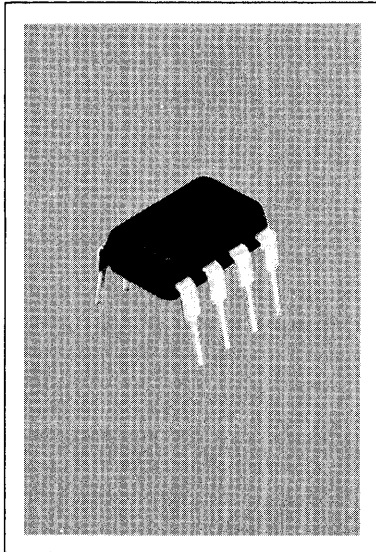
| | |
|---------------------------------------|----------------|
| Isolation voltage | 6000vDC |
| Total package power dissipation | 250mW |
| Derate linearly from 25°C | 2.63mW/°C |
| Operating temperature range | -55°C to 100°C |
| Storage temperature range | -55°C to 100°C |

Specifications subject to change without notice

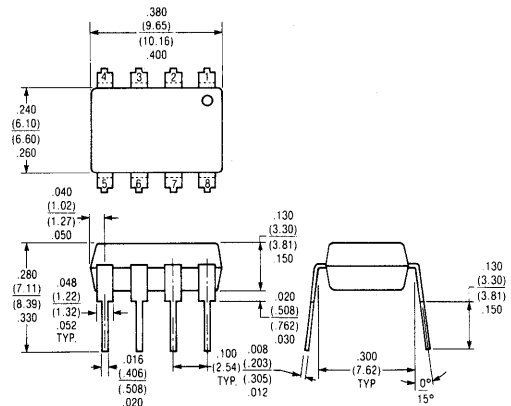
Electrical Characteristics (at 25°C Ambient)

| Parameter | Min | Typ | Max | Unit | Test Condition |
|---|------|-----|------|---------------|---|
| Input Diode | | | | | |
| Forward Voltage | | 1.2 | 1.5 | V | $I_F = 20\text{mA}$ |
| Reverse Voltage | 5.0 | | | V | $I_R = 10\mu\text{A}$ |
| Reverse Current | | | 10 | μA | $V_R = 5\text{v}$ |
| Photo — SCR | | | | | |
| Forward Leakage Current (I_D) | | 0.2 | 2.0 | μA | $R_{GK} = 27\text{Kohm}$, $I_F = 0$ $V_{RX} = 400\text{v}$, $T_A = 25^\circ\text{C}$ |
| Reverse Leakage Current (I_R) | | 0.2 | 2.0 | μA | $R_{GK} = 27\text{Kohm}$, $I_F = 0$ $V_{RX} = 400\text{v}$, $T_A = 25^\circ\text{C}$ |
| Forward Blocking Voltage (V_{DM}) | 400 | | | V | $R_{GK} = 10\text{Kohm}$, $T_A = 100^\circ\text{C}$ $I_d = 150\mu\text{A}$ |
| Reverse Blocking Voltage (V_{RM}) | 400 | | | V | $R_{GK} = 10\text{Kohm}$, $T_A = 100^\circ\text{C}$ $I_d = 150\mu\text{A}$ |
| On Voltage (V_t) | - | - | 1.2 | V | $I_T = 100\text{mA}$ |
| Holding Current (I_H) | - | - | 500 | μA | $R_{GK} = 27\text{Kohm}$ $V_{FX} = 50\text{v}$ |
| Gate Trigger Voltage (V_{GT}) | - | 0.6 | 1.0 | V | $V_{FX} = 100\text{v}$ $R_{GK} = 27\text{Kohm}$ $R_L = 10\text{Kohm}$ |
| Gate Trigger Current (I_{GT}) | | 20 | 50 | μA | $V_{FX} = 100\text{v}$ $R_L = 10\text{Kohm}$ $R_{GK} = 27\text{Kohm}$ |
| Coupled | | | | | |
| Turn-on Current (I_{FT}) | 0.5 | 5.0 | 10.0 | mA | $V_{FX} = 100\text{v}$ $R_{GK} = 27\text{Kohm}$ |
| Isolation Voltage | 6000 | | | V_{DC} | 1 second |
| Isolation Resistance | 100 | | | G-ohm | $V_{iso} = 500\text{v}$ |
| Isolation Capacitance | | | 2 | PF | $f = 1\text{MHz}$ |

DUAL PHOTOTRANSISTOR OPTO-ISOLATOR



Package Dimensions in Inches (mm)



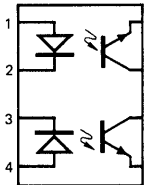
FEATURES

- Two Isolated Channels Per Package
- 6000V Isolation
- 50% Typical Current Transfer Ratio
- 1 nA Typical Leakage Current
- Direct Replacement For MCT6
- Underwriter Lab Approval #E52744

DESCRIPTION

The IL-CT6 is a two channel opto isolator for high density applications. Each channel consists of an optically coupled pair employing a Gallium Arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output. The IL-CT6 is especially designed for driving medium-speed logic, where it may be used to eliminate troublesome ground loop and noise problems. It can also be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

Pin Configuration



LED CHIPS ON PINS 2 AND 3
PT CHIPS ON PINS 6 AND 7

| PIN NO. | FUNCTION |
|---------|-----------|
| 1 | ANODE |
| 2 | CATHODE |
| 3 | CATHODE |
| 4 | ANODE |
| 5 | EMITTER |
| 6 | COLLECTOR |
| 7 | COLLECTOR |
| 8 | EMITTER |

MAXIMUM RATINGS

| | |
|---|-----------------|
| Maximum Temperatures | |
| Storage Temperature | -55°C to +150°C |
| Operating Temperature | -55°C to +100°C |
| Lead Temperature (Soldering, 10 seconds) | 260°C |
| Input Diode (each channel) | |
| Rated Forward Current, DC | 60 mA |
| Peak Forward Current (1 μ s pulse, 300 pps) | 3 A |
| Power Dissipation at 25°C Ambient | 100 mW |
| Derate Linearly From 25°C | 1.3 mW/°C |
| Output Transistor (each channel) | |
| Power Dissipation @ 25°C Ambient | 150 mW |
| Derate Linearly From 25°C | 2 mW/°C |
| Collector Current | 30 mA |
| Coupled | |
| Input to Output Breakdown Voltage | 6000 VDC |
| Total Package Power Dissipation @ 25°C Ambient | 400 mW |
| Derate Linearly From 25°C | 5.33 mW/°C |

ELECTRO-OPTICAL CHARACTERISTICS (25°C Free Air Temperature Unless Otherwise Specified)

| Parameter | Min | Typ | Max | Units | Test Conditions |
|---|------|------------------|------|----------|---|
| Input Diode | | | | | |
| Rated Forward Voltage | | 1.25 | 1.50 | V | $I_F = 20$ mA |
| Reverse Voltage | 3.0 | 8.0 | | V | $I_R = 10$ μ A |
| Reverse Current | | 0.001 | 10 | μ A | $V_R = 3.0$ V |
| Junction Capacitance | | 100 | | pF | $V_F = 0$ V |
| Output Transistor | | | | | |
| Breakdown Voltage, | | | | | |
| Collector to Emitter | 30 | 65 | | V | $I_C = 1.0$ mA |
| Emitter to Collector | 7.0 | 10 | | V | $I_E = 100$ μ A |
| Leakage Current, | | 1.0 | 100 | nA | $V_{CE} = 10$ V |
| Collector to Emitter | | | | | |
| Capacitance Collector to Emitter | | 8.0 | | pF | $V_{CE} = 0$ V |
| Coupled | | | | | |
| DC Current Transfer Ratio | 20 | 50 | | % | $V_{CE} = 10$ V, $I_F = 10$ mA |
| (I_C/I_F) | | | | | |
| Saturation Voltage – | | | 0.40 | V | $I_C = 2.0$ mA, $I_F = 16$ mA |
| Collector to Emitter | | | | | |
| Isolation Voltage | 7500 | | | VDC | |
| Isolation Resistance | | 10 ¹² | | Ω | $V_{I,O} = 500$ V |
| Isolation Capacitance | | 0.5 | | pF | $f = 1.0$ MHz |
| Breakdown Voltage – | | 1500 | | VDC | Relative Humidity = 40% |
| Channel-to-Channel | | | | | |
| Capacitance Between | | 0.4 | | pF | $f = 1.0$ MHz |
| Channels | | | | | |
| Bandwidth | | 150 | | KHz | $I_C = 2.0$ mA, $V_{CC} = 10$ V $R_L = 100$ Ω |
| Switching Times, Output Transistor | | | | | |
| Non-Saturated Rise Time, | | 2.4 | | μ s | $I_C = 2.0$ mA, $V_{CE} = 10$ V |
| Fall Time | | | | | $R_L = 100$ Ω |
| Non-Saturated Rise Time, | | 15 | | μ s | $I_C = 2.0$ mA, $V_{CE} = 10$ V |
| Fall Time | | | | | $R_L = 1.0$ K Ω |
| Saturated Turn-On Time | | 5.0 | | μ s | $R_L = 2.0$ K Ω , $I_F = 15$ mA |
| (From 5.0 V to 0.8 V) | | | | | |
| Saturated Turn-Off Time | | 25 | | μ s | $R_L = 2.0$ K Ω , $I_F = 15$ mA |
| (From Saturation to 2.0V) | | | | | |

Specifications subject to change without notice.

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES FOR EACH CHANNEL

FIGURE 1. I-V CURVE OF PHOTOTRANSISTOR

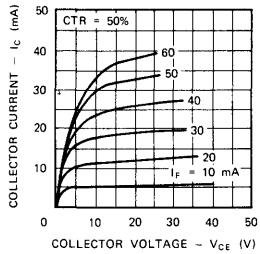


FIGURE 2. I-V CURVE IN SATURATION

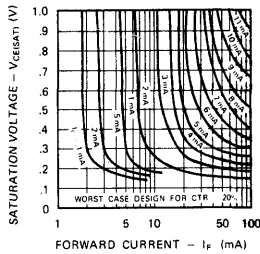


FIGURE 3. CTR VS FORWARD CURRENT

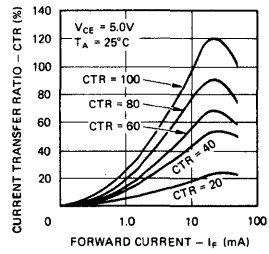


FIGURE 4. CURRENT TRANSFER RATIO VS TEMPERATURE

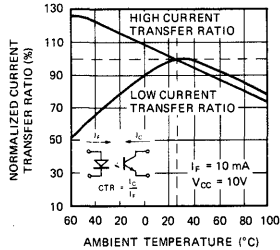


FIGURE 5. I-V CURVE OF LED VS TEMPERATURE

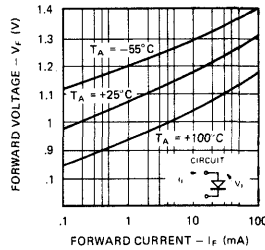


FIGURE 6. LEAKAGE CURRENT VS TEMPERATURE VS COLLECTOR VOLTAGE

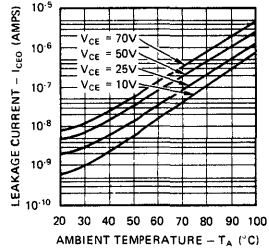
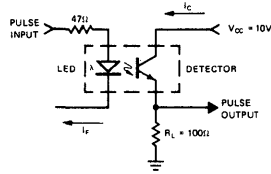
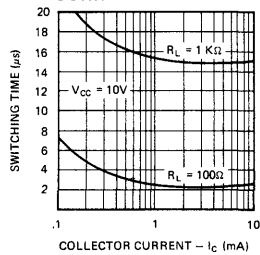


FIGURE 7. SWITCHING TIME VS COLLECTOR CURRENT



CIRCUIT USED TO OBTAIN SWITCHING TIME VS COLLECTOR CURRENT PLOT

Maximum Ratings

Maximum Temperatures

| | |
|--|-------------------|
| Storage Temperature | -55 °C to +150 °C |
| Operating Temperature | -55 °C to +100 °C |
| Lead Temperature (Soldering, 10 seconds) | 260 °C |

Input Diode (Each Channel)

| | |
|---|-----------|
| Rated Forward Current, DC | 60 mA |
| Peak Forward Current (1 μ s pulse, 300 pps) | 3 A |
| Power Dissipation @ 25 °C Ambient | 100 mW |
| Derate Linearly from 25 °C | 1.3 mW/°C |

Output Transistor (Each Channel)

| | |
|---|---------|
| Power Dissipation @ 25 °C Ambient | 150 mW |
| Derate Linearly from 25 °C | 2 mW/°C |
| Collector Current | 30 mA |

Coupled

| | |
|---|------------|
| Input-to-Output Breakdown Voltage | 5000 VDC |
| Total Package Power Dissipation @ 25 °C Ambient | 400 mW |
| Derate Linearly from 25 °C | 5.33 mW/°C |

Electro-Optical Characteristics (@ 25 °C Free Air Temperature Unless Otherwise Specified)

| Parameter | Min | Typ | Max | Units | Test Conditions |
|--|------|-----------|------|----------|---|
| Input Diode | | | | | |
| Rated Forward Voltage | | 1.25 | 1.50 | V | $I_F = 20$ mA |
| Reverse Voltage | 3.0 | 5.0 | | V | $I_R = 10$ μ A |
| Reverse Current | | 0.001 | 10 | μ A | $V_R = 3.0$ V |
| Junction Capacitance | | 100 | | pF | $V_F = 0$ V |
| Output Transistor | | | | | |
| Breakdown Voltage, | | | | | |
| Collector-to-Emitter | 30 | 50 | | V | $I_C = 1.0$ mA |
| Emitter-to-Collector | 7.0 | 10 | | V | $I_E = 100$ μ A |
| Leakage Current, | | | | | |
| Collector-to-Emitter | | 1.0 | 100 | nA | $V_{CE} = 10$ V |
| Capacitance, | | | | | |
| Collector-to-Emitter | | 8.0 | | pF | $V_{CE} = 0$ V |
| Coupled | | | | | |
| DC Current Transfer Ratio (I_C/I_F) | 20 | 50 | | % | $V_{CE} = 10$ V, $I_F = 10$ mA |
| Saturation Voltage — | | | | | |
| Collector-to-Emitter | | 0.25 | 0.40 | V | $I_C = 2.0$ mA, $I_F = 16$ mA |
| Isolation Voltage | 5000 | 7000 | | VDC | $t = 1$ Minute |
| Isolation Resistance | | 10^{12} | | Ω | $V_{I-O} = 500$ V |
| Isolation Capacitance | | 0.5 | | pF | $f = 1.0$ MHz |
| Breakdown Voltage — | | | | | |
| Channel-to-Channel | | 2500 | | VDC | $t = 1$ Minute |
| Capacitance Between Channels | | 0.4 | | pF | $f = 1.0$ MHz |
| Bandwidth | | 150 | | kHz | $I_C = 2.0$ mA, $V_{CC} = 10$ V $R_L = 100$ Ω |
| Switching Times, Output Transistor | | | | | |
| Non-Saturated Rise Time, | | | | | |
| Fall Time | | 2.4 | | μ s | $I_C = 2.0$ mA, $V_{CE} = 10$ V $R_L = 100$ Ω |
| Non-Saturated Rise Time, | | | | | |
| Fall Time | | 15 | | μ s | $I_C = 2.0$ mA, $V_{CE} = 10$ V $R_L = 1.0$ k Ω |
| Saturated Turn-On Time | | | | | |
| (From 5.0 V to 0.8 V) | | 5.0 | | μ s | $R_L = 2.0$ k Ω , $I_F = 15$ mA |
| Saturated Turn-Off Time | | | | | |
| (From Saturation to 2.0 V) | | 25 | | μ s | $R_L = 2.0$ k Ω , $I_F = 15$ mA |

Specifications subject to change without notice.

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES FOR EACH CHANNEL

FIGURE 1. I-V CURVE OF PHOTOTRANSISTOR

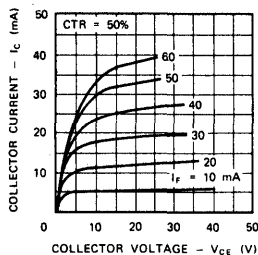


FIGURE 2. I-V CURVE IN SATURATION

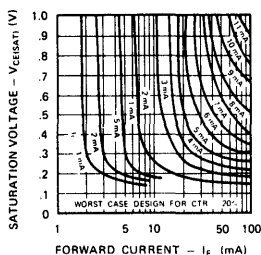


FIGURE 3. CTR VS FORWARD CURRENT

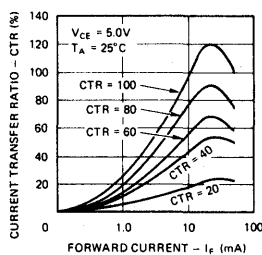


FIGURE 4. CURRENT TRANSFER RATIO VS TEMPERATURE

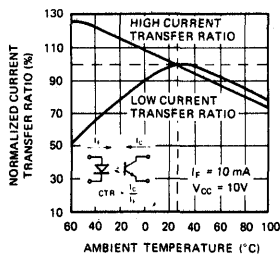


FIGURE 5. I-V CURVE OF LED VS TEMPERATURE

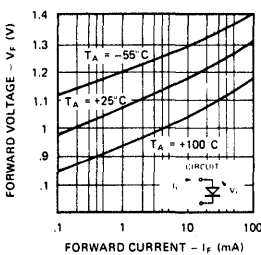


FIGURE 6. LEAKAGE CURRENT VS TEMPERATURE VS COLLECTOR VOLTAGE

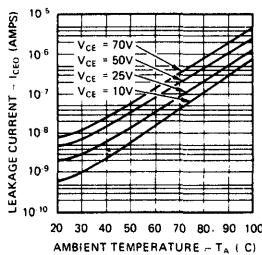
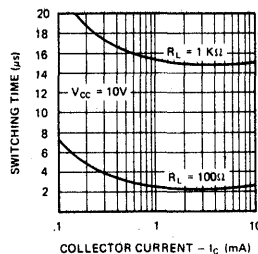
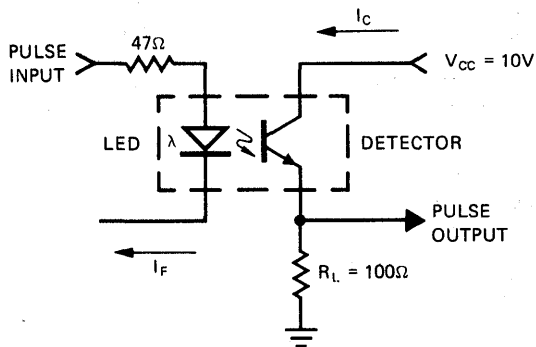
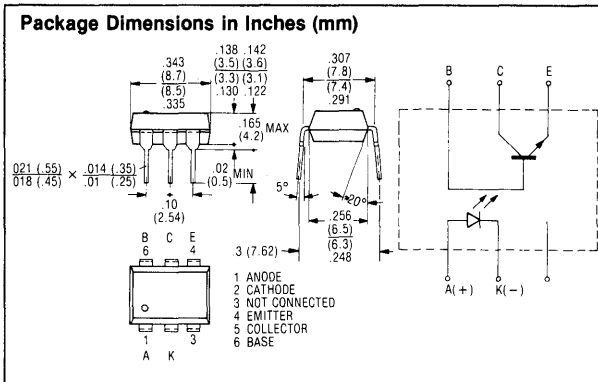
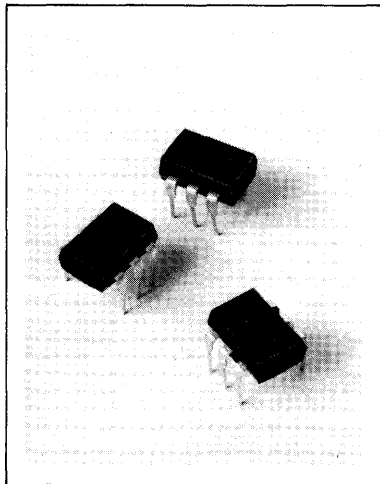


FIGURE 7. SWITCHING TIME VS COLLECTOR CURRENT



CIRCUIT USED TO OBTAIN SWITCHING TIME VS COLLECTOR CURRENT PLOT





FEATURES

- High Quality Premium Device
- Long Term Stability
- High Current Transfer Ratio, 4 Groups
 - SFH 600-0, 40 to 80%
 - SFH 600-1, 63 to 125%
 - SFH 600-2, 100 to 200%
 - SFH 600-3, 160 to 320%
- 2800 Volt Isolation (1 Minute)
- Storage Temperature
 - 55 to +150°C
- VCE SAT 0.25 (< 0.4) Volt
 - $I_F = 10 \text{ mA}$, $I_C = 2.5 \text{ mA}$
- UL Approval #E52744

DESCRIPTION

The optoelectronic coupler SFH 600 comprises a GaAs LED as the emitter which is optically coupled with a silicon planar phototransistor as the detector. The component is located in a plastic plug-in case 20 AB DIN 41866.

The coupler allows to transfer signals between two electrically isolated circuits. The potential difference between the circuits to be coupled is not allowed to exceed the maximum permissible insulating voltage.

Maximum Ratings

| | |
|--|--------|
| Reverse Voltage (V_R) | 6 V |
| Forward Current (I_F) | 60 mA |
| Surge Current (I_{FS}), $t_p = 10 \mu\text{s}$ | 1.5 A |
| Power Dissipation (P_{TOT}) | 100 mW |

Detector (Silicon Phototransistor)

| | |
|--|--------|
| Collector-Emitter Voltage (V_{CE}) | 70 V |
| Emitter-Base Reverse Voltage (V_{EBO}) | 7 V |
| Collector Current (I_C) | 50 mA |
| Collector Current (I_{CS}), $t = 1 \text{ ms}$ | 100 mA |
| Power Dissipation (P_{TOT}) | 150 mW |

Coupler

| | |
|--|---------------|
| Storage Temperature (T_{stor}) | -55 to +150°C |
| Ambient Temperature (T_{amb}) | -55 to +100°C |
| Junction Temperature (T_j) | 100°C |
| Soldering Temperature (T_L), 1 Min. | 280°C |
| Isolation Test Voltage (1 Min.) (V_{IS}) (between emitter and detector referred to standard climate 23/50 DIN 50014) | 2800 V |
| Tracking Resistance | Min. 8.2 mm |
| Air Path | Min. 7.6 mm |

Tracking Resistance

Group III (KC = > 800) in accordance with VDE0110 § 6
Table 3 and DIN 53480/VDE0303, Part 1

As to nominal isolation voltage DIN57883 or VDC0883 applies.

| | |
|--|------------------|
| Isolation Voltage (V_{IS}) at $V_{IS} = 500 \text{ V}$ | $10^{11} \Omega$ |
|--|------------------|

Climatic Conditions

DIN 40040, Humidity Class F

Flammability

DIN57471 or VDE0471, Part 2, of April 1975 or MIL-202E, Method 11A

Characteristics ($T_{amb} = 25^\circ\text{C}$)

Emitter (GaAs LED)

| | |
|--|----------------------------------|
| Forward Voltage (V_F), $I_F = 60 \text{ mA}$ | 1.25 (≤ 1.65) V |
| Breakdown Voltage (V_{BR}), $I_R = 100 \mu\text{A}$ | 30 (≥ 6) V |
| Reverse Current (I_R), $V_R = 3 \text{ V}$ | 0.01 (≤ 10) μA |
| Capacitance (C_O), $V_R = 0\text{V}$, $f = 1 \text{ MHz}$ | 40 pF |
| Thermal Resistance ($R_{th \text{ Jamb}}$) | 750 K/W |

Detector (Silicon Phototransistor)

| | |
|---|---------|
| Capacitance, ($V_{CE} = 5 \text{ V}$, $f = 1 \text{ MHz}$) | |
| C_{CE} | 5.2 pF |
| C_{CB} | 6.5 pF |
| C_{EB} | 9.5 pF |
| Thermal Resistance ($R_{th \text{ Jamb}}$) | 500 K/W |

Specifications subject to change without notice.

Characteristics (Continued)

Coupler

Collector-Emitter Saturation Voltage ($V_{CE\ sat}$)

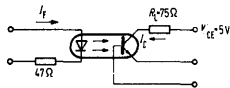
$I_F = 10\text{ mA}$, $I_C = 2.5\text{ mA}$ $0.25 (\leq 0.4)\text{ V}$

Coupling Capacitance (C_K) 0.55 pF

The couplers are grouped in accordance with their current ratio $\frac{I_C}{I_F}$ at $I_F = 10\text{ mA}$ and $V_{CE} = 5\text{ V}$ and marked by Roman numerals.

| Group | 0 | 1 | 2 | 3 | |
|--|-----------------|-----------------|-----------------|-----------------|----|
| I_C | 40-80 | 63-125 | 100-200 | 160-320 | % |
| I_F | | | | | |
| Collector-Emitter Leakage Current ($V_{CE} = 10\text{ V}$) I_{CEO} | 2 (≤ 35) | 2 (≤ 35) | 2 (≤ 35) | 5 (≤ 70) | nA |

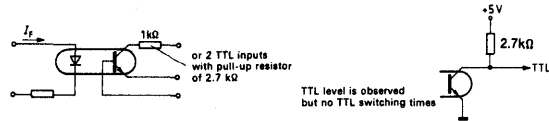
Linear operation (without saturation)



| | | |
|-----------------------------|--------------------|---------------|
| Load Resistance (R_L) | 75 | Ω |
| Delay Time (t_d) | 3.2 (< 4.6) | μS |
| Rise Time (t_r) | 2 (≤ 3) | μS |
| Storage Time (t_s) | 3.0 (< 4.0) | μS |
| Fall Time (t_f) | 2.5 (≤ 3.3) | μS |
| Cut-off Frequency (f_g) | 250 | KHz |

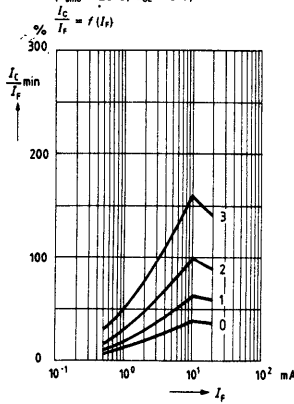
$I_F = 10\text{ mA}$
 $V_{CE} = 5\text{ V}$
 $T_{amb} = 25^\circ\text{C}$

Switching operation (with saturation)

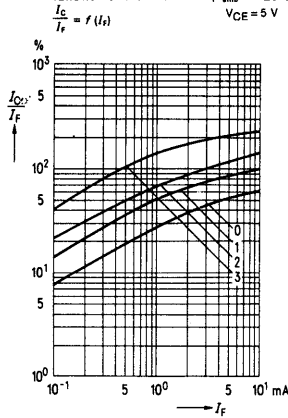


| Group | 0 | 1 and 2 | 3 | |
|--------------------------------|----------------------|----------------------|---------------------|---------------|
| | $I_F = 20\text{ mA}$ | $I_F = 10\text{ mA}$ | $I_F = 5\text{ mA}$ | |
| Switch-On Time (t_{0in}) | 3.7 (≤ 5.8) | 4.5 (≤ 6.2) | 5.8 (≤ 8.0) | μS |
| Rise Time (t_r) | 2.5 (≤ 4.0) | 3 (≤ 4.2) | 4 (≤ 5.5) | μS |
| Switch-Off Time (t_{0off}) | 19 (≤ 25) | 21 (≤ 27) | 24 (≤ 31) | μS |
| Fall Time (t_f) | 11 (≤ 14) | 12 (≤ 15) | 14 (≤ 18) | μS |
| $V_{CE\ sat}$ | | 0.25 (≤ 0.4) | | V |

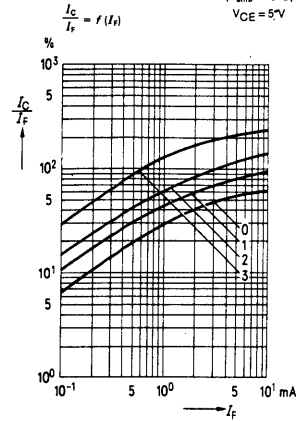
Minimum current transfer ratio as a function of diode current ($T_{amb} = 25^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



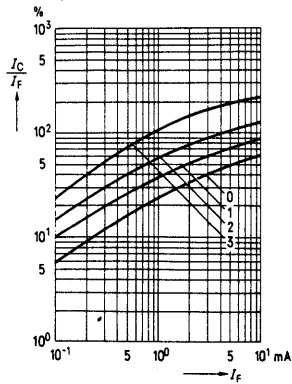
Current transfer ratio as a function of diode current ($T_{amb} = -25^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



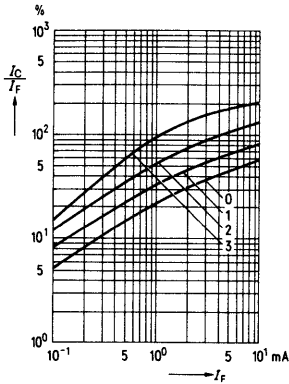
Current transfer ratio as a function of diode current ($T_{amb} = 0^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



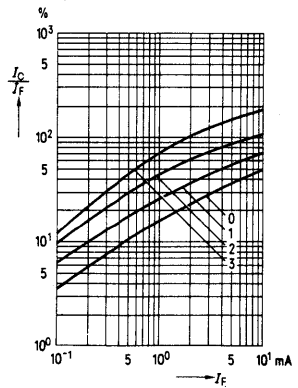
Current transfer ratio as a function of diode current ($T_{amb} = 25^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



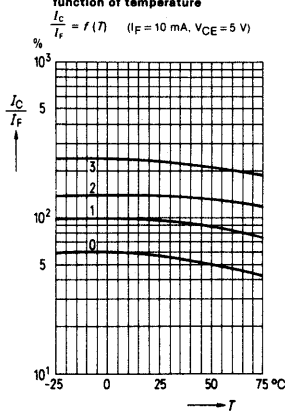
Current transfer ratio as a function of diode current ($T_{amb} = 50^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



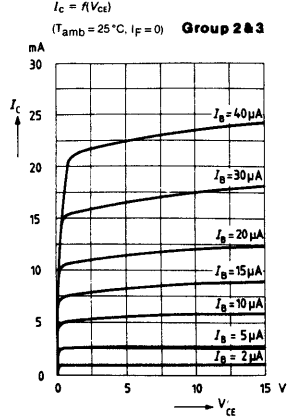
Current transfer ratio as a function of diode current ($T_{amb} = 75^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



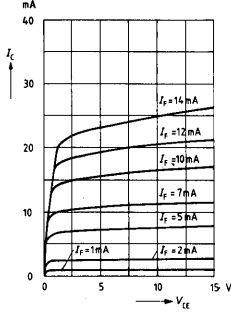
Current transfer ratio as a function of temperature



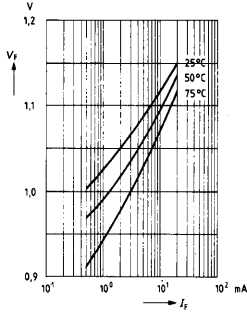
Transistor characteristics ($\beta = 550$)



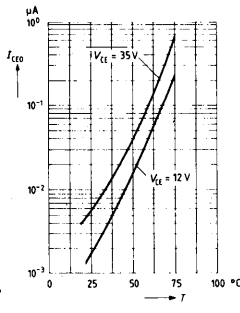
Output characteristics $I_C = f(V_{CE})$
($T_{amb} = 25^\circ\text{C}$): Group 2 & 3



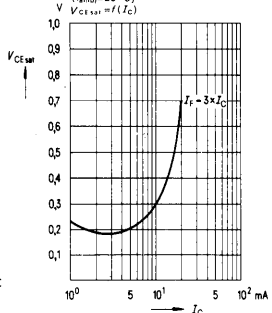
Forward voltage $V_f = f(I_f)$



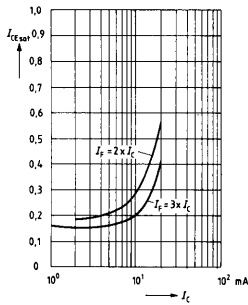
Collector-emitter off-state current $I_{CEO} = f(V_{CE}, T)$
($T_{amb} = 25^\circ\text{C}, I_B = 0$)



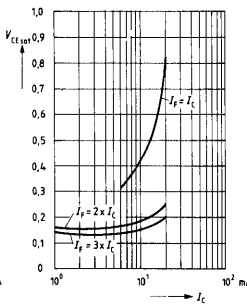
Saturation voltage as a function of collector current and modulation depth for SFH 600-0
($T_{amb} = 25^\circ\text{C}$)
 $V_{CE(sat)} = f(I_C)$



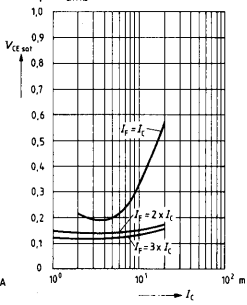
Saturation voltage as a function of collector current and modulation depth for SFH 600-1
 $V_{CE(sat)} = f(I_C)$
($T_{amb} = 25^\circ\text{C}$)



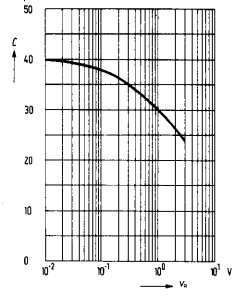
Saturation voltage as a function of collector current and modulation depth for SFH 600-2
 $V_{CE(sat)} = f(I_C)$
($T_{amb} = 25^\circ\text{C}$)



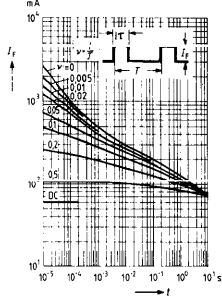
Saturation voltage as a function of collector current and modulation depth for SFH 600-3
 $V_{CE(sat)} = f(I_C)$
($T_{amb} = 25^\circ\text{C}$)



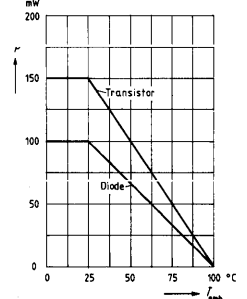
Diode capacitance $C = f(V_a)$
($T_{amb} = 25^\circ\text{C}, f = 1 \text{ MHz}$)



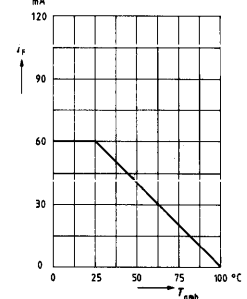
Permissible pulse load
 $v = \text{parameter}, T_{amb} = 25^\circ\text{C}$
 $I_B = I_{B0}$



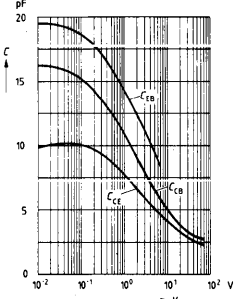
Permissible loss transistor $P_{tot} = f(T_{amb})$ and Diode



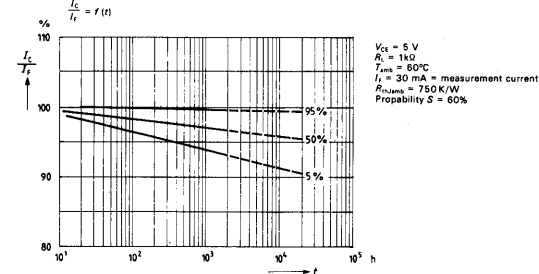
Permissible loss diode $P_{tot} = f(T_{amb})$

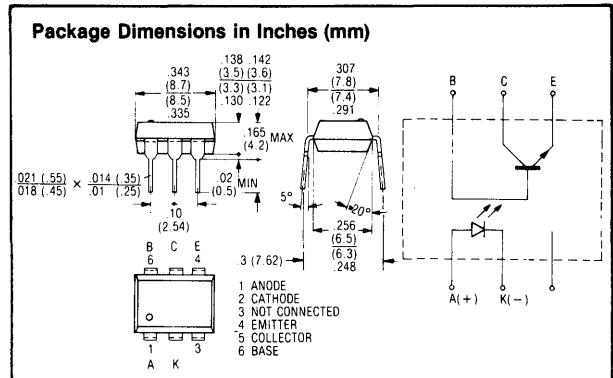
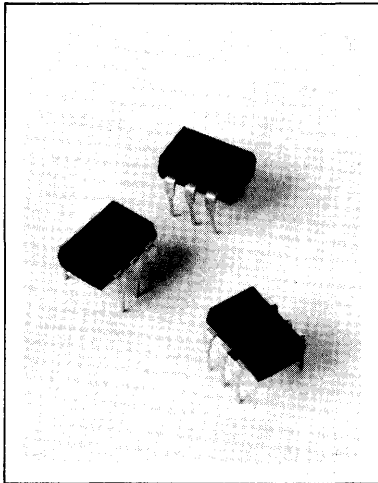


Transistor capacitances $C = f(V_a)$
($T_{amb} = 25^\circ\text{C}, f = 1 \text{ MHz}$)



Variation of current transfer ratio as a function of load time
 $\frac{I_C}{I_B} = f(t)$





FEATURES

- Highest Quality Premium Device
- Built to Conform to VDE Requirements
- Long Term Stability
- High Current Transfer Ratios, 4 Groups
SFH 601-1, 40 to 80%
SFH 601-2, 63 to 125%
SFH 601-3, 100 to 200%
SFH 601-4, 160 to 320%
- 5300 Volt Isolation (1 Minute)
- Storage Temperature -40° to $+150^{\circ}\text{C}$
- V_{CEsat} 0.25 (< 0.4) Volt
 $I_F = 10$ mA, $I_C = 2.5$ mA
- UL Approval #E52744
- VDE Approval #0883 & #0830 group C

DESCRIPTION

The optoelectronic coupler SFH 601 comprises a GaAs LED as the emitter which is optically coupled with a silicon planar phototransistor as the detector. The component is located in a plastic plug-in case 20 AB DIN 41866.

The coupler allows to transfer signals between two electrically isolated circuits. The potential difference between the circuits to be coupled is not allowed to exceed the maximum permissible insulating voltage.

Maximum Ratings

| | |
|--|--------|
| Reverse Voltage (V_R) | 6 V |
| Forward Current (I_F) | 60 mA |
| Surge Current (I_{FS}), $t_p = 10 \mu\text{s}$ | 1.5 A |
| Power Dissipation (P_{Tot}) | 100 mW |

Detector (Silicon Phototransistor)

| | |
|--|--------|
| Collector-Emitter Voltage (V_{CEC}) | 70 V |
| Emitter-Base Reverse Voltage (V_{EBO}) | 7 V |
| Collector Current (I_C) | 50 mA |
| Collector Current (I_{CS}), $t = 1$ ms | 100 mA |
| Power Dissipation (P_{Tot}) | 150 mW |

Coupler

| | |
|--|---------------------------------|
| Storage Temperature (T_{Stor}) | -40 to $+150^{\circ}\text{C}$ |
| Ambient Temperature (T_{Amb}) | -40 to $+100^{\circ}\text{C}$ |
| Junction Temperature (T_j) | 100°C |
| Soldering Temperature (T_s), 10 s Max. | 260°C |
| Isolation Test Voltage (V_{IS}), 1 Min. (between emitter and detector referred to standard climate 23/50 DIN 50014) | 5300 V- |

| | |
|---------------------|-------------|
| Tracking Resistance | Min. 8.2 mm |
| Air Path | Min. 7.6 mm |

Tracking Resistance

Group III (KC = > 600) in accordance with VDE 0110 § 6 Table 3 and DIN 53480/VDE 0303, Part 1.

As to nominal isolation voltage DIN 57883 or VDE 0883 applies.

| | |
|--|------------------|
| Isolation Voltage (R_{IS}), @ $V_{IS} = 500$ V | $10^{11} \Omega$ |
|--|------------------|

Climatic Conditions

DIN 40040, humidity Class F

Flammability

DIN 57471 or VDE 0471, Part 2, of April 1975 or MIL202E, Method 11 A

Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

Emitter (GaAs LED)

| | |
|---|----------------------------------|
| Forward Voltage (V_F), $I_F = 60$ mA | 1.25 (≤ 1.65) V |
| Breakdown Voltage (V_{BR}), $I_R = 100 \mu\text{A}$ | 30 (≥ 6) V |
| Reverse Current (I_R), $V_R = 3$ V | 0.01 (≤ 10) μA |

Capacitance (C_C)

| | |
|-------------------------------------|---------|
| ($V_R = 0$ V; $f = 1$ MHz) | 40 pF |
| Thermal Resistance (R_{thJamb}) | 750 K/W |

Detector (Silicon Phototransistor)

| | |
|--|---------|
| Capacitance ($V_{CE} = 5$ V; $f = 1$ MHz) | |
| C_{CE} | 6.8 pF |
| C_{CB} | 8.5 pF |
| C_{EB} | 11 pF |
| Thermal Resistance (R_{thJamb}) | 500 K/W |

Specifications subject to change without notice.

Characteristics (Continued)

Coupler

Collector-Emitter Saturation Voltage (V_{CEsat})

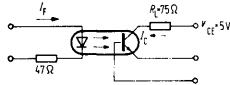
($I_F = 10\text{ mA}$, $I_C = 2.5\text{ mA}$) 0.25 (<0.4) V

Coupling Capacitance (C_K) 0.30 pF

The couplers are grouped in accordance with their current ratio $\frac{I_C}{I_F}$ at $I_F = 10\text{ mA}$ and $V_{CE} = 5\text{ V}$ and marked by numbers.

| Group | 1 | 2 | 3 | 4 | |
|--|---------|---------|----------|----------|----|
| $\frac{I_C}{I_F}$ | 40-80 | 63-125 | 100-200 | 160-320 | % |
| Collector-Emitter Leakage | 2 (<50) | 2 (<50) | 5 (<100) | 5 (<100) | nA |
| Current ($V_C = 10\text{ V}$), I_{CEO} | | | | | |

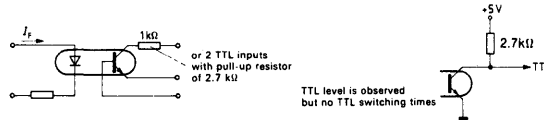
Linear operation (without saturation)



| | | |
|-----------------------------|--------------------|---------------|
| Load Resistance (R_L) | 75 | Ω |
| Delay Time (t_d) | 3.0 (≤ 5.6) | μS |
| Rise Time (t_r) | 2.0 (≤ 4.0) | μS |
| Storage Time (t_s) | 2.3 (≤ 4.1) | μS |
| Fall Time (t_f) | 2.0 (≤ 3.5) | μS |
| Cut-off Frequency (f_g) | 250 | kHz |

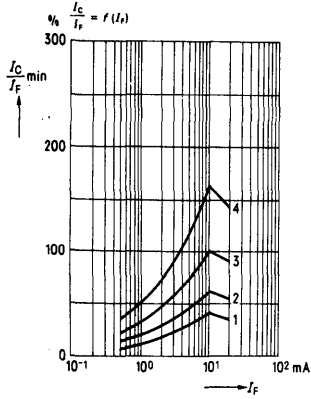
$I_F = 10\text{ mA}$
 $V_{CE} = 5\text{ V}$
 $T_{amb} = 25^\circ\text{C}$

Switching operation (with saturation)

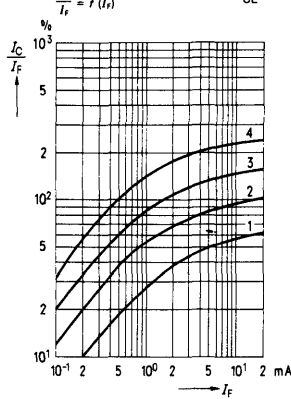


| Group | 1 $I_F = 20\text{ mA}$ | 2 and 3 $I_F = 10\text{ mA}$ | 4 $I_F = 5\text{ mA}$ | |
|-------------------------------|---------------------------|---------------------------------|--------------------------|---------------|
| Switch-On Time (t_{ein}) | 3.0 (≤ 5.5) | 4.2 (≤ 8.0) | 6.0 (≤ 10.5) | μS |
| Rise Time (t_r) | 2.0 (≤ 4.0) | 3.0 (≤ 6.0) | 4.6 (≤ 8.0) | μS |
| Switch-Off Time (t_{off}) | 18 (≤ 34) | 23 (≤ 39) | 25 (≤ 43) | μS |
| Fall Time (t_f) | 11 (≤ 20) | 14 (≤ 24) | 15 (≤ 26) | μS |
| $V_{CE sat}$ | | 0.25 (≤ 0.4) | | V |

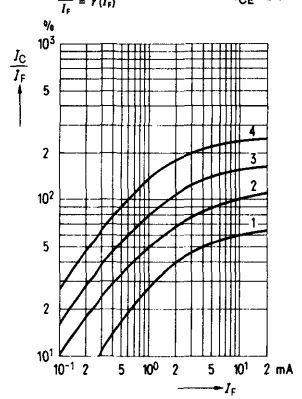
Minimum current transfer ratio as a function of diode current ($T_{amb} = 25^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



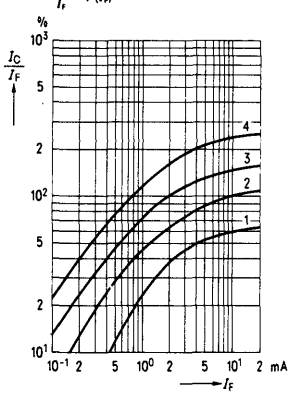
Current transfer ratio as a function of diode current ($T_{amb} = -25^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



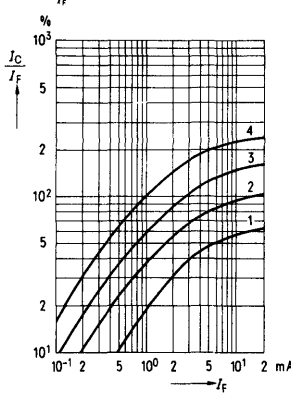
Current transfer ratio as a function of diode current ($T_{amb} = 0^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



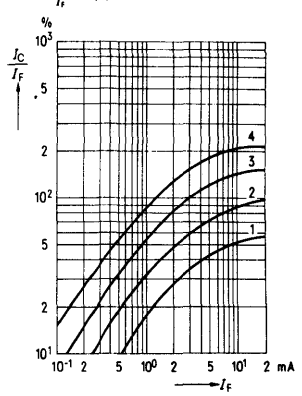
Current transfer ratio as a function of diode current ($T_{amb} = 25^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



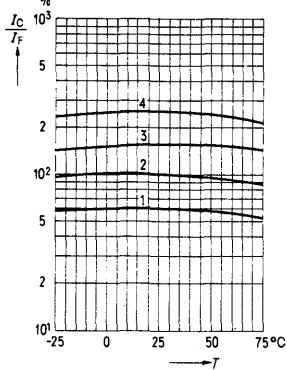
Current transfer ratio as a function of diode current ($T_{amb} = 50^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



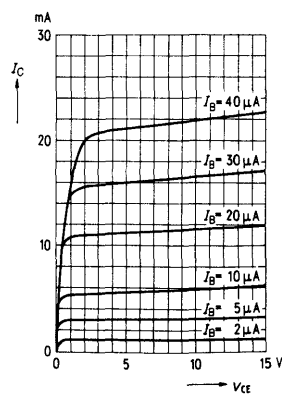
Current transfer ratio as a function of diode current ($T_{amb} = 75^{\circ}\text{C}$, $V_{CE} = 5\text{ V}$)



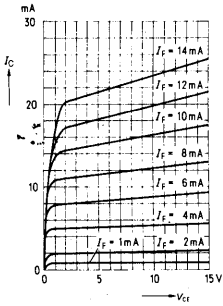
Current transfer ratio as a function of temperature ($I_F = 10\text{ mA}$, $V_{CE} = 5\text{ V}$)



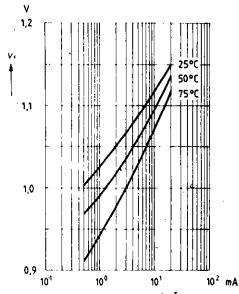
Transistor characteristics ($\beta = 550$, $I_C = \beta I_{CB}$, $T_{amb} = 25^{\circ}\text{C}$, $I_F = 0$)



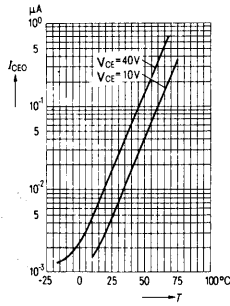
Output characteristics $I_C = f(V_{CE})$
($T_{amb} = 25^\circ\text{C}$)



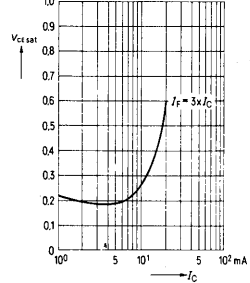
Forward voltage $V_f = f(I_f)$



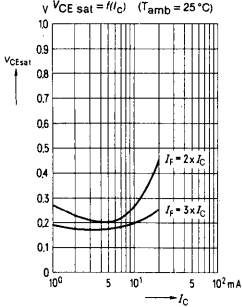
Collector-emitter off-state current $I_{CEO} = f(V_{CE}, T)$ ($T_{amb} = 25^\circ\text{C}, I_f = 0$)



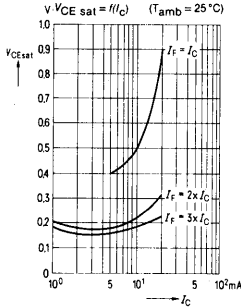
Saturation voltage as a function of collector current and modulation depth for SFH 601-1
 $V_{CE sat} = f(I_C)$
($T_{amb} = 25^\circ\text{C}$)



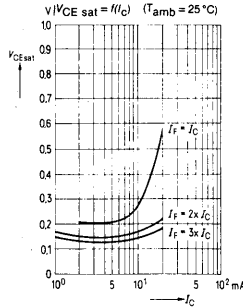
Saturation voltage as a function of collector current and modulation depth for SFH 601-2
 $V_{CE sat} = f(I_C)$ ($T_{amb} = 25^\circ\text{C}$)



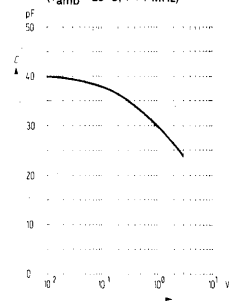
Saturation voltage as a function of collector current and modulation depth for SFH 601-3
 $V_{CE sat} = f(I_C)$ ($T_{amb} = 25^\circ\text{C}$)



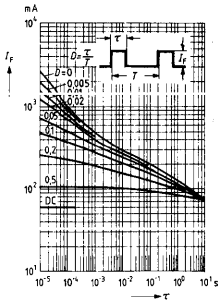
Saturation voltage as a function of collector current and modulation depth for SFH 601-4
 $V_{CE sat} = f(I_C)$ ($T_{amb} = 25^\circ\text{C}$)



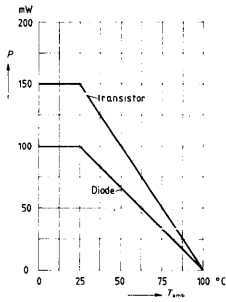
Diode capacitance $C = f(V_{CE})$
($T_{amb} = 25^\circ\text{C}, f = 1 \text{ MHz}$)



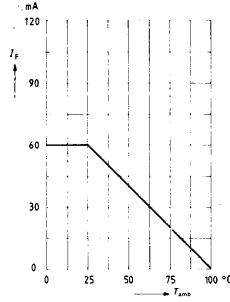
Permissible pulse load
 $I_f = f(t)$
 $T_{amb} = 25^\circ\text{C}$



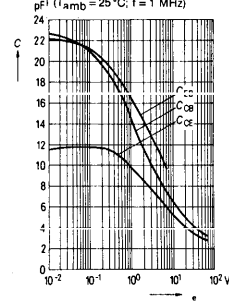
Permissible loss transistor $P_{tot} = f(T_{amb})$



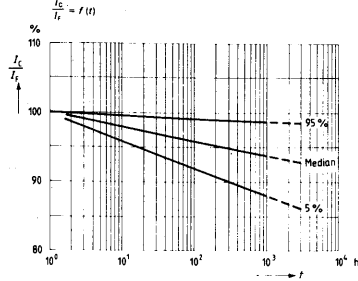
Permissible loss diode $P_{tot} = f(T_{amb})$



Transistor capacitances $C = f(V_{CE})$
($T_{amb} = 25^\circ\text{C}, f = 1 \text{ MHz}$)



Variation of current transfer ratio as a function of load time
 $I_C/I_f = f(t)$

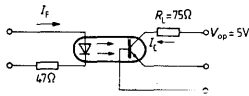


$V_{CE} = 5 \text{ V}$
 $R_f = 1 \text{ k}\Omega$
 $T_{amb} = 60^\circ\text{C}$
 $I_f = 30 \text{ mA}$ = measurement current
 $R_{th(junction)} = 750 \text{ K/W}$
Probability $S = 60\%$

CHARACTERISTICS @ 25°C

| | | | |
|---|--|--|---|
| Emitter (GaAs infrared emitter) Forward voltage ($I_F = 60 \text{ mA}$) Breakdown voltage ($I_R = 100 \text{ }\mu\text{A}$) Reverse current ($V_R = 6 \text{ V}$) Capacitance ($V_R = 0 \text{ V}; f = 1 \text{ MHz}$) Thermal resistance | V_F $V_{(BR)}$ I_R C_O $R_{\theta J(A)}$ | 1.25 (≤ 1.65) 30 (≥ 6) 0.01 (≤ 10) 40 750 | V V μA pF K/W |
| Detector (silicon phototransistor) Capacitance ($V_{CE} = 5 \text{ V}; f = 1 \text{ MHz}$) ($V_{CB} = 5 \text{ V}; f = 1 \text{ MHz}$) ($V_{EB} = 5 \text{ V}; f = 1 \text{ MHz}$) Thermal resistance | C_{CE} C_{CB} C_{EB} $R_{\theta J(A)}$ | 6.8 8.5 11 500 | pF pF pF K/W |
| Optocoupler Collector-emitter saturation voltage ($I_F = 10 \text{ mA}, I_C = 2.5 \text{ mA}$) Coupling capacitance | V_{CEsat} C_K | 0.25 (≤ 0.4) 0.30 | V pF |
| The optocouplers are grouped according to their current transfer ratio I_C/I_F at $I_F = 10 \text{ mA}$ and $V_{CE} = 5 \text{ V}$. | | | |
| Group | 1 | 2 | 3 |
| I_C/I_F Collector-emitter reverse current I_{CEO} ($V_{CE} = 10 \text{ V}$) | 40 to 80 2 (≤ 50) | 63 to 125 2 (≤ 50) | 100 to 200 5 (≤ 100) % nA |

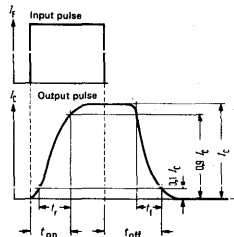
Linear operation (without saturation)



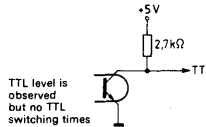
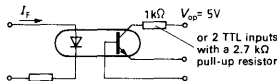
$I_F = 10 \text{ mA}$
 $V_{op} = 5 \text{ V}$
 $T_{amb} = 25^\circ\text{C}$

| | | | |
|-------------------|-----------|--------------------|---------------|
| Load resistance | R_L | 75 | Ω |
| Turn-on time | t_{on} | 3.0 (≤ 5.6) | μs |
| Rise time | t_r | 2.0 (≤ 4.0) | μs |
| Turn-off time | t_{off} | 2.3 (≤ 4.1) | μs |
| Fall time | t_f | 2.0 (≤ 3.5) | μs |
| Cut-off frequency | f_{co} | 250 | kHz |

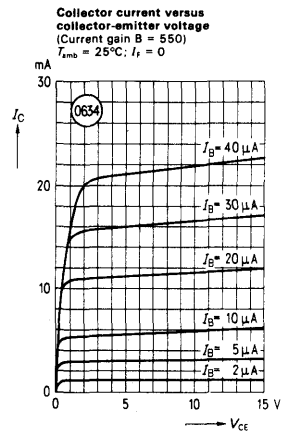
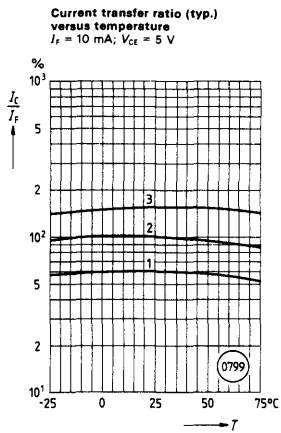
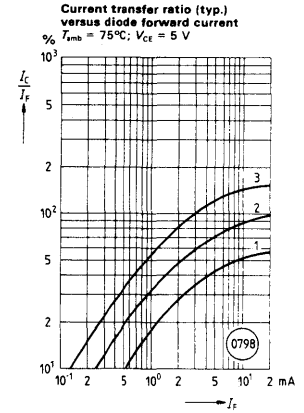
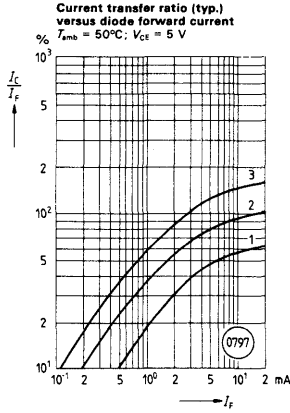
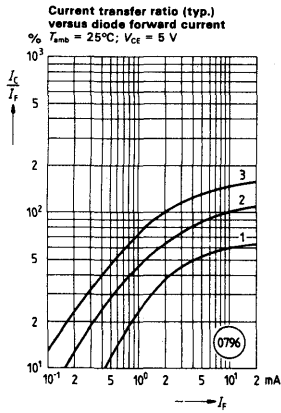
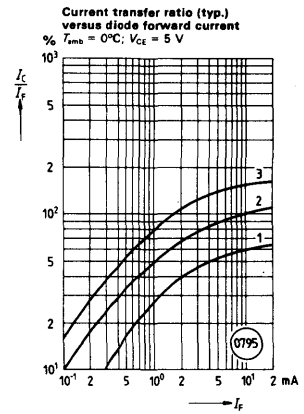
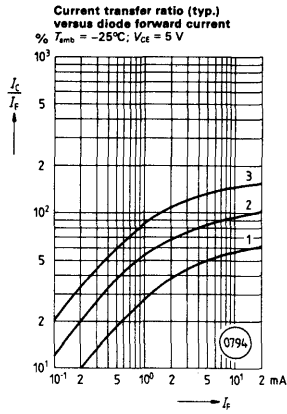
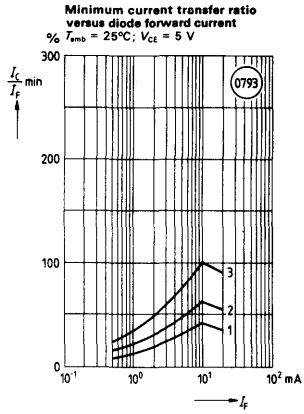
Switching times

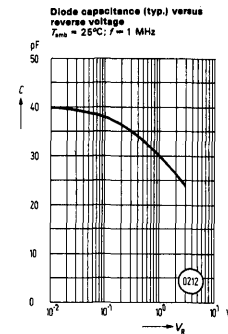
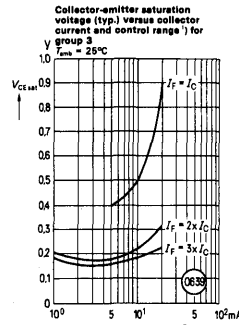
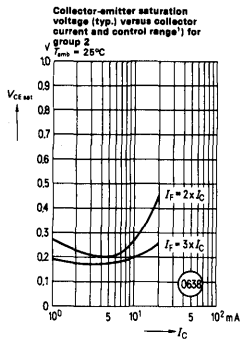
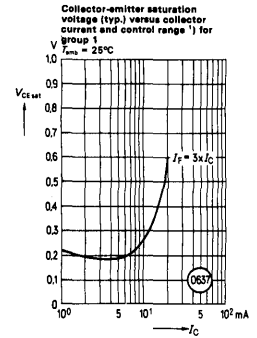
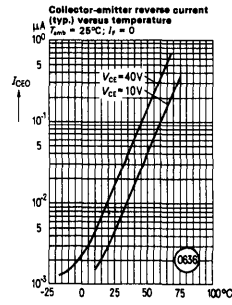
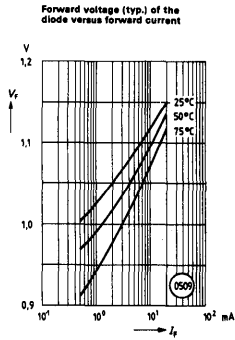
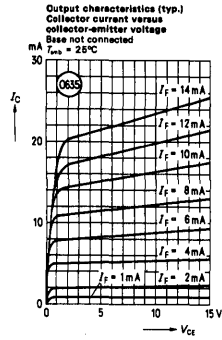


Switching operation (with saturation)

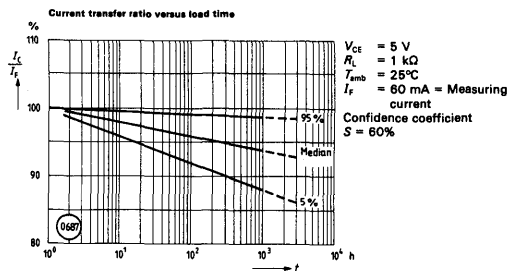
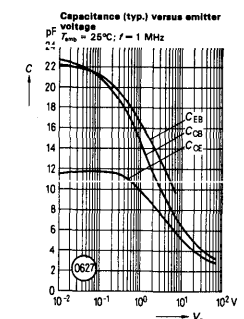
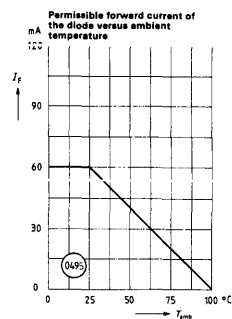
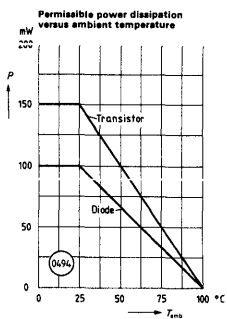
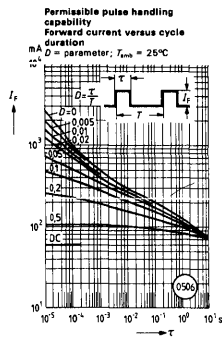


| | | | |
|---------------|-----------------------|-----------------------|----------------------------------|
| Group | 1 | 2 and 3 | |
| | $I_F = 20 \text{ mA}$ | $I_F = 10 \text{ mA}$ | |
| Turn-on time | t_{on} | 3.0 (≤ 5.5) | 4.2 (≤ 8.0) μs |
| Rise time | t_r | 2.0 (≤ 4.0) | 3.0 (≤ 6.0) μs |
| Turn-off time | t_{off} | 18 (≤ 34) | 23 (≤ 39) μs |
| Fall time | t_f | 11 (≤ 20) | 14 (≤ 24) μs |
| | V_{CEsat} | 0.25 (≤ 0.4) V | |





¹⁾ $I_F = 2 \times I_C$ means that the current flow of the diode has to be adjusted to the doubled value of the collector current.



Isolation resistance at $V_{IS} = 500V$

$R_{IS} \quad 10^{11} \quad \Omega$

Climatic conditions

Application in acc. with DIN 40040, humidity category F

Flammability

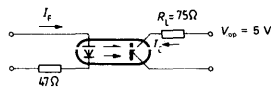
In acc. with DIN 57471 or VDE 0471, part 2 (April '75) and/or MIL 202 E, method 111A

| CHARACTERISTICS Tamb @ 25°C | | | | | | |
|--|----------------|---|--|--------------------------------------|----|--|
| Emitter (GaAs infrared emitter) Forward voltage ($I_F = 60 \text{ mA}$) Breakdown voltage ($I_R = 100 \mu\text{A}$) Reverse current ($V_R = 6V$) Capacitance ($V_R = 0 \text{ V}; f = 1 \text{ MHz}$) Thermal resistance ¹⁾ | | V_F V_{BR} I_R C_O R_{thJA} | 1.25 (≤ 1.65) 30 (≥ 6) 0.01 (≤ 10) 25 750 | V V μA pF K/W | | |
| Detector (silicon phototransistor) Capacitance ($V_{CE} = 5 \text{ V}; f = 1 \text{ MHz}$) Thermal resistance ¹⁾ | | C_{CE} R_{thJA} | 6.8 500 | pF K/W | | |
| Optocoupler Collector-emitter saturation voltage ($I_F = 10 \text{ mA}, I_C = 2.5 \text{ mA}$) Coupling capacitance | | $V_{CE \text{ sat}}$ C_K | 0.25 (≤ 0.4) 0.35 | V pF | | |
| The optocouplers are grouped according to their current transfer ratio I_C/I_F at $I_F = 10 \text{ mA}$ and $V_{CE} = 5V$. | | | | | | |
| Group | 1 | 2 | 3 | 4 | | |
| I_C / I_F | 40...80 | 63...125 | 100...200 | 160...320 | % | |
| Collector-emitter reverse current I_{CEO} ($V_{CE} = 10 \text{ V}$) | 2(≤ 50) | 2(≤ 50) | 5(≤ 100) | 5(≤ 100) | nA | |

¹⁾ Static air, coupler soldered to PCB or base.

Switching characteristics

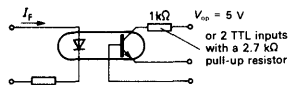
Linear operation (without saturation)



| | | | |
|-------------------|-----------|--------------------|---------------|
| Load resistance | R_L | 75 | Ω |
| Turn-on time | t_{on} | 3.0 (≤ 5.6) | μs |
| Rise time | t_r | 2.0 (≤ 4.0) | μs |
| Turn-off time | t_{off} | 2.3 (≤ 4.1) | μs |
| Fall time | t_f | 2.0 (≤ 3.5) | μs |
| Cut-off frequency | f_{co} | 250 | kHz |

$I_F = 10 \text{ mA}$
 $V_{op} = 5 \text{ V}$
 $T_{amb} = 25^\circ\text{C}$

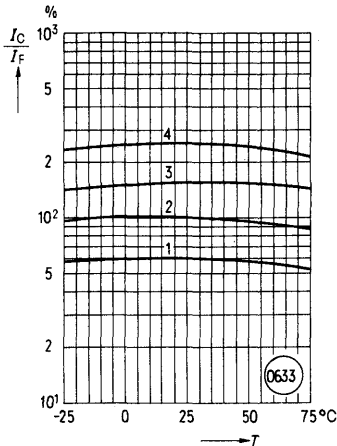
Switching operation (with saturation)



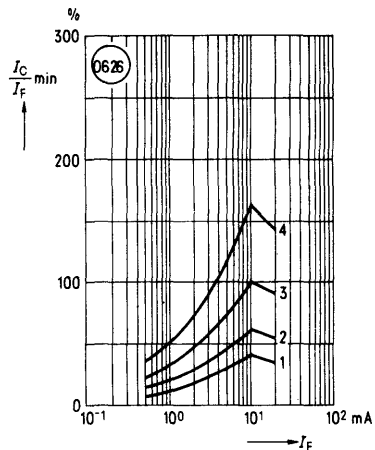
TTL level is observed but no TTL switching times

| Group | 1 $I_F = 20 \text{ mA}$ | 2 and 3 $I_F = 10 \text{ mA}$ | 4 $I_F = 5 \text{ mA}$ | | |
|---------------|----------------------------|----------------------------------|---------------------------|---------------------|---------------|
| Turn-on time | t_{on} | 3.0 (≤ 5.5) | 4.2 (≤ 8.0) | 6.0 (≤ 10.5) | μs |
| Rise time | t_r | 2.0 (≤ 4.0) | 3.0 (≤ 6.0) | 4.6 (≤ 8.0) | μs |
| Turn-off time | t_{off} | 18 (≤ 34) | 23 (≤ 39) | 25 (≤ 43) | μs |
| Fall time | t_f | 11 (≤ 20) | 14 (≤ 24) | 15 (≤ 26) | μs |
| | $V_{CE \text{ sat}}$ | 0.25 (≤ 0.4) | | | V |

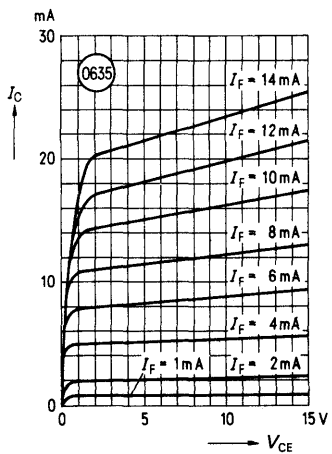
Current transfer ratio (typ.) versus temperature
 $I_F = 10 \text{ mA}; V_{CE} = 5 \text{ V}$



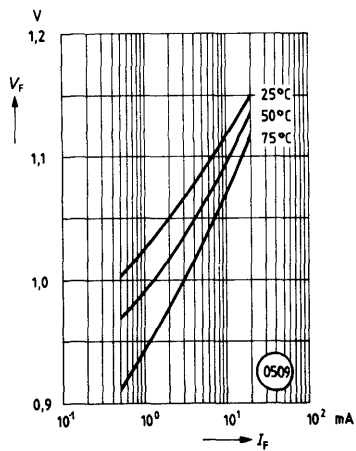
Minimum current transfer ratio versus diode forward current
 $T_{amb} = 25^\circ\text{C}; V_{CE} = 5 \text{ V}$



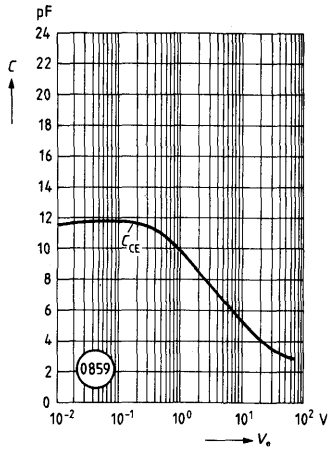
Collector current versus collector-emitter voltage (typ.)
 $T_{amb} = 25^\circ\text{C}$



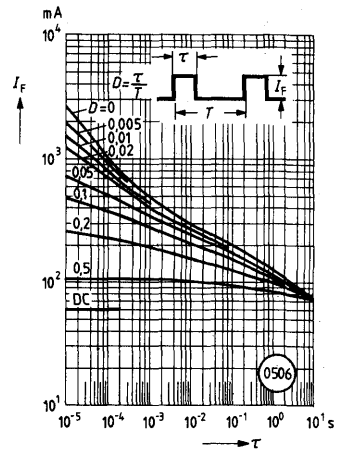
Forward voltage (typ.) of the diode versus forward current



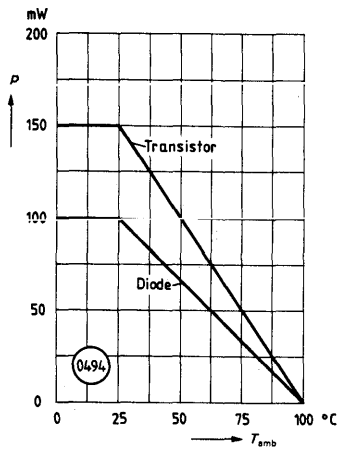
**Transistor capacitance (typ.)
versus emitter voltage**
 $T_{amb} = 25^{\circ}\text{C}; f = 1\text{ MHz}$



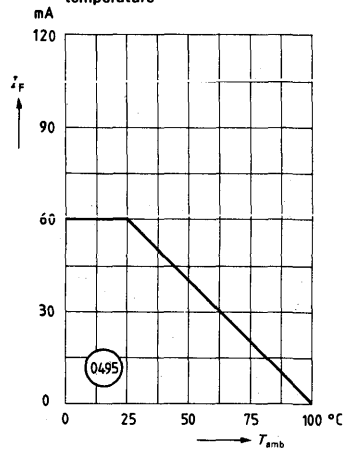
**Permissible pulse handling
capability
Forward current versus cycle
duration**
 $D = \text{parameter}; T_{amb} = 25^{\circ}\text{C}$



**Permissible power dissipation
versus ambient temperature**

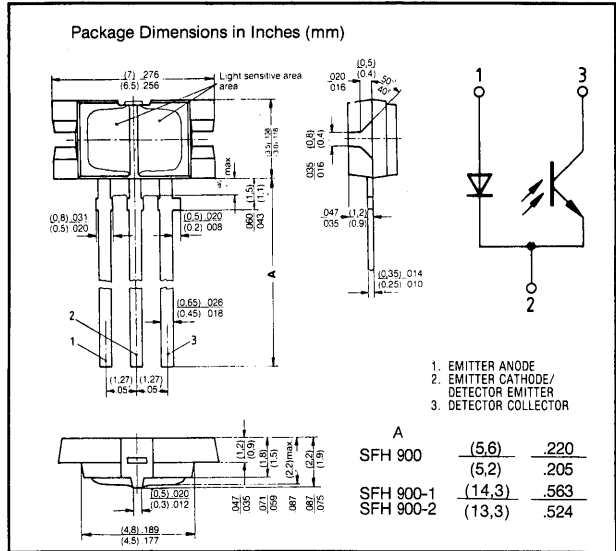
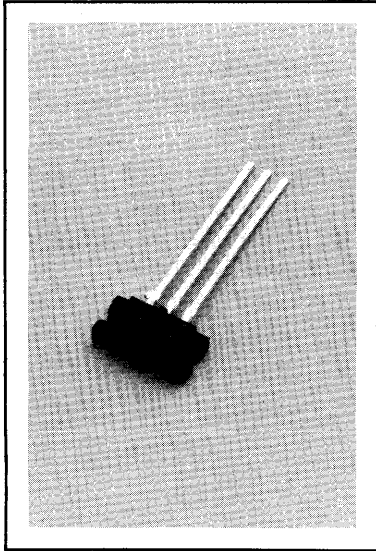


**Permissible forward current of
the diode versus ambient
temperature**



MINIATURE LIGHT REFLECTION EMITTER/SENSOR

Preliminary



FEATURES

- IR Emitter and NPN Phototransistor Detector
- High Sensitivity
- Designed for Short Distances Up to 5 mm
- Three Current Transfer Ratio Groups
 - SFH 900** — 5.6 mm leads, $I_{CE} > 0.5$ mA
 - SFH 900-1** — 14.3 mm leads, $I_{CE} > 0.3$ mA
 - SFH 900-2** — 14.3 mm leads, $I_{CE} > 0.5$ mA

DESCRIPTION

The SFH 900 is a reflex light barrier for short distances, operating in the infrared range, which includes a GaAs IRED as transmitter and an NPN phototransistor with a high photosensitivity as receiver. Both components are manufactured in modern strip-line technique and are mounted side-by-side in a plastic package. A daylight filter screens against undesired light effects.

The miniature relex light barrier is designed for applications in industrial and entertainment electronics, e.g., as position reporting device and end position switch, for speed monitoring or in general, as a sensor element in various types of motion transmitters.

Maximum Ratings

Emitter (GaAs Infrared Diode)

| | |
|---|-------|
| Reverse Voltage (V_R) | 6 V |
| Forward Current (I_F) | 50 mA |
| Surge Current (I_{FS}), $t \leq 10 \mu s$ | 1.5 A |
| Power Dissipation (P_{tot}), $T_{amb} = 40^\circ C$ | 80 mW |

Detector (Silicon Phototransistor)

| | |
|---|--------|
| Collector-Emitter Voltage (V_{CE0}) | 30 V |
| Emitter-Base Voltage (V_{EBO}) | 7 V |
| Collector Current (I_{CE}) | 10 mA |
| Power Dissipation (P_{tot}) | 100 mW |

Package

| | |
|-------------------------------------|--------------|
| Storage Temperature (T_{stor}) | -40 to +85°C |
| Operating Temperature (T_{amb}) | -40 to +85°C |
| Junction Temperature (T_j) | 100°C |
| Soldering Temperature (T_s) | |
| ($t < 3$ sec) | 235°C |
| | 260°C |
| Power Dissipation | 150 mW |

Characteristics ($T_{amb} = 25^\circ C$)

Emitter (GaAs Infrared Diode)

| | |
|--|----------------------------|
| Forward Voltage (V_F), $I_F = 50$ mA | 1.25 (≤ 1.65) V |
| Breakdown Voltage (V_{BR}), ($I_R = 10 \mu A$) | 30 (≥ 6) V |
| Reverse Current (I_R), $V_R = 6$ V | 0.01 (≤ 10) μA |
| Capacitance (C_0) ($V_R = 0$ V; $f = 1$ MHz) | 40 pF |
| Thermal Resistance (R_{thJL}) | 750 K/W |

Detector (Silicon Phototransistor)

| | |
|--|----------------------|
| Capacitance ($V_{CE} = 5$ V; $f = 1$ MHz) | |
| C_{CE} | 11 pF |
| C_{CB} | 15 pF |
| C_{EB} | 16 pF |
| Thermal Resistance (R_{thJL}) | 600 K/W |
| Collector-Emitter Leakage Current (I_{CE0}) | |
| ($V_{CE} = 10$ V) | 20 (≤ 200) nA |
| Photo Current (I_p) | |
| ($V_{CE} = 5$ V; $E_E = 0.5$ mW/cm ²) | ≤ 3 mA |

1) Dip Soldering; 3 mm From Case Bottom.

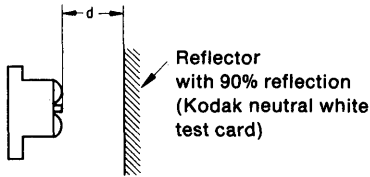
2) With Heat Sink Between Case & Soldering.

Reflex light barrier

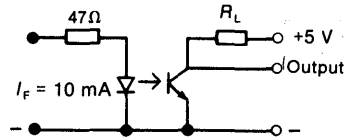
Coupling factor

Collector-emitter current

($I_F = 10 \text{ mA}$; $V_{CE} = 5 \text{ V}$; $d = 1 \text{ mm}$) SFH900 $I_{CE} \dots \geq 0.5 \text{ mA}$
 SFH900-1 $I_{CE} \dots \geq 0.3 \text{ mA}$
 SFH900-2 $I_{CE} \dots \geq 0.5 \text{ mA}$

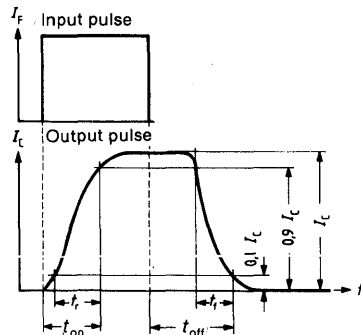


Test circuit



| Load resistance | R_L | 1 | kΩ | $I_F = 10 \text{ mA}$ |
|-----------------|-----------|-----------|----|-----------------------|
| Turn-on time | t_{on} | 65 (typ.) | μs | $I_C = 1 \text{ mA}$ |
| Rise time | t_r | 50 (typ.) | μs | |
| Turn-off time | t_{off} | 55 (typ.) | μs | |
| Fall time | t_f | 50 (typ.) | μs | |

Switching characteristics



According to the figure above the times are defined as follows:

Turn-on time t_{on}

The turn-on time t_{on} is the time in which the output current (collector current) I_C rises to 90% of its maximum value after activation of the drive current I_F .

The rise time t_r is the time in which the collector current I_C rises from 10% to 90% of its final value.

Turn-off time t_{off}

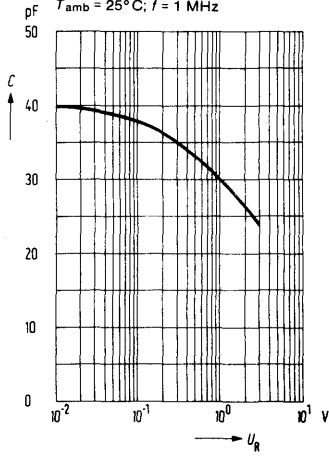
The turn-off time t_{off} is the time in which the output current (collector current) I_C drops to 10% of its maximum value after deactivation of the drive current I_F .

The fall time t_f is the time in which the collector current I_C drops from 90% to 10% of its maximum value.

Diode capacitance (typ.)

versus reverse voltage

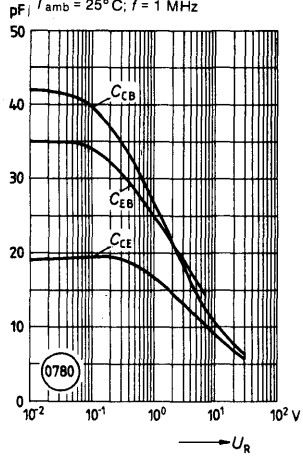
$T_{amb} = 25^{\circ}C; f = 1\text{ MHz}$



Transistor capacitance (typ.)

versus reverse voltage

$T_{amb} = 25^{\circ}C; f = 1\text{ MHz}$

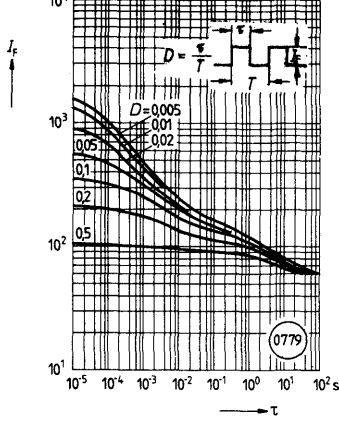


Permissible pulse handling capability

Forward current versus cycle duration

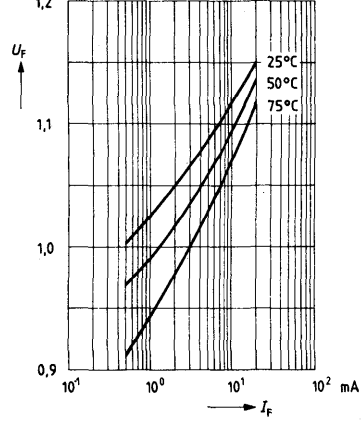
Duty cycle $D =$ parameter

$T_{amb} = 25^{\circ}C$

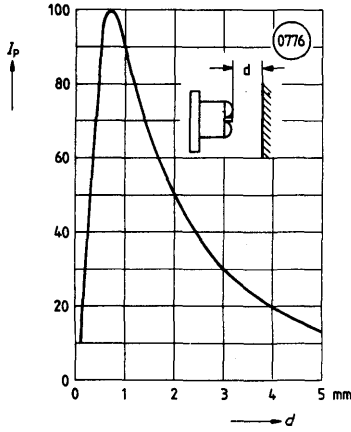


Forward voltage (typ.) of diode

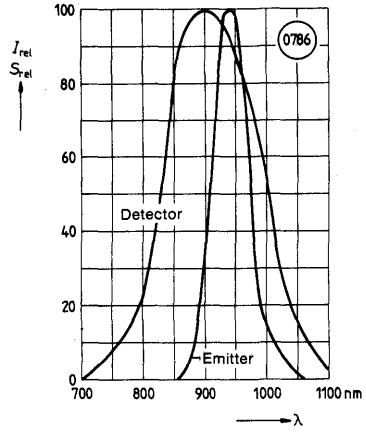
versus forward current

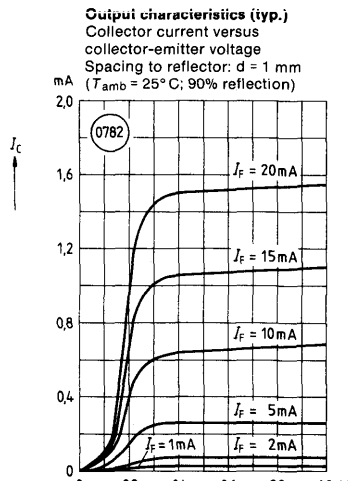
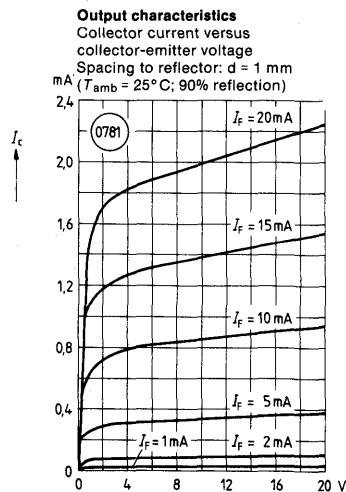
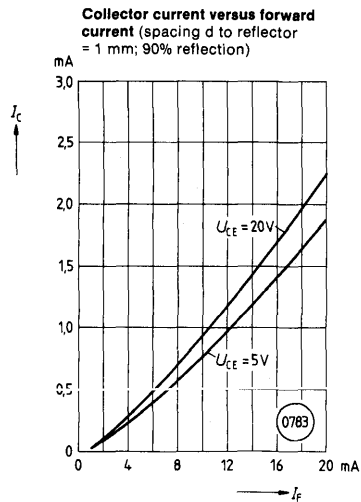
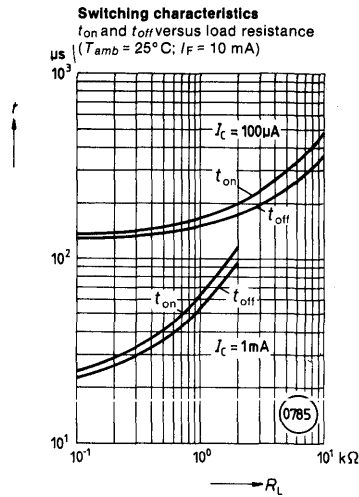
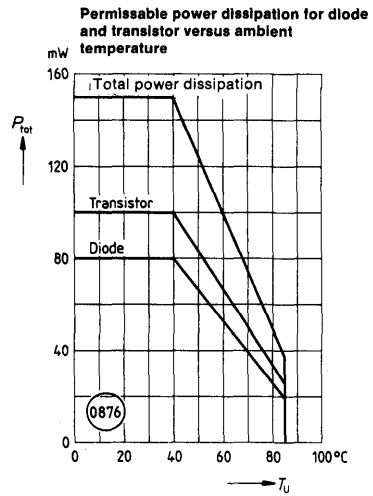
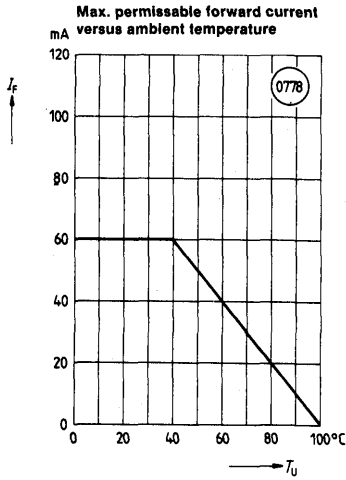


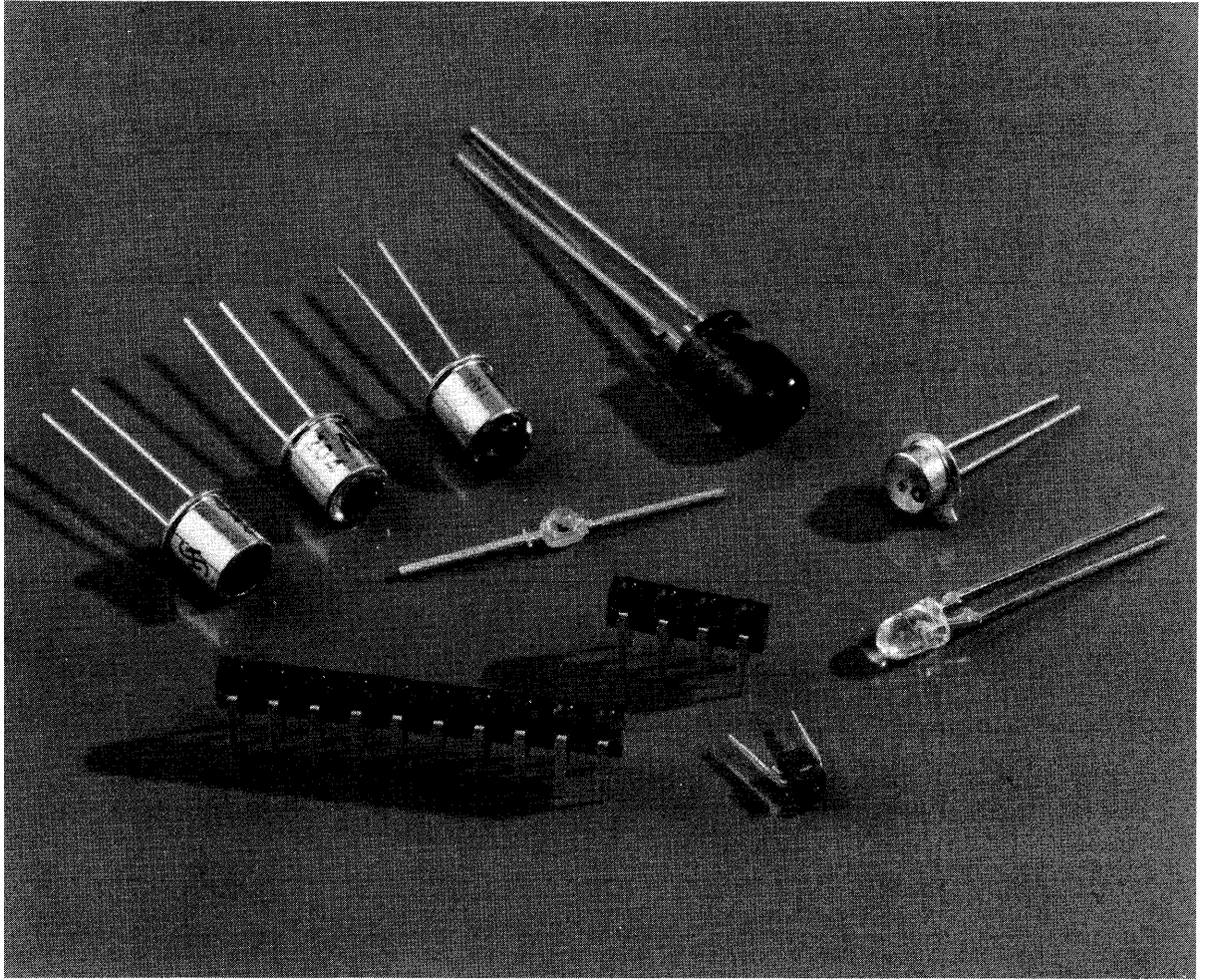
Photocurrent versus spacing of media



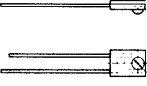


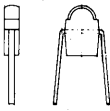

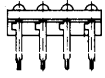
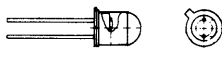
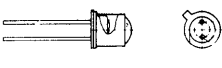
Relative spectral emission of emitter and detector versus wavelength







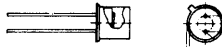
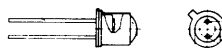
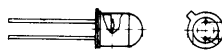

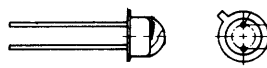
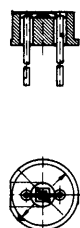
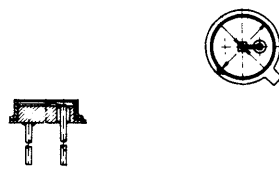
Infrared Emitters

| Package Type | Package Outline | Part Number | Half Angle | Radiant Intensity (mW/sr) | @ (mA) | Surge Current ($t < 10\mu s$) (A) | Features | Page |
|--|---|---|------------|--------------------------------------|--------|---|--|---------------|
| Miniature Clear Plastic Side Facing |  | IRL-80 | 40° | 2.75 (>0.7) | 50 | 3 | Ga As, 950 nm, side facing device, wide beam. Matches with LPT-80 phototransistor. | 281 |
| | | IRL-81 | 40° | 4.5 Typ. | 50 | 2.8 | Ga Al As, 880 nm, side facing device. Matches with LPT-80 phototransistor or LPD-80 photodarlington. | 283 |
| Miniature Axial Lead |  | IRL-60 | 25° | Total external radiated power >400μW | 50 | 1.5 | Small package size Axial Lead Ga As, 900 nm | 279 |
| Miniature Axial Lead High Dome Lens |  | IRL-61 | 18° | Total external radiated power >400μW | 50 | 1.5 | Small package size Axial Lead Ga As, 900 nm | No Data Sheet |
| Miniature Radial Lead 1 mm Pkg. Width |  | SFH405-2 | 16° | 1.6-3.2 | 50 | 1.5 | Ideal for very short range light barriers. Extremely thin. 0.99" (1 mm) package width. Radial Lead Ga As, 950 nm Matches with SFH305 phototransistor | 306 |
| | | SFH405-3 | | 2.5-5.0 | | | | |
| | | SFH405-4 | | 4.0-8.0 | | | | |
| Miniature Radial Lead 2 mm Pkg. Width |  | LD261-4 | 30° | 2.0-4.0 | 50 | 1.5 | Small package size Radial Lead GaAs, 950 nm Matches with BPX81 phototransistor | 290 |
| | | LD261-5 | | 3.2-6.3 | | | | |
| 2 Diode Array 3 Diode Array 4 Diode Array 5 Diode Array 6 Diode Array 7 Diode Array 8 Diode Array 9 Diode Array 10 Diode Array |  | LD262 LD263 LD264 LD265 LD266 LD267 LD268 LD269 LD260 | 30° | 2.0-10 | 50 | 1.5 | Ideal for card readers. 2 Through 10 diode arrays Ga As, 950 nm Matches with BPX80 family of phototransistors | |
| TO-18 Round Glass Lens |  | SFH400-2 | 6° | 20-40 | 100 | 5 | Hermetic seal for high rel. use. Narrow angle Ga As, 950 nm Recommended for use with BPX-43 phototransistor | 298 |
| | | SFH400-3 | | 32-64 | | | | |
| TO-18 Dome Glass Lens |  | SFH401-2 SFH401-3 | 15° | 10-20 16-32 | | 5 | Hermetic seal for high rel. use. Very narrow angle. Ga As, 950 nm Recommended for use with BPY62 phototransistor | 300 |

Miniature & Arrays

High Reliability

Infrared Emitters

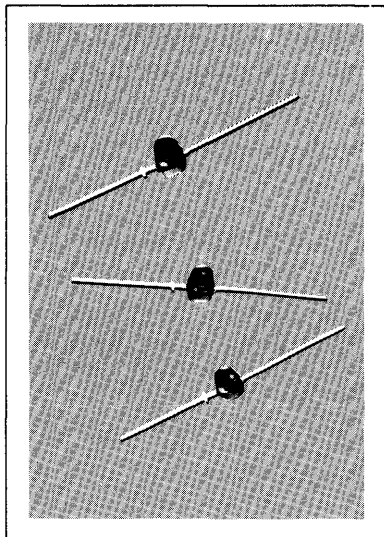
| Package Type | Package Outline | Part Number | Half Angle | Radiant Intensity I_e (mW/sr) | @(mA) | Surge Current ($t < 10\mu s$) (A) | Features | Page |
|-----------------------------|---|-------------|----------------|---|-------|-------------------------------------|--|------|
| TO-18 Flat Glass Lens |  | SFH402-2 | 40° | 2.5-5.0 | 100 | 5 | Hermetic seal for high rel use. Wide angle. Ga As. 950 nm. Recommended for use with BPX38 phototransistor or BPX65/BPX66 photodiodes. | 302 |
| | | SFH402-3 | | 4.0-8.0 | | | | |
| TO-18 Round Glass Lens |  | SFH480 | 6° | 50 | | 2.5 | Hermetic seal for high rel use. Very narrow angle, very high intensity Ga Al As. 880 nm. | 312 |
| TO-18 Flat Glass Lens |  | SFH481 | 15° | 20 | 100 | 2.5 | Hermetic seal for high rel use. Narrow angle, high intensity Ga Al As. 880 nm. | 313 |
| TO-18 Flat Glass Lens |  | SFH482 | 40° | 7 | 100 | 2.5 | Hermetic seal for high rel use. Wide angle. Ga Al As. 880 nm. | 314 |
| Modified TO-18 Lens Plastic |  | LD242-2 | 60° | 4.0-8.0 | 100 | 5 | Suitable for sound transmission. Ideal for short range light barriers. Very wide angle. High power Ga As. 950 nm. Matches with BP103 phototransistor and BPX63 photodiode. | 288 |
| | | LD242-3 | | 6.3-12.5 | | | | |
| TO-46 Flat Plastic Package |  | SFH404 | not applicable | output rad. power approx. 100μW Direct contact optical fiber ($r > 2\text{ mm}$) | 80 | .3 | Burrus type Long range For fiber optics applications. Ga Al As. 830 nm/ 40 Mbit/s | 304 |
| TO-46 |  | SFH407-1 | not applicable | 0.4-0.8 | 100 | 2 ($t < 100\mu s$) | For fiber optics applications. Ga As. 900 nm/5 Mbit/s High radiant intensity | 308 |
| | | SFH407-2 | | .63-1.25 | | | | |
| | | SFH407-3 | | 1.0-2.0 | | | | |

High Reliability

Fiber Optics

Infrared Emitters

| Package Type | Package Outline | Part Number | Half Angle | Radiant Intensity I_e (mW/sr) | @(mA) | Surge Current ($I < 10\mu s$) (A) | Features | Page |
|-----------------------------------|-----------------------------|----------------------|------------|------------------------------------|-------|---|---|--|
| T1 1/4 5 mm Grey Plastic | | LD271 | 25° | 10-15 | 100 | 2.5 | IR remote control. Most commonly used IR emitter. Low cost. Wide angle high power Ga As, 950 nm. Recommended for use with SFH205 or BP104 photodiode or BP103B phototransistor. | 292 |
| | | LD271H | | ≈ 16 | | | | |
| | | LD271L (1" Leads) | | 10-15 | | | | |
| T1 1/4, 5 mm Blue Plastic | | LD274 | 10° | 60(≥ 30) | 100 | 3 | IR remote control Ga As, 950 nm, very high intensity, narrow angle, matches with SFH205, TSP104 and BP103B phototransistor. | 296 |
| T1 1/4, 5 mm Clear Plastic | | SFH484 | 8° | 100(≥ 50) | 100 | 2.8 | IR remote control Ga Al As, 880 nm. Extremely high intensity, narrow angle. | 315 |
| T1 1/4, 5 mm clear plastic | Infrared Remote Control | SFH485 | 18° | 30(≥ 15) | 100 | 2.8 | IR remote control Ga Al As, 880 nm. High intensity, medium angle. | 317 |
| Grey Oval Plastic Package | | | LD273 | 25° | 30 | 100 | 3 | IR Remote control Space Saving IR Emitter. Two IR chips in series. Very high power Ga As, 950 nm. Recommended for use with SFH205 or BP104 photodiode or BP103B phototransistor. |
| T1 3 mm Plastic | | SFH409 | 30° | > 5 | 100 | 2 | IR remote control. Small (T1) size Ga As, 950 nm. Matches with SFH309 phototransistor. | 310 |
| T1, 3 mm Clear Plastic | | SFH487 | 20° | 30(≥ 15) | 100 | 2 | IR remote control Ga Al As, 880 nm. High intensity medium angle. | 321 |



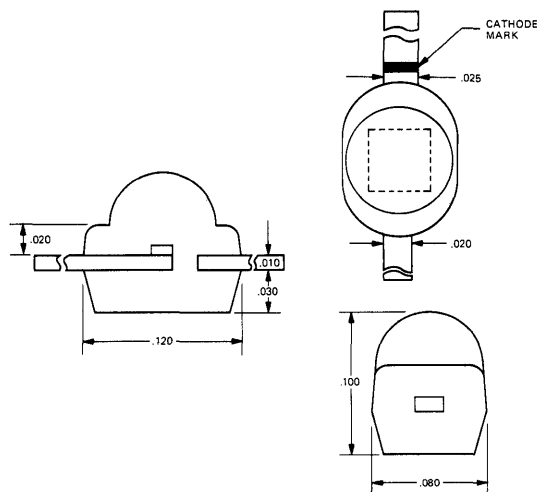
FEATURES

- Spectrally matched to Silicon Sensors
- Maximum package strength consistent with mounting on .087" centers
- Optical Encoding source
- Positioning and counting source
- Solid State reliability

DESCRIPTION

The IRL-60 is a gallium arsenide infrared emitting diode. On forward bias, it emits a spectrally narrow intense band of radiation peaking at 900 nm (the peak sensitivity point of silicon detectors). The packaging of this unit permits close-spacing in linear arrays. Its low cost and volume producibility opens new areas of use anywhere an infrared source is desirable.

DIMENSIONS (in inches, Nominal)



Maximum Ratings

| | |
|-----------------------------------|-------------|
| Power Dissipation, 25°C | 75 mW |
| Derate Linearly from 25°C | 1.0 mW/°C |
| Storage and Operating Temperature | -55 + 100°C |
| Reverse Voltage | 3.0 V |
| DC forward current | 50 mA |
| Lead solder time @ 260°C (Note 1) | 10 sec |

Opto-Electronic Characteristics

| Parameter | Min | Typ | Max | Units | Test Conditions |
|-------------------------------|-----|-----|-----|-------|------------------------|
| Total External Radiated Power | 400 | 550 | | μW | I _F = 50 mA |
| Forward Voltage | | 1.3 | 1.5 | V | I _F = 50 mA |
| Reverse Current | .15 | 10 | | μA | I _F = 3.0 V |
| Radiation Rise and Fall | | 1.0 | | n sec | |
| Capacitance | 80 | | | pF | V=0 |
| Peak Emission Wave Length | | 900 | | nm | |
| Spectral Line Half-Width | | 40 | | nm | |

NOTE:

- 1) The leads were immersed in 260° molten solder to a distance 1/16" from the body of the device per MIL-S-750.

TYPICAL OPTO-ELECTRONIC CHARACTERISTIC CURVES

Figure 1 – Radiant Intensity vs. Angle

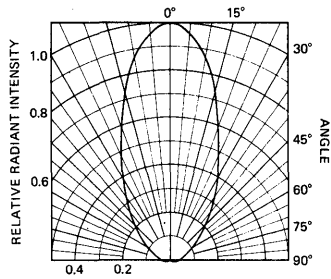


Figure 2 – Output Power vs. Input Current

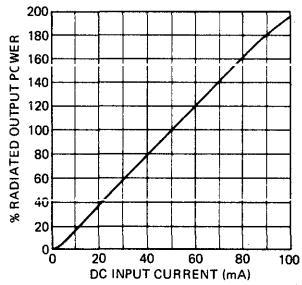
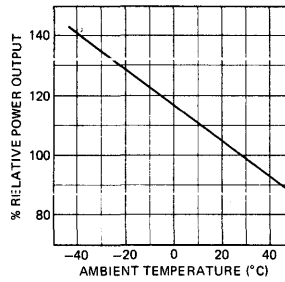
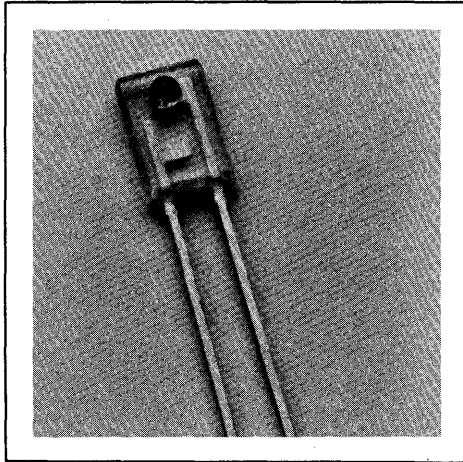


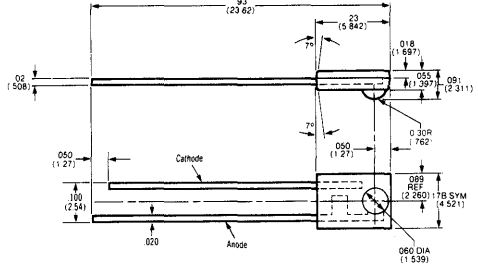
Figure 3 – % Relative Power Output vs. Ambient Temperature



Preliminary



Package Dimensions in inches (mm)



FEATURES

- GaAs Infrared emitting diode
- Low Cost
- Miniature side facing package
- Clear Plastic
- Long Term Stability
- Wide Beam, 40°
- Matches phototransistor LPT-80

DESCRIPTION

The GaAs infrared emitting diode IRL-80 is designed to emit radiation at a wavelength in the near infrared range. The chip is positioned to emit radiation from the side of the clear plastic miniature package. It operates efficiently with the matching LPT-80 phototransistor.

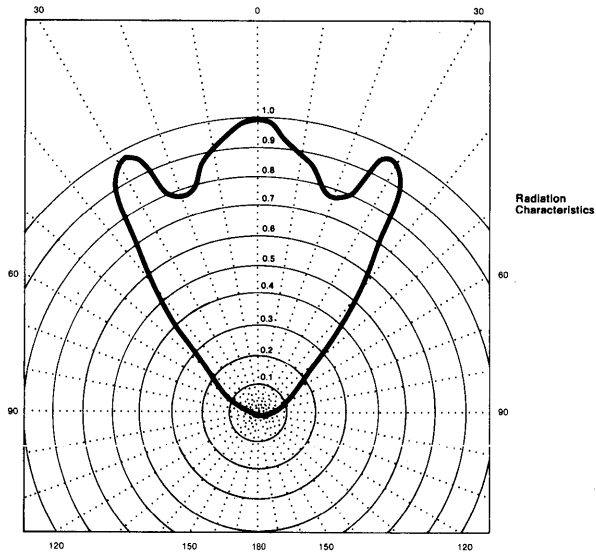
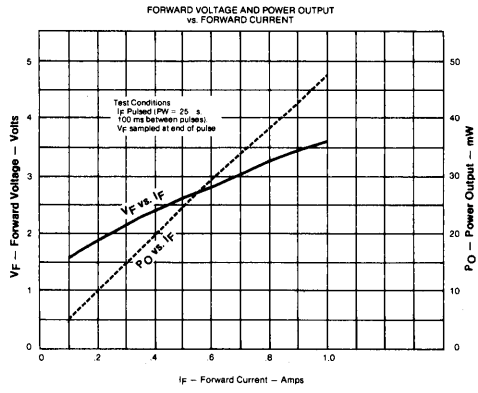
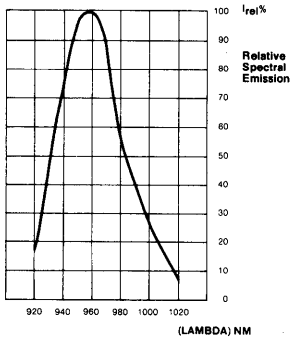
Maximum Ratings

| | | | |
|--|------------|-------------|-------|
| Reverse voltage | V_R | 4 | V |
| Forward current | I_F | 50 | mA |
| Storage temperature | T_{Stor} | -40 to +100 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{Tot} | 100 | mW |
| Derate above 25°C | | 2.0 | mW/°C |

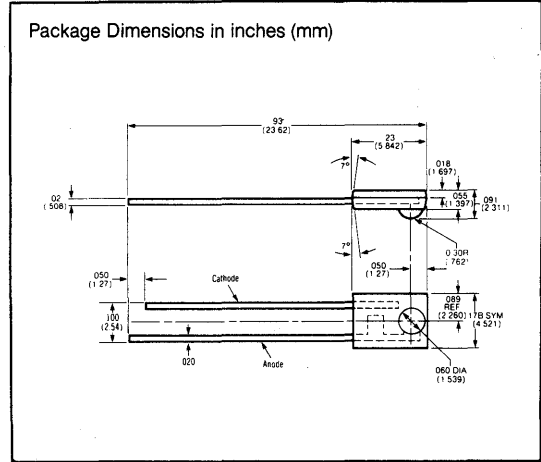
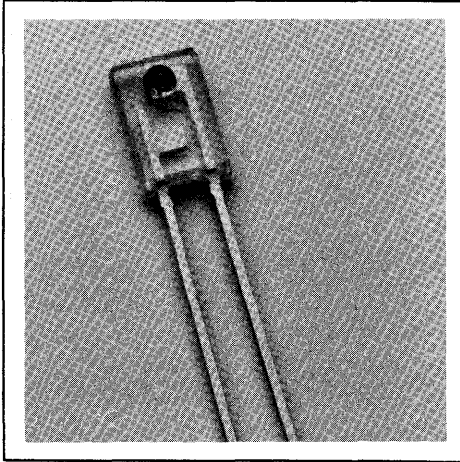
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|------------|--------------------|---------------|
| Wavelength of radiation at I_{max} | | 950 | nm |
| Spectral bandwidth at 50% of I_{max} | | ± 20 | nm |
| Radiant intensity in axial direction | | | |
| $I_F = 50$ mA for half angle $\varphi = 40^\circ$ | I_e | 2.75(≥ 0.7) | mW/ sr |
| Half angle | φ | 40 | degree |
| (limits for 50% of radiant intensity I_e) | | | |
| Switching times | | | |
| ($\frac{1}{2}I_e$ from 10% to 90%; | | | |
| 90% to 10% $I_F = 50$ mA) | t_r, t_f | 2; 1.5 | μs |
| Forward voltage ($I_F = 100$ mA) | V_F | 1.4(≤ 1.7) | V |
| Breakdown voltage ($I_R = 100 \mu\text{A}$) | V_{BR} | 30(≥ 4) | V |
| Temperature coefficient of I_e or $\frac{1}{2}I_e$ | TC | -0.55 | %/K |
| Temperature coefficient of V_F | TC | -1.5 | mV/K |
| Temperature coefficient of $\frac{1}{2}I_e$ peak | TC | +0.3 | nm/K |

Specifications are subject to change without notice



Preliminary



FEATURES

- GaAlAs Infrared emitting diode
- Low Cost
- Miniature side facing package
- Clear Plastic
- Long Term Stability
- Wide Beam, 40°
- Matches phototransistor LPT-80

DESCRIPTION

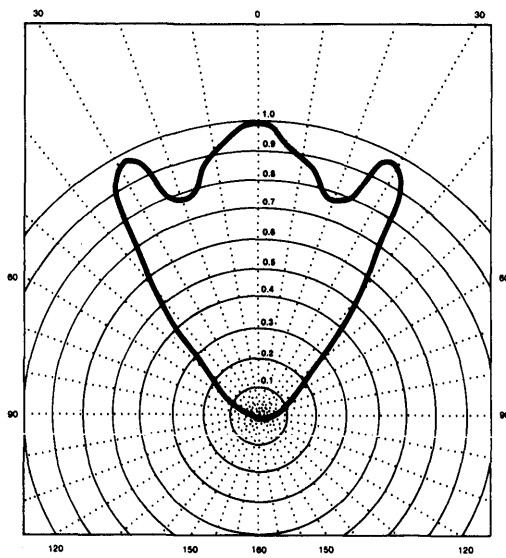
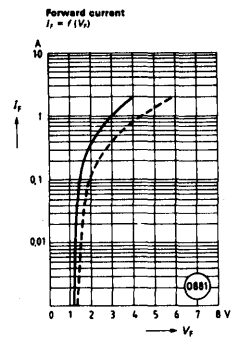
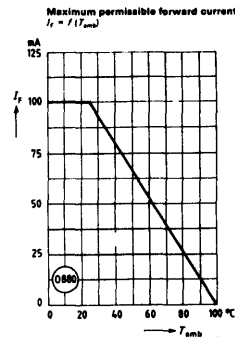
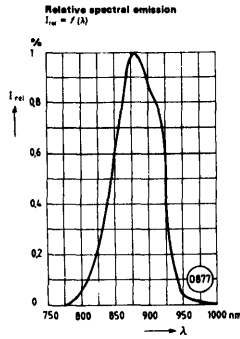
The GaAlAs infrared emitting diode IRL-81 is designed to emit radiation at a wavelength in the near infrared range. The chip is positioned to emit radiation from the side of the clear plastic miniature package. It operates efficiently with the matching LPT-80 phototransistor.

Maximum Ratings

| | | | |
|--|------------|---------------|-------|
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 100 | mA |
| Storage temperature | T_{stor} | - 40 to + 100 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 200 | mW |
| Derate above 25°C | | 1.33 | mW/°C |

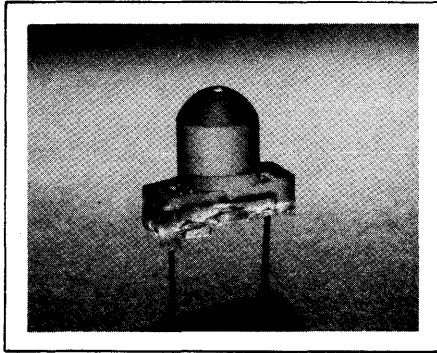
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|-----------------|--------------------|---------------|
| Wavelength of radiation at I_{max} | λ_{pk} | 883 | nm |
| Spectral bandwidth at 50% of I_{max} | $\Delta\lambda$ | - 36... + 44 | nm |
| Radiant intensity in axial direction | | 4.5 | |
| $I_F = 50\text{ mA}$ for half angle $\varphi = 40^\circ$ | I_e | 4.5 | mW/ sr |
| Half angle (limits for 50% of radiant intensity I_e) | φ | 40 | degree |
| Switching times (Φ from 10% to 90%; | | | |
| 90% to 10% $I_F = 100\text{ mA}$) | t_r, t_f | .6/ .5 | μs |
| Forward voltage ($I_F = 20\text{ mA}$) | V_F | 1.5 (≤ 2.0) | μs |
| Breakdown voltage ($I_R = 10\text{ }\mu\text{A}$) | V_{BR} | 30 (≥ 5) | V |
| Radiant Intensity $I_F = 20\text{ mA}$ | I_e | ≥ 0.5 | mW/sr |
| Radiant Power Output $I_F = 20\text{ mA}$ | P_o | 1.5 | mW |
| Temperature coefficient of I_e or Φ_e | TC | - 0.50 | %/K |
| Temperature coefficient of V_F | TC | - 0.2 | %/K |
| Temperature coefficient of Φ_{peak} | TC | + 0.25 | nm/K |



Radiation Characteristics

Advance Data Sheet



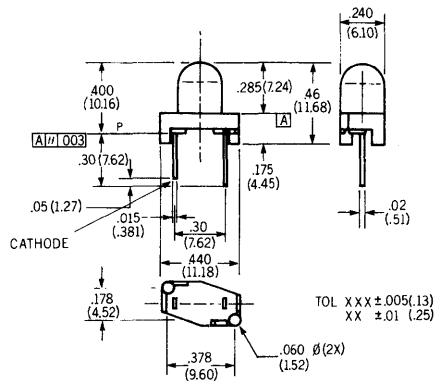
FEATURES

- Extremely accurate mechanical to optical alignment.
- Package referenced for users to maintain mechanical alignment.
- Spot size @ 20 inches is less than 1.5 inches diameter.
- Extremely narrow beam—typically 2.5° half angle.
- Clear lens.
- High intensity—greater than 30 mW/sr @ 100 mA.
- Peak emission @ 890 nm—very closely matched to silicon detectors.
- Fast on, off. Bandwidth to 7 MHz.
- Matches with LPT-500 Phototransistor.

DESCRIPTION

The IRL-500 is a GaAs infrared emitting diode designed to achieve superior optical coupling between emitter and detector. Because of the precision injection molded housing and manufacturing techniques the optical axis can be referred to any of 3 mechanical references to a tolerance within 2.5 degrees. The emitter's extremely narrow beam of 5 degrees (2.5° half angle) contains about 65% of the emitted flux and is therefore suitable for applications that require more effective optical coupling with the detector and high resolution. It can also be effectively coupled with any detector. This device is also useful as a beam interrupter in security systems, industrial controls and other applications that advantage of the narrow beam and precision alignment. It matches with the LPT-500 phototransistor detector.

Package Dimensions in Inches (mm)



MAXIMUM RATINGS

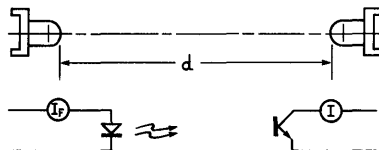
| | | |
|---|-----------|---------------|
| Reverse voltage | V_R | 2 V |
| Forward current | I_F | 50 mA |
| Surge current ($\tau \leq 100 \mu s$) | I_{FS} | 200 mA |
| Storage temperature range | T_{sto} | -40 ... +80°C |
| Junction temperature | T_j | 80°C |

Characteristics (25°C)

| | | |
|---|------------------|----------|
| Wavelength of Peak Emission | λ_{peak} | 893 nm |
| Spectral Bandwidth at 50% of I_{max} | $\Delta\lambda$ | 35 nm |
| Radiant intensity in axial direction @ 100 mA | I_o | 40 mW/sr |
| Half Angle (50% of Radiant intensity) | φ | 2.5° |
| Rise Time @ $I_F = 100$ mA | t_r | 50 nS |
| Fall Time @ $I_F = 100$ mA | t_f | 40 nS |
| Bandwidth | | 7 MHz |

Coupling Characteristics

Typical coupling characteristics using an IRL-500 emitter & LPT-500 phototransistor.



IRL-500
@ I_F

10 mA
20 mA
50 mA

$d = 4$ inches
4.35 mA
10.52 mA
20.13 mA

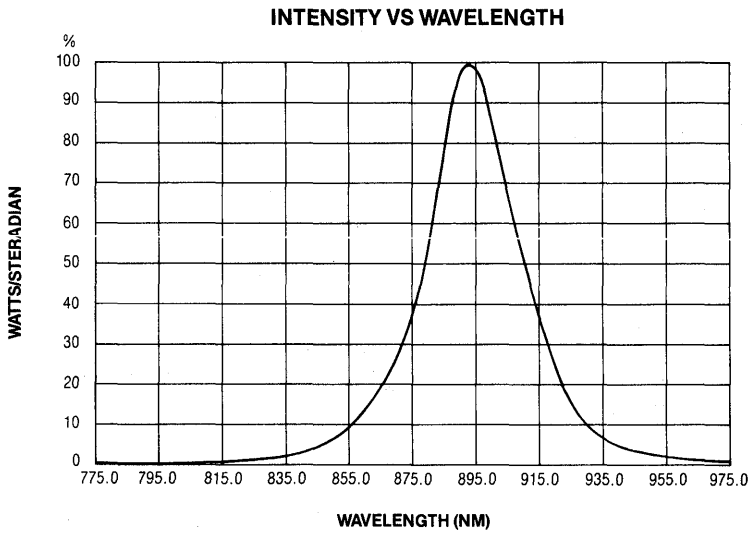
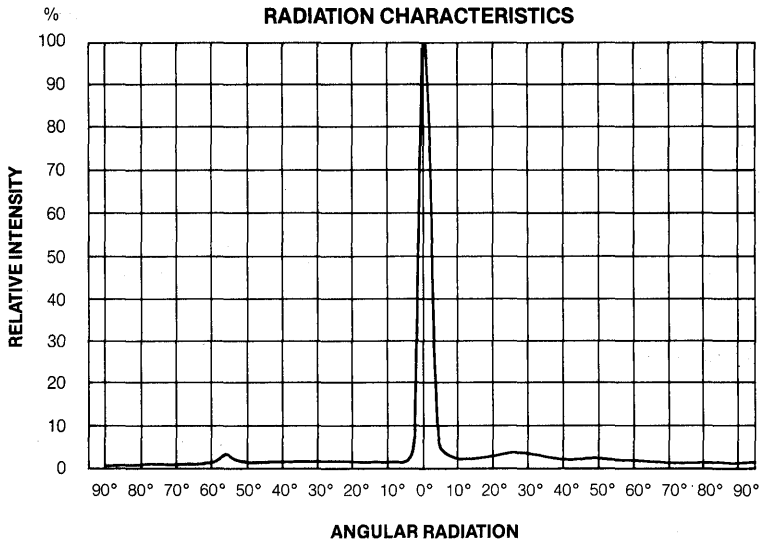
LPT-500

$I = f(d) @ V_{CE} = 5V$

8 inches
1.62 mA
4.20 mA
12.82 mA

20 inches
.201 mA
.570 mA
1.870 mA

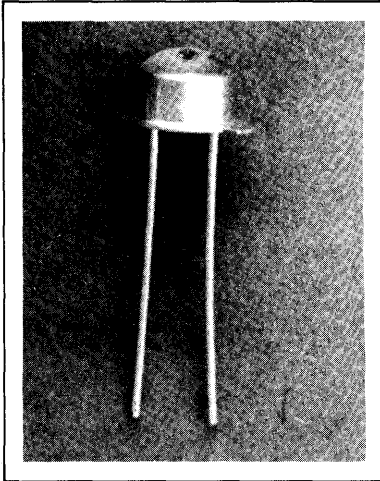
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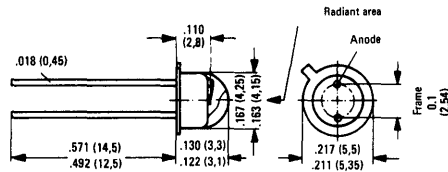


SIEMENS

LD 242 SERIES INFRARED EMITTER



Package Dimensions in Inches (mm)



Maximum Ratings

| | | | |
|------------------------------------|---------------|--------------|-------------|
| Reverse voltage | V_R | 4 | V |
| Forward current | I_F | 300 | mA |
| Surge current ($t \leq 1 \mu s$) | i_{FS} | 5 | A |
| Junction temperature | T_J | 100 | $^{\circ}C$ |
| Storage temperature | T_{stor} | -60 to + 100 | $^{\circ}C$ |
| Power dissipation | P_{tot} | 470 | mW |
| Thermal resistance | | | |
| Junction to air | $R_{th,amb}$ | 450 | K/W |
| Junction to case | $R_{th,case}$ | 135 | K/W |

Characteristics ($T_{amb} = 25^{\circ}C$)

| | | | |
|---|------------------|------------------------|---------|
| Wavelength at peak emission at I_{max} | λ_{peak} | 950 | nm |
| Spectral bandwidth at 50% of I_{max} | $\Delta\lambda$ | ± 20 | nm |
| Half angle (limits for 50% of radiant intensity I_a) | φ | 60 | degree |
| Switching times (I_a from 10% to 90%; $I_F = 100$ mA) | t_r, t_f | 1 | μs |
| Capacitance at $V_R = 0$ V | C_0 | 40 | pF |
| Forward voltage ($I_F = 100$ mA) | V_F | 1.35 (≤ 1.7) | V |
| Forward voltage ($I_F = 1$ A) | V_F | 1.9 (≤ 2.3) | V |
| Breakdown voltage ($I_R = 100 \mu A$) | V_{BR} | 30 (≥ 4) | V |
| Reverse current ($V_R = 3$ V) | I_R | 0.0 i (≈ 10) | μA |
| Temperature coefficient of I_a or ϕ_a | TC | -0.55 | %/K |
| Temperature coefficient of V_F | TC | -1.5 | mV/K |
| Temperature coefficient of λ_{peak} | TC | 0.3 | nm/K |

Radiant Intensity & Power

| Type | Group | Min | Typ | Max | Unit | Test Condition |
|----------|------------------|-----|-----|------|-------|----------------|
| LD 242-2 | Intensity I_a | 4.0 | | 8.0 | mW/sr | 100 mA |
| | Φ_a (Total) | | 10 | | mW | 100 mA |
| LD 242-3 | Intensity I_a | 6.3 | | 12.5 | mW/sr | 100 mA |
| | Φ_a (Total) | | 16 | | mW | 100 mA |

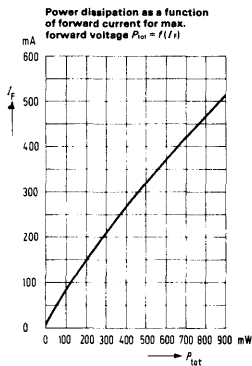
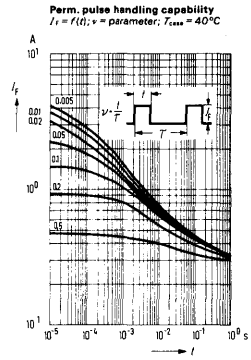
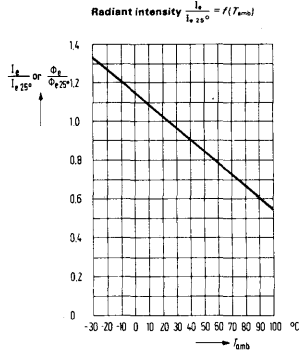
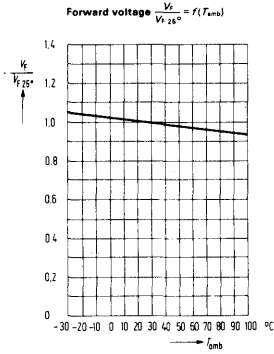
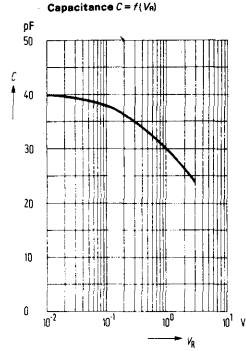
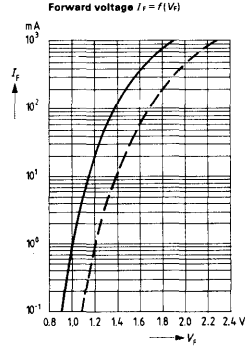
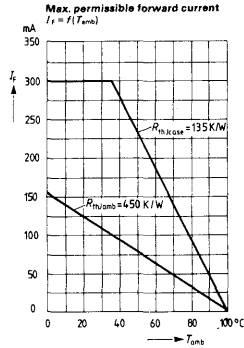
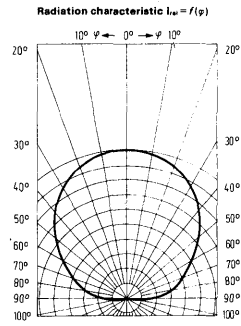
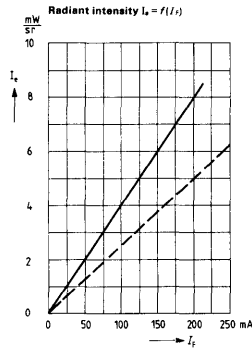
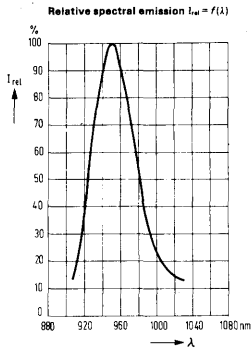
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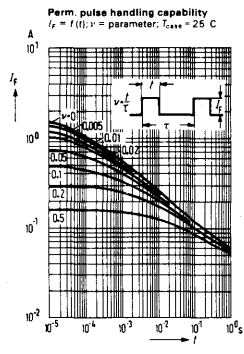
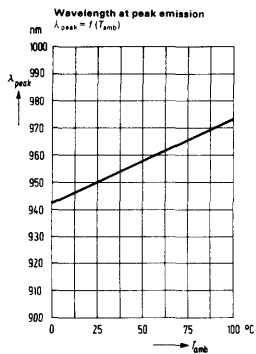
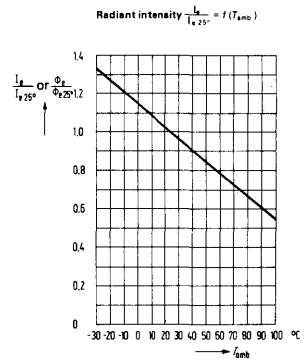
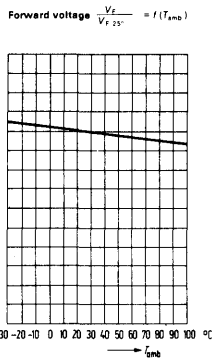
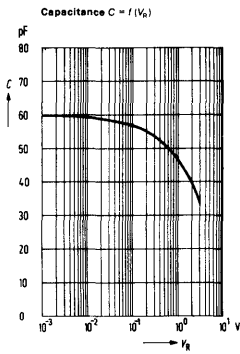
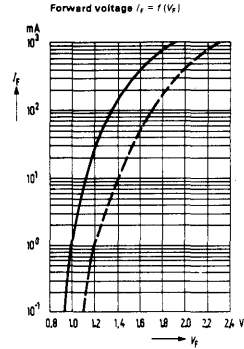
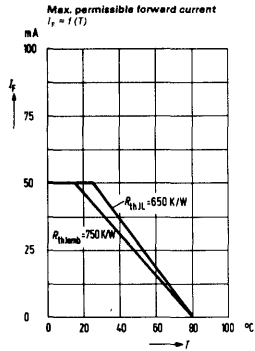
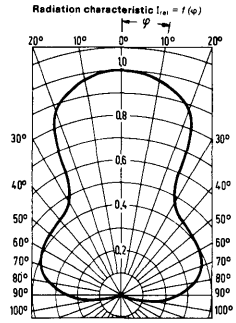
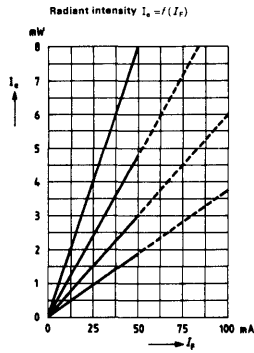
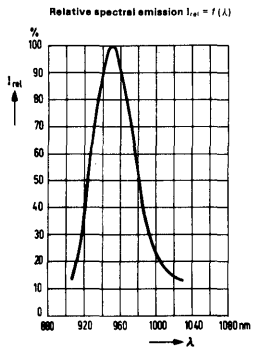
FEATURES

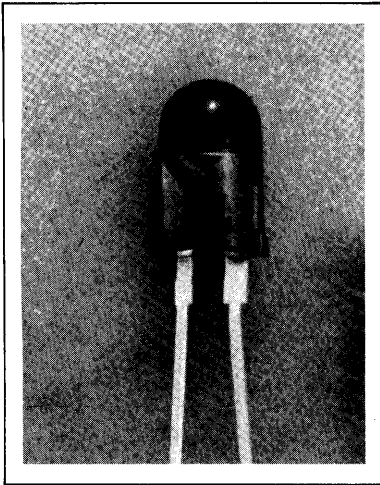
- Modified TO-18 Size Metal Case
- Rounded Plastic Lens
- Long Term Stability
- Very Wide Beam, 60°
- Very High Power, 16 mW Typical
- High Intensity, 12.5 mW/sr

DESCRIPTION

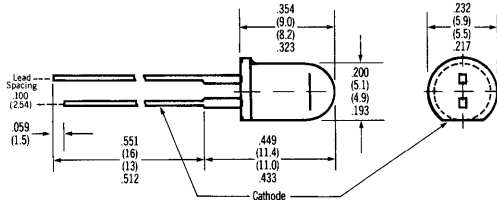
The GaAs infrared emitting diode LD 242 is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. The plastic cover permits wide-angle radiation. The anode terminal is marked by the adjacent projection on the rim of the case bottom. The cathode is electrically connected to the case. The LD 242 is particularly suitable for use as emitter for IR sound transmission in radio and TV sets.







Package Dimensions in Inches (mm)



FEATURES

- Low Cost
- T-1 $\frac{1}{4}$ Package
- Lightly Diffused Gray Plastic Lens
- LD 271L, 1-inch Leads (Polarized)
- Long-Term Stability, Typical 1000 Hour Degradation is Less Than 20%
- Medium Wide Beam, 25°
- Very High Power, 16 mW Typical
- High Intensity, 16 mW/sr

DESCRIPTION

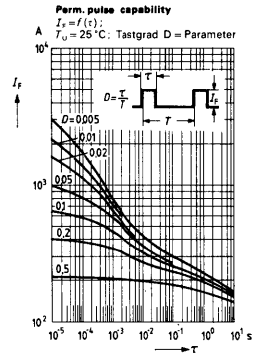
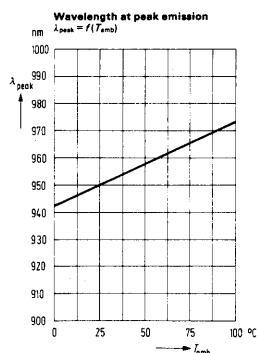
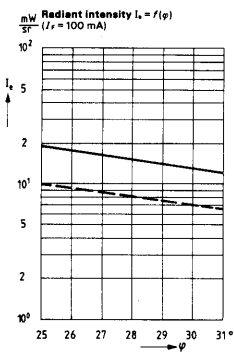
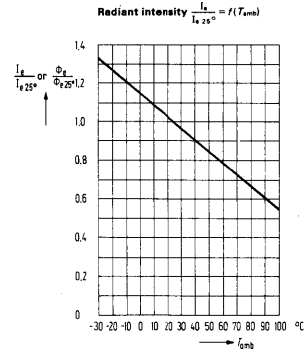
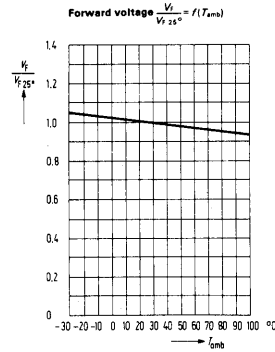
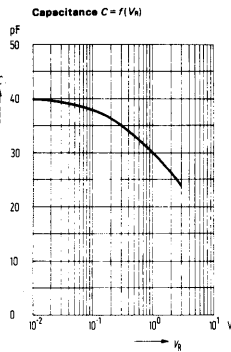
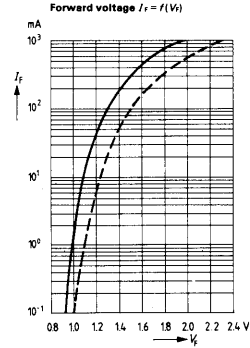
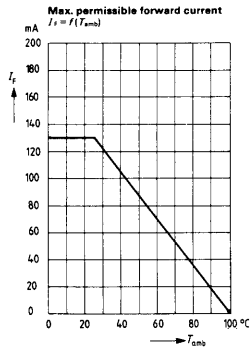
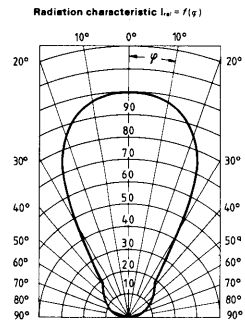
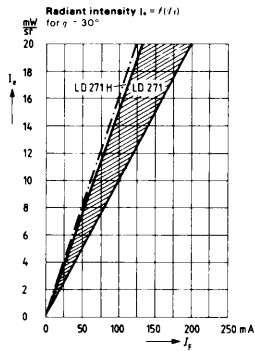
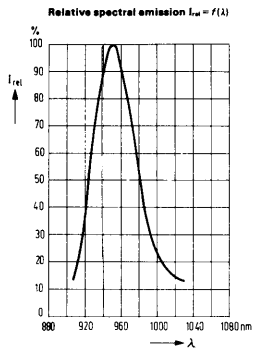
The GaAs infrared emitting diode LD 271 is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. LD 271 is enclosed in a gray plastic package of 5 mm diameter. It is preferably provided for IR remote control of color TV receivers.

Maximum Ratings

| | | | |
|---|--------------|-------------|-----|
| Reverse voltage | V_R | 4 | V |
| Forward current | I_F | 130 | mA |
| Surge current ($t \leq 10 \mu s$) | i_{FS} | 2.5 | A |
| Junction temperature | T_j | 100 | °C |
| Storage temperature | T_{stor} | -55 to +100 | °C |
| Power dissipation ($T_{case} = 40^\circ C$) | P_{tot} | 210 | mW |
| Thermal resistance | | | |
| Junction to air | R_{thJamb} | 350 | K/W |

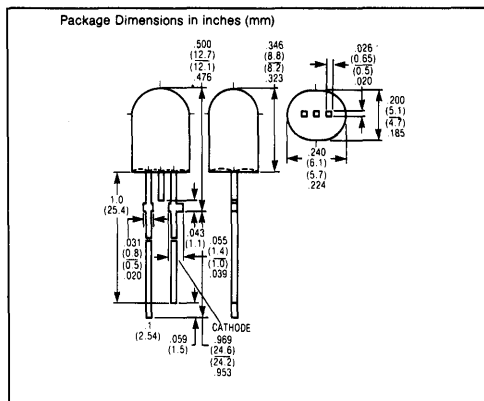
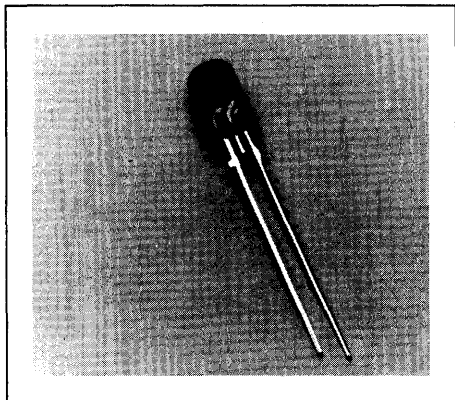
Characteristics ($T_{amb} = 25^\circ C$)

| | | | |
|---|------------------|---|---------|
| Wavelength of radiation at I_{max} | λ_{peak} | 950 | nm |
| Spectral bandwidth at 50% of I_{max} | $\Delta\lambda$ | ± 20 | nm |
| Radiant intensity in axial direction $I_F = 100 \text{ mA}$ for half angle $\varphi = 30^\circ$ | I_e | 15 (≥ 10) ≥ 16 15 (≥ 10) | mW/sr |
| LD271 LD271H LD271L | | | |
| Radiant flux ϕ_e ($I_F = 100 \text{ mA}$) total (typ.) | ϕ_e | 16 | mW |
| Half angle (limits for 50% of radiant intensity I_e) Switching times (ϕ_e from 10% to 90%; $I_F = 100 \text{ mA}$) | φ | 25 | degree |
| Capacitance at $V_A = 0 \text{ V}$ | t_r/t_f | 1 | ns |
| Forward voltage ($I_F = 100 \text{ mA}$) | C_0 | 40 | pF |
| Breakdown voltage ($I_R = 100 \mu A$) | V_F | 1.35 (≤ 1.7) | V |
| Reverse current ($V_A = 3 \text{ V}$) | V_{BR} | 30 (≥ 4) | V |
| Temperature coefficient of I_e or ϕ_e | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of V_F | TC | -0.55 | %/K |
| Temperature coefficient of λ_{peak} | TC | -1.5 | mV/K |
| | TC | +0.3 | nm/K |



SIEMENS

LD 273 TWO CHIP INFRARED EMITTER



FEATURES

- Very high radiant intensity greater than 30 mW/sr
- Two chip device
- Grey oval plastic package
- Equivalent to T1 ¾ size.

DESCRIPTION

The LD 273 is an infrared emitter consisting of two GaAs-IRLED chips connected in series. This provides a very high radiant intensity of greater than 30 mW/sr. Radiation is emitted in the axial (0°) direction from a smoke colored oval plastic package. This device serves particularly well as a powerful emitter of increased range in remote control applications.

Mounting Instruction

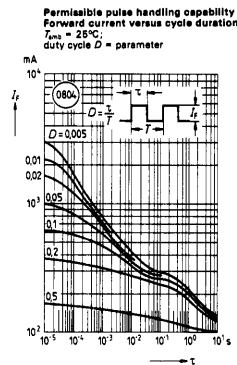
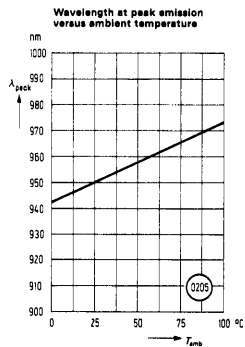
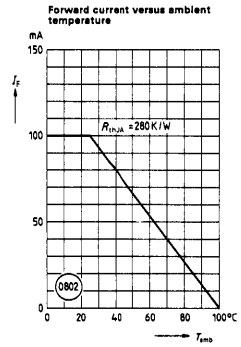
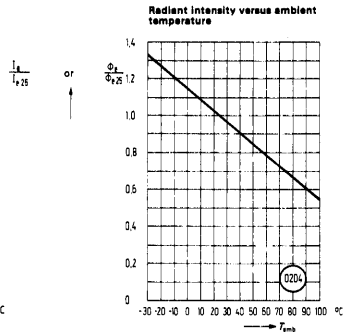
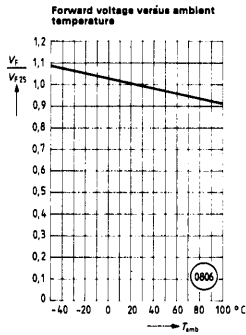
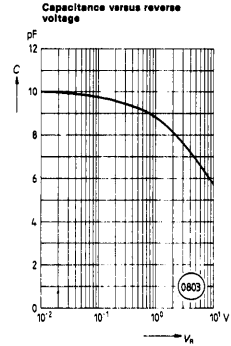
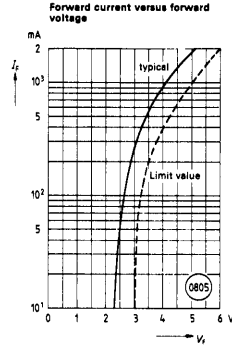
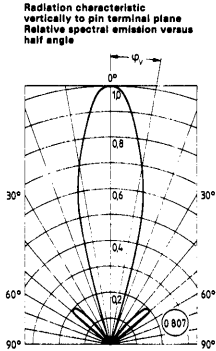
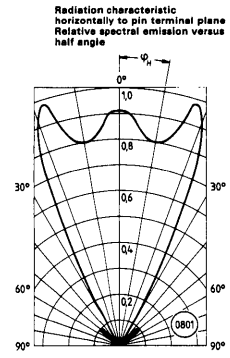
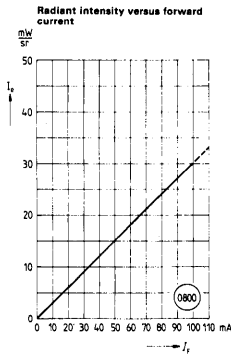
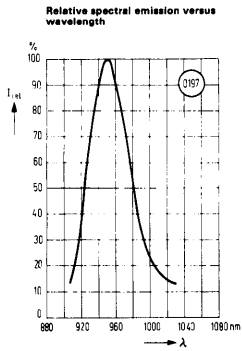
In order not to damage the system when soldering in the emitting diodes, the soldering distance to the plastic package has to be dimensioned as large as possible. We recommend a minimum distance of 10 mm between package and soldering point for the usual soldering conditions (260°C/3 sec).

Maximum ratings

| | | | |
|--|------------|---------------|-----|
| Reverse voltage | V_R | 8 | V |
| Forward current | I_F | 100 | mA |
| Surge current ($t \leq 10 \mu s$) | I_{FS} | 3 | A |
| Junction temperature | T_j | 100 | °C |
| Storage temperature range | T_{stg} | - 55... + 100 | °C |
| Total power dissipation ($T_{case} = 40^\circ C$) | P_{tot} | 260 | mW |
| Thermal resistance: junction to ambient air | R_{thJA} | 280 | K/W |

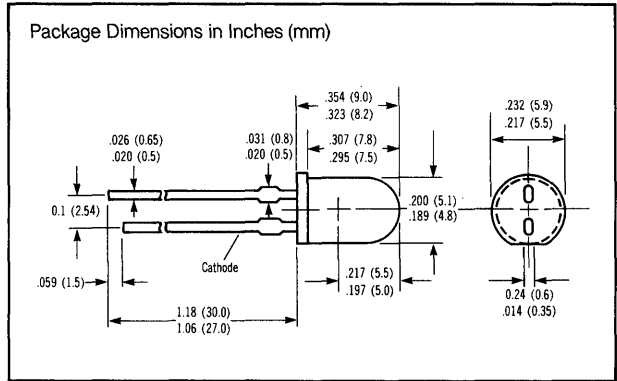
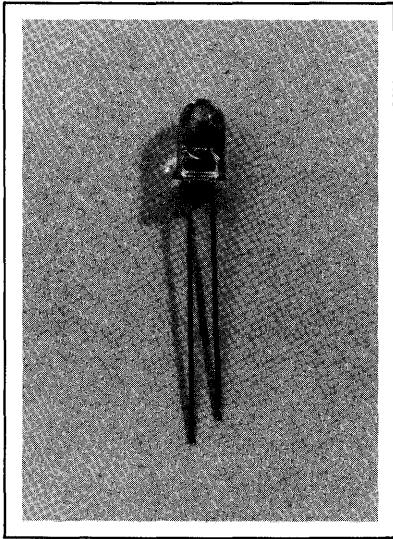
Characteristics ($T_{amb} = 25^\circ C$)

| | | | |
|--|------------------|---------------------|---------|
| Wavelength at peak emission at I_{max} | λ_{peak} | 950 | nm |
| Spectral bandwidth at 50% of I_{max} | $\Delta\lambda$ | ± 20 | nm |
| Radiant intensity in axial direction at $I_F = 100$ mA | I_e | ≥ 30 | mW/sr |
| Half angle Pin terminal plane horizontal (limits for 50% of radiant intensity I_e) | φ_H | 25 | degrees |
| Half angle Pin terminal plane vertical (limits for 50% of radiant intensity I_e) | φ_V | 15 | degrees |
| Switching times (I_e from 10% to 90%; $I_F = 100$ mA) | t_r, t_f | 1 | μs |
| Capacitance ($V_R = 0$ V) | C_0 | 10 | pF |
| Forward voltage ($I_F = 100$ mA) | V_F | 2.55 (≤ 3.2) | V |
| Breakdown voltage ($I_R = 100 \mu A$) | V_{BR} | 50 (≥ 10) | V |
| Reverse current ($V_R = 10$ V) | I_R | 1 | μA |
| Temperature coefficient of I_e or Φ_e | TC | - 0.55 | %/K |
| Temperature coefficient of V_F | TC | - 3 | mV/K |
| Temperature coefficient of λ_{peak} | TC | + 0.3 | nm/K |



SIEMENS

LD 274 Series INFRARED EMITTER



FEATURES

- Extremely High Radiant Intensity, 60mW/sr Typical
- Low Cost
- T 1 $\frac{3}{4}$ Package
- Lightly Diffused Gray Plastic Lens
- Long Term Stability, Typical 1000 Hour Degradation is Less than 20%
- Narrow Beam, 10 $^\circ$
- Excellent Spectral Match to Silicon Photodetector BP 103B

DESCRIPTION

The GaAs infrared emitting diode LD 274 emits radiation at a wavelength in the near infrared range. It is enclosed in a T 1 $\frac{3}{4}$ plastic package of 5 mm diameter. This device is designed for remote control applications requiring extremely high power.

Maximum Ratings

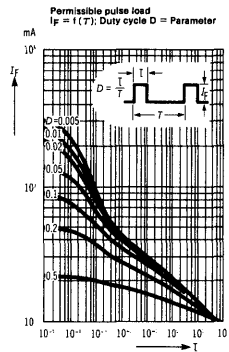
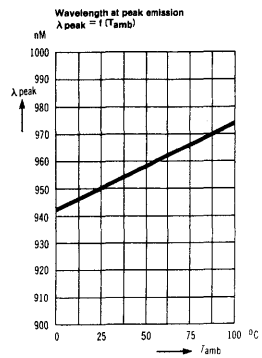
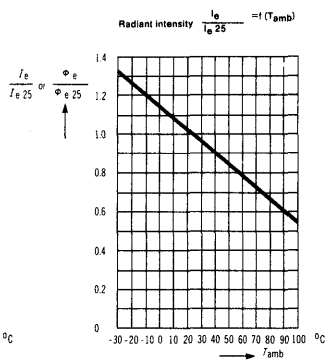
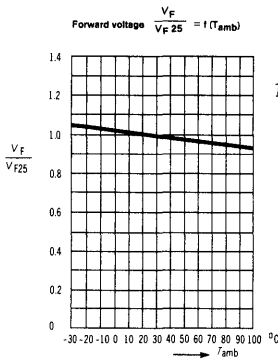
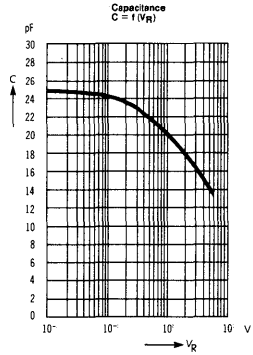
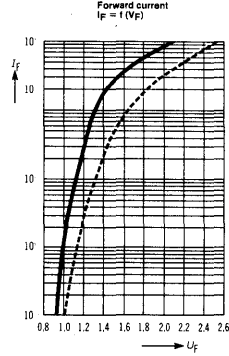
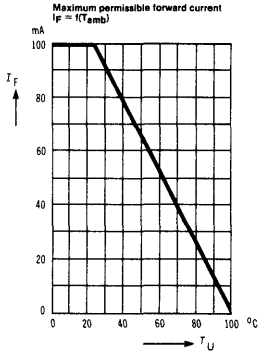
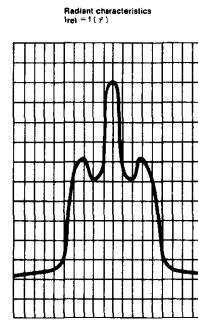
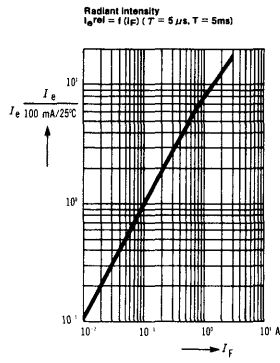
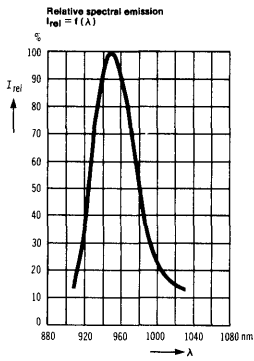
| | | | |
|--|-------------------|---------------|-----|
| Storage temperature | T _{stg} | - 55 to + 100 | °C |
| Soldering temperature | | | |
| Distance from casing-solder tab \geq 2mm | | | |
| Dip soldering time \leq 5s | T _{sold} | 260 | °C |
| Iron soldering time \leq 3s | T _{sold} | 300 | °C |
| Junction temperature | T _j | 100 | °C |
| Reverse voltage | V _R | 5 | V |
| Forward current | I _F | 100 | mA |
| Surge current ($\tau = 10\mu$ s) | I _{FS} | 3 | A |
| Power dissipation (T = 25 °C) | P _{tot} | 165 | mW |
| Thermal Resistance | R _{thA} | 450 | K/W |

Characteristics (T_{amb} = 25 °C)

| | | | |
|---|---------------------------------|--------------------|-----------------|
| Wavelength at peak emission at I _F = 100 mA, t _p = 20ms, t _{off} = 100ms | λ_{peak} | 950 \pm 20 | nm |
| Spectral bandwidth at 50% of I _{max} at I _F = i00mA, t _p = 20 ms | $\Delta\lambda$ | 70 | nm |
| Half angle | ϕ | 10 | Degree |
| Active chip area | A | 0.09 | mm ² |
| Dimensions of active chip area | L x W | 0.3 x 0.3 | mm |
| Distance chip surface to case surface | D | 5-5.5 | mm |
| Switching time: | | | |
| (I _e from 10% to 90%; I _F = 100mA) | t _r , t _f | 1 | μ s |
| Capacity (V _R = 0 V) | C _o | 25 | pF |
| Forward Voltage (I _F = 100mA) | V _F | 1.35(\leq 1.65) | V |
| (I _F = 1A; t _p = 100 μ s) | V _F | 2.0 (\leq 2.7) | V |
| Breakdown voltage (I _R = 100 μ A) | V _{BR} | 30 (\geq 5) | V |
| Reverse current (V _R = 5V) | I _R | 0.01 (\leq 10) | μ A |
| Temperature coefficient of I _e or ϕ_e | TC | - 0.55 | %/K |
| Temperature coefficient of V _F | TC | - 1.5 | mV/K |
| Temperature coefficient of λ_{peak} | TC | + 0.3 | nm/K |

Radiant intensity I_e in axial direction at a steradian $\Omega = 0.01$ sr, or 6.65 $^\circ$.

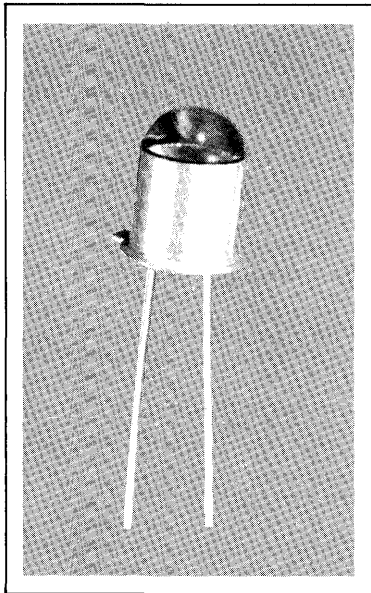
| | | | |
|---|----------------|-----------------|-------|
| Radiant intensity at (I _F = 100mA, t _p = 20 ms) | I _e | (\geq 30) 60 | mW/sr |
| I _F = 1A; t _p = 100 μ s | I _e | 400 | mW/sr |
| ϕ_e = (Total) typ. | | | |



SIEMENS

SFH 400 SERIES

INFRARED EMITTER



FEATURES

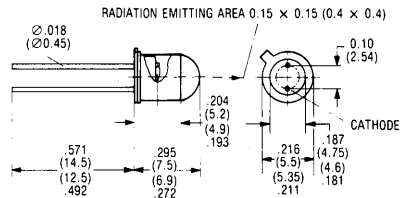
- TO-18 Hermetic Package
- Round Glass Lens
- Very Narrow Beam, 6°
- Two Very High Power Intensity Ranges

SFH 400-2, 20 to 40 mW/sr
SFH 400-3, 32 to 64 mW/sr

DESCRIPTION

The SFH-400 GaAs infrared emitting diode emits radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. The case 18 A 2 DIN 41876 (similar to TO-18) is closed by a glass lens. The anode terminal is marked by the adjacent projection on the rim of the case bottom. The cathode is electrically connected to the case. From $I_F = 100$ mA heat sinks have to be used.

Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|---|---------------|
| Reverse Voltage (V_R) | 4 V |
| Forward Current (I_F) | 300 mA |
| Surge Current (I_{FS}), $\tau \leq 1 \mu s$ | 5 A |
| Junction Temperature (T_J) | 100°C |
| Storage Temperature (T_S) | -55 to +100°C |
| Power Dissipation (P_{tot}), $T_G = 25^\circ C$ | 470 mW |
| Thermal Resistance: | |
| Junction to Air (R_{thJamb}) | 450 K/W |
| Junction to Case (R_{thJC}) | 160 K/W |

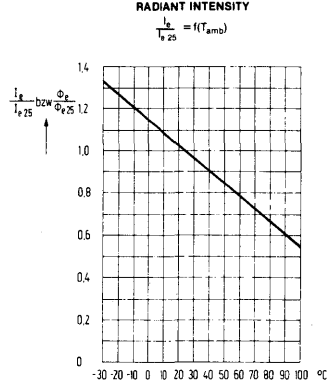
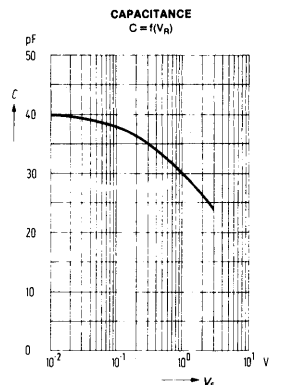
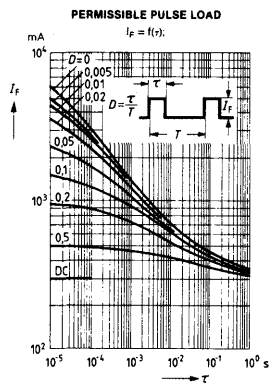
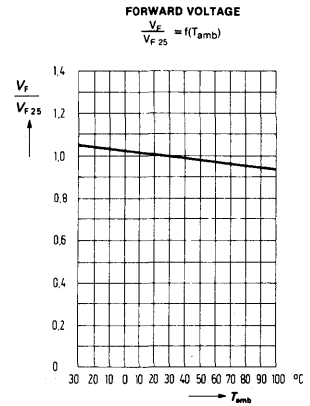
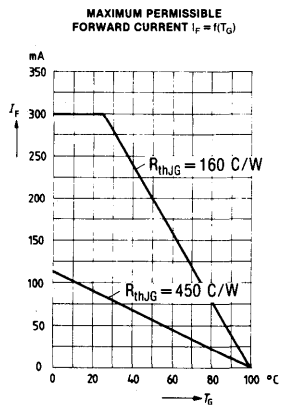
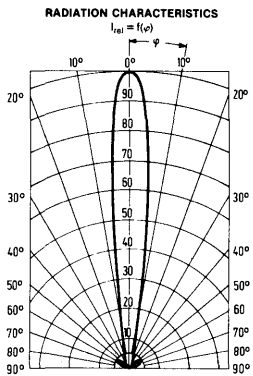
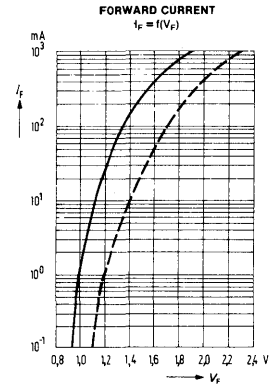
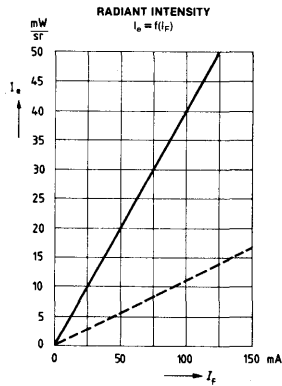
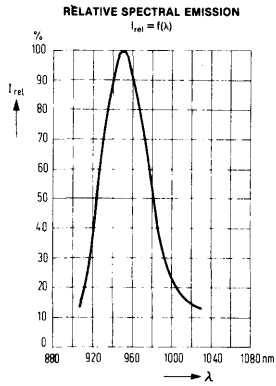
Characteristics ($T_{amb} = 25^\circ C$)

| | |
|--|----------------------------|
| Wavelength at Peak Emission (λ_{peak}), at I_{max} | 950 nm |
| Spectral Bandwidth at 50% ($\Delta\lambda$), of I_{max} | ± 20 nm |
| Half Angle (Limits for 50% of Radiant Intensity I_e), (φ) | 6 Degrees |
| Switching Times (t_e from 10% to 90%; $I_F = 100$ mA), (t_r, t_f) | 1 μs |
| Capacitance (C_J), $V_R = 0$ V | 40 μF |
| Forward Voltage (V_F) | |
| $I_F = 100$ mA | 1.35 (≤ 1.7) V |
| $I_F = 1$ A | 1.9 (≤ 2.3) V |
| Breakdown Voltage (V_{BR}), $I_R = 100 \mu A$ | 30 (≥ 4) V |
| Reverse Current (I_R) | |
| $V_R = 3$ V | 0.01 (≤ 10) μA |
| Temperature Coefficient of I_e or Φ_e (TC) | -0.55 %/K |
| Temperature Coefficient of V_F (TC) | -1.5 mV/K |
| Temperature Coefficient of λ_{peak} (TC) | 0.3 nm/K |

The diodes are grouped according to their radiant intensity $I_e =$ at $I_F = 100$ mA in axial direction.

| Group | 2 | 3 | |
|---|----------|----------|-------|
| Radiant Intensity ($\varphi = 6^\circ$) I_e | 20 to 40 | 32 to 64 | mW/sr |
| Φ_e (Total) typ. | 6.3 | 10 | mW |

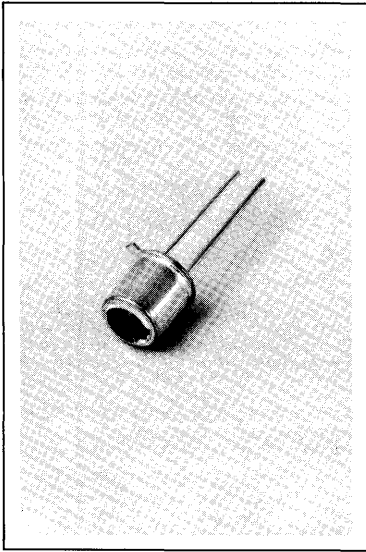
Specifications subject to change without notice.



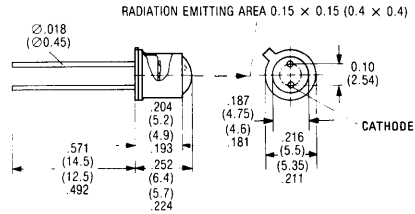
SIEMENS

SFH 401 SERIES

INFRARED EMITTER



Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|---|---------------|
| Reverse Voltage (V_R) | 4 V |
| Forward Current (I_F) | 300 mA |
| Surge Current (I_{FS}), $\tau \leq 1 \mu s$ | 5 A |
| Junction Temperature (T_j) | 100°C |
| Storage Temperature Range (T_S) | -55 to +100°C |
| Power Dissipation (P_{tot}) | 470 mW |
| Thermal Resistance | |
| Junction-to-Air (R_{thJamb}) | 450 K/W |
| Junction-to-Case (R_{thJG}) | 160 K/W |

Characteristics ($T_{amb} = 25^\circ C$)

| | |
|--|----------------------------|
| Wavelength at Peak Emission (@ I_{max}), λ_{peak} | 950 nm |
| Spectral Bandwidth (@ 50% of I_{max}), $\Delta\lambda$ | ± 20 nm |
| Half-Angle (Limits for 50% of Radiant Intensity (I_e), φ) | 15 Degrees |
| Switching Times (I_e from 10% to 90%): | |
| $I_F = 100$ mA), t_r, t_f | 1 μs |
| Capacitance ($V_R = 0$ V), C_O | 40 pF |
| Forward Voltage (V_F) | |
| ($I_F = 100$ mA) | 1.35 (≤ 1.7) V |
| ($I_F = 1$ A) | 1.9 (≤ 2.3) V |
| Breakdown Voltage ($I_R = 100 \mu A$) V_{BR} | 30 (≥ 4) V |
| Reverse Current ($V_R = 3$ V), I_R | 0.01 (≤ 10) μA |
| Temperature Coefficient of (I_e or Φ_e), TC | -0.55 %/K |
| Temperature Coefficient of (V_F), TC | -1.5 mV/K |
| Temperature Coefficient of (λ_{peak}), TC | 0.3 nm/K |

The diodes are grouped according to their radiant intensity I_e at $I_F = 100$ mA in axial direction.

| Group | 2 | 3 | |
|--|----------|----------|-------|
| Radiant Intensity ($\varphi = 15^\circ$) I_e | 10 to 20 | 16 to 32 | mW/sr |
| Φ_e (Total) typ. | 4 | 10 | mW |

FEATURES

- TO-18 Hermetic Package
- Dome Glass Lens
- Narrow Beam, 15°
- Two High Power Intensity Ranges

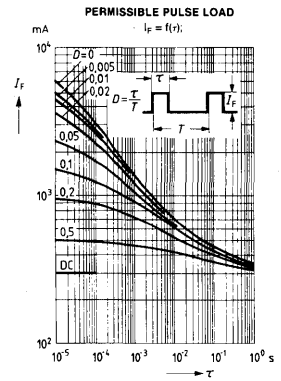
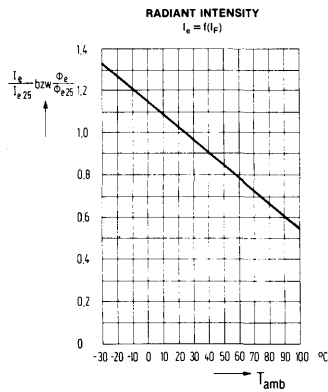
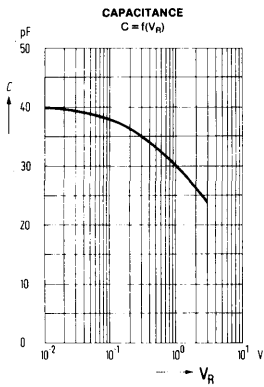
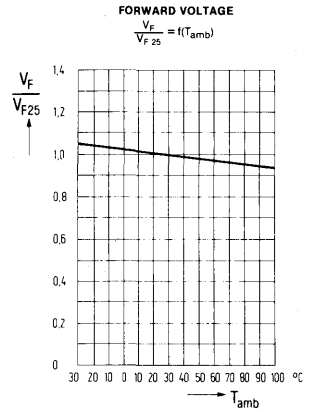
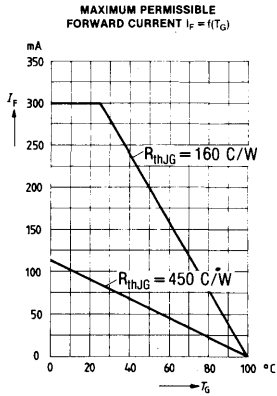
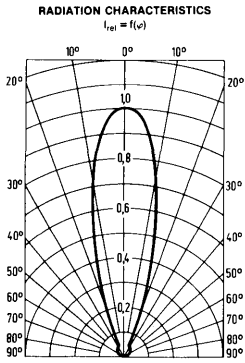
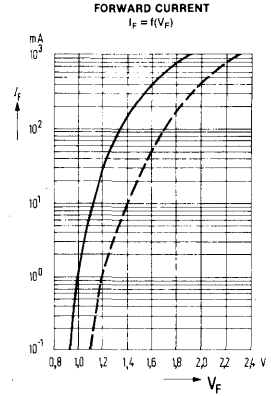
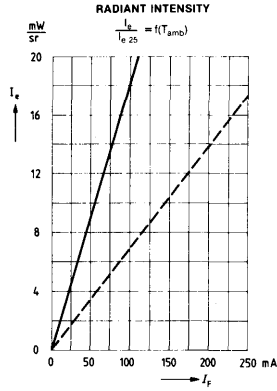
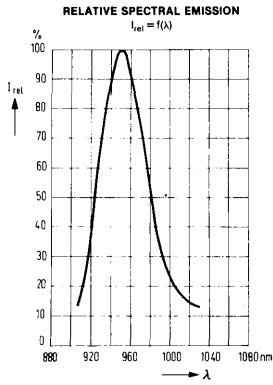
SFH 401-2, 10 to 20 mW/sr

SFH 401-3, 16 to 32 mW/sr

DESCRIPTION

The SFH 401 GaAs infrared emitting diode is designed to emit radiation at a wavelength in the near infrared. The radiation emitted is excited by current flowing in forward direction and can be modulated. The case 18A 2 DIN41876 (similar to TO-18) is closed by a glass lens. The anode terminal is marked by the adjacent projection on the rim of the case bottom. The cathode is electrically connected to the case. From $I_F = 100$ mA heat sinks have to be used.

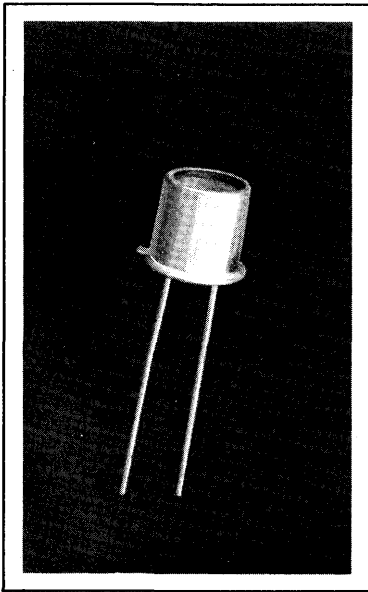
Specifications subject to change without notice.



SIEMENS

SFH 402 SERIES

INFRARED EMITTER



FEATURES

- TO-18 Hermetic Package
- Flat Glass Lens
- Wide Beam, 40°
- Two Intensity Ranges

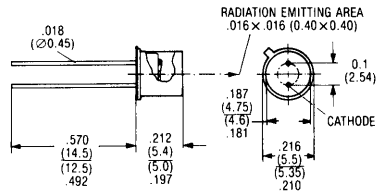
SFH 402-2, 2.5 to 5.0 mW/sr

SFH 402-3, 4.0 to 8.0 mW/sr

DESCRIPTION

The SFH 402 GaAs infrared emitting diode is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. The case similar to TO-18 is equipped with a flat light window. The anode is marked by the adjacent projection on the rim of the case bottom. The cathode is electrically connected to the case. From $I_F = 100$ mA heat sinks have to be used.

Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|---|----------------|
| Reverse Voltage (V_R) | 4 V |
| Forward Current (I_F) | 300 mA |
| Surge Current (i_{FS}), $\tau \leq 1 \mu s$ | 5 A |
| Junction Temperature (T_J) | 100 °C |
| Storage Temperature (T_S) | -55 to +100 °C |
| Power Dissipation (P_{tot}) | |
| ($T_{amb} = 25$ °C) | 470 mW |
| Thermal Resistance | |
| Junction-to-Air (R_{thJamb}) | 450 K/W |
| Junction-to-Case (R_{thJG}) | 160 K/W |

Characteristics ($T_{amb} = 25$ °C)

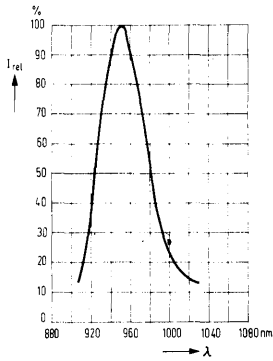
| | |
|--|----------------------------|
| Wavelength at Peak Emission (@ I_{max}), λ_{peak} | 950 nm |
| Spectral Bandwidth (@ 50% of I_{max}), $\Delta\lambda$ | ± 20 nm |
| Half-Angle (Limits for 50% of Radiant Intensity I_e), φ | 40 Degrees |
| Switching Times (I_e from 10% to 90%; | |
| $I_F = 100$ mA), t_r ; t_f | 1 μs |
| Capacitance ($V_R = 0$ V), C_0 | 40 pF |
| Forward Voltage (V_F) | |
| ($I_F = 100$ mA) | 1.35 (≤ 1.7) V |
| ($I_F = 1$ A) | 1.9 (≤ 2.3) V |
| Breakdown Voltage ($I_R = 100 \mu A$), V_{BR} | 30 (≥ 4) V |
| Reverse Current ($V_R = 3$ V), I_R | 0.01 (≤ 10) μA |
| Temperature Coefficient of (I_e or Φ_e), TC | -0.55 %/K |
| Temperature Coefficient of (V_F), TC | -1.5 mV/K |
| Temperature Coefficient of (λ_{peak}), TC | 0.3 nm/K |

The diodes are grouped according to their radiant intensity I_e at $I_F = 100$ mA in axial direction.

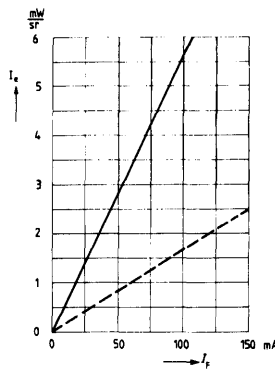
| Group | 2 | 3 | |
|--|----------|--------|-------|
| Radiant Intensity ($\varphi = 40^\circ$) I_e | 2.5 to 5 | 4 to 8 | mW/sr |
| Φ_e (Total) typ. | 6.3 | 10 | mW |

Specifications subject to change without notice.

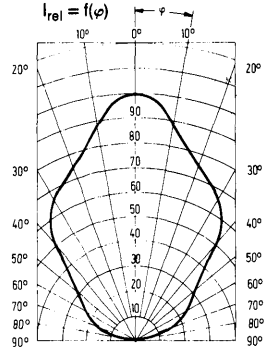
RELATIVE SPECTRAL EMISSION
 $I_{rel} = f(\lambda)$



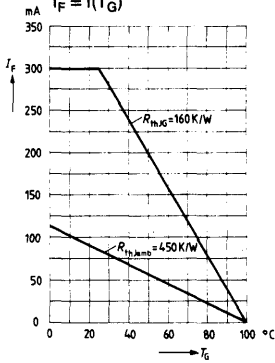
RADIANT INTENSITY
 $I_e = f(I_F)$



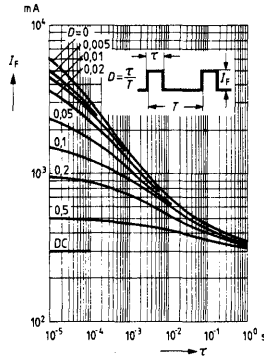
RADIATION CHARACTERISTICS
 $I_{rel} = f(\varphi)$



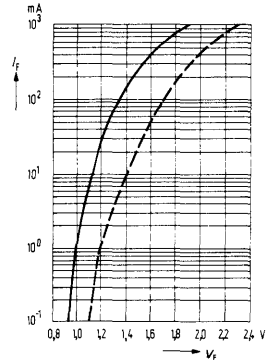
MAXIMUM PERMISSIBLE FORWARD CURRENT
 $I_F = f(T_G)$



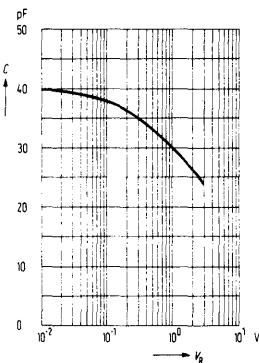
PERMISSIBLE PULSE LOAD
 $I_F = f(\tau)$



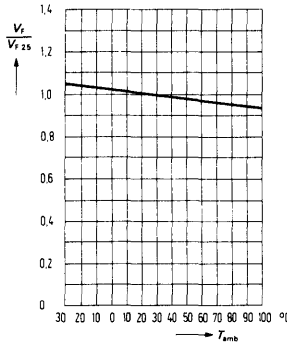
FORWARD CURRENT
 $I_F = f(V_F)$



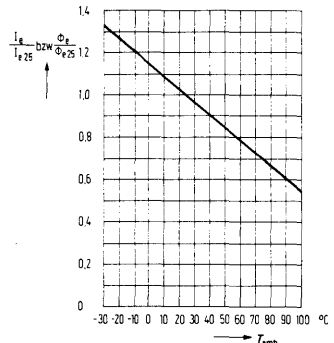
CAPACITANCE
 $C = f(V_R)$



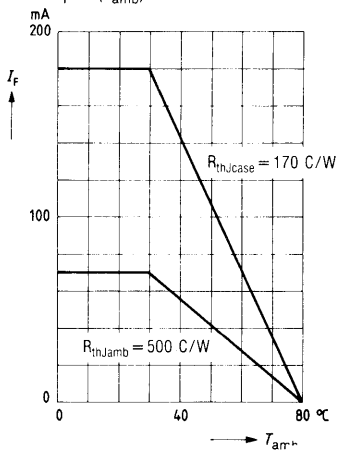
FORWARD VOLTAGE
 $\frac{V_F}{V_{F25}} = f(T_{amb})$



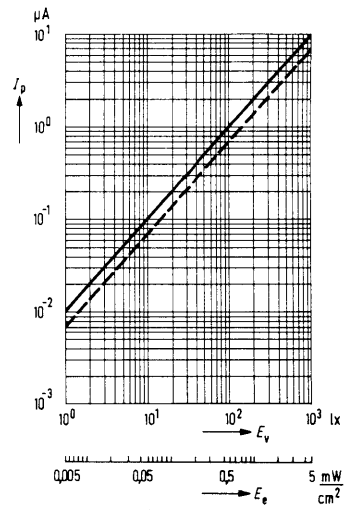
RADIANT INTENSITY
 $\frac{I_e}{I_{e25}} = f(T_{amb})$



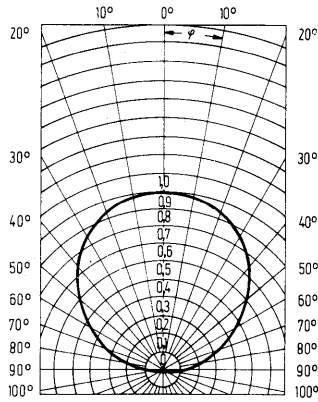
MAXIMUM PERMISSIBLE FORWARD CURRENT
 $I_F = f(T_{amb})$



PHOTOCURRENT
 $I_P = f(E_v)$



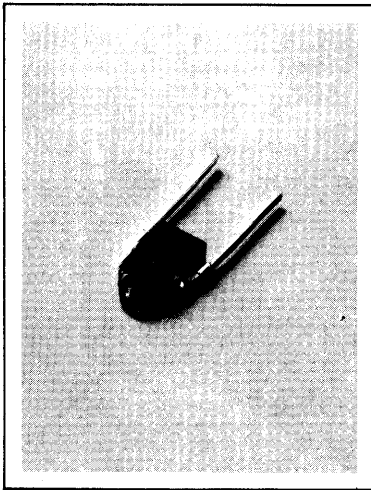
RADIATION CHARACTERISTICS
 $I_P = f(\varphi)$



SIEMENS

SFH 405 SERIES

INFRARED EMITTER



FEATURES

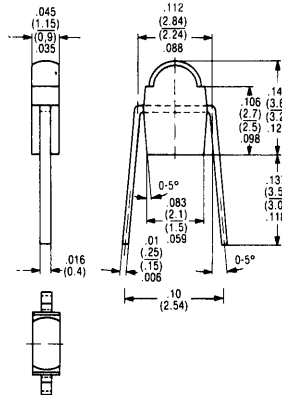
- Miniature Plastic Package
- 1/10" (2.54 mm) Lead Spacing
- Emitter for SFH-305 Phototransistor Detector
- Designed for Maximum Spacing of 10 mm Between Emitter and Detector
- Three Radiant Intensity Groups

DESCRIPTION

The SFH 405 is a GaAs infrared diode which emits radiation at a wavelength in the near infrared. The radiation emitted is excited by current flowing in the forward direction.

The case is transparent plastic with a lens shaped light output. The plastic is slightly smoke colored in order to differentiate between phototransistors of the same type (SFH 305). The terminals are solder pins in 1/10" (2.54 mm) lead spacing. The infrared emitting diodes are grouped according to radiation intensity. SFH 405 is suitable for use as emitter with the phototransistor SFH 305 to effect miniature light barriers with close spacing between sender and receiver up to 10 mm maximum. The cathode is marked with a colored dot.

Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|--|---------------|
| Reverse Voltage (V_R) | 4 V |
| Forward Current (I_F) | 40 mA |
| Surge Current (I_{FS} , $t \leq 10 \mu s$) | 1.5 A |
| Junction Temperature (T_J) | 80 °C |
| Storage Temperature (T_S) | -40 to +80 °C |
| Soldering Temperature in a 2 mm case. (T_L) ($t \leq 3$ s) | 230 °C |
| Power Dissipation (P_{Tot}) ($T_{amb} = 25$ °C) | 65 mW |
| Thermal Resistance | |
| Junction-to-Air (R_{thJamb}) | 950 K/W |
| Junction-to-Case (R_{thJL}) | 850 K/W |

Characteristics ($T_{amb} = 25$ °C)

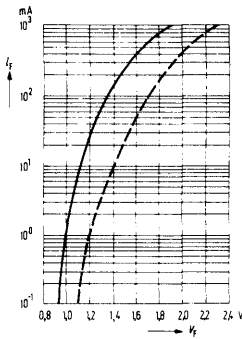
| | |
|---|----------------------------|
| Wavelength at Peak Emission at I_{max} , λ_{peak} | 950 nm |
| Spectral Bandwidth at 50% of I_{max} , $\Delta\lambda$ | ± 20 nm |
| Switching Times (I_e from 10% to 90%; | |
| $I_F = 50$ mA), t_r ; t_f | 1 μs |
| Capacitance ($V_R = 0$ V), C_O | 60 pF |
| Forward Voltage ($I_F = 50$ mA), V_F | 1.25 (≤ 1.6) V |
| Breakdown Voltage ($I_R = 100 \mu A$), V_{BR} | 30 (≥ 4) V |
| Reverse Current ($V_R = 3$ V), I_R | 0.01 (≤ 10) μA |
| Temperature Coefficient of I_e or Φ_e , TC | -0.55%/K |
| Temperature Coefficient of V_F , TC | -1.5 mV/K |
| Temperature Coefficient of λ_{peak} , TC | 0.3 nm/K |
| Half Angle, φ | 16 Degrees |

| Group | SFH 405-2 | SFH 405-3 | SFH 405-4 | |
|-----------------------|------------|------------|------------|-------|
| Radiant Intensity | | | | |
| I_e @ $I_F = 50$ mA | 1.6 to 3.2 | 2.5 to 5.0 | 4.0 to 8.0 | mW/sr |
| Φ_e (Total) typ. | 2.5 | 4 | 6.3 | mW |

Specifications subject to change without notice.

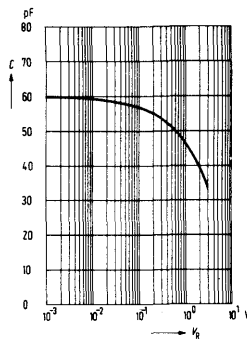
FORWARD CURRENT

$I_F = f(V_F)$



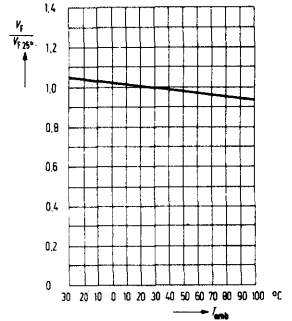
CAPACITANCE

$C = f(V_F)$



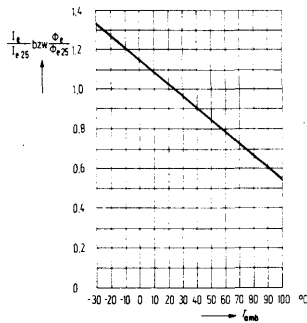
FORWARD VOLTAGE

$V_{F25} = f(T_{amb})$



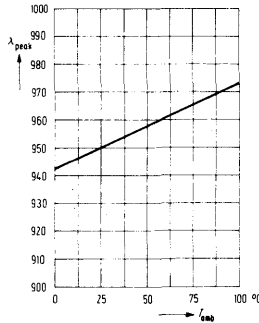
RADIANT INTENSITY

$I_e = f(T_{amb})$



WAVELENGTH AT PEAK EMISSION

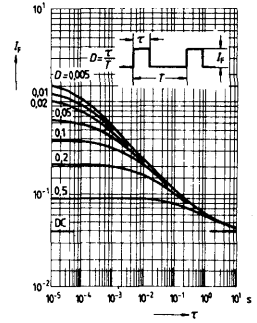
$\lambda_{peak} = f(T_{amb})$



PERMISSIBLE PULSE LOAD

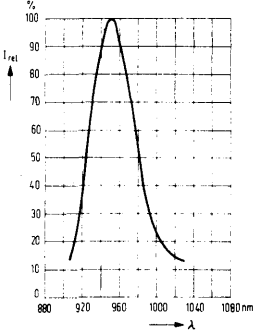
$I_F = f(\tau); T_{amb} = 25^\circ\text{C};$

Duty Cycle $D = \text{Parameter}$



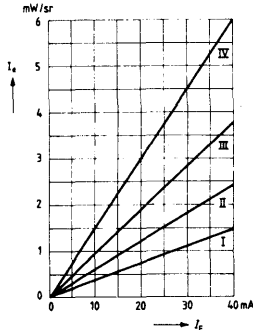
RELATIVE SPECTRAL EMISSION

$I_{rel} = f(\lambda)$



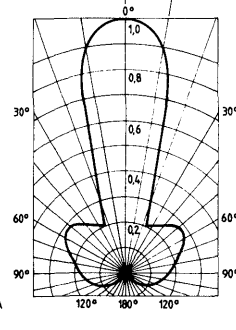
RADIANT INTENSITY

$I_e = f(I_F)$



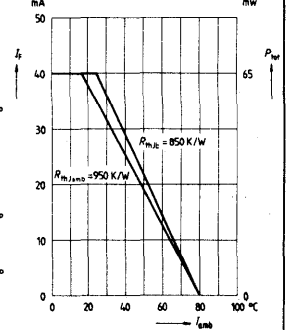
RADIATION CHARACTERISTICS

$I_p = f(\varphi)$



MAXIMUM PERMISSIBLE FORWARD CURRENT

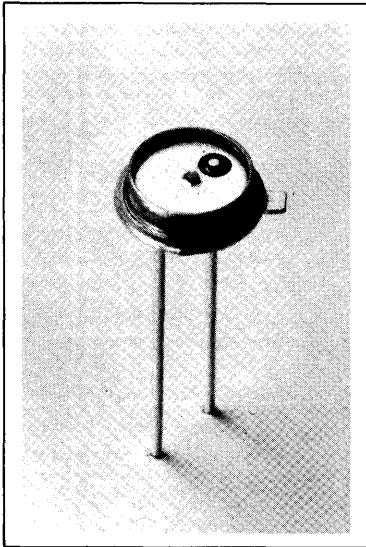
$I_F = f(T_{amb})$



SIEMENS

SFH 407 SERIES

INFRARED EMITTER



FEATURES

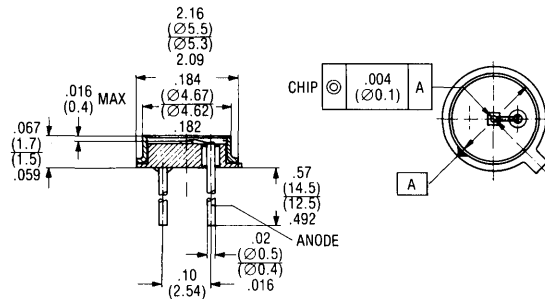
- TO-46 Package
- Flat Epoxy Coating
- 1/10" (2.54 mm) Lead Spacing
- For Fiber Optic Communications Up to 5 MBit/s
- Three Intensity Ranges
 SFH 4071, .4 to .8 mW/sr
 SFH 4072, .63 to 1.25 mW/sr
 SFH 4073, 1.0 to 2.0 mW/sr

DESCRIPTION

The SFH 407 GaAs diode emits radiation in the near infrared range. The radiation emitted is excited by current flowing in the forward direction and can be modulated. This diode is particularly noted for its high radiation ability.

The SFH 407 is mounted in a TO-46 case with collar casing and is encapsulated with epoxy. It is designed for applications in fiber optics communications up to 5 MBit/s

Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|--|--------------|
| Reverse Voltage (V_R) | 2 V |
| Forward Current (I_F) | 50 mA |
| Forward Current When Mounted in LWL Socket (I_F), ($T_{amb} \leq 25^\circ C$) | 100 mA |
| Surge Current (I_{FS}), $\tau \leq 100 \mu s$ | 200 mA |
| Storage Temperature Range (T_S) | -40 to +80°C |
| Junction Temperature (T_J) | 80°C |
| Thermal Resistance: | |
| Junction-to-Air (R_{thJamb}) | 750 K/W |
| Junction-to-Air When Inserted in LWL Socket (R_{thJamb}) | 400 K/W |
| Junction-to-Case (R_{thJC}) | 225 K/W |

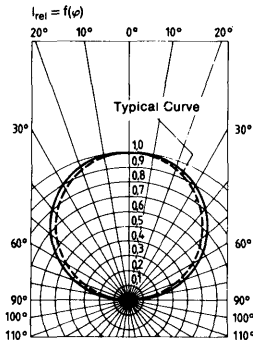
Characteristics ($T_{amb} = 25^\circ C$)

| | |
|--|----------------------------|
| Wavelength at Peak Emission, λ_{peak} | 900 ± 20 nm |
| Spectral Bandwidth, $\Delta\lambda$ | 40 nm |
| Half-Life Radiant Intensity in Gradient Profile Fiber with Core Diameter 63 μm and NA = 0.2 ($I_e = 1$ mW/sr), Φ_{in} | 2 μW |
| Rise Time (10% to 90% $I_F = 100$ mA), t_r | 50 ns |
| Fall Time (90% to 10% $I_F = 100$ mA), t_f | 40 ns |
| Bandwidth, B | 7 MHz |
| Forward Voltage ($I_F = 30$ mA), V_F | 1.22 (≤ 1.6) V |
| Reverse Current ($V_R = 2$ V), I_R | 0.01 (≤ 10) μA |
| Capacitance ($V_R = 0$ V), C_0 | 35 pF |

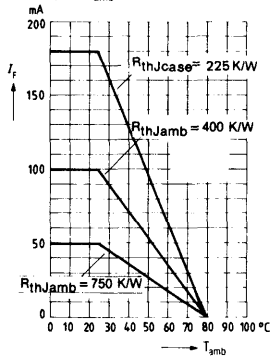
| Group | 1 | 2 | 3 | |
|---|------------|--------------|------------|---------|
| Radiant Intensity, I_e | 0.4 to 0.8 | 0.63 to 1.25 | 1.0 to 2.0 | mW/sr |
| Radiant Flux (Radiant Power) (Total) Typ., Φ_e | 1.9 | 3.0 | 4.7 | mW |
| Gradient Profile Fiber Optic Cable with Cord Diameter = 63 μm and NA = 0.2 (Total) Typ., Φ_{in} | 1.1 | 1.8 | 2.8 | μW |

Specifications subject to change without notice.

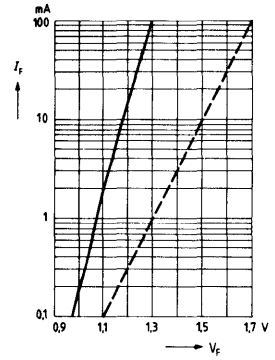
RADIATION CHARACTERISTICS



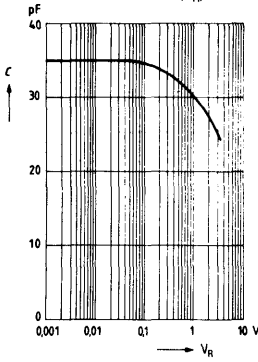
MAXIMUM PERMISSIBLE FORWARD CURRENT
 $I_F = f(T_{amb})$



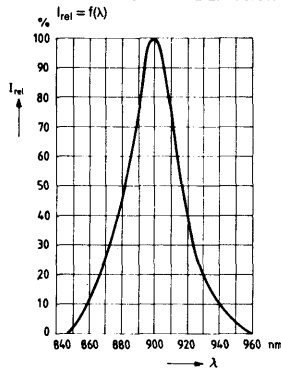
FORWARD CURRENT $I_F = f(V_F)$



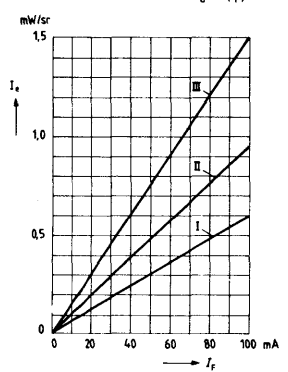
CAPACITANCE $C = f(V_R)$



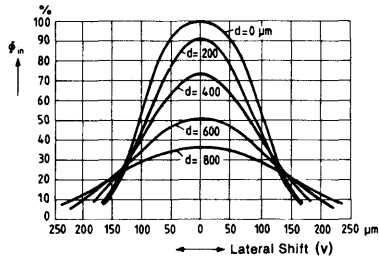
RELATIVE SPECTRAL EMISSION
 $I_{rel} = f(\lambda)$



RADIANT INTENSITY $I_e = f(I_F)$

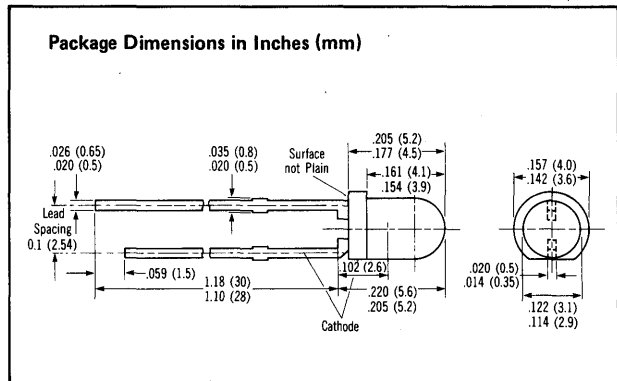
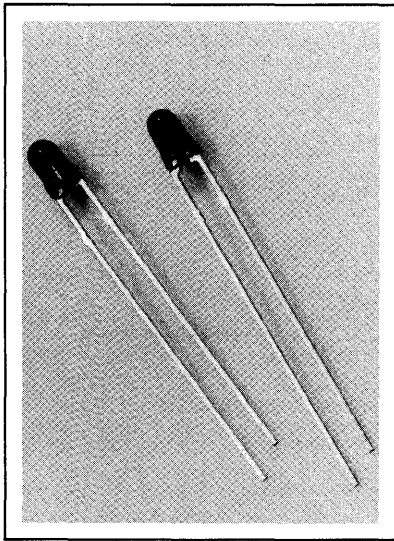


RELATIVE COMBINED RADIATED POWER INDEPENDENT FROM SPACING (d) AND LATERAL SHIFT (v) $\Phi_{in} = f(v)$; d = Parameter



SIEMENS

SFH 409 INFRARED EMITTER



FEATURES

- High Reliability
- 3 mm (T1) Size Package
- 1/10" (2.54 mm) Lead Spacing
- Low Cost
- High Pulse Power
- Long Term Stability, Typical 1000 hour Degradation is Less Than 20%
- Medium Wide Beam, 20°
- Excellent Spectral Match with SFH-309 Photodetector

DESCRIPTION

The SFH-409 is a GaAs Infrared Emitting Diode in a standard T1 size plastic package. It is designed for a variety of low cost, high volume applications such as IR remote control and other consumer and entertainment products.

Maximum Ratings:

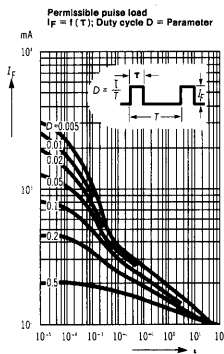
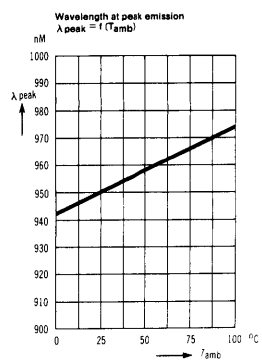
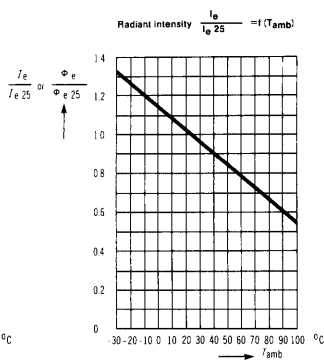
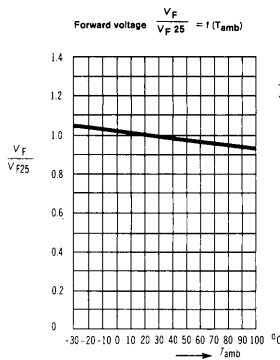
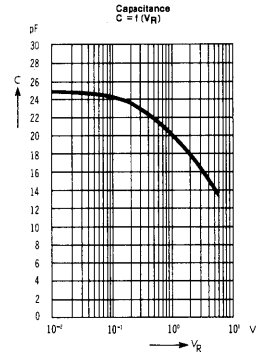
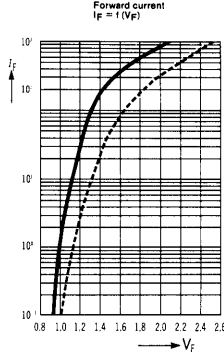
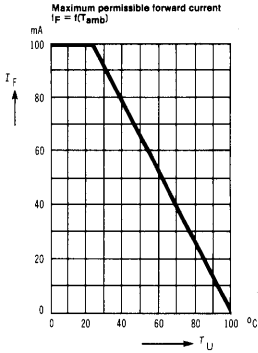
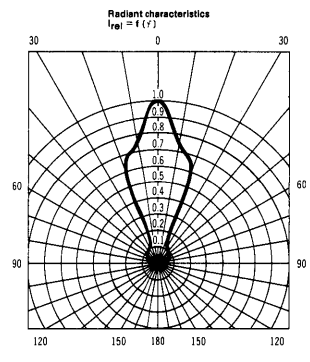
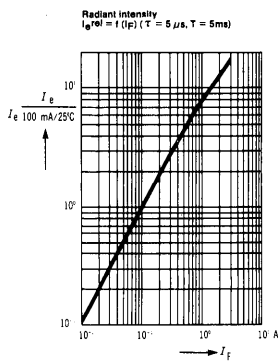
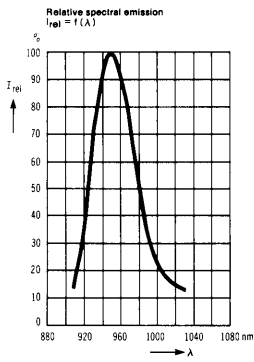
| | | | |
|---------------------------------|--------------------|-------------|----|
| Storage temperature | T _{stg} | -55 to +100 | °C |
| Soldering temperature | | | |
| Distance from casing-solder tab | | ≥2mm | |
| Dip soldering time | T _{sold} | 260 | °C |
| Iron soldering time | T _{sold} | 300 | °C |
| Junction temperature | T _j | 100 | °C |
| Reverse voltage | V _R | 5 | V |
| Forward current | I _F | 100 | mA |
| Surge current (τ = 10μs) | I _{FS} | 3 | A |
| Power dissipation (T = 25°C) | P _{tot} | 165 | mW |
| Thermal Resistance | R _{th jc} | 450 | KW |

Characteristics (T_{amb} = 25 °)

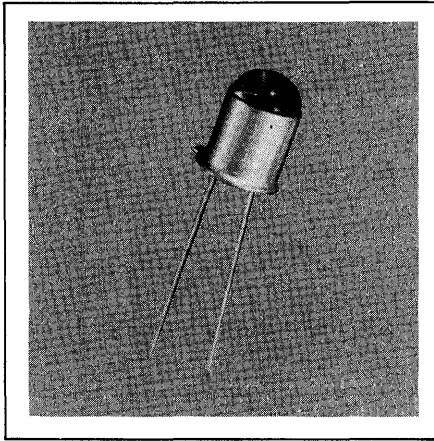
| | | | |
|--|---------------------------------|-------------|-----------------|
| Wave length at peak emission at I _F = 100 mA, t _p = 20ms, t _{off} = 180ms | λ _{peak} | 950 ± 20 | nm |
| Spectral bandwidth at 50% of I _{max} at I _F = 100mA, t _p = 20 ms | Δλ | 70 | nm |
| Half angle | φ | 20 | Degrees |
| Active chip area | A | 0.09 | mm ² |
| Dimensions of active chip area | L × W | 0,3 × 0,3 | mm |
| Distance chip surface to leadframe standoff | D | 2,6 | mm |
| Switching time: | | | |
| (I _e from 10% to 90%; I _F = 100mA) | t _r , t _f | 1 | μs |
| Capacity (V _R = 0 V) | C _o | 25 | pF |
| Forward Voltage (I _F = 100mA) | V _F | 1.35(≤1.65) | V |
| (I _F = 1A; t _p = 100μs) | V _F | 2.0 (≤2.7) | V |
| Breakdown voltage (I _R = 100 μA) | V _{BR} | 30 (≥5) | V |
| Reverse current (V _R = 5V) | I _R | 0.01 (≤10) | μA |
| Temperature coefficient of I _e or φ _e | TC | -0,55 | %/K |
| Temperature coefficient of V _F | TC | -1,5 | mV/K |
| Temperature coefficient of λ _{peak} | TC | +0,3 | nm/K |

Radiant intensity I_e in axial direction at a steradian Ω = 0,01 sr, or 6,65°

| | | | |
|---|----------------|---------|-------|
| Radiant intensity at (I _F = 100mA, t _p = 20 ms) | I _e | (≥6) 15 | mW/sr |
| (I _F = 1A; t _p = 100 μs) | I _e | 100 | mW/sr |
| Radiant flux total | | | |



Advance Data Sheet

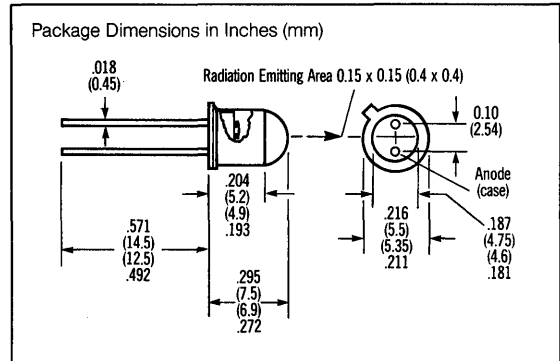


FEATURES

- TO-18 Hermetic Package
- Round Glass Lens
- Very Narrow Beam, 6°
- Very High Power, 8 mW Typical at 100 mA

DESCRIPTION

The SFH 480 GaAlAs infrared emitting diode emits radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. The case 18A 2 DIN 41876 (similar to TO-18) is closed by a glass lens. The cathode terminal is marked by the adjacent projection on the rim of the case bottom. The anode is electrically connected to the case. From $I_F = 100$ mA, heat sinks have to be used.



Maximum Ratings

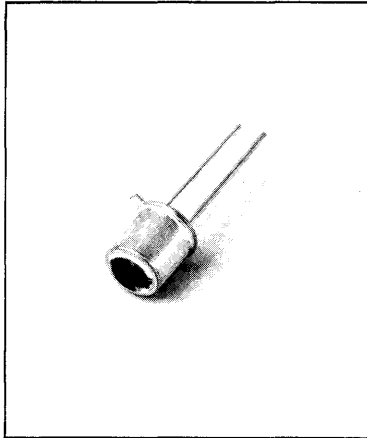
| | | | |
|---|--------------|-------------|------------------|
| Reverse Voltage | V_R | 5 | V |
| Forward Current ($T_c \leq 25^\circ\text{C}$) | I_F | 200 | mA |
| Surge Current ($r \leq 10\mu\text{s}$) | I_{FS} | 2.5 | A |
| Junction Temperature | T_J | 100 | $^\circ\text{C}$ |
| Storage Temperature | T_S | -55 to +100 | $^\circ\text{C}$ |
| Power Dissipation ($T_c \leq 25^\circ\text{C}$) | P_{tot} | 470 | mW |
| Thermal Resistance: | | | |
| Junction to Air | R_{thJAmb} | 450 | K/W |
| Junction to Case | R_{thJC} | 160 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA; | λ_{peak} | 880 | nm |
| Wavelength at peak emission at $I_F = 100$ mA; | λ_{peak} | 883 | nm |
| $t_p = 20$ ms; D = 1:12 | λ_{peak} | 886 | nm |
| Wavelength at peak emission at $I_F = 1$ A | $\Delta\lambda$ | -36 + 44 | nm |
| $t_p = 100$ μs ; D = 1:200 | ϕ | 6 | degrees |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | A | 0.16 | mm ² |
| Half angle | L x W | 0.4 x 0.4 | mm |
| Active chip area | t_r, t_f | 0.6/0.5 | μs |
| Dimensions of active chip area | C_D | 25 | pF |
| Switching time: (I_a from 10% to 90%; | V_F | 1.5 (≤ 2.0) | V |
| and from 90% to 10% $I_F = 100$ mA) | V_F | 3.0 (≤ 4.5) | V |
| Capacitance ($V_a = 0$ V; f = 1 MHz) | V_{BR} | 30 (≥ 5) | V |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) | I_R | 0.01 (≤ 10) | μA |
| ($I_F = 1$ A; $t_p = 100$ μs) | TC | -0.5 | %/K |
| Breakdown voltage ($I_a = 10$ μA) | TC | -0.2 | %/K |
| Reverse current ($V_a = 5$ V) | TC | 0.25 | nm/K |
| Temperature coefficient of I_a or Φ_e | | | |
| Temperature coefficient of V_F | I_a | 50 | mW/sr |
| Temperature coefficient of λ_{peak} | I_a | 450 | mW/sr |
| Radiant intensity I_a in axial direction at a steradian $\Omega = 0.01$ sr, or 6.5° | Φ_e | 8 | mW |
| Radiant intensity ($I_F = 100$ mA; $t_p = 20$ ms) | | | |
| ($I_F = 1$ A; $t_p = 100$ μs) | | | |
| Φ_e (Total) typ. ($I_F = 100$ mA) | | | |

Specifications are subject to change without notice.

Advance Data Sheet

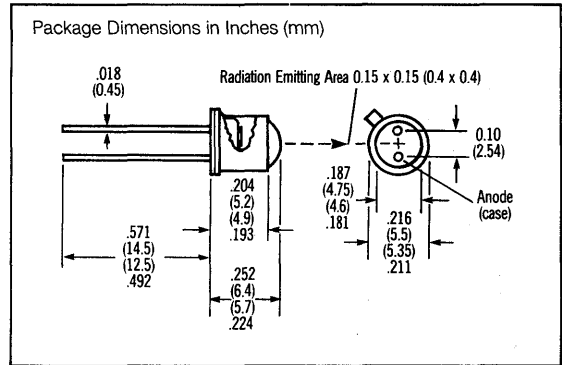


FEATURES

- TO-18 Hermetic Package
- Dome Glass Lens
- Narrow Beam, 15°
- Very High Power, 8 mW Typical at 100 mA

DESCRIPTION

The SFH 481 GaAlAs infrared emitting diode is designed to emit radiation at a wavelength in the near infrared. The radiation emitted is excited by current flowing in forward direction and can be modulated. The case 18A 2 DIN 41876 (similar to TO-18) is closed by a glass lens. The cathode terminal is marked by the adjacent projection on the rim of the case bottom. The anode is electrically connected to the case. From $I_F = 100$ mA, heat sinks have to be used.



Maximum Ratings

| | | | |
|---|--------------|-------------|------------------|
| Reverse Voltage | V_R | 5 | V |
| Forward Current ($T_c \leq 25^\circ\text{C}$) | I_F | 200 | mA |
| Surge Current ($t_r \leq 10 \mu\text{s}$) | I_{FS} | 2.5 | A |
| Junction Temperature | T_J | 100 | $^\circ\text{C}$ |
| Storage Temperature Range | T_s | -55 to +100 | $^\circ\text{C}$ |
| Power Dissipation ($T_c \leq 25^\circ\text{C}$) | P_{tot} | 470 | mW |
| Thermal Resistance: | | | |
| Junction to Air | R_{thJamb} | 450 | K/W |
| Junction to Case | R_{thJC} | 160 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Wavelength at peak emission at $I_F = 100$ mA $t_p = 20$ ms; D = 1:12 | λ_{peak} | 883 | nm |
| Wavelength at peak emission at $I_F = 1$ A $t_p = 100$ μs ; D = 1:200 | λ_{peak} | 886 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta\lambda$ | -36 + 44 | nm |
| Half angle | φ | 15 | degrees |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | L x W | 0.4 x 0.4 | mm |
| Switching time: (I_F from 10% to 90%; and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | 0.6/0.5 | μs |
| Capacitance ($V_a = 0$ V; $f = 1$ MHz) | C_o | 25 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) | V_F | 1.5 (≤ 2.0) | V |
| ($I_F = 1$ A; $t_p = 100$ μs) | V_F | 3.0 (≤ 4.5) | V |
| Breakdown voltage ($I_R = 10$ μA) | V_{BR} | 30 (≥ 5) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of I_R or Φ_e | TC | -0.5 | %/K |
| Temperature coefficient of V_F | TC | -0.2 | %/K |
| Temperature coefficient of λ_{peak} | TC | 0.25 | nm/K |
| Radiant intensity I_e in axial direction at a steradian $\Omega = 0.01$ sr, or 6.5° | I_e | 20 | mW/sr |
| Radiant intensity ($I_F = 100$ mA; $t_p = 20$ ms) | I_e | 180 | mW/sr |
| ($I_F = 1$ A; $t_p = 100$ μs) | I_e | 8 | mW |
| Φ_e (Total) typ. ($I_F = 100$ mA) | Φ_e | 8 | mW |

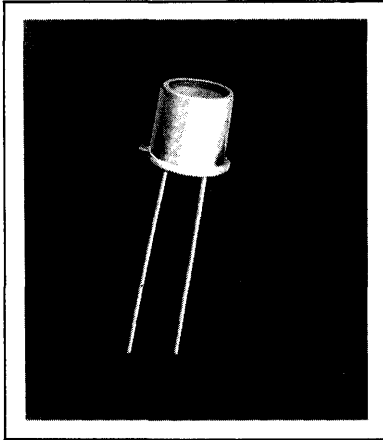
Specifications are subject to change without notice.

SIEMENS

SFH 482

GaAlAs INFRARED EMITTING DIODE

Advance Data Sheet



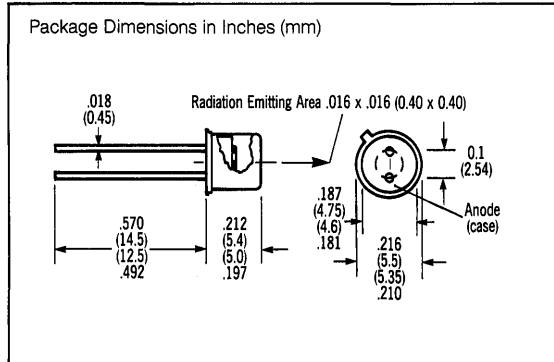
FEATURES

- TO-18 Hermetic Package
- Flat Glass Lens
- Wide Beam, 40°
- Very High Power, 8 mW Typical at 100 mA

DESCRIPTION

The SFH 482 GaAlAs infrared emitting diode is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. The case similar to TO-18 is equipped with a flat light window. The cathode is marked by the adjacent projection on the rim of the case bottom. The anode is electrically connected to the case. From $I_F = 100$ mA, heat sinks have to be used.

Package Dimensions in Inches (mm)



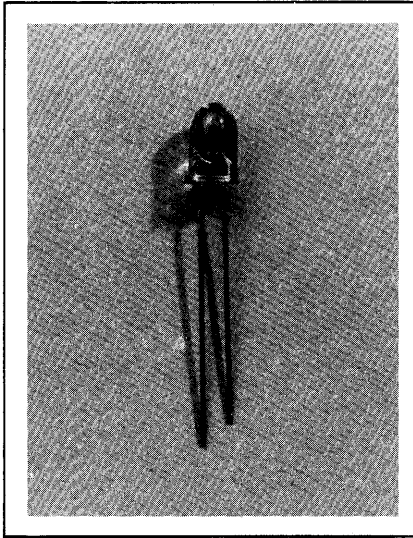
Maximum Ratings

| | | | |
|---|-------------|-------------|------------------|
| Reverse Voltage | V_R | 5 | V |
| Forward Current ($T_C \leq 25^\circ\text{C}$) | I_F | 200 | mA |
| Surge Current ($t_r \leq 10 \mu\text{s}$) | I_{FS} | 2.5 | A |
| Junction Temperature | T_J | 100 | $^\circ\text{C}$ |
| Storage Temperature | T_S | -55 to +100 | $^\circ\text{C}$ |
| Power Dissipation ($T_C \leq 25^\circ\text{C}$) | P_{tot} | 470 | mW |
| Thermal Resistance: | | | |
| Junction to Air | $R_{th,Ja}$ | 450 | K/W |
| Junction to Case | $R_{th,Jc}$ | 160 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Wavelength at peak emission at $I_F = 100$ mA; | | | |
| $t_p = 20$ ms; $D = 1:12$ | λ_{peak} | 883 | nm |
| Wavelength at peak emission at $I_F = 1$ A; | | | |
| $t_p = 100 \mu\text{s}$; $D = 1:200$ | λ_{peak} | 886 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta\lambda$ | -36 + 44 | nm |
| Half angle | φ | 40 | degrees |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | L x W | 0.4 x 0.4 | mm |
| Distance chip surface to case surface | D | 5...5.5 | mm |
| Switching time: (I_a from 10% to 90%; | | | |
| and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | 0.6/0.5 | μs |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz) | C_o | 25 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) | V_F | 1.5 (≤ 2.0) | V |
| ($I_F = 1$ A; $t_p = 100 \mu\text{s}$) | V_F | 3.0 (≤ 4.5) | V |
| Breakdown voltage ($I_R = 10 \mu\text{A}$) | V_{BR} | 30 (≈ 5) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of I_a or Φ_e | TC | -0.5 | %/K |
| Temperature coefficient of V_F | TC | -0.2 | %/K |
| Temperature coefficient of λ_{peak} | TC | 0.25 | nm/K |
| Radiant intensity I_a in axial direction at a steradian $\Omega = 0.01$ sr, or 6.5° | | | |
| ($I_F = 100$ mA; $t_p = 20$ ms) | I_a | 7 | mW/sr |
| ($I_F = 1$ A; $t_p = 100 \mu\text{s}$) | I_a | 63 | mW/sr |
| Φ_e (Total) typ. ($I_F = 100$ mA) | Φ_e | 8 | mW |

Specifications are subject to change without notice.

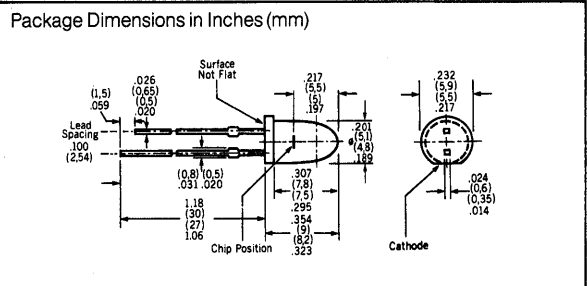


FEATURES

- Good Spectral Match with Silicon Photo Detector
- Gallium Aluminum Arsenide Material
- Low Cost
- T-1 1/4 Package
- Clear Plastic Lens
- Long Term Stability
- Narrow Beam, 8°
- Very High Power, 20 mW Typical at 100 mA
- High Intensity, 100 mW/sr at 100 mA

DESCRIPTION

The GaAlAs infrared emitting diode SFH 484 is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. SFH 484 is enclosed in a plastic package of 5 mm diameter. It is provided for IR remote control of color TV receivers, smoke detectors and other applications requiring very high power such as IR touch screens.



Maximum Ratings

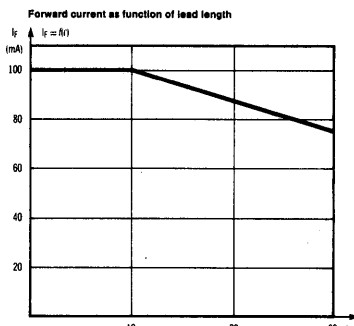
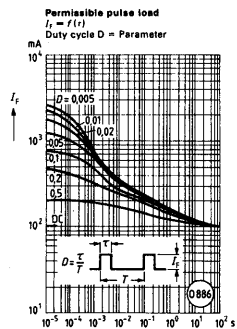
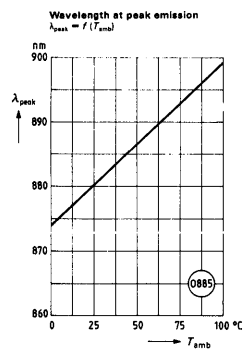
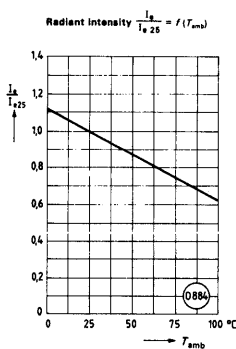
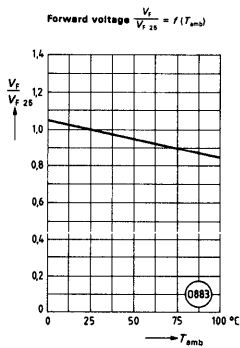
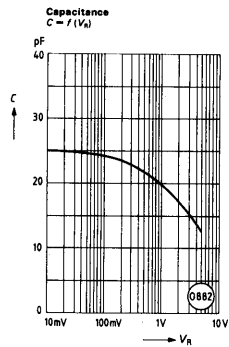
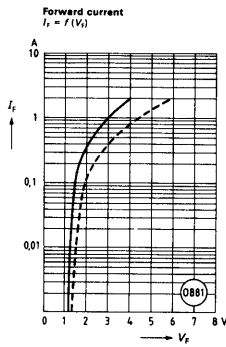
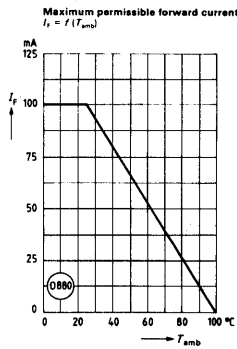
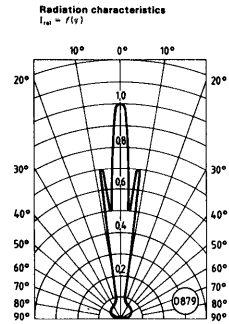
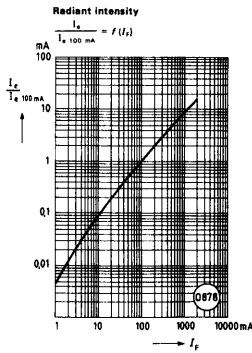
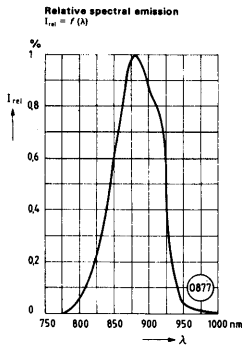
| | | | |
|--|------------|---------------|-----|
| Storage temperature | T_{stg} | - 55... + 100 | °C |
| Soldering temperature at dip soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 5$ sec) | T_{sold} | 260 | °C |
| Soldering temperature at iron soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 3$ sec) | T_{sold} | 300 | °C |
| Junction temperature | T_j | 100 | °C |
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 100 | mA |
| Surge current ($\tau = 10 \mu s$) | I_{FS} | 2.5 | A |
| Power dissipation ($T = 25^\circ C$) | P_{tot} | 200 | mW |
| Thermal resistance* | R_{thA} | 375 | K/W |

Characteristics ($T_{amb} = 25^\circ C$)

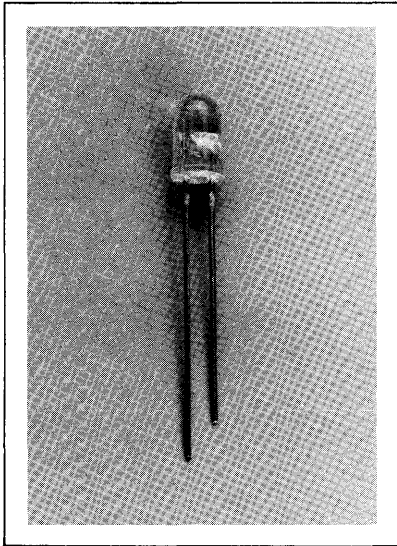
| | | | |
|---|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Wavelength at peak emission at $I_F = 100$ mA; $t_p = 20$ ms, $D = 1:12$ | λ_{peak} | 883 | nm |
| Wavelength at peak emission at $I_F = 1$ A; $t_p = 100 \mu s$, $D = 1:100$ | λ_{peak} | 886 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta \lambda$ | - 36... + 44 | nm |
| Half angle | φ | 8 | degrees |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | L x W | 0.4 x 0.4 | mm |
| Distance chip surface to case surface | D | 4.9...5.5 | mm |
| Switching time: (I_e from 10% to 90%; and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | 0.6/0.5 | μs |
| Capacitance ($V_R = 0$ V, $f = 1$ MHz) | C_o | 25 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) | V_F | 1.5 (≤ 2.0) | V |
| ($I_F = 1$ A; $t_p = 100 \mu s$) | V_F | 3.0 (≤ 4.5) | V |
| Breakdown voltage ($I_R = 10 \mu A$) | V_{BR} | 30 (≥ 5) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of I_e or Φ_e | TC | - 0.5 | %/K |
| Temperature coefficient of V_F | TC | - 0.2 | %/K |
| Temperature coefficient of λ_{peak} | TC | 0.25 | nm/K |
| Radiant intensity I_e in axial direction at a steradian $\Omega = 0.01$ sr or 6.5° | | | |
| Radiant intensity ($I_F = 100$ mA, $t_p = 20$ ms) | I_e | 100 (≥ 50) | mW/sr |
| ($I_F = 1$ A; $t_p = 100 \mu s$) | I_e | 900 | mW/sr |
| Φ_e (Total) typ. ($I_F = 100$ mA) | Φ_e | 20 | mW |

*At 10mm maximum clearance between PC board and bottom of plastic body.

Specifications are subject to change without notice.



Preliminary

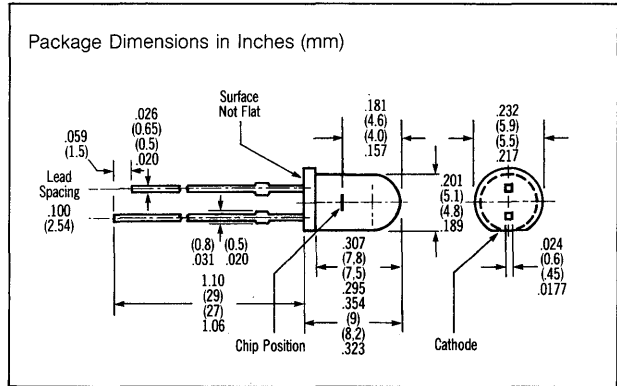


FEATURES

- Perfect Spectral Match with Silicon Photodetectors
- Gallium Aluminum Arsenide Material
- Low Cost
- T1¾ Package
- Clear Plastic Lens
- Long Term Stability
- Medium wide beam, 20°
- Very High Power, 20 mW Typical at 100 mA
- High Intensity, 30 mW/sr at 100 mA

DESCRIPTION

The GaAlAs infrared emitting diode SFH 485 is designed to emit radiation at a wave-length in the near infrared range, 880 nm peak. The radiation emitted is excited by current flowing in forward direction and can be modulated. SFH485 is enclosed in a plastic package of 5 mm diameter. It is provided for IR remote control of color TV receivers and smoke detectors and other applications requiring very high power.



Maximum Ratings

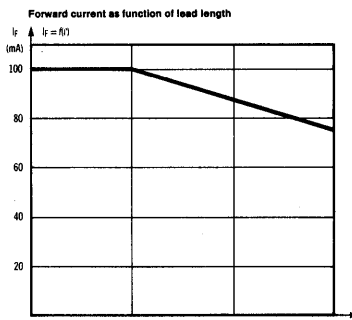
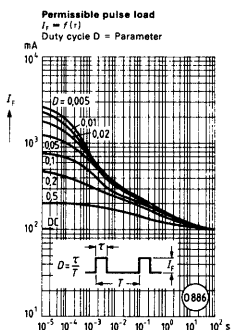
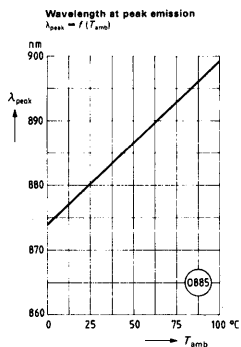
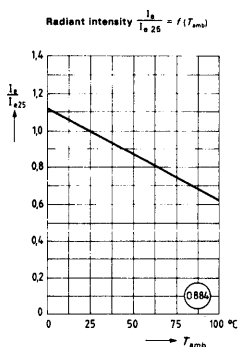
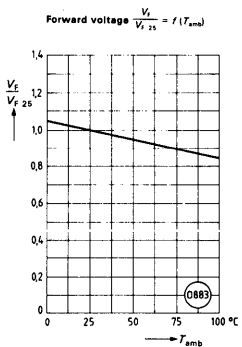
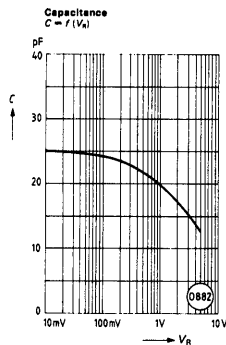
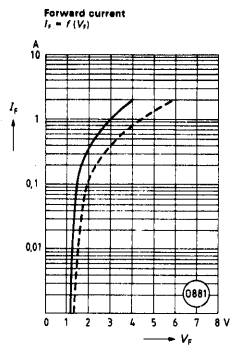
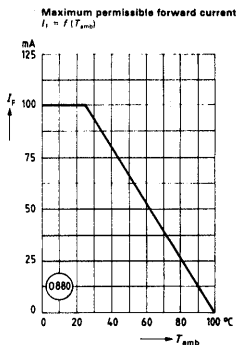
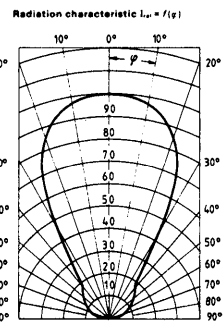
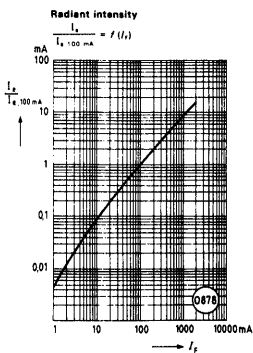
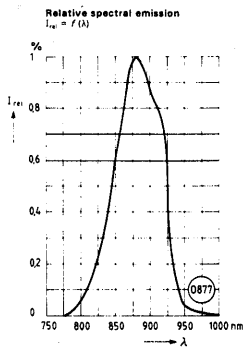
| | | | |
|--|------------|-------------|-----|
| Storage temperature | T_{stor} | -55 to +100 | °C |
| Soldering temperature at dip soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 5$ sec) | T_{sold} | 260 | °C |
| Soldering temperature at iron soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 3$ sec) | T_{sold} | 300 | °C |
| Junction temperature | T_j | 100 | °C |
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 100 | mA |
| Surge current ($\tau = 10$ μ sec) | I_{FS} | 2.5 | A |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 150 | mW |
| Thermal resistance* | R_{thJA} | 375 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

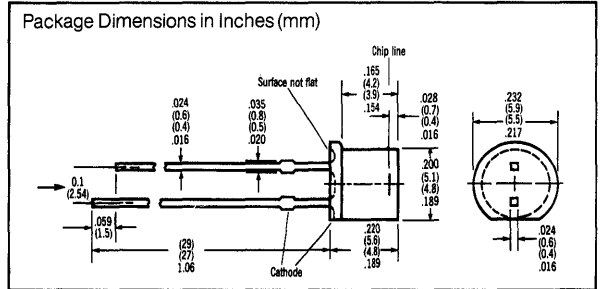
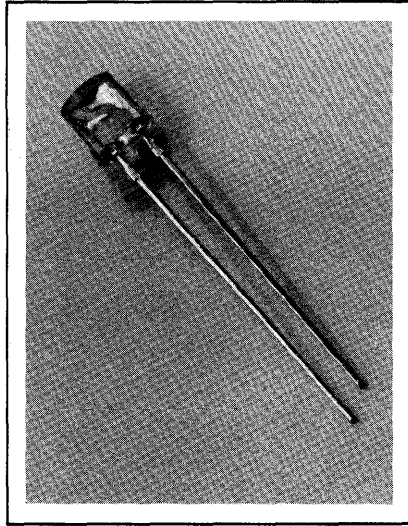
| | | | |
|--|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta\lambda$ | -36... +44 | nm |
| Half angle | θ | 20 | Degree |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | L x W | 0.4 x 0.4 | mm |
| Distance chip surface to case surface | D | 4.6...4.0 | mm |
| Switching time: (I_e from 10% to 90%; and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | .6/.5 | μ s |
| Capacitance ($V_R = 0$ V, $f = 1$ MHz) | C_o | 25 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_b = 20$ ms) ($I_F = 1$ A; $t_b = 100$ μ s) | V_F | 1.5 (≤ 2.0) | V |
| Breakdown voltage ($I_R = 10$ μ A) | V_{BR} | 3.0 (≤ 4.5) | V |
| Reverse current ($V_R = 5$ V) | I_{RR} | 30 (≥ 5) | μ A |
| Temperature coefficient of I_e or Φ_e | TC | 0.01 (≤ 10) | μ A/K |
| Temperature coefficient of V_F | TC | -0.5 | %/K |
| Temperature coefficient of λ_{peak} | TC | -0.2 | %/K |
| Radiant intensity I_e in axial direction at a steradian $\Omega = 0.01$ sr, or 6.5° | | | |
| Radiant intensity ($I_F = 100$ mA, $t_b = 20$ ms) | I_e | 40 (≥ 16) | mW/sr |
| ($I_F = 1$ A; $t_b = 100$ μ s) | I_e | 360 | mW/sr |
| Φ_e (Total) typ. ($I_F = 100$ mA) | Φ_e | 20 | mW |

*At 10 mm max clearance between PC board and bottom of plastic body.

Specifications are subject to change without notice.



Preliminary



FEATURES

- Good Spectral Matching to Silicon Photo Detector
- Gallium Aluminum Arsenide Material
- Low Cost
- T-1 1/4 Diameter Package
- Flat Plastic Top
- Long Term Stability
- Very Wide Beam, 45°
- Very High Power, 20 mW Typical at 100 mA

DESCRIPTION

The GaAlAs infrared emitting diode SFH 485P is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. SFH 485P is enclosed in a flat plastic top of 5 mm diameter. It is provided for IR remote control applications, IR sound transmission and other applications requiring very high power.

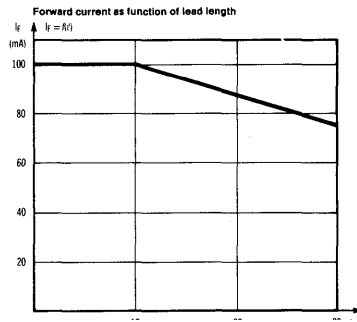
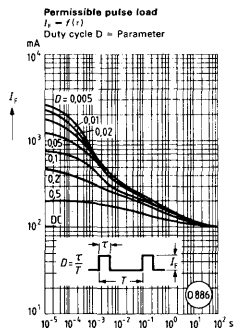
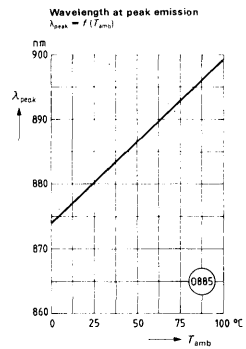
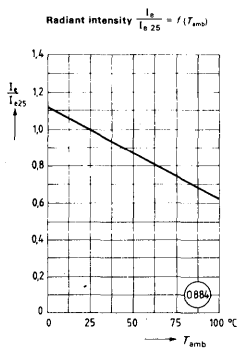
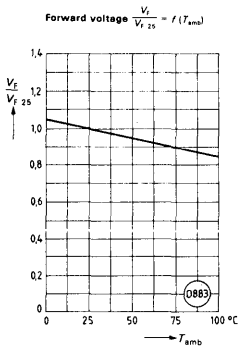
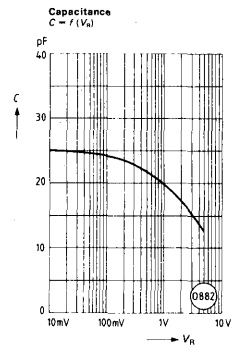
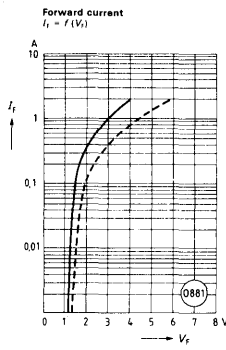
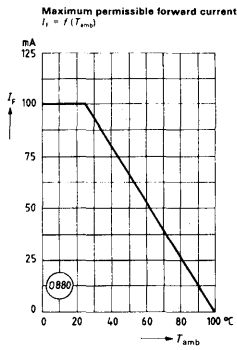
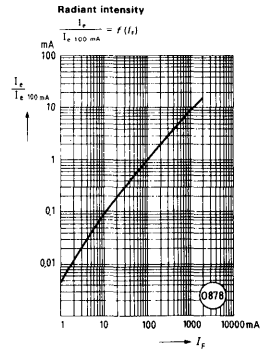
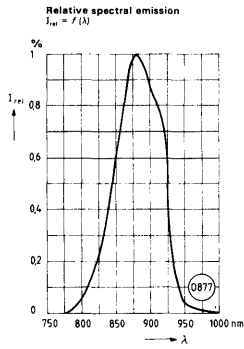
Maximum Ratings

| | | | |
|--|------------|---------------|-----|
| Storage temperature | T_{sig} | - 55... + 100 | °C |
| Soldering temperature at dip soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 5$ sec) | T_{sold} | 260 | °C |
| Soldering temperature at iron soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 3$ sec) | T_{sold} | 300 | °C |
| Junction temperature | T_j | 100 | °C |
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 100 | mA |
| Surge current ($r = 10 \mu s$) | I_{FS} | 2.5 | A |
| Power dissipation ($T = 25^\circ C$) | P_{tot} | 200 | mW |
| Thermal resistance | R_{thA} | 375 | K/W |

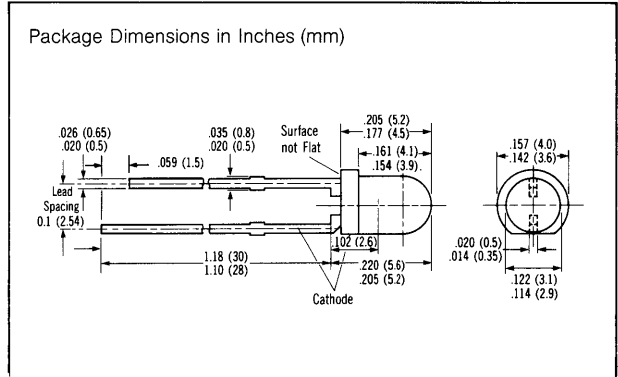
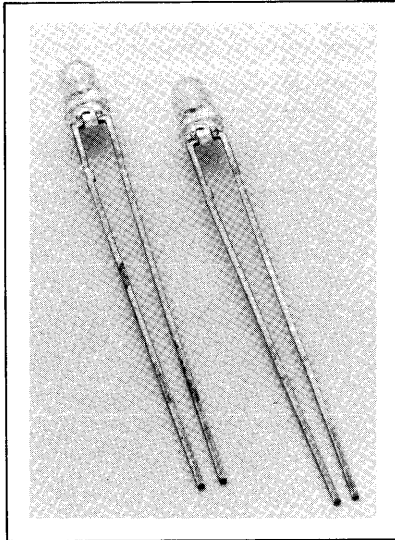
Characteristics ($T_{amb} = 25^\circ C$)

| | | | |
|---|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Wavelength at peak emission at $I_F = 100$ mA; $t_p = 20$ ms, $D = 1:12$ | λ_{peak} | 883 | nm |
| Wavelength at peak emission at $I_F = 1$ A; $t_p = 100 \mu s$, $D = 1:100$ | λ_{peak} | 886 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta\lambda$ | - 36... + 44 | nm |
| Half angle | φ | 45 | degrees |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | L x W | 0.4 x 0.4 | mm |
| Distance chip surface to case surface | D | 5...5.5 | mm |
| Switching time: (I_F from 10% to 90%; and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | 0.6/0.5 | μs |
| Capacitance ($V_R = 0$ V, $f = 1$ MHz) | C_o | 25 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) | V_F | 1.5 (≤ 2.0) | V |
| ($I_F = 1$ A; $t_p = 100 \mu s$) | V_F | 3.0 (≤ 4.5) | V |
| Breakdown voltage ($I_R = 10 \mu A$) | V_{BR} | 30 (≥ 5) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of I_o or Φ_o | TC | - 0.5 | %/K |
| Temperature coefficient of V_F | TC | - 0.2 | %/K |
| Temperature coefficient of λ_{peak} | TC | 0.25 | nm/K |
| Radiant intensity I_o in axial direction at a steradian $\Omega = 0.01$ sr or 6.5° | I_o | 6 | mW/sr |
| ($I_F = 100$ mA, $t_p = 20$ ms) | I_o | 54 | mW/sr |
| ($I_F = 1$ A; $t_p = 100 \mu s$) | Φ_o | 20 | mW |
| Φ_o (Total) typ. ($I_F = 100$ mA) | Φ_o | 20 | mW |

Specifications are subject to change without notice.



Preliminary



FEATURES

- Good Spectral Match to Silicon Photo Detector
- Gallium Aluminum Arsenide Material
- Low Cost
- T-1 Package
- Clear Plastic Lens
- Long-Term Stability
- Medium Wide Beam, 20°
- Very High Power, 20 mW Typical at 100 mA
- High Intensity, 30 mW/sr at 100 mA

DESCRIPTION

The GaAlAs infrared emitting diode SFH 487 is designed to emit radiation at a wavelength in the near infrared range, 880 nm peak. The radiation emitted is excited by current flowing in forward direction and can be modulated. SFH 487 is enclosed in a plastic package of 3 mm diameter. It is provided for IR remote control of color TV receivers and smoke detectors and other applications requiring very high power, such as IR touch screens.

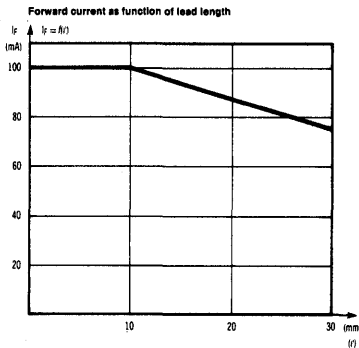
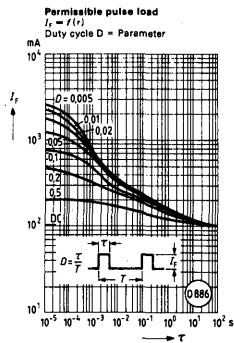
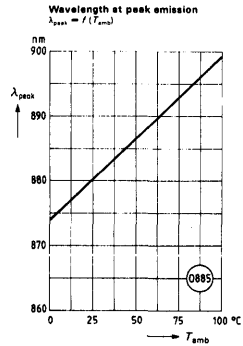
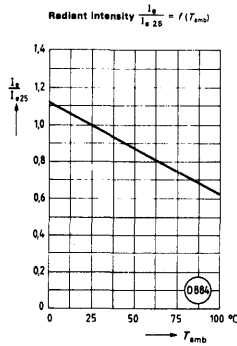
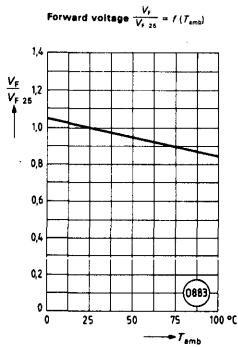
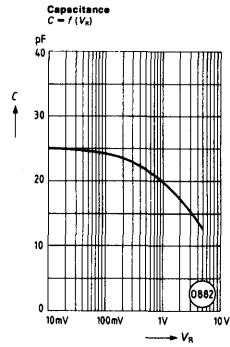
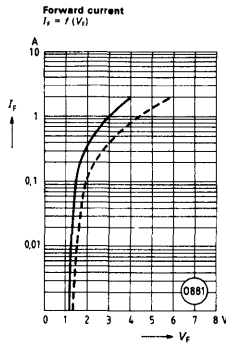
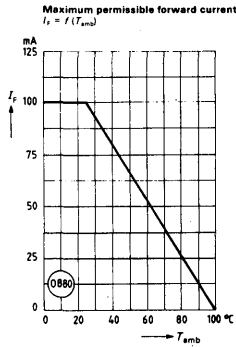
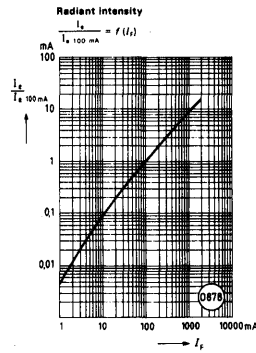
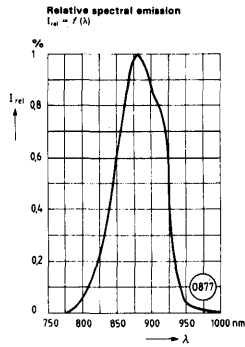
Maximum Ratings

| | | | |
|--|------------|---------------|-----|
| Storage temperature | T_{stg} | - 55... + 100 | °C |
| Soldering temperature at dip soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 5$ sec) | T_{sold} | 260 | °C |
| Soldering temperature at iron soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 3$ sec) | T_{sold} | 300 | °C |
| Junction temperature | T_j | 100 | °C |
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 100 | mA |
| Surge current ($\tau = 10 \mu s$) | I_{FS} | 2.5 | A |
| Power dissipation ($T = 25^\circ C$) | P_{tot} | 200 | mW |
| Thermal resistance | R_{thA} | 375 | K/W |

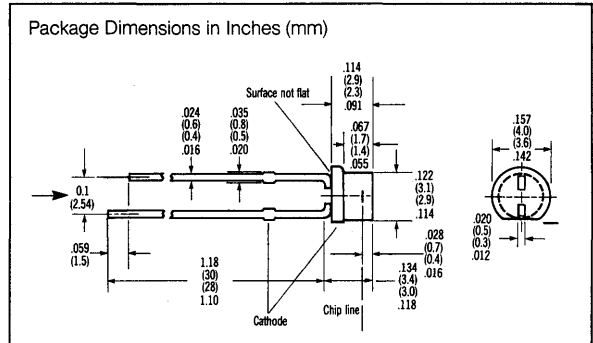
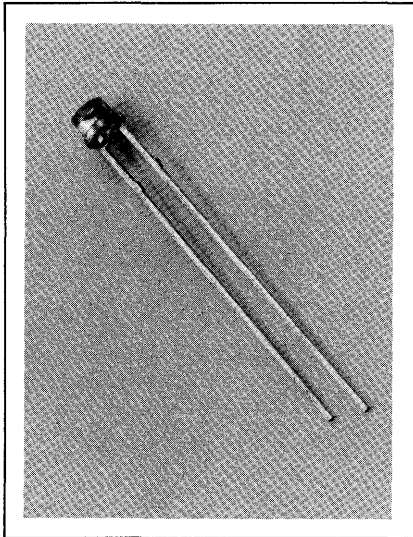
Characteristics ($T_{amb} = 25^\circ C$)

| | | | |
|---|------------------|--------------------|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta\lambda$ | - 36... + 44 | nm |
| Half angle | ϕ | 20 | degrees |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | $L \times W$ | 0.4 × 0.4 | mm |
| Distance chip surface to stand off | D | 2.6 | mm |
| Switching time: (I_b from 10% to 90%; and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | 0.6/0.5 | μs |
| Capacitance ($V_R = 0$ V, $f = 1$ MHz) | C_0 | 25 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) | V_F | 1.5 (≤ 2.0) | V |
| ($I_F = 1$ A; $t_p = 100 \mu s$) | V_F | 3.0 (≤ 4.5) | V |
| Breakdown voltage ($I_R = 10 \mu A$) | V_{BR} | 30 (≥ 5) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of I_b or Φ_e | TC | - 0.5 | %/K |
| Temperature coefficient of V_F | TC | - 0.2 | %/K |
| Temperature coefficient of λ_{peak} | TC | 0.25 | nm/K |
| Radiant intensity I_b in axial direction at a steradian $\Omega = 0.01$ sr or 6.5° | I_b | 30 (≥ 12.5) | mW/sr |
| Radiant intensity ($I_F = 100$ mA, $t_p = 20$ ms) | I_b | 270 | mW/sr |
| ($I_F = 1$ A; $t_p = 100 \mu s$) | I_b | 20 | mW |
| Φ_e (Total) typ. ($I_F = 100$ mA) | Φ_e | 20 | mW |

Specifications are subject to change without notice.



Preliminary



FEATURES

- Perfect Spectral Match with Silicon Photo Detector
- Gallium Aluminum Arsenide Material
- Low Cost
- T1 Diameter Package
- Flat Plastic Top
- Long-Term Stability
- Very Wide Beam, 45°
- Very High Power, 20 mW Typical at 100 mA

DESCRIPTION

The GaAlAs infrared emitting diode SFH487P is designed to emit radiation at a wavelength in the near infrared range. The radiation emitted is excited by current flowing in forward direction and can be modulated. SFH487P is enclosed in a plastic package of 3 mm diameter. Typical applications are in fiber optics and light interruptors for DC and AC operation up to 500 KHz.

Maximum Ratings

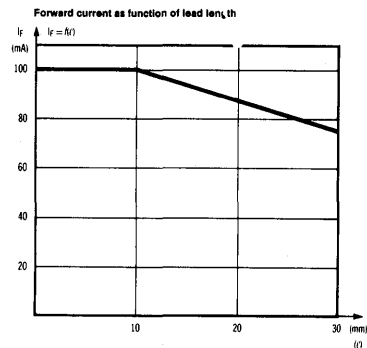
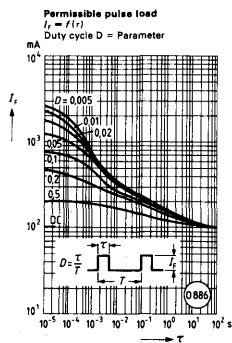
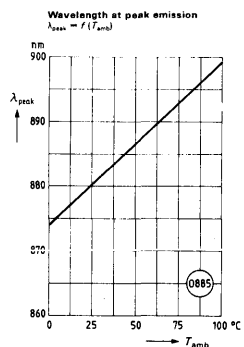
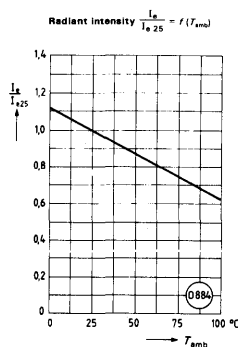
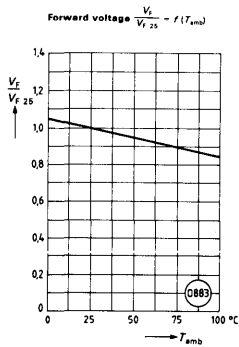
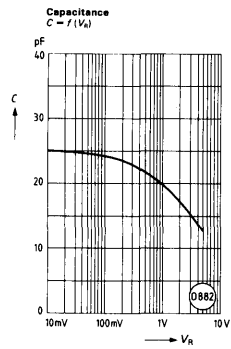
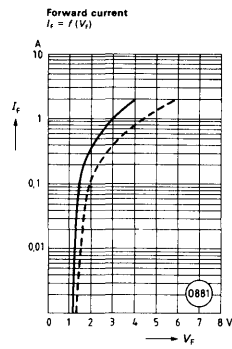
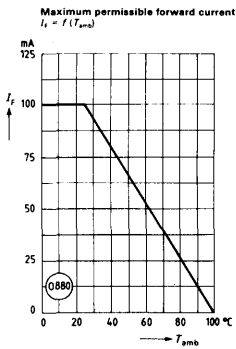
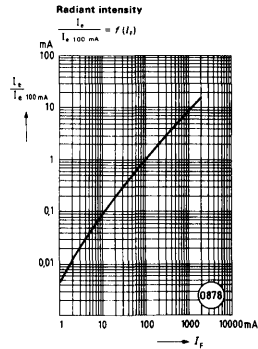
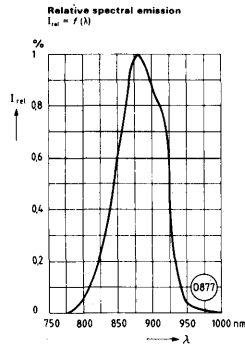
| | | | |
|--|-------------|-------------|-----|
| Storage temperature | T_{stg} | -55... +100 | °C |
| Soldering temperature at dip soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 5$ sec) | T_{solid} | 260 | °C |
| Soldering temperature at iron soldering: (≥ 2 mm distance from the case bottom; soldering time $t \leq 3$ sec) | T_{solid} | 300 | °C |
| Junction temperature | T_j | 100 | °C |
| Reverse voltage | V_R | 5 | V |
| Forward current | I_F | 100 | mA |
| Surge current ($\tau = 10 \mu s$) | I_{FS} | 2.5 | A |
| Power dissipation ($T = 25^\circ C$) | P_{tot} | 200 | mW |
| Thermal resistance* | R_{thA} | 375 | K/W |

Characteristics ($T_{amb} = 25^\circ C$)

| | | | |
|---|------------------|--|-----------------|
| Wavelength at peak emission at $I_F = 10$ mA | λ_{peak} | 880 | nm |
| Spectral bandwidth at 50% of I_{max} at $I_F = 10$ mA | $\Delta\lambda$ | -36... +44 | nm |
| Half angle | φ | 60 | degree |
| Active chip area | A | 0.16 | mm ² |
| Dimensions of active chip area | L x W | 0.4 x 0.4 | mm |
| Distance chip surface to case surface | D | 0.7...0.4 | mm |
| Switching time: (I_e from 10% to 90%; and from 90% to 10% $I_F = 100$ mA) | t_r, t_f | 0.6/0.5 | μs |
| Capacitance ($V_R = 0$ V, $f = 1$ MHz) | C_o | 45 | pF |
| Forward Voltage ($I_F = 100$ mA; $t_p = 20$ ms) ($I_F = 1$ A; $t_p = 100 \mu s$) | V_F | 1.5 (≤ 2.0) 3.0 (≤ 4.5) | V |
| Breakdown voltage ($I_R = 10 \mu A$) | V_{BR} | 30 (≥ 5) | V |
| Reverse current ($V_R = 5$ V) | I_R | 0.01 (≤ 10) | μA |
| Temperature coefficient of I_e or Φ_e | TC | -0.5 | %/K |
| Temperature coefficient of V_F | TC | -0.2 | %/K |
| Temperature coefficient of λ_{peak} | TC | 0.25 | nm/K |
| Radiant intensity I_e in axial direction at a steradian $\Omega = 0.01$ sr or 6.5° | I_e | 3 | mW/sr |
| Radiant intensity ($I_F = 100$ mA, $t_p = 20$ ms) ($I_F = 1$ A; $t_p = 100 \mu s$) | I_e | 27 | mW/sr |
| Φ_e (Total) typ. ($I_F = 100$ mA) | Φ_e | 20 | mW |


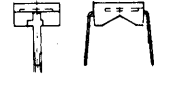
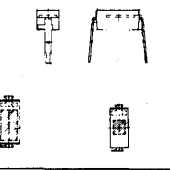
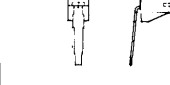
*At 10 mm clearance between PC board and bottom of plastic body.

Specifications are subject to change without notice.

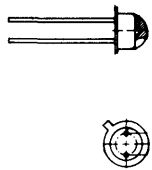
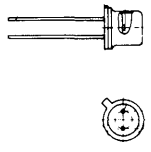
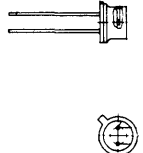

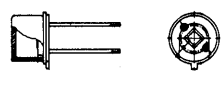




Photodiodes

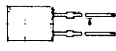
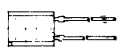

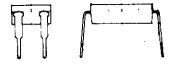
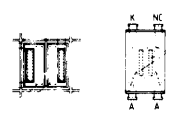
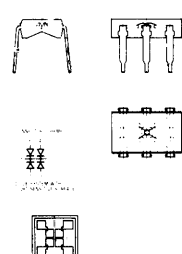
| Package Type | Package Outline | Part Number | Half Angle | Dark Current [V _R] E-O IR(nA) | Sensitivity $s(nA/lx)$ Typical | Radiant Sensitive Area mm ² | Peak Wavelength | Features | Page |
|--------------------------------|---|-------------|------------------|---|--|--|---|---|------|
| Plastic Back |  | BP104 | 60° | 2(<30) (10V) | 40 μA $\frac{cm^2}{mW}$ | 5 | 950 | PIN type IR remote control Built in filter | 330 |
| | | BPW33 | | 20pa(<100) (1V) | 50 | 7.6 | 850 | Transparent for exposure meters | 336 |
| Plastic, Colorless Solder Tabs |  | BPW34 | 2(<30) (10V) | 70 | Transparent for IR Sound transmission | | | 338 | |
| | | BPX91B | 7(<300) (10V) | 50 | Transparent high blue sensitivity Operates at low luminance | | | 356 | |
| Plastic, Colorless Solder Tabs |  | BPX90 | 60° | 5(<200) (10V) | 40 | 5.0 | High sensitivity Superior signal to noise ratio at low luminance | 354 | |
| | | BPX93 | | 0.5(<50) (10V) | 8 | 1.0 | Superior signal to noise ratio at low luminance | 360 | |
| | | BPW32 | | 5pA(<20) (1V) | 10 | 1.0 | Extremely low dark current 5pA | 334 | |
| | | SFH100 | | 0.4(<10) (7V) | 175 | 23.5 | Extremely sensitive Including high blue sensitivity Operates at low luminance | 362 | |
| | | SFH200 | | 20 pA (3V) | 20 | 2.8 | High zero crossover For exposure meters and automatic timers | 364 | |
| Plastic, Colorless Solder Tabs |  | BPX92 | 60° | 1(<100) (10V) | 7 | 1.5 | 850 | Superior signal to noise ratio at low luminance | 358 |

Photodiodes



| Package Type | Package Outline | Part Number | Half Angle | Dark Current [VR] E-O I _r (nA) | Sensitivity s(nA/lx) Typical | Radiant Sensitive Area mm ² | Peak Wavelength | Features | Page |
|---------------------------------|---|-------------|------------|---|------------------------------|--|-----------------|---|------|
| TO-18 Round Plastic Lens |  | BPX63 | 75° | 5 pA (<20) (1V) | 10 | | 800 | Extremely low dark current, 5 pA. For exposure meters. Matches with LD242 IR emitter. | 348 |
| PIN TO-18 Flat Glass Lens |  | BPX65 | 30° | 1(<5) (20V) | 10 | 1 | 850 | PIN type. Very high speed, 5nS. Low dark current, 1 mA | 350 |
| | | BPX66 | | .15(<0.3) (1V) | 9 | | | PIN type. Very high speed, 5nS. Very low dark current, 15 mA | 352 |
| PIN TO-18 Flat Glass Lens |  | SFH202 | 60° | 1(<5) (20V) | 10 | | | PIN type. For fiber optic transmission over 560 m/bits | 366 |
| Similar to TO-5 Flat Glass Lens |  | BPW21 | 60° | 2(<30) | 9(>5.5) | 7.34 | 550 | Hermetic seal glass lens for high reliability. Incorporates V ₂ filter 550 nm. | 332 |
| TO-5 Glass Lens |  | SFH-203 | 35° | 7(<50) | 7.5(>5.0) | 7.6 | 555 | Hermetic seal glass lens for high reliability. BG 38 Filter | 368 |

High Reliability

Photodiodes

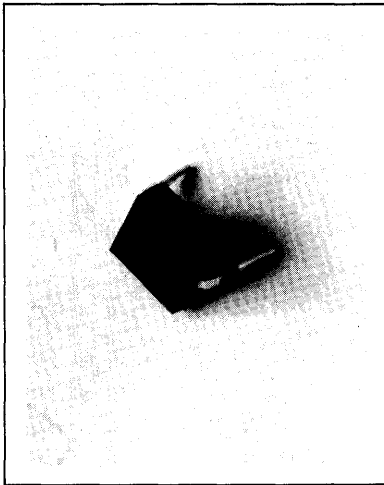
| Package Type | Package Outline | Part Number | Half Angle | Dark Current [N] E.O. IR(nA) | Sensitivity s(nA/ls) Typical | Radiant Sensitive Area mm ² | Peak Wavelength | Features | Page | | | | | | |
|---|---|-------------|------------|------------------------------|--------------------------------------|--|-----------------|---|---|---|-----|----|-----|---|---------|
| Plastic, Black, Solder Tabs 1/10" Spacing |  | SFH205 | 70° | 2(< 30) (10V) | 50µA $\frac{\text{cm}^2}{\text{mW}}$ | 7.6 | 950 | PIN Type built in filter Curved surface Superior s/n ratio at low luminance | 372 | | | | | | |
| | | | | | | | | Plastic, Colorless Solder Tabs 1/10" Spacing |  | SFH206 | 60° | 70 | 850 | PIN Type built in filter Flat surface Superior s/n ratio at low luminance | 376 |
| | | | | | | | | | | | | | |  | SFH206K |
| Plastic, Colorless Solder Tabs |  | BPX48 | 60° | 100(< 200) (10V) | 32 | 2x1.5 | 850 | Differential type. Fast response. Photodiodes separated by 50 micrometers. | 342 | | | | | | |
| | | | | | | | | | |  | | | | | |
| Miniature 6 Lead |  | SFH204 | — | 0.01(< 2) (10V) | .11 | 4x.01 | 850 | Four quadrant. Two axis precision position control. Fast response. Photodiodes separated by 12 micrometers. | 370 | | | | | | |

Photodiodes

| Package Type | Package Outline | Part Number | Half Angle | Dark Current [V _R] E-O I _R (nA) | Sensitivity s(nA/lx) Typical | Radiant Sensitive Area mm ² | Peak Wavelength | Features | Page |
|---|---|-------------|------------|--|------------------------------|--|-----------------|--|------|
| Similar to TO-5 Flat Glass Lens High Reliability |  | BPX60 | 50° | 7(<300) (10V) | 50 | 7.6 | 850 | Superior signal to noise ratio at low luminance | 344 |
| |  | BPX61 | | 2(<30) (10V) | 70 | | | PIN type Superior s/n ratio at low luminance. Low dark current 2 nA. | 346 |

SIEMENS

BP 104 PIN PHOTODIODE



FEATURES

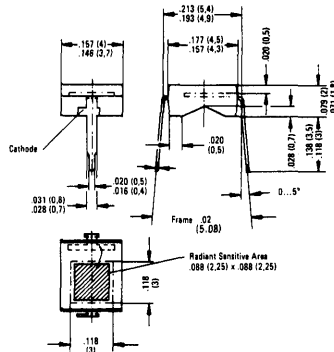
- Silicon Planar PIN Photodiode
- IR Transparent Filter Plastic Package
- 2/10" Lead Spacing
- High Speed, 10 ns

DESCRIPTION

BP 104 is a silicon planar PIN photodiode, encapsulated in a plastic package, which simultaneously serves as filter and is transparent to IR radiation. Its terminals are soldering tabs spaced 5.08 mm (2/10") apart. Due to its design the diode can easily be mounted, even on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible. Arrays can be realized by multiple arrangements. This universal photodetector is suitable for diode as well as voltaic cell operation. The signal/noise ratio is particularly favorable, even at low illuminances.

The PIN photodiode is outstanding for its low junction capacitance, high maximum frequency, and fast switching times. It is particularly suitable for IR sound transmission

Package Dimensions in Inches (mm)



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

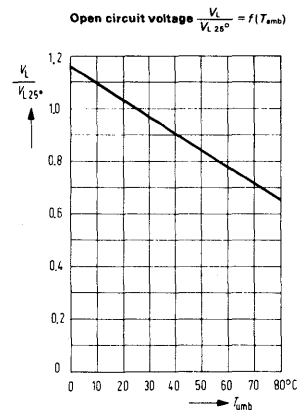
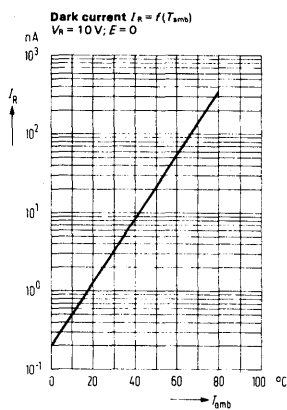
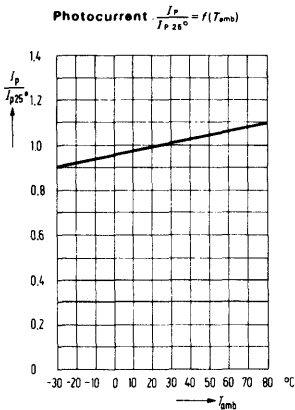
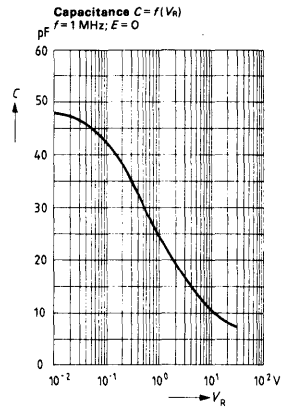
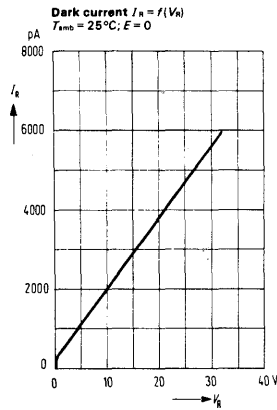
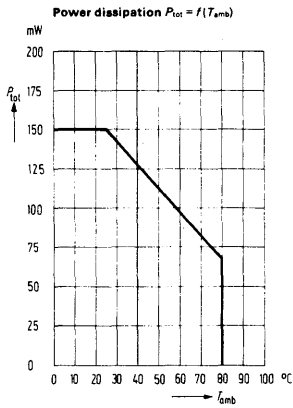
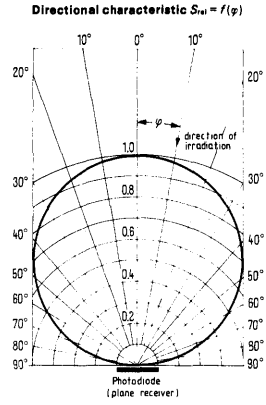
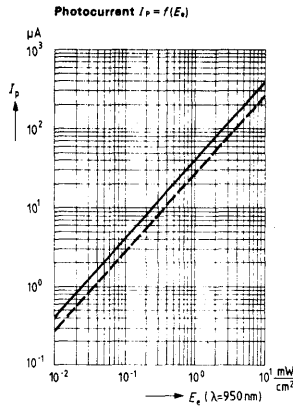
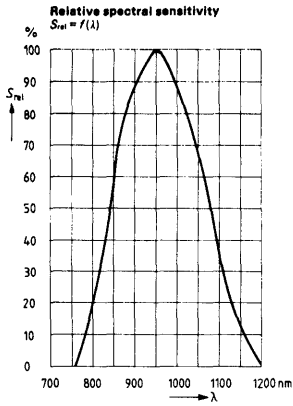
Maximum Ratings

| | | | |
|---|------------|------------|----|
| Reverse voltage | V_R | 20 | V |
| Operating and storage temperature range | T_{stor} | -40 to +80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 150 | mW |

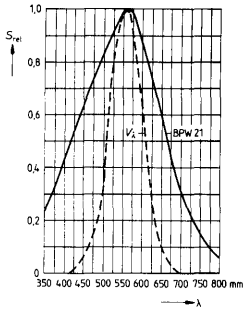
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|--------------------|-----------------------|---|
| Spectral sensitivity ($V_R = 5$ V) ($\lambda = 950$ nm) | S | 40 (≥ 25) | $\mu\text{A} \cdot \frac{\text{cm}^2}{\text{mW}}$ |
| Wavelength of max. spectral sensitivity | $\lambda_{s, max}$ | 950 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 950$ nm) | η | 0.92 | Electrons/Photon |
| Spectral sensitivity ($\lambda = 950$ nm, $V_R = 5$ V) | S | 0.71 | A/W |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | t_r, t_f | 125 | ns |
| ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm) | t_r, t_f | 10 | ns |
| Temperature coefficient for I_k or I_p | TC | 0.18 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 48 | pF |
| ($V_R = 3$ V; $f = 1$ MHz; $E = 0$) | C_3 | 17 | pF |
| Radiant sensitive area | A | 5.06 | mm ² |
| Dark current ($V_R = 10$ V) | I_R | 2 (≤ 30) | nA |
| Noise equivalent power ($V_R = 10$ V) | NEP | 4.2×10^{-14} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| Detection limit | D^* | 5.4×10^{12} | $\frac{\text{cm} \sqrt{\text{Hz}}}{\text{W}}$ |

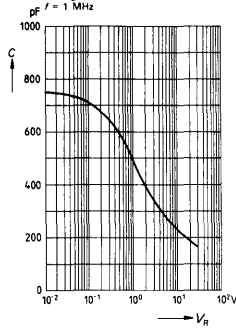
Specifications are subject to change without notice.



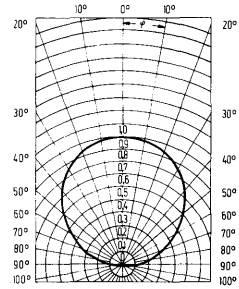
Relative spectral photosensitivity versus wavelength



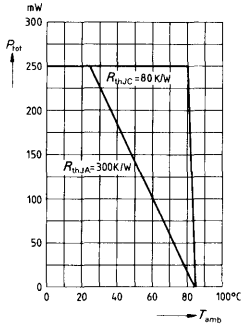
Capacitance versus reverse voltage
 $f = 1 \text{ MHz}$



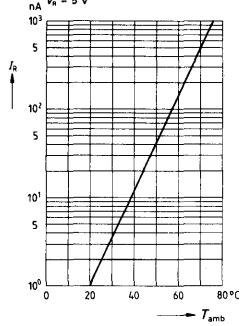
Directional characteristic
Short-circuit current versus half angle



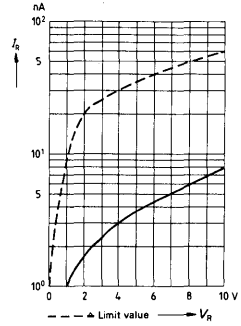
Total power dissipation versus ambient temperature



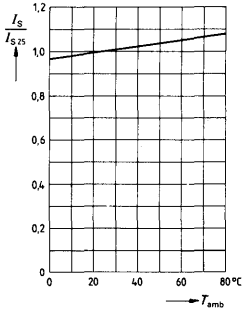
Dark current versus ambient temperature
 $V_R = 5 \text{ V}$



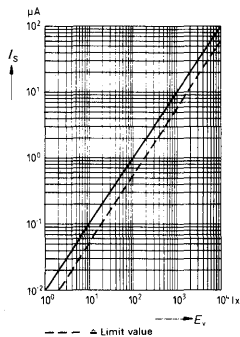
Dark current versus reverse voltage



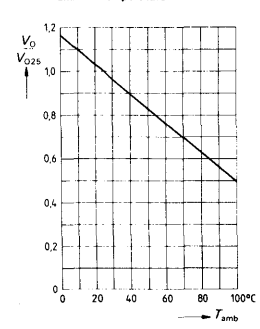
Short-circuit current versus ambient temperature



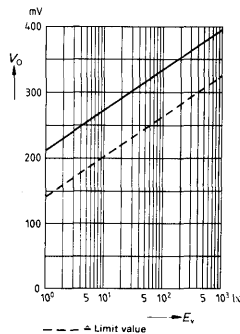
Short-circuit current versus illuminance



Open-circuit voltage versus ambient temperature

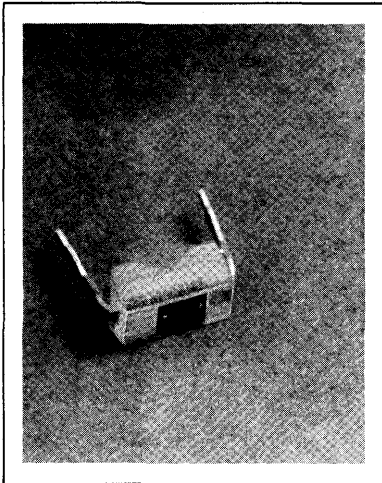


Open-circuit voltage versus illuminance



SIEMENS

BPW 32 PHOTODIODE



FEATURES

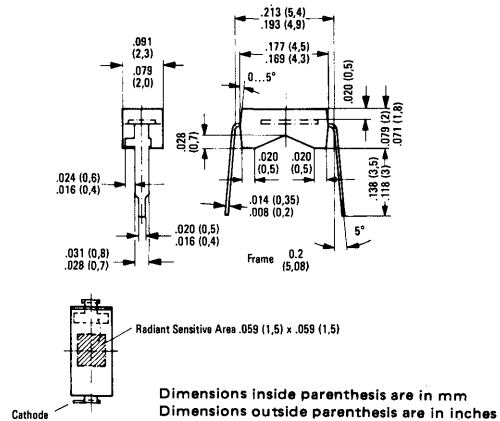
- Silicon Planar Photodiode
- Transparent Plastic Package
- 2/10" Lead Spacing
- Very Low Dark Current, 5 pA

DESCRIPTION

The BPW 32 is a silicon planar photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs, arranged in 5.08 mm (2/10") lead spacing. Because of this design, the diodes can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible.

The BPW 32 has been developed as a detector for low illuminances and is intended for use as a sensor in exposure meters and automatic exposure timers. The component is outstanding for low dark currents and — when used as a voltaic cell — for a high open circuit voltage at low illuminances. The cathode is marked by an orange dot.

Package Dimensions



Maximum Ratings

| | | | |
|---|------------|--------------|----|
| Reverse voltage | V_R | 7 | V |
| Storage temperature range | T_{stor} | - 55 to + 80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 100 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|-----------------|-----------------------|--|
| Spectral sensitivity ¹⁾ | S | 10 (± 7) | nA/lx |
| Zero cross over ²⁾ | S_0 | ≥ 0.5 | mV/pA |
| ($E_a = 0$ lx; $T = 50^\circ\text{C}$) | A | 1 | mm ² |
| Radiant sensitive area | λ_s max | 800 | nm |
| Wavelength of the max. sensitivity | η | 0.73 | Electrons/Photon |
| Quantum yield | S | 0.47 | A/W |
| (Electrons per photon) ($\lambda = 800$ nm) | $t_r; t_f$ | 1.3 | μs |
| Spectral sensitivity ($\lambda = 800$ nm) | $t_r; t_f$ | 1.0 | μs |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | C_0 | 120 | pF |
| ($R_L = 1$ k Ω ; $V_R = 5$ V; $\lambda = 950$ nm) | C_3 | 50 | pF |
| Capacitance ($V_R = 0$ V; $E = 0$) ($V_R = 3$ V; $E = 0$) | I_k | 5 (≤ 20) | pA |
| Dark current ($V_R = 1$ V; $E = 0$) | TC | 0.2 | %/K |
| ($V_R = 1$ V; $E = 0$) | NEP | 2.1×10^{-15} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| Temperature coefficient of I_k | NEP | 2.1×10^{-15} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| Noise equivalent power ($V_R = 1$ V) | D^* | 4.8×10^{13} | $\frac{\text{cm}^2/\text{Hz}}{\text{W}}$ |
| Detection limit | | | |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp; at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC Publ. 306 1).

²⁾ S_0 is a measure for the lower spectral sensitivity when the photodiode is used in exposure meters. The zero cross over S_0 is defined in the diagram.

Specifications are subject to change without notice.

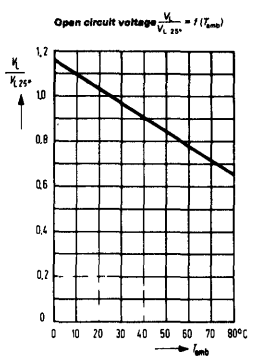
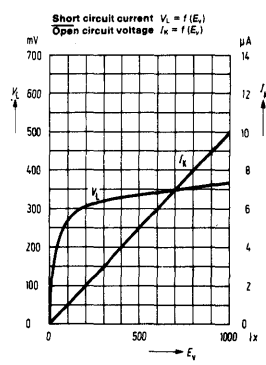
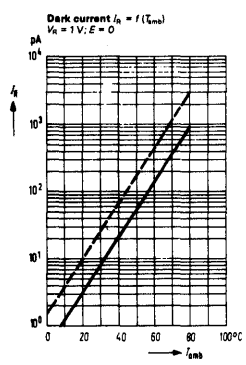
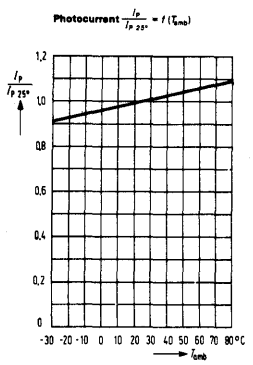
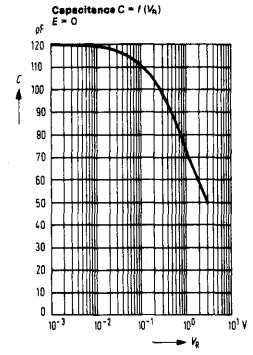
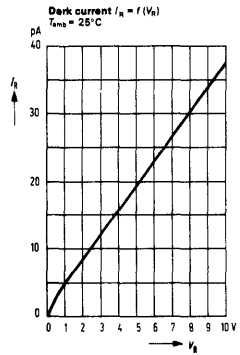
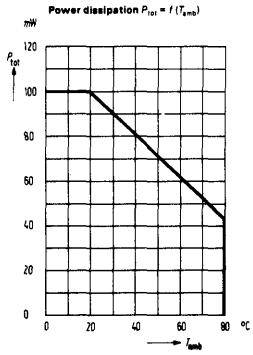
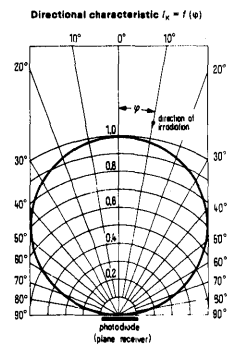
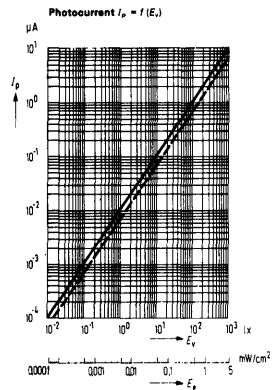
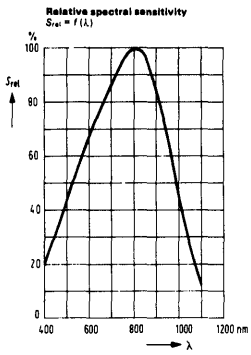
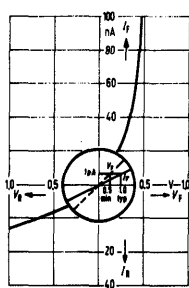
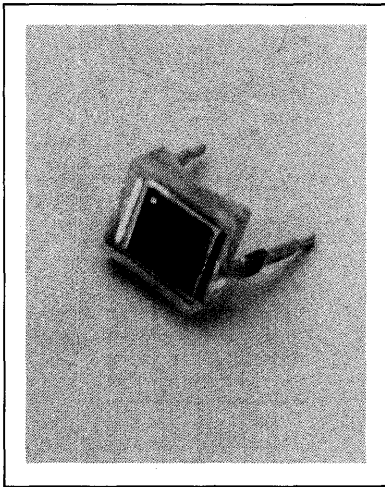


Diagram of the zero cross over S_0





FEATURES

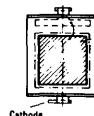
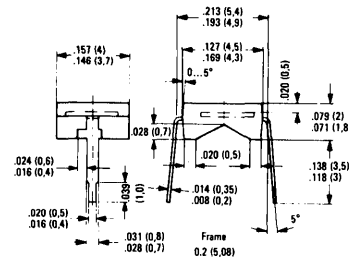
- Silicon Planar Photodiode
- Transparent Plastic Package
- 2/10" Lead Spacing
- Very Low Dark Current, 20 pA
- High Sensitivity, 50 nA/lx

DESCRIPTION

The BPW 33 is a large area silicon planar photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs, arranged in 5.08 mm (2/10") lead spacing. Because of its design the diodes can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible.

The BPW 33 has been developed as a detector for low illuminances and is intended for use as a sensor in exposure meters and automatic exposure timers. The component is outstanding for high open circuit voltage at low illuminances. The cathode is marked by an orange dot.

Package Dimensions



Radiant Sensitive Area
.108 (2,75) x .108 (2,75)

Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

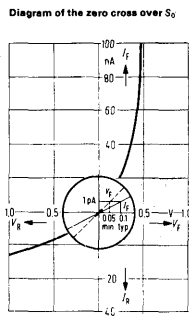
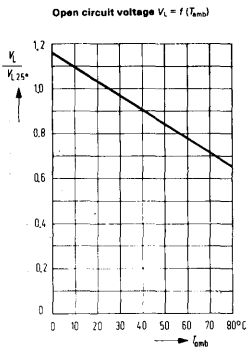
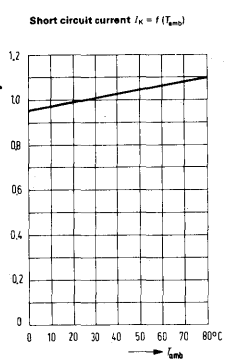
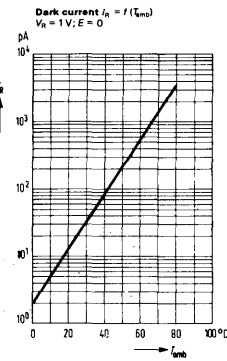
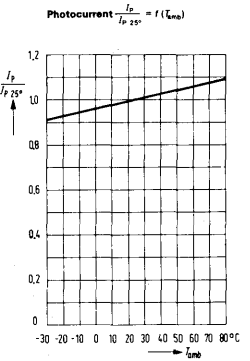
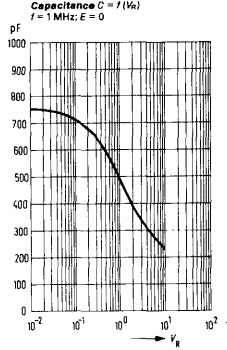
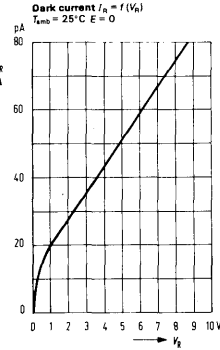
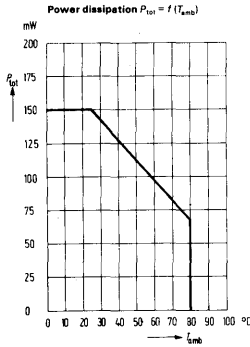
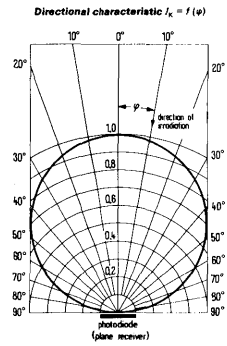
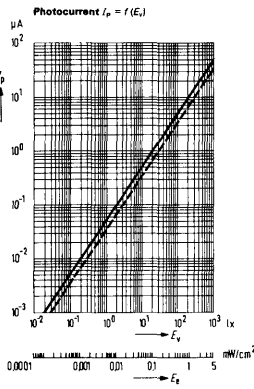
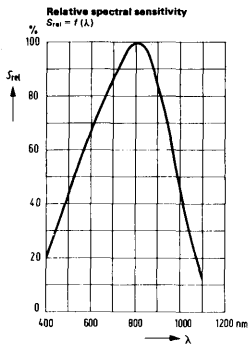
| | | | |
|---|------------|------------|----|
| Reverse voltage | V_R | 7 | V |
| Storage temperature range | T_{stor} | -40 to +80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 150 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|------------------|-----------------------|--|
| Spectral sensitivity ¹⁾ | S | 50 (≥ 35) | nA/lx |
| Zero cross over ²⁾ | | | |
| ($E_V = 0$; $T_{amb} = 50^\circ\text{C}$) | S_0 | ≥ 0.05 | mV/pA |
| Radiant sensitive area | A | 7.6 | mm ² |
| Wavelength of the max. sensitivity | λ_{Smax} | 800 | nm |
| Quantum yield | η | 0.73 | Electrons/Photon |
| (Electrons per photon) ($\lambda = 800$ nm) | S | 0.47 | A/W |
| Spectral sensitivity ($\lambda = 800$ nm) | | | |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value | t_r ; t_f | 2.5 | μs |
| ($R_L = 1 \text{ k}\Omega$; $V_R = 0 \text{ V}$; $\lambda = 950$ nm) | t_r ; t_f | 1.0 | μs |
| ($R_L = 1 \text{ k}\Omega$; $V_R = 5 \text{ V}$; $\lambda = 950$ nm) | C_D | 750 | pF |
| Capacitance ($V_R = 0 \text{ V}$; $E = 0$) | C_S | 330 | pF |
| ($V_R = 3 \text{ V}$; $E = 0$) | | | |
| Dark current | I_R | 20 (≤ 100) | pA |
| ($V_R = 1 \text{ V}$; $E = 0$) | TC | 0.2 | %/K |
| Temperature coefficient of I_k | | | |
| Noise equivalent power | NEP | 5.3×10^{-15} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| ($V_R = 1 \text{ V}$) | | | |
| Detection limit | D^* | 5.2×10^{13} | $\frac{\text{cm}^2/\text{Hz}}{\text{W}}$ |

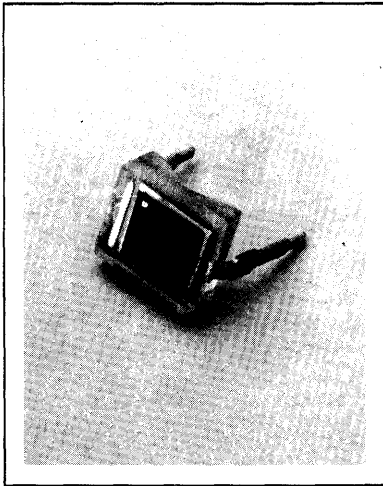
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5040 and IEC publ. 306-1).

²⁾ S_0 is a measure for the lower spectral sensitivity when the photodiode is used in exposure meters. The zero cross over S_0 is defined in the diagram.



SIEMENS

BPW 34 PIN PHOTODIODE



FEATURES

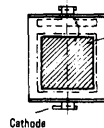
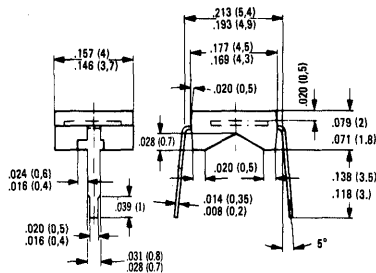
- Silicon Planar PIN Photodiode
- Transparent Plastic Package
- 2/10" Lead Spacing
- Low Junction Capacitance, ≤ 40 pF
- Short Switching Time, 50 ns
- High Sensitivity, 70 nA/lx

DESCRIPTION

The BPW 34 is a silicon planar PIN photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs arranged in 5.08 mm (2/10") lead spacing. Due to its design the diode can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible.

Arrays can be realized by multiple arrangements. This versatile photodetector can be used as a diode as well as a voltaic cell. The signal/noise ratio is particularly favorable, even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells. The PIN photodiode is outstanding for low junction capacitance, high cut-off frequency and short switching times. The photodiode is particularly suitable for IR sound transmission.

Package Dimensions



Radiant Sensitive Area .108 (2,75) x .108 (2,75)

Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

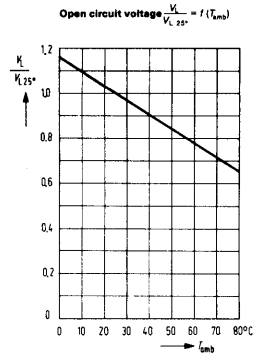
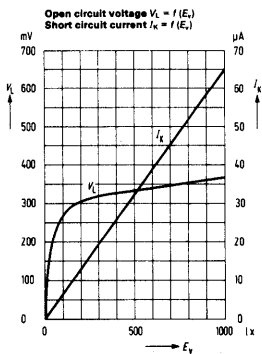
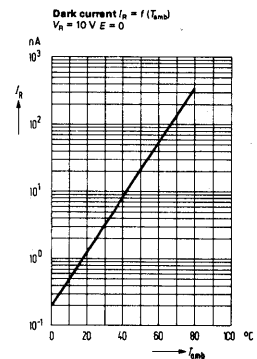
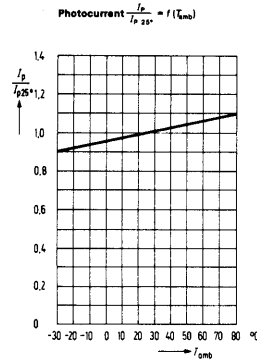
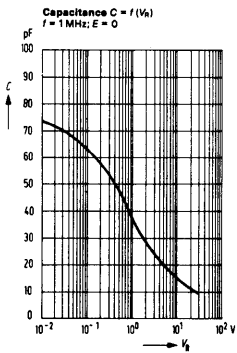
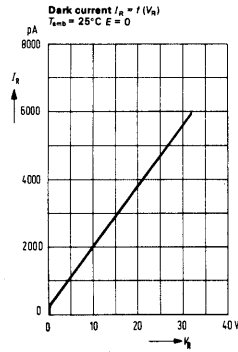
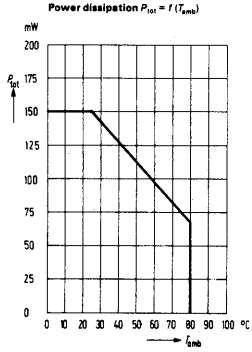
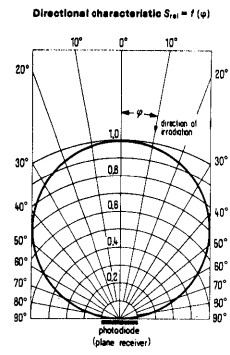
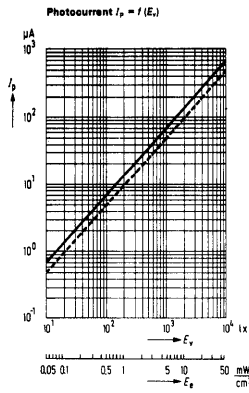
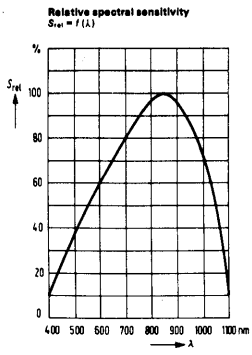
| | | | |
|---|------------|------------|--------------|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature range | T_{stor} | -40 to +80 | $^{\circ}$ C |
| Soldering temperature | T_s | 230 | $^{\circ}$ C |
| Power dissipation ($T_{amb} = 25^{\circ}$ C) | P_{tot} | 150 | mW |

Characteristics ($T_{amb} = 25^{\circ}$ C)

| | | | |
|--|------------------|------------------------|-----------------------|
| Spectral sensitivity ¹⁾ ($V_R = 5$ V) | S | 70 (≥ 50) | nA/lx |
| Wavelength of the max. sensitivity | λ_{smax} | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.88 | Electrons |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.60 | A/W |
| Open circuit voltage ($E_v = 100$ lx) ¹⁾ | V_L | 285 | mV |
| Open circuit voltage ($E_v = 1000$ lx) ¹⁾ | V_L | 365 | mV |
| Short circuit current ($E_v = 100$ lx) ¹⁾ | I_K | 6.5 | μ A |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 850$ nm) ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 850$ nm) | t_r ; t_f | 125 | ns |
| Temperature coefficient of V_L | T_C | -2.6 | mV/K |
| Temperature coefficient of I_K or I_p | T_C | 0.18 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) ($V_R = 3$ V; $f = 1$ MHz; $E = 0$) | C_0 C_3 | 72 25 (≤ 40) | pF |
| Radiant sensitive area | A | 7.6 | mm ² |
| Dark current ($V_R = 10$ V) | I_R | 2 (≤ 30) | nA |
| Noise equivalent power ($V_R = 10$ V) | NEP | 4.2×10^{-14} | $\frac{W}{\sqrt{Hz}}$ |
| Detection limit | D^* | 6.8×10^{12} | $\frac{cm^2}{Hz}$ |

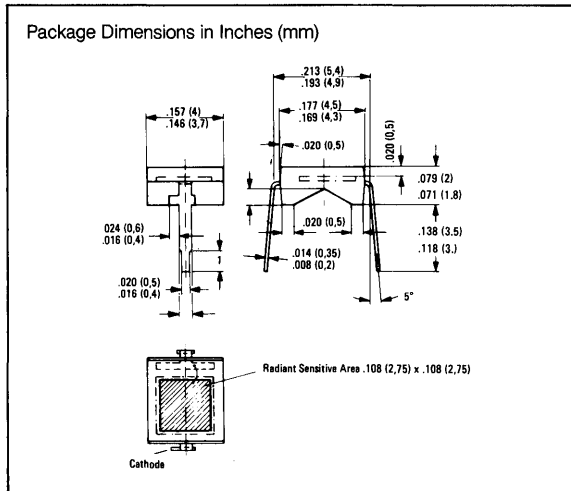
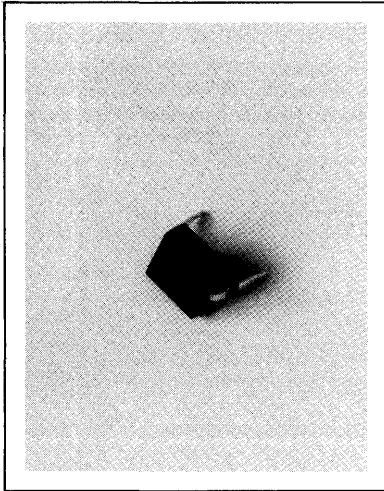
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A) in accordance with DIN 5030 and IEC publ. 506-1).

Specifications are subject to change without notice.



SIEMENS

BPW 34F PIN PHOTODIODE



FEATURES

- Silicon Planar Pin Photodiode
- Plastic Package
- 2/10" Lead Spacing
- Low Junction Capacitance, ≤ 40 pF
- Short Switching Time
- High Sensitivity

DESCRIPTION

The BPW 34F is a silicon planar PIN photodiode, which is incorporated in a plastic package. Its terminals are soldering tabs arranged in 5.08 mm (2/10") lead spacing. due to its design the diode can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible.

Arrays can be realized by multiple arrangements. This versatile photodetector can be used as a diode as well as a voltaic cell. The signal/noise ratio is particularly favorable, even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells. The PIN photodiode is outstanding for low junction capacitance, high cut-off frequency and short switching times. The photodiode is particularly suitable for IR sound transmission. The cathode is marked by a blue dot.

Maximum Ratings

| | | | |
|---|------------|------------|----|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature range | T_{stor} | -40 to +80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 150 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|-----------------|-----------------------|---|
| Spectral sensitivity ($V_R = 5$ V, $\lambda = 950$ nm) | S | 50 (≥ 30) | $\frac{\mu\text{A cm}}{\text{mW}}$ |
| Wavelength of the max. sensitivity | λ_s max | 950 | nm |
| Spectral range of photosensitivity of ($S = 10\%$ of S max) | λ | 800-1100 | nm |
| Radiant sensitive area | A | 7.34 | mm ² |
| Dimensions of the radiant sensitivity area | L x B | 2.71 x 2.71 | mm |
| Distance chip surface to package surface | H | 0.5 | mm |
| Half angle | φ | $\pm 60^\circ$ | degrees |
| Dark current ($U_R = 10$ V) | I_{dR} | $2 (\leq 30)$ | nA |
| Spectral sensitivity ($\lambda = 950$ nm) | S_λ | 0.57 | A/W |
| Quantum yield ($\lambda = 950$ nm) | η | 0.74 | $\frac{\text{Electrons}}{\text{Photon}}$ |
| Open circuit voltage ($E_g = 0.5$ mW/cm ² ; $\lambda = 950$ nm) | V_O | 327 | mV |
| Short circuit current ($E_g = 0.5$ mW/cm ² ; $\lambda = 950$ nm) | I_S | 25 (≥ 15) | μA |
| Rise and fall time of the photo current from 10% to 90%, or from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) and a photo current ($I_p = 25$ μA) | t_r, t_f | 125 | ns |
| Forward voltage at ($I_f = 100$ mA, $E_g = 0$, $T_U = 25^\circ\text{C}$) | V_F | 1.3 | V |
| Temperature coefficient of V_O | TK | -2.6 | mV/K |
| Temperature coefficient of I_S | TK | 0.18 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E_V = 0$) | C | 72 | pF |
| Noise equivalent power ($V_R = 10$ V) | NEP | 4.4×10^{-14} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| Detection limit ($V_R = 10$ V) | D | 6.3×10^{12} | $\frac{\text{cm} \sqrt{\text{Hz}}}{\text{W}}$ |

1) The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5030 and IEC publ. 306-1).

RELATIVE SPECTRAL SENSITIVITY

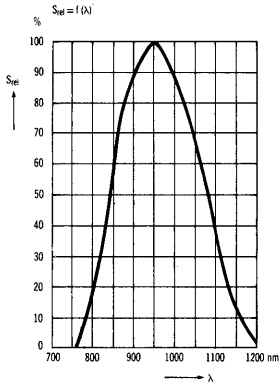
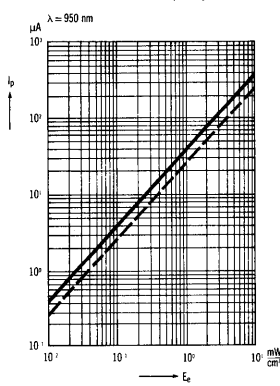
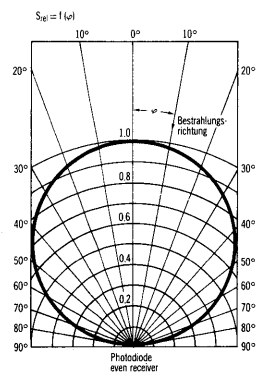


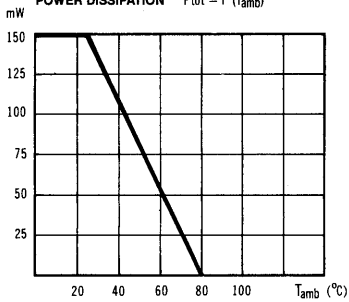
PHOTO CURRENT $I_p = f(E_e)$



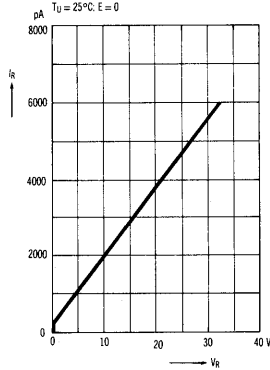
DIRECTIONAL CHARACTERISTIC



POWER DISSIPATION $P_{tot} = f(T_{amb})$



DARK CURRENT $I_k = f(V_R)$



CAPACITANCE $C = f(V_R)$

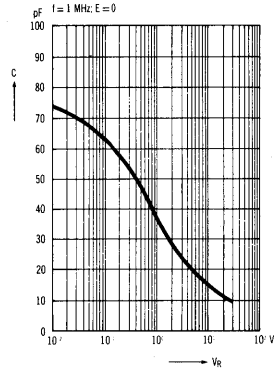
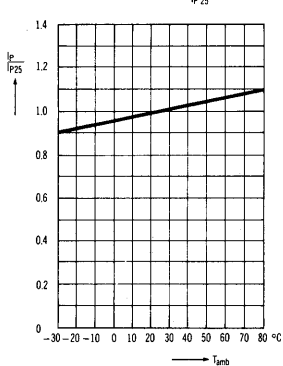
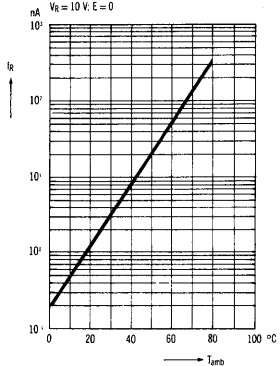


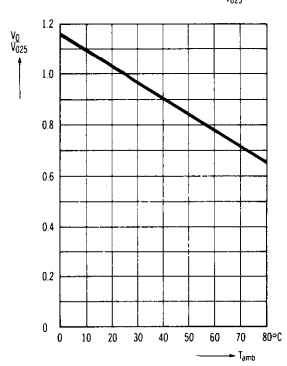
PHOTO CURRENT $\frac{I_p}{I_{p25}} = f(T_{amb})$



DARK CURRENT $I_k = f(T_{amb})$

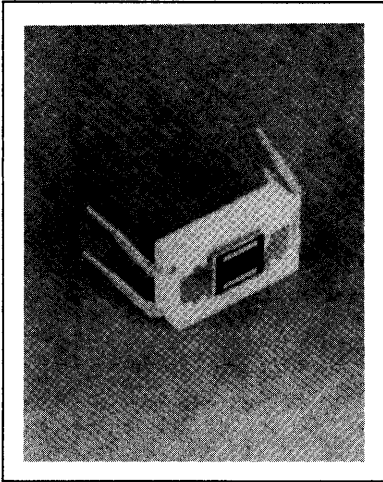


OPEN CIRCUIT VOLTAGE $\frac{V_O}{V_{O25}} = f(T_{amb})$

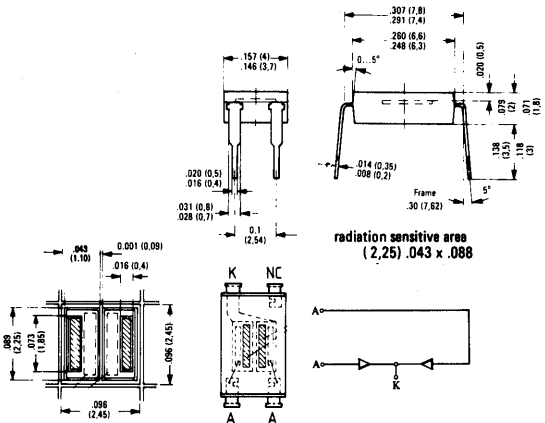


SIEMENS

BPX 48 DIFFERENTIAL PHOTODIODE



Package Dimensions in Inches (mm)



radiation sensitive area

Maximum Ratings

| | | | |
|---------------------------|------------|------------|----|
| Reverse voltage | V_R | 10 | V |
| Junction temperature | T_J | 125 | °C |
| Storage temperature range | T_{stor} | -40 to +80 | °C |
| Power dissipation | P_{tot} | 50 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

(the data refers to one photodiode system)

| | | | |
|---|-------------------|--------------------|---------------------|
| Spectral sensitivity ¹⁾ | S | 32 (≥ 15) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{S\max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.80 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.55 | A/W |
| Rise and fall time of the photo current from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V) | $t_r; t_f$ | ≤ 500 | ns |
| ($R_L = 1$ k Ω ; $V_R = 10$ V) | $t_r; t_f$ | ≤ 150 | ns |
| Cut-off frequency measured with a load resistance ($R_L = 1$ k Ω ; $V_R = 10$ V) | f_g | 3 | MHZ |
| Capacitance ($V_R = 0$ V) | C_0 | 40 | pF |
| ($V_R = 10$ V) | C_{10} | 10 | pF |
| Radiant sensitive area | A | 2×2.47 | mm ² |
| Dark current ($V_R = 10$ V; $E = 0$) | I_R | 100 (≤ 200) | nA |

1) The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

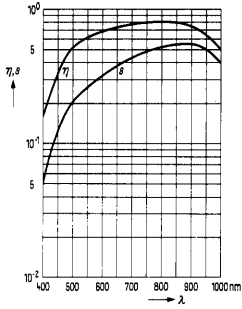
FEATURES

- Differential Photodiode
- Plastic Encapsulated, Strip Line Technique
- Tightly Spaced Diodes For Precise Positional Indication

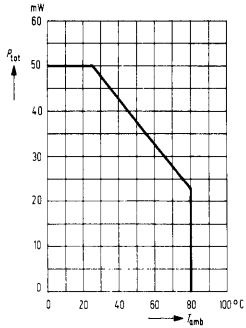
DESCRIPTION

The differential photodiode BPX 48 is designed for special industrial electronic applications, such as follow-up control, edge control, path and angle scanning, respectively. The individual diodes are spaced 90 μm apart, thus resulting in a highly precise positional indication. The rise and fall times of the photocurrent are so short that control systems with small down times can be built up. The silicon planar method ensures a low dark current level, low noise and thus very favorable signal relationships.

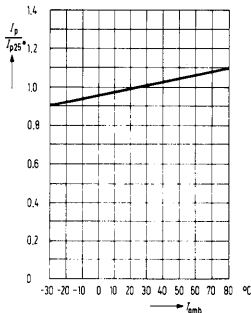
**Spectral sensitivity $S = f(\lambda)$
in A/W and quantum yield $\eta = f(\lambda)$
in electrons per photon**



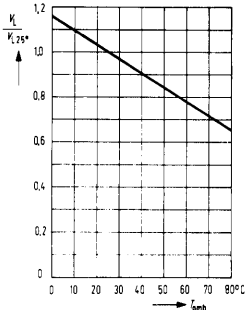
Power dissipation $P_{tot} = f(T_{amb})$



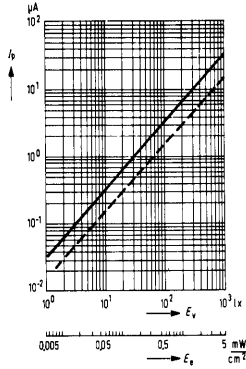
Photocurrent $\frac{I_p}{I_{p25^{\circ}}} = f(T_{amb})$



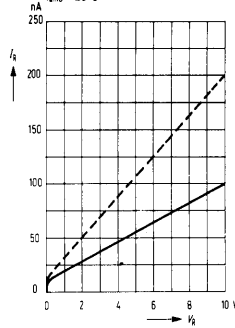
Open circuit voltage $V_k = f(T_{amb})$



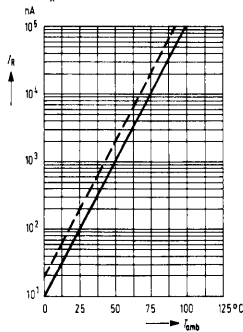
Photocurrent $I_p = f(E_v)$



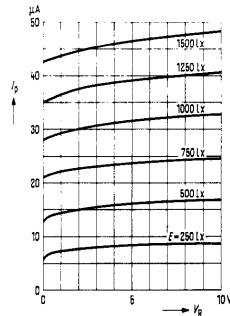
**Dark current $I_{d0} = f(V_R)$
 $T_{amb} = 25^{\circ}\text{C}$**



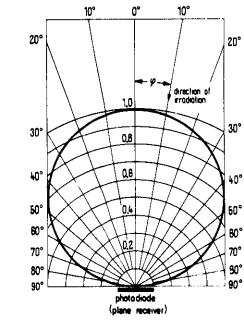
**Dark current $I_{d0} = f(T_{amb})$
 $V_R = 10\text{ V}$**



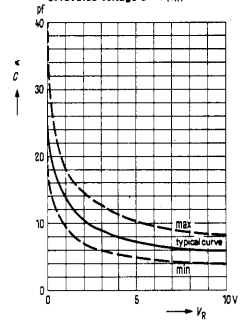
**Family of characteristics $I_p = f(V_R)$
 $E_v = \text{parameter}$**



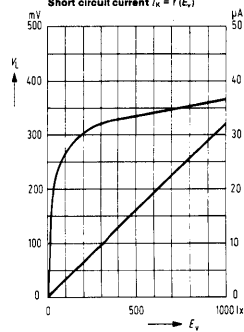
Directional characteristic $I_p = f(\varphi)$



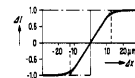
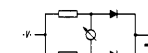
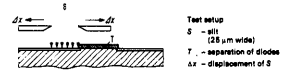
**Diode capacitance as a function
of reverse voltage $C = f(V_R)$**



**Open circuit voltage $V_k = f(E_v)$
Short circuit current $I_k = f(E_v)$**



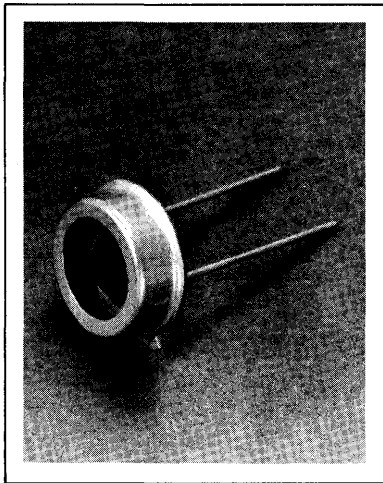
**Scanning a differential photodiode
with a 28 μm light beam.**



Test setup
 $S = 28\ \mu\text{m}$ (width)
 T - separation of diodes
 Δx - displacement of S

Measuring circuit

**Differential photo signal ΔI
(related to saturation value I_0)
as a function of the displacement Δx
of the axis of light S**



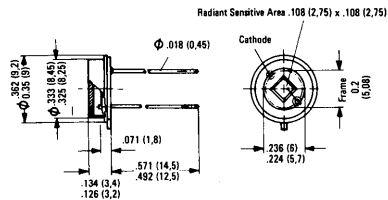
FEATURES

- Silicon Planar Photodiode
- Premium Hi-Rel Device
- Modified TO-5 Hermetic Case
- Flat Glass Lens
- Large Photo Sensitive Area

DESCRIPTION

The BPX 60 is a planar silicon photodiode. The large area photosensitive system is suitable for cell as well as diode operation at a very low reverse current level. The hermetically sealed case—a TO-5 modification with flat glass window—allows application at extreme operating conditions. The signal/noise ratio is particularly favorable even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

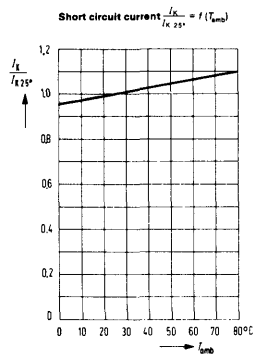
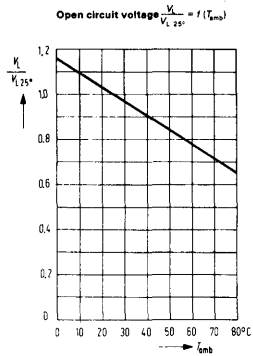
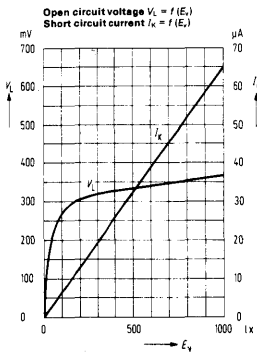
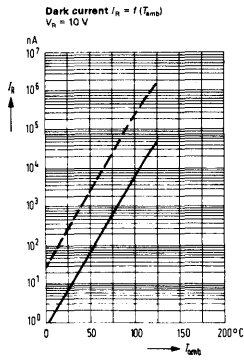
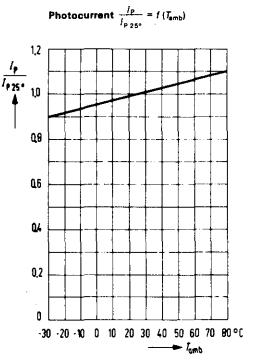
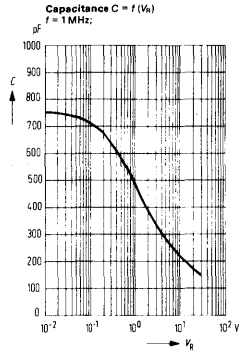
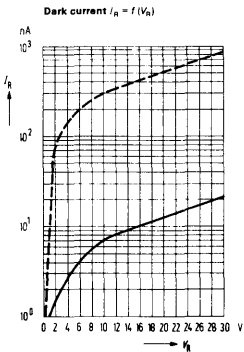
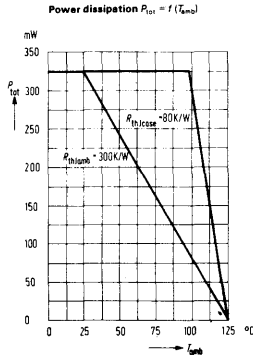
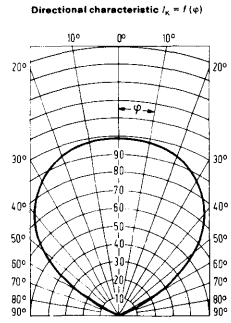
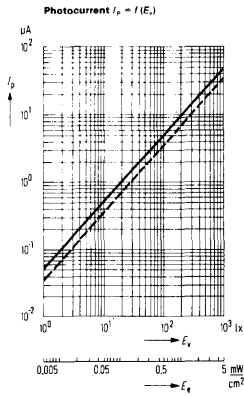
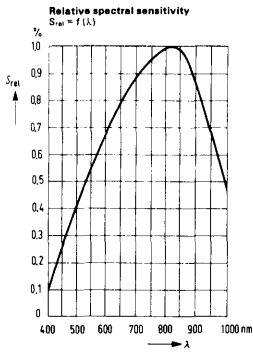
Maximum Ratings

| | | | |
|---|----------------|-------------|-----|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature range | T_{stor} | -40 to +100 | °C |
| Junction temperature | T_j | 100 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation | P_{tot} | 325 | mW |
| Thermal resistance | $R_{th Jamb}$ | 300 | K/W |
| | $R_{th Jcase}$ | 80 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|-------------------|--------------------|------------------|
| Spectral sensitivity ¹⁾ | S | 50 (≥ 35) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{S max}$ | 850 | nm |
| Quantum yield | η | 0.73 | Electrons/Photon |
| (Electrons per photon) ($\lambda = 850$ nm) | S | 0.50 | A/W |
| Spectral sensitivity ($\lambda = 850$ nm) | V_L | 360 (≥ 270) | mV |
| Open circuit voltage ($E_v = 100$ lx) ¹⁾ | V_i | 460 | mV |
| ($E_v = 1000$ lx) ¹⁾ | I_K | 5 (≥ 3.5) | μA |
| Short circuit current ($E_v = 100$ lx) ¹⁾ | $t_r; t_f$ | 2.5 | μs |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | $t_r; t_f$ | 1.0 | μs |
| ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm) | TC | -2.6 | mV/K |
| Temperature coefficient of V_L | TC | 0.2 | %/K |
| Temperature coefficient of I_K | C_0 | 750 | pF |
| Junction capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_{10} | 220 | pF |
| ($V_R = 10$ V; $f = 1$ MHz; $E = 0$) | A | 7.6 | mm ² |
| Radiant sensitive area | I_R | 7 (≥ 300) | nA |
| Dark current ($V_R = 10$ V; $T_{amb} = 25^\circ\text{C}$; $E = 0$) | | | |

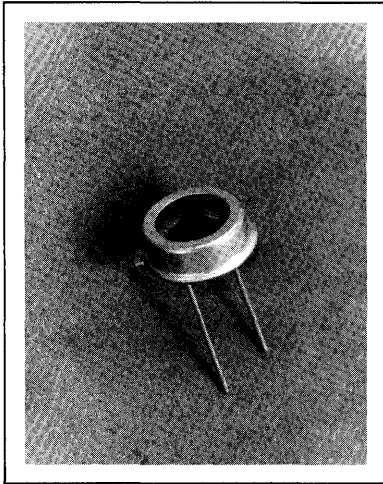
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).



SIEMENS

BPX 61

PIN PHOTODIODE



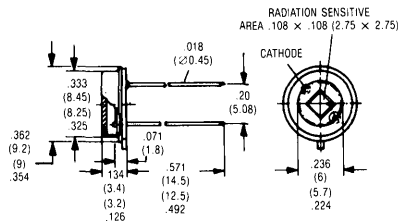
FEATURES

- Silicon Planar PIN Photodiode
- Premium Hi-Rel Device
- Modified TO-5 Hermetic Case
- Flat Glass Lens
- Large Photo Sensitive Area
- Low Dark Current, 2 nA
- Short Switching Time, 50 ns

DESCRIPTION

The BPX 61 is a planar silicon photodiode with low reverse current. Its low capacitance permits use up to 10 MHz. The large area photosensitive system is suitable for cell as well as diode operation at a very low reverse current level. The hermetically sealed case—a TO-5 modification with flat glass window—allows application at extreme operating conditions. The signal/noise ratio is particularly favorable even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells. The PIN photodiode is outstanding for low junction capacitance, high cut-off frequency and short switching times.

Package Dimensions in Inches (mm)



Maximum Ratings

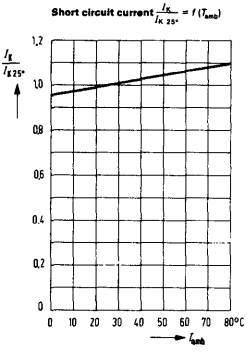
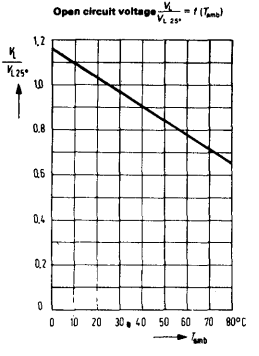
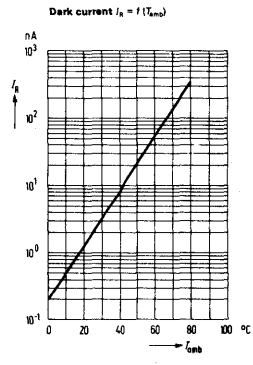
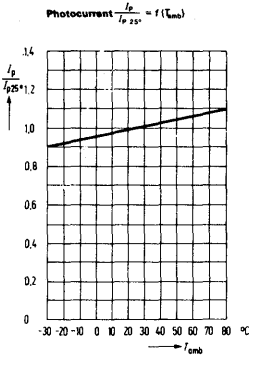
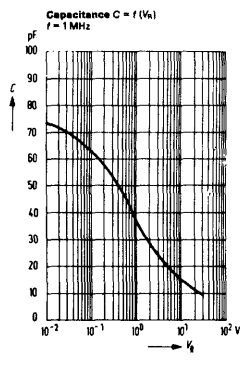
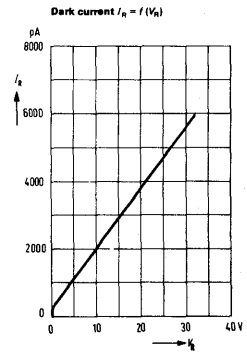
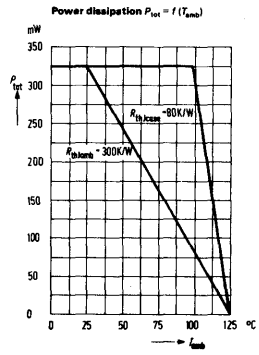
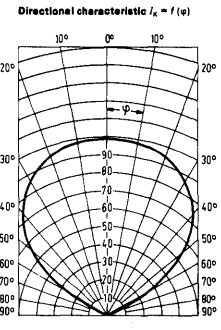
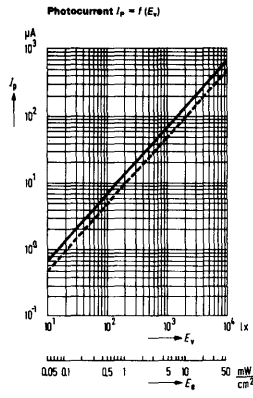
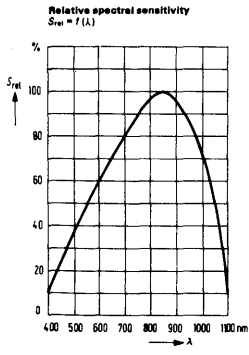
| | | | |
|---|-----------------|-------------|-----|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature range | T_{stor} | -40 to +100 | °C |
| Junction temperature | T_J | 100 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 325 | mW |
| Thermal resistance | $R_{th\ Jamb}$ | 300 | K/W |
| | $R_{th\ Jcase}$ | 80 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|--------------------|-----------------------|-------------------------|
| Spectral sensitivity ¹⁾ ($V_R = 5$ V) | S | 70 (≥ 50) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{S\ max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.88 | Electrons/Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.60 | A/W |
| Open circuit voltage ($E_v = 100$ lx) ¹⁾ ($E_v = 1000$ lx) ¹⁾ | V_L | 285 | mV |
| Short circuit current ($E_v = 100$ lx) ¹⁾ | I_K | 6.5 | μA |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm) | t_r ; t_f | 125 | ns |
| Temperature coefficient of V_L | t_r ; t_f | 50 | ns |
| Temperature coefficient of I_K | TC | - 2.6 | mV/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) ($V_R = 3$ V; $f = 1$ MHz; $E = 0$) | TC | 0.2 | %/K |
| Radiant sensitive area | C_0 | 72 | pF |
| Dark current ($V_R = 10$ V; $T_{amb} = 25^\circ\text{C}$; $E = 0$) | C_S | 25 (≤ 40) | pF |
| Noise equivalent power ($V_R = 10$ V) | A | 7.6 | mm ² |
| Detection limit ($V_R = 10$ V) | I_R | 2 (≤ 30) | nA |
| | NEP | 4.2 $\times 10^{-14}$ | $\frac{W}{\sqrt{Hz}}$ |
| | D^* | 6.6 $\times 10^{12}$ | $\frac{cm\sqrt{Hz}}{W}$ |

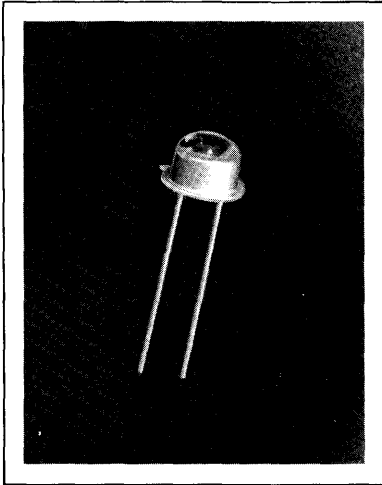
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

Specifications are subject to change without notice.

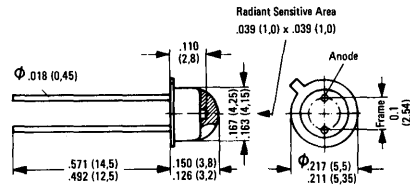


SIEMENS

BPX 63 PHOTODIODE



Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | | | |
|---|------------|--------------|-------------|
| Reverse voltage | V_R | 7 | V |
| Storage temperature range | T_{stor} | - 55 to + 90 | $^{\circ}C$ |
| Power dissipation ($T_{amb} = 25^{\circ}C$) | P_{tot} | 200 | mW |

Characteristics ($T_{amb} = 25^{\circ}C$)

| | | | |
|--|-------------------|-----------------------|---------------------------|
| Spectral sensitivity ¹⁾ | S | 10 (≥ 8) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{S,max}$ | 800 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 800$ nm) | η | 0.73 | Electrons Photon |
| Spectral sensitivity ($\lambda = 800$ nm) | S | 0.47 | A/W |
| Forward voltage ²⁾ ($E = 0$; $I_S = 1$ μA ; $T_{amb} = 50^{\circ}C$) | V_F | 1 (≥ 0.5) | mV |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | t_r ; t_f | 1.3 | μs |
| ($R_L = 1$ k Ω ; $V_R = 5$ V; $\lambda = 950$ nm) | t_r ; t_f | 1.0 | μs |
| Capacitance ($V_R = 0$ V) ($V_R = 3$ V) | C_0 C_3 | 120 50 | μF pF |
| Dark current ($V_R = 1$ V; $E = 0$) | I_R | 5 (≤ 20) | pA |
| Temperature coefficient of I_K | TC | 0.1 | %/K |
| Radiant sensitive area | A | 1 | mm ² |
| Noise equivalent power ($V_R = 1$ V) | NEP | 2.7×10^{-15} | $\frac{W}{\sqrt{Hz}}$ |
| Detection limit ($V_R = 1$ V) | D^* | 3.7×10^{13} | $\frac{cm^2 \cdot Hz}{W}$ |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

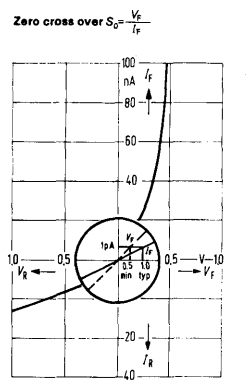
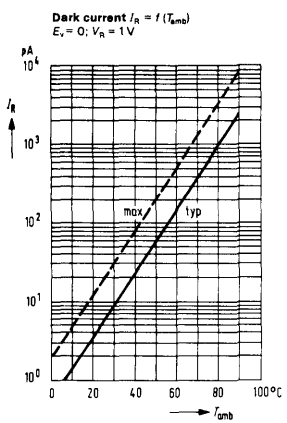
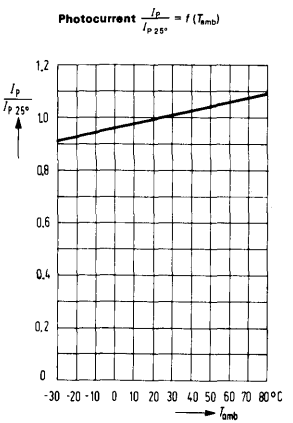
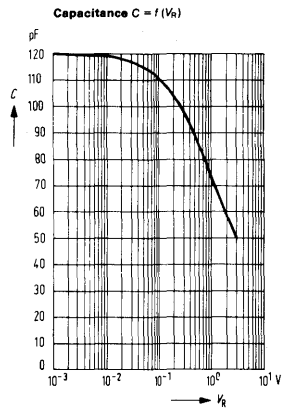
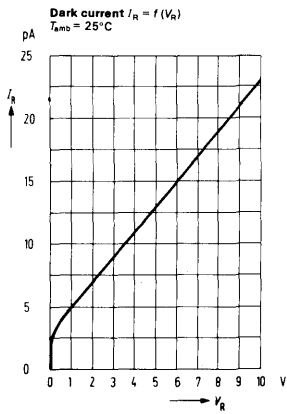
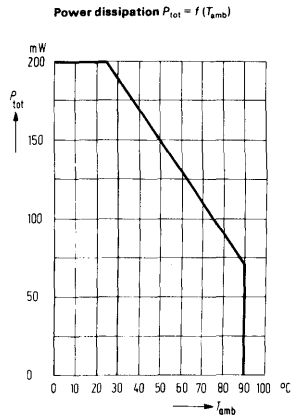
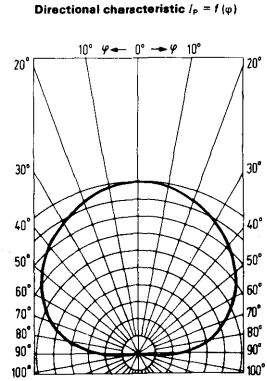
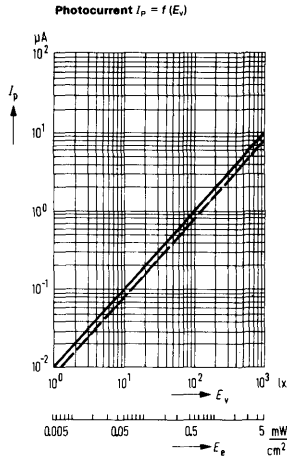
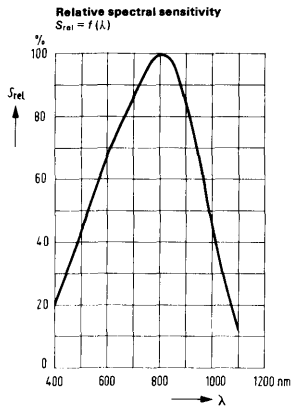
²⁾ V_F is a measure for the lower spectral sensitivity when the photodiode is used in exposure meters.

FEATURES

- Silicon Planar Photodiode
- Modified TO-18 Package
- Metal Case and Plastic Lens
- Very Low Dark Current, 5 pA

DESCRIPTION

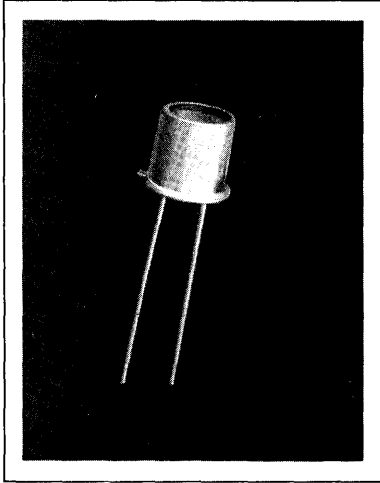
The BPX 63 is a planar silicon photodiode, mounted on a TO-18 base plate and covered with transparent plastic material. The BPX 63 has been developed as a detector for low illuminances and is intended for use as a sensor for exposure meters and automatic exposure meters. The component is outstanding for low dark currents and—when used as a voltaic cell—for a high open circuit voltage at low illuminances. The cathode of the BPX 63 is electrically connected to the case.



SIEMENS

BPX 65

PIN PHOTODIODE



FEATURES

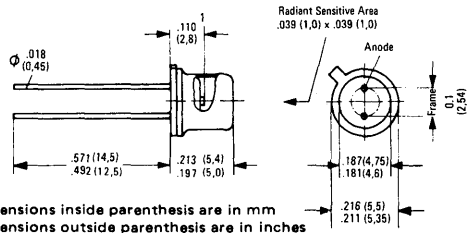
- Silicon Planar PIN Photodiode
- Premium Hi-Rel Device
- TO-18 Size Package
- Flat Glass Lens
- High Speed, 1 ns
- Low Dark Current, 1 nA

DESCRIPTION

The BPX 65 is a planar silicon PIN photodiode in a case 18 A 2 DIN 41876 (sim. to TO-18) with a flat window. The cathode is electrically connected to the case. The flat window has no influence on the beam path of optical lens systems. Because of its high cut-off frequency this diode is particularly suitable for use as optical sensor of high modulation bandwidth.

The PIN photodiode is outstanding for low junction capacitance and short switching times.

Package Dimensions



Maximum Ratings

| | | | |
|---------------------------|------------|-------------|----|
| Reverse voltage | V_R | 50 | V |
| Junction temperature | T_j | 125 | °C |
| Storage temperature range | T_{stor} | -55 to +125 | °C |
| Power dissipation | P_{tot} | 250 | mW |

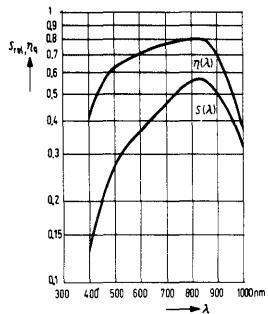
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|--------------------|-----------------------|---|
| Radiant sensitive area | A | 1 | mm ² |
| Wavelength of the max. sensitivity | $\lambda_{S\ max}$ | 850 | nm |
| Quantum yield | | 0.80 | Electrons Photon |
| (Electrons per photon) ($\lambda = 850\ \text{nm}$) | η | | A/W |
| Spectral sensitivity ($\lambda = 850\ \text{nm}$) | S | 0.55 | |
| Rise time of the photo current (load resistance $R_L = 50\ \Omega$; $V_R = 20\ \text{V}$; $\lambda = 900\ \text{nm}$) | t_r | 0.5 (≤ 1) | ns |
| Capacitance ($V_R = 0\ \text{V}$) | C_0 | 15 | pF |
| ($V_R = 1\ \text{V}$) | C_1 | 12 | pF |
| ($V_R = 20\ \text{V}$) | C_{20} | 3.5 | pF |
| Cut off-frequency (load resistance $R_L = 50\ \Omega$; $V_R = 20\ \text{V}$; $\lambda = 900\ \text{nm}$) | f_c | 500 | MHz |
| Dark current ($V_R = 20\ \text{V}$; $E = 0$) | I_D | 1 (≤ 5) | nA |
| Spectral sensitivity \parallel $V_R = 20\ \text{V}$ | S | 10 (≤ 7) | nA/lx |
| Noise equivalent power ($V_R = 20\ \text{V}$) | NEP | 3.3×10^{-14} | $\frac{W}{\sqrt{\text{Hz}}}$ |
| Detection limit ($V_R = 20\ \text{V}$) | D^* | 3.1×10^{12} | $\frac{\text{cm}^2 \cdot \text{Hz}}{W}$ |
| Temperature coefficient for I_D | TC | 0.2 | %/K |

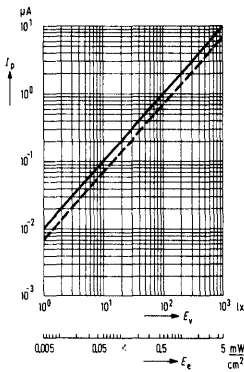
1) The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

Specifications are subject to change without notice.

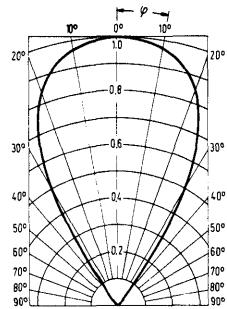
Spectral sensitivity $S_{rel} = f(\lambda)$ in A/W and quantum yield $\eta = f(\lambda)$ in electrons per photon



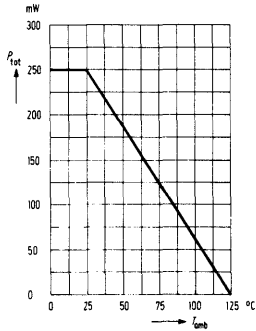
Photocurrent $i_p = f(E_e)$



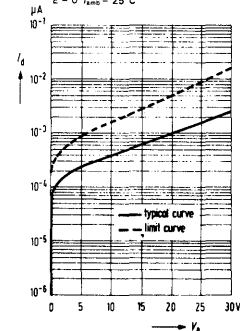
Directional characteristic $i_p = f(\varphi)$



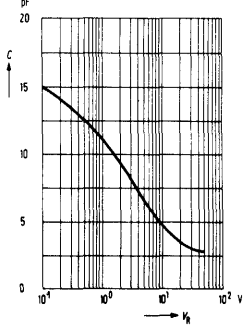
Power dissipation $P_{tot} = f(T_{amb})$



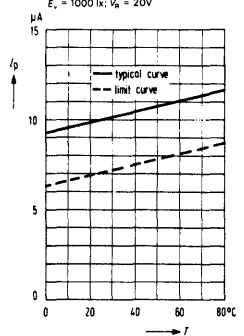
Dark current $i_d = f(V_b)$



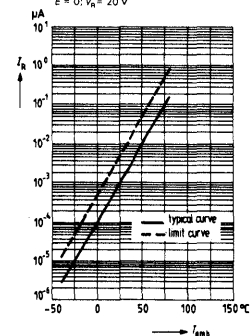
Junction capacitance $C = f(V_b)$



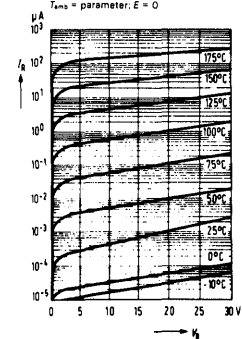
Photocurrent $i_p = f(t)$



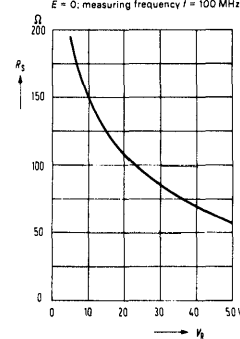
Dark current $i_d = f(T_{amb})$



Dark current $i_d = f(V_b)$

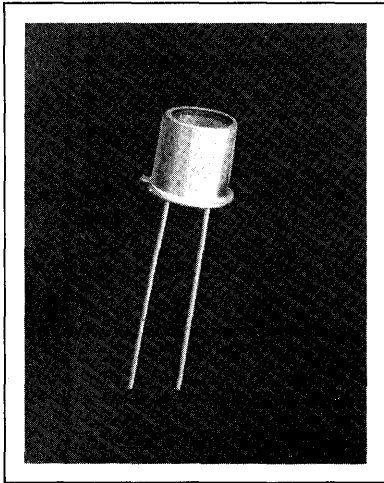


Series resistance $R_s = f(V_b)$



SIEMENS

BPX 66 PIN PHOTODIODE



FEATURES

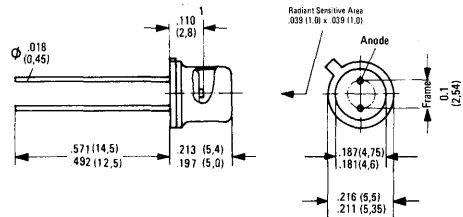
- Silicon Planar PIN Photodiode
- Premium Hi-Rel Device
- TO-18 Size Package
- Flat Glass Lens
- High Speed, 0.5 ns
- Low Dark Current, 0.15 nA

DESCRIPTION

The BPX 66 is a planar silicon PIN photodiode in a case 18 A 2 DIN 41876 (sim. to TO-18) with a flat window and extremely low dark current. The cathode is electrically connected to the case. The flat window has no influence on the beam path of optical lens systems. Because of its high cut-off frequency, this diode is particularly suitable for use as optical sensor of high modulation bandwidth.

The PIN photodiode is outstanding for low junction capacitance and short switching times.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | | | |
|---------------------------|------------|---------------|----|
| Reverse voltage | V_R | 50 | V |
| Junction temperature | T_J | 125 | °C |
| Storage temperature range | T_{stor} | - 55 to + 125 | °C |
| Power dissipation | P_{tot} | 250 | mW |

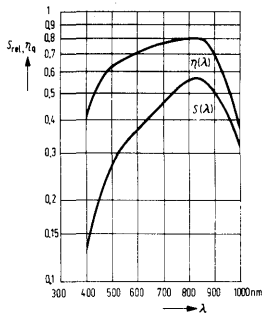
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|-------------------|-----------------------|--------------------------|
| Radiant sensitive area | A | 1 | mm ² |
| Wavelength of the max. sensitivity | $\lambda_{S,max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.80 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.55 | A/W |
| Rise time of the photocurrent (load resistance $R_L = 50 \Omega$; $V_R = 20$ V; $\lambda = 900$ nm) | t_r | 0.5 (≤ 1) | ns |
| Capacitance ($V_R = 0$ V) | C_0 | 15 | pF |
| ($V_R = 1$ V) | C_1 | 12 | pF |
| ($V_R = 20$ V) | C_{20} | 3.5 | pF |
| Cut-off-frequency (load resistance $R_L = 50 \Omega$; $V_R = 20$ V; $\lambda = 900$ nm) | f_g | 500 | MHz |
| Dark current ($V_R = 1$ V; $E = 0$) | I_R | 0.15 (≤ 0.3) | nA |
| Spectral sensitivity ¹⁾ ($V_R = 1$ V) | S | 9 (≥ 5) | nA/Hz |
| Noise equivalent power ($V_R = 1$ V) | NEP | 1.3×10^{-14} | $\frac{W}{\sqrt{Hz}}$ |
| Detection limit ($V_R = 1$ V) | D^* | 6.4×10^{12} | $\frac{cm \sqrt{Hz}}{W}$ |
| Temperature coefficient for I_P | TC | 0.2 | %/K |

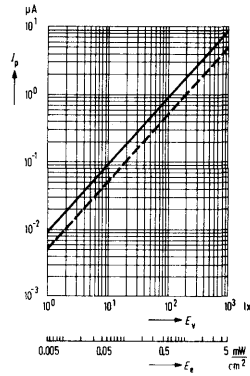
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

Specifications are subject to change without notice.

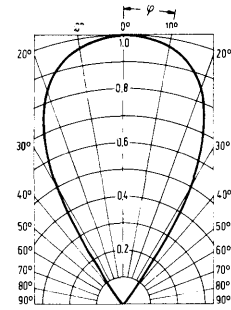
Spectral sensitivity $S_{rel} = f(\lambda)$ in A/W and quantum yield $\eta = f(\lambda)$ in electrons per photon



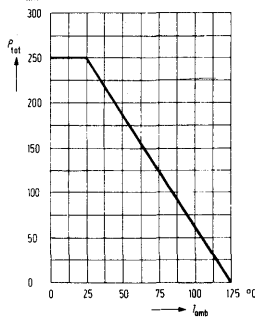
Photocurrent $I_p = f(E_e)$



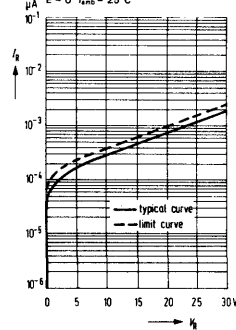
Directional characteristic $I_p = f(\varphi)$



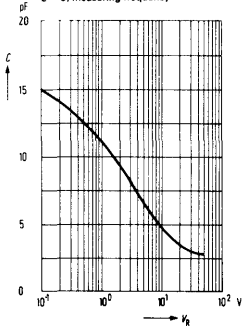
Power dissipation $P_{tot} = f(T_{amb})$



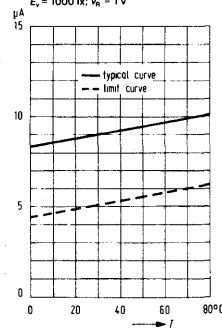
Dark current $I_d = f(V_k)$



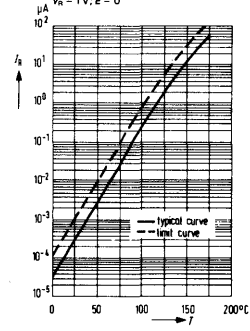
Junction capacitance $C = f(V_k)$



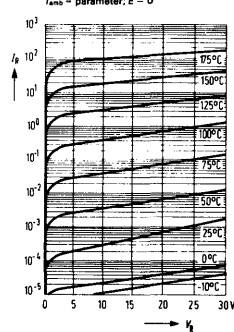
Photocurrent $I_p = f(T)$



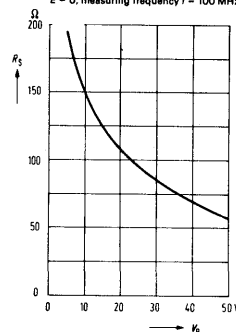
Dark current $I_d = f(T)$



Dark current $I_d = f(V_k)$

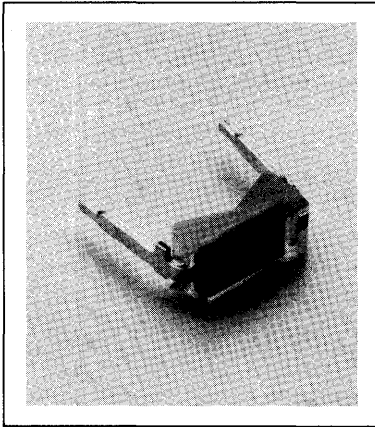


Series resistance $R_S = f(V_k)$

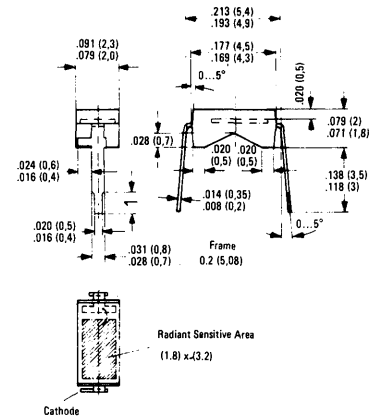


SIEMENS

BPX 90 PHOTODIODE



Package Dimensions in Inches (mm)



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

FEATURES

- Silicon Planar Photodiode
- Transparent Plastic Package
- 2/10" Lead Spacing
- High Sensitivity, 40 nA/lx

DESCRIPTION

The BPX 90 is a planar silicon photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs arranged in 5.08 mm (2/10") lead spacing. Due to its design the diode can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible. Arrays can be realized by multiple arrangements.

This versatile photodetector is suitable for diode as well as voltaic cell operation. The signal/noise ratio is particularly favorable, even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells.

Maximum Ratings

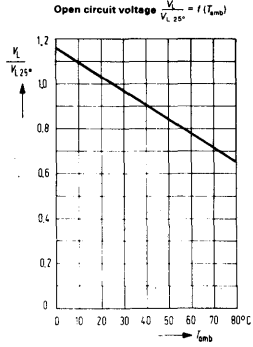
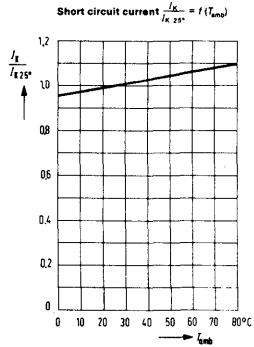
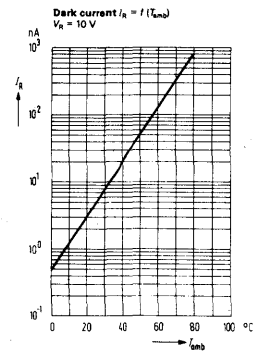
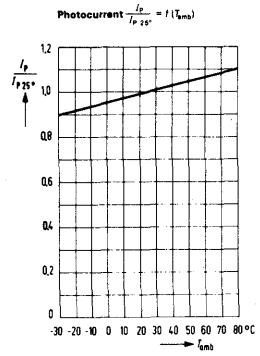
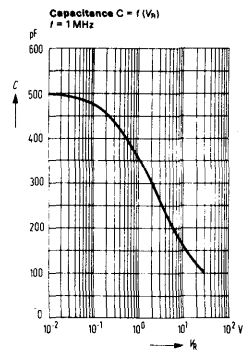
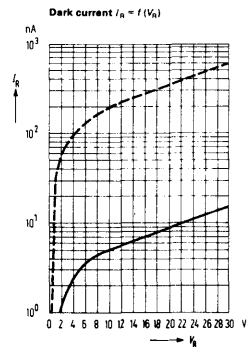
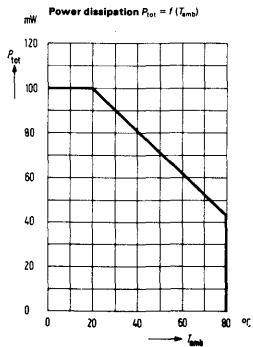
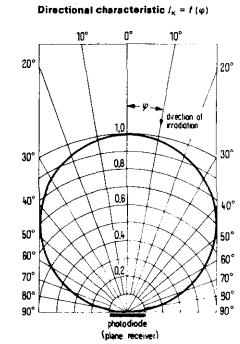
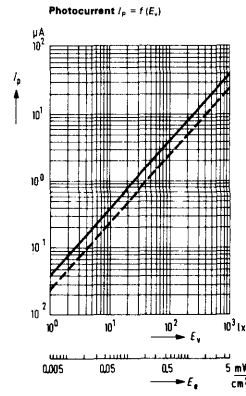
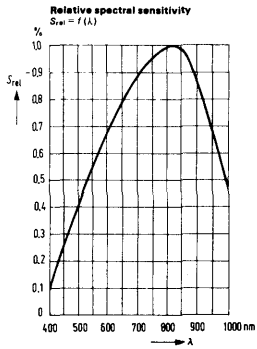
| | | | |
|---|------------|--------------|----|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature range | T_{stor} | - 40 to + 80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation | P_{tot} | 100 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|--------------------|-----------------------|---------------------|
| Spectral sensitivity ¹⁾ | S | 40 (≈ 25) | nA/lx |
| Wavelength of max. spectral sensitivity | $\lambda_{S\ max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.73 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.50 | A/W |
| Open circuit voltage ($E_v = 100$ lx) ¹⁾ | V_L | 360 (≈ 270) | mV |
| ($E_v = 1000$ lx) ¹⁾ | V_L | 460 | mV |
| Short circuit current ($E_v = 100$ lx) ¹⁾ | I_K | 4 (≈ 2.5) | μA |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | t_r ; t_f | 1.1 | μs |
| ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm) | t_r ; t_f | 0.8 | μs |
| Temperature coefficient for V_L | TC | -2.6 | mV/K |
| Temperature coefficient for I_K | TC | 0.2 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 500 | pF |
| ($V_R = 10$ V; $f = 1$ MHz; $E = 0$) | C_{10} | 170 | pF |
| Radiant sensitive area | A | 5.0 | mm ² |
| Dark current ($V_R = 10$ V; $E = 0$) | I_A | 5 (≤ 200) | nA |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten-filament lamp at a color temperature of 2856 K. (Standard light A in accordance with DIN 5033 and IEC pub. 306-1.)

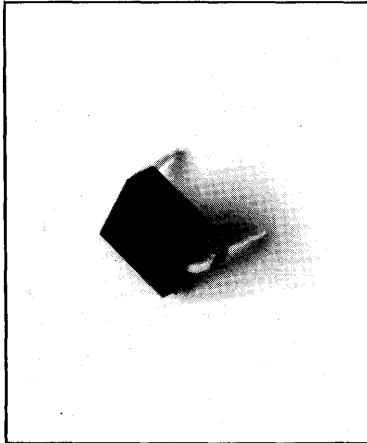
Specifications are subject to change without notice.



SIEMENS

BPX 91B

PHOTODIODE



Supersedes BPX 91

FEATURES

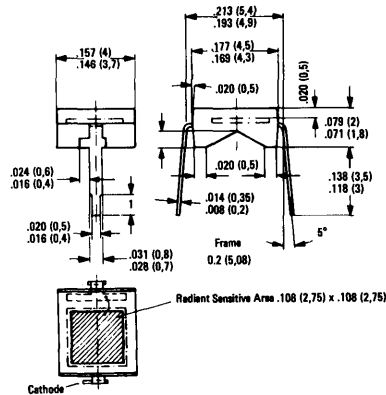
- Transparent Plastic Package
- 2/10" (5.08 mm) Lead Spacing
- High Blue Sensitivity,
400 nm = 30% Srel

DESCRIPTION

The BPX 91B is a planar silicon photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs arranged in 2/10" (5.08 mm) lead spacing. Due to its design, the diode can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible. Arrays can be realized by multiple arrangements. The increased blue sensitivity with short wavelength makes the BPX 91B particularly suitable for application with high blue light source.

This versatile photodetector is suitable for diode as well as voltaic cell operation. The signal/noise ratio is particularly favorable, even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells. The cathode is marked by a tab on the solder lead.

Package Dimensions in Inches (mm)



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | |
|---|---------------|
| Reverse Voltage (V_R) | 10 V |
| Operating and Storage Temperature Range (T_S) | -40 to +80 °C |
| Soldering Temperature in a 2 mm Distance from the Case Bottom (T_J), $t \leq 3$ s | 230 °C |
| Power Dissipation (P_{tot}), $T_{amb} = 25$ °C | 150 mW |

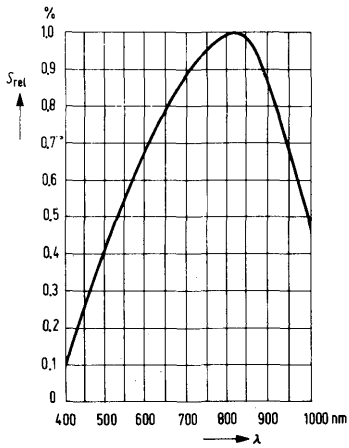
Characteristics ($T_{amb} = 25$ °C)

| | |
|--|--------------------------|
| Photo Spectral Sensitivity (S) | 50 (≥ 35) nA/lx |
| Wavelength of the Max. Sensitivity (λ_{Smax}) | 850 nm |
| Quantum Yield (η) | 0.73 Electrons/Photon |
| Spectral Sensitivity (S_λ), $\lambda = 850$ nm | 0.47 A/W |
| Open Circuit Voltage (V_J) | |
| $E_v = 100$ lx | 360 (≥ 270) mV |
| $E_v = 1000$ lx | 460 mV |
| Short Circuit Current (I_K) | |
| $E_v = 100$ lx | 5 (≥ 3.5) μ A |
| Rise and Fall Time of the Photo Current (t_r, t_f) | |
| $R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm | 2.5 μ s |
| $R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm | 1.0 μ s |
| Temperature Coefficient of (V_J), TC | -2.6 mV/K |
| Temperature Coefficient of (I_K), TC | 0.2 %/K |
| Capacitance | |
| $V_R = 0$ V; $f = 1$ MHz; $E = 0$ (C_0) | 750 pF |
| $V_R = 10$ V; $f = 1$ MHz; $E = 0$ (C_{10}) | 220 pF |
| Radiant Sensitive Area (A) | 7.6 mm ² |
| Dark Current (I_R) | |
| $V_R = 10$ V; $E = 0$ | 7 (≤ 300) nA |

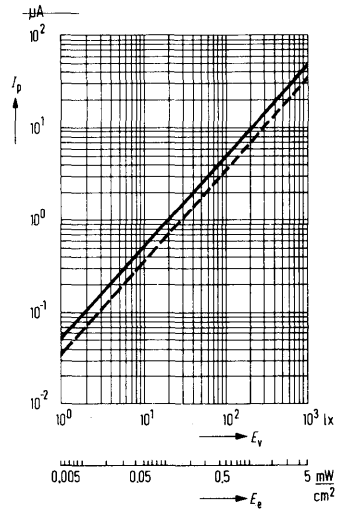
Specifications subject to change without notice.

RELATIVE SPECTRAL SENSITIVITY

$$S_{rel} = f(\lambda)$$

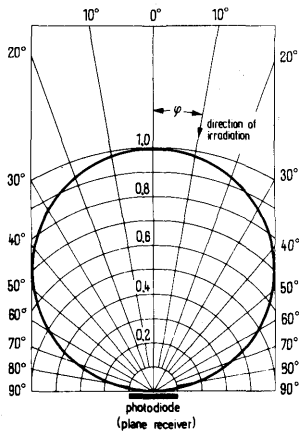


PHOTOCURRENT $I_p = f(E_v)$



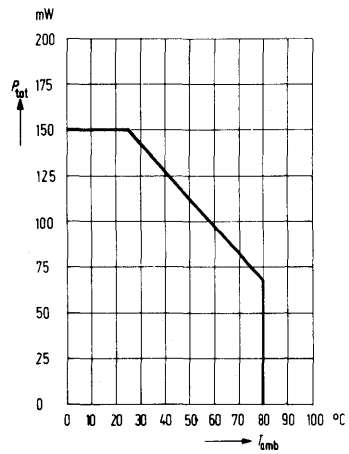
DIRECTIONAL CHARACTERISTIC

$$I_K = f(\varphi)$$



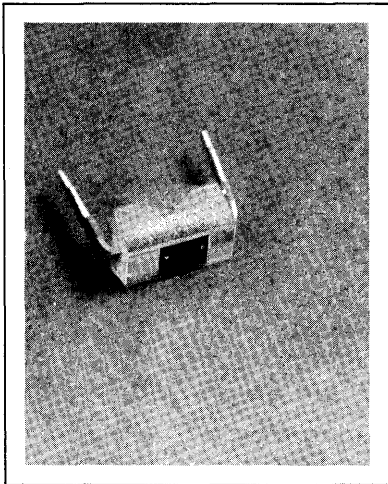
POWER DISSIPATION

$$P_{tot} = f(T_{amb})$$



SIEMENS

BPX 92 PHOTODIODE



FEATURES

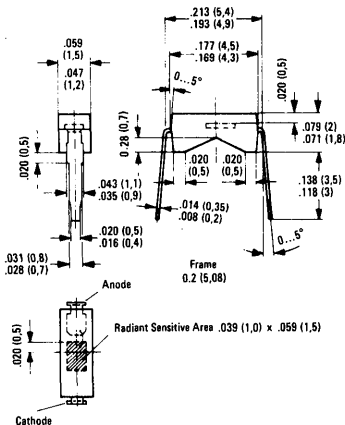
- Silicon Planar Photodiode
- Transparent Plastic Package
- 2/10" Lead Spacing
- Low Dark Current, 1 nA

DESCRIPTION

The BPX 92 is a planar silicon photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs arranged in 5.08 mm (2/10") lead spacing. Due to its design the diode can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible. Arrays can be realized by multiple arrangements.

This versatile photodetector is suitable for diode as well as voltaic cell operation. The signal/noise ratio is particularly favorable, even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions inside parenthesis are in inches

Maximum Ratings

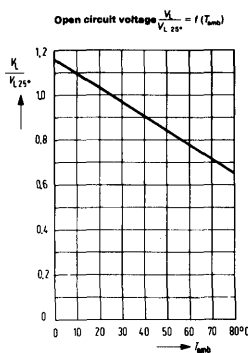
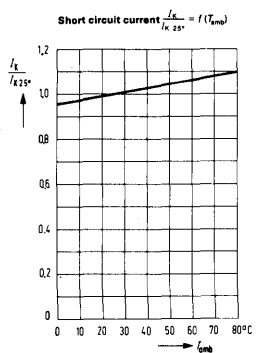
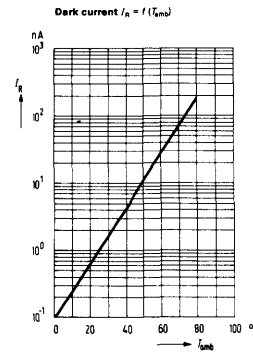
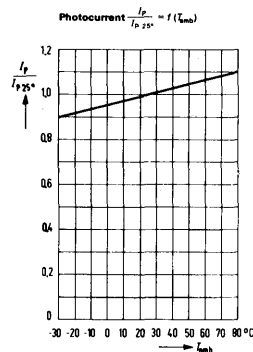
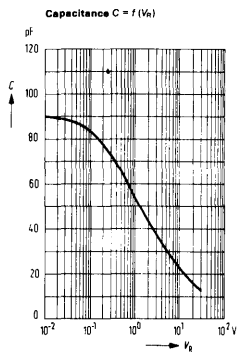
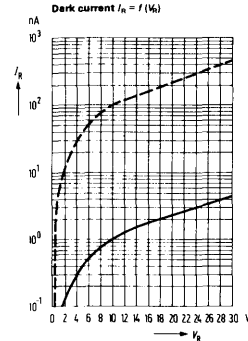
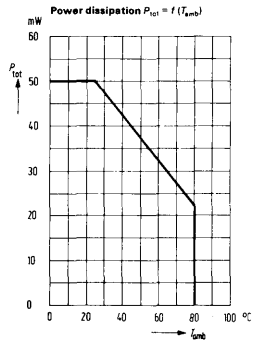
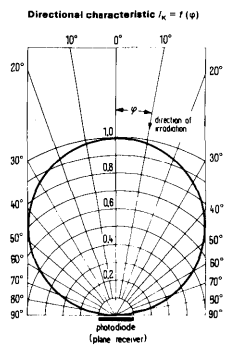
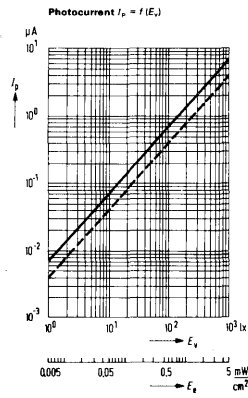
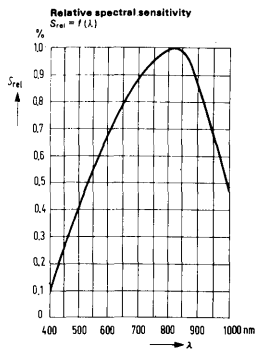
| | | | |
|---|------------|--------------|----|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature | T_{stor} | - 55 to + 80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_S | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 50 | mW |

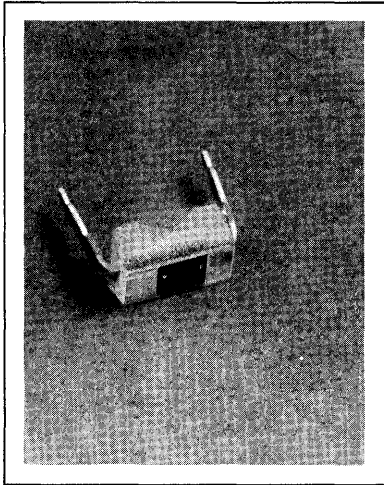
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|--------------------|--------------------|---------------------|
| Spectral sensitivity ¹⁾ | S | 7 (≥ 4) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{s, max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.73 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.50 | A/W |
| Short circuit current ($E_v = 100$ lx) ¹⁾ | I_L | 325 (≥ 240) | mV |
| ($E_v = 1000$ lx) ¹⁾ | I_L | 410 | mV |
| Open circuit voltage ($E_v = 100$ lx) ¹⁾ | I_K | 0.7 (≥ 0.4) | μA |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1\Omega$; $V_R = 0$ V; $\lambda = 950$ nm) | t_r ; t_f | 1.1 | μs |
| ($R_L = 1\Omega$; $V_R = 10$ V; $\lambda = 950$ nm) | t_r ; t_f | 0.8 | μs |
| Temperature coefficient of V_L | TC | - 2.6 | mV/K |
| Temperature coefficient of I_K | TC | 0.2 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 90 | pF |
| ($V_R = 10$ V; $f = 1$ MHz; $E = 0$) | C_0 | 23 | pF |
| Radiant sensitive area | A | 1.5 | mm ² |
| Dark current ($V_R = 10$ V; $E = 0$) | I_R | 1 (≤ 100) | nA |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC pub. 308-1).

Specifications are subject to change without notice.





FEATURES

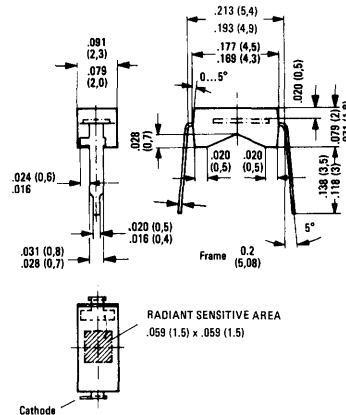
- Silicon Planar Photodiode
- Transparent Plastic Package
- 2/10" Lead Spacing
- Low Dark Current, 0.5 nA

DESCRIPTION

The BPX 93 is a planar silicon photodiode, which is incorporated in a transparent plastic package. Its terminals are soldering tabs arranged in 5.08 mm (2/10") lead spacing. Due to its design the diode can also very easily be assembled on PC boards. The flat back of the epoxy resin case makes rigid fixing of the component feasible. Arrays can be realized by multiple arrangements.

This versatile photodetector is suitable for diode as well as voltaic cell operation. The signal/noise ratio is particularly favorable, even at low illuminances. The open circuit voltage at low illuminances is higher than with comparable mesa photovoltaic cells. The cathode is marked by a white dot.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

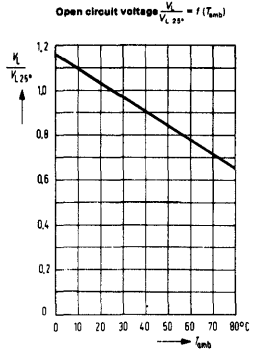
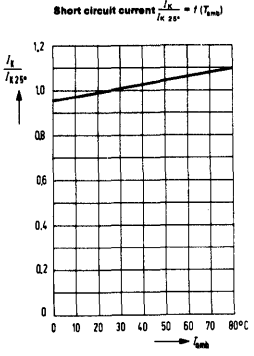
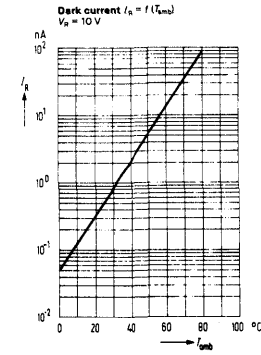
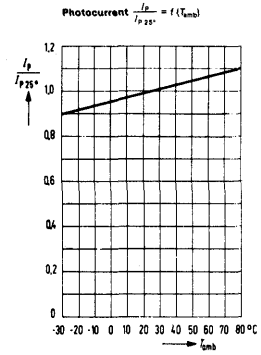
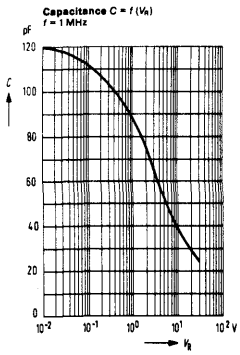
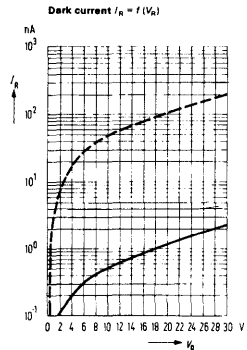
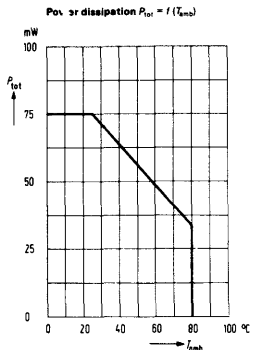
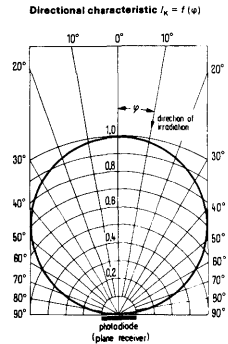
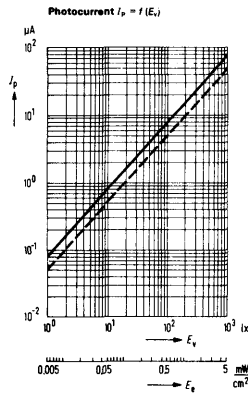
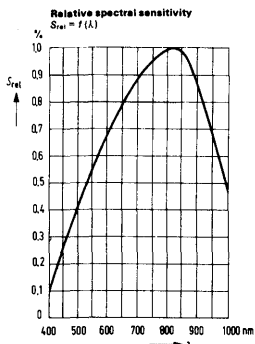
Maximum Ratings

| | | | |
|---|------------|------------|----|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature | T_{stor} | -55 to +80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_s | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 75 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

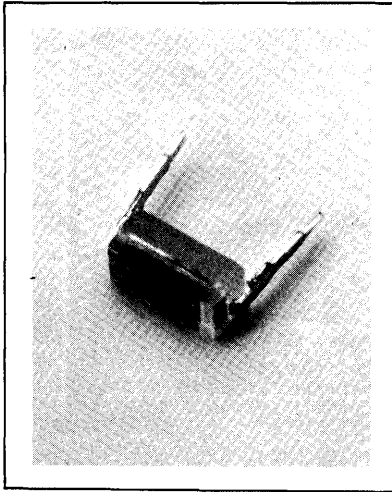
| | | | |
|---|-------------------|-------------|------------------|
| Spectral sensitivity ¹⁾ | S | 8 (± 5) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{c,max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.73 | Electrons/Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S | 0.50 | A/W |
| Open circuit voltage ($E_v = 100$ lx) ¹⁾ | V_L | 360 (± 270) | mV |
| ($E_v = 1000$ lx) ¹⁾ | V_L | 460 | mV |
| Short circuit current ($E_v = 100$ lx) ¹⁾ | I_K | 0.8 (± 0.5) | μA |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V) | $t_r; t_f$ | 1.1 | μs |
| ($R_L = 1$ k Ω ; $V_R = 10$ V) | $t_r; t_f$ | 0.8 | μs |
| Temperature coefficient of V_L | TC | - 2 | mV/K |
| Temperature coefficient of I_K | TC | 0.1 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 120 | pF |
| ($V_R = 10$ V; $f = 1$ MHz; $E = 0$) | C_{10} | 40 | pF |
| Radiant sensitive area | A | 1 | mm ² |
| Dark current ($V_R = 10$ V; $E = 0$) | I_R | 0.5 (± 50) | nA |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC pub. 306-1).



SIEMENS

SFH 100 PHOTODIODE



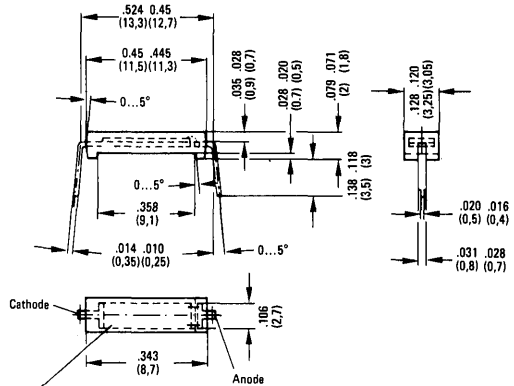
FEATURES

- Transparent Plastic Package
- 12.7 mm Lead Spacing
- Low Reverse Voltage, 0.1 V

DESCRIPTION

The SFH100 silicon planar photodiode is supplied for universal applications. It is especially suitable for operation with small reverse voltage (approx. 0.1V) for the detection of very limited illumination. The increased blue sensitivity of the diode lightens application with luminous source, which has a short wave emission spectrum. The component is built in a transparent plastic package and contains solder tab leads spaced at 12.7 mm.

Package Dimensions in Inches (mm)



Radiant Sensitive Area .343 (8,7) x .106 (2,7)

Maximum Ratings

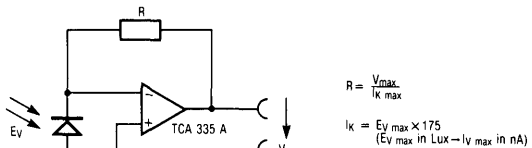
| | | | |
|--|-----------|-----------|----|
| Reverse voltage | V_R | 7 | V |
| Operating and storage temperature range | T_a | -40...+80 | °C |
| Soldering temperature in a 2mm distance from the case bottom ($t \leq 3$ s) | T_L | 230 | °C |
| Power dissipation | P_{tot} | 100 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|--------------------|--------------------|---------------------|
| Spectral sensitivity ¹ | S | 175 (≥ 150) | nA/lx |
| Wavelength of max. spectral sensitivity | $\lambda_{S \max}$ | 800 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.88 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850$ nm) | S_λ | 0.5 | A/W |
| Open circuit voltage ($E_g = 100$ lx) ¹ | V_L | 370 | mV |
| ($E_g = 1000$ lx) ¹ | V_L | 430 | mV |
| Short circuit current ($E_g = 100$ lx) ¹ | I_K | 175 | μA |
| Rise time ($V_R = 3\text{V}$, $R_L = 1\text{K}\Omega$) | t_r | 1.2 | μs |
| Temperature coefficient for V_L | TC | -0.6 | %/K |
| Temperature coefficient for I_K | TC | 0.2 | %/K |
| Capacitance ($V_R = 0$ V; $E = 0$) | C_D | 1000 | pF |
| Radiant sensitive area | A | 23.5 | mm ² |
| Dark current ($V_R = 10$ V; $E = 0$) | I_R | 0.4 (≤ 10) | nA |

¹The illuminance indicated refers to unfiltered radiation of a tungsten-filament lamp at a color temperature of 2856K. (Standard light A in accordance with DIN 5033 and IEC publ. 306-1.)

Switching Applications

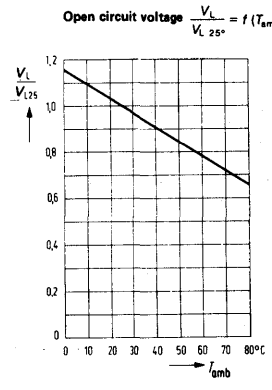
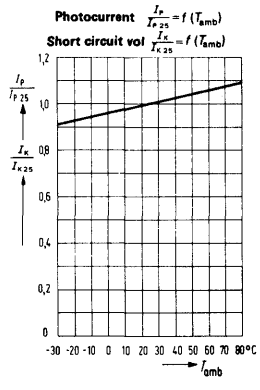
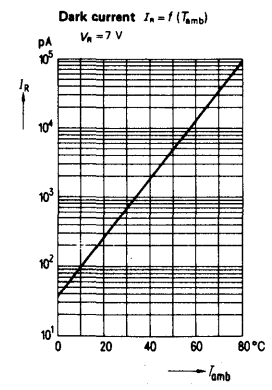
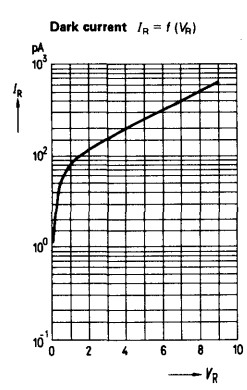
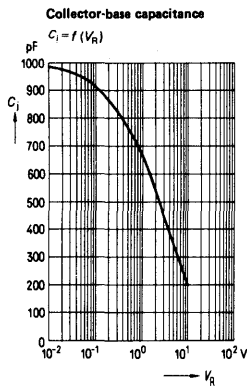
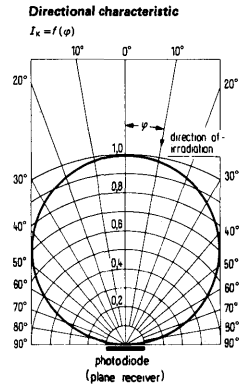
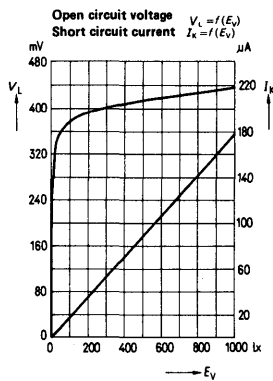
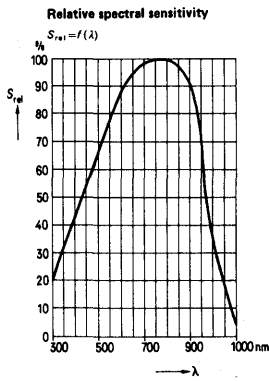


$$R = \frac{V_{\max}}{I_K \max}$$

$$I_K \max = \frac{E_y \max \times 175}{(E_y \max \text{ in Lux} - I_v \max \text{ in nA})}$$

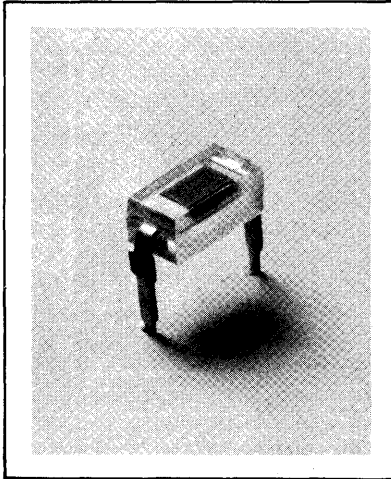
A type with small input current should be used as operational amplifier.

Specifications subject to change without notice.



SIEMENS

SFH 200 PHOTODIODE



FEATURES

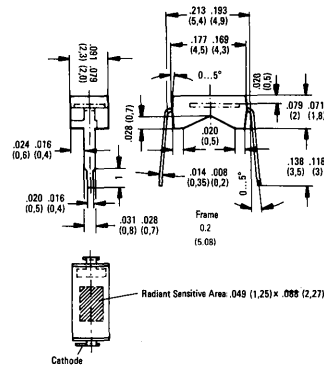
- **Transparent Plastic Case**
- **5.08 mm (2/10") Lead Spacing**
- **Very Large Zero Crossover, 1 mV/pA**

DESCRIPTION

SFH 200 is a planar silicon photodiode incorporated in a transparent plastic package. Its terminals are solder tabs arranged in 5.08 mm (2/10 inch) lead spacing. The diode can also very easily be mounted on PC boards. The SFH 200 is developed for low luminescence as receiver for such applications as exposure meters. The photo component distinguishes itself by large zero point divisions and by high open circuit voltage with low luminescence.

Type Characterization: notch with blue point. The cathode is marked by a tab on solder lead

Package Dimensions in Inches (mm)



Temperature

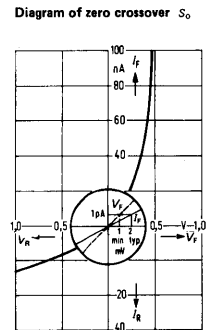
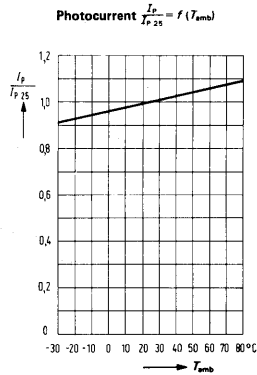
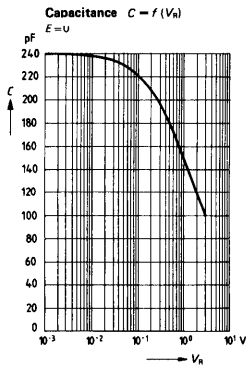
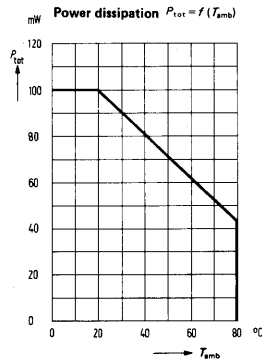
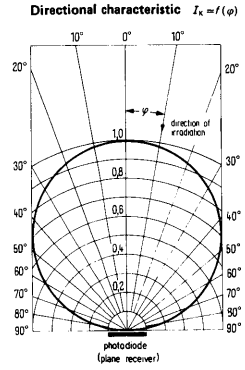
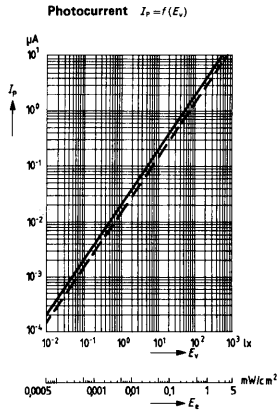
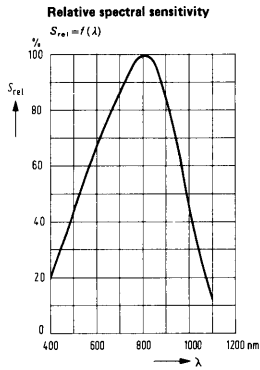
| | | | |
|---|------------|-----------|----|
| Operating and storage temp. range | T_{stor} | -55...+80 | °C |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ sec) | | 230 | °C |

Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| | | | |
|---|--------------------|------------------|---------------------|
| Spectral sensitivity ¹ | S | 20 (≥ 14) | nA/lx |
| Zero cross over | S_0 | ≥ 1 | mV/pA |
| Forward Current | | | |
| ($I_{ca} = 0$ lx; $T_{amb} = 25^{\circ}\text{C}$; $V_F = 50$ mV) | I_F | 20 | pA |
| Radiant sensitive area | A | 2.8 | mm ² |
| Wavelength of max. spectral sensitivity | $\lambda_{S\ max}$ | 800 | nm |
| Quantum yield | η | 0.73 | Electrons Photon |
| Spectral sensitivity ($\lambda = 800$ nm) | S_{λ} | 0.47 | A/W |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value | | | |
| ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | $t_r; t_f$ | 1.3 | μs |
| ($R_L = 1$ k Ω ; $V_R = 5$ V; $\lambda = 950$ nm) | $t_r; t_f$ | 1.0 | μs |
| Capacitance | | | |
| ($V_R = 0$ V; $E = 0$) | C_0 | 240 | pF |
| ($V_R = 3$ V; $E = 0$) | C_3 | 100 | pF |
| Temperature coefficient for I_{lc} | T_K | 0.2 | %/K |
| Dark current ($V_R = 3$ V; $E = 0$) | I_R | 20 | pA |

¹The Illuminance Indicated refers to unfiltered radiation of a tungsten-filament lamp at a color temperature of 2856 K. (Standard Light A in accordance with DIN 5033 and IEC publ. 306-1.)

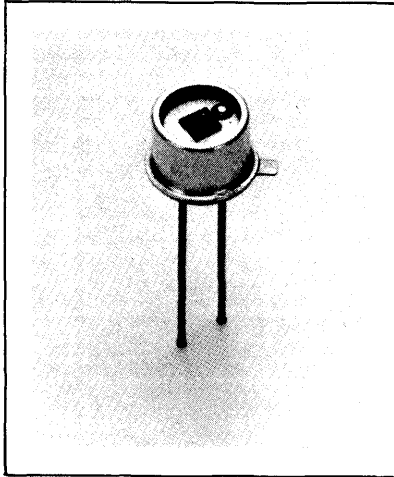
Specifications are subject to change without notice.



SIEMENS

SFH 202

PIN PHOTO DIODE



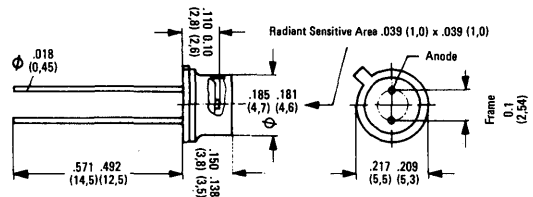
FEATURES

- TO-18 Hermetic Package
- Flat Glass Lens
- For Fiber Optic Communications
fg = 500 MHz, tr = 0.5 ns

DESCRIPTION

SFH 202 is a planar silicon PIN-photo diode in case 18A2 DIN 41876 (similar to TO18) with flat glass lens. The cathode is electrically connected with the case. The PIN diode is a receiver with high limiting frequency that distinguishes itself through limited reverse current capacity and short switching time. Through the flat lens the diode is especially suitable for use with fiber optic cables, up to 560 Mbits/s.

Package Dimensions in Inches (mm)



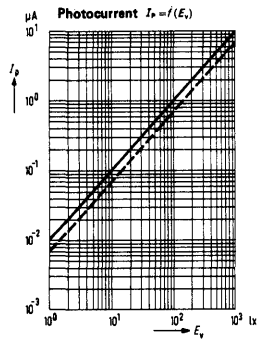
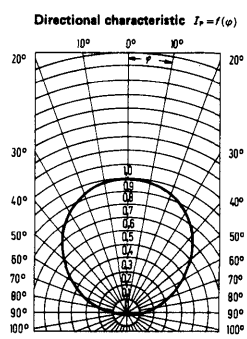
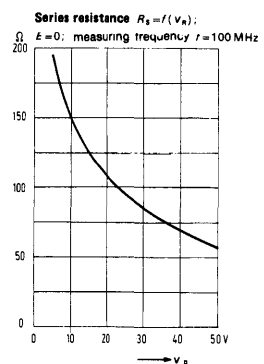
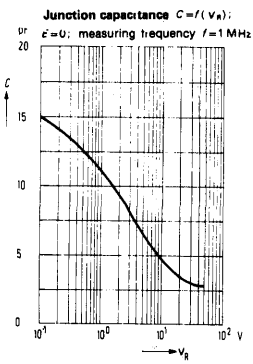
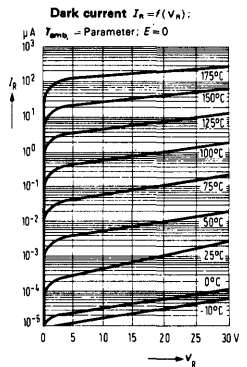
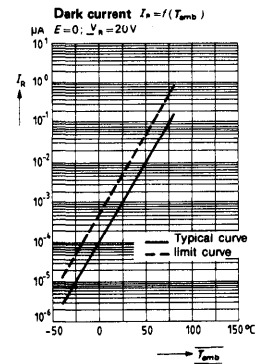
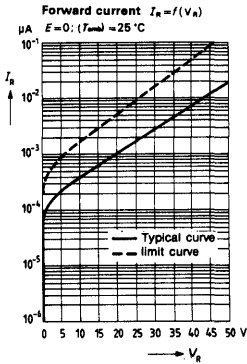
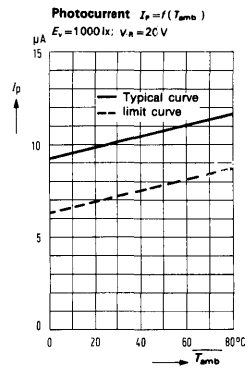
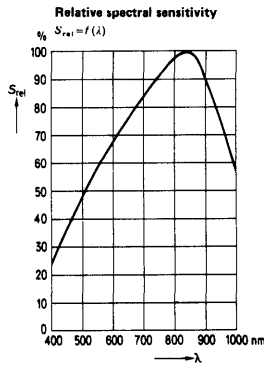
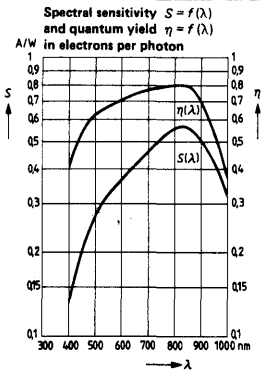
Maximum Ratings

| | | | |
|---------------------------|-------|-----------|----|
| Reverse voltage | V_R | 50 | V |
| Junction temperature | T_J | 80 | °C |
| Storage temperature range | T_s | -40...+80 | °C |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

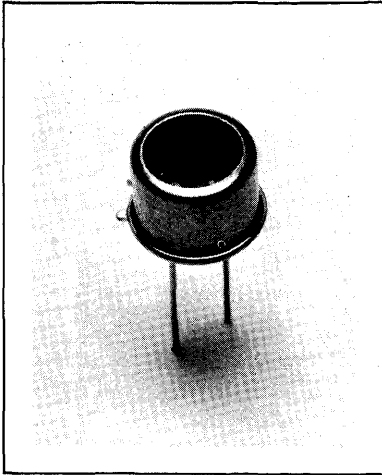
| | | | |
|---|-------------------|-----------------------|--|
| Radiant sensitive area | A | 1 | mm ² |
| Wavelength of the max. sensitivity | $\lambda_{S\max}$ | 850 | nm |
| Quantum yield (Electrons per photon)($\lambda = 850$ nm) | η | 0,60 | $\frac{\text{Electrons}}{\text{Photon}}$ |
| Spectral sensitivity ($\lambda = 850$ nm) | S_λ | 0,55 | $\frac{\text{A/W}}$ |
| Rise time of the photocurrent ($R_L = 50\Omega$; $V_R = 20$ V; $\lambda = 900$ nm) | t_r | 0,5 (≤ 1) | ns |
| Capacitance ($V_R = 0$ V) | C_0 | 15 | pF |
| ($V_R = 1$ V) | C_1 | 12 | pF |
| ($V_R = 20$ V) | C_{20} | 3,5 | pF |
| Cut-off frequency ($R_L = 50\Omega$; $V_R = 20$ V; $\lambda = 900$ nm) | f_c | 500 | MHz |
| Dark current ($V_R = 20$ V; $E = 0$) | I_R | 1 (≤ 5) | nA |
| Spectral sensitivity ($V_R = 20$ V) | S | 10 (≥ 7) | nA/lx |
| Noise equivalent power ($V_R = 20$ V) | NEP | $3,3 \times 10^{-14}$ | $\frac{W}{\sqrt{\text{Hz}}}$ |
| Detection limit ($V_R = 20$ V) | D^* | $3,1 \times 10^{12}$ | $\frac{\text{cm}\sqrt{\text{Hz}}}{W}$ |
| Temperature coefficient for I_p | TK | 0,2 | %/K |

Specifications are subject to change without notice.



SIEMENS

SFH 203 SILICON PHOTODIODE



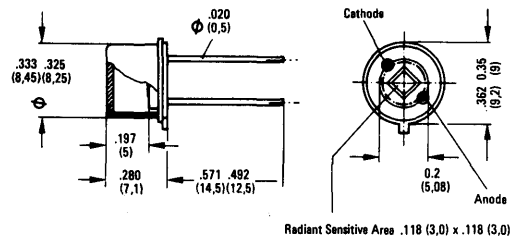
FEATURES

- TO-5 Hermetic Package
- Flat Glass Lens
- BG 38 Filter for Adaptable Sensitivity

DESCRIPTION

SFH 203 is a silicon planar photodiode. The large area photo sensitive system is suitable for cell as well as diode operation at very slow reverse voltage level. The hermetic modified TO-5 package is supplied with a flat glass lens that allows operation under extreme conditions. The filtered glass window (Schott & Gen) adapts the system to a sensitive aperture. The SFH 203 is therefore, especially applicable for daylight as well as being suitable for artificial lighting of high color temperature for photography and color analysis.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | | | |
|---|------------------------|------------|--------------------|
| Reverse voltage | V_R | 32 | V |
| Operating and storage temperature range | T_a | -40...+100 | $^{\circ}\text{C}$ |
| Junction temperature | T_j | 100 | $^{\circ}\text{C}$ |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | T_L | 230 | $^{\circ}\text{C}$ |
| Power dissipation | P_{tot} | 325 | mW |
| Thermal resistance | $R_{th \text{ Jamb}}$ | 300 | K/W |
| | $R_{th \text{ Jcase}}$ | 80 | K/W |

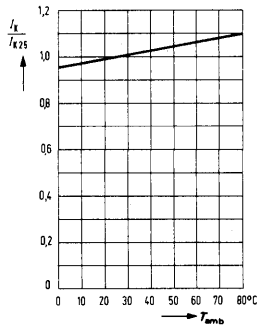
Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| | | | |
|---|---------------------------|------------------|-----------------|
| Spectral sensitivity ¹ | S | 7.5 (≥ 5) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{S \text{ max}}$ | 555 | nm |
| Spectral sensitivity ($\lambda = 555$ nm) | S_{λ} | 0.21 | A/W |
| Open circuit voltage | V_L | 244 | mV |
| ($E_v = 100$ lx) ¹ | V_L | 380 | mV |
| ($E_v = 1000$ lx) ¹ | I_K | 0.70 | μA |
| Short circuit current ($E_v = 100$ lx) ¹ | | | |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value | $t_r; t_f$ | 2.5 | μs |
| ($R_L = 1$ k Ω ; $V_R = 0$ V) | $t_r; t_f$ | 1.0 | μs |
| ($R_L = 1$ k Ω ; $V_R = 10$ V) | TK | -0.6 | %/K |
| Temperature coefficient of V_L | TK | 0.2 | %/K |
| Temperature coefficient of I_K | | | |
| Capacitance | C_0 | 900 | pF |
| ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 770 | pF |
| ($V_R = 3$ V; $f = 1$ MHz; $E = 0$) | A | 7.6 | mm ² |
| Radiant sensitive area | I_R | 7 (≤ 50) | nA |
| Dark current ($V_R = 10$ V; $E = 0$) | | | |

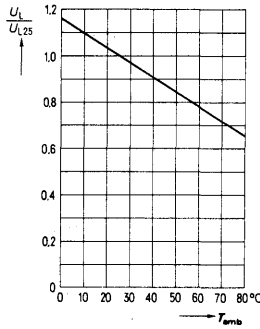
¹The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

Specifications are subject to change without notice.

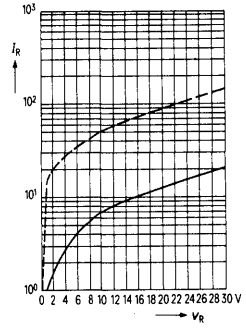
Short circuit current $I_{k25} = f(V_k)$



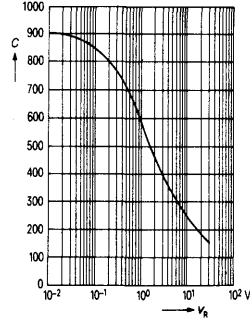
Open circuit voltage $\frac{U_L}{U_{L25}} = f(T_{amb})$



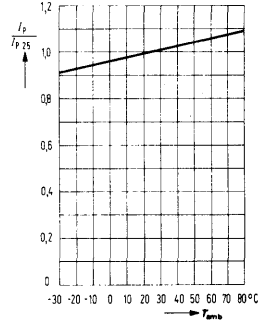
Dark current $I_n = f(V_k)$



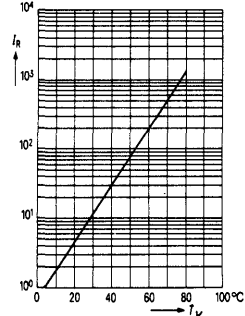
Capacitance $C = f(V_k)$
 $f = 1 \text{ MHz}$



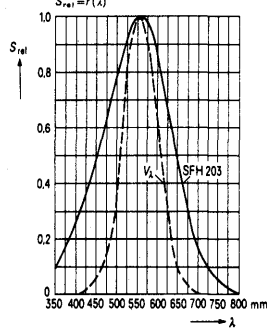
Photocurrent $\frac{I_p}{I_{p25}} = f(T_{amb})$



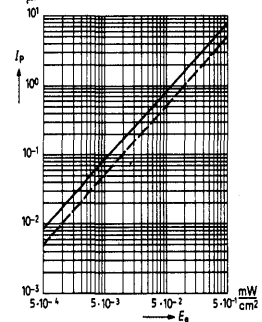
Dark current $I_n = f(T_{amb})$
 $V_k = 10 \text{ V}$



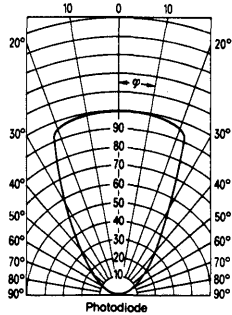
Relative spectral sensitivity $S_{rel} = f(\lambda)$



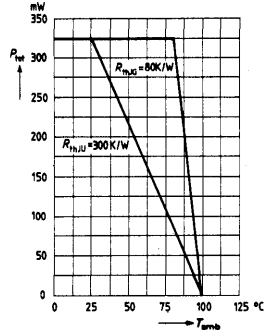
Photocurrent $I_p = f(E_e)$
 $\mu\text{A } \lambda = 555 \text{ nm}$



Directional characteristic $I_k = f(\varphi)$



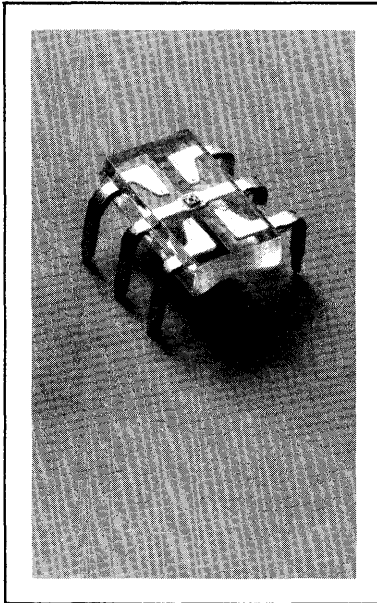
Power dissipation $P_{tot} = f(T_{amb})$



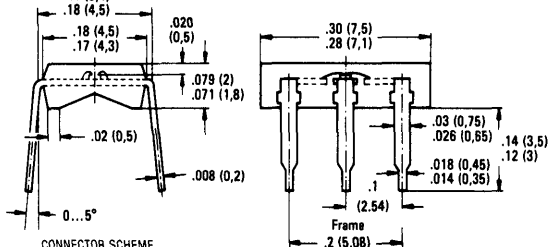
SIEMENS

SFH 204

SILICON FOUR QUADRANT PHOTODIODE



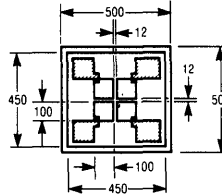
Package Dimensions in Inches (mm)



CONNECTOR SCHEME



DIODE SYSTEM WITH LIGHT SENSITIVE SURFACE



MEASUREMENT IN μm

FEATURES

- Miniature size
- Four quadrant active sections
- Close spacing of contacts, 12 μm
- Can determine if and by how much a light source has deviated

DESCRIPTION

The SFH 204 silicon planar miniature four quadrant photodiode has application in edge drive, positioning, and path and corner scanning control devices. The active units are spaced at only 12 μm apart from individual contacts. It is therefore possible to get exact positioning with high definition.

Maximum Ratings

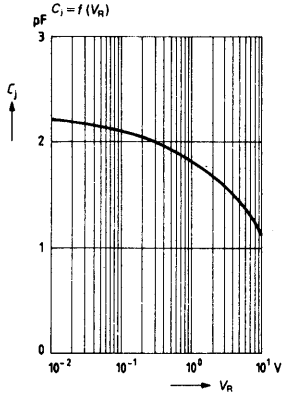
| | | | |
|--|------------------|-------------|--------------------|
| Reverse voltage | V_R | 12 | V |
| Junction temperature | T_j | 80 | $^{\circ}\text{C}$ |
| Soldering temperature in a 2mm distance from the case bottom ($t \leq 3$ s) | T_s | -20 ... +80 | $^{\circ}\text{C}$ |
| Power dissipation | P_{tot} | 40 | mW |

Characteristics ($T_{\text{amb}} = 25^{\circ}\text{C}$)

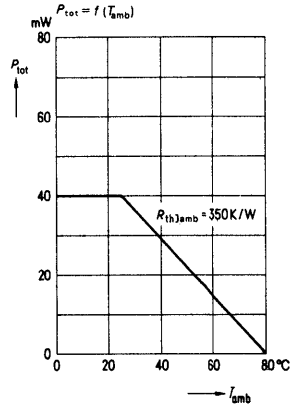
| | | | |
|---|-------------------------|----------------------|---------------|
| Wavelength of the max. sensitivity | $\lambda_s \text{ max}$ | 850 | nm |
| Spectral sensitivity | S | 0.11 (≥ 0.08) | nA/lx |
| Spectral sensitivity ($\lambda = 850$ nm) | S_λ | > 0.35 | A/W |
| Dark current ($V_R = 10$ V; $T_{\text{amb}} = 25^{\circ}\text{C}$; $E = 0$) | I_R | 0.01 (≤ 2) | nA |
| Junction capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 2.5 | pF |
| ($V_R = 10$ V; $f = 1$ MHz; $E = 0$) | C_{10} | 1.5 | pF |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 50\Omega$; $V_R = 0$ V; $\lambda = 950$ nm) | t_r ; t_f | 2 | μs |
| ($R_L = 10\text{k}\Omega$; $V_R = 10$ V; $\lambda = 950$ nm) | t_r ; t_f | 4 | μs |
| Radiant sensitive area | A | 4×0.01 | mm^2 |
| Distance between radiant sensitive areas, breadth of the cross-shaped geometry | | 12 (≥ 10) | μm |
| Maximum deviation of the spectral sensitivity of the four systems from the mean | ΔS | < 20 | % |

Specifications subject to change without notice.

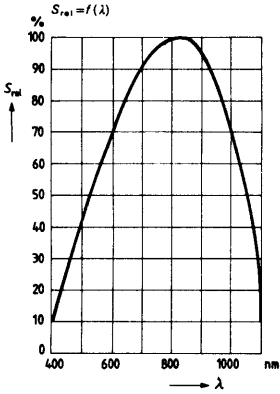
Capacitance



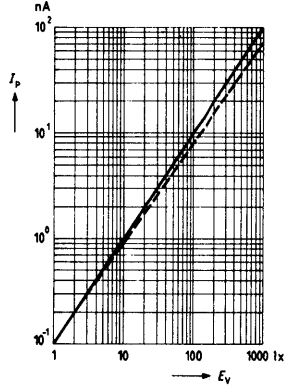
Power Dissipation



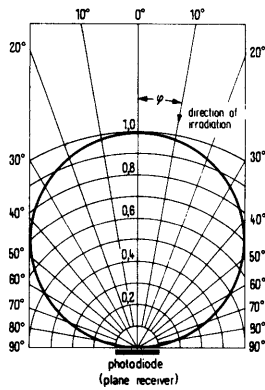
Relative spectral sensitivity



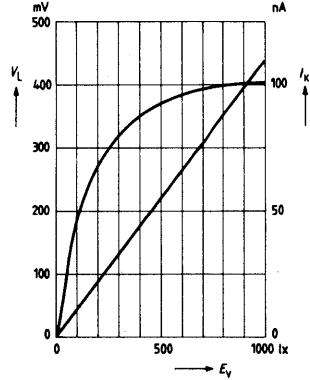
Photocurrent $I_p = f(E_v)$



Directional characteristic $I_k = f(\varphi)$



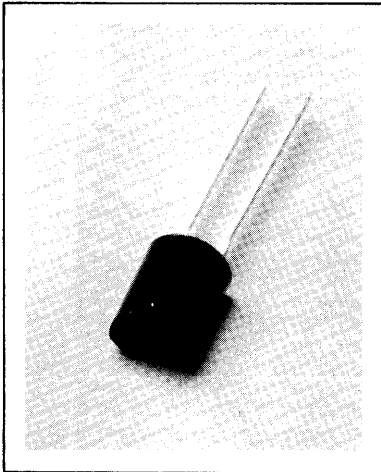
**Open circuit voltage $V_k = f(E_v)$
Short circuit current $I_k = f(E_v)$**



SIEMENS

SFH 205

PIN PHOTODIODE



FEATURES

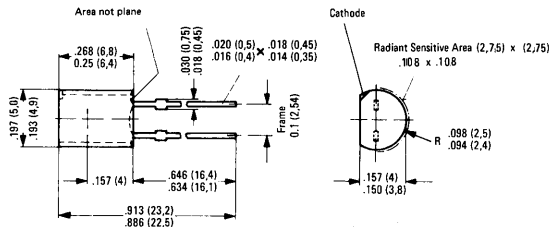
- Black Plastic Encapsulated Package
- 2.54 mm (1/10") Lead Spacing
- Built in Day Light Filter
- Suitable for IR Sound Transmission

DESCRIPTION

The SFH 205 is a silicon planar PIN photodiode, which is incorporated in a plastic package which simultaneously serves as filter and is also transparent for infrared emission. Its terminals are soldering tabs arranged in 2.54 mm (1/10") lead spacing. Due to its design, the diode can vertically be assembled on PC boards. Arrays can be realized by multiple arrangements. This versatile photodetector can be used as a diode as well as a voltaic cell. The signal/noise ratio is particularly favorable, even at low illuminances.

The PIN photodiode is outstanding for low junction capacitance, high cut-off frequency and short switching times. The photodiode is particularly suitable for IR sound transmission and remote control. The cathode is marked by stamping at the case edge.

Package Dimensions in Inches (mm)



Maximum Ratings

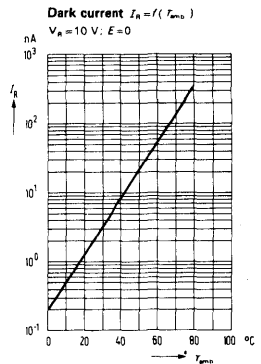
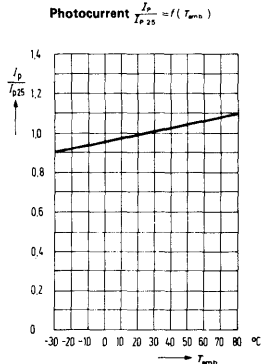
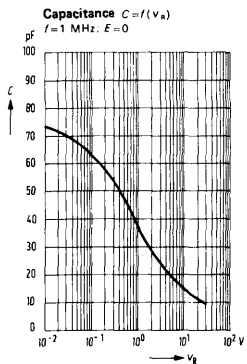
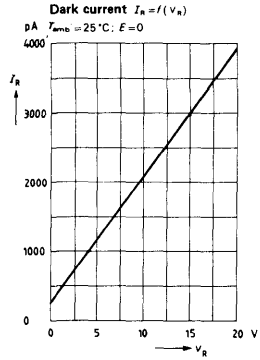
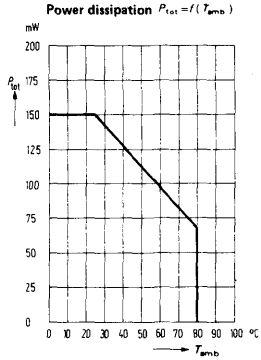
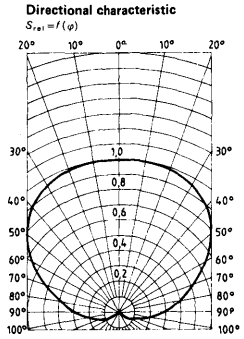
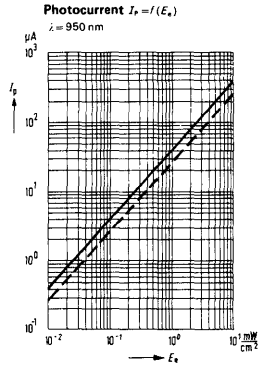
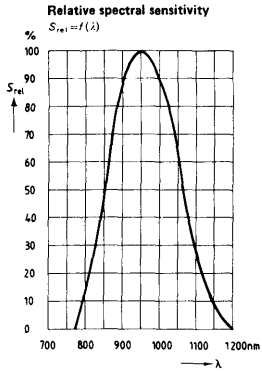
| | | | |
|---|-----------|-----------|----|
| Reverse voltage | V_R | 20 | V |
| Operating and storage temperature range | T_a | -40...+80 | °C |
| Soldering temperature in a 1 mm distance from the case bottom ($t \leq 3$ s) | T_L | 230 | °C |
| Power dissipation ($T_{amb} = 25$ °C) | P_{tot} | 150 | mW |

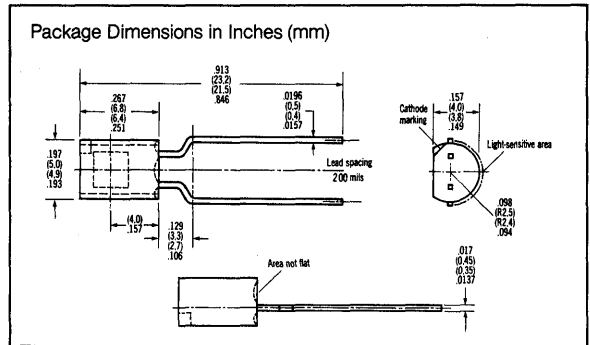
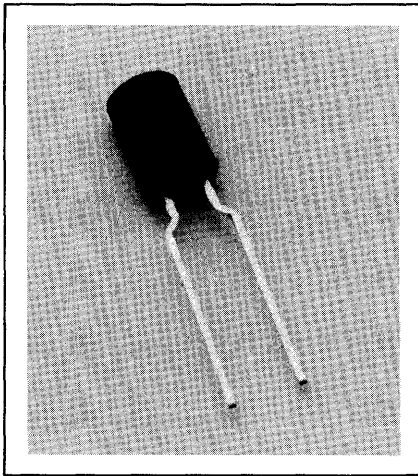
Characteristics ($T_{amb} = 25$ °C)

| | | | |
|---|-------------------|-----------------------|-------------------------------|
| Spectral sensitivity ¹ ($V_R = 5$ V) | S | 50 (≥ 30) | $\frac{\mu A \cdot cm^2}{mW}$ |
| Wavelength of the max. sensitivity | $\lambda_{S,max}$ | 950 | nm |
| Quantum yield (Electrons per Photon) ($\lambda = 950$ nm) | η | 0.74 | $\frac{Electrons}{Photon}$ |
| Spectral sensitivity ($\lambda = 950$ nm) | S_λ | 0.57 | A/W |
| Open circuit voltage ($E_a = 0.5$ mW/cm ² , $\lambda = 950$ nm) | V_L | 327 | mV |
| ($E_a = 0.05$ mW/cm ² , $\lambda = 950$ nm) | V'_L | 243 | mV |
| Short circuit current ($E_a = 0.05$ mW/cm ² , $\lambda = 950$ nm) | I_K | 2 | μA |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω , $V_R = 0$ V; $\lambda = 950$ nm) | t_r, t_f | 125 | ns |
| ($R_L = 1$ k Ω , $V_R = 10$ V; $\lambda = 950$ nm) | t_r', t_f' | 50 | ns |
| Temperature coefficient of V_L | TK | -2.6 | mV/K |
| Temperature coefficient of I_K or I_P | TK | 0.18 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 72 | pF |
| Radiant sensitive area | A | 7.6 | mm ² |
| Dark current ($V_R = 10$ V) | I_R | 2 (≤ 30) | nA |
| Noise equivalent power ($V_R = 10$ V) | NEP | 4.4×10^{-14} | $\frac{W}{\sqrt{Hz}}$ |
| Detection limit | D^* | 6.3×10^{12} | $\frac{cm \sqrt{Hz}}{W}$ |

¹The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5030 and IEC publ. 306-1).

Specifications are subject to change without notice.





FEATURES

- **Black Plastic Encapsulated Package**
- **5.08 mm (.20") Lead Spacing**
- **Built-in Daylight Filter**
- **Suitable for IR Sound Transmission**

DESCRIPTION

The SFH 205Q2 is a silicon planar PIN photodiode, which is incorporated in a plastic package which simultaneously serves as filter and is also transparent for infrared emission. Its terminals are soldering tabs arranged in 5.08 mm (.20") lead spacing. Due to its design, the diode can vertically and automatically be assembled on PC boards. Arrays can be realized by multiple arrangements. This versatile photodetector can be used as a diode as well as a voltaic cell. The signal/noise ratio is particularly favorable, even at low illuminances.

The PIN photodiode is outstanding for low junction capacitance, high cut-off frequency and short switching times. The photodiode is particularly suitable for IR sound transmission and remote control. The cathode is marked by stamping at the case edge.

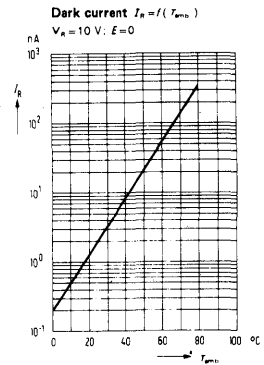
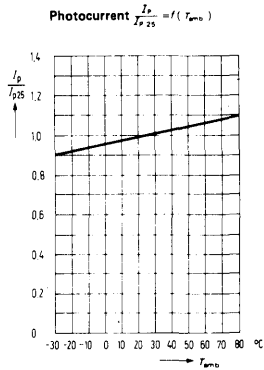
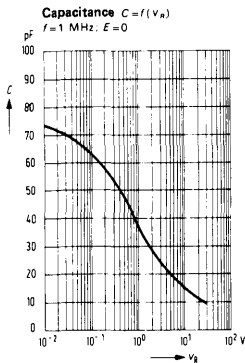
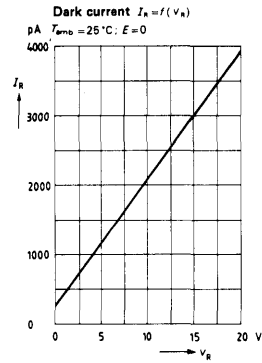
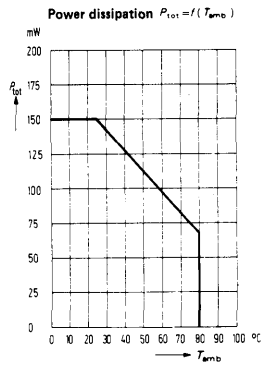
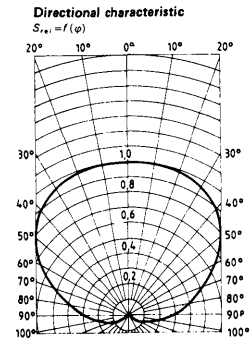
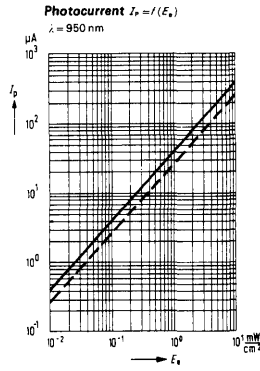
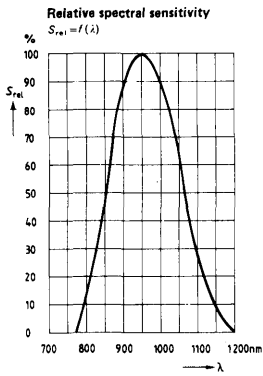
Maximum Ratings

| | | | |
|---|-----------|------------|----|
| Reverse voltage | V_R | 20 | V |
| Operating and storage temperature range | T_S | -40... +80 | °C |
| Soldering temperature in a 1 mm distance from the case bottom ($t \leq 3$ s) | T_L | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 150 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

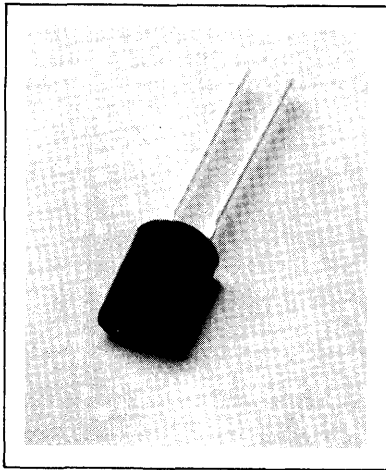
| | | | |
|--|-------------------|-----------------------|---|
| Spectral sensitivity ¹⁾ ($V_R = 5$ V) | S | 50 (≥ 30) | $\frac{\mu\text{A} \cdot \text{cm}^2}{\text{mW}}$ |
| Wavelength of the max. sensitivity | $\lambda_{S\max}$ | 950 | nm |
| Quantum yield (Electrons per Photon) ($\lambda = 950$ nm) | η | 0.74 | <u>Electrons</u> Photon |
| Spectral sensitivity ($\lambda = 950$ nm) | S_λ | 0.57 | A/W |
| Open circuit voltage ($E_o = 0.5$ mW/cm ² ; $\lambda = 950$ nm) | V_L | 327 | mV |
| ($E_o = 0.05$ mW/cm ² ; $\lambda = 950$ nm) | V_L | 248 | mV |
| Short circuit current ($E_o = 0.05$ mW/cm ² ; $\lambda = 950$ nm) | I_K | 2 | μA |
| Rise and fall time of the photo current from 10% to 90% and from 90% to 10%, of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | t_r, t_f | 125 | ns |
| ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm) | t_r, t_f | 50 | ns |
| Temperature coefficient of V_L | TK | -2.6 | mV/K |
| Temperature coefficient of I_K or I_p | TK | 0.18 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_o | 72 | pF |
| Radiant sensitive area | A | 7.6 | mm ² |
| Dark current ($V_R = 10$ V) | I_R | 2 (≤ 30) | nA |
| Noise equivalent power ($V_R = 10$ V) | NEP | 4.4×10^{-14} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| Detection limit | D^* | 6.3×10^{12} | $\frac{\text{cm} \sqrt{\text{Hz}}}{\text{W}}$ |

1) The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5030 and IEC publ. 306-1).



SIEMENS

SFH 206 PIN PHOTODIODE



FEATURES

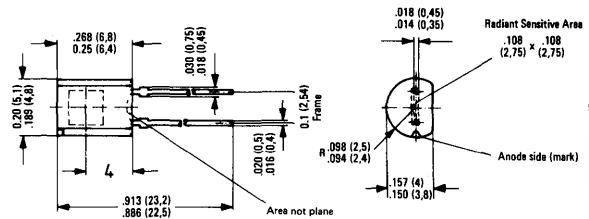
- Black Plastic Package
- 2.54 mm (1/10") Lead Spacing
- Built in Daylight Filter

DESCRIPTION

The SFH 206 is a silicon planar PIN photodiode which is incorporated in a black plastic package that serves as a filter for infrared radiation. Its terminals are solder tabs arranged in 2.54 mm (1/10") spacing. Due to its design the diode can vertically be assembled on PC boards. Arrays can be realized by multiple arrangements. This versatile photodetector can be used as a diode as well as a voltaic cell. The signal/noise ratio is particularly favorable, even at low illuminances.

The PIN photodiode is outstanding for low junction capacitance, high cut off frequency and short switching times. It is particularly suitable for IR sound transmission and remote control. The anode is marked by stamping at the case edge.

Package Dimensions in Inches (mm)



Maximum Ratings

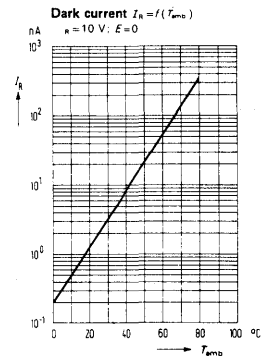
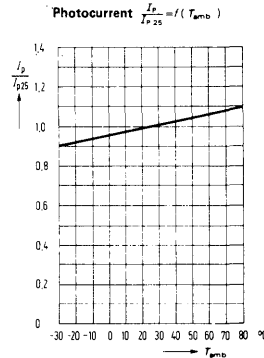
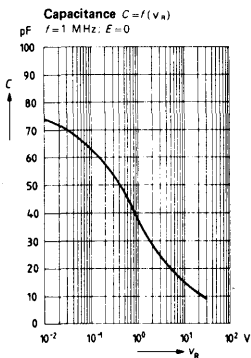
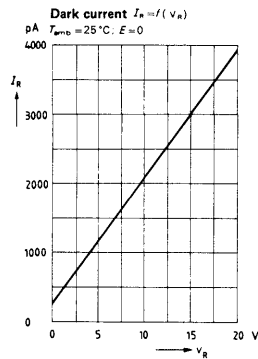
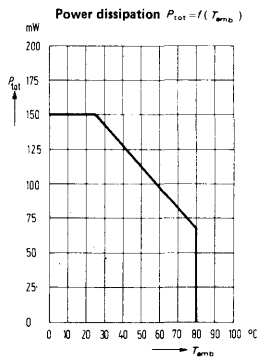
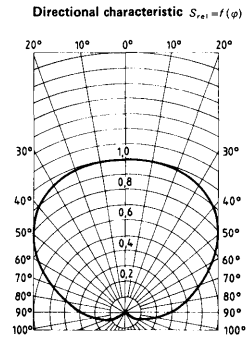
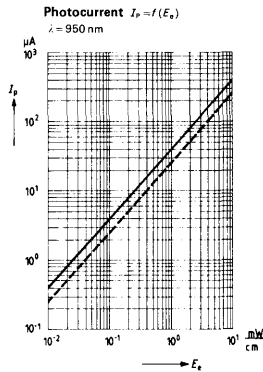
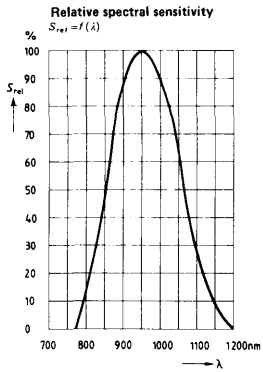
| | | | |
|---|-----------|-----------|----|
| Reverse voltage | V_R | 20 | V |
| Operating and storage temperature range | T_s | -40...+80 | °C |
| Soldering temperature in a 1 mm distance from the case bottom ($t \leq 3$ s) | T_L | 230 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 150 | mW |

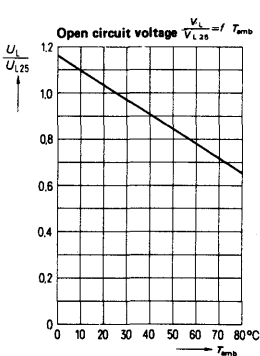
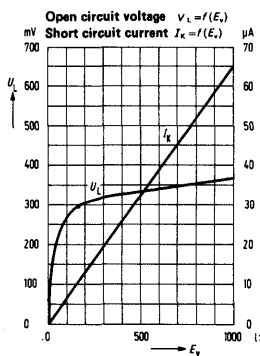
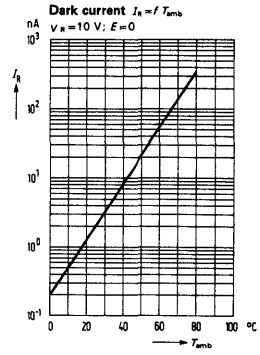
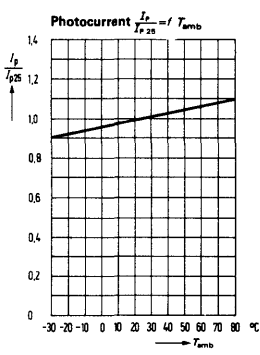
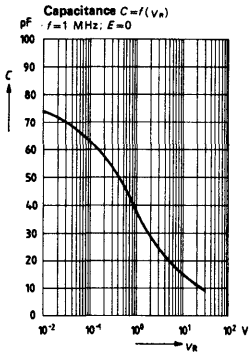
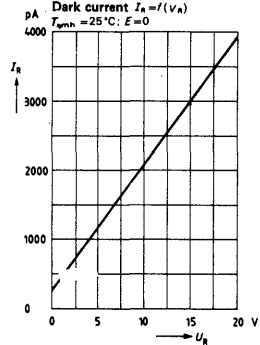
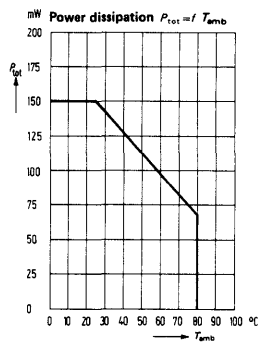
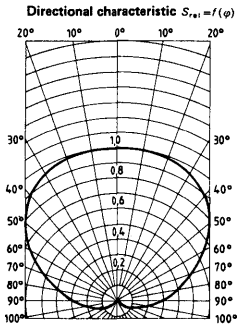
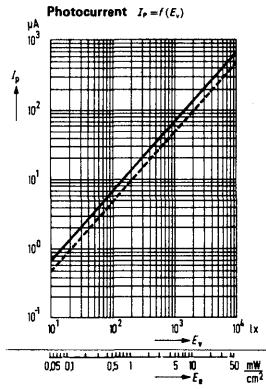
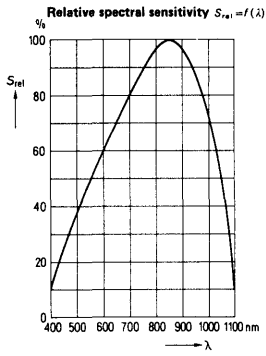
Characteristics

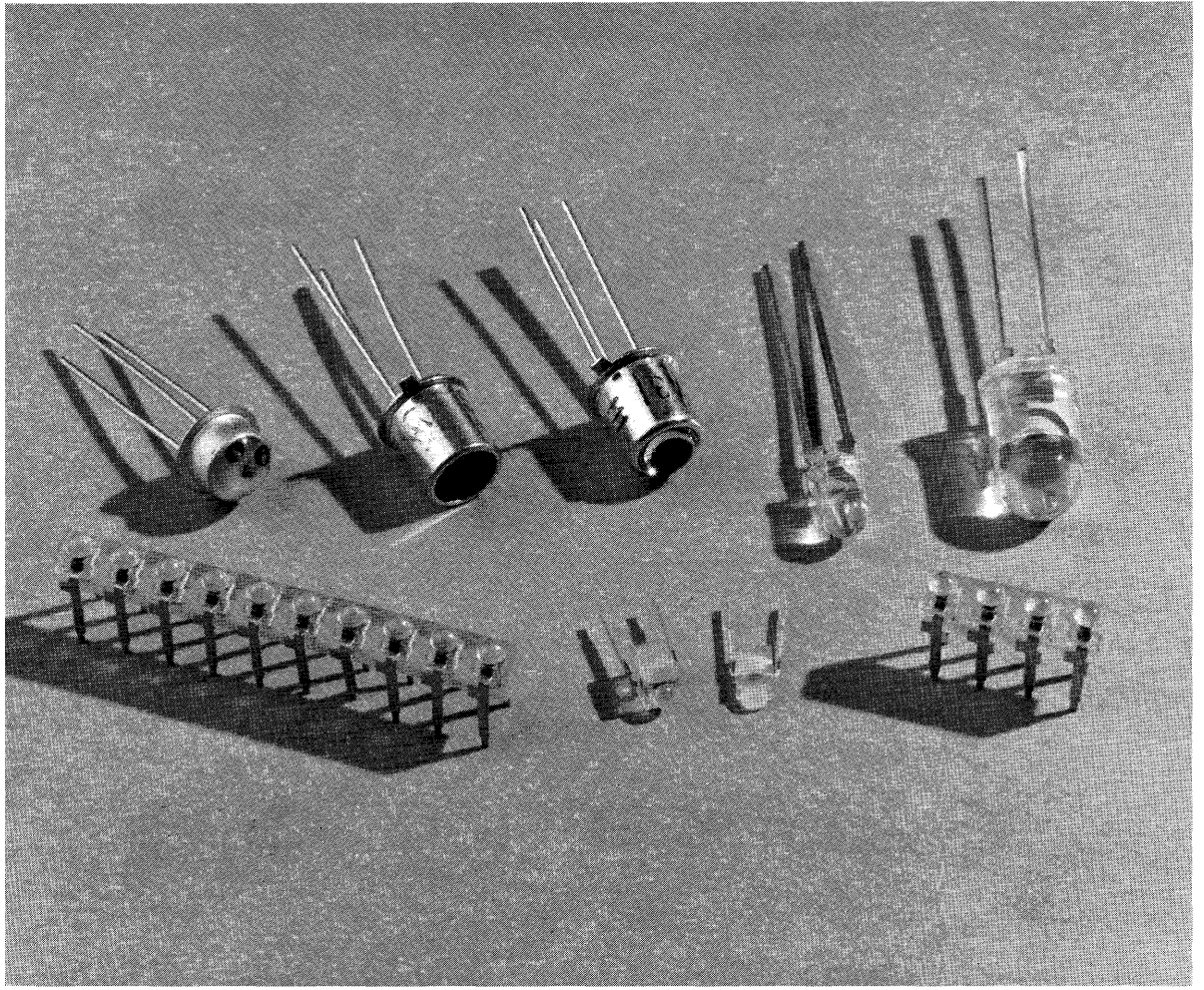
| | | | |
|---|---------------------------|-----------------------|---|
| Spectral sensitivity ¹ ($V_R = 5$ V) | S | 50 (≥ 32) | $\frac{\mu\text{A} \cdot \text{cm}^2}{\text{mW}}$ |
| Wavelength of the max. sensitivity | $\lambda_{S, \text{max}}$ | 950 | nm |
| Quantum yield (Electrons per Photon) ($\lambda = 950$ nm) | η | 0.74 | $\frac{\text{Electrons}}{\text{Photon}}$ |
| Spectral sensitivity ($\lambda = 950$ nm) | S_λ | 0.57 | $\frac{\text{A/W}}{\text{Photon}}$ |
| Open circuit voltage ($E_a = 0.5$ mW/cm ² , $\lambda = 950$ nm) | V_L | 327 | mV |
| ($E_a = 0.05$ mW/cm ² , $\lambda = 950$ nm) | V_L | 248 | mV |
| Short circuit current ($E_a = 0.05$ mW/cm ² , $\lambda = 950$ nm) | I_{sc} | 2 | μA |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value ($R_L = 1$ k Ω ; $V_R = 0$ V; $\lambda = 950$ nm) | t_r ; t_f | 125 | ns |
| ($R_L = 1$ k Ω ; $V_R = 10$ V; $\lambda = 950$ nm) | t_r ; t_f | 50 | ns |
| Temperature coefficient of V_L | TK | -2.8 | mV/K |
| Temperature coefficient of I_{sc} or I_p | TK | 0.18 | %/K |
| Capacitance ($V_R = 0$ V; $f = 1$ MHz; $E = 0$) | C_0 | 72 | pF |
| Radiant sensitive area | A | 7.6 | mm ² |
| Dark current ($V_R = 10$ V) | I_R | 2 (≤ 30) | nA |
| Noise equivalent power ($V_R = 10$ V) | NEP | 4.9×10^{-14} | $\frac{\text{W}}{\sqrt{\text{Hz}}}$ |
| Detection limit | D^* | 5.6×10^{12} | $\frac{\text{cm} \sqrt{\text{Hz}}}{\text{W}}$ |

¹The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 6033 and IEC publ. 306-1).

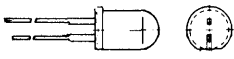
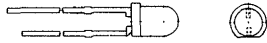
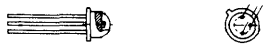
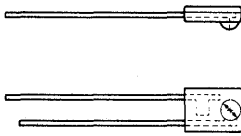
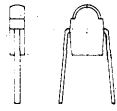


Specifications are subject to change without notice.







Phototransistors

| Package Type | Package Outline | Part Number | Acceptance Half Angle | Photo Current VCE=5V Ey=1000lx (mA) | Collector Emitter Voltage VCE0(V) | Radiant Sensitive Area mm ² | Features | Page |
|--|---|---|-----------------------|-------------------------------------|-----------------------------------|--|--|------|
| T1 1/2 5 mm Clear Plastic |  | BP103B-2 | 16° | 2.5 - 5.0 | 35 | .12 | Low Cost Narrow angle High gain 850 nm Matches with LD271 or LD273 infrared emitter | 386 |
| | | BP103B-3 | | 4.0 - 8.0 | | | | |
| | | BP103B-4 | | 6.3 - 12.6 | | | | |
| T1 3 mm Clear Plastic |  | SFH309 | 16° | 1.0 | 35 | .12 | Small (T1) Size 850 nm Matches with SFH409 infrared emitter | 406 |
| Similar to TO-18 Clear Plastic |  | BP103-2 | 60° | .25 - 0.5 | 50 | | Ideal for short range light barriers. Very wide angle 850 nm Matches with LD242 infrared emitter | 384 |
| | | BP103-3 | | 0.4 - 0.8 | | | | |
| | | BP103-4 | | .63 - 12.6 | | | | |
| Miniature Clear Plastic Side Facing |  | LPT80 | 40° | 660(> 100) (uA) | 50 | .187 | Side facing device. 870 nm. Matches with IRL80. | 397 |
| Miniature 1 mm Clear Plastic |  | SFH305-2 | 16° | 1.0-2.0 | 32 | .17 | Extremely thin .039" (1 mm) package axial lead 850 nm Ideal for very short range light barriers. Matches with SFH405 infrared emitter | 404 |
| | | SFH305-3 | | 1.6-3.2 | | | | |
| Miniature Clear Plastic |  | BPX81-2 | 18° | 1.0 - 2.0 | 32 | .17 | Small package size axial lead 850 nm Matches with LD261 infrared emitter | 392 |
| | | BPX81-3 | | 1.6 - 3.2 | | | | |
| | | BPX81-4 | | 2.5 min. | | | | |
| 2 Diode Array 3 Diode Array 4 Diode Array 5 Diode Array 6 Diode Array 7 Diode Array 8 Diode Array 9 Diode Array 10 Diode Array |  | BPX82 BPX83 BPX84 BPX85 BPX86 BPX87 BPX88 BPX89 BPX80 | 18° | .63-5.0 | 32 | .17 (per chip) | 2 Through 10 diode arrays 850 nm Matches with LD26X infrared emitters | |

IR Remote Control

Miniature & Arrays

Miniature & Arrays

Phototransistors

| Package Type | Package Outline | Part Number | Acceptance Half Angle | Photo Current $V_{CE}=5V$ $E_V=1000lx$ (mA) | Collector Emitter Voltage $V_{CE0}(V)$ | Radiant Sensitive Area mm^2 | Features | Page |
|------------------------------|-----------------|-------------|-----------------------|---|--|-------------------------------|--|------|
| TO-18 Flat Glass Lens | | BPX38-2 | 40° | .63-.125 | 50 | .65 | Hermetic seal for high rel use Wide angle 870 nm | 388 |
| | | BPX38-3 | | 1.0-2.0 | | | | |
| | | BXP38-4 | | 1.6-3.2 | | | | |
| TO-18 Round Glass Lens | | BPX43-2 | 20° | 2.5-5.0 | 50 | .12 | Hermetic seal for high rel use Narrow angle 870 nm | 390 |
| | | BPX43-3 | | 4.0-8.0 | | | | |
| | | BPX43-4 | | 6.3-1.25 | | | | |
| | | BPY62-2 | 8° | 2.0-4.0 | 32 | .12 | Hermetic seal for high rel use Very narrow angle 800 nm | 394 |
| | | BPY62-3 | | 3.2-6.3 | | | | |
| TO-18 Flat Glass Lens | | SFH500 | 60° | 0.7 | 15 | .14 | Monolithic photo amplifier Hermetic seal for high rel use Very wide angle 825 nm Recommended for fiber optics or camera applications | 408 |

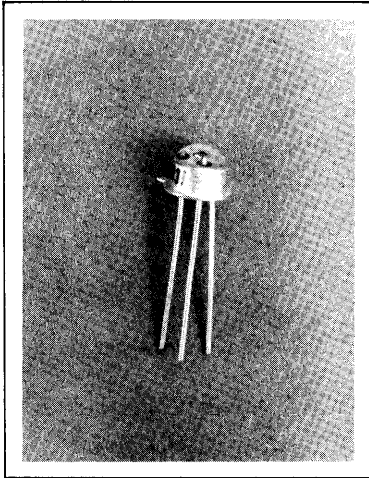
Photodarlington

| Package Type | Package Outline | Part Number | Acceptance Half Angle | Photo Current $V_{CE}=5V$ $E_V=1000lx$ (mA) | Collector Emitter Voltage $V_{CE0}(V)$ | Radiant Sensitive Area mm^2 | Features | Page |
|---|-----------------|-------------|-----------------------|---|--|-------------------------------|--|------|
| Miniature Clear Plastic Side Facing | | LPD-80 | 40° | .5 ($V_{CE}=2V$) | 5 | .187 | Side facing device. 810 nm Matches with IRL-80 IR emitter. | 396 |

SIEMENS

BP-103 SERIES

SILICON PHOTOTRANSISTOR



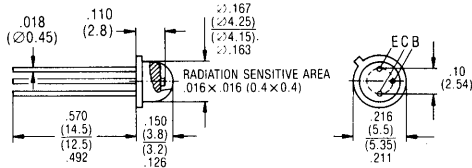
FEATURES

- Silicon NPN Epitaxial Phototransistor
- Modified TO-18 Package
- Clear Plastic Lens
- Wide Acceptance Angle, 60°
- Three Sensitivity Ranges

DESCRIPTIONS

The BP-103 is an epitaxial NPN silicon planar phototransistor, mounted on a base plate similar to 18 A 3 DIN 41876 (TO-18) with glass-clear plastic encapsulation. The plastic cover provides a wide angle for the incident light. This angle can also be reduced by mounting a diaphragm. The emitter terminal is marked by a small projection on the case bottom. The collector is electrically connected to the metallic case parts. The phototransistor is particularly suitable for use in automatic electronic flashes with base integrating circuit and self-excited (high-frequency) breakdown voltage generators (see circuit diagram) and in high Q electronic instructional toys used in filament lamp light and daylight, as well as in combination with GaAs infrared emitting diodes in small light barriers.

Package Dimensions in Inches (mm)



Maximum Ratings

| | |
|--|--------------|
| Collector-Emitter Voltage (V_{CE0}) | 50 V |
| Emitter-Base Voltage (V_{EBO}) | 7 V |
| Collector Current (I_C) | 100 mA |
| Collector Peak Voltage (I_{CM} , $t \leq 10 \mu s$) | 200 mA |
| Junction Temperature (T_J) | 125°C |
| Storage Temperature (T_{stor}) | -55 to +80°C |
| Maximum Permissible Soldering Temperature (T_S , $t \leq 5 s$) | 260°C |
| Power Dissipation (P_{tot}), $T_{amb} = 25^\circ C$ | 300 mW |
| Thermal Resistance Collector Junction-To-Air (R_{thJAmb}) | 500 K/W |
| Collector Junction-To-Case ($R_{thJCase}$) | 200 K/W |

Characteristics ($T_{amb} = 25^\circ C$)

| | | |
|---|-------------------------------|-------------------------|
| Collector-Emitter Leakage Current (I_{CEO}) | ($V_{CE} = 30 V$; $E = 0$) | 5 (≤ 100) nA |
| Range of Spectral Photosensitivity (λ) ($S = 0.1 S_{max}$) | | 440 to 1070 nm |
| Wavelength of the Max. Sensitivity (λ_{Smax}) | | 850 nm |
| Typical Spectral Sensitivity of the Collector Base Photodiode (I_{PCB}) | | |
| $E_v = 1000$ lx; $V_{CE} = 5 V$ | | 2.1 μA |
| $E_b = 0.5$ mW/cm ² ; $\lambda = 950$ nm; $V_{CE} = 5 V$ | | 0.55 μA |
| Radiant Sensitive Area (A) | | 0.12 mm ² |
| Rise Time to 90% of the Final Value | | |
| Fall Time to 10% of the Initial Value (t_r , t_f) ($R_L = 1 k\Omega$) | | 5 (≤ 10) μs |
| Capacitance (C_{CE}), $V_{CE} = 0 V$; $f = 1$ MHz; $E = 0$ | | 9 pF |
| (C_{CB}), $V_{CB} = 0 V$; $f = 1$ MHz; $E = 0$ | | 13 pF |
| (C_{EB}), $V_{EB} = 0 V$; $f = 1$ MHz; $E = 0$ | | 21 pF |
| Half-Angle (φ) | | 60 Degrees |

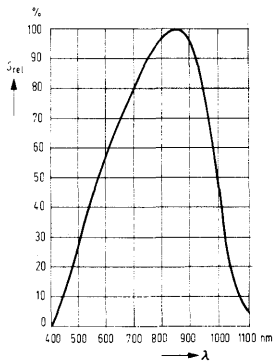
| Group | BP 103-2 | BP 103-3 | BP 103-4 | |
|--|------------|------------|----------|---------|
| Photocurrent ($V_{CE} = 5 V$; $E_v = 1000$ lx) | 250 to 500 | 400 to 800 | 630 min. | μA |
| Photocurrent ($V_{CE} = 5 V$; $E_b = 20$ mW/cm ²) | 1.1 to 2.2 | 1.8 to 3.6 | 2.8 min. | mA |
| Current Gain ($E_v = 1000$ lx; $V_{CE} = 5 V$) | 280 | 450 | 710 | |
| Collector-Emitter/ Saturation Voltage ($I_C = 0.1$ mA; $I_B = 1 \mu A$; $E = 0$) | 170 | 160 | 160 | mV |
| ($I_C = 2.5$ mA; $I_B = 25 \mu A$; $E = 0$) | 160 | 150 | 150 | mV |

The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856K. (Standard light A in accordance with DIN 5033 and IEC 306-11). Irradiance E_b measured with HP radiant flux meter 8334A with option 013.

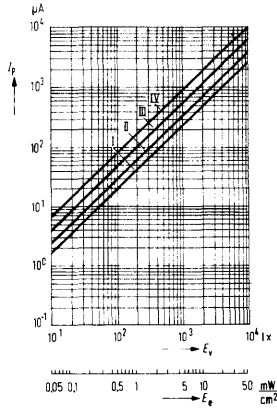
1. Measured with LED $\lambda = 950$ nm. (1) I_{PCB} = Photocurrent of transistors; I_{PCB} = Photocurrent of Collector-Basis-Diode.

Specifications subject to change without notice.

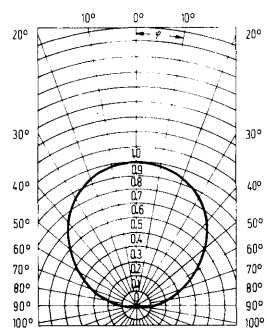
Relative Spectral Sensitivity
 $S_{rel} = f(\lambda)$



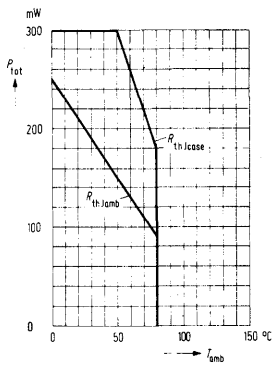
Photocurrent as a Function of E_v or E_e ; $I_p = f(E_v)$



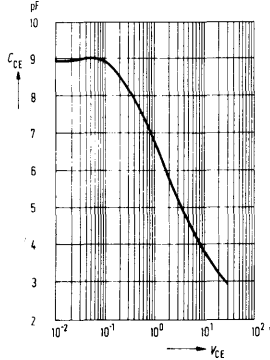
Directional Characteristic $I_p = f(\varphi)$



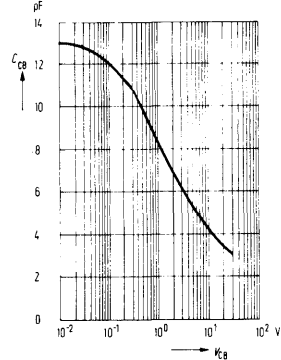
Power Dissipation $P_{tot} = f(T_{amb})$



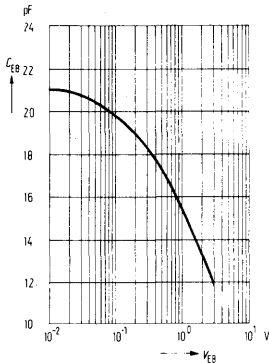
Collector-Emitter Capacitance
 $C_{CE} = f(V_{CE})$



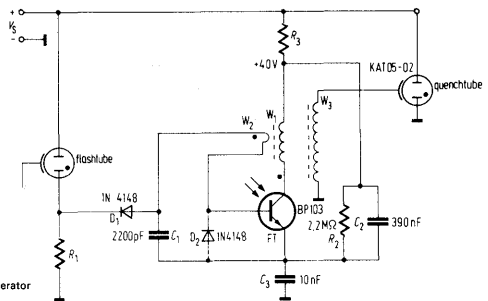
Collector-Base Capacitance
 $C_{CB} = f(V_{CB})$



Emitter-Base Capacitance
 $C_{EB} = f(V_{EB})$



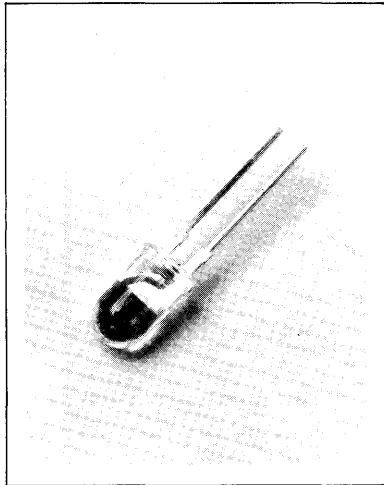
Application Example



Breakdown voltage generator
 for measuring circuit
 W_1 : 4 turns $0.15 \text{ } \varnothing \text{ CuLS}$
 W_2 : 1 turns $0.25 \text{ } \varnothing \text{ CuL}$
 W_3 : 140 turn $0.15 \text{ } \varnothing \text{ CuLS}$
 Interior space of the coil
 with SIFERRIT cylindrical core,
 material M 25,
 inner coil diameter: 11 mm

SIEMENS

BP 103B SERIES PHOTOTRANSISTOR



FEATURES

- Silicon NPN Epitaxial Phototransistor
- Low Cost
- T 1½ Package
- Clear Plastic Lens
- Narrow Acceptance Angle 16°
- Very High Gain, Ranges Up to 28 mA (min)

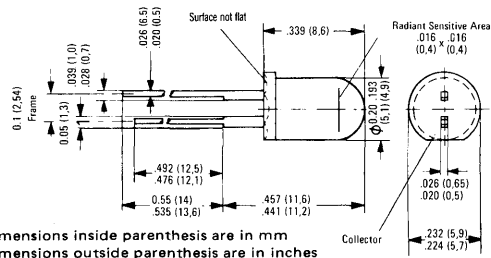
DESCRIPTION

BP103B is an epitaxial NPN silicon phototransistor of high sensitivity. It is enclosed in a tubular 5 mm all-plastic package.

The base terminal is not contacted, control is performed by the incident light. The collector is characterized by a flattening on the package base.

The phototransistor is mainly intended for standard applications and for use in automatic electronic flashes. Due to the tubular plastic shape, it can easily be mounted into holes and performed plastic sleeves; e.g. LED mounting assemblies.

Package Dimensions



Maximum Ratings

| | | | |
|---|--------------|-----------|-----|
| Collector-emitter voltage | V_{CEO} | 35 | V |
| Emitter-Collector voltage | V_{EBO} | 7 | V |
| Collector current | I_C | 100 | mA |
| Collector peak current ($t \leq 10 \mu s$) | I_{CM} | 200 | mA |
| Junction temperature | T_j | 125 | °C |
| Storage temperature | T_{stor} | -55 to 80 | °C |
| Max. permissible soldering temperature ($t \leq 5 s$) | T_s | 260 | °C |
| Power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} | 210 | mW |
| Thermal resistance | | | |
| Collector junction to air | $R_{th,amb}$ | 350 | K/W |

Characteristics ($T_{amb} = 25^\circ C$)

| | | | |
|---|--------------------|------------------|---------------|
| Collector-emitter leakage current ($V_{CE} = 30 V; E = 0$) | I_{CEO} | 5 (≤ 100) | nA |
| Range of spectral sensitivity ($S = 0.1 S_{max}$) | λ | 440 to 1070 | nm |
| Wavelength of the max. sensitivity | $\lambda_{s, max}$ | 850 | nm |
| Collector base - Photodiode ($E_v = 1000 \text{ lx}; V_{CE} = 5 V$) | I_{PCB} | 10.8 | μA |
| ($E_v = 0.5 \text{ mW/cm}^2; \lambda = 950 \text{ nm}; V_{CE} = 5 V$) | I_{PCB} | 2.7 | μA |
| Radiant sensitive area | A | 0.12 | mm^2 |
| Rise time to 90% of the final value | | | |
| Fall time to 10% of the initial value ($R_L = 1 \text{ k}\Omega$) ¹⁾ | $t_f; t_r$ | 5 (≤ 10) | μs |
| Capacitance ($V_{CE} = 0 V; f = 1 \text{ MHz}; E = 0$) | C_{CE} | 11 | pF |
| Acceptance half angle | φ | 16 | degrees |

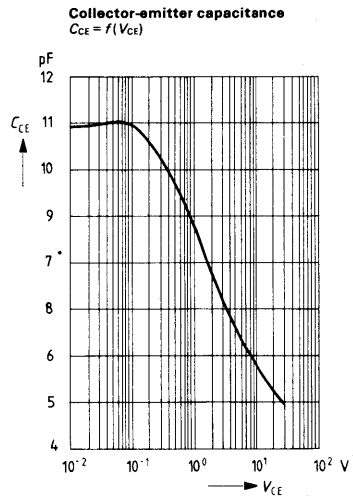
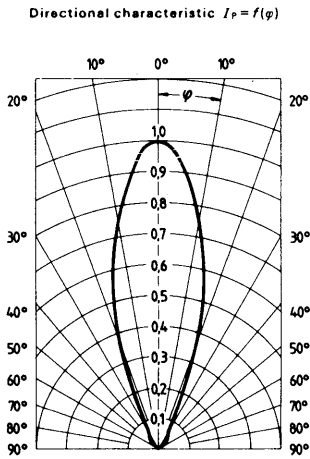
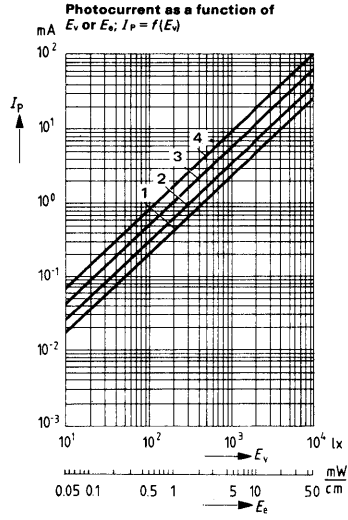
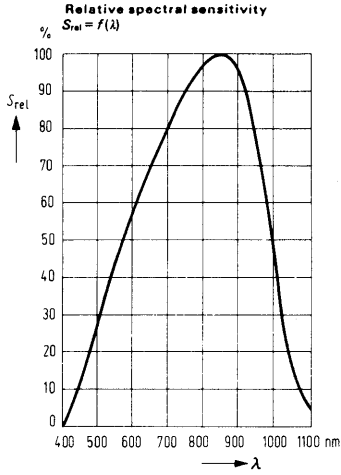
Grouping is done at $E_v = 1000 \text{ lx}$.

| Group | BP 103B-2 | BP 103B-3 | BP 103B-4 | |
|---|------------|------------|-----------|----|
| Photocurrent ($V_{CE} = 5 V; E_v = 1000 \text{ lx}$) | 2.5 to 5.0 | 4.0 to 8.0 | 6.3 min. | mA |
| Photocurrent approx. I_P ($V_{CE} = 5 V; E_v = 20 \text{ mW/cm}^2$) | 11 to 22 | 18 to 36 | 28 min. | mA |

The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC 306-1). Irradiance E_v measured with HP radiant flux meter 8334A with option 013.

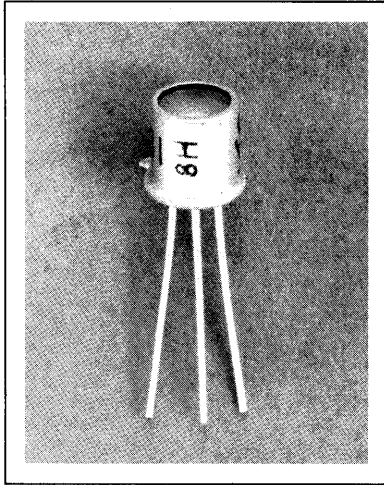
¹⁾ measured with LED $\lambda = 950 \text{ nm}$

Specifications are subject to change without notice.



SIEMENS

BPX 38 SERIES PHOTOTRANSISTOR



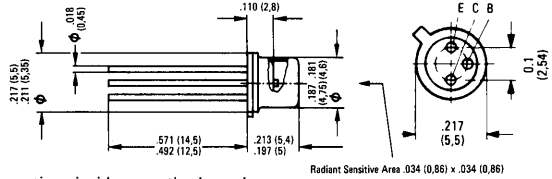
FEATURES

- Silicon NPN Epitaxial Planar Photo-transistor
- Premium Hi-Rel Device
- TO-18 Size Hermetic Package
- Flat Glass Lens
- Wide Acceptance Angle, 40°
- Moderate Gain, Ranges Up to 7 mA (min)
- Three Sensitivity Ranges

DESCRIPTION

The BPX 38 is a silicon NPN epitaxial planar phototransistor in an 18 A 3 DIN 41876 (TO 18) case with flat window and high radiant sensitivity for front irradiation. The flat window has no influence on the light paths. It is, therefore, particularly suitable for industrial applications, where lens systems are used. The collector terminal is electrically connected to the case.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | | | |
|--|---------------|-------------|-----|
| Collector-emitter voltage | V_{CE0} | 50 | V |
| Emitter-base voltage | V_{EB0} | 7 | V |
| Collector current | I_C | 50 | mA |
| Junction temperature | T_j | 175 | °C |
| Storage temperature | T_{stor} | -55 to +125 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 330 | mW |
| Max. permissible soldering temperature ($t \leq 5$ s) | T_s | 260 | °C |
| Thermal resistance | | | |
| Collector junction to air | R_{thJamb} | ≤ 450 | K/W |
| Collector junction to case | $R_{thJcase}$ | ≤ 150 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|------------------|-------------|-----------------|
| Range of spectral sensitivity ($S = 0.1 S_{max}$) | λ | 450 to 1080 | nm |
| Wavelength of the max. sensitivity | λ_{Smax} | 870 | nm |
| Collector-base - photodiode ($E_v = 1000$ lx; $V_{CE} = 5$ V) | I_{PCB} | 4.8 | μA |
| ($E_v = 0.5$ mW/cm ² ; $\lambda = 950$ nm; $V_{CE} = 5$ V) | I_{PCB} | 1.2 | μA |
| Radiant sensitive area | A | 0.65 | mm ² |
| Capacitance | | | |
| ($V_{CE} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{CE} | 23 | pF |
| ($V_{CB} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{CB} | 41 | pF |
| ($V_{EB} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{EB} | 47 | pF |
| Acceptance half angle | φ | 40 | degree |
| Grouping is done at $E_v = 1000$ lx. | | | |

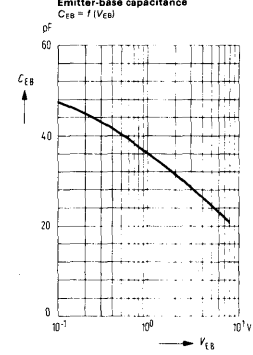
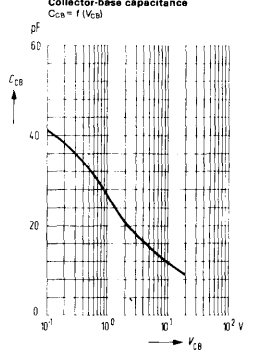
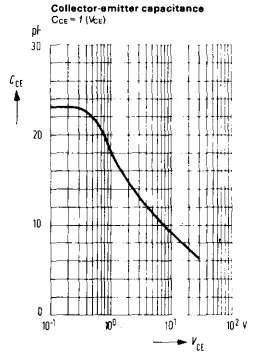
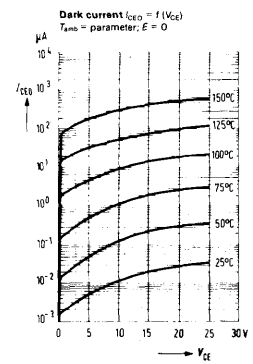
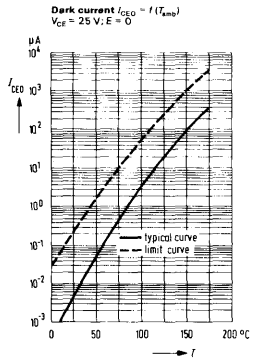
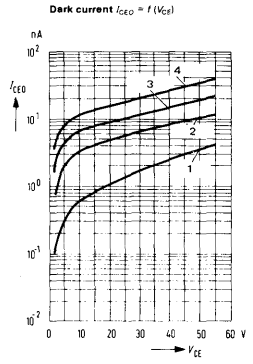
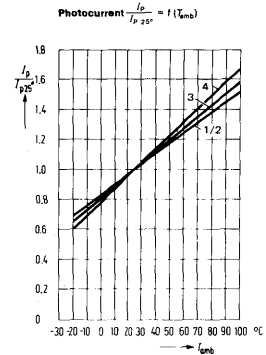
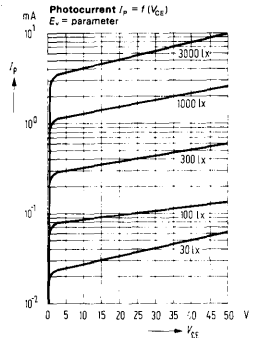
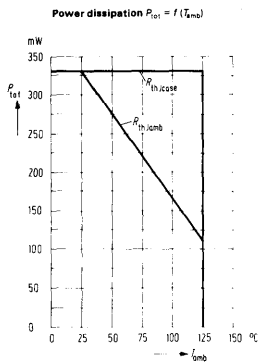
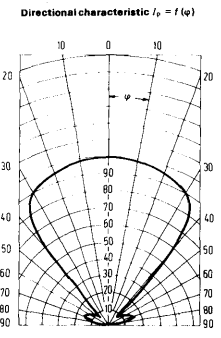
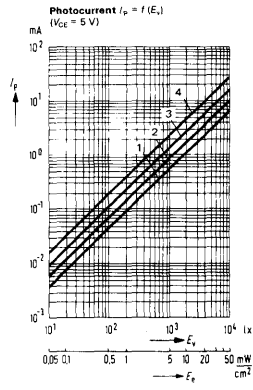
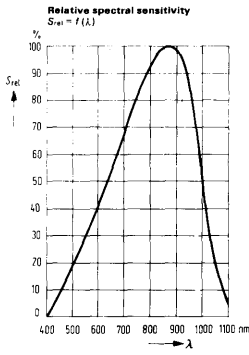
| Group | BPX 38-2 | BPX 38-3 | BPX 38-4 | |
|--|------------------|-------------------|-------------------|---------------|
| Photocurrent I_p ($V_{CE} = 5$ V; $E_v = 1000$ lx) | 0.63 to 1.25 | 1.0 to 2.0 | 1.6 min. | mA |
| Photocurrent approx. I_p ($V_{CE} = 5$ V; $E_v = 20$ mW/cm ²) | 2.5 to 5.0 | 4.5 to 9.0 | 7.0 min. | mA |
| Rise time from 10% to 90% of the final value | | | | |
| Fall time from 90% to 10% of the initial value ($I_C = 1$ mA; $V_{CE} = 5$ V; $R_L = 1$ k Ω) ¹⁾ | 6 | 8 | 12 | μs |
| Collector-emitter saturation voltage ($I_C = 2$ mA; $I_B = 50$ μA ; $E = 0$) | 175 | 160 | 140 | mV |
| Power gain $\frac{(I_{PCB}^2)}{(I_{FICE1})}$ V_{CEsat} ($E_v = 1000$ lx; $V_{CE} = 5$ V) | 160 | 250 | 400 | |
| Collector-emitter leakage current ($V_{CE0} = 25$ V; $E = 0$) | I_{CEO} | | | nA |
| | 8 (≤ 200) | 12 (≤ 500) | 20 (≤ 500) | |

The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K. (standard light A in accordance with DIN 5033 and IEC 306-1). Irradiance E_v measured with HP radiant flux meter 8334A with option 013.

1) measured with LED $\lambda = 950$ nm

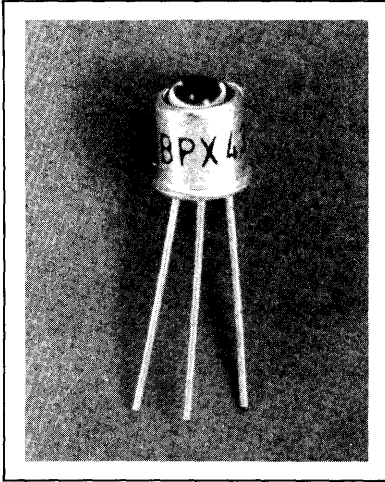
2) $I_{p,CE}$ = Photocurrent of the phototransistor
 $I_{p,CB}$ = Photocurrent of the collector-base photodiode

Specifications are subject to change without notice.



SIEMENS

BPX 43 SERIES PHOTOTRANSISTOR



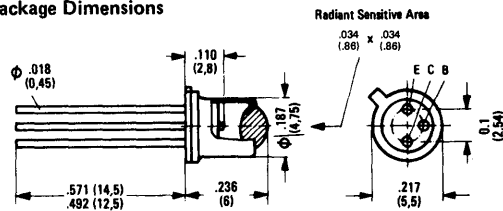
FEATURES

- Silicon NPN Epitaxial Planar Photo-transistor
- Premium Hi-Rel Device
- TO-18 Size Hermetic Package
- Rounded Glass Lens
- Narrow Acceptance Angle, 20°
- Very High Gain, Ranges Up to 35 mA (min)
- Three Sensitivity Ranges

DESCRIPTION

The BPX 43 is a silicon NPN epitaxial planar phototransistor in an 18 A 3 DIN 41876 (TO 18) case with lens-shaped window for front irradiation. The special transistor system in connection with the lens shaped window provides the transistor with a particularly high spectral sensitivity. It is therefore suitable for industrial applications at low illuminances. The collector terminal is electrically connected to the case

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | | | |
|--|-----------------|-------------|-----|
| Collector-emitter voltage | V_{CE0} | 50 | V |
| Emitter-base voltage | V_{EB0} | 7 | V |
| Collector current | I_C | 100 | mA |
| Junction temperature | T_J | 175 | °C |
| Storage temperature | T_{stor} | -55 to +125 | °C |
| Power dissipation ($T_{amb} = 25$ °C) | P_{tot} | 330 | mW |
| Max. permissible soldering temperature (t = 5 s) | T_s | 260 | °C |
| Thermal resistance | | | |
| Collector junction to air | $R_{th,j amb}$ | <450 | K/W |
| Collector junction to case | $R_{th,j case}$ | 150 | K/W |

Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| | | | |
|--|-------------------|-------------|-----------------|
| Range of spectral sensitivity ($S = 0.1 S_{max}$) | λ | 450 to 1080 | nm |
| Wavelength of the max. sensitivity | $\lambda_{S max}$ | 870 | nm |
| Collector base - photodiode ($E_v = 1000$ lx; $V_{CE} = 5$ V) | I_{PCB} | 25 | μA |
| ($E_a = 0.5$ mW/cm ² ; $\lambda = 950$ nm; $V_{CE} = 5$ V) | I_{PC} | 7.1 | μA |
| Radiant sensitive area | A | 0.65 | mm ² |
| Capacitance | | | |
| ($V_{CE} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{CE} | 23 | pF |
| ($V_{CB} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{CB} | 41 | pF |
| ($V_{EB} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{EB} | 47 | pF |
| Acceptance Half Angle | φ | 20 | Degrees |

Grouping is done at $E_v = 1000$ lx.

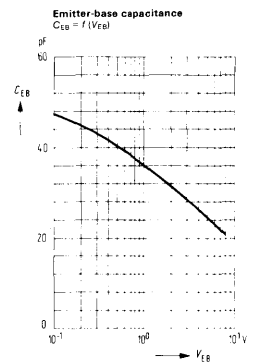
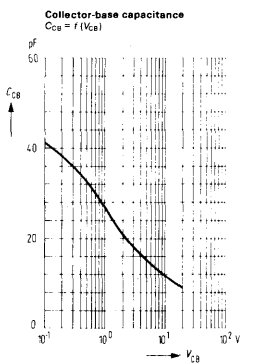
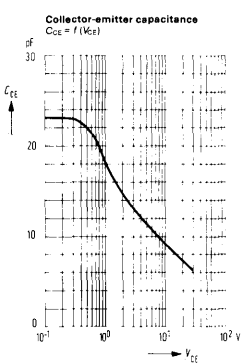
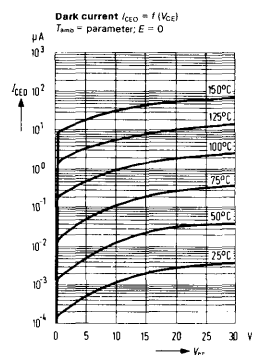
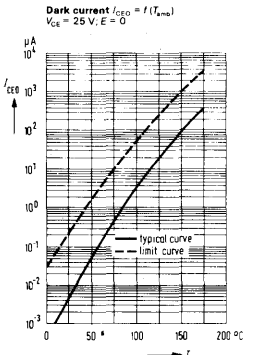
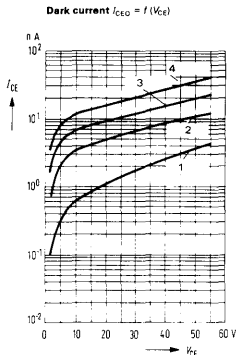
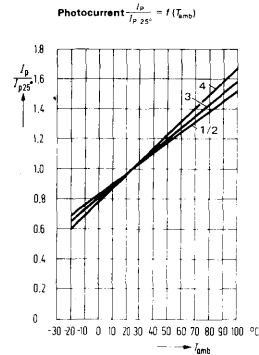
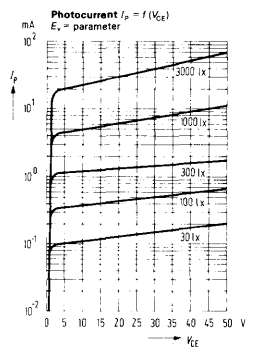
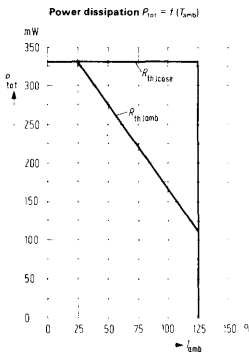
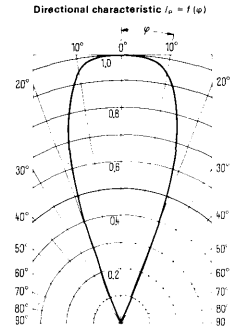
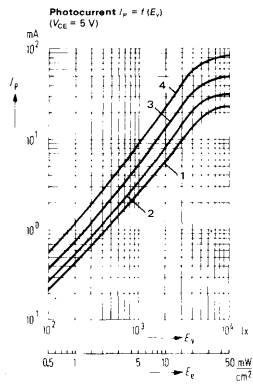
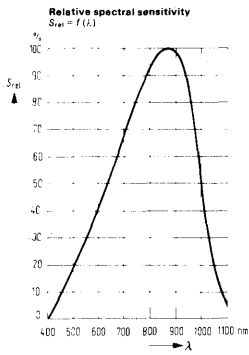
| Group | BPX 43-2 | BPX 43-3 | BPX 43-4 | | |
|--|-----------------------------|------------------|-------------------|-------------------|---------------|
| Photocurrent ($V_{CE} = 5$ V; $E_v = 1000$ lx) | 2.5 to 5.0 | 4.0 to 8.0 | 6.3 min. | mA | |
| Photocurrent approx. I_P ($V_{CE} = 5$ V; $E_a = 20$ mW/cm ²) | 14 to 28 | 22 to 45 | 35 min. | mA | |
| Rise time from 10% to 90% of the final value | | | | | |
| Fall time from 90% to 10% of the initial value | | | | | |
| ($I_C = 1$ mA; $V_{CE} = 5$ V; $R_L = 1$ k Ω) | $t_r; t_f$ | 6 | 8 | 12 | μs |
| Collector-emitter saturation voltage ($I_C = 2$ mA; $I_B = 50$ μA ; $E = 0$) | V_{CEsat} | 175 | 160 | 140 | mV |
| Power gain ($E_v = 1000$ lx; $V_{CE} = 5$ V) | $\frac{I_{PCER2}}{I_{PCB}}$ | 135 | 215 | 345 | |
| Collector-emitter leakage current ($V_{CE0} = 25$ V; $E = 0$) | I_{CE0} | 8 (≤ 200) | 12 (≤ 500) | 20 (≤ 500) | nA |

The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K. (standard light A in accordance with DIN 5033 and IEC 306-1). Irradiance E_a measured with HP radiant flux meter 8334A with option 013.

1) measured with LED $\lambda = 950$ nm

2) I_{PCER2} = Photocurrent of the phototransistor
 I_{PCB} = Photocurrent of the collector-base photodiode

Specifications are subject to change without notice.

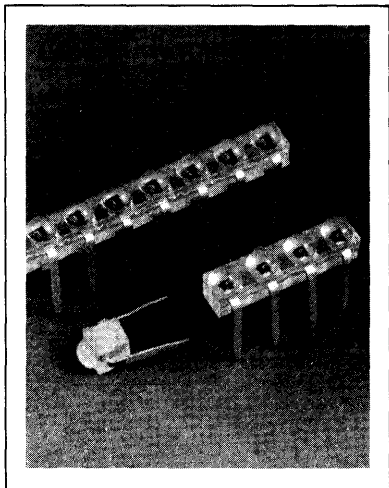


SIEMENS

BPX 81 SERIES

PHOTOTRANSISTOR

SINGLE AND ARRAYS



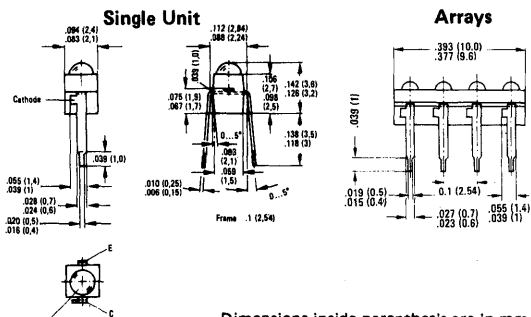
FEATURES

- Silicon NPN Planar Phototransistor
- Low Cost
- Miniature Size
- Available As Single Unit, BPX 81 and Arrays—
Two Chip, BPX 82
Three Chip, BPX 83
Four Chip, BPX 84
Five Chip, BPX 85
Six Chip, BPX 86
Seven Chip, BPX 87
Eight Chip, BPX 88
Nine Chip, BPX 89
Ten Chip, BPX 80
- Narrow Acceptance Angle, 18°
- High Gain, Up to 5 mA

DESCRIPTION

The types BPX 80 to BPX 89 are plastic encapsulated phototransistor arrays consisting of an arrangement of max. 10 silicon NPN epitaxial planar phototransistors. The individual photoelectric detectors are spaced apart according to the standard lead spacing of 2.54 mm (1/10"). A small angle of the lens-shaped light window avoids optical "cross modulation" from the adjacent system. The collector terminals are marked by small projections arranged at the sides of the solder pins. The phototransistor is suitable for versatile applications in conjunction with filament lamps and infrared light. The BPX 81 can be mounted on PC boards and is also provided for use as detector of the light emitting diode LD 261 (same type as BPX 81) in miniature light barriers.

Package Dimensions



Radiant Sensitive Area: .016 (0.43) x .016 (0.43)

Maximum Ratings

| | | |
|---|--------------|---------|
| Collector-emitter voltage | 32 | V |
| Junction temperature | 90 | °C |
| Collector current | 50 | mA |
| Storage temperature | -40 to +80 | °C |
| Power dissipation | 100 | mW |
| Soldering temperature in a 2 mm distance from the case bottom ($t \leq 3$ s) | | |
| Thermal resistance | T_s | °C |
| Collector junction to air | R_{thJamb} | 750 K/W |
| Collector junction to solder pin | R_{thJL} | 650 K/W |

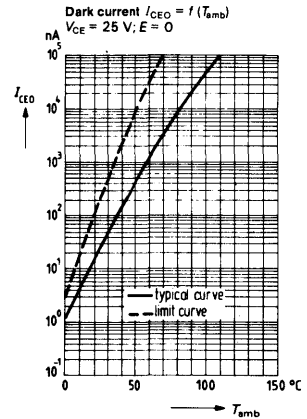
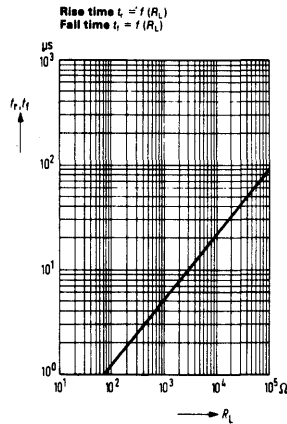
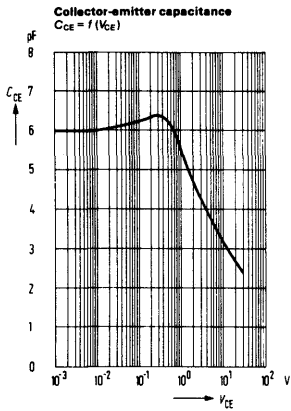
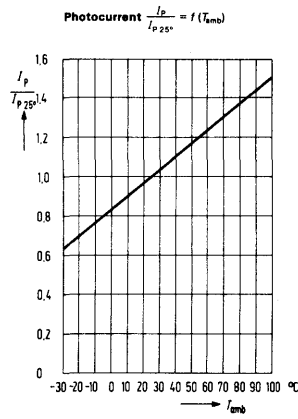
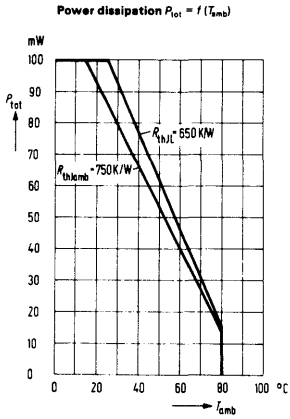
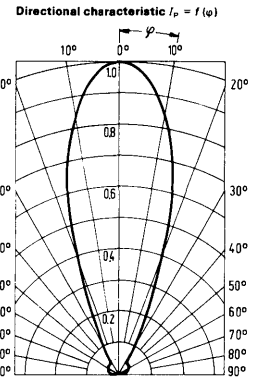
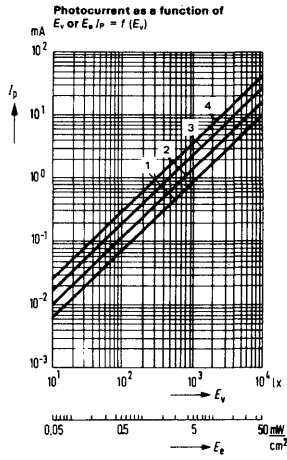
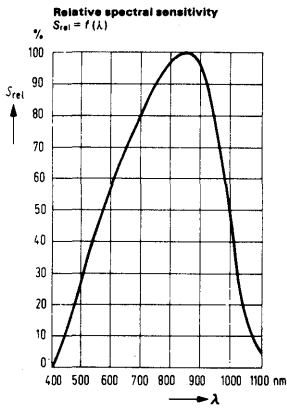
Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|--------------------------------------|-------------------|-----------------|
| Collector-base - photodiode ($E_v = 1000$ lx; $V_{CE} = 5$ V) ($E_a = 0.5$ mW/cm ² ; $\lambda = 950$ nm; $V_{CE} = 5$ V) ($V_{CE} = 5$ V) | I_{PCB} | 7.1 | μA |
| Collector-emitter leakage current ($V_{CE} = 25$ V; $E = 0$) | I_{CEO} | 25 (≤ 200) | nA |
| Collector emitter saturation voltage ($I_C = 0.25$ mA; $E_v = 1000$ lx) | V_{CEsat} | 0.2 | V |
| Range of spectral sensitivity ($S \geq 0.1$ S _{max}) | λ | 440 to 1070 | nm |
| Wavelength of the max. sensitivity | λ_{Smax} | 850 | nm |
| Rise time from 10% up to 90% of the final value | t_r ; t_f | 5 (≤ 10) | μs |
| Fall time from 90% up to 10% of the initial value ($R_L = 1$ k Ω) | A | 0.17 | mm ² |
| Radiant sensitive area | C_{CE} | 6 | pF |
| Capacitance ($V_{CE} = 0$ V; $f = 1$ MHz; $E = 0$) | φ | 18 | degrees |
| Acceptance half angle | Grouping is done at $E_v = 1000$ lx. | | |

| Group | BPX 81-2 | BPX 81-3 | BPX 81-4 | BPX 82 to 80 |
|--|------------|------------|----------|--------------------------------------|
| Photocurrent ($V_{CE} = 5$ V; $E_v = 1000$ lx) | 1.0 to 2.0 | 1.6 to 3.2 | 2.5 min. | 1.25-4.0 |
| Photocurrent approx. I_p ($V_{CE} = 5$ V; $E_a = 5$ mW/cm ²) | .25 to .50 | .40 to .80 | 6.3 min. | .25 to 1.25 20 mW/cm ² |

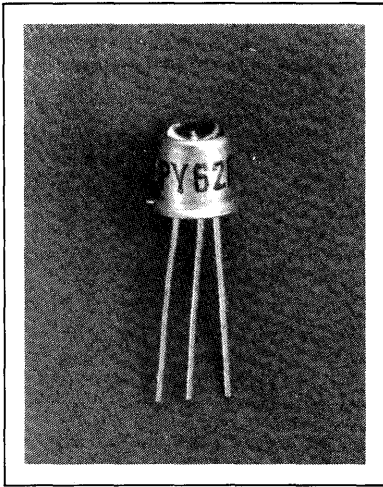
The illuminances refer to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K. (standard light A in accordance with DIN 5033 and IEC 306-1). Irradiance E_a measured with HP radiant flux meter 8334A with option 013.

Specifications are subject to change without notice.



SIEMENS

BPY 62 SERIES PHOTOTRANSISTOR



FEATURES

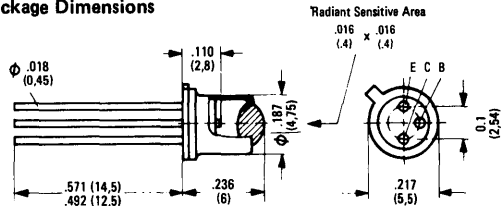
- Silicon NPN Epitaxial Planar Phototransistor
- Premium Hi-Rel Device
- TO-18 Size Hermetic Package
- Rounded Glass Lens
- Very Narrow Acceptance Angle, 8°
- High Gain, Ranges Up to 28 mA

DESCRIPTION

The BPY 62 is a silicon NPN epitaxial phototransistor in an 18 A 3 DIN 41876 (TO 18) case with a light window for front irradiation. The base connection is brought out and the emitter is marked by a small projection on the case bottom. The collector is electrically connected to the case.

The phototransistor BPY 62 is suitable for versatile applications in connection with filament lamp light mainly where particularly sensitive photoelectric detectors are required.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

| | | | |
|--|---------------|-------------|-----|
| Collector-emitter voltage | V_{CE0} | 32 | V |
| Emitter-base voltage | V_{EB0} | 5 | V |
| Collector current | I_C | 100 | mA |
| Junction temperature | T_j | 125 | °C |
| Storage temperature | T_{stor} | -55 to +125 | °C |
| Power dissipation ($T_{amb} = 75^\circ\text{C}$) | P_{tot} | 300 | mW |
| Thermal resistance | | | |
| Collector junction to air | R_{thJamb} | 500 | K/W |
| Collector junction to case | $R_{thJcase}$ | 200 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|------------------|------------------|-----------------|
| Collector-emitter leakage current ($V_{CE} = 25\text{ V}; E = 0$) | I_{CEO} | 5 (≤ 100) | nA |
| Collector-emitter saturation voltage ($I_C = 1\text{ mA}; E_v = 1000\text{ lx}$) | V_{CEsat} | 0.3 | V |
| Range of spectral sensitivity ($S > 0.1\ \Phi_{max}$) | λ | 430 to 1060 | nm |
| Wavelength of the max. sensitivity | λ_{Smax} | 800 | nm |
| Collector-base - photodiode ($E_v = 1000\text{ lx}; U_{CE} = 5\text{ V}$) | I_{PCB} | 17 | μA |
| ($E_p = 0.5\text{ mW/cm}^2; \lambda = 950\text{ nm}; V_{CE} = 5\text{ V}$) | I_{PCB} | 3.5 | μA |
| Rise time from 10% up to 90% of I_P | t_r | 5 | μs |
| Fall time from 90% up to 10% of I_P ($R_L = 1\text{ k}\Omega$) | t_f | 0.12 | mm ² |
| Radiant sensitive area | A | | |
| Capacitances | | | |
| ($V_{CE} = 0\text{ V}; f = 1\text{ MHz}; E = 0$) | C_{CE} | 6 | pF |
| ($V_{CB} = 0\text{ V}; f = 1\text{ MHz}; E = 0$) | C_{CB} | 10 | pF |
| ($V_{EB} = 0\text{ V}; f = 1\text{ MHz}; E = 0$) | C_{EB} | 12 | pF |
| Acceptance half angle | φ | 8 | degrees |

Grouping is done at $E_v = 1000\text{ lx}$.

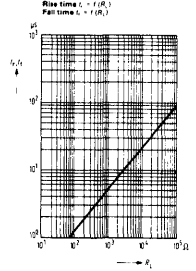
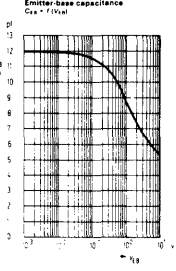
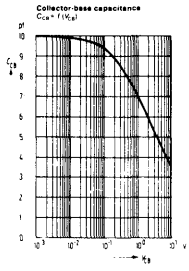
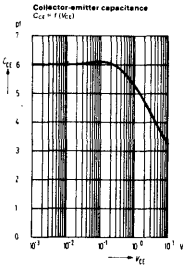
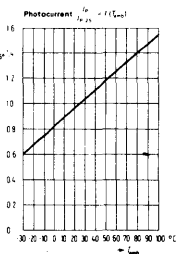
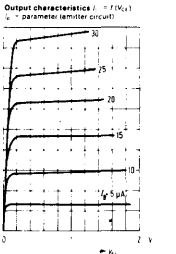
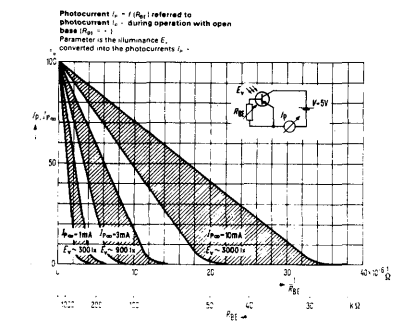
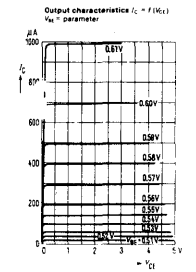
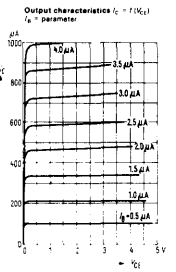
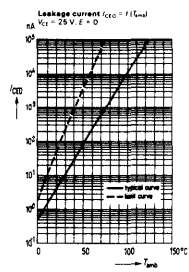
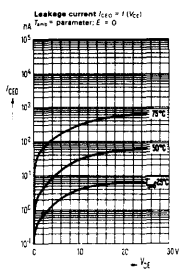
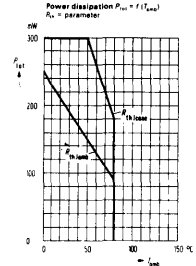
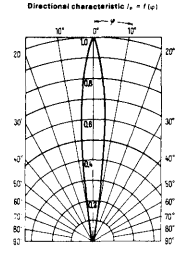
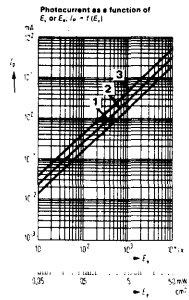
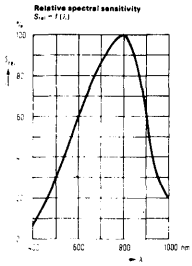
| Group | BPY 62-2 | BPY 62-3 | |
|---|-------------|--------------|----|
| Photocurrent ($V_{CE} = 5\text{ V}; E_v = 1000\text{ lx}; I_P$) | 2.0 to 4.0 | 3.2 to 6.3 | mA |
| ($V_{CE} = 5\text{ V}; E_p = 20\text{ mW/cm}^2$ approx. I_P) | 9.0 to 18.0 | 14.0 to 28.0 | mA |
| Power gain (I_{PCB}^2 / I_{CE}^2) ($E_v = 1000\text{ lx}; V_{CE} = 5\text{ V}$) | 560 | 900 | |

The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K. (standard light A in accordance with DIN 5033 and IEC 306-1). Irradiance E_p measured with HP radiant flux meter 8334A with option 013.

¹⁾ measured with LED $\lambda = 950\text{ nm}$

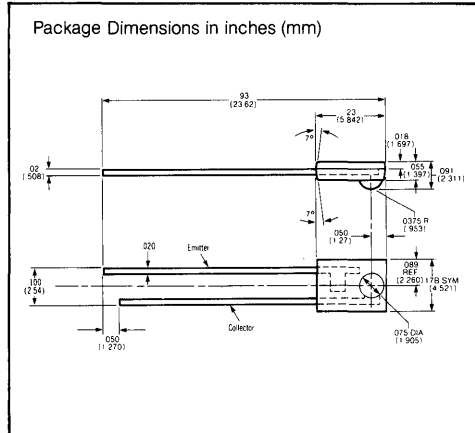
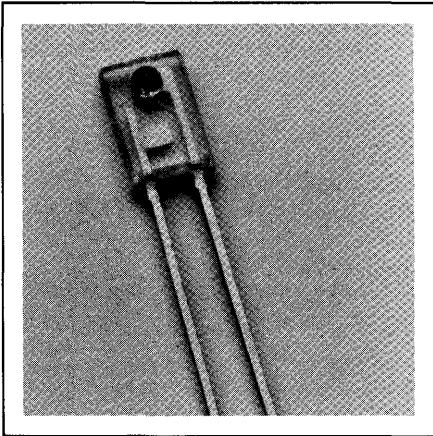
²⁾ I_{PCB} = Photocurrent of the phototransistor
 I_{CE} = Photocurrent of the collector-base photodiode

Specifications are subject to change without notice.



SIEMENS

LPD-80 PHOTODARLINGTON PRELIMINARY



FEATURES

- Silicon NPN Photodarlington
- Miniature Side Facing Package
- Low Cost
- High Sensitivity
- Matches IRL-80 Infrared Emitter

DESCRIPTION

The LPD-80 is an epitaxial NPN silicon photodarlington. The chip is positioned to accept radiation from the side of the clear miniature package. It efficiently receives infrared radiation from the matching IRL-80.

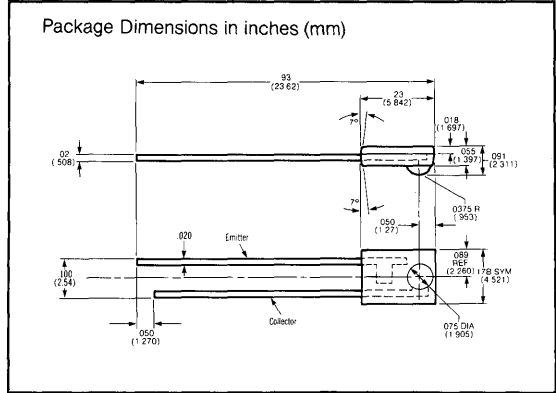
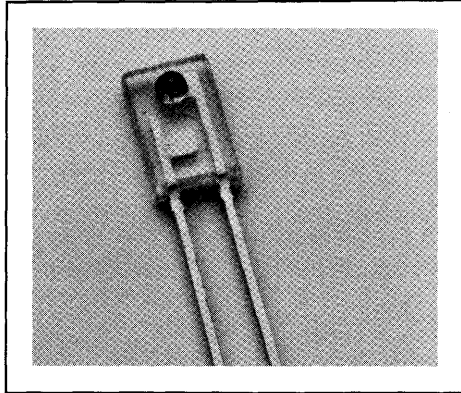
MAXIMUM RATINGS

| | | | |
|---------------------------|------------|-------------|-------|
| Collector Emitter Voltage | V_{CE} | 30 | V |
| Emitter Collector Voltage | V_{EC} | 5 | V |
| Storage Temperature | T_{STOR} | -40 to +100 | °C |
| Operating Temperature | T_{OP} | -40 to +100 | °C |
| Junction Temperature | T_J | 100 | °C |
| Power Dissipation | P_{TOT} | 100 | mW |
| Deviate Above 25°C | | — | mW/°C |

CHARACTERISTICS ($T_{amb} = 25^\circ\text{C}$)

| | | Min. | Typ. | Max. |
|--|---------------|------|------|---------------|
| Photocurrent ($V_{CE} = 2V, E_b = 1\text{mW/cm}^2, R_L = 50\Omega$) | I_{CE} | .5 | 4 | mA |
| Collector Emitter Leakage Current ($V_{CE} = 10V, E_b = 0$) | I_{CEO} | | 100 | nA |
| Rise Time ($V_{CE} = 5V, T_w = 100\mu\text{sec}, f = 100\text{Hz}, \lambda = 940\text{nm}, R_L = 75\Omega$) | t_r | | 5 | μs |
| Fall Time ($V_{CE} = 5V, T_w = 100\mu\text{sec}, f = 100\text{Hz}, \lambda = 940\text{nm}, R_L = 75\Omega$) | t_f | | 16 | μs |
| Collector-Emitter Saturation Voltage ($I_C = 4\text{mA}, E_b = 1\text{mW/cm}^2$) | $V_{CE(SAT)}$ | | .7 | 1.1V |
| Wavelength of max. sensitivity | | | 810 | nm |
| Acceptance of half angle | | | 40 | degree |

Specifications are subject to change without notice.



FEATURES

- Silicon NPN Epitaxial Phototransistor
- Low Cost
- Miniature sidfacing package
- Clear Plastic
- Matches IRL-80

DESCRIPTION

The LPT-80 is an epitaxial NPN silicon phototransistor. The chip is positioned to accept radiation from the side of the clear plastic miniature package. It efficiently receives infrared radiation from the matching IRL-80 infrared emitter.

Maximum Ratings

| | | |
|--|-----------------|-------|
| Collector-emitter voltage | V_{CE0} 50 | V |
| Emitter-Collector voltage | V_{EBO} 5 | V |
| Collector current | I_C 50 | mA |
| Collector peak current ($t = 1ms$) | I_{CM} 100 | mA |
| Storage and operating temperature | T -40 to +100 | °C |
| Max. permissible soldering temperature ($t \leq 5s$) | T_S 240 | °C |
| Power dissipation ($T_{amb} = 25^\circ C$) | P_{tot} 100 | mW |
| Derate above 25°C | 2.0 | mW/°C |

Characteristics ($T_{amb} = 25^\circ C$)

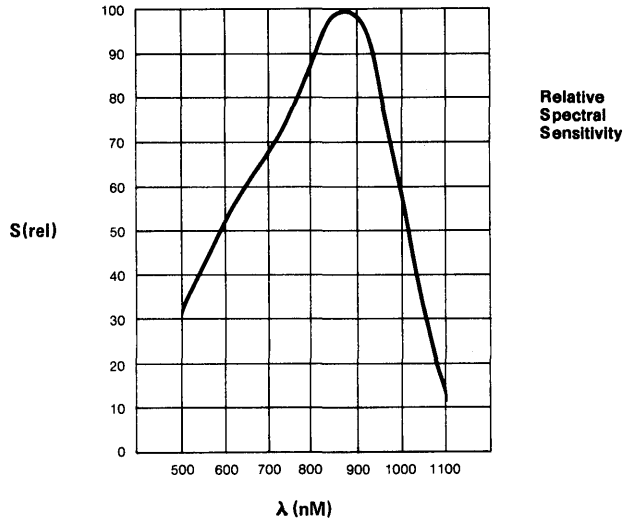
| | | |
|---|--------------------------|-----------------|
| Collector-emitter leakage current ($V_{CE} = 30V; E = 0$) | $I_{CEO} \leq 100$ | nA |
| Range of spectral sensitivity ($S = 0.1 S_{max}$) | 450-1080 | nm |
| Wavelength of the max. sensitivity | 870 | nm |
| Radiant sensitive area | A .187 | mm ² |
| Rise time to 90% of the final value | | |
| Fall time to 10% of the initial value | | |
| ($R_L = 1 k\Omega, I_{CE} = 1mA, V_{CE} = 5V$) | t_r, t_f 20 | μs |
| Acceptance half angle | φ 40 | degrees |
| Photo current ($V_{CE} = 5V, E_e = 0.5mW/cm^2$) | I_p 660 (≥ 100) | μA |

The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC 306-1).

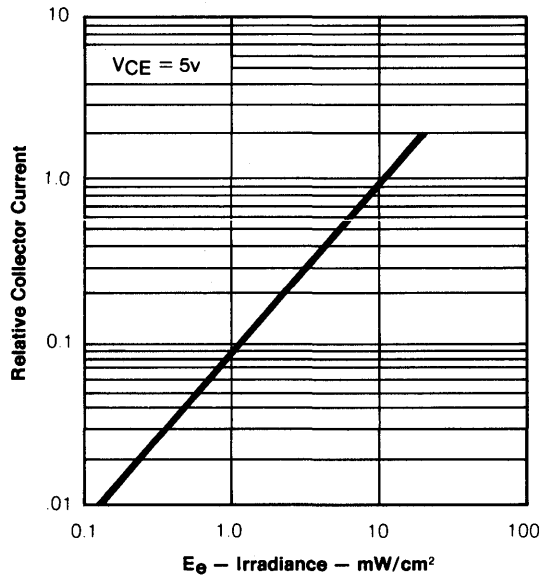
¹ measured with LED $\lambda = 950 nm$

Specifications are subject to change without notice.

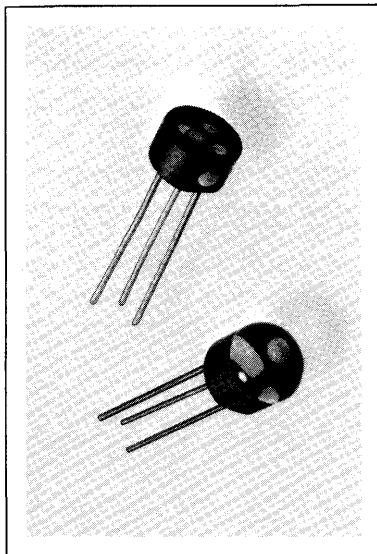
Relative Spectral Sensitivity



Relative Collector Current vs Irradiance



PHOTOTRANSISTOR



FEATURES

- Collector Dark Current 0.25 nA Typ
- Responsivity
 - 0.6 μ A/mW/cm² Min (Tungsten)
 - 1.8 μ A/mW/cm² Min (GaAs)
- Photo Current
 - 0.2 mA Min (Tungsten)
 - 0.6 mA Min (GaAs)
- Rise and Fall Time 2.8 μ s Typ

APPLICATIONS

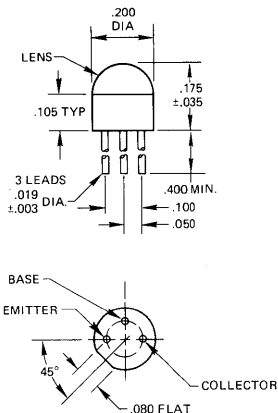
- Position Detector
- Intrusion Alarm Sensor
- Optical Tachometer

BENEFITS

- Flexible Circuit Design
 - Base Lead Availability
 - Large Range of Sensitivities
- Greater Power Dissipation – Ceramic Case
- Reliable – Exceptionally Stable Characteristics

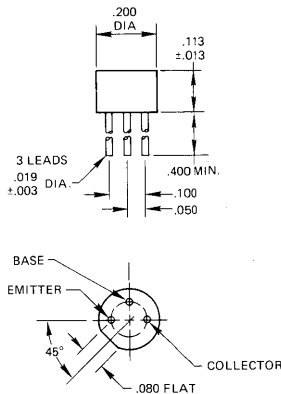
Package Dimensions (in inches)

LPT100/LPT100A/LPT100B



NOTE: ALL LEADS ELECTRICALLY ISOLATED FROM CASE

LPT110/LPT110A/LPT110B



NOTE 1: ALL LEADS ELECTRICALLY ISOLATED FROM CASE.
 NOTE 2: FLATNESS VARIATION OF TOP OF CUP IS $\pm .015$.
 NOTE 3: PHOTOSENSITIVE AREA IS WITHIN A .030 DIAMETER CIRCLE WITH CENTER OF CIRCLE COINCIDENT WITH THE CENTER OF PACKAGE.

Specifications are subject to change without notice.

MAXIMUM RATINGS

| | |
|---|-----------------|
| Maximum Temperatures/Humidity | |
| Storage Temperature | -55°C to +100°C |
| Operating Junction Temperature | -55°C to +85°C |
| Relative Humidity at Temperature | 98% at +65°C |
| Maximum Power Dissipation (Notes 1 and 2) | |
| Total Dissipation at +25°C Case Temperature | 200 mW |
| Total Dissipation at +25°C Ambient Temperature | 100 mW |
| Maximum Voltages (Note 5) | |
| BV _{CBO} Collector to Base Voltage | 50V |
| LV _{CEO} Collector to Emitter Sustaining Voltage | 30V |
| Maximum Current | |
| I _C Collector Current | 100 mA |

OPTO-ELECTRICAL CHARACTERISTICS (25°)

| Symbols | Parameter | LPT-100/A/B | | | LPT-110/A/B | | | Units | Test Conditions |
|---------------------------------|---|-------------|------|-----|-------------|------|-----|-----------------------|--|
| | | Min | Typ | Max | Min | Typ | Max | | |
| I _{CBO} | Collector Dark Current | 0.25 | 25 | | 0.25 | 25 | | nA | V _{CB} = 10V (Note 5) |
| I _{CBO} (65°C) | Collector Dark Current | 0.025 | 0.5 | | 0.025 | 0.5 | | μA | V _{CB} = 10V (Note 5) |
| I _{CEO} | Collector Dark Current | 2.0 | 100 | | 2.0 | 100 | | nA | V _{CE} = 5.0V (Note 5) |
| R _{CB} | Responsivity (Tungsten) | 0.6 | 1.6 | | 0.6 | 1.0 | | μA/mW/cm ² | V _{CB} = 10V (Notes 3 and 8) |
| R _{CB} | Responsivity (GaAs) | 1.8 | 4.8 | | 1.8 | 3.0 | | μA/mW/cm ² | V _{CB} = 10V (Notes 4 and 8) |
| I _{CE(L)} | Photo Current (Tungsten) | | | | | | | | $\left\{ \begin{array}{l} V_{CE} = 5.0V \\ H = 5.0 \text{ mW/cm}^2 \end{array} \right.$ (Notes 3 and 7) |
| | LPT-100 and LPT-110 | 0.2 | 1.4 | | 0.2 | 0.88 | | mA | |
| | "A" Only | 1.0 | | 3.0 | 0.6 | | 1.8 | mA | |
| | "B" Only | 1.3 | | 2.6 | 0.8 | | 1.6 | mA | |
| I _{CE(L)} | Photo Current (GaAs) | 0.6 | 4.2 | | 0.6 | 2.7 | | mA | V _{CE} = 5.0V H = 5.0 mW/cm ² (Notes 4 and 7) |
| t _r , τ _r | Light Current Rise Time | | 2.8 | | | 2.8 | | μs | (Note 6) |
| V _{CE(SAT)} | Collector to Emitter Saturation Voltage | | 0.16 | | | 0.16 | | V | I _C = 500μA H = 20 mW/cm ² |
| BV _{CBO} | Collector to Base Break-down Voltage | 50 | 120 | | 50 | 120 | | V | I _C = 100μA (Note 5) |
| LV _{CEO} | Collector to Emitter Sustaining Voltage | 30 | 50 | | 30 | 50 | | V | I _C = 1.0 mA (Note 5) |
| BV _{ECO} | Emitter to Collector Breakdown | | 7.0 | | | 7.0 | | V | I _{EC} = 100μA (Note 5) |

Note 1: These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Note 2: These ratings give a maximum junction temperature of +85°C and junction to case thermal resistance of +300°C/W (derating factor of 3.33 mW/°C) and a junction to ambient thermal resistance of +600°C/W (derating factor of 1.67 mW/°C).

Note 3: Measured at noted irradiance as emitted from a tungsten filament lamp at a color temperature of 2854°K.

Note 4: These are values obtained at noted irradiance as emitted from a GaAs source at 0.9μ.

Note 5: Measured with radiation flux intensity of less than 0.1μW/cm² over the spectrum from 100 to 1500 nm.

Note 6: Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: I_{CE} = 4.0 mA, V_{CE} = 5.0V, R_L = 100 Ohms, GaAs Source.

Note 7: No electrical connection to base lead.

Note 8: No electrical connection to emitter lead.

TYPICAL OPTO-ELECTRONIC CHARACTERISTICS

FIGURE 1. PHOTO CURRENT CHARACTERISTICS

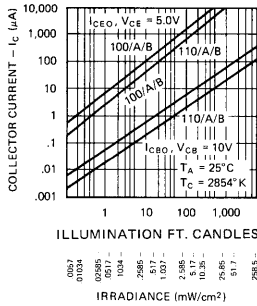


FIGURE 2. COLLECTOR CURRENT VS COLLECTOR VOLTAGE

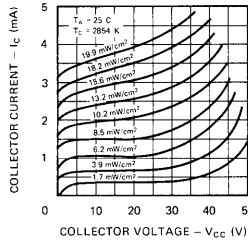


FIGURE 3. COLLECTOR BASE CHARACTERISTICS

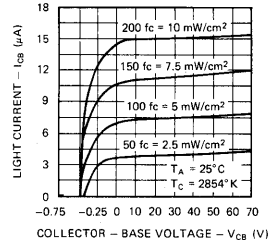


FIGURE 4. ANGULAR RESPONSE

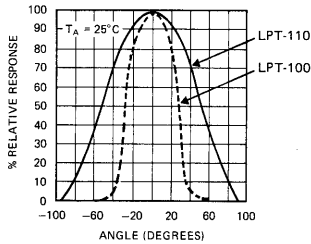


FIGURE 5. COLLECTOR DARK CURRENT VS TEMPERATURE

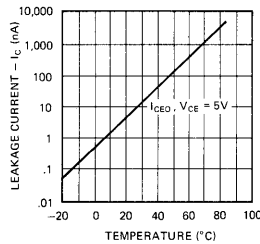


FIGURE 6. SPECTRAL CHARACTERISTICS

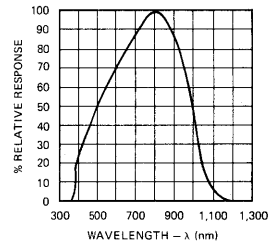


FIGURE 7. RISE AND FALL TIME VS COLLECTOR CURRENT (SHOWN IN FIGURE 10)

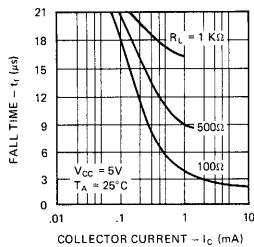


FIGURE 8. TURN-OFF DELAY TIMES FOR CURRENT (SHOWN IN FIGURE 11)

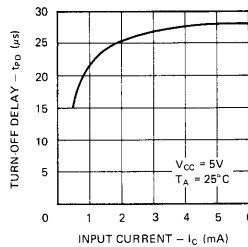
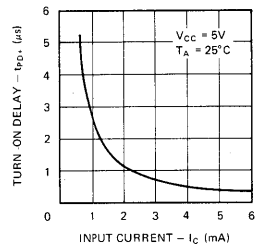


FIGURE 9. TURN-ON DELAY TIMES FOR CURRENT (SHOWN IN FIGURE 11)

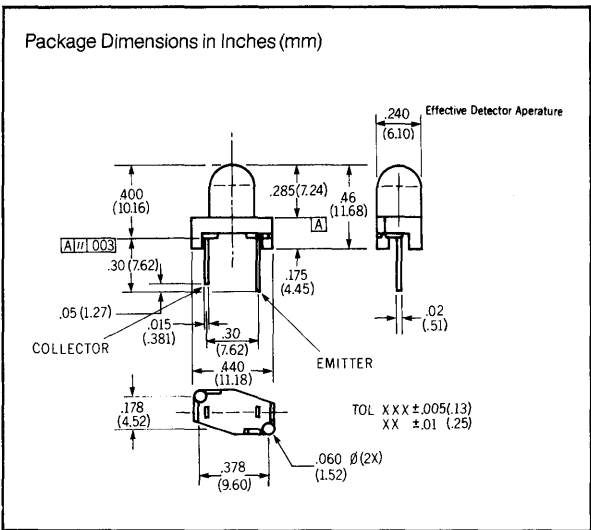
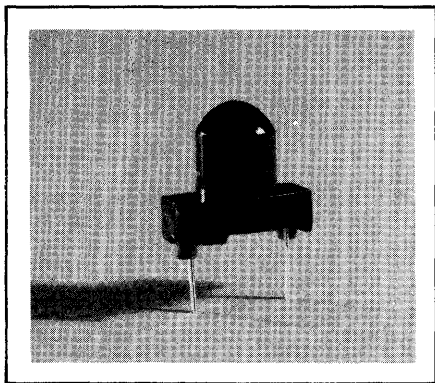


SIEMENS

LPT-500

PHOTOTRANSISTOR

Advance Data Sheet



FEATURES

- Extremely Accurate Mechanical to Optical Alignment
- Package Referenced for Users to Maintain Mechanical Alignment
- An Effective Active Area Aperture of .240 Diameter
- Extremely Narrow Acceptance Angle—Typically 2.5° Half-Angle
- Built-in Daylight Filter
- Peak Response at 880 nm
- Matches with IRL-500 Infrared Emitter

DESCRIPTION

The IPT-500 is an epitaxial NPN silicon phototransistor. The chip is mounted in a precision injection molded housing that guarantees a very accurate alignment tolerance, typically 2.5 degrees. Its detection angle matches with the IRL-500 infrared emitter of 5 degrees (2.5° half angle). The lens is opaque to visible and transparent to IR emission and thus receives efficiently IR light from the matching IRL-500.

Maximum Ratings

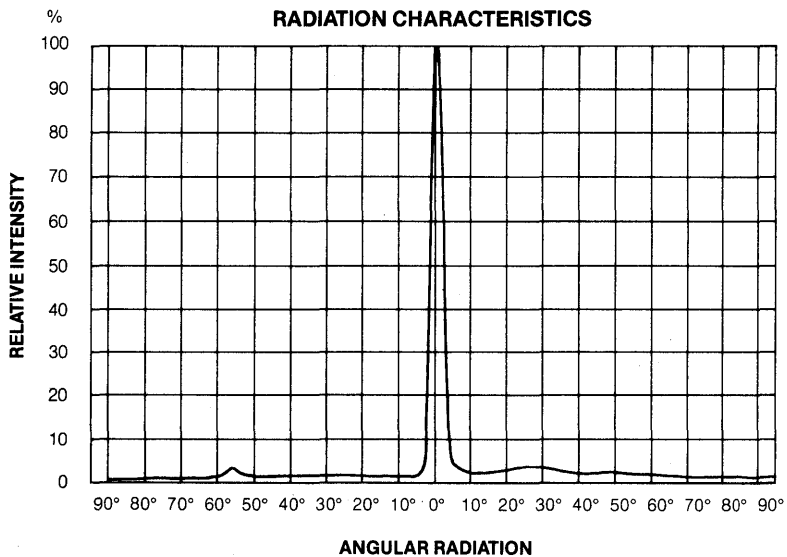
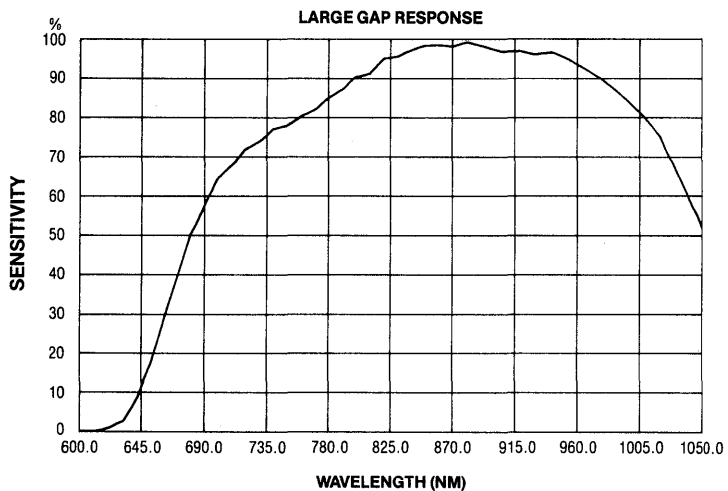
| | | | |
|---------------------------|-----------|--------------|----|
| Collector-Emitter Voltage | V_{CE0} | 30 | V |
| Emitter-Collector Voltage | V_{ECO} | 7 | V |
| Collector Current | I_C | 100 | mA |
| Junction Temperature | T_J | -55° to +85° | C |
| Storage Temperature | T_S | -20° to +70° | C |
| Power Dissipation @ 25°C | P_{TOT} | 100 | mW |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|--|---------------|-----|---------------|
| Spectral Sensitivity | λ | 880 | nm |
| Photocurrent* | $I_{CE(L)}$ | 20 | mA |
| $(V_{CE} = 5.0 \text{ V}, E_e = 0.5 \text{ mW/cm}^2)$ | | | |
| Risetime ($I_C = 4 \text{ mA}, V_{CE} = 5 \text{ V}, R_L = 1 \text{ K}\Omega$) | t_r | 2.8 | μS |
| Falltime ($I_C = 4 \text{ mA}, V_{CE} = 5 \text{ V}, R_L = 1 \text{ K}\Omega$) | t_f | 2.8 | μS |
| Collector-Emitter Saturation Voltage | $V_{CE(SAT)}$ | .26 | V |
| $(I_C = 2.0 \text{ mA}, H = 5 \text{ mW/cm}^2)$ | | | |
| Collector Dark Current ($V_{CE} = 5 \text{ V}$) | I_{CEO} | 2.0 | nA |

*Measured with tungsten filament bulb at 2856°K color temperature per IEC 306-1, DIN 3055, CIE Illuminant A.

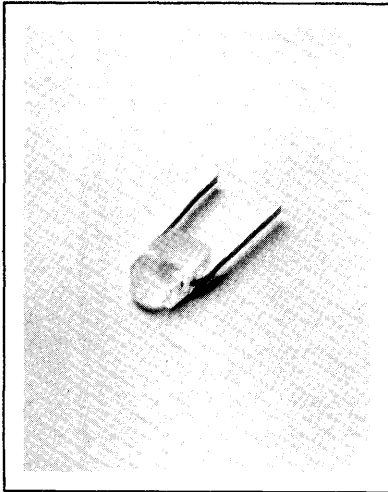
RELATIVE SPECTRAL SENSITIVITY VS WAVELENGTH



SIEMENS

SFH 305 SERIES

PHOTOTRANSISTOR



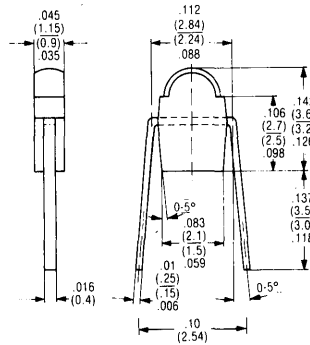
FEATURES

- Miniature Plastic Package
- 2.5 mm (1/10") Lead Spacing
- Detector for SFH 405 Infrared Emitter
- Designed for Maximum Spacing of 10 mm Between Emitter & Detector

DESCRIPTION

The SFH 305 is a NPN silicon planar photo transistor in clear plastic encapsulation with solder PIN terminals. The connectors in the form of solder tabs are spaced 2.54 mm (1/10 inch). The photo transistors are grouped according to photo sensitivity. The SFH 305 is suitable for use as detector for the infrared diode SFH 405 to effect miniature light barriers with close spacing between sender and receiver up to 10 mm maximum. Also, the SFH 305 is suitable for application with glow-lamp light, i.e. daylight. The collector is marked with a colored dot.

Package Dimensions in Inches (mm)



Maximum Ratings

| | | | |
|--|---------------|-----------|-----|
| Collector-emitter voltage | V_{CE0} | 32 | V |
| Junction temperature | T_j | 90 | °C |
| Collector current | I_C | 50 | mA |
| Storage temperature | T_S | -40...+80 | °C |
| Power dissipation ($T_{amb} = 25^\circ\text{C}$) | P_{tot} | 75 | mW |
| Max. soldering temperature ($t \leq 5$ s) | T_L | 230 | °C |
| Thermal resistance | | | |
| Collector junction to air | $R_{thJAamb}$ | 950 | K/W |
| Collector junction to case | R_{thJC} | 850 | K/W |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|------------------|-----------------|-----------------|
| Collector-emitter leakage current ($V_{CE} = 30$ V; $E = 0$) | I_{CE0} | 3 (≤ 20) | nA |
| Collector-emitter saturation voltage ($I_C = 500$ μ A; $I_B = 25$ μ A; $E = 0$) | V_{CEsat} | 0.2 | V |
| Range of spectral sensitivity ($S = 0.1$ S_{max}) | λ | 440...1070 | nm |
| Wavelength of the max. sensitivity | λ_{Smax} | 850 | nm |
| Radiant sensitive area | | | |
| Rise time to 90% of the final value | t_r | 5 (≤ 10) | μ s |
| Fall time to 10% of the initial value ($R_L = 1$ k Ω) ¹ | t_f | 0.17 | mm ² |
| Radiant sensitive area | A | | |
| Capacitance ($V_{CE} = 0$ V; $f = 1$ MHz; $E = 0$) | C_{CE} | 8 | pF |
| Half Angle | φ | 16 | Degrees |

¹ measured with LED $\lambda = 950$ nm

| Group | I ² | SFH 305-2 | SFH 305-3 | IV ² | |
|---|----------------|-------------|------------|-----------------|----|
| Photocurrent ($V_{CE} = 5$ V; $E_v = 1000$ lx) | I_p | 1.0 to 2.0 | 1.6 to 3.2 | | mA |
| Photocurrent ¹⁾ ($V_{CE} = 5$ V; $E_p = 0.5$ mW/cm ²) | I_p | 0.25 to 0.5 | 0.4 to 0.8 | | mA |

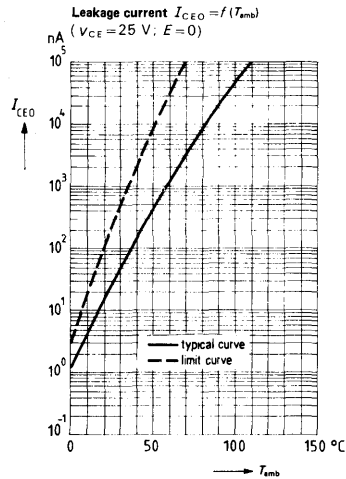
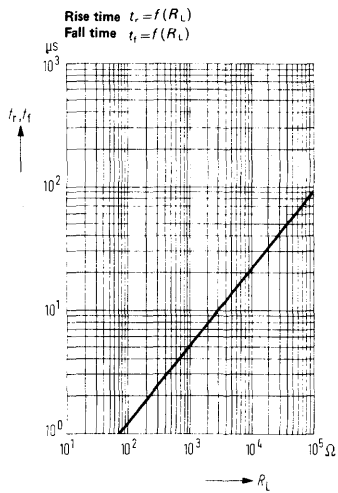
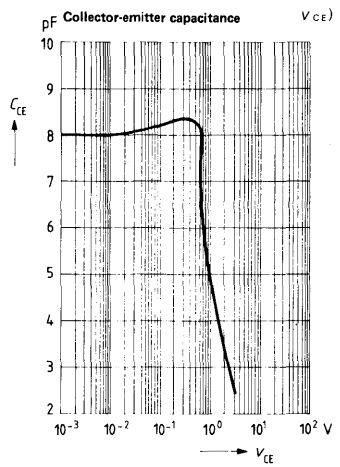
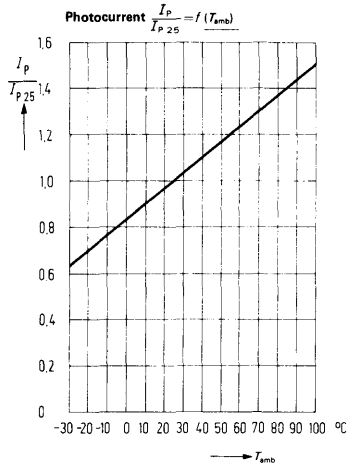
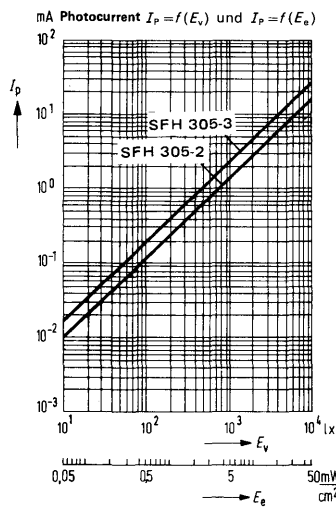
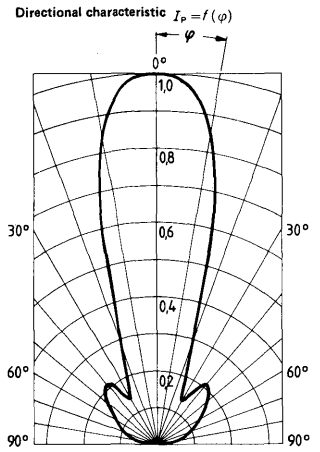
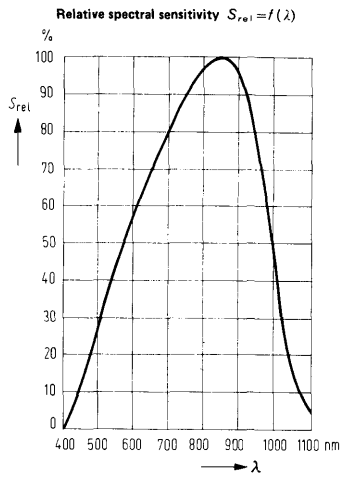
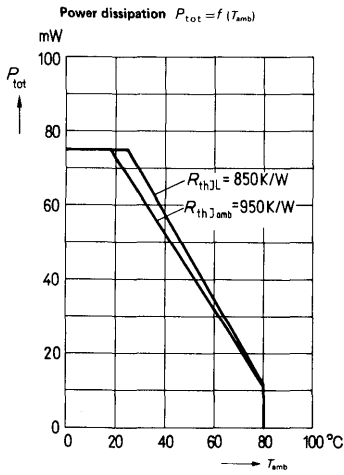
The illuminances refer to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K. (Standard light A in accordance with DIN 5033 and IEC 306-1).

Irradiance E_p measured with HP radiant flux meter 8334A with option 013.

¹⁾ Measured with LED $\lambda = 950$ nm:

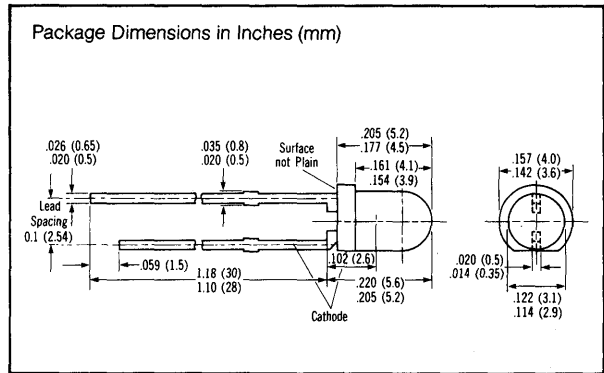
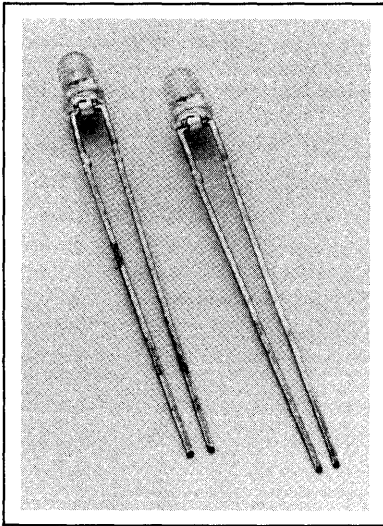
²⁾ In preparation.

Specifications are subject to change without notice.



SIEMENS

SFH 309 T1 SILICON PHOTOTRANSISTOR



Maximum Ratings

| | | |
|------------------------------------|---------------------|--------------------------|
| Storage temperature | T _{stg} | - 55 to + 100 °C |
| Soldering temperature | | |
| Distance from casing-solder tab | ≥ 2mm | |
| Dip soldering, time | ≤ 5s | T _{sold} 260 °C |
| Iron soldering, time | ≤ 3s | T _{sold} 300 °C |
| Collector - emitter voltage | V _{CE0} | 35 V |
| Collector current | I _C | 75 mA |
| Collector peak current (τ < 10 μs) | I _{C peak} | 200 mA |
| Power dissipation | P _{tot} | 165 mW |
| Thermal resistance | R _{th JA} | 450 K/W |

Characteristics (T_{amb} = 25 °C)

| | | |
|--|---------------------------------|-----------------------|
| Wavelength at the max. photo sensitivity | λ _{S max} | 875 nm |
| Range of spectral photo sensitivity | λ | 420...1125 nm |
| S = 10% of S _{max} | A | 0,038 mm ² |
| Radiant sensitive area | φ | 0,220 mm |
| Dimensions at radiant sensitive area | H | 2,6 mm |
| Distance chip surface to leadframe stand-off | φ | 20 degrees |
| Half angle | | |
| Photo current of collector-base photo diode | I _{PCB} | 11,3 μA |
| (E _v = 1000 lx; V _{CE} = 5V) | | |
| (E _e = 0,5 mW/cm ² ; λ = 950 nm; V _{CE} = 5V) | I _{PCB} | 3 μA |
| Capacitance | C _{CE} | 5,3 pF |
| (V _{CE} = 0V; f = 1 MHz; E = 0 lux) | C _{CB} | 7,2 pF |
| (V _{CB} = 0V; f = 1 MHz; E = 0 lux) | | |
| Photo current | I _p | (≥ 1) typ. 5 mA |
| (E _v = 1000 lux; V _{CE} = 5V) | I _p | (≥ 0,25) typ. 1.3 mA |
| (E _e = 0,5 mW/cm ² ; λ = 950 nm; V _{CE} = 5V) | | |
| Rise time/fall time | t _r , t _f | 25 μs |
| (I _e = 1 mA; V _{CE} = 5V; R _L = 1 Kohm) | | |
| Collector-emitter saturation voltage | V _{CE sat} | 200 mV |
| (I _C = 2 mA; I _B = 50 μA; E = 0 lx) | | |
| Current gain | I _{PCB} | typ. 400-600 |
| (E _v = 1000 lux; V _{CE} = 5V) | I _{PCB} | |
| (E _e = 0,5 mW/cm ² ; λ = 950 nm; V _{CE} = 5V) | | |
| Collector-emitter reverse current | I _{CEO} | 60(≤ 200) nA |
| (V _{CE0} = 25V; E = 0 lx) | | |

Specifications subject to change without notice

FEATURES

- High Reliability
- 3 mm (T1) Size Package
- .10 Inch (2.54 mm) Lead Spacing
- Low Cost
- High Radiant Intensity
- Good Linearity
- Matches with SFH-409 Infrared Emitter

DESCRIPTION

The SFH-309 is a silicon NPN phototransistor in a standard T1 size plastic package. It is designed for a variety of low cost, high volume applications such as IR remote control and other consumer and entertainment products.

Relative spectral sensitivity
 $S_{rel} = f(\lambda)$

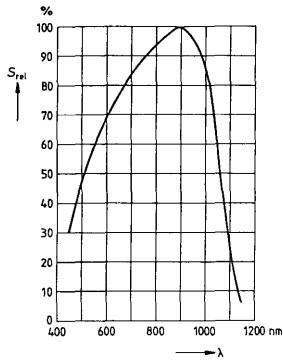
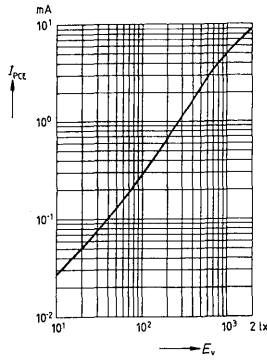
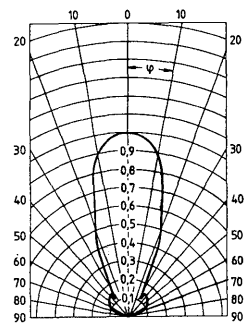


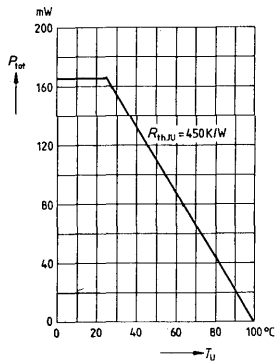
Photo current
 $I_{PCE} = f(E_v)$
 $(V_{CE} = 5 V)$



Directional characteristic
 $I_p = f(\varphi)$



Power dissipation
 $P_{tot} = f(T_{amb})$



Dark current
 $I_{CEO} = f(V_{CE})$

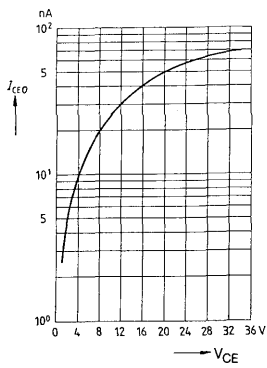


Photo current
 $I_{PCE} = f(V_{CE})$

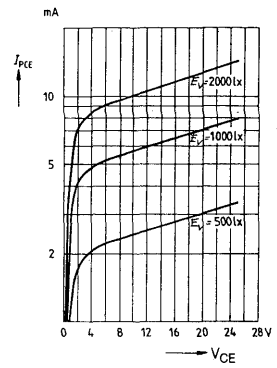
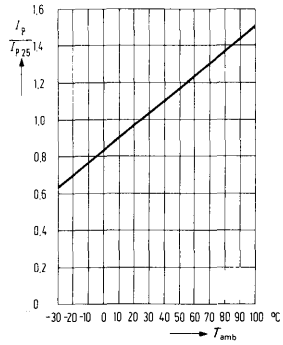
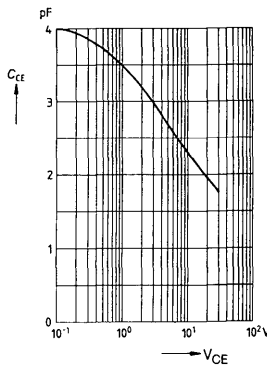


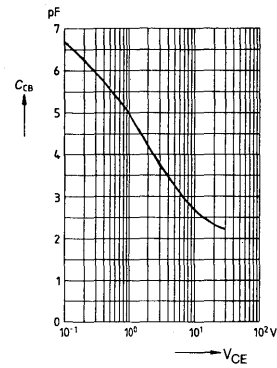
Photo current
 $\frac{I_p}{I_{p25}} = f(T_{amb})$



Collector emitter capacitance
 $C_{CE} = f(V_{CE})$



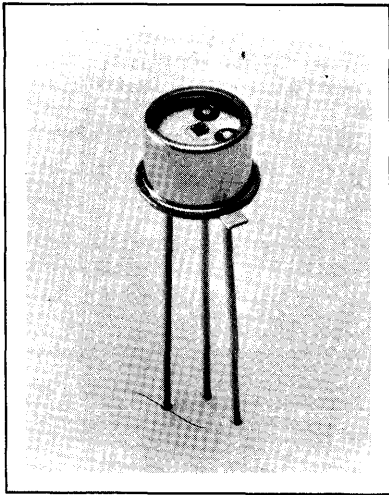
Collector-base capacitance
 $C_{CB} = f(V_{CE})$



SIEMENS

SFH 500

PHOTO TRANSISTOR



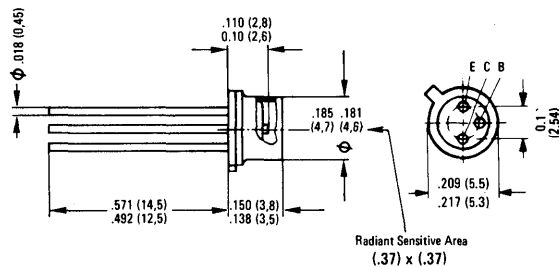
FEATURES

- TO-18 Package
- Flat Glass Lens
- Fast Speed, 2 MHz

DESCRIPTION

SFH 500 is a fast NPN silicon planar photodetector with a frequency to 2 MHz and a wide range of modulation from 10^2 to 10^4 LUX. The chip is mounted in a TO-18 package with flat glass lens window. The photodetector is especially suitable for light wave conductor application through the small cap body (up to 2 Mbits/s). Also suitable for industrial electronics and in camera applications where a wider sensitivity range is necessary. The case is electrically connected to the collector.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

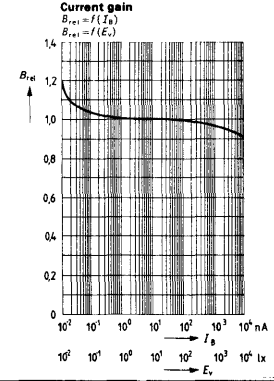
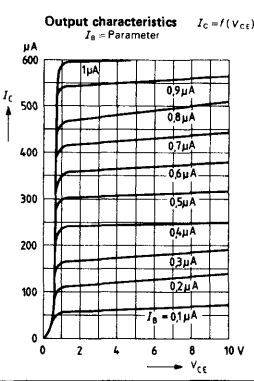
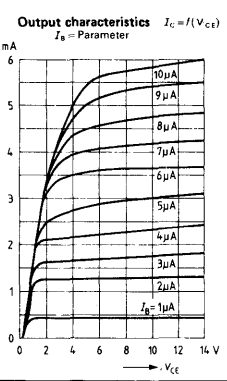
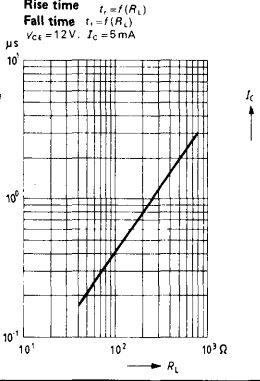
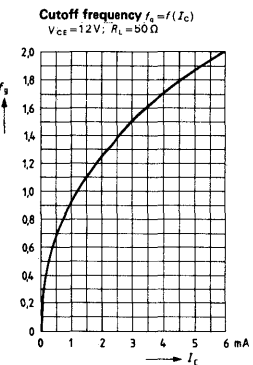
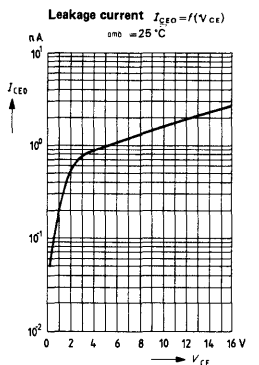
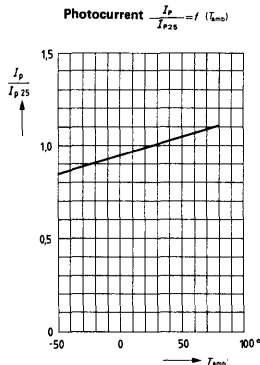
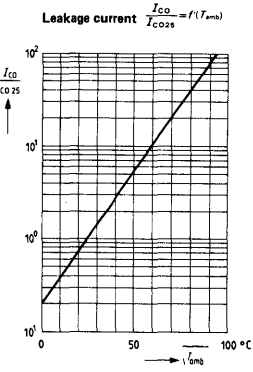
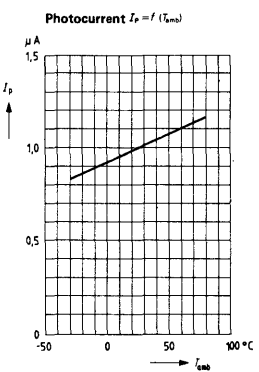
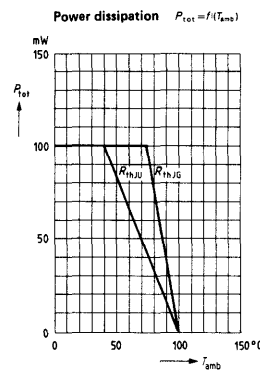
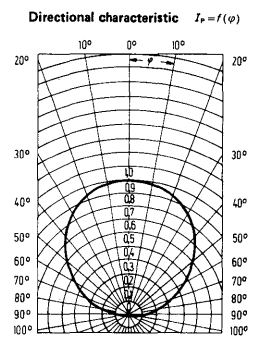
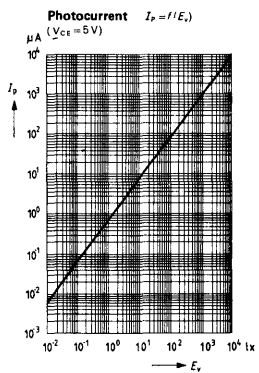
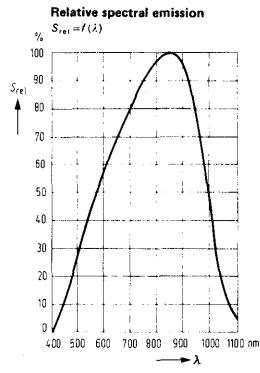
| | | | |
|--|---------------|------------|--------------------|
| Collector-emitter voltage | V_{CE0} | 15 | V |
| Emitter-base voltage | V_{EB0} | 7 | V |
| Collector current | I_C | 20 | mA |
| Junction temperature | T_j | 100 | $^{\circ}\text{C}$ |
| Storage temperature | T_s | -55...+100 | $^{\circ}\text{C}$ |
| Max. soldering temperature ($t \leq 5$ s) | T_L | 260 | $^{\circ}\text{C}$ |
| Power dissipation ($T_{amb} = 25^{\circ}\text{C}$) | P_{tot} | 100 | mW |
| Thermal resistance | | | |
| Collector junction to air | R_{thJamb} | 600 | K/W |
| Collector junction to case | $R_{thJcase}$ | 250 | K/W |

Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| | | | |
|--|------------------|--------------------|--|
| Photocurrent ($V_{CE} = 5$ V; $E_s = 1000$ lx) ¹ ($V_{CE} = 5$ V; $E_s = 0.5$ mW/cm ²) ² | I_p | 700 (≥ 450) | μA |
| | I_p | 185 | μA |
| Wavelength of the max. sensitivity | λ_{Smax} | 825 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850$ nm) | η | 0.84 | $\frac{\text{Electrons}}{\text{Photon}}$ |
| Spectral sensitivity ($\lambda = 850$ nm) | S_λ | 0.56 | A/W |
| Collector-emitter leakage current ($V_{CE} = 10$ V; $E = 0$) | I_{CE0} | 20 (≤ 50) | nA |
| Collector-emitter saturation voltage ($I_C = 500$ μA ; $I_B = 25$ μA ; $E = 0$) | V_{CEsat} | 0.8 (≤ 1.2) | V |
| Range of spectral sensitivity ($S = 0.1$ S _{max}) | λ | 420...1100 | nm |
| Typ. spectral sensitivity of the collector base photodiode | S | 1.17 | nA/lx |
| Radiant sensitive area | A | 0.14 | mm ² |
| Rise and fall time of the photocurrent | | | |
| Rise time to 90% of the final value | t_r ; t_f | 0.25 | μs |
| Fall time to 10% of the initial value ($V_{CE} = 12$ V; $I_C = 5$ mA; $R_L = 50$ Ohm) | | | |
| Capacitance | | | |
| ($V_{CE} = 5$ V; $f = 1$ MHz; $E = 0$) | C_{CE} | 2.7 | pF |
| ($V_{CB} = 5$ V; $f = 1$ MHz; $E = 0$) | C_{CB} | 5.6 | pF |
| Cut-off frequency | | | |
| ($R_L = 50$ Ω ; $V = 12$ V; $I = 5$ mA) | f_c | 2 | MHz |
| Current gain ($V_{CE} = 5$ V; $I_C = 0.1$ mA) | β | 600 | - |

¹ I_p (CE) = Photocurrent of the phototransistor
² I_p (CB) = Photocurrent of the collector-base photodiode

Specifications are subject to change without notice.

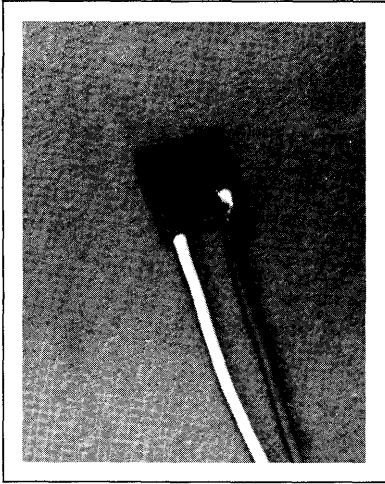


Photovoltaic Cells

| Package Type | Package Outline | Part Number | Half Angle | Sensitivity s(A/lx) Typical | Dark Current $I_D = I_D$; $E = 0$ I_R (μ A) | Radiant Sensitive Area cm^2 | Peak Wavelength | Capacitance ($V_R = 0V$; $E = 0$) C_O nF | Page |
|------------------------------------|-----------------|-------------|------------|-----------------------------------|--|-------------------------------------|--------------------|--|------|
| Chip with Leads Encapsulated | | TP60 | 60° | 1.0 | 25 | 1.5 cm^2 | 850 | 16 | 418 |
| Chip with Leads | | TP61 | 60° | 1.0 | 25 | | | | |
| Chip with Leads | | BPY64P | 60° | .25 | 4 | .32 cm^2 | | 3 | 416 |
| Chip with Leads | | BPX79 | 60° | 135 nA/lx | 0.3(<50) | 20 | 800 | 2500pF | 412 |
| Chip with Leads | | BPY11P-4 | 60° | 47-63 | 1(<10) | 7 | 850 | 8 | 414 |
| | | BPY11P-5 | | 56-75 | | | | | |
| | | BPY11P-6 | | >71 | | | | | |

SIEMENS

BPX 79 PHOTOVOLTAIC CELL



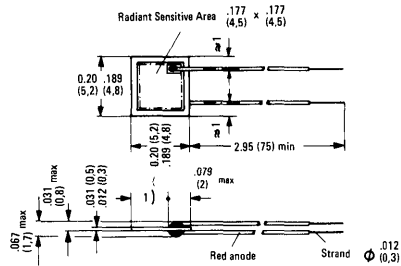
FEATURES

- Silicon Planar Photovoltaic Cell
- Medium Size Radiation Sensitive Surface
- High Sensitivity, 0.1 $\mu\text{A/lx}$ (min)

DESCRIPTION

The BPX 79 is a silicon planar photovoltaic cell. The increased sensitivity with shorter wavelengths makes it particularly suitable for applications with light sources having a high share of blue. The planar method ensures a low reverse current level and low noise. The photovoltaic cell is nitride-passivated and has an anti-reflection coating for a wavelength of $\lambda = 450 \text{ nm}$.

Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

Maximum Ratings

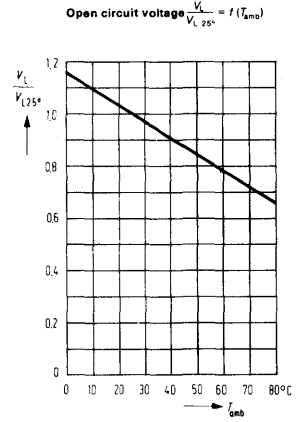
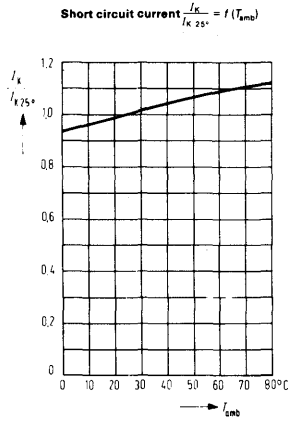
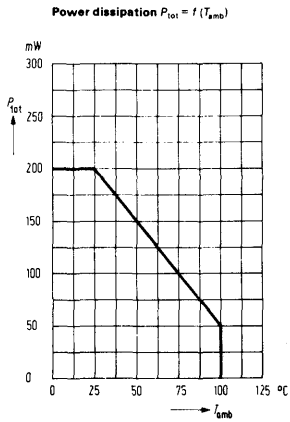
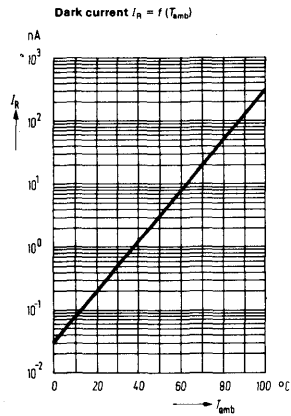
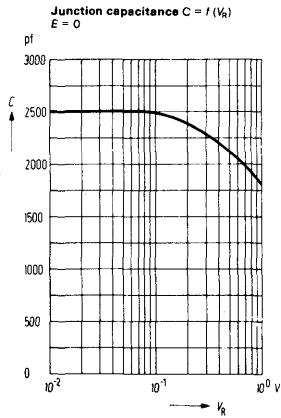
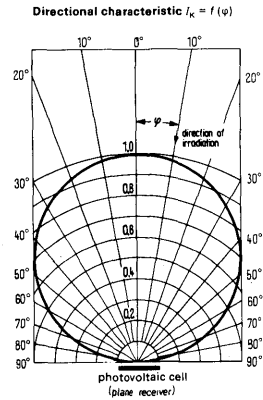
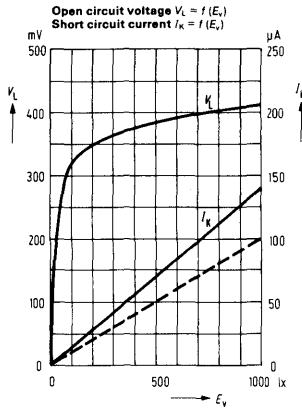
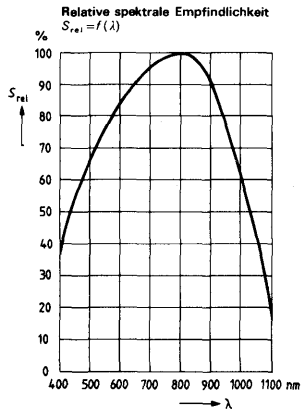
| | | | |
|---|-----------|---------------|--------------------|
| Reverse voltage | V_R | 1 | V |
| Storage temperature and operating temperature | T_{amb} | - 55 to + 100 | $^{\circ}\text{C}$ |

Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| | | | |
|---|---------------------------|-----------------------|---------------------|
| Spectral sensitivity ¹⁾ | S | 135 (≈ 100) | nA/lx |
| Open circuit voltage ($E_v = 100 \text{ lx}$) ¹⁾ | V_L | 320 (≈ 220) | mV |
| Open circuit voltage ($E_v = 1000 \text{ lx}$) ¹⁾ | V_L | 410 (≈ 310) | mV |
| Wavelength of the max. sensitivity | $\lambda_{S \text{ max}}$ | 800 | nm |
| Quantum yield | η | 0.73 | Electrons Photon |
| (Electrons per photon) ($\lambda = 800 \text{ nm}$) | S | 0.47 | A/W |
| Spectral sensitivity ($\lambda = 800 \text{ nm}$) | | | |
| Rise and fall time of the photocurrent from 10% to 90% and from 90% to 10% of the final value | $t_r; t_f$ | 6 | μs |
| ($R_L = 1 \text{ k}\Omega$; $V_R = 1 \text{ V}$; $\lambda = 950 \text{ nm}$) | $t_r; t_f$ | 10 | μs |
| ($R_L = 1 \text{ k}\Omega$; $V_R = 0 \text{ V}$; $\lambda = 950 \text{ nm}$) | | | |
| Capacitances | C_0 | 2500 | pF |
| ($V_R = 0 \text{ V}$) | C_1 | 1800 | pF |
| ($V_R = 1 \text{ V}$) | A | 20 | mm^2 |
| Radiant sensitive area | I_R | 0.3 (≤ 50) | μA |
| Dark current ($V_R = 1 \text{ V}$; $E = 0$) | TC | - 2.6 | mV/K |
| Temperature coefficient of V_L | TC | 0.2 | %/K |
| Temperature coefficient of I_K | | | |

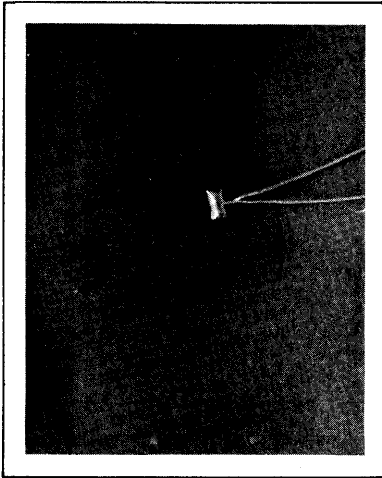
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 508-1).

Specifications are subject to change without notice.



SIEMENS

BPY 11 P SERIES SILICON PHOTOVOLTAIC CELL



FEATURES

- Small Package
- May Be Stacked Tightly Together
- Choice of 3 Sensitivity Groups
- Fast Response Time

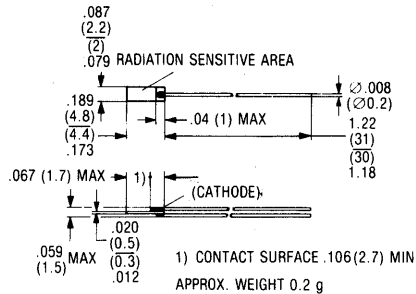
DESCRIPTION

BPY 11 P is a photovoltaic cell, fabricated with planar technology.

The silicon photovoltaic cell is suitable for use in control and drive circuits, for light pulse scanning, and for quantitative light measurements. Its rapid response, small dimensions, and high permissible operating temperature make universal application feasible.

Since this cell is not encased, the assembly of high efficient scanning systems can be realized. For this purpose the cells may be cemented closely together on suitable mounting assemblies.

Package Dimensions in Inches (mm)



Maximum Ratings

| | | | |
|--|-----------|------------|----|
| Ambient temperature | T_{amb} | -55 to 100 | °C |
| Reverse voltage (positive pole to cathode) | V_R | 1 | V |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

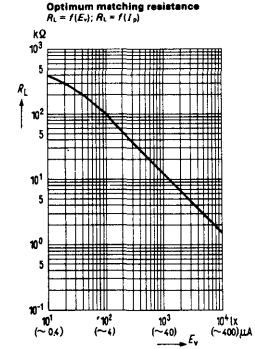
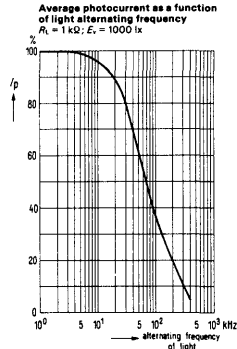
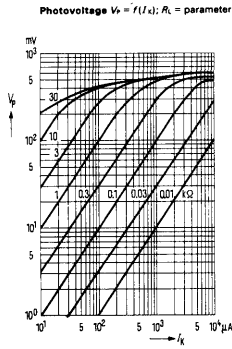
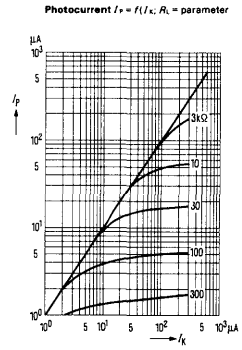
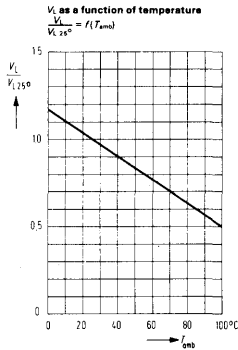
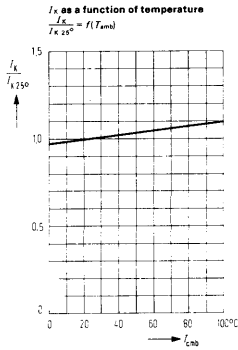
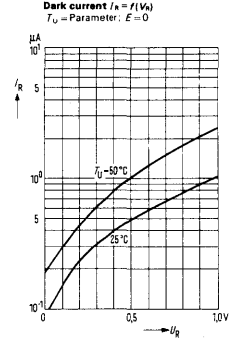
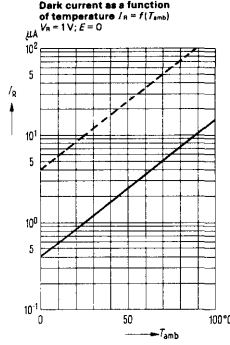
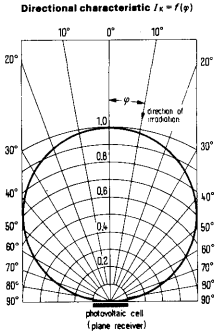
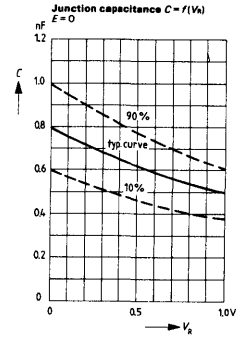
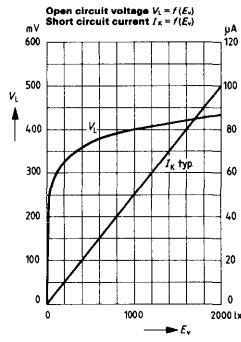
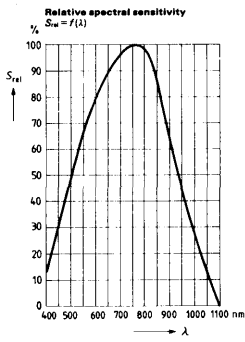
| | | | |
|---|--------------------|-----------------------|------------------|
| Spectral sensitivity ¹⁾ | S | 50 (≈ 28) | nA/lx |
| Wavelength of the max. sensitivity | $\lambda_{S \max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850 \text{ nm}$) | η | 0.80 | Electrons/Photon |
| Spectral sensitivity ($\lambda = 850 \text{ nm}$) | S | 0.55 | A/W |
| Open circuit voltage ($E_v = 100 \text{ lx}$) ¹⁾ | V_o | 310 (≈ 180) | mV |
| Open circuit voltage ($E_v = 1000 \text{ lx}$) ¹⁾ | V_o | 410 (≈ 260) | mV |
| Short circuit current ($E_v = 1000 \text{ lx}$) ¹⁾ | I_K | 50 | μA |
| Rise time (for 60% of I_K) | t_r | 4 | μs |
| Cut-off frequency (load resistance $R_L = 1 \text{ k}\Omega$) | f_g | 55 | kHz |
| Temperature coefficient of V_o (see diagram) | TC | -2.6 | mV/K |
| Temperature coefficient of I_K (see diagram) | TC | 0.12 | %/K |
| Capacitance ($V_R = 0 \text{ V}$; $E = 0$) | C_0 | 0.8 | nF |
| Radiant sensitive area | A | 7 | mm^2 |
| Dark current ($V_R = 1 \text{ V}$; $E = 0$) | I_R | 1 (≤ 10) | μA |
| Dark current ($V_R = 1 \text{ V}$; $T_{amb} = 50^\circ\text{C}$; $E = 0$) | I_R | 2.5 | μA |

Spectral Sensitivity Groups

| Type | Short circuit current I_K (μA) $E_v = 100 \text{ lx}$ ¹⁾ | Color code |
|-----------|--|------------|
| BPY 11P-4 | 4.7 to 6.3 | yellow |
| BPY 11P-5 | 5.6 to 7.5 | green |
| BPY 11P-6 | ≥ 7.1 | blue |

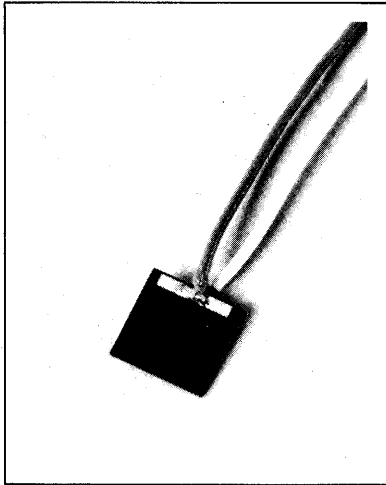
¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC pub. 306-1).

Specifications subject to change without notice.



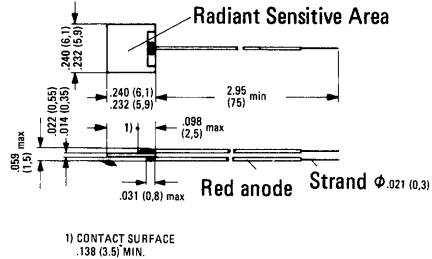
SIEMENS

BPY 64P PHOTOVOLTAIC CELL



Supercedes BPY 64

Package Dimensions in Inches (mm)



Maximum Ratings

| | | | |
|-------------------------------|-----------|---------------|----|
| Reverse voltage ¹⁾ | V_R | 1 | V |
| Temperature range | T_{amb} | - 55 to + 100 | °C |

Characteristics ($T_{amb} = 25^\circ\text{C}$)

| | | | |
|---|-------------------------|----------------------|---------------------|
| Spectral sensitivity ¹⁾ (Short circuit current I_{sc}) | S | 0.25 (≥ 0.18) | $\mu\text{A/lx}$ |
| Wavelength of the max. sensitivity | $\lambda_{S\text{max}}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850\text{ nm}$) | η | 0.80 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850\text{ nm}$) | S | 0.55 | A/W |
| Open circuit voltage ($E_v = 10000\text{ lx}$) ¹⁾ | V_L | ≥ 450 | mV |
| ($E_v = 1000\text{ lx}$) ¹⁾ | V_L | 410 (≥ 280) | mV |
| ($E_v = 100\text{ lx}$) ¹⁾ | V_L | 300 (≥ 150) | mV |
| Radiant sensitive area | A | approx. 0.32 | cm^2 |
| Temperature coefficient of V_L (see diagram) | TC | - 2.6 | mV/K |
| Temperature coefficient of I_{sc} (see diagram) | TC | 0.2 | %/K |
| Capacitance ($V_R = 0\text{ V}; E = 0$) | C_D | 3 | nF |
| Dark current ($V_R = 1\text{ V}; E = 0$) | I_R | 4 | μA |
| Dark current ($V_R = 1\text{ V}; T_{amb} = 50^\circ\text{C}; E = 0$) | I_R | 10 | μA |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a colour temperature of 2856 K (standard light A in accordance with DIN 5033 and IEC publ. 306-1).

FEATURES

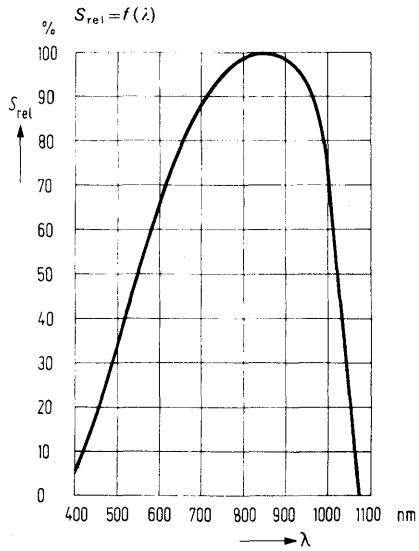
- Silicon Photovoltaic Cell
- Medium Size Radiation Sensitive Surface
- High Sensitivity, 0.18 $\mu\text{A/lx}$

DESCRIPTION

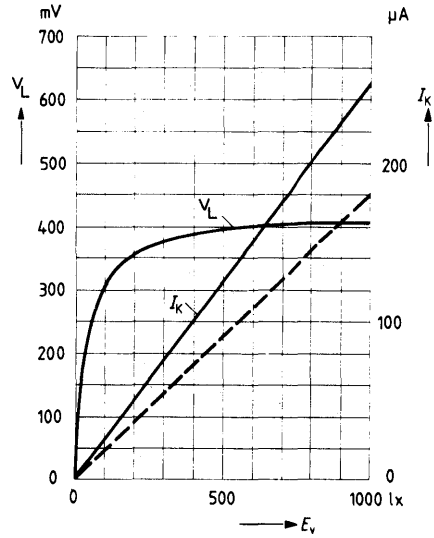
The BPY 64P is suitable for versatile applications in control and drive circuits. It can be used, like all silicon photovoltaic cells, as detector for light of filament lamps or day-light.

For mounting instructions see photovoltaic cell application note.

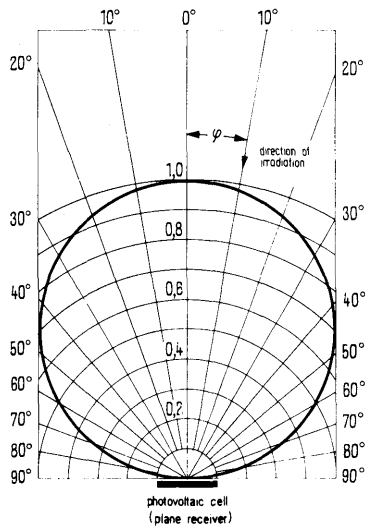
Relative spectral sensitivity



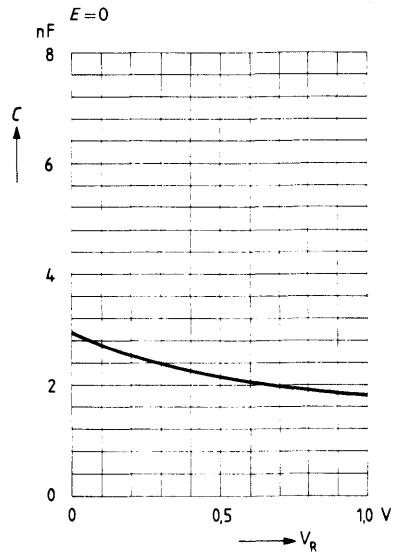
Open circuit voltage $V_L = f(E_v)$
Short circuit current $I_K = f(E_v)$



Directional characteristic $I_K = f(\varphi)$

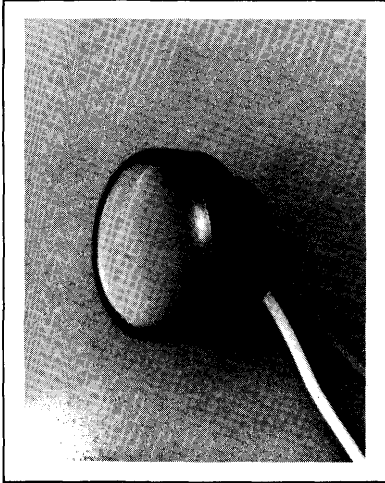


Capacitance $C = f(V_R)$

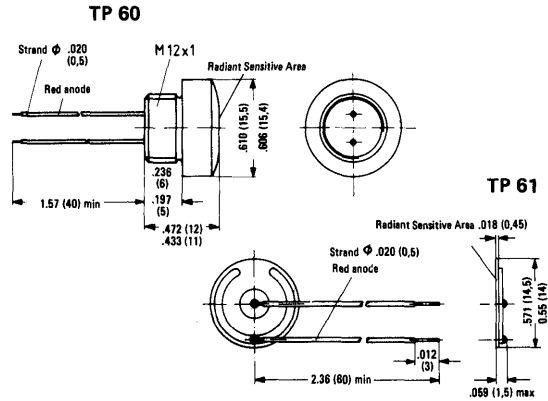


SIEMENS

TP 60, TP 61 SILICON PHOTOVOLTAIC CELLS



Package Dimensions



Dimensions inside parenthesis are in mm
Dimensions outside parenthesis are in inches

FEATURES

- Silicon Photovoltaic Cell
- Stud Package, TP 60
- Wide Temperature Range, -55° to $+100^{\circ}$, TP 61
- Very High Sensitivity, $.7 \mu\text{A}/\text{lx Min}$

DESCRIPTION

The silicon photovoltaic cells TP 60 and TP 61 are suitable for use in drive and control circuits. Featuring the same electrical characteristics, they differ only in design. The anode (positive pole of the cell) is marked by a red lead.

For mounting instructions see photovoltaic cell application note.

Maximum Ratings

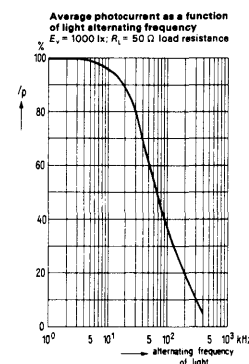
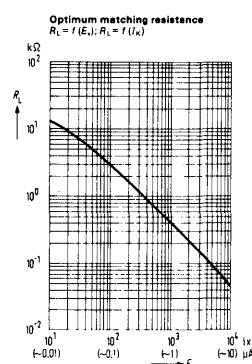
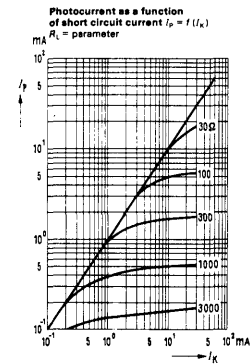
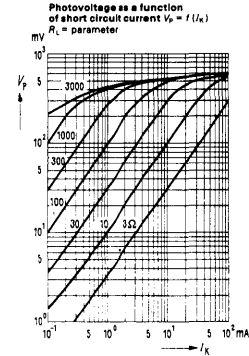
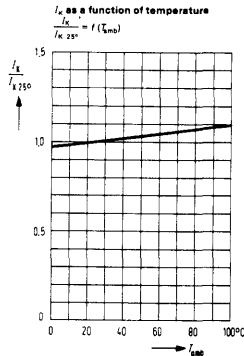
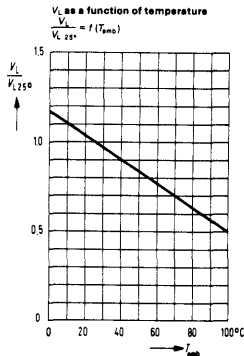
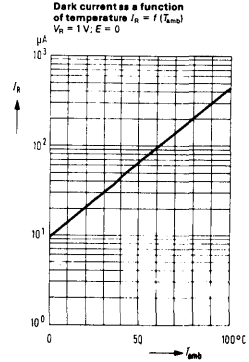
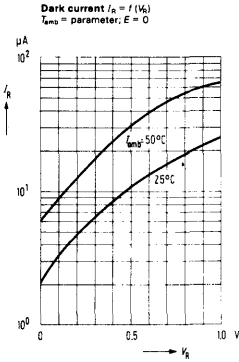
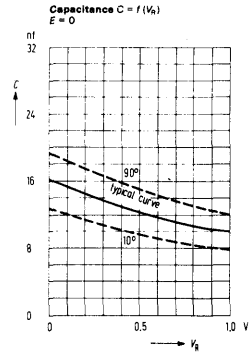
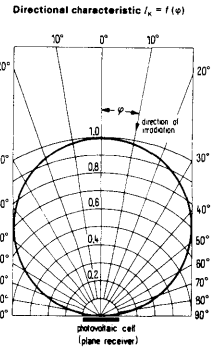
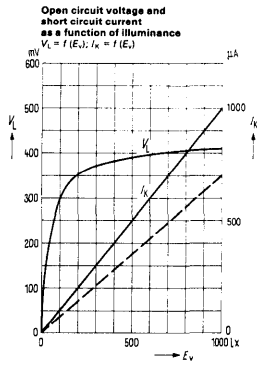
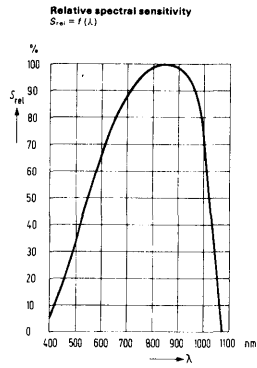
| | TP 60 | TP 61 | |
|---|-------------------------------|---------------|--------------------|
| Operating and storage temperature range | T_{amb} - 25 to + 75 | - 55 to + 100 | $^{\circ}\text{C}$ |
| Reverse voltage ¹⁾ | V_R 1.0 | 1.0 | V |

Characteristics ($T_{\text{amb}} = 25^{\circ}\text{C}$)

| | | | |
|--|-------------------------|--|-------------------------|
| Spectral sensitivity ¹⁾ (Short circuit current I_K) | S | 1 (≥ 0.7) | $\mu\text{A}/\text{lx}$ |
| Wavelength of the max. sensitivity | $\lambda_S \text{ max}$ | 850 | nm |
| Quantum yield (Electrons per photon) ($\lambda = 850 \text{ nm}$) | η | 0.80 | Electrons Photon |
| Spectral sensitivity ($\lambda = 850 \text{ nm}$) | S | 0.55 | A/W |
| Open circuit voltage ($E_V = 10\,000 \text{ lx}$) ¹⁾ ($E_V = 1000 \text{ lx}$) ¹⁾ ($E_V = 100 \text{ lx}$) ¹⁾ | V_L | ≥ 440 410 (≥ 270) 300 (≥ 140) | mV mV mA |
| Short circuit current ($E_V = 10\,000 \text{ lx}$) ¹⁾ ($E_V = 1000 \text{ lx}$) ¹⁾ | I_K | ≥ 7 ≥ 0.7 | mA mA |
| Infrared response limit | λ_g | 1.100 | nm |
| Radiant sensitive area | A | 1.5 | cm^2 |
| Tolerance of the radiant sensitive area | A tol | ± 0.1 | cm^2 |
| Temperature coefficient of V_L (see diagram) | TC | - 2.8 | mV/K |
| Temperature coefficient of I_K (see diagram) | TC | 0.12 | %/K |
| Capacitance ($V_R = 0 \text{ V}; E = 0$) | C_0 | 16 | nF |
| Dark current ($V_R = 1 \text{ V}; E = 0$) | I_R | 25 | μA |
| Dark current ($V_R = 1 \text{ V}; T_{\text{amb}} = 50^{\circ}\text{C}; E = 0$) | I_R | 65 | μA |

¹⁾ The illuminance indicated refers to unfiltered radiation of a tungsten filament lamp at a color temperature of 2856 K (standard light A) in accordance with DIN 5033 and IEC publ. 308-1).

Specifications are subject to change without notice.



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LED'S & PHOTOMETRY

by George Smith

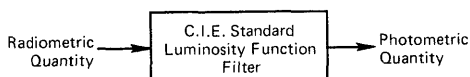
The observed spectrum of electromagnetic radiations, extends from a few Hz, to beyond 10^{24} Hz, covering some 80 octaves. The narrow channel from 430 THz to 750 THz would be entirely negligible, except for the fact that more information is communicated to human beings, in this channel, than is obtained from the rest of the spectrum. This radiation has a wavelength ranging from 400nm to 700nm, and is detectable by the sensory mechanisms of the human eye. Radiation observable by the human eye is commonly called light.

Measurements of the physical properties of light and light sources, can be described in the same terms as any other form of electromagnetic energy. Such measurements are commonly called Radiometric Measurements.

Measurements of the psychophysical attributes of the electromagnetic radiation we call light, are made in terms of units, other than these radiometric units. Those attributes which relate to the luminosity (sometimes called visibility) of light and light sources, are called photometric quantities, and the measurement of these aspects is the subject of Photometry.

The electronics engineer who is starting to apply light emitting diodes and other opto-electronic devices to perform useful tasks, will find the subject of photometry to be a confused mass of strange units, confusing names for photometric quantities, and general disagreement as to what the important requirements are for his application.

The photometric quantities are related to the corresponding radiometric quantities by the C.I.E. Standard Luminosity Function (Fig. 1), which we may colloquially refer to as the standard eyeball. We can think of the luminosity function, as the transfer function of a filter which approximates the behavior of the average human eye under good lighting conditions.



The eye responds to the rate at which radiant energy falls on the retina, i.e., on the radiant flux density expressed as Watts/m². The corresponding photometric quantity is Lumens/m². The standard luminosity function is then, a plot of Lumens/Watt as a function of wavelength.

The function has a maximum value of 680 Lumens/Watt at 555nm and the ½ power points occur at 510nm and 610nm (Fig. 2).

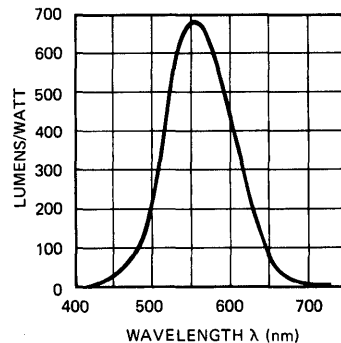


Figure 2. CIE standard photopic luminosity function.

The LUMEN is the unit of LUMINOUS FLUX and corresponds to the watt as the unit of radiant flux.

Thus the total luminous flux emitted by a light source in all directions is measured in lumens, and can be traced back to the power consumed by the source to obtain an efficiency number.

Since it is generally not practical to collect all the flux from a light source, and direct it in some desired direction, it is desirable to know how the flux is distributed spatially about the source. If we treat the source as a point (far field measurement), we can divide the space around the source into elements of solid angle ($d\omega$), and inquire as to the luminous flux (dF) contained in each element of solid angle ($\frac{dF}{d\omega}$). The resulting quantity is Lumens/Steradian and is called LUMINOUS INTENSITY (I) (Fig. 3). The unit

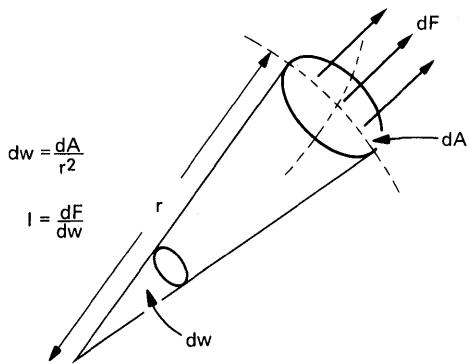


Figure 3. Solid angles and luminous intensity.

Since the space surrounding a point contains 4π steradians, it is apparent that an isotropic radiator of one candela intensity, emits a total luminous flux of 4π Lumens.

No real light source is isotropic, so it is quite common to show a plot of Luminous intensity versus angle off the axis (Fig. 4). If the source has no axis of symmetry, a more complex diagram is required.

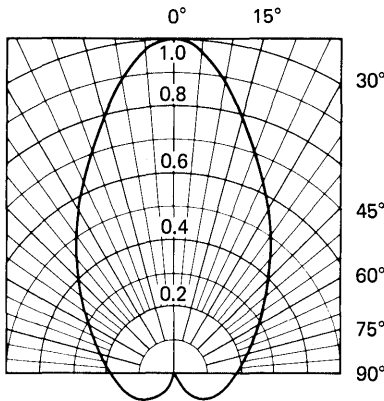


Figure 4. Spatial distribution pattern.

For an extended radiating surface, (such as an LED chip), each element of area contributes to the luminous intensity of the source, in any given direction. The luminous intensity contribution in the given direction, divided by the projected area of the surface element in that direction, is called the LUMINANCE (B) of the source (in that direction), (Fig. 5). The quantity is sometimes called photometric brightness, or simply brightness. The use of the term brightness on its own, should be discouraged, as this involves various subjective properties such as texture, color, sparkle, apparent size, etc. that have psychological implications.

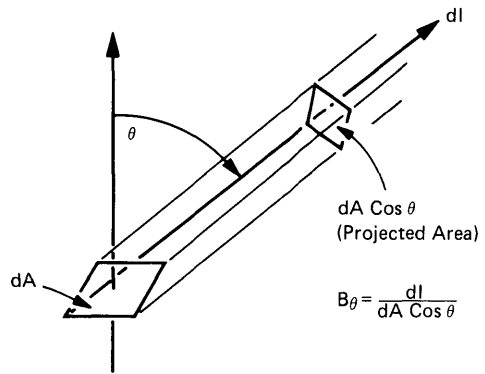


Figure 5. Definition of luminance.

The fundamental quantitative standard of the photometric system of units is the standard of luminance.

The luminance of a black body radiator at the temperature of freezing platinum (2043.8°K) is 60 candela per square centimeter. [A blackbody radiator is a perfect absorber of all electromagnetic energy incident on it. In thermal equilibrium at a given temperature, it emits radiation, spectrally distributed according to Plancks Formula

$$W_{\lambda} = \frac{c_1 \lambda^{-5}}{\exp\left(\frac{c_2}{\lambda}\right) - 1}$$

The units of Luminance in present use are an engineering nightmare.

- 1 candela/cm² is called a *Stilb*
- 1/π candela/cm² is called a *Lambert*
- 1 candela/m² is called a *Nit*
- 1/π candela/m² is called an *Apostilb*
- 1/π candela/ft² is called a *foot-Lambert*

The foot Lambert is the most commonly used unit in this country.

Of particular interest is a source whose angular distribution pattern is a circle (Fig. 6). For such a source we have $I_{\theta} = I_0 \cos \theta$, the luminance of such a source in a given direction θ , is then given by

$$B_{\theta} = \frac{dI_{\theta}}{dA \cos \theta} = \frac{dI_0 \cos \theta}{dA \cos \theta} = \frac{dI_0}{dA}$$

The luminance is seen to be the same in all directions. Such a source is called a LAMBERTIAN SOURCE. It can be shown that a perfectly diffusing surface behaves in this fashion. The formula governing a diffusing surface $I_{\theta} = I_0 \cos \theta$ is called Lambert's Cosine Law.

It can be shown that a flat LED chip is a very good approximation to a Lambertian Source.

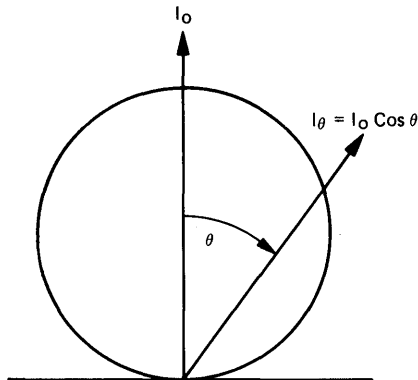


Figure 6. Lambertian radiation pattern.

If we now take a surface element (dA) and determine the intensity contribution in each direction we can determine the total flux (dF) emitted by the surface element. The resultant ratio ($\frac{dF}{dA}$) Lumens/ m^2 is called the LUMINOUS EMITTANCE (L). For a flat surface we may calculate L from

$$L = 2\pi \int_0^{\pi/2} B(\theta) S_{IN} \theta \cos \theta d\theta$$

The corresponding radiant emittance in watts/ m^2 is of considerable interest for GaAs infrared LED's where total output power is an important parameter.

The total luminous flux emitted by a light source can then be calculated from $F_{total} = \int L dA$.

These photometric quantities are sufficient to describe the properties of light sources such as light emitting diodes.

When light falls on a receiving surface, it is either partially reflected in the case of a purely passive surface, or partly converted into some other form of energy by what we may describe as an active surface (such as a phototransistor or photomultiplier cathode). In either case we are interested in how much flux falls on each element of the surface; Lumens/ m^2 in the case of a passive surface which we wish to illuminate, or the eye; and Watts/ m^2 in the case of other active surfaces. The quantity Lumens/ m^2 in this case is called the ILLUMINANCE sometimes loosely referred to as the illumination. The unit of illuminance is the LUX also referred to as the metercandle. Another commonly used unit of illuminance, in this country is the FOOT CANDLE, equal to one lumen per square foot. One lumen per square cm is called a PHOT.

Many of these photometric quantities and units are in common use in the field of illumination engineering, with the English units being most common in this country. It should be apparent to the reader that a

APPLICATION TO LIGHT EMITTING DIODES

The above description of photometric quantities should indicate to the reader that there are many ways in which the photometric properties of LED's can be stated. There is no general agreement among LED makers and users, as to the best way to specify LED performance, and this has led to much confusion and misunderstanding.

Many factors must be taken into account when evaluating LED specifications for a particular application, and electronic engineers will need to develop a knowledge of these factors to put LED's to effective use in new designs.

Presently available light emitting diodes are made from the so-called III-V compound semiconductors, with Gallium Arsenide Phosphide and Gallium Phosphide being the major materials. Gallium Aluminum Arsenide is also used but is less common. Gallium Arsenide is commonly included in this group, but it should be remembered that GaAs emits only infra-red radiation around 900nm, which is not visible to the eye, and is thus not properly called light. All specifications of GaAs emitters must be in radiometric units.

GaP emits green light between 520 and 570nm peaking 550nm very close to the peak eye sensitivity. It also can emit red light between 630 and 790nm peaking at 690nm.

GaAs_(1-x)P_x emits light over a broad orange red range depending on the percentage of phosphorus in the material (x). For x in the 0.4 region, red light between 640 and 700nm peaking at 660nm, is obtained. For x = 0.5, amber light peaking around 610nm is obtained.

Ga_(1-x)Al_xAs as presently available, emits red light between 650 and 700nm peaking at 670nm.

The efficiency of these materials is very dependent on the emitted wavelength, with drastic fall off in efficiency as the wavelength gets shorter. Fortunately the standard eyeball filter, favors the shorter wavelength (down to 555nm) and gives some measure of compensation. Some typical efficiencies reported by device makers, and the resulting overall luminous efficiency (Lumens/electrical watt) are as follows:

| | |
|--|------------------------------------|
| GaP.red | .72% @ 20Lum/Watt = |
| | .14 Lum/Watt overall (Opcoa) |
| GaAs _{0.6} P _{0.4} red | .3% @ 50Lum/Watt = |
| | .15 Lum/Watt overall (Litronix) |
| GaAlAs red | .06% @ 40Lum/Watt = |
| | .024 Lum/Watt overall (Mitsubishi) |
| GaP green | .006% @ 675Lum/Watt = |
| | .04 Lum/Watt overall (Monsanto) |
| GaAs _{0.5} P _{0.5} amber | .0044% @ 340Lum/Watt - |

For simple status indicator applications, front panel lamps and similar applications, several factors must be taken into account:

- (1) Color. Generally the designer has Henry Ford's color choice; various similar shades of red. Amber and green are available in small quantity, because of availability of suitable raw material.
- (2) Apparent source size. Various combinations of chip size and optical systems are available so that apparent source sizes from about 5 mils to about 300 mils diameter are available as standard products. Other things being equal, a larger source size is more visible.
- (3) Angular distribution. GaAsP diode chips are nearly Lambertian, but GaP are nearly isotropic. With suitable optical design, the angular distribution pattern can be changed from very broad to quite narrow. By placing the chip at the focus of the lens system a narrow high intensity beam is obtained. The off axis visibility is drastically reduced. By using diffusing lens materials, a large area source with good off axis visibility is obtained. In this case the luminance is reduced.
- (4) Luminous intensity. This will govern the visibility under optimum background contrast conditions, when viewed at normal distances. 1 millicandela is typical for red lamps of either GaAsP or GaP at normal operating conditions.
- (5) Luminance. When it is not possible to provide a dark contrasting background, or when the source is viewed at very close distances, the luminance becomes important. Values from 100 ft-L to 5000 ft-L are typical.

These factors are all related to the design of the device and the user should understand the trade offs. High luminance values in excess of 10,000 ft-L are easily obtained by running very high current densities in the LED chip, but this can lead to shortened life if carried too far.

For a given drive current the luminous intensity of two different chips will be similar, while the luminance will be inversely proportional to the active area of the chip.

If the designer can use filter screens or circularly polarizing filters in front of the light source, excellent protection from background illumination can be

obtained. In this case a diffusive lens giving a large apparent source with lower luminance, is more visible than a high luminance point source.

When a LED is used with an optical system to activate a remote sensor such as a cadmium sulphide or cadmium selenide cell (red light), or a GaAs IR emitter is used with a silicon photo detector, the performance requirements are somewhat different. It can be shown that for a given optical arrangement the irradiance of the detector determines the detected signal and this is proportional to the radiance of the source, which is comparable to the luminance (brightness) of the source. The intensity of the source will not be a factor unless the detector active area is larger than the incident beam.

When average power consumption must be minimized but good visibility is required, or detection at a considerable distance is required, pulsed operation can be used. With GaAs and GaAsP emitters using low duty cycle short pulses, very high peak intensity levels can be reached permitting communication over considerable distances. This technique is not useful with GaP diodes since they do not exhibit a linear relationship between optical output and instantaneous forward current, becoming saturated at moderate current levels. GaP also has a 50% higher rate of fall off in light output with temperature increase, than GaAsP which further inhibits high power applications.

The use of LED's to give a "Heads Up" projected display, such as for an automobile speedometer readout, or aircraft cockpit application, places severe requirements on the display luminance. For easy visibility, the projected image must be sufficiently contrasted with the ambient illumination. This requires very high luminance values for the LED's together with the use of photochromic windshields and probably polarizing screens.

The foregoing is a necessarily simplified, description of a very complex subject. The reader should avail himself of the standard textbook literature on these subjects.

References:

- R. Kingslake, *Applied Optics & Optical Engineering*
Committee on Colorimetry of the O.S.A., *The Science of Color*.
Warren J. Smith, *Modern Optical Engineering*.

APPLICATIONS OF OPTO-ISOLATORS

by George Smith

The 1L-IB is the first in a family of Opto-Isolators. These products are also called photon coupled isolators, photo-couplers, photo-coupled pairs and optically coupled pairs. All of the characteristics of the 1L-IB are electrical: it has no external optical properties. Hence opto-isolators are not OPTO-ELECTRONIC DEVICES; they are in fact one of the simplest of all ELECTRO-OPTICAL SYSTEMS.

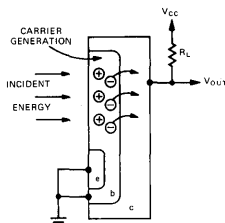
The Iso-Lit 1 consists of a Gallium Arsenide infrared emitting diode, and a silicon phototransistor mounted together in a DIP package.

When forward current (I_F) is passed through the Gallium Arsenide diode, it emits infrared radiation peaking at about 900nm wavelength. This radiant energy is transmitted through an optical coupling medium and falls on the surface of the NPN phototransistor.

Photo-transistors are designed to have large base areas; and hence a large base-collector junction area; and a small emitter area. Some fraction of the photons that strike the base area cause the formation of electron-hole pairs in the base region. This fraction is called the QUANTUM EFFICIENCY of the photo-detector.

If we ground the base and emitter, and apply a positive voltage to the collector of the photo-transistor, the device operates as a photo diode.

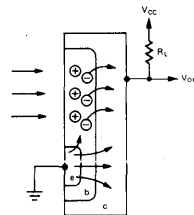
The high field across the collector base junction quickly draws the electrons across into the collector region. The holes drift towards the base terminal attracting electrons from the terminal.



The high junction capacitance, C_{cb} , results in an output circuit time constant $R_L C_{cb}$, with a corresponding output voltage rise time.

The output current in this configuration is quite small and hence this connection is not normally used.

The commonest circuit configuration is to leave the base connection open. With this connection, the holes generated in the base region cause the base potential to rise, forward biasing the base-emitter junction. Electrons are then injected into the base from the emitter, to try to neutralize the excess holes. Because of the close proximity of the collector junction, the probability of an electron recombining with a hole is small and most of the injected electrons are immediately swept into the collector region. As a result, the total collector current is much higher than the photo-generated current, and is in fact β times as great.



The total collector current is then several hundred times greater than for the previous connection.

This gain comes with a penalty of much slower operation. Any drop in collector voltage is coupled to the base via the collector-base capacitance tending to turn off the injected current. The only current available to charge this junction capacitance is the original photo-current. Thus, the rate of change of the output voltage is the same for both the diode and transistor connections. In the latter case, the voltage swing is β times as great, so the total rise time is β times as great as for the diode connection. Thus the effective output time constant is $\beta R_L C_{cb}$.

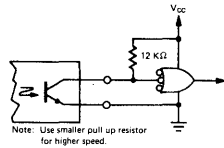
The ratio of the output current from the photo-transistor (I_C or I_E), to the input current in the Gallium Arsenide diode, is called the Current Transfer Ratio (CTR). For the 1L-IB CTR is specified at 20% minimum with 35% being typical at $I_F = 10$ mA.* Thus for 10 mA input current the minimum output current is 2 mA. Other important parameters are V_F typically 1.3V at 100 mA I_F .

DIGITAL INTERFACES

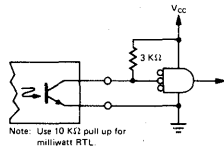
Output Sensing Circuits

The output of the photo-transistor can directly drive the input of standard logic circuits such as the 930 DTL and 7400 TTL families. The worst case input current for the 74 series gate is -1.6 mA for $V_{IN} = 0.4$ Volts. This can be easily supplied by the Iso-Lit 1, with 10 mA input to the infrared diode.

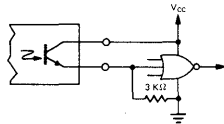
DTL or TTL Active Level Low (930 or 7400)



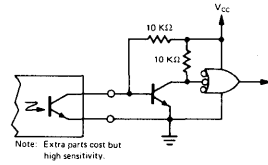
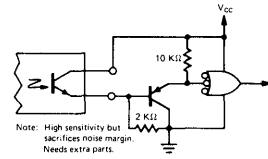
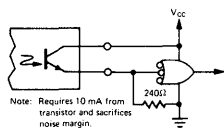
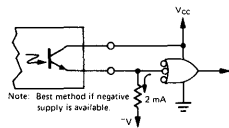
RTL Active Level Low (μ 914)



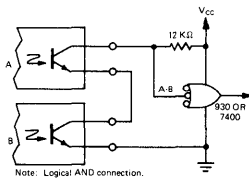
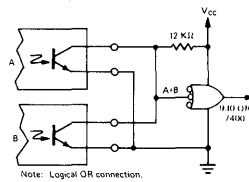
RTL Active Level High (μ 914)



It is more difficult to operate into DTL and TTL gates in the active level high configuration. Some possible methods are as follows;

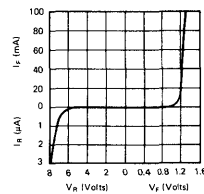


Obviously, several Iso-Lit output transistors can be connected to perform logical functions.



Input Driving Circuits

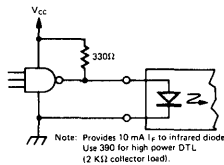
The input side of the 1L-IB has a diode characteristic as shown.



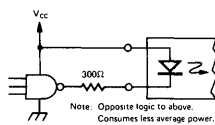
The forward current must be controlled to provide the desired operating condition.

The input can be conveniently driven by integrated circuit logic elements in a number of different ways.

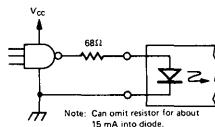
DTL Active Level High (930 Series)



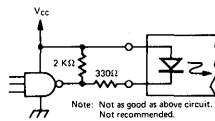
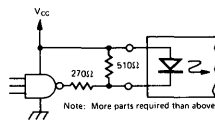
DTL Active Level Low (930 Series)



TTL Active Level High (7400 Series)



TTL Active Level Low (7400 Series)



There are obviously many other ways to drive the device with logic signals, but the commonest needs can be met with the above circuits. All provide 10 mA into the LED giving 2 mA minimum out of the photo-transistor. The 1 Volt diode knee and its high capacitance (typically 100 pF), provides good noise immunity. The rise time and propagation delay can be reduced by biasing the diode on to perhaps 1 mA forward current, but the noise performance will be worse.

All previous configurations show medium speed digital interfaces. These circuits have various advantages over other ways of doing the task.

(1) They can replace relays and reed relays, giving much faster switching speeds, no contact bounce, better reliability, and usually better electrical isolation except for special configurations. However relays have high current capability, higher output voltage, lower on resistance and offset

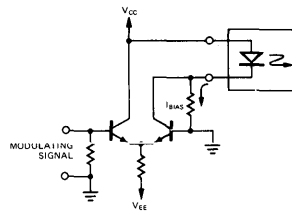
(2) They can replace pulse transformers in many floating applications. Opto-isolators can transmit DC signal components and low frequency AC, whereas pulse transformers couple only the high frequency components, and a latch is required to restore the DC information. Pulse transformers have faster rise time than photo-transistor opto-isolators.

(3) Integrated circuit line drivers and receivers are used to transmit digital information over long lines in the presence of common mode noise. The maximum common mode noise voltage permissible is usually in the 30 Volt range. There are many practical situations where common mode noise voltages of several hundred Volts can be induced in long lines. For these applications opto-isolators provide protection against several thousand Volts.

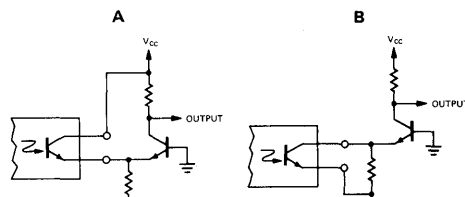
LINEAR APPLICATIONS

The curve of input current versus output current for the IL-IB is somewhat non-linear, because of the variation of β with current for the photo-transistor, and the variation of infrared radiation out versus forward current in the GaAs diode. The useful range of input current is about 1 mA to 100 mA, but higher currents may be used for short duty cycles.

For linear applications the LED must be forward biased to some suitable current (usually 5 mA to 20 mA). Modulating signals can then be impressed on this DC bias. A differential amplifier is a good way to accomplish this.

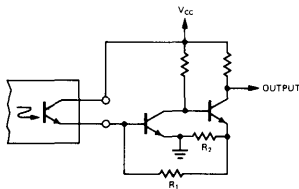


Sensing in linear applications can be done in several ways depending on the requirements. For high frequency performance, the photo-transistor should be operated into a low impedance input current amplifier. The simplest such scheme is a grounded base amplifier.



The circuit will work equally well either way, with a phase inversion between the two. Obviously a PNP transistor would work as well.

A feedback amplifier could also be used to get a low impedance input.



The current gain is $\left(1 + \frac{R_1}{R_2}\right)$.

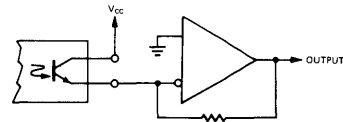
The input impedance is approximately

$$\left(\frac{R_1}{1 + \frac{V_{CC} - 2V_{BE}}{.026}}\right)$$

For example if $R_1 = 900\Omega$, $R_2 = 100\Omega$, $V_{CC} = 5V$; we would have a current gain of 10 and an input

impedance of about 6.3Ω . This would give a considerable speed improvement over a 100Ω load.

A high speed operational amplifier could be used to give excellent performance.



Note that in all cases the output can be taken from either the collector, or the emitter of the photo-transistor depending on the polarity desired. The operating speed is the same in either case.

CONCLUSION

This appnote covers the most commonly used ways of applying photo-transistor opto-isolators. The design engineer will see many ways to expand on these circuits to achieve his end goals. The devices are extremely versatile, and can provide better solutions to many systems problems than other competing components. Special designs are possible to optimize certain parameters such as coupling capacitance, or transfer ratio, and the engineer can expect to see a variety of these products in the future.

SUMMARY OF PROPERTIES OF SIGNAL COUPLING DEVICES

| Device | Advantages | Disadvantages |
|---|--|--|
| Opto-Isolator | Economical. Solid state reliability. Medium to high speed signal transmission. DC & low frequency transmission. High voltage isolation. High isolation impedance. Small size DIP Package. No contact bounce Low power operation. | Finite ON Resistance Finite OFF Resistance. Limited ON state current. Limited OFF state voltage. Low transmission efficiency. (Low CTR) |
| Relays | High power capability. Low ON resistance. DC transmission. High voltage isolation. | High cost. High power consumption. Unreliable. Very slow operation. Physically large. |
| Pulse Transformers | High speed signal transmission. Moderate size. Good transmission efficiency. | No DC or low frequency transmission. Expensive for high isolation impedance or voltage. |
| Differential line Drivers and Receivers | Solid state reliability. Small size DIP package. High speed transmission. DC transmission. Low cost. | Very low breakdown Voltage. Low isolation impedance. |

MULTIPLEXING LED DISPLAYS

by George Smith

In digital displays, such as would be used in a D.V.M. or counter of conventional design, all digits are operated in parallel, with a separate decoder-driver for each digit operated from data generally stored in a quad latch.

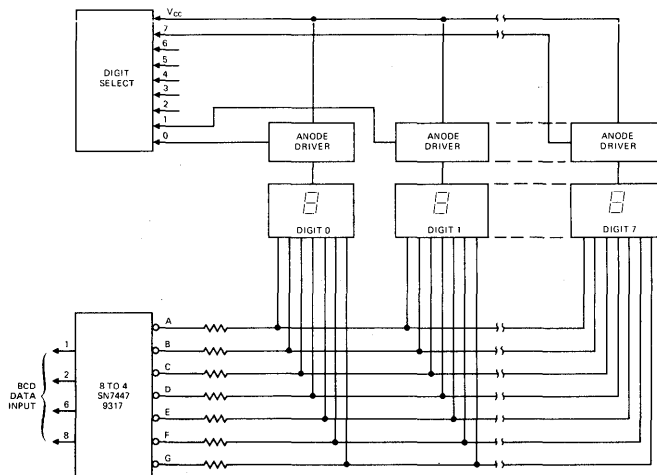
In many cases, a reduction in cost can be effected by operating the display in a time division multiplexed mode. The question of cost effectiveness depends on the particular application. As a general rule, the greater the number of digits in the display, the more advantageous the multiplex system becomes from the cost standpoint. Because of the great variety of situations possible, it is difficult to say at what number of digits the change should be made. In some circumstances, non-multiplexed operation of less than 8 digits is more economical. On the other hand, there are circumstances under which multiplexing is used for three and four digit displays at a cost saving. This application note attempts to show some of the many ways of multiplexing digits, and it is left to the designer to decide whether his own system application would be lower in cost if he used a multiplex scheme.

The properties of light emitting diodes (LED) make

them particularly suitable for multiplexed operation, and hence it is the preferred method to use, if a scheme can be designed which is cost competitive with non-multiplexed operation.

Throughout this paper, it will be generally assumed that we are talking of a system using TTL type logic families, with MSI functions being used where applicable. In most production situations this will be the most economical approach. There will be some cases where discrete gates and flip-flops may yield a lower cost. There are also cases where a single MOS chip contains all the necessary logic functions, and only interface driver circuits are required.

The seven segment numeric displays with a common anode connection made by Litronix provide compatibility with the most widely available decoder-drivers, which are active level low outputs. The commonest devices are SN7447, 8T04, 9317 and similar. Any of these is suitable for driving the DL-76XX Series type display. For common cathode displays such as the Litronix DL-340M SN7448, 8T06 and 9307 decoders can be used, and anode drivers become cathode drivers.



In a multiplex system, the corresponding cathodes of each digit are bussed together, and driven from one seven segment decoder-driver, via the usual current limiting resistors. The display data is presented serially by digit, to the decoder-driver, together with an enable signal to the appropriate digit anode Figure 1.

Each digit anode is driven by a switch, capable of passing the full current of all segments. The simplest switch would be a PNP high current switch or amplifier transistor, such as a core driver type.

In operation, the anode switches are activated one at a time, in the desired sequence, while the appropriate digital data is presented at the input to the decoder-driver. The amount of circuitry required in Figure 1

most of the packages are lower cost than the seven segment decoder. The scheme shown is a 20% cost reduction over non-multiplexed operation, based on O.E.M. prices for the components. For less than eight digits, it would be difficult to compete with non-multiplexed operation using this scheme.

CASE 2:

Multiplexing becomes more attractive, when the data is stored in a shift register, rather than in latches. In this case the data is circulated around the register, at some suitable rate, and is sequentially presented at the input of the seven-segment decoder-driver. The anode drive can be obtained from a counter and decoder as in Figure 2, or from a parallel output shift register — Figure 3.

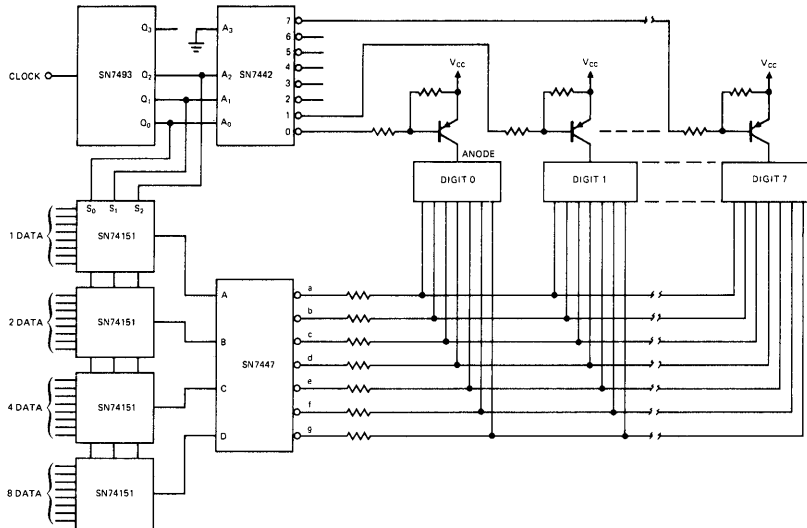


Figure 2

is much less than that used in the non-multiplexed scheme. The question of overall economy is dependent on the amount of circuitry required to sequence the anodes and present the data at the decoder input. Let us consider some typical situations.

CASE 1:

An 8-digit counter-timer display, with the data stored in multiple latch circuits. This is the most common situation present in a counter-timer of conventional design. A quad latch (SN7475) is used to store each digit, and this data is periodically updated. To scan this data, a 4 pole 8 position switch is required (SN74151). To select the appropriate digit, an octal counter (SN7493) and a 1 of 8 decoder (SN7442) are required. The complete circuit is as in Figure 2.

The total package count is about the same for this arrangement, as for non-multiplexed operation, but

This circuit, which can be expanded to any number of digits, circulates a single zero, and thus can directly drive the PNP anode switches. Systems using circulating memories generally require this digit timing circuitry for other reasons, so it is generally available in the system already.

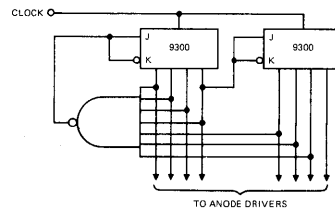


Figure 3

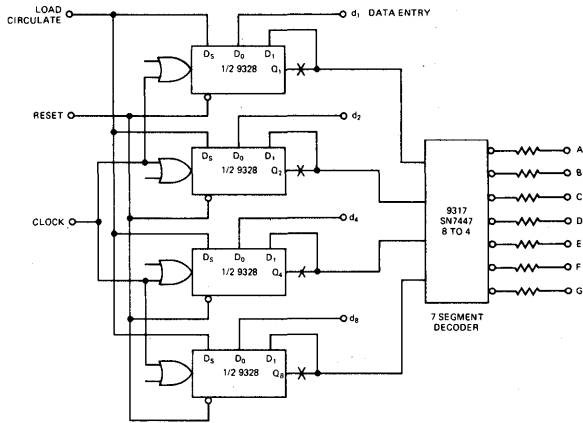


Figure 4

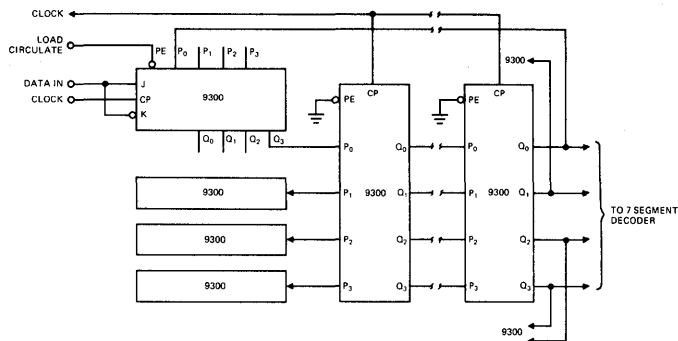


Figure 5

For displays of 8 digits; a very common number in counter-timer instruments, the 9328 dual 8 bit shift register makes a very good circulating shift register. Two packages are required to store and circulate 8 digits — Figure 4.

The scheme can be extended to more digits by adding a 4 bit parallel shift register such as the 9300, for each extra digit; the extra shift bits are inserted at the points marked X in Figure 4. The same circuit can be used for less than 8 digits, if a 12-1/2% duty cycle is satisfactory. For less than 8 digits, where maximum available duty cycle must be maintained, the scheme shown in Figure 5 can be used.

The preceding schemes demonstrate that systems containing recirculating data are very effectively coupled to multiplexed LED displays. Many multi-digit systems such as calculating machines use L.S.I. MOS circuits to provide their logic, and these naturally lend themselves to recirculating data. It is now practical to use custom L.S.I. to provide the logic functions of a D.V.M. or a counter-timer type of instrument,

cost savings over conventional instrument designs.

Apart from the strictly logical problems involved in a multiplexed display, the designer must choose suitable operating conditions for the LED's. Peak forward current, current pulse width, duty cycle and repetition rate, are all factors which the designer must determine.

The luminous intensity, or the luminance of GaAsP LED's, is essentially proportional to forward current over a wide range, but certain phenomena modify this condition. At low currents, the presence of non-radiative recombination processes, results in less light output than the linear relationship would predict. This effect is noticeable in the region below about 5 mA per segment (for 1/4 inch characters). The result is that noticeable difference in luminance from segment to segment can occur at low currents. At high currents, the power dissipation in the chip causes substantial temperature rise, and this reduces the efficiency of the chip. As a result the light output

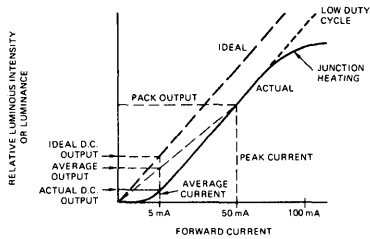


Figure 6

line, at high currents (Figure 6). It should be emphasized that this latter effect is entirely due to self heating. If the power dissipation is limited, by running short pulses at low duty cycle, the output follows the straight line up to very high current densities. Whereas 100 A/cm^2 may be used in DC operation, as much as 10^4 A/cm^2 can be used under pulsed conditions, with a proportionate increase in peak intensity. (If this did not occur, GaAsP lasers could not be built.) Gallium Phosphide, however, has an inherent saturation mechanism that causes a drastic reduction in efficiency at high current densities even if the junction temperature remains constant. This effect is due to competing non-radiative recombination mechanisms at high current density.

As a first approximation the brightness of a pulsed LED will be similar to that when operated at a DC forward current equal to the average pulsed current. For example, for 40 mA peak current at 25% duty cycle, the brightness will be similar to DC operation at 10 mA. The actual brightness comparison will depend on the actual pulsing conditions. Under most legitimate conditions the brightness will be greater for pulsed operation.

Figure 6 shows how the actual light output at 5 mA DC is substantially less than expected from the ideal curve, because of the "foot" on the curve at low currents. Operation at 50 mA peak current and 10% duty cycle yields a high peak output as shown, and an integrated average output that is much closer to the ideal value. It should be obvious that variations in the "foot" from segment to segment cause a significant

variation in light output at a low DC current, but a much smaller variation in the average output when operated in a pulsed mode. As well as an increase in luminance, or luminous intensity due to pulsing, there is an increase in brightness because of the behavior of the eye. The eye does not behave as an integrating photometer, but as a partially integrating and partially peak reading photometer. As a result, the eye perceives a brightness that is somewhere between the peak and the average brightness.

The net result is that a low duty cycle high intensity pulse of light looks brighter than a DC signal equal to the average of the pulsed signal. The practical benefit of multiplexed operation then, is an improvement in display visibility for a given average power consumption besides the lower cost. The brightness variation from segment to segment and digit to digit is also reduced by time-sharing. The gain in brightness over DC operation can be as much as a factor of 5 at low duty cycles of 1 or 2 percent, and peak currents of 50 to 100 mA.

A number of factors must be taken into account when deciding on the design of a multiplexed display. Besides the optical output, thermal considerations are very important.

Most 1/4" size LED numerics are rated at 30 mA DC max per segment. Under pulsed operation, higher currents can be used provided several thermal considerations are taken into account.

- (1) The average power dissipation must not exceed the maximum rated power.
- (2) The power pulse width must be short enough to prevent the junction from overheating during the pulse. This implies that the pulse width must get shorter as the amplitude increases.

Present experience indicates that for pulses of $10 \mu\text{s}$, the amplitude should be limited to 100 mA max. Shorter pulses of higher amplitude may be used but the circuit problems become severe if the pulse width is very short. As more information on thermal parameters of the devices becomes available, more specific design rules can be given to assist the designer.

DRIVING HIGH-LEVEL LOADS WITH OPTO-ISOLATORS

by David M. Barton

Frequently a load to be driven by an Iso-Lit requires more current, voltage, or both, than an Iso-Lit can provide at its output.

Available opto-isolator output current, of course, is found by multiplying input (LED section) current by the "CTR" or current - transfer-ratio. For worst-case design, the minimum specified value would be used. The minimum CTR of the IL-IB is 20% . Temperature derating is not usually necessary over the 0 to +60 degree Celcius range because the LED light output and transistor beta have approximately compensating coefficients.

Multiplying the minimum CTR by 0.9 would ensure a safe design over this temperature range. Over a wide range, more margin would be required.

The LED source current is limited by its rated power dissipation. Table I shows maximum allowable I_F vs maximum ambient temperature.

Values for Table I are based on a 1.33 mW/°C derate from the 100 mW at 25°C power rating.

Table I

| MAXIMUM TEMPERATURE | I_F MAXIMUM |
|---------------------|---------------|
| 40°C | 65 mA |
| 60°C | 48 mA |
| 80°C | 25 mA |

Obviously, one can increase the available output current then by either choosing a higher CTR-rated Iso-Lit, by providing more current, or both. Table II

Table II

| P/N | I_{CE} (MIN) mA |
|-------|-------------------|
| IL-IB | 8.6 |

shows the minimum available output current of each device assuming 60°C derating (from Table I) and a 10 percent margin for temperature effects.

If the IL-IB is being operated from logic with 5 volt driving transistor and 0.2 volt V_{CE} saturation is assumed for the driving transistor, a 75 ohm R_{IF} resistor will provide the 48 mA. The forward voltage of the IR-emitting LED is about 1.2 volts. Figures 1A and 1B show two such drive circuits.

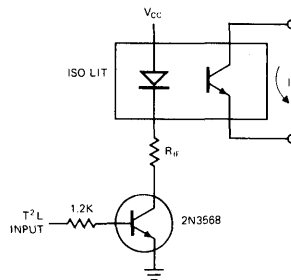


Figure 1A. NPN Driver

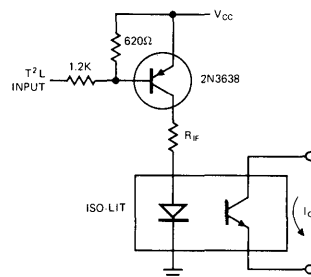


Figure 1B. PNP Driver

A "buffer-gate," such as the SN7440 or Signetics 8855, provides a very good alternative to discrete transistor drivers. Figure 2 shows how this is done. Note that the gate is used in the "current-sinking" rather than the "current-sourcing" mode. In other words, conventional current flows *into* the buffer-gate to turn on the LED. This makes use of the fact that a T²L gate will sink more current than it will source. The SN7440 is specified to drive thirty 1.6 mA loads or 48 mA. Changing R_{IF} from 75 to 68 ohms adjusts for the higher saturation voltage of the monolithic device.

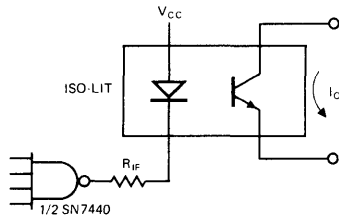


Figure 2. Buffer-Gate Drive

MORE CURRENT

For load currents greater than 8.6 mA, a current amplifier is required. Figures 3A and 3B show two simple one-transistor current amplifier circuits.

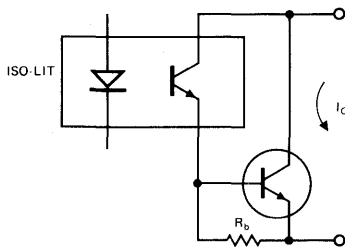


Figure 3A. NPN Current Booster

Since the transistor in the optoisolator is treated as a two-terminal device, no operational difference exists between the NPN and the PNP circuits. R_b provides a return path for I_{CB0} of the output transistor. Its value is: $R_b = 400 \text{ mV} / I_{CB0}(T)$ where I_{CB0}(T) is found for the highest junction temperature expected.

Assume that leakage currents double every ten degrees. Use the maximum dissipated power, the specified maximum junction-to-ambient thermal resistance,

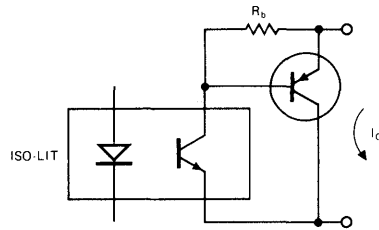


Figure 3B. PNP Current Booster

and the maximum design ambient temperature in conjunction with the specified maximum 25 degree I_{CB0} to calculate I_{CB0}(T).

As an example, suppose a 2N3568 is used to provide a 100 mA load current. Also assume a maximum steady-state transistor power dissipation of 100 mW and a 60°C maximum ambient. The transistor junction-to-ambient thermal resistance is 333°C/watt, so a maximum junction temperature of 60 + 33 or 93°C is expected. This is about 7 decades above 25°C. Therefore, $I_{CB0}(T) = I_{CB0}(\text{max}) \times 27 = 50 \text{ nA} \times 128 = 6.5 \text{ } \mu\text{A}$. A safe value for R_b is 400 mV/6.5 μA = 62 kilohms.

Working backwards, maximum base current under load will be $I_b / h_{FE}(\text{min}) = 100 \text{ mA} / 100 = 1 \text{ mA}$. Current in R_b is $V_{BE} / R_b = 600 \text{ mV} / 60 \text{ k} = 10 \text{ } \mu\text{A}$, which is negligible. An IL-1B with 9 mA drive would operate effectively.

If the load requires more current than can be obtained with the highest beta transistor available, then more than one transistor must be used in cascade. For example, suppose 3 amperes load current and 10 watt dissipation are needed. A Motorola MJE3055 might be used for the output transistor, driven by a MJE205 as shown in Figure 4. Using a 5°/watt heat sink and the rated MJE3055 junction-to-case thermal resistance of 1.4°/watt, we find that junction temperature rise is 6.4 × 10, or 64°. Therefore maximum junction temperature is 124°C. This is 10 decades above 25°C making $I_{CB0}(T) = 2^{10} I_{CB0}(\text{max}) = 10^3 I_{CB0}(\text{max})$.

I_{CB0}(max) at 30 volts or less is not given, but I_{CEO} is. Using (for safety) a value of 20 for the minimum low-current h_{FE} of the device, I_{CB0} could be as large as

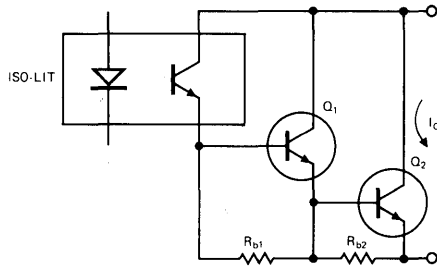


Figure 4. Two-NPN Current Booster

$I_{CEO}/20 = 35 \mu A$. Then $I_{CBO}(T)$ is 35 mA and $R_{b2} = 400 \text{ mV}/35 \text{ mA} = 11 \text{ ohms}$. For I_b use $I_o/h_{FE}(\text{min @ } 4A) = 3A/20 = 150 \text{ mA}$. $I_{Rb2} = 600 \text{ mV}/10 \text{ ohms} = 60 \text{ mA}$, so $I_{e(Q1)} = 210 \text{ mA}$.

Maximum Power in Q_1 will be about 1/14 the power in Q_2 since its current is lower by that ratio and the two collector-to-emitter voltages are nearly the same. This means Q_1 must dissipate 700 mW.

Assuming a small "flag" heat sink having $50^\circ/\text{watt}$ thermal resistance, we find the junction at about 95°C . The 150°C case temperature I_{CBO} rating for this device is 2 mA, so one can work backwards and assume about 1/30 of this value, or $70 \mu A$. On the other hand, the 25° rated I_{CBO} is $100 \mu A$. Choosing the larger of these contradictory specifications, $R_{b1} = 400 \text{ mV}/0.1 \text{ mA} = 4\text{k} \approx 3.9\text{k}$. Q_1 base current is $I_{E(Q1)}/h_{FE(Q1-\text{min})} = 210 \text{ mA}/50^* = 4.2 \text{ mA}$. Total current is $I_{b(Q1)} + I_{Rb1} = 4.2 + 0.24 = 4.5 \text{ mA}$. Table II shows that an Iso-Lit 1 could be used here.

MORE LOAD VOLTAGES

All of the current-gain circuits shown so far have one common feature: load voltage is limited by the 30 volt rating of the IL-IB not by the voltage or power rating of the transistor(s). Figure 5A shows a method of overcoming this limitation. This circuit will stand off BV_{CEO} of Q_1 . The voltage rating of the phototransistor is irrelevant since its maximum collector-emitter voltage is the base-emitter voltage of Q_1 (about 0.7 volts).

Unlike the "Darlington" configurations shown previously, this circuit operates "normally-ON." When

no current flows in the LED the phototransistor, being OFF, allows R_2 current to flow into the base of Q_1 , turning Q_1 ON. When the Iso-Lit is energized, its phototransistor "shorts out" the R_2 current turning Q_1 OFF.

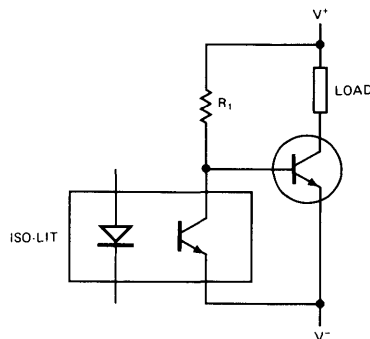


Figure 5A. NPN HV Booster

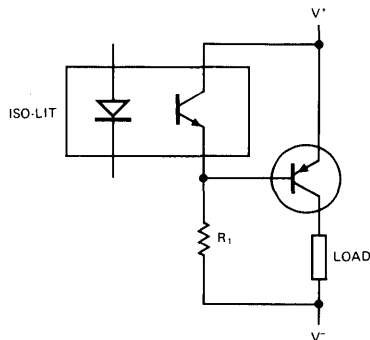


Figure 5B. PNP HV Booster

The value of R_1 depends only on the load-supply voltage $V^+ - V^-$, and the *maximum* required Q_1 base current. This is derived from the minimum beta of Q_1 at minimum temperature and the load current. The required current-drive capability is the same as I_{R1} , since I_{R1} changes negligibly when the circuit goes between its "ON" and "OFF" states.

In some applications either more current gain will be required than one transistor can provide or the power dissipated in R_1 will be objectionable. In these cases, simply use the Darlington high-voltage booster shown in Figure 6A.

*Minimum h_{FE} is obtained using the specification at $I_{CE} = 2A$ and the "Normalized DC Current Gain" graph given in the Motorola "Semiconductor Data Book," 5th Edition, pp. 7 - 232, 3.

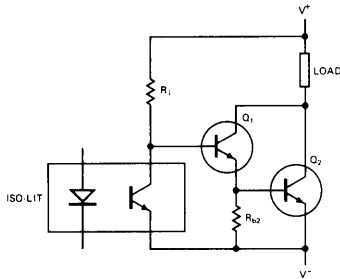


Figure 6A. NPN Darlington HV Booster

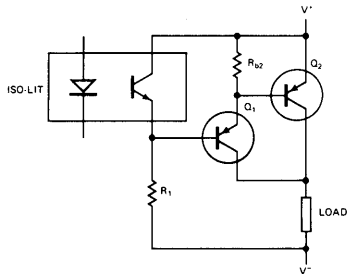


Figure 6B. PNP Darlington HV Booster

If more than one load is being driven and their negative terminals must be in common, use the PNP circuit, Figure 6B. Otherwise, the NPN is better because

the transistors cost less. Of course performance characteristics of the NPN and PNP versions are identical if the device parameters are also the same.

APPLICATIONS

Opto-isolator isolated circuits are useful wherever ground loop problems exist in systems, or where dc voltage level translations are needed. In many systems so-called interpose relays are used between a logic circuit section (which may be a mini-computer) and the devices being controlled. Sometimes *two levels* of interpose relays are used in cascade either because of the load power level or because of extreme difficulties with EMI. Opto-isolators aided by booster circuits such as those described, can replace many of the relays in these systems.

The reed relays, typically used as the first level of interpose and mounted on the interface logic cards in the electronic part of the system, are almost always replaceable by opto-isolator since their load is just the coil of a larger relay. This relay may have a coil power of 1/2 to 5 watts and operate on 12, 24 or 48 volts dc.

Assuming worst-case design techniques are carefully followed, system reliability should improve in proportion to the number of relays replaced.

MORE SPEED FROM OPTICAL ISOLATORS

by David M. Barton

Figure 1 shows a typical circuit employing an opto-isolator to transmit logic signals between electrically isolated parts of a system. In the circuit shown, the opto-isolator must "sink" the current from one T²L load plus a pull-up resistor to V_{CC}. The resistor in series with the LED half of the opto-isolator must supply the worst-case load current divided by the "current transfer ratio" or CTR of the opto-isolator. If an IL-IB is used, having a min CTR of 0.2, and 30 percent variation in the load is allowed. 8.1 mA is required. This is supplied by the 430Ω resistor.

The maximum repetition rate at which this circuit will operate is only about 3 kHz. The severe speed limitation is due entirely to the characteristics of the photo-transistor half of the Iso-Lit. This device has a large base-collector junction area and a very thick base region in order to make it sensitive to light. C_{ob} is typically 25 pF. This capacitance is, in the circuit of Figure 1, effectively multiplied by a large factor due to the "Miller effect." Also, because the base region volume is large, so is base storage time.

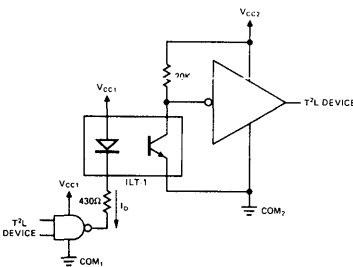


Figure 1

A very simple method of reducing both of these effects is to add a resistor between the base and emitter as shown in Figure 2. This resistor helps by reducing the time constant due to C_{ob} and by removing stored charge from the base region faster than recombination can. When a base-emitter resistor is used, of course, the required LED drive is increased since much of the photo-current generated in the base-collector junction is now deliberately "dumped."

Using this method does not usually result in a large power supply current drain since *average* repetition rate is low in most applications.

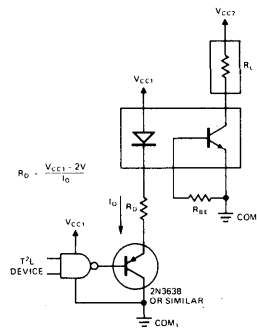


Figure 2

As drive is increased and R_{BE} reduced, turn-on time and turn-off time both decrease. The total amount of charge stored can also be reduced by decreasing the LED drive pulse duration. Also, as higher drive levels are used, the load resistance, R_L can be reduced to further enhance the speed of the circuit. These parameters are related to each other such that all should be changed together for best results.

One important generalization can be made concerning their interdependence. The LED drive pulse duration, T_{in}, output fall time, t_f, output rise time, t_r and propagation delay, t_p, should occur in a 1.5:1:1:1 ratio, approximately. If this relationship does not occur, the circuit will not operate at as high a repetition rate as it could at the same drive level. T_{out} equals T_{in} at low currents but stretches out at high currents.

Figure 3 is a graph relating the important parameters for a typical IL-IB whose CTR is 0.25. The optimum values of T_{in}, R_{BE}, and R_L are shown versus LED pulse current as are the resultant output pulse width and maximum full-swing frequency. Rise, fall and propagation time can be read as 2/3 of T_{in}.

Figure 3 shows that increasing drive to 200 mA and using optimum R_{BE} and R_L will increase the maximum repetition rate from 3 kHz to 500 kHz, a 167:1 improvement.

Lower grade isolators will behave similarly if the LED drive level is scaled appropriately to allow for a lower CTR.

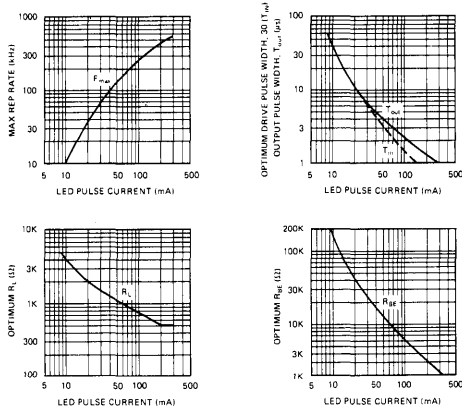


Figure 3. Parameters vs LED Pulse Current

Another method of increasing speed is to operate the photo-transistor as a photo-diode. In this method, bias voltage is supplied between the collector and base terminal, the emitter being unused. Operation to at least 10 MHz is possible this way, but the price is the need for external amplification. Figure 4 is a graph

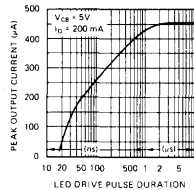


Figure 4. Diode Mode Output Current vs Drive Pulse Duration

showing peak output current versus drive pulse duration for 200 mA peak drive current.

Since output current is small, some type of wide-bandwidth amplifier must be employed in order to drive T^2L loads.

One simple solution for intermediate speed operation is the use of a low-power T^2L inverter (1/6 74L04). The collector of the photo-transistor is connected to its input along with a 100K pullup resistor. The base is connected to system output-side common. This inverter will in turn drive one 7400 series device.

Another device which will provide a good interface is an integrated comparator amplifier. The photo-transistor collector goes to V_{CC} . Its base has a 200Ω load resistor to ground and goes to one input of the comparator. Also, a resistor goes from this node to the minus supply. This resistor is chosen to supply 50 μA. The other comparator input is grounded. The voltage at the comparator input will switch from -10 mV to +10 mV or more when the diode turns on and the output will drive the T^2L loads.

Of course discrete-component amplifiers could be used and may be best in some applications.

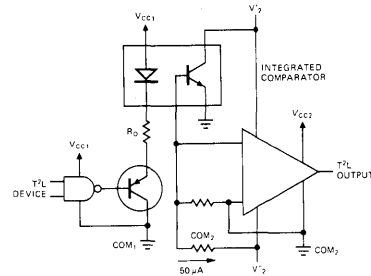


Figure 5

CONCLUSIONS

For operation to 500 kHz, the addition of a base-emitter resistor and a high-current driver is probably the best method of increasing opto-isolator speed. Above 500 kHz one must revert to photodiode mode and use an external amplifier to drive most loads, particularly T^2L .

OPERATING LED'S ON AC POWER

by David M. Barton

Introduction

Frequently it is desirable to operate LEDs on AC power rather than DC. Typically, the power source is 120 VRMS 60 Hz. The most obvious method is to rectify this power with a series diode and use a resistor to limit LED current as shown in Figure 1.

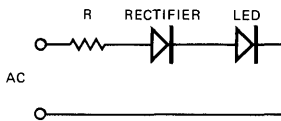


FIGURE 1. The Power Resistor Method

This method, though sound, results in very high power dissipation in the resistor since the LED operates on only 1.6 volts.

The Method

Figure 2 shows a better method. Here a capacitor is used to control LED current and a shunt silicon diode provides rectification.

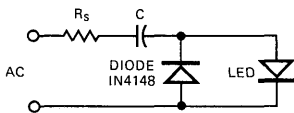


FIGURE 2.

Since, for current in either direction, voltage drop across the LED or rectifier is a negligible part of the supply voltage, current in the capacitor is almost exactly equal to the AC supply voltage divided by the reactance of the capacitor. Average capacitor current is then

1. $I_C (AV) = .9 \times VRMS/X_C$
and average half-cycle LED or rectifier current is
2. $I_{LED (AV)} = 1/2 I_D (AV) = .45 VRMS/X_C$
or, for 120 VRMS, 60 Hz operation,
3. $I_{LED (AV)} = 20 \text{ mA} \times C_{\mu F}$
or $C_{\mu F} = \frac{I_{LED (AV)}}{20 \text{ mA}}$

Figure 3 shows the value of the series capacitor needed for a range of average LED currents assuming

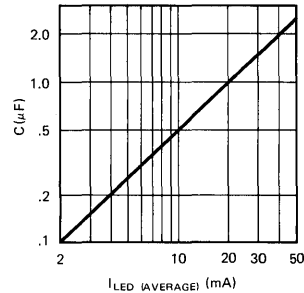


FIGURE 3. Series Capacitor Value vs Average LED Current for 120 VRMS 60 Hz.

A resistor is necessary in series with the capacitor to limit turn-on transient currents. A value of 100 ohms will be adequate in most cases.

The current in the LED, of course, flows almost exactly in quadrature with the line voltage. For this reason, power dissipation is low, being limited to the expected LED and rectifier power loss, the loss in series resistor and to losses in the capacitor. The latter term will be extremely low if high quality capacitors are used. Although power consumption of a circuit may not be of much significance in terms of the cost of the power, it certainly can be important to reduce heat generation within an enclosure.

If more than one LED is to be operated from the same source, simply put the LEDs in series in the same circuit, as shown in Figure 4. For small numbers of LEDs the current will be, for practical purposes, the same as for one.

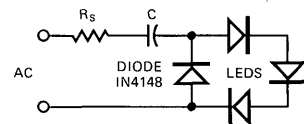


FIGURE 4.

Conclusion

Cost of the series capacitor (mylar) will be similar to the cost of a series power resistor. The shunt diode, a IN4148 or similar, will cost about two cents; much less than a series rectifier which must have a several hundred volt PIV rating.

So, the capacitor method is both lower in cost and lower in heat generation and power consumption than

APPLYING THE DL-1416 Intelligent Display®

by Dave Takagishi

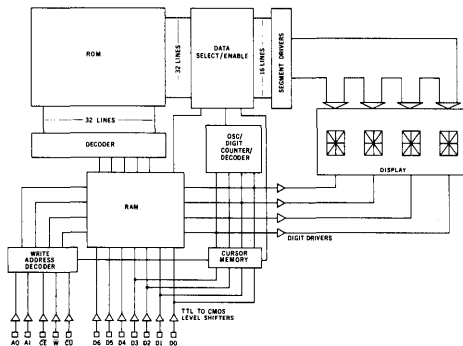
This application note is intended to serve as design and application guide for users of the DL-1416 Alphanumeric Display. The information presented covers: device electrical description and operation, considerations for general circuit designs, multi-digit display systems and interfacing to the 6800, Z80, and 8080 microprocessors.

The DL-1416 was designed to provide an easy-to-use alphanumeric display for the 64 character ASCII systems. Only twelve interconnect pins plus power and ground are needed to drive a single four digit display. The overall package is designed to allow end stacking of the DL-1416 to form any desired character length display.

ELECTRICAL DESCRIPTION

The on-board electronics of the DL-1416 eliminates all the traditional difficulties of using displays—segment decoding, driving, and multiplexing. The DL-1416 has gone further and provided internal memory for the four digits. This approach allows the user to address one of four digits, load the desired data asynchronously to the multiplex rate and continue.

Figure 1 is a block diagram of the circuitry in the DL-1416. The unit consists of a display and a single integrated circuit chip. The display is four 16-segment alphanumeric monolithic LED die magnified to a height of 160 mils. The IC chip contains the 16 segment drivers, 4 digit drivers, 64-character ROM, four-word 7-bit RAM, internal oscillator for multiplexing, multiplex counter/decoder, cursor RAM, write address decoder, and level shifters for the inputs.



INTERNAL SCHEMATIC
FIGURE 1

The inputs to the DL-1416 are:

- \overline{CE} CHIP ENABLE (active low)
This determines which device in an array will actually execute the loading of data. When the chip enable is in the high state, all inputs are inhibited.
- A_0, A_1 DIGIT ADDRESS
The address to the DL-1416 determines the digit in which the data will be written. Address order is right-to-left for positive-true address.
- $D_0 - D_6$ DATA LINES
The seven data input lines are designed to accept the 64 ASCII code set. See Table 1 for character set.
- \overline{W} WRITE (active low)
Data to be written into the DL-1416 must be present before the leading edge of write. The data and address must be stable until after the trailing edge.
- \overline{CU} CURSOR (active low)
When the \overline{CU} is held low, the DL-1416 enables the user to write or remove a cursor in any digit position. The cursor function lights all 16 segments in the selected digits without erasing the data. After the cursor is removed, the digit will again display the previously written character.
- $V+$ POSITIVE SUPPLY
TTL compatible + 5 volts
- $V-$ NEGATIVE SUPPLY
Ground

CHARACTER SET

| | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 |
|-------------|----|----|----|----|----|----|----|----|
| D0 | L | H | L | H | L | H | L | H |
| D1 | L | L | L | H | L | L | H | H |
| D2 | L | L | L | L | L | H | H | H |
| D6 D5 D4 D3 | | | | | | | | |
| L H L L | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| L H L H | < | > | * | + | / | -- | - | / |
| L H H L | 8 | 9 | : | ; | ∠ | = | ∆ | ? |
| H L L L | a | A | B | C | D | E | F | G |
| H L L H | H | I | J | K | L | M | N | O |
| H L H L | P | Q | R | S | T | U | V | W |
| H L H H | X | Y | Z | [| \ |] | ^ | _ |

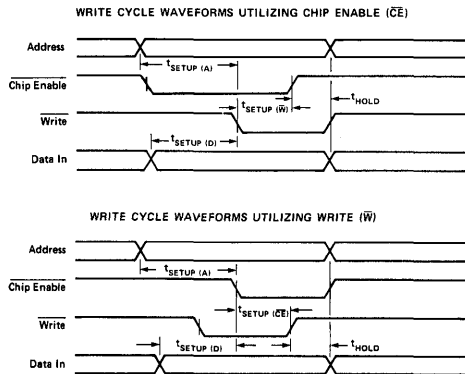
Note: All undefined codes will display a blank.

TABLE 1

OPERATION

Loading data into the DL-1416 is similar to writing into a RAM. The data and address must be present before the leading edge of the write signal (\overline{W}) and must be present until after the trailing edge. The waveforms of Figure 2 demonstrate the relationship of the signals required to generate a write cycle utilizing chip enable (\overline{CE}) and write (\overline{W}) (Check data sheet for minimum values).

As can be seen from the waveforms, \overline{CE} and \overline{W} are interchangeable. The true internal "write" function is formed by the "and-of-the-nots".



ADDRESS TABLE
FIGURE 2

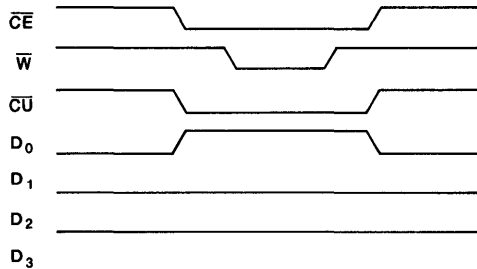
Multiplexed display systems sequentially read and display data from a memory device. In *synchronous* systems, control circuitry must compare the location of data to be read and displayed to the location of new data to be stored, i.e. synchronize, before a write can be done. This can be slow if there are many memory locations. It can also be cumbersome.

Data entry of the DL-1416 is *asynchronous* and data may be stored in random order. Each digit will continue to display the character last "written" until replaced by another.

The cursor function causes all 16 segments of a digit to light. The cursor can indicate the position in the display of the next character to be entered. The cursor *is not* a character but overrides display of the stored character. Upon removal of the cursor, the display will again show the character stored in memory.

The cursor can be written into any digit position by enabling chip enable (\overline{CE}), cursor (\overline{CU}), the positional data, and a write (\overline{W}) signal. The position of the cursor will be dependent on which of the first four data lines (D_0 , D_1 , D_2 , D_3) are held high. A

line D_3 will place a cursor display in the left-most digit. The cursor can be loaded into, or erased from more than one position simultaneously by simply holding more than one data line high during the cursor write cycle.



CURSOR WRITE CYCLE
FIGURE 3

The cursor will remain displayed after the cursor (\overline{CU}) and write (\overline{W}) signals have been removed. The wave forms in Figure 3 show a cursor being placed in Digit 0 and erased from Digit 1, Digit 2, and Digit 3 simultaneously.

Hardwiring the cursor (\overline{CU}) line high is not recommended. This internal cursor memory will be randomly loaded on power-up and all positions must be cleared before a cursor-free display is ensured.

GENERAL CIRCUIT DESIGN CONSIDERATIONS

Using positive-true address logic, address order is from right to left. For left to right address order, use the "ones-complement" or simple inversion of the addresses.

For systems with only a 6 bit ASCII code format, data line D_6 cannot be left open. Data D_6 must be the complement of data line D_5 . If an illegal code is loaded into the DL-1416, it will display a blank in the digit accessed.

A "display test" function can be realized by simply storing a cursor in all digits simultaneously. This is done by holding D_0 , D_1 , D_2 and D_3 high and \overline{CU} low during a cursor write cycle. The same operation, with the data lines low will end "display test".

Because of the random state of the cursor RAM after power up, it is necessary to clear it initially to assure that all the cursors are off.

When using DL-1416's on a separate display board having more than 6 inches of cable length, it may be necessary to buffer all DL-1416 inputs. This is most easily achieved with hex-non-inverting buffers such as 74365 IC's. The object is to prevent transient current in the DL-1416 protection diodes. The buffers should be located on the display board near the DL-1416's. Local power supply bypass capacitors are also needed in many cases. These should be 6 or 10 volt tantalum type having 10 μ F or greater capacitance. Low internal resistance is important to elimi-

If small wire cables are used, it is good engineering practice to calculate the wire resistance of the ground plus the +5 volt wires. More than 0.1 volt drop (at 25mA per digit worst case) should be avoided, since this loss is in addition to any inaccuracies or load regulation limitations of the power supply.

GENERAL INTERFACE

The most general and straight-forward interface approach would be to use the parallel I/O device of a microprocessor. This interface scheme can be completely software dependent. One eight bit output port can handle the seven input data bits and the cursor. Another eight bit output port can contain the address and chip enable information with one bit reserved for the write signal.

An 8080 system shown in Figure 4 illustrates a 16 character display using a 8255 programmable peripheral interface I/O device with a 7442 one-of-ten decoder added for ease of programming. The following program will display a simple 16 character message using the parallel I/O interface.

| | | |
|--------|---------------|-------------------------|
| INIT: | MVI A, 80H; | control data mode 0 |
| | OUT CONTROL; | load control register |
| CUSR: | MVI A, 00H; | clear cursor data |
| | OUT PORTA; | load data port |
| | MVI B, 0FH; | set counter |
| CUSR1: | MOV A, B | |
| | CALL DSPWT; | write subroutine |
| | DCR B; | decrement counter |
| | JNZ CUSR1; | 16 characters |
| DISP: | LXI H, TABLE; | set table |
| DISP1: | MOV A, M | |
| | OUT PORTA; | load data output |
| | MOV A, B | |
| | CALL DSPWT; | load address & write |
| | INX H; | increment table address |
| | INR B; | increment counter |
| | MVI A, 10H; | set # of digits |
| | CMP B | |
| | JNZ DISP1; | 16 characters |
| | HLT; | end of program |
| DSPWT: | ORI 80H; | set write bit off |
| | OUT PORTB; | load address |
| | ANI 7FH; | set write bit on |
| | OUT PORTB; | load write |
| | ORI 80H; | set write bit off |
| | OUT PORTB; | load write |
| | RET | |
| TABLE: | DB | 0C3H |
| | DB | 0C9H |
| | DB | 0D4H |
| | DB | 0D3H |
| | DB | 0C1H |
| | DB | 0D4H |
| | DB | 0CEH |
| | DB | 0C1H |
| | DB | 0C6H |
| | DB | 0A0H |
| | DB | 0D3H |
| | DB | 0D4H |
| | DB | 0C8H |
| | DB | 0C7H |
| | DB | 0C9H |
| | DB | 0CCH |

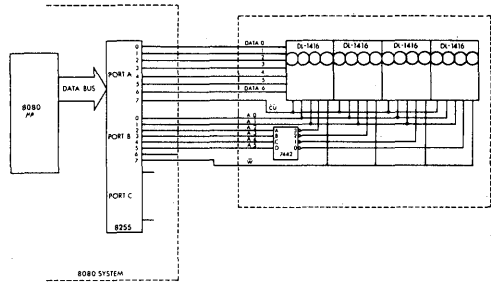


FIGURE 4

I/O OR MEMORY MAPPED ADDRESSING

Some designers may wish to avoid the additional cost of a parallel I/O device in their system. Structuring the addressing architecture for the DL-1416 to look like a set of output devices (I/O mapped) or RAM's, ROM's (memory mapped) is ideal. However, the set-up and hold times of the DL-1416 are too slow for some present μ P's running at maximum speed.

To operate at maximum clock rates, the processor must be made to pause for the required display write cycle interval.

DL 1416/8080 INTERFACE

Microprocessors like the 8080 and Z80 have the ability to generate "wait states" for use with relatively slow memories. Figure 5 shows a circuit which utilizes "wait states" to interface the DL-1416 display to an 8080 system with a T cycle = 500 nS.

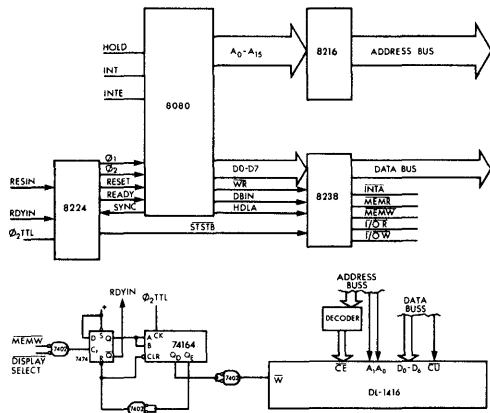


FIGURE 5

The signal $\overline{\text{MEMW}} \bullet \overline{\text{DISPLAY SELECT}}$ defines a DL-1416 display write cycle and initiates the RDYIN signal. $\overline{\text{MEMW}}$ alone would generate wait states for all write cycles and would slow down total computation. The shift register, 74164, is useful for generating a DL-1416 write signal which meets the setup times for different processor clock rates. The timing diagram, Figure 6, illustrates the relationship between write, wait, and DL-1416 write.

*Note: System controller 8238 required for an early MEMW signal.

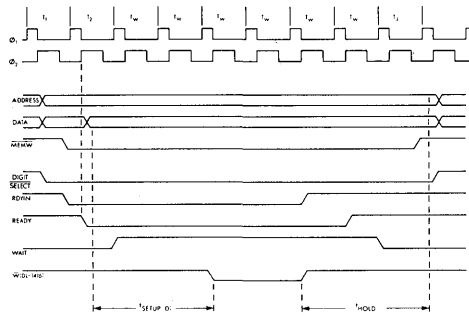


FIGURE 6

DL-1416/Z80 INTERFACE

The organization of the Z80 is very similar to the 8080 processor. Both processors utilize wait states for slow memory and, as can be seen in Figure 7, the interface can be identical to the 8080 System. For T cycle = 500 nS, only signal names are different.

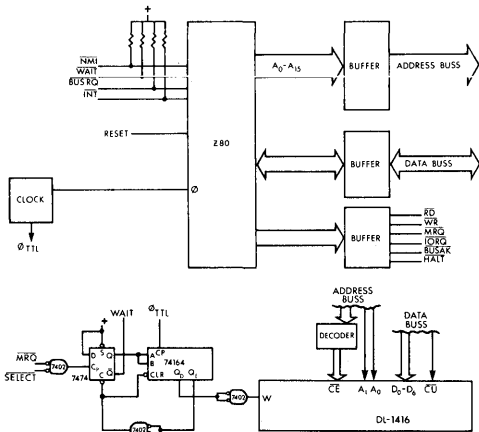


FIGURE 7

DL-1416/6800 Interface

For processors such as the 6800 that do not have wait state capability, clock pulse stretching techniques can be used. Microprocessor clocks such as the Motorola MC6871B have the ability to hold either $\phi 1$ or $\phi 2$. Figure 8 uses the same interface techniques as for the 8080 and Z80. The signal $\overline{\text{H2}}$ extends the $\phi 2$ clock. All address and data lines will remain valid until $\overline{\text{H2}}$ is released. $\overline{\text{H2}}$ was taken from the output of the first stage of the shift register in this case to synchronize with $\phi 2$; otherwise a narrow $\phi 1$ may result.

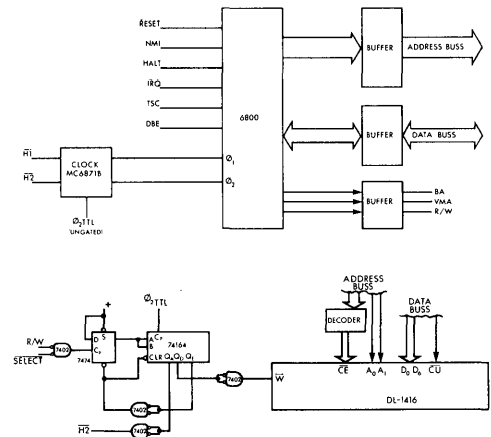


FIGURE 8

CONCLUSION

The interface schemes shown demonstrate the general simplicity of DL-1416 use with microprocessors. The differences among the examples are in providing proper write signals. Because of the setup and hold times of the DL-1416, many microprocessor systems will require some type of interface circuitry for compatibility. The techniques used in these examples were chosen for their versatility in accepting a wide range of clock rates. The user will undoubtedly invent other schemes to optimize his particular system to its requirements.

This application note is not intended to imply specific endorsement or warranty of other manufacturer's products by Litronix.

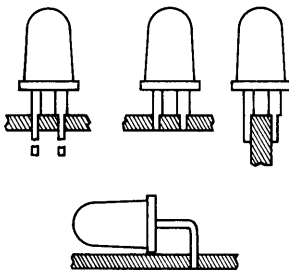
MOUNTING CONSIDERATIONS FOR LED LAMPS AND DISPLAYS

by Dave Takagishi

There are numerous ways to mount an LED lamp into a panel or a piece of equipment and this application note is written as an aid to designers and engineers when using LED lamps and displays.

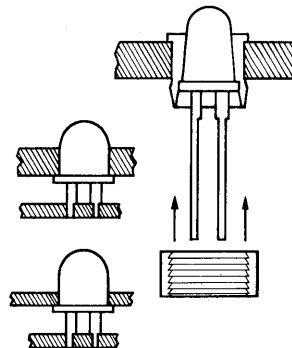
MOUNTING TECHNIQUES:

There are several ways to mount LED lamps such as the Litronix RL2000 by soldering directly into PCB's, plugging into sockets, or panel mounting with or without clips. Bending of the leads is allowed bearing the following guidelines in mind. Leads must not be bent closer than 0.65 inches from the base of case when leads are not in excess of .020 inch in diameter. Leads should be clamped next to the case during bending of leads to relieve stresses. Under no circumstances must any mechanical force be applied to case while bending the leads. Also, incorrectly spaced holes in the printed circuit board will place mechanical stress on the plastic case which can cause failure during soldering.



Displays of the DL747 or DL707 type can be soldered directly into a printed circuit board or be plugged into sockets. Stick display products such as the DL4530 can be plugged into a connector or soldered to a cable directly. Stick products can also be provided with pins suitable for soldering or special clip-on pins can be flow soldered directly to the board such as from Precision Concepts. Many displays

can be end-stacked (butted end-to-end) to obtain longer displays with more digits. This usually causes no break in digit spacing. In applications using screw-down mounting, a flexible washer should be used to avoid strain from misalignment or board warpage.



Connector/Socket Suppliers

| Connector/Socket Suppliers | | (Partial List) | | | | | | | | | |
|----------------------------|-------|----------------|-----|-----------------|-------------------------|----------------|---------------|--------------------|----------------|-----------------|-------------|
| Aries | Augat | Berg | EMC | Robinson Nugent | Precision Concept, Inc. | Frenchtown, NJ | Attleboro, MA | New Cumberland, PA | Woonsocket, RI | New Albany, IND | Bohemia, NY |

THERMAL CONSIDERATIONS:

Most LED failures can be traced to excess thermal stress. A typical LED chip is mounted on a substrate or lead frame with a wire bond from the top of the chip to a metallized trace on the substrate and is encapsulated in epoxy. Temperature changes cause these various materials to expand and contract at different rates. Extreme low temperatures are most likely to cause structural failure. High temperatures, usually cause reduced lifetime rather than immediate failures.

The internal LED junction temperature depends on ambient temperature, power applied to the LED, and the thermal resistance, LED chip-to-ambient.

Long-term degradation of the LED chips, causing reduced light output, will occur if junction temperature exceeds 125 deg. C. Also the epoxy material overcoating the LED chips may gradually become opaque if it is subjected to temperatures above 125 deg. C.

For these reasons, all Litronix LED products carry derating specifications designed to limit LED junction temperature to 100 deg. C.

Particular care is needed in designing multiplexed systems. Here, increased forward voltage and the effects of the thermal time constant, chip to ambient (about 10mS typical) can cause "thermal ripple" peak excursions above 100 deg. C while calculated average temperature is much lower.

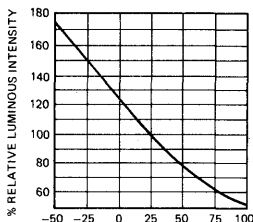
A separate reason for keeping LED chip temperature down is the reduced light output, shown in Figure 1. One can reach a point of diminishing returns, particularly in multiplexed systems, in which an increase in current reduces reliability while actually resulting in little or no increase in display visibility. In such cases, one would be well advised to put his money in higher brightness-grade displays.

A well-designed display system, especially if high power levels or multiplexed operations are involved, should:

1. Allow for convection airflow around the display.
2. Place other heat-generating components* either away from or above, but never below the display (*Display current-control resistors, for example).
3. Take the increased forward voltage and "thermal ripple" peaks into account, in multiplexed systems, and not allow peak temperature to exceed 100 deg. C.

In common with many semiconductor products, LED displays offer the user the most reliable and longest lifetime product available. These good properties do depend, however, on proper usage. Semiconductor products are well-known to be rather unforgiving of abuse when compared to the older technologies. LED's are not different, they are, in fact, hybrid integrated circuits.

LUMINOUS INTENSITY VS AMBIENT TEMPERATURE



SOLDERING CONSIDERATIONS:

Care should be taken not to overheat LED's when soldering. Effectiveness and safety in soldering are related to three basic parameters: temperature, time, and distance. In general, soldering time should not exceed 3 seconds at 1/16 inch from case at 260°C. Some packages allow greater latitude, as indicated on individual data sheets.

OPTICAL CONSIDERATIONS:

Litronix recommends the use of a contrast enhancing filter in front of LED displays. This filter will increase the contrast ratio of digit to surrounding area and help remove reflected light and glare from the PCB and components around the display. Insetting the display to reduce direct ambient light on the display should also be considered.

Litronix displays have been designed to maximize contrast ratio. Displays such as the DL747 series have a black matte plastic cap surrounding the segments. Some multi-digit displays have a red cap to enhance the contrast. Other displays with clear caps will require a filter.

ROHM & HAAS red "Plexiglass" #2423 makes a good general purpose filter for the 640-660 nm Peak Emission Wavelength of red LEDs. A 1/16 inch thick sheet of this inexpensive material is quite effective. Additional information on this and other filter materials may be obtained by contacting the following suppliers:

| | |
|--------------|-------------------|
| ROHM & HAAS | Philadelphia, PA |
| HOMALITE | Wilmington, DEL |
| PANELGRAPHIC | West Caldwell, NJ |
| 3M | St. Paul, MIN |
| POLAROID | Cambridge, MASS |

FOR RED LEDS

| | |
|--------------|-------------------|
| ROHM & HAAS | Plexiglass 2423 |
| HOMALITE | 1670, 1605 |
| PANELGRAPHIC | Red 60, Red 63, |
| | Red 65, Purple 90 |
| POLAROID | HRCF |

FOR GREEN LEDS

| | |
|--------------|-----------------|
| ROHM & HAAS | Plexiglas 38168 |
| PANELGRAPHIC | Green 48 |
| HOMALITE | 1425, 1440 |

FOR YELLOW LEDS

| | |
|---------------|---------------------|
| PANELGRAPHICS | Yellow 25, Amber 23 |
| HOMALITE | 1720, 1726 |

NEUTRAL DENSITY FILTER

| | |
|----------|-----------------|
| HOMALITE | Neutral Gray 10 |
|----------|-----------------|

DISPLAYING MESSAGE SYSTEMS WITHOUT A MICROPROCESSOR

by Dave Takagishi

The DL-1416, 4 digit 16 segment, alphanumeric "Intelligent" display, and succeeding products in the family, have on board memory, decoder and drive circuitry. This makes it particularly well suited to marry directly to a microprocessor. However, small multi-message systems of 4, 8, 12, 16 character length need not have a microprocessor to drive the Alpha-Numeric Display. The DL-1416 with the aid of PROM can combine lighted indicators, status displays, annunciator messages or symbols, or a "canned message" into a single display.

ANNUNCIATOR DISPLAYS

An automobile, for example, has several switches each lighting its own status or annunciator indicator. A single DL-1416 Alphanumeric Display could easily display messages alternately upon interrogation of the appropriate switches.

The circuit shown in Figure 1 will display four character messages sequentially for each open switch and continue to display until switches are returned to their normally closed positions. The Counters U4 and U5 address the PROM U6 and select switches on U1. The Data Selector, U1, sequentially selects one of eight switches (oil, temperature, catalytic, generator, brake, door, belt, and null). The eighth switch or null state can display a blank for a normal or off condition. The output of U1 enables the DL-1416, \overline{CE} . When this signal goes high, the Monostable, U2, will fire and inhibit the Oscillator U3 for approximately a two second display time. The PROM, U6, generates the ASCII code data for each word. Expansion of the display can easily be achieved by adding a PROM for each additional DL-1416.

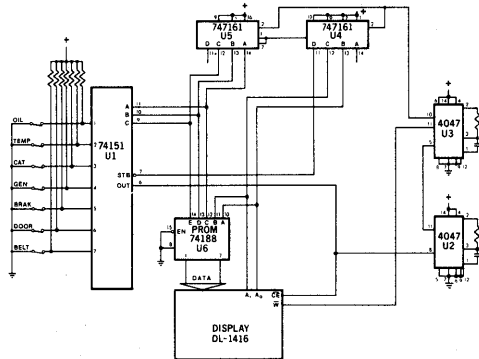


FIGURE 1

Another annunciator type display is shown in Figure 2. This display has a message of up to 16 characters and will continue to display the same line until the 6 bit input code changes state. With this scheme, it can be seen that the 16 character X64 line message PROM can easily be adapted for other message and character length combinations.

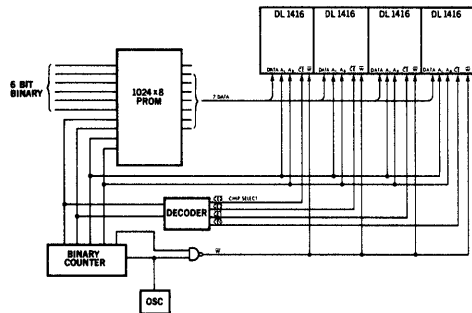


FIGURE 2
TYPICAL CIRCUIT FOR
64 MESSAGES OF 16 CHARACTERS LONG

CANNED MESSAGES

The canned message type display can be an ideal sales, marketing or instructional aid. The message can be altered by replacing the PROM.

The technique for this display would be to sequentially display a word or group of words, depending on the character length of the display, through the entire message. The system could either continue to repeat itself or could go through the complete sequence once each time a switch is operated.

Figure 3 is the schematic for a sales demo box for the DL-1416. A 256X8 PROM was used to display an 8 digit-32 word message. The oscillator, U1, increments the counters U2-U4 providing the address for the DL1416's and PROM U9. After eight counts the monostable U10 is fired, inhibiting the oscillator for a two second display time. Devices U5 and U8 were added for cursor control. Decoder U8 will alternately enable or disable a data bit for a cursor to proceed writing new data into each digit. The multiplexer U5 will select the character data or the cursor data for the D0-D3 data lines. Inverters on the address lines cause data entry to occur from the left rather than from the right.

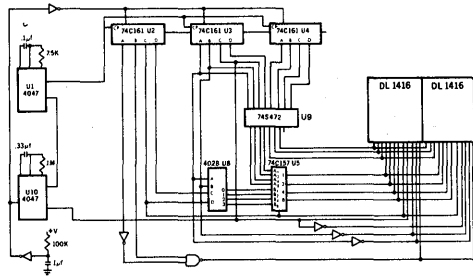


FIGURE 3

Applying the DL-2416 Intelligent Display®

by Dave Takagishi

This application note is intended to serve as a design and application guide for users of the DL-2416 alphanumeric intelligent display. The information presented covers device electrical description and operation, considerations for general circuit design, and interfacing the DL-2416 to microprocessors.

ELECTRICAL & MECHANICAL DESCRIPTION

The internal electronics in the DL-2416 intelligent display eliminates all the traditional difficulties of using multi-digit light emitting displays (segment decoding, drivers, and multiplexing). The intelligent display also provides internal memory for the four digits. This approach allows the user to asynchronously address one of four digits, and load new data without regard to the LED multiplex timing.

Figure 1 is a block diagram of the DL-2416. The unit consists of four 17-segment monolithic LED die and a single CMOS integrated circuit chip. The LED die are magnified to a height of 160 mils by built-in lenses. The IC chip contains 17 segment drivers, four digit drivers, 64 character ROM, four word x 7 bit Random Access Memory, oscillator for multiplexing, multiplex counter/decoder, cursor memory, address decoder, and Miscellaneous Control logic.

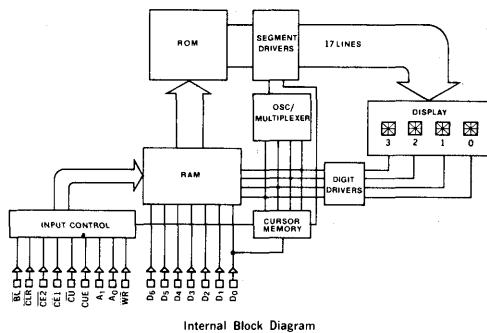
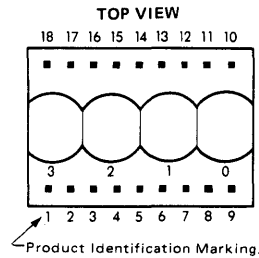


Figure 1

PACKAGING

Packaging consists of a transfer-molded lexan or nylon lens which also serves as a "encapsulation shell" since it covers five of the six "faces". The assembled and tested substrate (ceramic or "PTF" multilayer), is placed within the shell and the entire assembly is then filled with a water-clear IC-grade epoxy.

This yields a very rugged part, which is quite impervious to moisture, shock and vibration. Although not "hermetic", the device will easily withstand total immersion in water/detergent solutions.



| Pin | Function | Pin | Function |
|-----|-------------------|-----|------------------|
| 1 | CE1 Chip Enable | 10 | Gnd |
| 2 | CE2 Chip Enable | 11 | D0 Data Input |
| 3 | CLR Clear | 12 | D1 Data Input |
| 4 | CUE Cursor Enable | 13 | D2 Data Input |
| 5 | CU Cursor Select | 14 | D3 Data Input |
| 6 | WR Write | 15 | D6 Data Input |
| 7 | A1 Digit Select | 16 | D5 Data Input |
| 8 | A0 Digit Select | 17 | D4 Data Input |
| 9 | VCC | 18 | BT Display Blank |

Figure 2

ELECTRICAL INPUTS TO THE DL-2416

- VCC** Positive supply +5 volts
- Gnd** Ground
- D0-D6** Data Lines
The seven data input lines are designed to accept the first 64 ASCII characters. See Figure 3 for character set. (The DL-2416 interprets all undefined codes as a blank).
- A0, A1** Address Lines
The address determines the digit position to which the data will be written. Address order is right to left for positive-true logic.
- WR** Write (Active Low)
Data and address to be loaded must be present and stable before and after the trailing edge of write. (See data sheet for timing information).
- CE1, CE2** Chip Enable (Active Low)
This determines which device in an array will actually accept data. When either or both chip enable is in the high state, all inputs are inhibited.
- CLR** Clear (Active Low)
When held low for 15 mS, the data RAM will be cleared.
- CUE** Cursor Enable. Activates Cursor function.

When using DL-2416's on a separate display board having more than 6 inches of cable length, it may be necessary to buffer all DL-2416 inputs. This is most easily achieved with Hex non-inverting buffers such as the 74365. The object is to prevent transient current in the DL-2416 protection diodes. The buffers should be located on the display board near the DL-2416's.

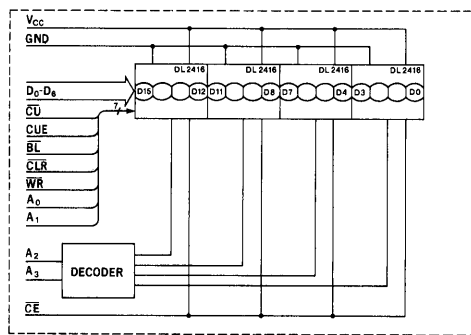
Local power supply bypass capacitors are also needed in many cases. These should be 6 or 10 volt, tantalum type having 10 μF or greater capacitance. Low internal resistance is important due to current steps which result from the internal multiplexing of the DL-2416.

If small wire cables are used, it is good engineering practice to calculate the wire resistance of the ground plus the +5 volt wires. More than 0.1 volt drop, (at 25mA per digit worst cast) should be avoided, since this loss is in addition to any inaccuracies or load regulation limitations of the power supply.

The 5-volt power supply for the DL-2416's should be the same one supplying V_{CC} to all logic devices which drive the display devices. If a separate supply must be used, then local buffers using hex non-inverting gates should be used on all DL-2416 inputs and these buffers should be powered from the display power supply. This precaution is to avoid logic inputs higher than display V_{CC} during power up or line transients.

INTERFACING THE DL-2416

A general and straight-forward interface circuit is shown in Figure 6. This scheme can easily interface to μP systems or any other systems which can provide the seven data lines, appropriate address and control lines.



GENERAL INTERFACE CIRCUIT

Figure 6

PARALLEL I/O

The parallel I/O device of a microprocessor can easily be connected to the circuit in Figure 6. One eight bit output port can provide the seven input data bits and the cursor (CU). Another eight bit output port can

contain the address and chip enable information and the other control signals.

Figure 7. illustrates a 16-character display with an 8080 system using the 8255 programmable peripheral interface I/O device. The following program will display a simple 16-character message using this interface.

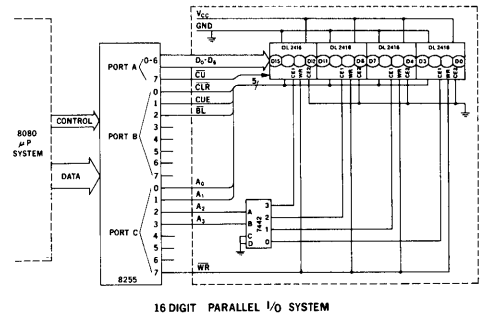


Figure 7

```

INIT:   MVI A,80H      ; CONTROL DATA MODE  $\phi$ 
        OUT CONTROL  ; LOAD CONTROL REGISTER
CUSR:   MVI A,00H    ; CLEAR CURSOR DATA
        OUT PORT A   ; LOAD DATA PORT
        MVI B,0FH    ; SET CHARACTER COUNTER
CUSRI:  MOV A, B
        CALL DSPWPT  ; WRITE SUBROUTINE
        DCR B        ; DECREMENT COUNTER
        JNZ CUSRI   ; DIGIT  $\phi$ ?
        MOV A, B
        CALL DSPWPT
        MVI A, FFH   ; SET DATA FOR CONTROL
        OUT PORT B   ; LOAD CONTROL LINES
DISP:   LXI H, TABLE ; SET TABLE ADDRESS
DISP1:  MOV A, M     ; MOVE TABLE DATA INTO ACCUMULATOR
        OUT PORT A   ; LOAD DATA PORT
        MOV A, B
        CALL DSPWPT  ; LOAD ADDRESS AND CONTROL
        INX H        ; INCREMENT TABLE ADDRESS
        INR B        ; INCREMENT COUNTER
        MVI A, 10H  ; SET # OF DIGITS
        CMP B
        JNZ DISP1   ; 16 CHARACTERS?
        HALT        ; END OF PROGRAM
DSPWPT: ORI FOH     ; SET CONTROL BITS OFF
        OUT PORT C   ; LOAD CONTROL
        ANI 7FH     ; SET WRITE BIT ON
        OUT PORT C   ; LOAD WRITE
        ORI FOH     ; SET WRITE BIT OFF
        OUT PORT C   ; LOAD CONTROL
        RET
TABLE:  DB          ; 0C3H
        DB          ; 0C9H
        DB          ; 0D4H
        DB          ; 0D3H
        DB          ; 0C1H
        DB          ; 0D4H
        DB          ; 0CEH
        DB          ; 0C1H
        DB          ; 0C6H
        DB          ; 0A0H
        DB          ; 0D3H
        DB          ; 0D4H
        DB          ; 0C8H
        DB          ; 0C7H
        DB          ; 0C9H
        DB          ; 0CCH
    
```


APPLYING THE DL-1414 Intelligent Display®

by Dave Takagishi

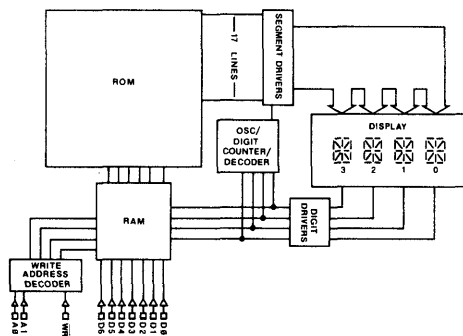
This application note is intended to serve as a design and application guide for users of the DL-1414 alpha-numeric intelligent display. The information presented covers device electrical description and operation, considerations for general circuit design, and interfacing the DL-1414 to microprocessors.

ELECTRICAL & MECHANICAL DESCRIPTION

General

The internal electronics in the DL-1414 intelligent display eliminates all the traditional difficulties of using multi-digit light emitting displays (segment decoding, drivers and multiplexing). The intelligent display also provides internal memory for the four digits. This approach allows the user to asynchronously address one of four digits, and load new data without regard to the LED multiplex timing.

Figure 1 is a block diagram of the DL-1414. The unit consists of four 17 segment monolithic LED die and a single CMOS integrated circuit chip. The LED die are magnified to a height of 112 mils by the built-in lenses. The IC chip contains 17 segment drivers, four digit drivers, 64 character ROM, four word x 7 bit Random Access Memory, oscillator for multiplexing, multiplex counter/decoder, address decoder and miscellaneous control logic.



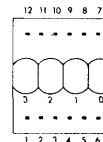
DL-1414 Block Diagram

FIGURE 1

PACKAGING

Packaging consists of an injection-molded plastic lens which also serves as an "encapsulation shell" since it covers five of the six "faces". The assembled and tested substrate (ceramic or "PTF" multilayer) is placed within the shell and the entire assembly is then filled with a water-clear IC-grade epoxy.

This yields a very rugged part which is quite impervious to moisture, shock and vibration. Although not "hermetic", the device will easily withstand total immersion in water/detergent solutions.



TOP VIEW

| Pin | Function | Pin | Function |
|-----|-----------------|-----|---------------------|
| 1 | D5 Data Input | 7 | Gnd |
| 2 | D4 Data Input | 8 | D0 Data Input (LSB) |
| 3 | WR Write | 9 | D1 Data Input |
| 4 | A1 Digit Select | 10 | D2 Data Input |
| 5 | A0 Digit Select | 11 | D3 Data Input |
| 6 | VCC | 12 | D6 Data Input (MSB) |

PIN FUNCTION

FIGURE 2

ELECTRICAL INPUTS TO THE DL-1414

- V_{CC} POSITIVE SUPPLY +5 volts
- Gnd GROUND
- D0-D6 DATA LINES

The seven data input lines are designed to accept the first 64 ASCII characters. See Figure 3 for character set. (The DL-1414 interprets all undefined codes as a blank).

A₀, A₁ ADDRESS LINES

The address determines the digit position to which the data will be written. Address order is right to left for positive-true logic.

WR

WRITE (Active Low).

Data and address to be loaded must be present and stable before and after the trailing edge of write. (See data sheet for timing info).

| D0 | L | H | L | H | L | H | L | H | L | H |
|-------------|---|---|---|---|---|---|---|---|---|---|
| D1 | L | L | H | H | L | L | H | H | L | L |
| D2 | L | L | L | L | L | H | H | H | H | H |
| D6 D5 D4 D3 | | | | | | | | | | |
| L H L L L | | . | " | 8 | 9 | % | ¢ | ' | | |
| L H L H H | | < | > | * | + | / | - | . | / | |
| L H H L L | | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | |
| L H H H H | | 8 | 9 | - | / | < | = | > | ? | |
| H L L L L | | a | A | B | C | D | E | F | G | |
| H L L L H | | H | I | J | K | L | M | N | O | |
| H L H L L | | P | Q | R | S | T | U | V | W | |
| H L H H H | | X | Y | Z | [| \ |] | ^ | _ | |

All Other Input Codes Display "Blank"

CHARACTER SET

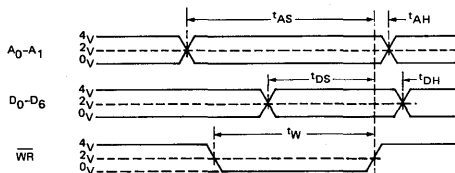
FIGURE 3

OPERATION

Multiplexed display systems sequentially read and display data from a memory device. In synchronous systems, control circuitry must compare the location of data to be read to the location or position of new data to be stored or displayed, i.e., synchronize before a Write can be done. This can be slow and cumbersome.

Data entry in "intelligent displays" is asynchronous and may be done in any random order. Loading data is similar to writing into a RAM. Each digit has its own memory location and will display until replaced by another code.

The waveforms of Figure 4 demonstrate the relationships of the signals required to generate a Write cycle. (Check individual data sheet for minimum values.) As can be seen from the waveforms, all signals are referenced from the rising or trailing edge of Write.



WRITE CYCLE WAVEFORM

FIGURE 4

| WR | ADDRESS | | DATA INPUT | | | | | | | DIGIT 3 | DIGIT 2 | DIGIT 1 | DIGIT 0 |
|----|----------------|----------------|------------|----|----|----|----|----|----|-------------------|-----------|-----------|-----------|
| | A ₁ | A ₀ | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | | |
| H | X | X | X | X | X | X | X | X | X | NO CHANGE | NO CHANGE | NO CHANGE | NO CHANGE |
| L | L | L | H | L | L | L | L | L | H | NO CHANGE | NO CHANGE | NO CHANGE | A |
| L | L | H | H | L | L | L | L | H | L | NO CHANGE | NO CHANGE | B | A |
| L | H | L | H | L | L | L | L | H | H | NO CHANGE | C | B | A |
| L | H | H | H | L | L | L | H | L | L | D | C | B | A |
| L | L | L | H | L | L | L | H | L | H | D | C | B | E |
| L | H | L | H | L | L | H | L | H | H | D | K | B | E |
| L | - | - | - | - | - | - | - | - | - | SEE CHARACTER SET | | | |

X = DON'T CARE

DATA LOADING TABLE

FIGURE 5

GENERAL DESIGN CONSIDERATIONS

Using positive true logic, address order is from right to left. For left to right address order, use the "ones complement" or simple inversion of the addresses.

For systems with only a 6-bit (abbreviated ASCII) code format, Data Line D6 cannot be left open. Data D6 must be the complement of Data Line D5.

When using DL-1414's on a separate display board having more than 6 inches of cable length, it may be necessary to buffer all DL-1414 inputs. This is most easily achieved with Hex non-inverting buffers such as the 74365. The object is to prevent transient current in the DL-1414 protection diodes. The buffers should be located on the display board near the DL-1414's.

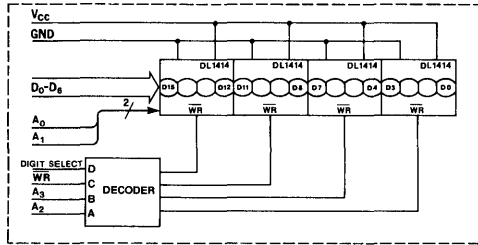
Local power supply bypass capacitors are also needed in many cases. These should be 6 or 10 volt, tantalum type having 10 μ F or greater capacitance. Low internal resistance is important due to current steps which result from the internal multiplexing of the DL-1414.

If small wire cables are used, it is good engineering practice to calculate the wire resistance of the ground plus the +5 volt wires. More than 0.1 volt drop, (at 25 mA per digit worst case) should be avoided, since this loss is in addition to any inaccuracies or load regulation limitations of the power supply.

The 5-volt power supply for the DL-1414's should be the same one supplying V_{CC} to all logic devices which drive the display devices. If a separate supply must be used, then local buffers using hex, non-inverting gates should be used on all DL-1414 inputs and these buffers should be powered from the display power supply. This precaution is to avoid logic inputs higher than display V_{CC} during power up or line transients.

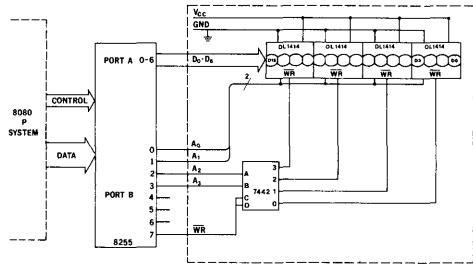
INTERFACING THE DL-1414

A general and straight-forward interface circuit is shown in Figure 6. This scheme can easily interface to μ P systems or any other systems which can provide the seven data lines, appropriate address and control lines.



GENERAL INTERFACE CIRCUIT

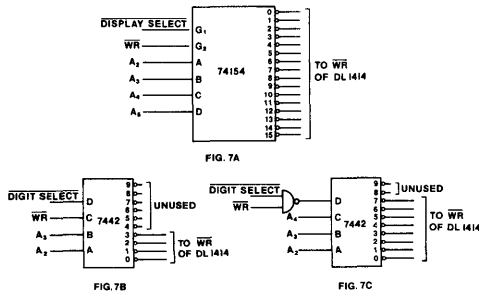
FIGURE 6



16 DIGIT PARALLEL I/O SYSTEM

FIGURE 8

The DL-1414 does not have a chip enable input. Therefore, each DL-1414 in a system requires its Write pulse be gated with appropriate address signals. Figure 7A shows the use of a 74154 decoder (4 line to 16 line) for up to a 64 character display. Using the G1 input for display select (address select in a memory mapped system) and the G2 input to gate the Write signal. Another approach (Figure 7B & 7C) which minimizes logic for a 16 or 32 digit display takes advantage of decoding scheme of the 7442 decoder.



GATING THE WRITE PULSE

FIGURE 7

SAMPLE I/O PROGRAM

```

INIT:  MVI A,80H ; CONTROL DATA MODE 0
        OUT CONTROL ; LOAD CONTROL REGISTER
        MVI B,00H ; SET COUNTER = 0
DISP:  LXI H,TABLE ; SET TABLE ADDRESS
DISP1: MOV A,M ; MOVE TABLE DATA TO ACCUMULATOR
        OUT PORTA ; LOAD DATA PORT
        MOV A,B ; LOAD ADDRESS AND CONTROL
        CALL DSPWT ; INCREMENT TABLE ADDRESS
        INX H ; INCREMENT COUNTER
        INR B ; SET # OF DIGITS
        CMP B ; 16 CHARACTERS ?
        JNZ DISP1 ; END OF PROGRAM
DSPWT: ORI F0H ; SET CONTROL BITS OFF
        OUT PORTB ; LOAD CONTROL
        ANI 7FH ; SET WRITE BIT ON
        OUT PORTB ; LOAD WRITE
        ORI F0H ; SET WRITE BIT OFF
        OUT PORTB ; LOAD CONTROL
        RET
TABLE: DL ; 0C3H
        DB ; 0C9H
        DB ; 0D4H
        DB ; 0D3H
        DB ; 0C1H
        DB ; 0D4H
        DB ; 0CEH
        DB ; 0C1H
        DB ; 0C6H
        DB ; 0A0H
        DB ; 0D3H
        DB ; 0D4H
        DB ; 0C8H
        DB ; 0C7H
        DB ; 0C9H
        DB ; 0CCH
    
```

PARALLEL I/O

The parallel I/O device of a microprocessor can easily be connected to the circuit in Figure 6. One eight bit output port can provide the seven input data bits. Another eight bit output port can contain the address and control signals.

Figure 8 illustrates a 16-character display with an 8080 system using the 8255 programmable peripheral interface I/O device. The following program will display a simple 16-character message using this interface.

I/O OR MEMORY MAPPED ADDRESSING

Some designers may wish to avoid the additional cost of a parallel I/O in their system. Structuring the addressing architecture for the DL-1414 to look like a set of peripheral or output devices (I/O mapped) or RAM's and ROM's (memory mapped), is very easy. Figure 9 shows the simplicity of interfacing to microprocessors, such as 8080, Z80 and 6502 as examples.

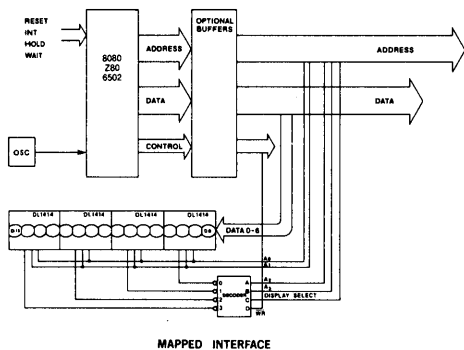


FIGURE 9

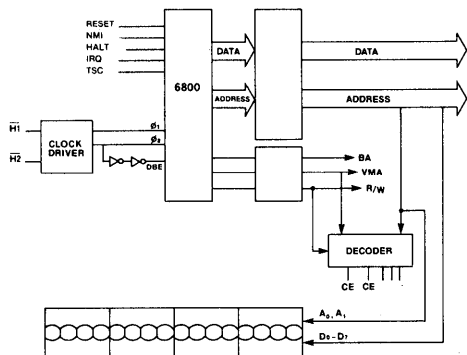


FIGURE 10

The interface with the 6800 microprocessor in Figure 10 illustrates the need for designers to check the timing requirements of the DL-1414 and the μP . The typical data output hold time is only 30 ns for $DBE = \phi 2$ timing; two inverters in the DBE line are added to increase the data output hold time for compatibility with the 50 ns minimum spec of the DL-1414.

CONCLUSION

Note that although other manufacturer's products are used in examples, this application note does not imply specific endorsement, or recommendation or warranty of other manufacturer's products by Litronix.

The interface schemes shown demonstrate the simplicity of using the DL-1414 with microprocessors. The slight differences encountered with different microprocessors to interface with the DL-1414 are similar to those encountered when using different RAM's. The techniques used in the examples were shown for their generality. The user will undoubtedly invent other schemes to optimize his particular system to its requirements.

SILICON PHOTOVOLTAIC CELLS, SILICON PHOTODIODES AND PHOTOTRANSISTORS

Optoelectronic components are increasingly used in modern electronics. Main fields of application are light barriers for production control and safety devices, light control and regulating equipment like twilight switches, fire detectors and facilities for optical heat supervision, scanning of punched cards and perforated tapes, positioning of machine tools (for measuring length, angle and position), of optical apparatus and ignition processes, for signal transmission at electrically separated input and output, as well as conversion of light into electrical energy.

Lately, new fields of application opened up for optoelectronic components in the photo industry in form of exposure and aperture control and for automatic electronic flashes. IR sound transmission and IR remote control are new modes in the radio industry. Computer diagnosis and LED displays in instrument panels are possible applications in the automotive industry.

Depending upon the application either photovoltaic cells or photodiodes are used. Wherever amplifiers with high input impedance are required, photodiodes are to be preferred.

Phototransistors are predominantly used in connection with transistor circuits or to drive integrated circuits, whereas photovoltaic cells are preferred to scan large surfaces, if a strictly linear relation between light and signal level or optimum reliability is required.

PHOTOVOLTAIC CELLS

Photovoltaic cells are active two-poles with a comparably low resistance that has its cause in the voltage of the voltaic cell, which may only be some tenth of a volt. For practical application, this characteristic requires special attention.

The open circuit voltage V_L rises almost logarithmically as a function of the illuminance and, particularly in case of planar photovoltaic cells, reaches high values already at very low illuminances. It is independent of the size of the photovoltaic cell.

The short circuit current I_K increases linearly with the illuminance. It is proportional to the size of the exposed photosensitive area at uniform illuminance.

The maximum energy of the photovoltaic cell is yielded in a load resistance R_L of approx $\frac{V_L}{I_K}$.

Practical short circuit operation and thus proportionality between optical and electrical signal is given at load resistance up to $\frac{V_L}{2 I_K}$. This relation can be applied to an open circuit voltage of ≥ 100 mV.

In any type of application the highest value of I_K has to be used. A simple procedure to gain information on the load resistance required is to measure V_L and I_K at given illumination conditions, irrespective of the radiation source.

In case the voltage yielded by the photovoltaic cell is insufficient it can also be used in diode operation at reverse voltages up to 1 V. In such case the flowing dark current has to be taken into consideration.

The rise time of a signal voltage delivered to a load resistor by the voltaic cell primarily depends on the operating conditions. There are two distinctive borderline cases:

1. Load resistor smaller than the matching resistor (tendency toward short circuit operation).
2. Load resistor larger than the matching resistor (tendency to open circuit operation).

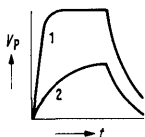
In case 1) the photovoltage rise is analogous to the charging of a capacitor via a resistor from a constant voltage source. In photovoltaic cells the junction capacitance C_j must be charged. The rise occurs by the time constant $\tau = R_L \cdot C_j$, R_L being the load resistor (the low ohmic resistance of the photovoltaic cell is considered negligible).

In case 2) the photovoltage rise is similar to the charging of a capacitor by a constant current mode. The rise time τ_r of the photovoltage follows the equation:

$$\tau_r = \frac{V_p \cdot C_j}{I_K}$$

I_K is the short-circuit current under given illumination conditions. This relation only holds true for values of V_p less than 80% of the final value of the open circuit voltage.

The principal characteristic of the rise time of photovoltaic cells is shown in the following diagram:



Case 1) Rise time according to the equation

$$V_p = I_K \cdot R_L \cdot \left(1 - e^{-\frac{t}{R_L \cdot C_j}}\right)$$

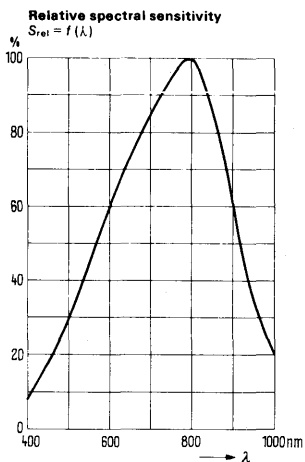
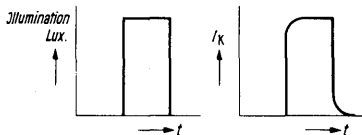
$$\text{Time constant } \tau = R_L \cdot C_j$$

Case 2) Rise time $t_r = \frac{V_p \cdot C_j}{I_K}$

$$\text{fall time in both cases } \tau = R_L \cdot C_j$$

Modulation transients can, under certain conditions, lead to a modification of the above diagram.

E.g. At very low time constants (particularly in short circuit operation) the actual pulse shape of the short circuit current that deviates from an ideal square pulse has to be noted. See diagram.



SILICON PHOTODIODES

These photodiodes have a PN junction poled by a reversed bias. The capacitance which decreases with a growing reverse voltage reduces the switching times. The PN junction is of easy access to the light. Without illumination a very small reverse current flows, the so-called dark current. Light falling onto the surrounding of the PN junction generates charge carrier pairs there that lead to an increase of the reverse current. This photocurrent is proportional to the illuminance. Therefore, photodiodes are particularly well suited for quantitative light measurements. The planar technique has 2 essential advantages: The dark currents are considerably smaller than for comparable photo electric components in non-planar technique. This leads to a reduction of the current noise and thus to a decisive improvement of the signal/noise ratio.

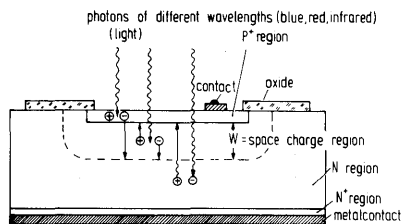


Figure 1

Figure 1 shows the basic design of a photodiode. The limit of the space charge region is indicated by a dashed line.

Without illumination only a small dark current I_D flows through the PN junction as a result of thermally generated carriers.

With light, additional charge carrier pairs (hole electron pairs) are generated in the P and N region by the radiation quantum (internal photo effect). Carriers originating in the space charge region are immediately extracted because of the electrical field present there, i.e. the holes in the P and the electrons in the N direction. Carriers from the remaining field must first diffuse into the space charge region in order to be separated there. If holes and electrons recombine before, they do not contribute to the photocurrent. Thus, the photocurrent I_p is a combination of the drift current of the space charge region and the diffusion current of the P and N area.

I_p is proportional to the incident radiation intensity. Since I_D is very small for diodes, it can be neglected in the equation $I_p = I_p + I_D$. Subsequently one gets a linear I_p correlation between I_p and the incident radiation intensity over a very wide range.

Diodes with a small space charge width are termed PN diodes, diodes with a large space charge width PIN diodes.

PN diodes have the diffusion current as dominating part of the photocurrent whereas it is the drift current

As the capacitance of the space charge width W is inversely proportional, the PIN diode is characterized by a smaller capacitance than a PN diode of identical surface. The capacitance of (most of) the diodes reads:

$$C_D \sim \sqrt{\frac{N}{V}}$$

The less the doping N of the basic material and the higher the applied voltage V , the lower the capacitance.

Fig. 2 shows the capacitance as function of the voltage for a PIN diode, e.g. BPY 12.

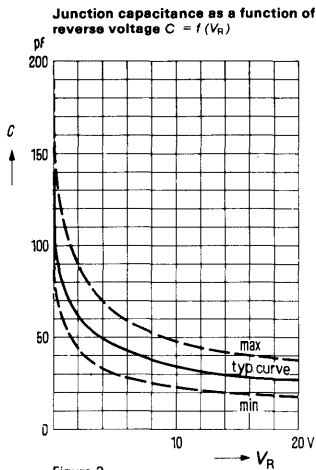


Figure 2

SILICON PHOTOTRANSISTORS

The introduction of the planar technique allows to produce phototransistors of small dimensions. They are used as photoelectric detectors in control and regulating devices. The photoelectric transistors are excellently suited as receivers for incandescent lamp light, as their maximal photosensitivity lies near the infrared limit of the light wave spectrum.

In its mode of operation a photoelectric transistor corresponds to that of a photodiode with built-in amplifier. It has a 100 to 500 times higher photosensitivity than a comparable photoelectric diode.

The photoelectric transistor is preferably operated in an emitter circuit and acts similar to an AF transistor.

Unilluminated only a small collector-emitter leakage current flows. It amounts to approximately $I_d = B \cdot I_{CBO}$, B standing for the current amplification and I_{CBO} for the reverse current of the base diode.

At illumination the reverse current of the base diode I_{CBO} increases by the photocurrent I_p' . Thus, one receives for the photocurrent $I_p \sim B(I_{CBO} + I_p')$.

Consequently, the photocurrent of a transistor is a function of the photocurrent I_p' of the base diode and the current amplification B . As B cannot be increased indefinitely, an as high as possible photosensitivity of the base diode is aimed at.

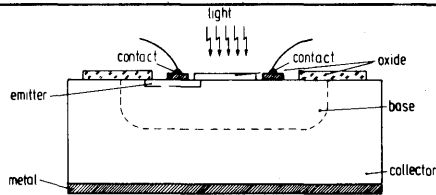


Figure 3

Figure 3 shows the design of a phototransistor. The emitter and base leads are affixed laterally to make the base diode most easily accessible to light. The large collector zone ensures that the most possible radiation quanta are absorbed there and will contribute to the photocurrent.

Contrary to a photodiode, a linear interconnection between the incident radiation intensity and the photocurrent I_p exists only in a small region, since the current gain B depends on the current. Figure 4 shows typical current voltage characteristics of a phototransistor.

Since the reverse current I_{CBO} of the base diode is amplified in the same way as the photocurrent I_p' , the signal/noise ratio of the phototransistor is the same as that of the photodiode.

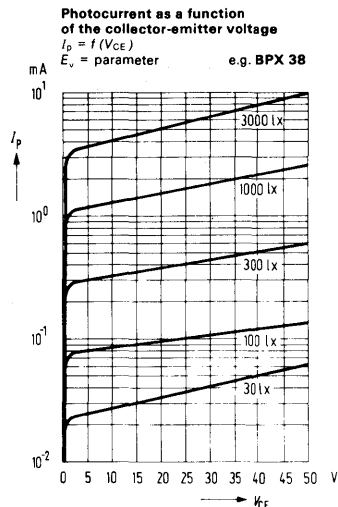


Figure 4

For the versatile applications, special type phototransistors are available. BPY 62, BPX 43, BP 101 and BP 102 requiring no lens on the receiver side are suitable for general applications.

BPY 62 is outstanding for a higher cut off frequency, BPX 43 for a higher photo-sensitivity.

In case the application demands a lens on the detector side, this requirement is met by BPX 38. The flat window of this phototransistor makes a precise reproduction of the focal spot on the photosensitive

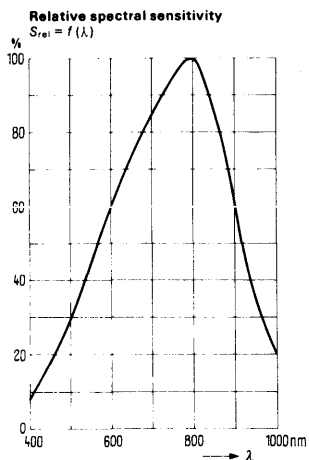
surface of the transmitter system possible. On account of the larger system surface, the adjustment and alignment of the transistor case to the light emitter causes less difficulties.

At the types mentioned, the user may preset the operating point of the phototransistor by wiring the base leads. The rapidity of response may thus be increased and the photosensitivity reduced. A fixed bias can reverse the phototransistor. Coincidence circuits can be realized by scanning this bias.

The phototransistor BPY 61 meets the requirement for high packing density. It is enclosed in a miniature glass case of 13 mm x 2.1 mm \varnothing and its photosensitivity is by the factor 500 to 1000 higher than small-surface silicon photovoltaic cells. Also the BPX 62 in micro ceramic case is provided for use on PC boards at minimum space requirements. The tolerance range of the light sensitivity is subdivided into four sensitivity groups. There is no base contact. Light is the controlling element which produces a correspondingly high collector current via the emitter-base path of the transmitter system, multiplied by the factor of the current gain. The rise and fall times depend on the illuminance and decrease with rising intensity.

Main applications are scanning of binary coded discs, films and punched cards.

Under limited mounting conditions the following amplifier must often be connected by relatively long leads. There is only little danger of interference pick-up since a sufficiently large signal to noise ratio is ensured by high photoelectric currents.



Mounting Instructions For Silicon Voltaic Cells and Photodiodes, open design without casing

As silicon is an inherently brittle material, the photoelectric component should be shielded from pressure or tension. Contact points are particularly endangered. Should tension come to bear on the solid wire leads which, for technological reasons, are alloyed to a very thin P layer it should only be parallel to the surface and must not exceed 200 p (pond). Leads may only be bent 3 mm off the outer edge of the photoelectric

component. Photoelectric components can be cemented onto metallic or plastic supports but the expansion coefficient of the material has to be taken into consideration to prevent mechanical strain between support and photoelectric component at change of temperature. An epoxy resin is to be used to cement or encapsulate the photoelectric component. It has to be colourless and should not grow darker with time. After curing, the epoxy resin must not have any gas occlusions (filter effect). The epoxy resin EPICOTE 162¹⁾ together with the hardener LAROMIN-C 260²⁾ are particularly suited for the encapsulation of photoelectric components. 100 weight parts EPICOTE 162, 38 weight parts LAROMIN-C 260 are to be mixed well and remain workable for about 30 minutes. After that period of time the epoxy becomes viscid. All material to be encapsulated has to be dry, dust- and grease-free. Should bubbles form after the encapsulation it is advisable to raise the curing process temperature to 100°C for a short time. It makes the bubbles come to the surface and burst. The normal curing temperature lies between 60 and 80°C. The curing time is 1 hour, it lessens with higher temperature. When working with epoxy great care should be taken that neither the resin nor the hardener touches the skin. The quickly binding glue SICOMET 85³⁾ proves adequate to cement open-design Si diodes or photovoltaic cells. The light sensitive surface of the photovoltaic cell is coated with a protective lacquer and should not be contaminated while cementing.

1) Registered trademark (Shell Chemical)

2) Registered trademark (BASF)

3) Registered trademark (Sichel-Werke, Hannover)

GUIDELINES FOR HANDLING AND USING Intelligent Displays®

by Malcolm Howard, David Takagishi

IMPORTANT!

This Appnote contains vital information for optimum design and performance of Intelligent Displays.™

Siemens Intelligent Displays are four and eight digit LED modules, having a 16, 17 or 22 segment font and an on-board CMOS integrated circuit driver. The CMOS chip provides segment decoding, drivers, multiplexing and memory for easy interfacing to most microprocessors.

Since Siemens began manufacturing the Intelligent Display in 1978, several questions concerning their use have arisen. This application note is a guide for considerations in design and handling of this product.

SYSTEM DESIGN CONSIDERATIONS

The practical circuit design (i.e. design of PCB, etc.) should be such that the voltage to *any input* must *never exceed the power supply inputs* (i.e. $Gnd < V_{in} < V_{cc}$). If these conditions are not met, then malfunction, or at worst, device destruction can occur. The most common cause of this condition is circuit noise due to noise on the input leads and transient power supply changes.

Good Circuit Layout. The principles of good circuit layout are those for all logic circuitry, but the tolerance of MOS circuitry for deviations is much less than that of bipolar logic. The most important principle is to keep the lead length from the output of one device to the input of another as short as possible. This is to reduce the coupling effect between input signals.

Buffering. The second most common deviation from good design practice is the use of parallel tracking. Avoid PCB design which allow an interconnection track to run parallel to another. This is particularly true if one of the tracks is a power bus when the fluctuations

of power supply current can cause inductively coupled change in the input track. Possibly the worst example of parallel tracking is the ribbon cable: it is physically neat and convenient, but can be electrically destructive for the MOS circuits.

It is often necessary, because of the very nature of the Intelligent Display, to use ribbon cable from the CPU board to the display assembly board. In those circumstances for *cables over 15 cm (6 inches)*, use a *TTL buffer for each used input*. This is especially true for noisy systems which have motors, relays, etc. The buffers must be on the display end of the cable; thus maintaining a minimum distance between their outputs and the display inputs. Long cables can be a poor transmission line for speed pulses. Line drivers, line receivers, or schmidt trigger gates may be required to shape pulses.

Voltage Transients. It has become common practice to provide 0.01 uf bypass capacitors liberally in digital systems. For intelligent displays, the emphasis is on adequate decoupling. Like other CMOS circuitry, the Intelligent Display controller chip has very low power consumption and the usual 0.01 uf would be adequate were it not for the LEDs. The module itself can, in some conditions, use up to 100 mA (multiplexed). In order to prevent power supply transients, capacitors with low inductance and high capacitance at high frequencies are required. This suggests a solid tantalum or ceramic disc for high frequency bypass. For larger displays, distribute the bypass capacitors evenly, keeping *capacitors as close to the power pins as possible*. Do not rely on existing on-board decoupling, *use a 10 uf and 0.01 uf for every 3 or 4 Intelligent Displays* to decouple the displays themselves, at the displays.

See Figure 1

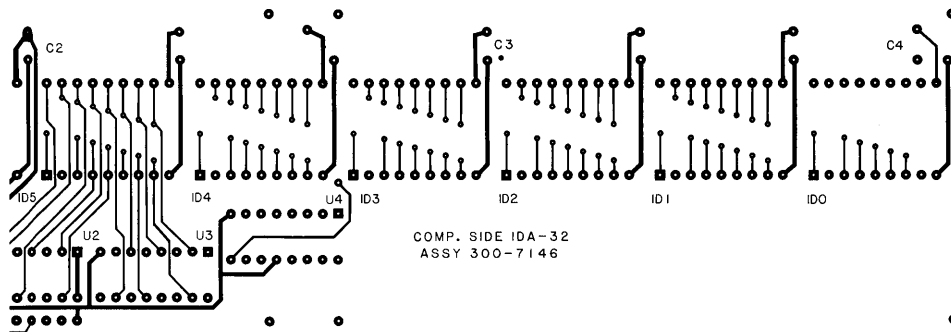


Figure 1 is an actual PCB layout for a line of DL 2416 intelligent displays. Capacitors are spaced evenly and close to the displays with room for additional capacitors should the system require them.

Functional Limitations. Several parameters in the intelligent display data sheets which may affect your design will be emphasized again. While this may not be destructive, it may affect reliability and/or functional operation. (See May 1981 or newer data sheet.)

1. The length of time all cursors may be lit should be 1 minute max.
2. The timing parameters for 25° C will increase with increased temperature.
3. The timing parameters will increase with increased Vcc.

MANUFACTURING CONSIDERATIONS

Handling. The static voltages generated by friction with modern synthetic materials (i.e. carpets, clothing, device carriers, etc.) are often measured in thousands of volts. Although there is usually little energy in these static charges, to MOS circuitry that energy is sufficient to cause destruction if applied between circuit inputs. Input protection diodes can minimize the vulnerability of the circuits, but there is a limit to their protection capabilities. Under certain conditions, static charges can exceed that limit. The most effective protection is to avoid the generation of static charges. When they are inevitable, prevent that charge from coming in contact with the device pins.

1. Avoid touching the pins; handle the body only.
2. Keep the devices in anti-static tubes or conductive material when transporting.
3. Use conductive and grounded working area. (conductive flooring, conductive work benches, individual wrist straps, etc.)

Intensity Codes. Display uniformity is a concern when two or more displays are in a system. Siemens has adopted a letter code to maintain a uniform display. It is recommended a single letter code be used per system. Because this may be difficult due to yield and delivery, adjacent codes (i.e. D with E or E with F) can be used with minimal problems. Jumping over a code (i.e. D with F) may be noticed by the most critical observer.

Soldering. Because of the plastic housing of the Intelligent Displays, it is necessary to control the solder temperature, soldering time and solder distance. A maximum of 260° C for 3 seconds at a distance of greater than 1/16 inch is required. An additional requirement for wave soldering is the Intelligent Display package cannot exceed 70° C.

Cleaning. The cleaning process for the Intelligent Displays is crucial to maintain the optical performance of the plastic housing. The solvent that cannot be used on the Intelligent Display product is alcohol. Alcohol will attack the lens material causing cracking, crazing and destruction of the clear optical properties of the lens.

In the suggested category are the chlorinated hydrocarbons (Acetone, 1,1,1 Trichloroethane, etc.) or freon TF, freon TA or warm DI water. One note of caution, do not specify a freon solvent without first finding the chemical composition. Some manufacturers use some form of alcohol as an additive, so beware.

Appnote 19 Cleaning LED Opto Products

by Dave Takagishi/Rick Rachford

Now that you have selected the right optoelectronic device for your application and designed the circuitry, the next step is to install the devices. This application note is a cleaning solvent selection guide for Litronix Optoelectronic products.

PURPOSE OF CLEANING

In the manufacturing of your product, the components will be handled and soldered. It is important to clean the board and remove both flux rosin and ionic residues after soldering to insure a reliable product operation.

Opto products have to be treated differently than other semiconductor devices with respect to cleaning. LED devices for visual applications require special materials for their optical properties. Exposure to a cleaning solvent must not degrade these properties in any way. For this reason, only certain cleaning solvents and their applications may be used for LED components.

Optoelectronic products are built using differing manufacturing packaging techniques depending upon the device and cost. (See Table 1). For this reason, different types of solvents and cleaning techniques may be required. (See Table 3 for solvent summary).

TABLE 1

OPTOELECTRONIC PACKAGING

1. Without housing (photovoltaic, etc.)
2. Cast or molded
3. Lensed (filled or non-filled)
4. Light pipe
5. Reflector (filled or non-filled)

CLEANING TECHNIQUES

The most common cleaning techniques used in the electronic industry are:

1. Brush/wipe
2. Immerse/spray
3. Vapor degreaser

Dipping a short hard bristle brush into a solvent and applying to the area desired is used mostly

for touch-up or rework areas where localized cleaning is required. This technique can be used on all optoelectronic products if care is taken to maintain their optical properties.

Immersing the printed circuit board into a pan of solvent with slight agitation is another method of cleaning. Spraying the cleaner, in a dishwasher type machine, is a method for removing water soluble type flux.

The most common technique is the vapor degreaser. This method elevates the solvent to its vapor state. The object is placed into this vapor area allowing condensation into a liquid solvent and dissolving the soil.

Regardless of the solvent, the non-filled lensed and the non-filled reflector type products can allow moisture to become entrapped within the display and degrade its optical properties.

SOLVENTS

There are many different solvents today. Some may be used only at room temperature; some are more effective with a vapor degreaser. Table 2 is a list of major solvent manufacturers.

TABLE 2

MAJOR SOLVENT MANUFACTURERS

Allied Chemical Corporation
Specialty Chemical Division
PO Box 1087
Morristown, N.J. 07960

Baron-Blakeslee
1620 S. Laramie Avenue
Chicago, Ill 60650

Dow Chemical
2020 Dow Center
Midland, MI 48640

El DuPont de Nemours & Co.
1007 Market Street
Wilmington, DE 19898

Cost should not be the only criteria for choosing a specific cleaning solvent. Any assembly that has a variety of components makes it mandatory to analyze the effects of any given solvent on all components. The component likely to be affected the most by any solvent should control your choice of solvent.

CONCLUSION

The list of suitable/not suitable solvents in Table 3 represents a small part of available solvents. Some others may be compatible, but more likely, most will not be compatible. Another area of con-

cern is that solvent manufacturers make comparable products, not exact products. Additives and concentrations are slightly different from manufacturer to manufacturer which may affect a solvent's acceptability.

Litronix does not assume any responsibility for damage caused to product/s by use of solvents mentioned above. This application note is only a guide to solvents that have been found satisfactory when tested under our own controlled conditions. We recommend that components be evaluated under your solvent conditions before committing to use on a production basis.

TABLE 3

| SUITABLE/NOT SUITABLE SOLVENTS FOR SIEMENS OPTOELECTRONIC PRODUCTS | | | | | | | | | | | |
|--|----|-------|-----|-----|-------|----|----|-----|---------|-------------------|---------------------|
| Product | TF | TP-35 | TCM | TMC | TMS + | TE | TA | TES | Acetone | Isopropyl Alcohol | III Trichloroethane |
| Visible Lamp | | | | | | | | | | | |
| All Types | S | S | N | N | S | S | N | N | N | S | N |
| IR Emitter/Detector | | | | | | | | | | | |
| All Types | S | S | N | N | S | S | N | N | N | S | N |
| Isolator | | | | | | | | | | | |
| All Types | S | S | N | N | S | S | N | N | N | S | N |
| Displays—Group 1 | | | | | | | | | | | |
| HD XXXX | S | S | N | N | S | S | N | N | N | S | N |
| DLX 34XX | S | S | N | N | S | S | N | N | N | S | N |
| DLX 413X | S | S | N | N | S | S | N | N | N | S | N |
| DLX 477X | S | S | N | N | S | S | N | N | N | S | N |
| DLX 573X | S | S | N | N | S | S | N | N | N | S | N |
| DLX 713X | S | S | N | N | S | S | N | N | N | S | N |
| DL 76XX | S | S | N | N | S | S | N | N | N | S | N |
| DL 77XX | S | S | N | N | S | S | N | N | N | S | N |
| DLO 39XX | S | S | N | N | S | S | N | N | N | S | N |
| XBG 1000 | S | S | N | N | S | S | N | N | N | S | N |
| XLB 2XXX | S | S | N | N | S | S | N | N | N | S | N |
| XBG 48X0 | S | S | N | N | S | S | N | N | N | S | N |
| Displays—Group 2 | | | | | | | | | | | |
| DL 3XXM/DL 4XXM | S | N | N | N | N | N | S | N | S | N | S |
| DL 1414T | S | N | N | N | N | N | S | N | S | N | S |
| DL 1416T | S | N | N | N | N | N | S | N | S | N | S |
| DL 1416B | S | N | N | N | N | N | S | N | S | N | S |
| DL 1814 | S | N | N | N | N | N | S | N | S | N | S |
| DL 2416H, T | S | N | N | N | N | N | S | N | S | N | S |
| DL 3416 | S | N | N | N | N | N | S | N | S | N | S |
| DL 3422 | S | N | N | N | N | N | S | N | S | N | S |
| IDA 1414 | S | N | N | N | N | N | S | N | S | N | S |
| IDA 1416 | S | N | N | N | N | N | S | N | S | N | S |
| IDA 2416 | S | N | N | N | N | N | S | N | S | N | S |
| IDA 3416 | S | N | N | N | N | N | S | N | S | N | S |
| PD 2816 | S | N | N | N | N | N | S | N | S | N | S |

S = Suitable

N = Not suitable

X = Substitute for specific part designation

Appnote 20 Moving Messages using Litronix Alphanumeric Intelligent Displays[®] and 8748 Microprocessor

Reprinted from Siemens Design Examples of Integrated Circuits Edition 1980/81

Output and display of texts including an important operator information are not only limited to devices of data processing systems but they are more and more applied in other fields of electronics, e.g. in industrial and consumer as well as control engineering. If data of different kinds (e.g. program results, error indications, decision criteria, test results, etc.) are displayed as moving news, they have a striking effect calling the operator's attention.

The text can easily be read when each character remains for 0.25 s on the display. A special advantage of a moving news panel being controlled by a microcomputer is in that the information can immediately be modified. The described circuit of **Fig. 1** operates with SAB 8748. Its program memory capacity (EPROM) is 1K Byte and up to 900 characters can be stored. If the microcomputer is replaced by another one incorporating a different program, the information which is to be displayed is also exchanged.

The described circuit offers the advantage in requiring a minimum of components. The single-chip microcomputer SAB 8748 operates in conjunction with an alphanumeric 16-segment-LED-display DL-2416. It incorporates memory decoder and driver.

Hardware

The ASCII-coded data is transferred from the SAB 8748 to the display ICs via the bus port (DB0 to DB6) and via the \overline{WR} -output (strobe). The information at pins P20 and P21 addresses the specific digits of the display-IC DL2416.

The signals at P22 to P26 select the individual ICs via the chip enable input $\overline{CE1}$. When one pin of port 1 is connected to ground, the microcomputer supplies the corresponding text. An output of 4 different texts is possible.

The text may have any length as long as the memory capacity of 900 bytes is not exceeded. There are no additional components required than indicated in the circuit of **Fig. 2**.

Software

The first 100 bytes of the EPROM are reserved for the program. As the program counter can only be read as data memory within 256 bytes, additional instructions are necessary (see listing). At the beginning of the program port 1 is read. If a signal with low level is available at one of the pins, the

starting address of the corresponding text is loaded to register 2 (low address) and 3 (high address). Now output registers 20H to 32H have to be filled with blanks. Then the first letter is transferred from text memory to data memory. Now the microprocessor operates in a waiting loop, determining the speed of the moving news. At an oscillator frequency of 3 MHz the timer has an overflow after $\frac{1}{3} \times 10^{-6} \mu s \times 15 \times 32 \times 256 = 40.96$ ms. The moving-news text is stepping four times per second after 6 overflows have occurred, that means the 900 characters need in total 3¼ minutes. If the 8-bit-word zero (figure 0, not the ASCII-character for 0) is read as character, the text end is recognized by the program. Therefore a counting is not necessary, that means all characters have been transferred. Now the program returns to read port 1.

The flowchart is shown in **Fig. 3** and **Fig. 4** presents the complete listing.

Components for circuit 2

- 1 8-bit single chip microcomputer (1-KByte-EPROM, 3-MHz-version) SAB 8748-8-D
- 5 4-digit alphanumeric LED-displays with memory, decoder and driver, (4 mm character height, 16 segments) DL 2416
- 1 Crystal 3 MHz
- 4 Push buttons for pc board mounting, 2 break-make contacts, lateral operation

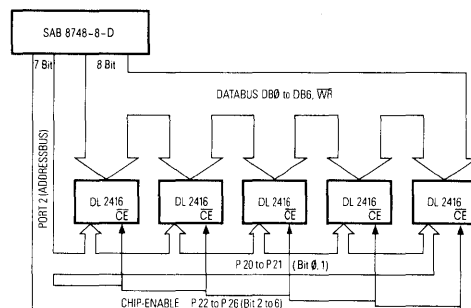


Fig. 1

Silver Plated Tarnished Leads Appnote 21

by Dave Takagishi

Silver plating, as an alternative to gold plating, has excellent electrical conductivity, LED die attach, and wire bonding properties. But tarnished leads can cause soldering difficulties. This application note will discuss silver tarnish and solderability.

Effects of Tarnish

Solderability means the metals or surfaces to be soldered must be types that will go into solution with tin-lead alloys. When exposed to the atmosphere, all metals form oxides or tarnish of varying degree which reduce the ability of solder alloys to adhere to the metals. Silver tarnish is formed when silver chemically reacts with sulfur to form silver sulfide (Ag₂S). This tarnish is the reason for poor solderability of silver plated products. However, the amount of tarnish and the kind of solder flux used actually determine the solderability. As the tarnish increases, a more active flux must be used to penetrate and remove the tarnish.

Prevention and Handling

Prevention is the best method for inhibiting the formation of tarnish and insuring good solderability of silver plated devices. To inhibit silver tarnish, do not expose the silver plating to sulfur and sulfur compounds. One source of sulfur is free air. Another is paper products such as bags and cardboard.

Listed below are a few suggestions for storing silver plated products.

1. Store the unused devices in polyethylene sheet to keep out free air.
2. Loose devices may be stored in zip-lock or sealed plastic bags.
3. For long term storage, place petroleum naphthalene (mothballs) with product inside plastic packages to help keep out free air.
4. The silver leads may be wrapped in "Silver Saver" paper for protection. "Silver Saver" is manufactured by:
Daubert Coated Products
1200 Jorie Drive
Oak Brook, Ill. 60521
(312) 582-1000
5. Tapes such as adhesive, electrical, and masking should not be used because the adhesive may leave a film and will need to be removed before soldering.

The best defense against the formation of tarnish is to keep silver plated devices in protective packaging until just prior to soldering.

Fluxes

Depending on the amount of tarnish, different types of flux may be required. Below is a list of flux in order of increasing strength.

Type R: Un-activated Rosin Flux

A pure water-white gum rosin without any additives. Flux and its residue are non-conductive and non-corrosive.

Type RMA: Mildly Activated Rosin Flux

A WW rosin flux with a small amount of activating agent. Flux its residue are non-conductive and non-corrosive.

Type RA: Activated Rosin Flux

Similar to RMA flux but with greater amounts of activating agents. Flux and its residue are non-conductive & non-corrosive.

Types AC: Organic Acid Flux

A fully active organic flux with greater flux ability than a rosin flux. Due to its organic nature, the flux residues decompose at soldering temperatures but must be removed to prevent conductive and corrosive aftereffects.

Recommended flux types with respect to the various tarnish amount:

1. Tarnish free may be soldered with Alpha 100, Kester 135, or equivalent Type R flux.
(Identified by a bright surface)
2. Minor tarnish will require Alpha 611, Kester 197, or equivalent Type RMA flux.
(Identified by a medium bright surface)
3. Mild tarnish will require Alpha 711, Kester 1544, or equivalent Type RA flux.
(Identified by a light tint surface)
4. Moderate tarnish will require Alpha 830, Kester 1429, or equivalent Type AC flux.
(Identified by a light tan color on the surface)
5. If severe tarnish is present, as identified by a dark tan to black color, a cleaner/surface conditioner Alpha 140, Kester 5560, or equivalent must be used. A few seconds and at room temperature is all that is required. These conditioners are acidic; therefore, a thorough wash and rinse is recommended. Care is advised to only immerse the leads and not the body, because optical properties may be damaged.

Soldering

To obtain reliable circuit operation, good soldering is necessary. For wave soldering, Sn60 is the most commonly used solder for electronic components. Two alternatives are Sn63 and Sn62 solder. A high quality rosin core flux is recommended for hand solder operations. Typically the core is an RMA type flux.

Two major soldering suppliers are:

Alpha Metals
600 Rt 440
Jersey City, NJ 07304
(201) 434-6778
Kester Solder
4201 Wrightwood Ave.
Chicago, Ill 60639
(312) 235-1600

Regardless of the flux and solder technique used, care should be taken to assure the optical properties of the optoelectronic product are not degraded in any manner. Litronix does not assume any responsibility for damage caused by products mentioned above.

SIEMENS

Socket Selection Guide Appnote 22

by Dave Takagishi

This application note is a guide to locate a suitable socket for various SIEMENS/LITRONIX products.

The selection of a socket is first based on the number of pins and the pin spacing required. Sockets for displays require an orientation and sometimes stackability. Other requirements may be:

- Contact type (ie. side vs edge)
- Plating type (ie. tin vs gold)
- PCB mounting (ie. solder vs wirewrap)
- Height of socket

To use this guide, (1) Find SIEMENS/LITRONIX product part number, (2) Note number of pins, (3) Note spacing & orientation . . . (Example 300 H) (4) Go to chart, find # of pin with corresponding spacing/orientation and follow to suggested socket.

The purpose of this application note has been to guide you to possible vendors and suggest one out of many possible socket choices. It is recommended that the part numbers given be used as a starting point with a vendor for choosing a socket. The part number will depend on your requirement and application.

This guide is not intended to imply specific endorsement or warranty of other manufacturers products by SIEMENS/LITRONIX.

List of possible vendors.

ARIES ELECTRONICS COMPANY
P.O. Box 130
Frenchtown, New Jersey 08825
201-996-6841

GARRY MANUFACTURING
1010 Jersey Ave.
New Brunswick, New Jersey 08902
201-545-2424

ROBINSON-NUGENT
800 E. Eighth St.
New Albany, Indiana 47150
812-945-0211

SAMTEC
810 Progress Blvd.
New Albany, Indiana 47150
812-944-6739

| Part Number | # of pins | Spacing |
|------------------------------|---------------------------|---------|
| DL-57 | 14 pins | .300 V |
| DL-330M | 12 pins | .300 H |
| DL-340M | 14 pins | .300 H |
| DL-416 | 22 pins | (SPC) |
| DL-430M | 12 pins | .300 H |
| DL-440M | 12 pins | .300 H |
| DL-1414 | 12 pins | .600 H |
| DL-1416 | 20 pins | (SPC) |
| DL-2416 | 18 pins | .600 H |
| DL-3416 | 22 pins | .600 H |
| DL-3422 | 22 pins | .600 H |
| DL-3400,3401,3403,3405,3406 | 16 pins | .600 V |
| DL-4770, DLO-4770 | 13 pins | (SPC) |
| DL-7750R,7751R,7756R,7760R | 14 pins | .300 V |
| DL-5735, DLG-5735 | 12 pins | .300 V |
| DL-7670G,7671G,7673G,7676G | 14 pins | .300 V |
| DLO-3900,3901,3903,3905,3906 | 16 pins | .600 V |
| DL-76500,76510,76530,76560 | 14 pins | .300 V |
| DL-7660Y,7661Y,7663,7666Y | 14 pins | .300 V |
| HD-1075G,1075O,1075R,1075Y | 10 pins | (SPC) |
| HD-1077G,1077O,1077R,1077Y | 10 pins | (SPC) |
| HD-1105G,1105O,1105R,1105Y | 10 pins | .300 V |
| HD-1106G,1106O,1106R,1106Y | 10 pins | .300 V |
| HD-1107G,1107O,1107R,1107Y | 10 pins | .300 V |
| HD-1108G,1108O,1108R,1108Y | 10 pins | .300 V |
| HD-1131G,1131O,1131R,1131Y | 10 pins | .600 H |
| HD-1132G,1132O,1132R,1132Y | 10 pins | .600 H |
| HD-1133G,1133O,1133R,1133Y | 10 pins | .600 H |
| HD-1134G,1134O,1134R,1134Y | 10 pins | .600 H |
| Isolites 6 pin | 6 pins | .300 B |
| 8 pin | 8 pins | .300 B |
| 16 pin | 16 pins | .300 B |
| Arrays | 2 pins thru 20 pins | .100 B |

| # of pins | row-row spacing | ARIES N.J. | GARRY MFG N.J. | R-N IND. | SAMTEC IND. |
|-----------|-----------------|-----------------|--------------------------|--------------|------------------------------------|
| 12 | .300 H | 12-513-10 | (2)102-06-X | (2)ICN-063-X | |
| 14 | .300 H | 14-511-10 | 102-14-X-X-X | ICL-143-S6-X | |
| 18 | .600 V | 18-6511-10 | 300-18-X-X-X | | ICC-314-T |
| 22 | .600 V | 24-6513-10 | 300-22-XX-X | | IC-618-X |
| 22 | SPC | | | | ICC-624-X |
| 13 | SPC | | | | |
| 12 | .300 V | 12-513-10 | | | |
| 14 | .300 V | 14-511-10 | 102-14-X-X-X | ICL-143-S6-X | ICC-314 |
| 14 | .600 V | 14-6511-10 | 300-14-X-X-X | | IC-614-X |
| 20 | .300 H | 20-511-10 | 102-20-CC-X-X | ICL-203-S6-X | ICC-320 |
| 10 | SPC | | | | |
| 10 | .300 V | | | | IC-310-X |
| 10 | .600 V | 10-6511-10 | | | IC-610-X |
| 18 | .300 V | 18-511-10 | 102-18-X-X-X | | ICC-318 |
| 6 | .300 B | 6-513-10 | 102-06-X | ICN-063-S3-X | IC 306-X |
| 8 | .300 B | 8-511-10 | 102-8-X-X-X | ICN-083-S3-X | ICC-308 |
| 16 | .300 B | | | | |
| 2-20 | .100 B | PIN-LINE SERIES | SERIES 200 SERIES 202 | SB-25-100X | SSA-1XX-XSERIES ICK-1XX-XSERIES |

NOTES:

1. All sockets are 0.100 pin-to-pin spacing.
2. Products listed are generally tin plated PCB solder type. Contact vendor for other types.
3. Row-row spacing of pins
(H)-pins are horizontal w/respect to viewing of display
(V)-pins are vertical w/respect to viewing of display
(B)-pins can be either horiz or vert
(SPC)-pins not standard 0.100 or row-row spacing
4. Others—Special sockets for display such as Rt angle, etc. Contact vendor for details.
5. Consult vendor for stackability.
6. Strip in-line sockets may be used. (Cut to length, req'd)
7. Vendor may have other products also suitable for your application.

LED Filter Selection Appnote 23

by Dave Takagishi

The most important design consideration for a piece of equipment using LED products is the ability to display information to an observer clearly. This information must be easily and accurately recognized in various ambient light conditions. This application note will discuss the design considerations and recommendations for filtering.

Since the quality of readability is very subjective, the best judge of the performance of a product is the human eye and in the user's conditions. To improve the readability of a display it will be necessary to employ certain techniques such as contrast enhancement, wavelength filtering, special filtering, and mounting.

Contrast Enhancement

The objective of contrast enhancement is to maximize the contrast between the display segments 'ON' and 'OFF' states. This is done by reducing the ambient light reflected from the surface of the display and allowing as much of the emitted light to reach the observer. This can be accomplished by painting the front surface of the display to match as close as possible the color of an 'OFF' segment. This reduces the distracting areas around the display and therefore enhances the 'ON' segments.

Contrast enhancement may be improved further by the use of selected wavelength filters. Under bright ambient conditions, contrast enhancement is more difficult and additional techniques such as louvered filters and/or shading may be necessary.

Filters

The majority of display applications use plastic filter material for their low cost and ease of assembly. The filter requirements for different ambient lighting conditions and different color displays make it necessary to become familiar with the various relative transmittance characteristics. Most filter manufacturers will provide transmittance curves for their products.

When selecting a filter, the shape of the transmittance curve vs wavelength should be considered in relationship to the LED radiated spectrum to obtain maximum contrast enhancement. For standard red displays, a long wavelength pass filter having a sharp cutoff in the 600nm to 620nm range is ideal. The same applies for high efficiency red displays with a long wavelength pass filter in the 570nm to 590nm range. The yellow and green displays are more difficult to filter effectively. The most effective filter for yellow displays is a yellow-orange or amber filter. Yellow-only filters are very poor for contrast enhancement. Green displays will require a band-pass yellow-green filter which peaks at 565nm.

A choice among available filters must be made on the basis of which filter and LED combination is most effective, but experimentation with each choice must be made to choose the most esthetic combination.

Effectiveness of Wavelength Filters with Different Lighting

Contrast is very dependent upon the ambient lighting. If the ambient light is outside the spectrum of the LED, then it is very easy to reduce the reflected light. This is the case for a red LED display in fluorescent lighting or a green LED in incandescent lighting. Bright sunlight has a flat spectral distribution curve and when it is directly incident upon a display the background may meet or exceed the light output of the display. It should be obvious that a wavelength filter alone is not sufficient in daylight ambient conditions.

Other Techniques

An acceptable contrast is difficult to achieve if high ambient light is parallel to the viewing axis (the incident light is perpendicular to the face of the display). If the incident light is not parallel to the viewing axis, the use of louvered filters or shading and recessing is recommended. It is the shading of louvered filters that reduces the incident light to allow for more contrast. The drawback to this filter is the restricted viewing angle.

Circular polarizing filters are effective in reducing the reflected light from the highly reflective (glossy) surfaces of bubble lensed products, such as the Intelligent Displays.

Glare can still be present from the surface of filters, therefore, an anti-reflection surface is recommended. This can be incorporated into the filter. The trade-off is that both ambient and display light are diffused and the display may appear fuzzy if not mounted close enough to the filter.

Care should be taken to design the printed circuit board to keep all reflective surfaces away from display area or display side of the board or consider a dark coating on the reflective surfaces.

Mounting Considerations

The designer should consider recessing the display and bezel assembly to add some shading effect. The shading will reduce the indirect lighting for better contrast.

It is essential to design the unit to allow sufficient air flow for circulation and mount current limiting resistors on another board or any heat generating components away from the displays.

Filter Material Manufacturers

Panelgraphic Corporation
 10 Henderson Drive
 West Caldwell, New Jersey 07006
 201-227-1500

SGL Homalite
 11 Brookside Drive
 Wilmington, Delaware 19804
 302-652-3686

3M Company
 Visual Products Division
 3M Center, Bldg 220-10W
 St. Paul, Minnesota 55101
 612-733-0128

Rohm and Haas
 Independence Mall West
 Philadelphia, Penn 19105
 215-592-3000

Polaroid Corporation
 Polarizer Division
 549 Technology Square
 Cambridge, Mass 02139
 617-864-6000

Bezel & Filter Assembly Manufacturers

R.M.F. PRODUCTS
 P.O. Box 413
 Batavia, Illinois 60510
 312-879-0020

NOBEX COMPONENTS
 Nobex Division
 Griffith Plastic Corp
 1027 California Dr.
 Burlingame, Ca 94010
 415-342-8170

PHOTO CHEMICAL PRODUCTS OF CALIFORNIA
 1715 Berkeley Street
 Santa Monica, Ca 90404
 213-828-9561

I.E.E.-Atlas
 Industrial Electronic Engrs Inc.
 7740 Lemona Avenue
 Van Nuys, Ca 91405
 213-787-0311

Filter Recommendation**Visible Filters**

| Manufacturer | Red | Hi-Eff | Ylw | Grn | Spcls |
|--------------|------------------|--------|------------------|--------------|------------------------|
| Homalite | 1605 | 1670 | 1720 1726 | 1425 1440 | |
| Panelgraphic | Red 60 Red 63 | Red 65 | Ylw 25 Amb 23 | Grn 48 | Gray 10 |
| Rohm & Haas | 2423 | 2444 | | | 2412 |
| 3-M | | | | | Louvered Filters |
| Polaroid | | | | | Circular Polarizing |

Near IR Filter

| | |
|-----|----------|
| 3-M | # IR9320 |
|-----|----------|

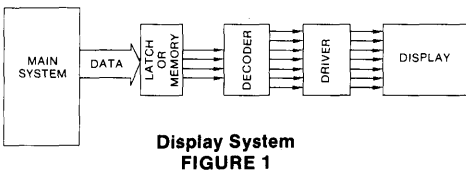
Drivers For Light Emitting Displays Appnote 24

by Dave Takagishi

The purpose of this application note is to provide some information on the integrated circuits presently available to drive Light Emitting Diodes (LED) displays and how to interface them to the various displays.

Background

LED displays come in various sizes (0.1" to 0.8"), colors (red, high-efficiency red, green, yellow), fonts (7/9/14/16 segment, dot-matrix, or bar graph), and types (common anode, common cathode, multi-digit). The brightness is essentially proportional to the current through an LED and each element within a display should have the same current or a brightness variation may be apparent. A display subsystem can be made up from several elements.



The partitioning of these elements are dependent on the drivers used; therefore, the display driver chosen is dependent on the specifications of the display and the application.

Also some types of displays require using a multiplexing technique because of the internal interconnections. This is only applicable for multi-digit displays.

Typical Circuits

Figure 1 shows a very basic circuit for driving an LED. The series resistance can be easily calculated from the following formula.

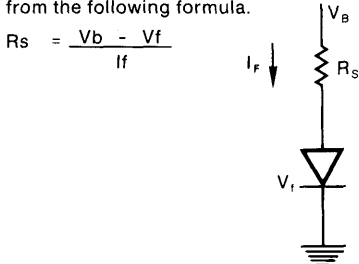


FIGURE 2

For circuits using TTL Logic or transistors (fig 3).

$$R_s = \frac{V_{cc} - V_{ce} - V_f}{I_f}$$

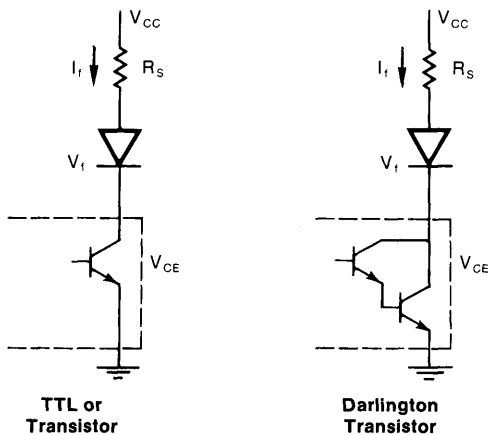
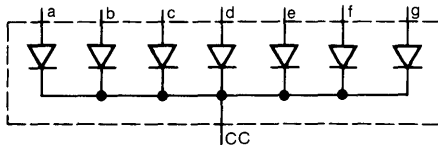


FIGURE 3

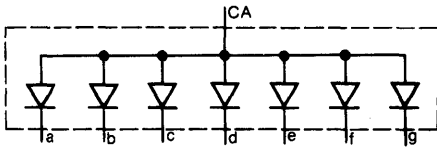
It can be seen that the term V_{ce} (saturation voltage) for the driver is going to be a factor in determining the series limiting resistor. Therefore, a darlington vs a single output transistor will have different current limiting resistor values to maintain a constant current through the LED.

Selection

One factor in choosing the display and/or driver will be whether the display is a common cathode or common anode type display.

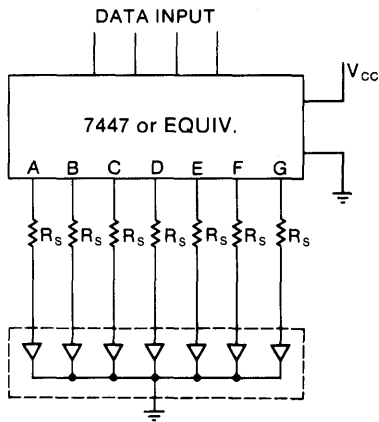


Common Cathode Display
FIGURE 4

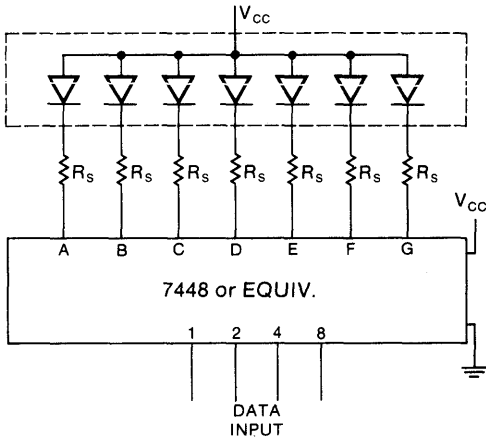


Common Anode Display
FIGURE 5

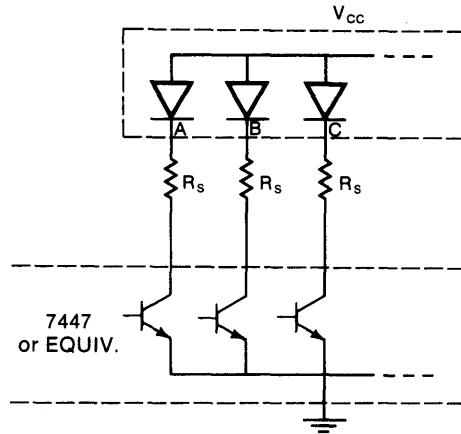
Another factor is the different drivers go low or high,



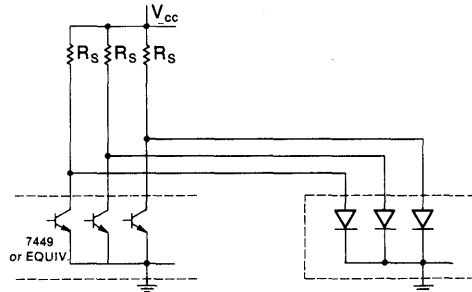
Common Cathode Display w/Driver
FIGURE 6



Common Anode Display w/Driver
FIGURE 7



Open Collector Type Driver
w/Common Anode Display
FIGURE 8



Open Collector Type Driver
w/Common Cathode Display
FIGURE 9

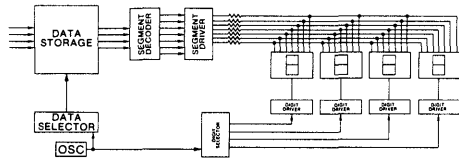
From figures 6/7/8/9, it may appear obvious to combine the seven (7) series resistors (R_s) into one common resistor in the common line. However this should not be done because of the possible variation in V_f from segment to segment. This variation in V_f can cause a variation in current, resulting in segment brightness differences.

Table 1 is a list of some of the most common LED drivers available. Besides having different current drive capabilities, one product may have a feature which may make them easier to use in a particular application.

- Serial vs parallel input data
- Data latching type drivers
- Blanking
 - Drive the ripple blanking input (rbo) with pulse width modulation to vary brightness.
- Multi-digit drivers
- Constant current drivers
- Advantage of a constant current driver is

Multiplexing

In a multiplex system, the corresponding segment of each digit is bussed together and driven from one segment drive via the usual current limiting resistors. The display data is presented serially by digit to the decoder driver together with the appropriate digit signal (figure 10). For more information on multiplexing, see Appnote #3 (Multiplexing LED Displays).



**Block Diagram of a 4-Digit
Multiplexed Display
FIGURE 10**

One way to simplify the design procedure for alphanumeric displays would be to consider the Siemens Intelligent Display®. This device family incorporates all necessary interface control with drivers and memory built-in with the display. This means the designer need not be concerned about the memory, multiplex circuitry, character generator, or drivers for these are provided inside a modular unit. More information on these products is available in the Intelligent Display Product Guide.

Circuits herein mentioned are not the responsibility of Siemens-Optoelectronics Division and are for reference only. Products are continually being improved by vendors and/or are obsoleted; therefore, consultation with the factory is recommended.

TABLE 1

Single Digit Decoder/Drivers

| PART # | MFGR | I _f /seg | TYPE | COMMENTS |
|----------------------------|---|---------------------|------|--|
| 7447 74247 7446 | Fairchild Hitachi Motorola National Signetics Teledyne TI | 40 ma | CA | BCD-to-7 seg, open coll, ripple blnkng |
| 7448 74248 | Fairchild Hitachi Motorola National Signetics TI | 6 ma | CC | BCD-to-7 seg, int pull-up, ripple blnkng |
| 7449 74249 | Fairchild Hitachi Motorola National Signetics TI | 8 ma | CC | BCD-to-7 seg, open coll, blnkng input |
| DS8857 | National | 60 ma | CA | BCD-to-7 seg decoder, ripple blnkng |
| DS8858 | National | 50 ma | CC | BCD-to-7 seg decoder, ripple blnkng |
| CD4511 4511B MC14511 | Fairchild National Motorola | 25 ma | CC | BCD-to-7 seg, latched, blnkng |
| DS8647 DS8648 | National | 10 ma | CC | 9 seg drivers |
| NE587 | Signetics | 50 ma | CA | BCD-to-7 seg, latched, ripple blnkng, vari current |
| NE589 | Signetics | 50 ma | CC | BCD-to-7 seg, latched, ripple blnkng, vari current |
| CA3161E | RCA | 25 ma | CA | BCD-to-7 seg, constant current drivers |
| 9368 | Fairchild | 20 ma | CC | BCD-to-7 seg, ripple blnkng |
| 9374 | Fairchild | 15 ma | CA | BCD-to-7 seg, ripple blnkng |

TABLE 1, Continued

Multi-Digit Display Drivers:

| | | | | |
|--|-----------|--------|----|---|
| MM5450 | National | 25 ma | CA | 34 seg serial input, brightness control |
| MM5451 | National | 25 ma | CA | 35 seg serial input, brightnes control |
| MM74C912 | National | 100 ma | CC | 6 digit, 7 seg+decimal, BCD decoder, output enable |
| MM74C911 | National | 100 ma | CC | 4 digit, 8 seg controller/seg driver |
| MM74917 | National | 100 ma | CC | 6 digit, 7 seg+decimal, Hex decoder, output enable |
| DS8669 | National | 25 ma | CA | Dual BCD-to-7 seg decoder/driver |
| CA3168E | RCA | 25 ma | CA | Dual BCD-to-7 seg decoder/driver |
| ICM7212 ICM7212A ICM7212M ICM7212AM | Intersil | 8 ma | CA | 4 digit, latched, 28 seg drivers, brightness cntl |
| ICM7218A | Intersil | 20 ma | CA | 8 digit, 8 seg (decoded/spcl), w/mem/drivers |
| ICM7218B | Intersil | 10 ma | CC | 8 digit, 8 seg (decoded/spcl), w/mem/drivers |
| ICM7218C | Intersil | 20 ma | CA | 8 digit, 8 seg(hex/bcd), w/mem drivers |
| ICM7218D | Intersil | 10 ma | CC | 8 digit, 8 seg(hex/bcd), w/mem/drivers |
| ICM7218E | Intersil | 20 ma | CA | 8 digit, 8 seg (decoded/spcl), w/mem drivers, cntls avble |
| TSC700A | Teledyne | 11 ma | CA | 4 digit decoder/driver, parallel output, brightness cntl |
| TSC7212A | Teledyne | 5 ma | CA | 4 digit decoder/driver, parallel output, brightness cntl |
| SAA1060 | Signetics | 40 ma | CA | 16 element serial in/parallel out driver |
| SDA2014 | Siemens | 12 ma | CC | 2 or 4 digit, serial bcd input |
| SDA2131 | Siemens | 20 ma | CA | 16 element, serial input |

Other Drivers:

| | | | | |
|--|-----------|--------|--------|---|
| XR-2000 | Exar | 400 ma | sink | 5 darlington transistors, MOS-to-LED |
| XR-2201 XR-2202 XR-2203 XR-2204 | Exar | 500 ma | sink | 7 darlington transistors, open collector w/diodes TTL-to-LED, compatible to Sprague (ULN-xxxx) |
| CA3081 | RCA | 100 ma | sink | 7 common emitter transistor array |
| CA3082 | RCA | 100 ma | source | 7 common collector transistor array |
| 9665 9667 | Fairchild | 250 ma | sink | 7 common emitter darlington transistor array |

Bar Graph Drivers:

| | | | | |
|--------|----------|---------|------|---|
| UAA180 | Siemens | 10 ma | n.a. | 12 element bar driver |
| LM3914 | National | 2-20 ma | n.a. | 10 element dot/bar linear output driver |
| LM3915 | National | 1-20 ma | n.a. | 10 element dot/bar log output driver |

The DLX-713x 5x7 Dot Matrix Intelligent Display Appnote 25

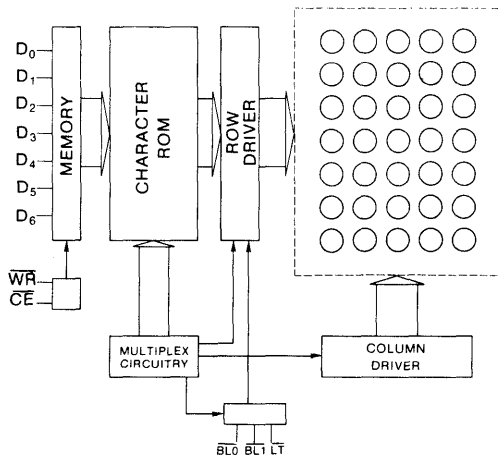
by Dave Takagishi

This application note is intended to serve as a design and application guide for users of the DLO-7135, and DLG-7137 Siemens Optoelectronics Division Intelligent Displays. The information presented covers device electrical description, operation, general circuit design considerations, and interfacing to microprocessors.

Electrical Description

If you have never designed a system using a dot matrix display before, you cannot appreciate the simplicity of using the DLX-713x Intelligent Alpha-numeric 5x7 Dot Matrix Display. The intelligent display contains memory, character generator, multiplexing circuits, and drivers built into a single package.

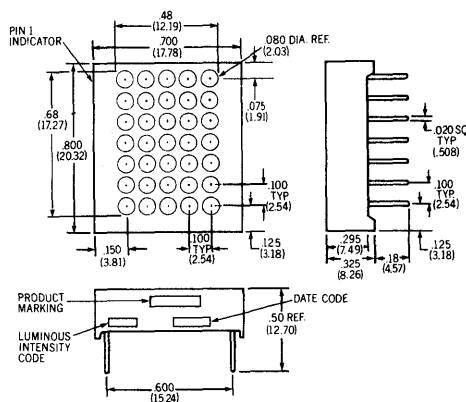
Figure 1 is a block diagram of the DLX-713x. The unit consists of 35 LED die arranged in a 5x7 pattern and a single CMOS integrated circuit chip. The IC chip contains the segment drivers, digit drivers, 96 character generator ROM, memory, multiplex and blanking circuitry.



DLX-713x Block Diagram
FIGURE 1

Package

The 35 dots form a 0.48 x 0.68 inch overall character size in a 0.700 x 0.800 inch dual-in-line package. The ± 50 degree wide viewing angle complements the large display and is the ideal display for the industrial control application. Display construction is a filled reflector type with the integrated circuit in the back and then filled with IC-grade epoxy. This results in a very rugged part which is quite impervious to moisture, shock, and vibration.



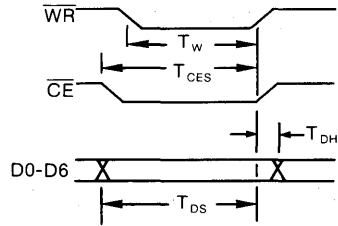
Physical Dimension Inches
FIGURE 2

Electrical Inputs

| PIN | Name | PIN | Name |
|-----|----------------|-----|---------------------|
| 1 | Vcc | 14 | D6 data input (msd) |
| 2 | LT lamp test | 13 | D5 data input |
| 3 | CE chip enable | 12 | D4 data input |
| 4 | WR write | 11 | D3 data input |
| 5 | BL1 brightness | 10 | D2 data input |
| 6 | BLO brightness | 9 | D1 data input |
| 7 | GND | 8 | D0 data input (lsd) |

Pin Description

| | |
|--|--|
| Vcc | Positive Supply +5 volts |
| GND | Ground |
| D0-D6 | Data Lines see figure 3 for character set |
| $\overline{\text{CE}}$ | Chip Enable (active low) This determines which device in an array will accept data |
| $\overline{\text{WR}}$ | Write (active low) Data and chip enable must be present and stable before and after the write pulse (see data sheet for timing) |
| $\overline{\text{BL0}}, \overline{\text{BL1}}$ | Blanking Control Input (active low) Used to control the level of display brightness |
| $\overline{\text{LT}}$ | Lamp Test (active low) Causes all dots to light at 1/2 brightness |



Timing Characteristics
Figure 4

Display Blanking and Dimming

The DLX-713x Intelligent Display has the capability of three levels of brightness plus blank. Figure 5 shows the combination of $\overline{\text{BL0}}$ and $\overline{\text{BL1}}$ for the different levels of brightness. The $\overline{\text{BL0}}$ and $\overline{\text{BL1}}$ inputs are independent of write and chip enable and does not affect the contents of the internal memory. A flashing display can be achieved by pulsing the blanking pins at a 1-2 hertz rate. Either $\overline{\text{BL0}}$ or $\overline{\text{BL1}}$ should be held high to light up the display.

CHARACTER SET

| | | | | | | | | | | | | | | | |
|-------------|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| D0 | L | H | L | H | L | L | H | L | H | L | H | L | H | L | H |
| D1 | L | L | H | H | L | L | H | H | L | L | H | H | L | L | H |
| D2 | L | L | L | L | H | H | H | H | L | L | L | L | H | H | H |
| D3 | L | L | L | L | L | L | L | L | H | H | H | H | H | H | H |
| D0-D3/4/HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E |
| L L L L | 0 | | | | | | | | | | | | | | |
| L L L H | 1 | | | | | | | | | | | | | | |
| L H L L | 2 | | : | : | : | : | : | : | : | : | : | : | : | : | : |
| L H H 3 | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D |
| H L L 4 | 4 | A | B | C | D | E | F | G | H | I | J | K | L | M | N |
| H L H 5 | 5 | P | O | R | E | T | U | V | W | X | Y | Z | [|] | ~ |
| H H L 6 | 6 | ^ | _ | ` | a | b | c | d | e | f | g | h | i | j | k |
| H H H 7 | 7 | l | m | n | o | p | q | r | s | t | u | v | w | x | y |

Character Set
Figure 3

Operation

In a dot matrix display system, it is advantageous to use a multiplexed approach with 12 drivers (5 digit + 7 segments) rather than 35 segment drivers. This obviously reduces the number of drivers and interconnections required. A multiplexed system must be a synchronous system or the digits or elements may have different on (lit) times and therefore varying brightness.

The DLX-713x is an internally multiplexed display but the data entry is asynchronous. Loading data is similar to writing into a RAM. Present the data, select the chip, and give a write signal. For a multi-digit system, each digit has its own unique location and will display its contents until replaced by another code.

Dimming and Blanking Control

| Brightness Level | $\overline{\text{BL1}}$ | $\overline{\text{BL0}}$ |
|------------------|-------------------------|-------------------------|
| Blank | 0 | 0 |
| 1/4 brightness | 0 | 1 |
| 1/2 brightness | 1 | 0 |
| full brightness | 1 | 1 |

Lamp Test

The lamp test when activated causes all dots on the display to be illuminated at half brightness. It does not destroy any previously stored characters. The lamp test function is independent of chip enable, write, and the settings of the blanking inputs.

This convenient test gives a visual indication that all dots are functioning properly. Because of the lamp test not affecting the display memory, it can be used as a cursor or pointer in a line of displays.

General Design Considerations

When using the DLX-713x on a separate display board having more than 6 inches of cable length, it may be necessary to buffer all of the input lines. A non-inverting 74365 hex buffer can be used. The object is to prevent transient current into the DLX-713x protection diodes. The buffers should be located on the display board and as close to the displays as possible.

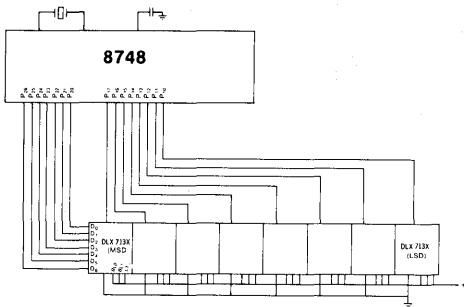
Because of high switching currents caused by the multiplexing, local power supply by-pass capacitors are also needed in many cases. These should be 6 or 10 volt, tantalum type having 5 - 10 uf capacitance. The capacitors may only be required every 6-7 displays depending on the line regulation and other noise generators.

If small wire cables are used, it is good engineering practice to calculate the wire resistance of the ground and the +5 volt wires. More than 0.2 volt drop (at 100ma per digit) should be avoided, since this loss is in addition to any inaccuracies or load regulation of the power supply.

The 5 volt power supply for the DLX-713x should be the same one supplying the Vcc to all logic devices. If a separate supply must be used, then local buffers should be used on all the inputs and these buffers should be powered from the display power supply. This precaution is to avoid line transients or any logic signals to be higher than Vcc during power up.

Interfacing

For an eight digit display using the DLX-713x, interfacing to a single chip microprocessor such as the 8748 is easy and straight forward. One approach may be to dedicate one port for the six data signals and another 8-bit port for the write signals. The schematic is shown in Figure 6.



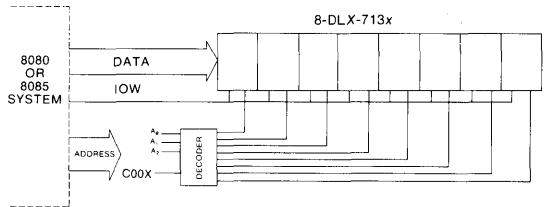
DLX-713x with 8748
Figure 6

```

INIT:   ORL   P1,#0FFH      ; SUBROUTINE TO LOAD AN 8-DIGIT
        ORL   P2,#00H      ; DISPLAY USING THE DL7135
        MOV  R1,#0FH       ; DATA IN RAM 10H-17H (MSD-LSD)
        MOV  R2,#0FEH      ; PORT 1 ALL HIGH (WRITE)
        MOV  R3,#008H      ; PORT 2 ALL LOW (DATA)
        INC  R1             ; RAM ADDRESS - 1
        INC  R2             ; WRITE PULSE
        INC  R3             ; COUNTER
START:  INC  A,@R1         ; INCREMENT RAM POINTER
DATA:   MOV  A,@R1         ; FETCH DATA FROM RAM
        OUTL P2,A          ; LOAD PORT 2
        MOV  A,R2          ; RECALL WRITE
        RR   A             ; SHIFT A TO NEXT WRITE
        MOV  R2,A          ; SAVE WRITE
WRITE:  OUTL P1,A          ; SEND WRITE PULSE
        MOV  A,#0FFH      ; WAIT
        OUTL P1,A          ; RESET WRITE PULSE
        DJNZ R3,START     ; LOAD COMPLETE?
        RET                ; RETURN TO MAIN PROGRAM
    
```

I/O or Memory Mapped System

For a memory mapped system using a processor such as the 8080 or 8085, the interfacing is also straight-forward. Each display is treated as a memory location with its own address, like another I/O or RAM location.



Block Diagram for 8-Digit
DLX-713x Dot Matrix Display
Figure 7

```

; ROUTINE FOR AN 8 DIGIT DISPLAY
; USING THE DLX-713x AND
; 8085 OR 8080 MICROPROCESSOR
;
; DATA TO BE DISPLAYED IS IN
; A0(LSD) THRU A8(MSD)
;
; DISPLAY ADDRESS C00X
; LSD IS RIGHT MOST DIGIT
;
; DOES NOT SAVE REG A,B,H,L,D,E
;
DADD EQU 0A000H      ; DATA ADDRESS LOCATION
DPAD EQU 0C000H      ; DISPLAY ADDRESS LOCATION
LEN EQU 08H          ; DISPLAY LENGTH
;
ORG 100H
;
DISP:  LXI  H,DADD     ; LOAD DATA ADDRESS
        LXI  D,DPAD     ; LOAD DISPLAY ADDRESS
        MVI  B,LEN     ; LOAD DISPLAY LENGTH
DISP1: MOV  A,M        ; GET DATA
        XCHG           ; XCHG H/L & D/E
        MOV  M,A        ; LOAD DISPLAY FROM REG A
        XCHG           ; RESTORE H/L & D/E
        INX  D          ; INCREMENT DISPLAY ADDRESS
        INX  H          ; INCREMENT DATA ADDRESS
        DCR  B          ; DECREMENT LENGTH COUNTER
        JNZ  DISP1     ; END OF DISPLAY?
        RET            ; RETURN TO MAIN PROGRAM
    
```

Conclusion

Note that although other manufacturer's products are used in the examples, this application note does not imply specific endorsement, or warranty of other manufacturer's products by Siemens. The interface schemes shown demonstrate the simplicity of using the DLX-713x Dot Matrix Intelligent Display. Slight timing differences may be encountered for various microprocessors, but can be resolved similar to those encountered when using different RAM's. The techniques used in the examples were shown for their generality. The user will undoubtedly invent other schemes to optimize his particular system to its requirements.

Application Note 26

SFH 900 – a Low-Cost Miniature Reflex Optical Sensor

Whether for an industrial plant or a hobbyists' drilling machine, an electric drive will hardly be acceptable nowadays without speed control. Incremental bar patterns simply applied to rotating shafts can be detected by the new Siemens reflex optical sensor, the SFH 900. The information can be processed with a minimum of circuitry, whether for a high rate of black-to-white transitions or just single, slow transitions.

Construction

The SFH 900 optical sensor is a remarkable component even by virtue of its shape alone. Its maximum height of 2.2 mm is in the trend of today's electronics, of putting a large number of functions into a very small space. The small dimensions allow it to be used where ordinary optical sensors run into space or other problems. **Fig. 1** is an enlarged picture of the device. Dimensions and pin configuration are shown in **Fig. 2**.

Fabricated by lead frame technique in a thermoplastic package, the sensor uses a GaAs infra-red diode as a radiation emitter and a large-area phototransistor as the detector. High sensitivity is ensured by a 1 mm² radiation sensitive area and a current gain of almost 1000. The effect of unwanted ambient light is almost screened out by a filter.

Two fixing notches are a help in mounting the device. Lead frame technology accurately locates the optically active areas relative to these notches and thus to the component body. **Fig. 3** is an example of one form of mounting.

Fig. 1 SFH 900 reflex optical sensor, front and back view, shown here three times normal size

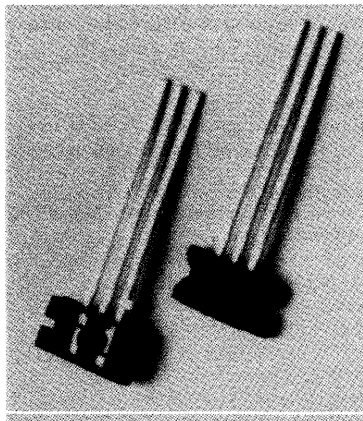
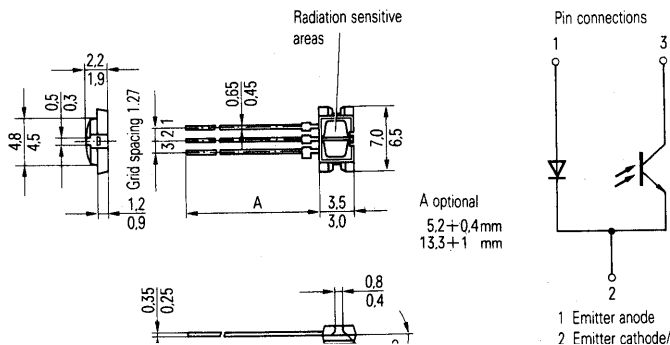


Fig. 2 Outline dimensions and pin connections of SFH 900



Characteristics

Main technical data are given in the **Table**. Turn-on and turn-off times are also important. These depend essentially on the collector current I_C and the load resistance R_L . Typical switching times for $I_C = 1$ mA and $R_L = 1$ k Ω are 50 to 70 μ s.

The user will be mainly concerned with the following points:

- What collector current, I_C , can be expected under given static conditions?
- What are the signal amplitudes when scanning bar patterns of different pitches?
- What is the temperature dependence of the collector current and what is the repeatability of the measured values?

Collector current

Dependence of collector current on emitter diode forward current I_F is almost linear at forward currents above 10 mA, as can be seen from **Fig. 4**. At currents below 1 mA the dependency shows almost a square law. The measurement was made with a standard reflector (Kodak neutral white test card, $r = 90\%$) at a distance of 1 mm.

Fig. 5 shows I_C characteristics for distances of 0.2 to 10 mm at a constant forward current of 10 mA. The curves are for four different reflecting materials: two standard Kodak reflectors with 15% and 90% reflection, polished aluminium and a strongly absorbing foil. DC-fix adhesive tapes and other tapes commonly used for printed circuit layouts proved particularly suitable. It should be mentioned that the curve for polished aluminium in **Fig. 5** is very similar to the Kodak reflector response with $r = 90\%$, in spite of the reflection being mirrored by the metal and diffused by the standard reflector, as a result of the wide directional characteristics of the emitter and detector.

At short distances (e.g. $d = 0.25$ mm) very large changes of current per unit distance are obtained. Because of these steep edges, which can only be used dynamically, the SFH 900 may also be utilized as a microphone.

Fig. 3 Suggestion for mounting the SFH 900. Projections N in the flexible plastic clamp locate in corresponding notches in the body of the optical sensor

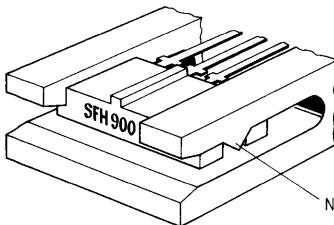


Fig. 4 SFH 900 collector current I_C as a function of forward current I_F with 90% diffuse reflector at distance $d = 1$ mm and with $U_s = 5$ V

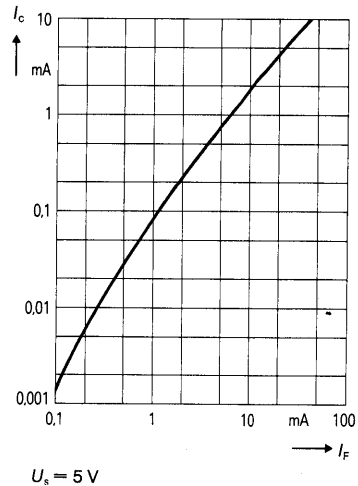
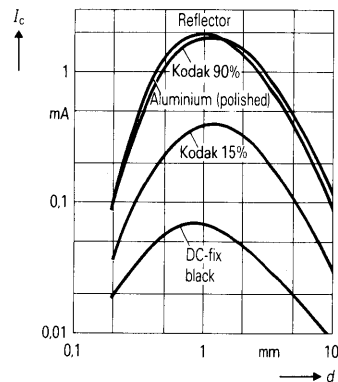
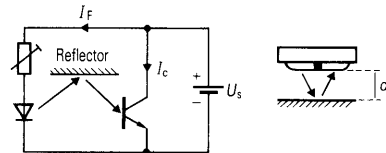


Fig. 5 SFH 900 collector current I_C as a function of reflector distance d with different reflector materials



Forward current $I_F = 10$ mA
Operating voltage $U_s = 5$ V.

Emitter (GaAs infra-red diode)

Reverse voltage
 Forward dc current
 Surge current ($t \leq 10 \mu\text{s}$)
 Power dissipation ($T_{\text{amb}} = 40^\circ\text{C}$)
 Thermal resistance

| | | |
|-------------------|-----|-----|
| U_R | 6 | V |
| I_F | 50 | mA |
| I_{FSM} | 1.5 | A |
| P_{tot} | 80 | mW |
| R_{thJU} | 750 | K/W |

Detector (silicon phototransistor)

Collector-emitter voltage
 Emitter-collector voltage
 Collector current
 Total power dissipation ($T_{\text{amb}} = 40^\circ\text{C}$)
 Collector-emitter leakage current ($U_{\text{CE}} = 10 \text{ V}$)
 Photocurrent under ambient light ($U_{\text{CE}} = 5 \text{ V}$)
 ($E_E = 0.5 \text{ mW/cm}^2$)

| | | |
|------------------|-------------------|----|
| U_{CEO} | 30 | V |
| U_{ECO} | 7 | V |
| I_C | 10 | mA |
| P_{tot} | 100 | mW |
| I_{CEO} | 20 (≤ 200) | nA |
| I_F | ≤ 3 | mA |

Reflex optical sensor

Storage temperature range
 Ambient temperature range
 Junction temperature
 Total power dissipation ($T_{\text{amb}} = 40^\circ\text{C}$)
 Collector current
 ($I_F = 10 \text{ mA}$; $U_{\text{CE}} = 5 \text{ V}$; $d = 1 \text{ mm}$)

| | | |
|---------------------------|------------|------------------|
| T_S | -40 to +85 | $^\circ\text{C}$ |
| T_U | -40 to +85 | $^\circ\text{C}$ |
| T_J | 100 | $^\circ\text{C}$ |
| P_{tot} | 150 | mW |
| SFH 900-1 I_{CE} | ≥ 0.3 | mA |
| SFH 900-2 I_{CE} | ≥ 0.5 | mA |

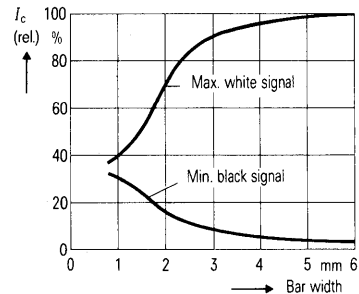
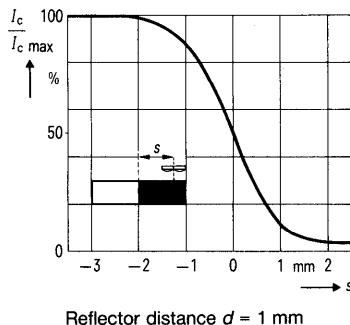
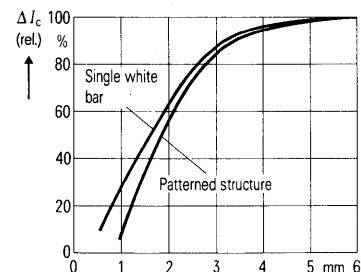
Table Selective characteristics of SFH 900**Resolution of black-and-white patterns**

As can be seen from Fig. 5, strongly reflecting and badly reflecting materials give collector currents differing by a factor of about 25. Strongly reflecting means »white«, badly reflecting »black«.

If a black-to-white transition is scanned, the displacement distance between the »fully white« signal and the »fully black« signal is 4 to 5 mm (Fig. 6).

If, in contrast, a regular bar pattern is scanned, the signal amplitude becomes smaller the smaller the bar width. Fig. 7 shows clearly how the excursion is affected: the maximum white signal becomes smaller with decreasing bar width, while the minimum black signal becomes larger. Fig. 8 shows the signal excursion itself, to make it clearer. Here a regular pattern and a single white bar are compared. The excursion is referred to a single black-to-white transition corresponding to a 100% signal excursion.

A bar width of 3 mm can thus be detected without significant loss of sensitivity. The signal excursion, however, drops to as low as 10% using a grid of 1 mm bar

Fig. 7 Maximum and minimum collector current when scanning a black-white pattern**Fig. 6** Resolution of a black-to-white transition. Relative collector current as a function of sensor position s **Fig. 8** Relative signal excursion as a function of white bar width $I_F = 10 \text{ mA}$, $d = 1 \text{ mm}$ 

width. An apparently higher signal excursion is obtained when a single 1 mm wide white bar on a black background is scanned. The result is then about a 30%, as shown in Fig. 8.

The optical sensor can be used for scanning in any position, regardless of whether the emitter-detector axis is at right-angles to the scanning direction. Tests have shown that the device sensitivity is independent of direction. If a white spot on a black background (or vice-versa) is to be detected without loss of sensitivity, this should have a minimum area of 5x5 mm. From this we can conclude that a pattern bar must not be larger than 5 mm.

Thus the resolution capability of the SFH 900 seems to be limited to bar widths of 1 to 2 mm minimum. In fact, however, considerably higher resolutions can be obtained when gratings are used. An example is given below.

Temperature dependence

The temperature dependence of the output signal is shown in Fig. 9. This fortunately very small dependence results from the combination of the temperature dependent diode emission (approx. $-0.55\%/K$) with the temperature dependent current gain of the phototransistor (approx. $+0.9\%/K$). As these two parameters partly compensate for each other the temperature dependence of the output signal is fairly small.

There is a spread of characteristics in the different devices but they remain within the specified tolerance range, allowing for ageing, with a probability of at least 95%.

Applications

Speed control for dc motors

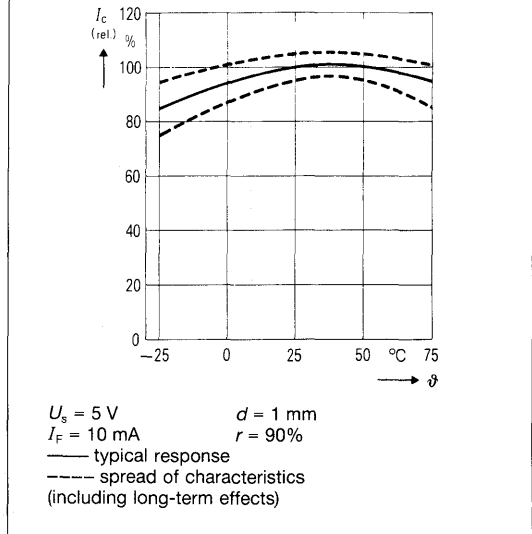
A simple speed regulator circuit for small dc motors can be designed using the TCA 955 device. Fig. 10 is an example. The teeth of a toothed wheel on the motor shaft serve as reflectors (40 teeth on a wheel of approx. 60 mm diameter). Pulses from the optical sensor are converted by the TCA 955 into a dc voltage proportional to speed. The pulse signal is first amplified, then frequency doubled, then fed to a monostable which produces a square wave with a constant pulse duration determined by the R_1 , C_1 product. The mean value of this pulse train is determined by capacitor C_2 and an 8.7 k Ω internal resistor.

The voltage present at C_2 , still with a slight triangular modulation, is compared with an internal set value. The difference is amplified and determines the duty cycle in the subsequent mark-to-space ratio converter. The motor is connected to the operating voltage via a BD 675 switching stage, which runs to the rhythm of the duty cycle. A larger mark-to-space ratio causes the speed to increase. The desired frequency can be set by P1 over a wide range.

Speed control for ac motors

This is mainly intended for use in the consumer field, in such things as kitchen appliances and drilling machines. It is important that the speed indicator should have a very low current consumption as it is supplied from a simple line rectifier circuit using a series resistor. The specimen circuit in Fig. 11 has an emitter diode current of only

Fig. 9 Relative collector current as a function of temperature



2 mA. Signal processing and triac triggering are done by the new TLB 3101 phase control IC. Total current needed for control is around 7 mA, including the SFH 900.

Pulses from the optical sensor are first amplified, then converted by a monostable to constant pulse width and finally filtered to give a mean value. By comparison with a sawtooth voltage the gate trigger time for the triac is fixed. A soft start is given by transistor T1.

The range of speed regulation is 5000 to 15000 rpm. The reflector is a disc mounted on the motor shaft, and at its periphery this disc has, as an example, 5 pairs of black and white segments.

Shaft encoder with direction sensing

This example shows how gratings can be used to give a considerable increase in resolution. A transparent disc of about 130 mm diameter has an array of 200 opaque bars at its periphery (Fig. 12a). The bar width is thus about 1 mm. A second grating with reflecting white bars is placed under the disc. If the disc pattern and the grating beneath are set gap to gap, the detector «sees» 100% black. If the bars of the two gratings are on top of each other the image appears as 50% white. So, when the disc is rotating the useful amplitude is therefore about 50% of the full black-to-white excursion.

The grating pattern is constructed so that one half is displaced by 90° of a grid period with respect to the other half. If a reflex optical sensor is assigned to each half, on rotation of the disc the output signals will be roughly sinusoidal and displaced by 90° from each other. This means that patterns of half bar width can be successfully resolved.

In further processing both sinewave voltages are converted into square waveforms, also phase-shifted by 90° (Fig. 13).

The rising edge of on square-wave (signal 1) is used for counting. It triggers a monoflop which generates a pulse of short duration relative to the square-wave period. The other, 90° shifted, square-wave controls the direction of the counter (Low = forward, High = backward).

According to the direction command, the conditions in **Fig. 13** come into effect. The active clock edge coincides with either the low level or the high level of signal 2. Counting therefore takes place in accordance with forward or backward rotation of the shaft. **Fig. 14** gives the detailed circuit diagram of the shaft encoder.

The counter used has a range of two decades and gives the BCD separately for each digit.

A 7-segment decoder-driver follows this for each of the two LED displays. The number of digits can be increased by cascading several stages.

For the purposes of explanation any bar in the pattern can be considered as the starting point and the counter reset to zero using the reset key. If now the disc is turned at any speed in either direction with respect to the stationary mark, the counter indicates the bar number difference with respect to the starting point. As only dc voltage coupling is used the rotational speed may have any arbitrary minimum value.

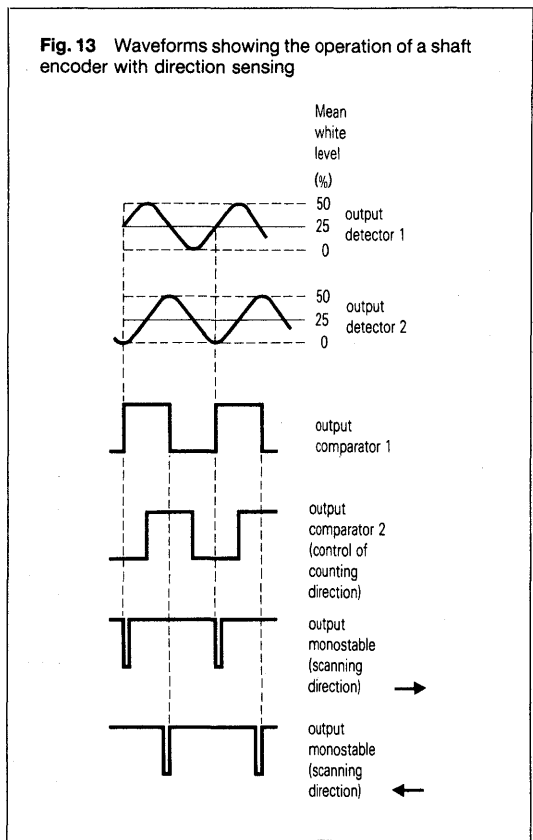
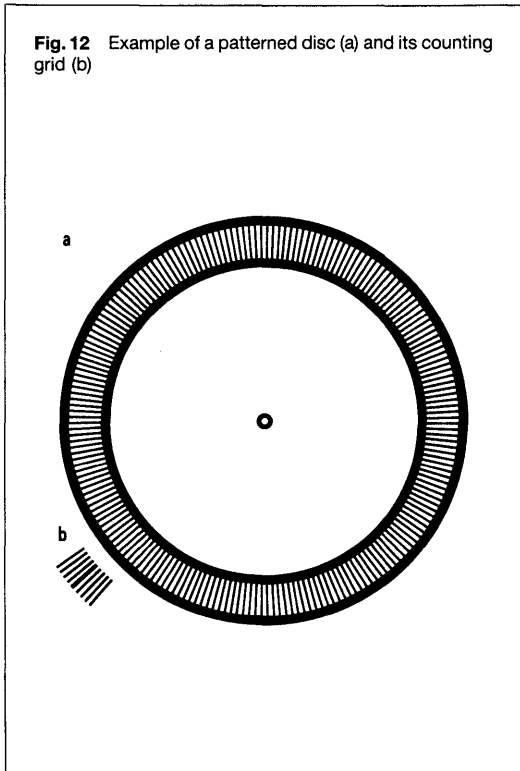
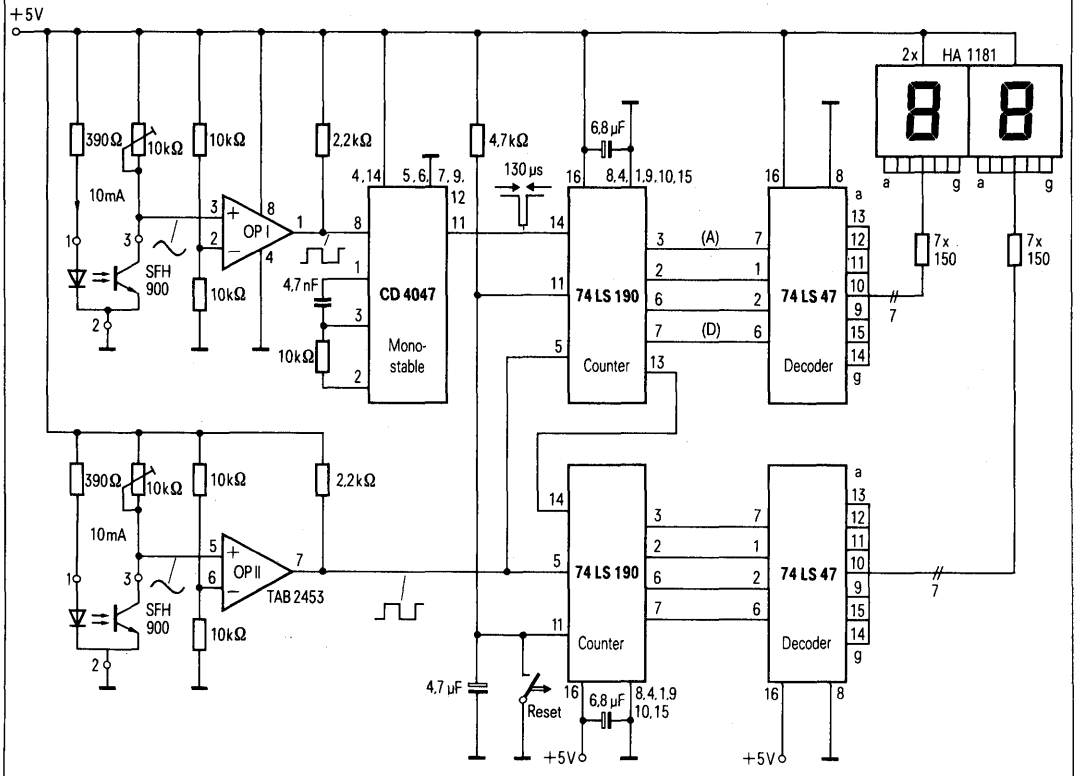


Fig. 14 SFH 900: circuit for shaft encoder with direction sensing



The DLX-413x 5x7 Dot Matrix Intelligent Display Appnote 28

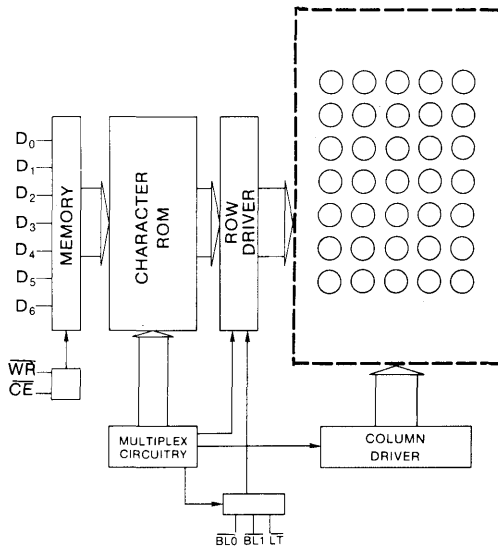
by Dave Takagishi

This application note is intended to serve as a design and application guide for users of the DLO-4135 and DLG-4137 Siemens Optoelectronics Division Intelligent Displays. The information presented covers device electrical description, operation, general circuit design considerations, and interfacing to microprocessors.

Electrical Description

If you have never designed a system using a dot matrix display before, you cannot appreciate the simplicity of using the DLX-413X Intelligent Alphanumeric 5x7 Dot Matrix Display. The intelligent display contains memory, character generator, multiplexing circuits, and drivers built into a single package.

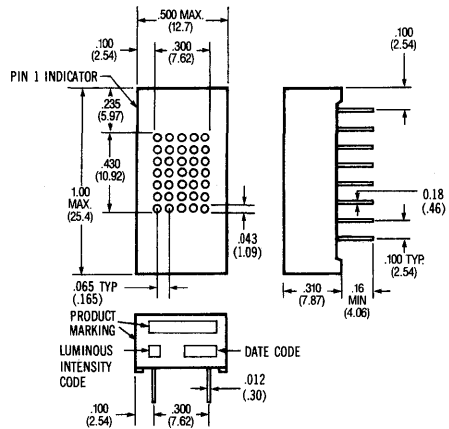
Figure 1 is a block diagram of the DLX-413X. The unit consists of 35 LED die arranged in a 5x7 pattern and a single CMOS integrated circuit chip. The IC chip contains the segment drivers, digit drivers, 96 character generator ROM, memory, multiplex and blanking circuitry.



DLX-413X BLOCK DIAGRAM
FIGURE 1

Package

The 35 dots form a 0.30 x 0.43 inch overall character size in a .500 x 1.00 inch dual-in-line package. The ±50 degree wide viewing angle complements the display and is the ideal display for the industrial control application. Display construction is a filled reflector type with the integrated circuit in the back and then filled with IC-grade epoxy. This results in a very rugged part which is quite impervious to moisture, shock, and vibration.



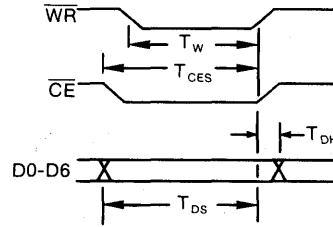
Physical Dimension Inches
FIGURE 2

Electrical Inputs

| PIN | Name | PIN | Name |
|-----|----------------------------|-----|---------------------|
| 1 | Vcc | 14 | D6 data input (msd) |
| 2 | LT lamp test | 13 | D5 data input |
| 3 | CE chip enable | 12 | D4 data input |
| 4 | WR write | 11 | D3 data input |
| 5 | BL ₁ brightness | 10 | D2 data input |
| 6 | BL ₀ brightness | 9 | D1 data input |
| 7 | GND | 8 | D0 data input (lsd) |

Pin Description

| | |
|--|--|
| Vcc | Positive Supply +5 volts |
| GND | Ground |
| D0-D6 | Data Lines see figure 3 for character set |
| $\overline{\text{CE}}$ | Chip Enable (active low) This determines which device in an array will accept data |
| $\overline{\text{WR}}$ | Write (active low) Data and chip enable must be present and stable before and after the write pulse (see data sheet for timing) |
| $\overline{\text{BL0}}, \overline{\text{BL1}}$ | Blanking Control Input (active low) Used to control the level of display brightness |
| $\overline{\text{LT}}$ | Lamp Test (active low) Causes all dots to light at 1/2 brightness |



Timing Characteristics
Figure 4

CHARACTER SET

| | | | | | | | | | | | | | | |
|-------|-----|---|---|---|----|---|---|---|---|---|---|---|---|---|
| D0 | L | H | L | H | L | H | L | H | L | H | L | H | L | H |
| D1 | L | L | H | H | L | H | H | L | L | H | H | L | L | H |
| D2 | L | L | L | L | H | H | H | L | L | L | L | H | H | H |
| D3 | L | L | L | L | L | L | L | L | H | H | H | H | H | H |
| D0-D3 | HEX | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C |
| | | D | E | F | | | | | | | | | | |
| L L L | 0 | | | | | | | | | | | | | |
| L L H | 1 | | | | | | | | | | | | | |
| L H L | 2 | ! | " | # | \$ | % | & | ' | (|) | * | + | , | . |
| L H H | 3 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | < | > |
| H L L | 4 | A | B | C | D | E | F | G | H | I | J | K | L | N |
| H L H | 5 | P | Q | R | S | T | U | V | W | X | Y | Z | [|] |
| H H L | 6 | a | b | c | d | e | f | g | h | i | j | k | l | n |
| H H H | 7 | p | q | r | s | t | u | v | w | x | y | z | { | } |

Character Set
Figure 3

Operation

In a dot matrix display system, it is advantageous to use a multiplexed approach with 12 drivers (5 digit + 7 segments) rather than 35 segment drivers. This obviously reduces the number of drivers and interconnections required. A multiplexed system must be a synchronous system or the digits or elements may have different on (lit) times and therefore varying brightness.

The DLX-413x is an internally multiplexed display but the data entry is asynchronous. Loading data is similar to writing into a RAM. Present the data, select the chip, and give a write signal. For a multi-digit system, each digit has its own unique location and will display its contents until replaced by another code.

The waveforms of figure 4 demonstrates the relation-

Display Blanking and Dimming

The DLX-413x Intelligent Display has the capability of three levels of brightness plus blank. Figure 5 shows the combination of $\overline{\text{BL0}}$ and $\overline{\text{BL1}}$ for the different levels of brightness. The $\overline{\text{BL0}}$ and $\overline{\text{BL1}}$ inputs are independent of write and chip enable and does not affect the contents of the internal memory. A flashing display can be achieved by pulsing the blanking pins at a 1-2 hertz rate. Either $\overline{\text{BL0}}$ or $\overline{\text{BL1}}$ should be held high to light up the display.

Dimming and Blanking Control

| Brightness Level | $\overline{\text{BL1}}$ | $\overline{\text{BL0}}$ |
|------------------|-------------------------|-------------------------|
| Blank | 0 | 0 |
| 1/4 brightness | 0 | 1 |
| 1/2 brightness | 1 | 0 |
| full brightness | 1 | 1 |

Lamp Test

The lamp test when activated causes all dots on the display to be illuminated at half brightness. It does not destroy any previously stored characters. The lamp test function is independent of chip enable, write, and the settings of the blanking inputs.

This convenient test gives a visual indication that all dots are functioning properly. Because of the lamp test not affecting the display memory, it can be used as a cursor or pointer in a line of displays.

General Design Considerations

When using the DLX-413x on a separate display board having more than 6 inches of cable length, it may be necessary to buffer all of the input lines. A non-inverting 74365 hex buffer can be used. The object is to prevent transient current into the DLX-413x protection diodes. The buffers should be located on the display board and as close to the displays as possible.

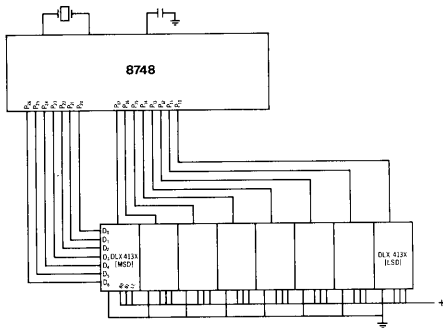
Because of high switching currents caused by the multiplexing, local power supply by-pass capacitors are also needed in many cases. These should be 6 or 10 volt, tantalum type having 5 - 10 uf capacitance. The capacitors may only be required every 6-7 displays depending on the line regulation and other noise generators.

If small wire cables are used, it is good engineering practice to calculate the wire resistance of the ground and the +5 volt wires. More than 0.2 volt drop (at 100ma per digit) should be avoided, since this loss is in addition to any inaccuracies or load regulation of the power supply.

The 5 volt power supply for the DLX-413x should be the same one supplying the Vcc to all logic devices. If a separate power supply must be used, then local buffers should be used on all the inputs and these buffers should be powered from the display power supply. This precaution is to avoid line transients or any logic signals to be higher than Vcc during power up.

Interfacing

For an eight digit display using the DLX-413x, interfacing to a single chip microprocessor such as the 8748 is easy and straight forward. One approach may be to dedicate one port for the six data signals and another 8-bit port for the write signals. The schematic is shown in Figure 6.



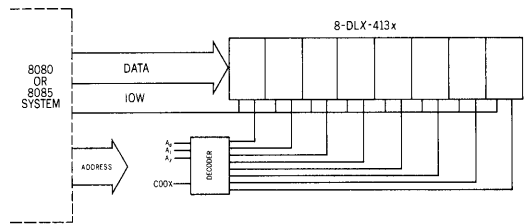
DLX-413x with 8748
Figure 6

```

INIT:  ORL   P1,#0FFH      ; SUBROUTINE TO LOAD AN 8-DIGIT
        ORL   P2,#00H      ; DISPLAY USING THE DL7135
        MOV   R1,#0FH      ; DATA IN RAM 10H-17H (MSD-LSD)
        MOV   R2,#0FEH     ; PORT 1 ALL HIGH (WRITE)
        MOV   R3,#08H      ; PORT 2 ALL LOW (DATA)
        INC   R1            ; RAM ADDRESS - 1
        INC   R1            ; WRITE PULSE
        INC   R1            ; COUNTER
START: INC   R1            ; INCREMENT RAM POINTER
DATA:  MOV   A,@R1         ; FETCH DATA FROM RAM
        OUTL P2,A          ; LOAD PORT 2
        MOV   A,R2         ; RECALL WRITE
        RR   A             ; SHIFT A TO NEXT WRITE
        MOV   R2,A         ; SAVE WRITE
WRITE: OUTL P1,A          ; SEND WRITE PULSE
        MOV   A,#0FFH     ; WAIT
        OUTL P1,A         ; RESET WRITE PULSE
        DJNZ R3,START     ; LOAD COMPLETE?
        RET                ; RETURN TO MAIN PROGRAM
    
```

I/O or Memory Mapped System

For a memory mapped system using a processor such as the 8080 or 8085, the interfacing is also straight-forward. Each display is treated as a memory location with its own address, like another I/O or RAM location.



**Block Diagram for 8-Digit
DLX-413x Dot Matrix Display**
Figure 7

```

; ROUTINE FOR AN 8 DIGIT DISPLAY
; USING THE DLX-713x AND
; 8085 OR 8080 MICROPROCESSOR
;
; DATA TO BE DISPLAYED IS IN
; A0(LSD) THRU A8(MSD)
;
; DISPLAY ADDRESS C00X
; LSD IS RIGHT MOST DIGIT
;
; DOES NOT SAVE REG A,B,H,L,D,E
;
DADD   EQU   0A000H      ; DATA ADDRESS LOCATION
DPAD   EQU   0C000H      ; DISPLAY ADDRESS LOCATION
LEN    EQU   08H        ; DISPLAY LENGTH
;
ORG    100H
;
DISP:  LXI   H,DADD      ; LOAD DATA ADDRESS
        LXI   D,DPAD     ; LOAD DISPLAY ADDRESS
        MVI   B,LEN      ; LOAD DISPLAY LENGTH
DISP1: MOV   A,M         ; GET DATA
        XCHG          ; XCHG H/L & D/E
        MOV   M,A        ; LOAD DISPLAY FROM REG A
        XCHG          ; RESTORE H/L & D/E
        INX   D          ; INCREMENT DISPLAY ADDRESS
        INX   H          ; INCREMENT DATA ADDRESS
        DCR   B          ; DECREMENT LENGTH COUNTER
        JNZ  DISP1      ; END OF DISPLAY?
        RET                ; RETURN TO MAIN PROGRAM
    
```

Conclusion

Note that although other manufacturer's products are not used in the examples, this application note does not imply specific endorsement, or warranty of other manufacturer's products by Siemens. The interface schemes shown demonstrate the simplicity of using the DLX-413x Dot Matrix Intelligent Display. Slight timing differences may be encountered for various microprocessors, but can be resolved similar to those encountered when using different RAM's. The techniques used in the examples were shown for their generality. The user will undoubtedly invent other schemes to optimize his particular system to its requirements.

Quality Assurance

The Quality Assurance Group at Siemens Optoelectronics Division serves a vital function in our organization, enabling the Division to maintain constant product quality standards. As such, Quality Assurance monitors and verifies all aspects of production, ensuring that all materials, processes, manufacturing and test equipment, and piece parts meet precise engineering specifications. Quality Assurance activities begin with carefully assessing the quality of raw materials. QA work continues through in-process monitoring, and concludes with outgoing audits as outlined below:

■ Raw Material

- Vendor surveys
- Vendor qualifications
- Incoming inspections
- Vendor rating systems

■ In-process Monitors

- Die attach monitors
- Lead bond monitors
- Encapsulation monitors
- Finishing operations monitors

■ Outgoing Audits

- Outgoing audits (all lots)
- Finished goods monitor (random)

Figure 2 further exemplifies the basic quality control procedures employed by the Division in the production of LEDs.

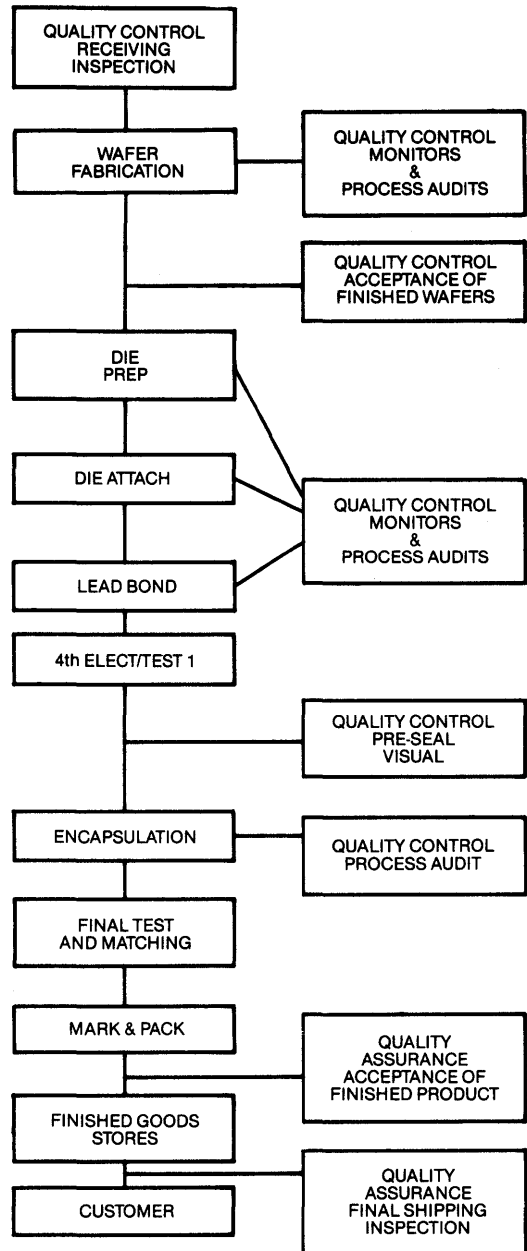


Figure 2 LED Quality Assurance Flowchart

Reliability

The fundamental objective of the Reliability program at Siemens Optoelectronic Division is to quantitatively/qualitatively determine that all products produced by the Division meet or exceed the performance requirements of our Engineering Group and our customers. To ensure achievement of this goal, the Reliability group constantly monitors products by generic groups. Routine monitoring provides continually updated measurement of product reliability in specific operating environments. Typical tests include temperature cycling, thermal shock, temperature and humidity, high-temperature burn-in, solder-heat test, high- and low-temperature storage and intermittent operating life.

Standard Reliability Matrix Test Format

Temperature Cycle: 100 Cycles from -40°C to 100°C

Thermal Shock: 30 Cycles from 0°C to 100°C

Ambient Life Test: Max rated power for 1000 hours

Elevated Life Test: Max rated power at 70°C for 1000 hours.

High Temperature Storage: Max storage temperature, 1000 hours

Low Temperature Storage: Minimum storage temperature, 1000 hours

Temperature Humidity: 85°C - 85% RH, 500 hours

Solder Heat Test: 260°C , 5 seconds

Reliability test equipment ranges from multiple burn-in racks and table testers to a scanning electron-beam microscope. We've even designed and produced our own automatic microprocessor-based read/record tester.

Figure 4 Reliability Test Data (1982-1983 Monitoring Data)

| Type of Test | Lamps | Standard Displays | Intelligent Displays | Opto-isolators |
|--|-------|-------------------|----------------------|----------------|
| Temperature Cycle (100 CY) | | | | |
| Sample Size | 467 | 1031 | 2084 | 2236 |
| Total Cycles | 47K | 103K | 208K | 2236 |
| Total Reject | 0 | 0 | 5 | 0 |
| Percent Reject | 0.0% | 0.0% | 0.2% | 0.0% |
| Thermal Shock (30 CY) | | | | |
| Sample Size | 466 | 976 | 1228 | 1468 |
| Total Cycles | 14K | 29K | 37K | 44K |
| Total Reject | 0 | 0 | 0 | 3 |
| Percent Reject | 0.0% | 0.0% | 0.0% | 0.3% |
| Room Temperature Burn-In (1000 Hrs) | | | | |
| Sample Size | 110 | 492 | 525 | 294 |
| Total Hours | 110K | 492K | 525K | 294K |
| Total Reject | 0 | 0 | 0 | 1 |
| FR* (%) | 0.0% | 0.0% | 0.0% | 0.3% |
| High Temperature Burn-In (1000 Hrs) | | | | |
| Sample Size | 110 | 222 | 525 | 492 |
| Total Hours | 110K | 222K | 525K | 492K |
| Total Reject | 0 | 0 | 1 | 1 |
| FR* | 0.0% | 0.0% | 0.2% | 0.2% |
| Solder Heat Test (260°C , 5 sec.) | | | | |
| Sample Size | 253 | 456 | 853 | 478 |
| Total Reject | 0 | 0 | 1 | 0 |
| Percent Reject | 0.0% | 0.0% | 0.1% | 0.0% |

*FR = Failure Rate, % per 1000 hours.

Special testing covers a broad spectrum of environmental and life-stress tests. How well a sample performs under these highly-accelerated conditions indicates its reliability potential under service-life conditions.

Special testing affords us vital information in many important areas:

- New product performance
- New processes
- New manufacturing technique
- New material quality
- Special customer specifications
- Long-term reliability prediction

Reliability is also concerned with failure analysis. To determine the cause of failure, we selectively test and section products to localize and identify their failure mechanism. Selective isolation enables us to gauge the precise effects of stresses induced during reliability testing.

Figure 5 Description of Tests - Reliability Monitor Program

| Type of Test | Military Standard | Pre Test Readings | Test | Post Test Readings |
|---------------------------|-----------------------------|-------------------|--|---------------------------------------|
| Temp Cycle (T/C) | MIL STD 883B, Method 1010.2 | GO/NO GO | 10 cycles per sub group, 15 min. dwell, 5 sec. transfer time, max. storage temp. ranges vary by product | GO/NO GO |
| Thermal Shock (T/S) | MIL STD 883B, Method 1011.1 | GO/NO GO | 30 cycles: boiling water; then ice water with 5 min. dwell time at each extreme | GO/NO GO |
| Life Test (L/T) | MIL STD 833B, Method 1005.2 | Read/Record | Room temperature burn-in at max. rated conditions, 1000 hours duration | Read/Record at 168,500 and 1000 hours |
| High Temp Burn In (HI BI) | MIL STD 883B, Method 1005.2 | Read/Record | Maximum rated operating temp. determined from product spec. and derated current as compensation for thermal dissipation, 1000 hours duration | Read/Record at 168,500 and 1000 hours |
| Solder Heat Test | — | GO/NO GO | Temp = 260 °C, dwell time = 5 seconds | GO/NO GO |

Conclusion

Siemens Optoelectronic Division is firmly committed to the design, development and production of innovative optoelectronic components and assemblies of the highest quality and reliability. Working to achieve this goal, every group within the Division—Management, Engineering, R & QA, Manufacturing—provides a vital service, enabling us to achieve and maintain the consistent product quality and levels of reliability required by our customers in the electronics industry.

Due in large part to the efforts of the Reliability and Quality Assurance department and our successful PPM and SQC efforts, Siemens Optoelectronic Division will continue to maintain its leadership position in a highly competitive future-oriented industry.

For complete reliability information please request booklet, "Quality Assurance Paper."

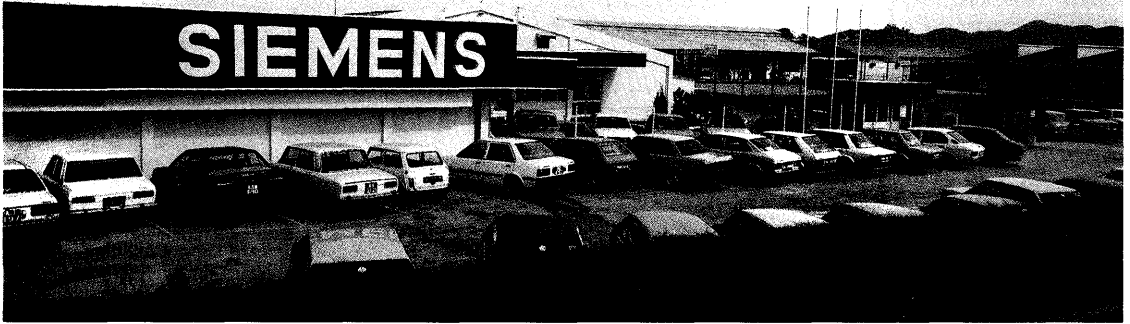
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- **Wisconsin:** Arrow, Oak Creek (414) 764-6600
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